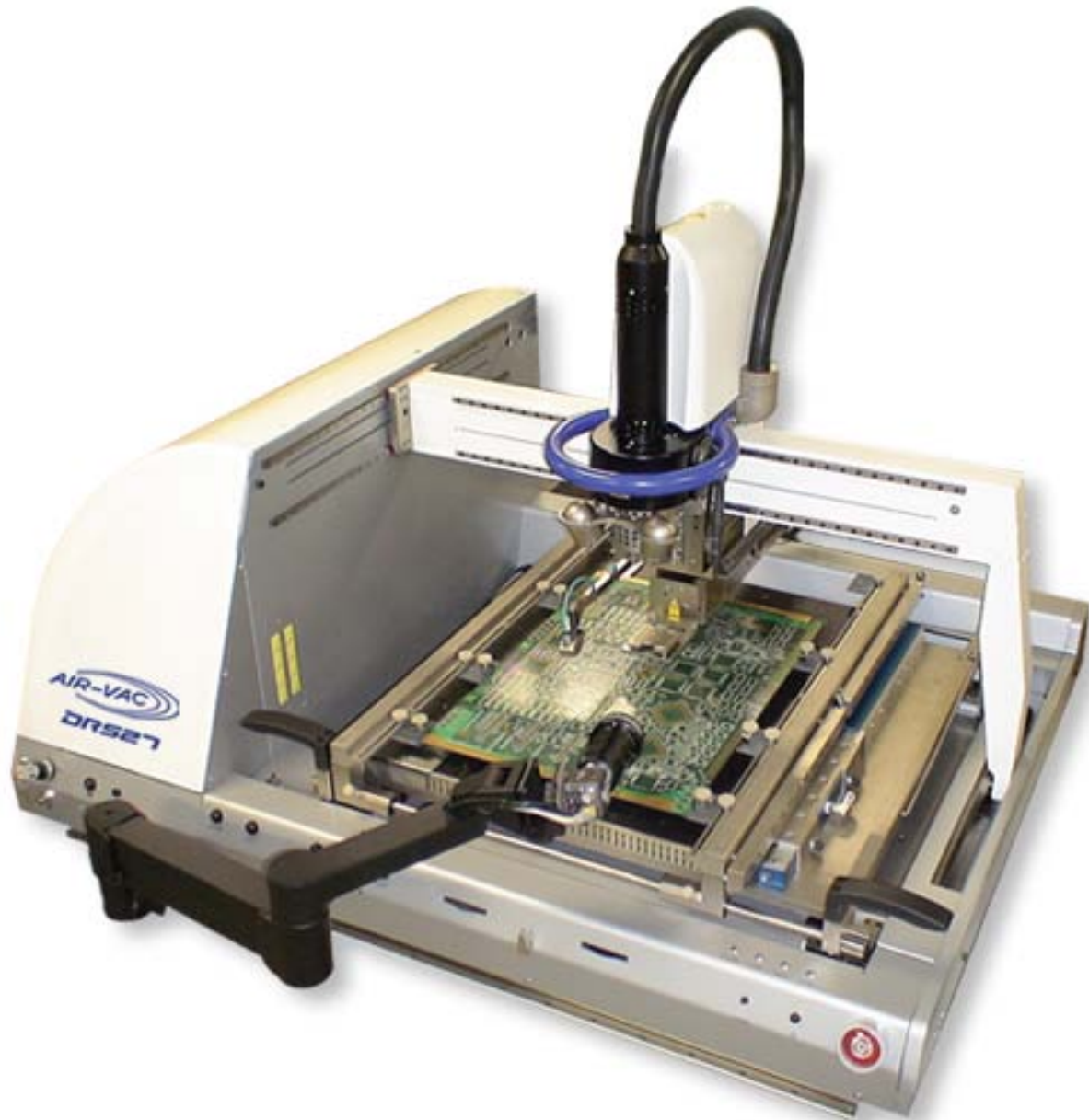


DRS27



Users Manual #0027.00.902

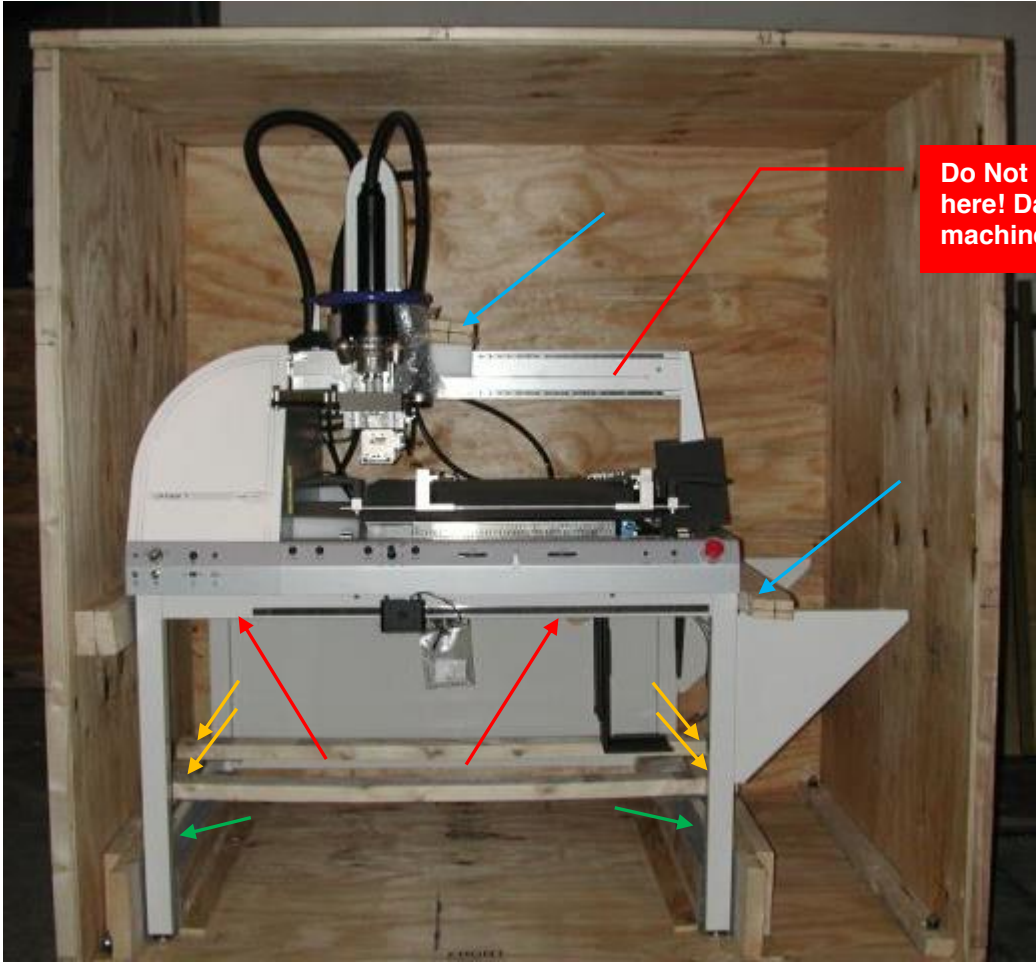


203.888.9900 | www.air-vac-eng.com



Removing Drs 27 from crate

Product Line: Drs 27	Date: 9-10-20
Category: Shipping Crate	Distribution: WEB ☐ Work Instruction ☒



Do Not lift machine here! Damage to the machine will occur

1. Remove the front panel bolts and screws and the top panel bolts and remove panels of the crate.
2. Remove all boxes from the crate.
- 3. Remove the shipping boards holding the bridge and side wings.
- 4. Remove the four bolts from the bottom two hold down boards.
- 5. Place two 2 x 4's onto the two forks of the fork lift to lift the machine out of the crate. Be aware of the power cord and the CPU holder when locating the forks under the machine.
- 6. Lift the machine above the supports as shown before pulling machine from crate.

TABLE OF CONTENTS

0027.00.902

R09.00

Chapter 1: Introduction & Overview

Chapter 2: Unpacking, Installations & Facility Requirements

Chapter 3: Machine Function Verifications

Chapter 4: Software Overview

Chapter 5: Process Development Guide/Engineering Training

Chapter 6: Templates: Removal, Site Clean Replacement

Chapter 7: Operator Training

Chapter 8: Maintenance

Chapter 9: Schematics

Appendix

1: Introduction/Overview

- 1 Introduction/Overview..... 3**
 - 1.0 GENERAL DESCRIPTION..... 3
 - 1.1 CONTACTS & SUPPORT 3
 - 1.2 WARRANTY - GENERAL 4
 - 1.3 HEATING ELEMENT LIMITED LIFE WARRANTY 4
 - 1.4 SAFETY SYSTEM..... 5
 - 1.4.1 GENERAL SAFETY 5
 - 1.4.2 ADDITIONAL SAFETY PRECAUTIONS..... 6
 - 1.4.3 LABEL DESCRIPTION AND PLACEMENT..... 7
 - 1.4.4 MACHINE WARNING LABELS 7
 - 1.4.5 DRS27 SYSTEM ALARMS 9
 - 1.5 MACHINE OVERVIEW..... 10
 - 1.5.1 FRONT PANEL CONTROLS..... 10
 - 1.5.2 POWER START UP/POWER DOWN CONTROLS 15
 - 1.6 OPTIONS OVERVIEW 16
 - 1.6.1 SITE CLEANING SYSTEM (0029.03.012) 16
 - 1.6.2 PIVOTING IR PROBE WITH LASER POINTER (0029.11.043)..... 16
 - 1.6.3 DIRECT VIEW CAMERA..... 17
 - 1.6.4 UNIVERSAL INSERTION TOOL (AU6LGA47R)..... 17
 - 1.6.5 PASTE-ON-DEVICE MICRO STENCIL ADAPTER (0024.24.111) 18
 - 1.6.6 FLUX DIP PEDESTALS (PART NUMBER QUOTED PER DEVICE)..... 18
 - 1.6.7 FUME EXTRACTION MANIFOLD & HOSE ASSEMBLY (300.00.547) 19

1 Introduction/Overview

1.0 General Description

The DRS27 is a SMT Rework and Repair machine. It is designed to remove and replace surface mounted and through-hole devices on printed circuit boards. This involves heating of the PCB using a radiant panel type preheater located under the PCB and a hot gas heater / delivery system mounted over the component to be reworked to provide heat to the component solder joints. A motorized Z (vertical) axis and vision deployment system aid in reducing operator required activity and providing a level of process control through partial automation.

1.1 Contacts & Support

Air-Vac is always willing to assist our customers with any technical or operating questions. If you have any questions on machine parameters, correct nozzle requirements, options, procedures or maintenance, please do not hesitate to call.

Air-Vac Engineering Company, Inc.

30 Progress Avenue, Seymour, CT 06483

Tel: 203-888-9900 - Fax: 203-888-1145

<http://www.air-vac-eng.com/>

General Sales & Tooling Information: airvac@air-vac-eng.com

Technical Support: airvac@air-vac-eng.com

Download PDF of this manual: <http://www.air-vac-eng.com/support.html>

Web Support Documents: <http://www.air-vac-eng.com/support.html>

1.2 Warranty - General

Air-Vac Engineering Company warrants its equipment for a period of one (1) year from date of shipment on all parts, materials and labor costs required to repair the system except for component parts that are considered "wear and tear" items that are warranted for ninety (90) days. These include, but are not limited to, heaters, belts, lights, vacuum cups and tubing.

Air-Vac agrees to repair or replace any or all such equipment that may prove to be defective within the warranty period, without expense, excluding shipping to the owner. This warranty shall not apply to any products that have been repaired or altered except by Air-Vac Engineering. Services under warranty shall not affect an extension of the warranty period, nor will a new warranty period be granted for the parts, which were replaced/repaired. The title of the replaced parts will automatically pass to Air-Vac.

Air-Vac reserves the right to reject replacement under this warranty where, in the sole opinion of Air-Vac, the defect is due to obvious misuse and/or improper maintenance of the module or any part thereof. The express and/or implied warranty of Air-Vac is limited to the replacement and/or repair of any item defective in material and/or workmanship. Other damages, if any, direct or consequential are expressly excluded from this warranty.

Air-Vac shall be liable under this warranty only if 1) Air-Vac receives notice during the appropriate warranty period (90 days or 1 year as applicable); 2) The products are operated in accordance with the supplied documentation; and 3) Such products are, to Air-Vac's satisfaction, determined to be defective.

When contacting Air-Vac for warranty inquiries, please provide the Order Number that the parts were shipped, Model and Serial Number of the product and the Reason for Warranty. Products cannot be returned to Air-Vac without authorization – please call for an RMA #.

1.3 Heating Element Limited Life Warranty

Air-Vac Engineering Company warrants the heating elements for a period of ninety (90) days from date of shipment. Air-Vac agrees to repair or replace any or all such equipment that may prove to be defective within the warranty period, without expense, excluding shipping to the owner. This warranty shall not apply to any products that have been repaired or altered except by Air-Vac Engineering. Services under warranty shall not affect an extension of the warranty period, nor will a new warranty period be granted for the parts, which were replaced/repaired. The title of the replaced parts will automatically pass to Air-Vac.

Air-Vac reserves the right to reject replacement under this warranty where, in the sole opinion of Air-Vac, the defect is due to obvious misuse and/or improper maintenance of the module or any part thereof.

Heating element life is affected by several factors, temperature, airflow, condition of incoming air (water and oil contamination) and overall process cycle. These products are considered a "consumable" item. The length of useful service will vary based on the conditions under which they are run. Higher temperatures and/or lower flows will cause shortened life.

The express and/or implied warranty of Air-Vac is limited to the replacement and/or repair of any item defective in material and/or workmanship. Other damages, if any, direct or consequential are expressly excluded from this warranty.

Air-Vac shall be liable under this warranty only if 1) Air-Vac receives notice during the warranty period; 2) The products are operated in accordance with the supplied documentation; and 3) Such products are, to Air-Vac's satisfaction, determined to be defective.

When contacting Air-Vac for warranty inquiries, please provide the Order Number that the parts were shipped, Model and Serial Number of the product and the Reason for Warranty. Products cannot be returned to Air-Vac without authorization – please call for an RMA #.

1.4 Safety System

The DRS27 system was designed with safety of the operator in mind. The operation and maintenance of the system must be performed cautiously due to the nature of the hot surfaces and the hazardous chemicals involved in the assembly and rework of printed circuit cards.

DANGER

- **SAFETY HAZARD.** *DO NOT* modify this equipment, or disable or bypass safety interlocks. Such actions may expose personnel to highly hazardous and possibly lethal conditions.

WARNING

- Only skilled and experienced Air-Vac Engineering trained personnel should perform service and maintenance on this equipment.
- If toxic gases/chemicals are used with the equipment, the experienced personnel must also be familiar with the applicable local, state and federal codes on handling such gases or chemicals and be trained accordingly.

NOTE: *When operating the AIR-VAC DRS27 system, follow all local codes for safe operation of the machine. Disposal of materials used in the processing of Printed circuit boards must be done in compliance with each Manufacturers recommendation in accordance with local codes.*

Other safety mechanisms include:

- A latching Emergency Off. This removes power from all machine functions and devices. The PC and monitor will remain powered. To reset, rotate the EMO knob to unlatch. Turn the key switch all the way to the right and release to restart. Restart the DRS27 software.
- Operator safety warning labels and markings are employed.
- Gas nozzle handling tools has been included and should be used when handling hot nozzles.

1.4.1 General Safety

Machines and tools of Air-Vac can only be used with maximum efficiency and safety by well trained personnel. **Do not attempt to operate or maintain this system without proper training from qualified personnel.**

Personnel

- Wear protective gloves when working with hot boards or gas nozzles. Solder can contain tin and lead, which are hazardous materials.
- Use caution if wearing loose clothing while operating this machine as loose clothing can fall into the work area. This is a fire hazard as well as an entanglement hazard in moving axis. Always secure or remove loose clothing before operating this equipment.
- Never eat, drink, or smoke while working on or near the machine.
- Only trained operators and technicians should work on this equipment.
- Hot surfaces will cause severe burns. Use extreme caution when operating this equipment. Heat resistant gloves are recommended particularly when handling hot components of the machine like nozzles, circuit boards and during maintenance if hot surfaces are being handled.
- Report any problem to supervisor.

Equipment

- Flux vapors result from soldering or desoldering. Fresh air must be provided. A venting system or fume extraction system is recommended.
- Keep all covers on. Do not open machine covers unless you are at the Main Menu Screen for basic maintenance, or to verify machine voltage (authorized personnel only).
- Keep hands clear of moving parts. Do not reach into the machine while it is moving.
- Do not override safety interlocks.
- Check area for any loose parts or tools that could cause mechanical interference.
- Do not place anything on the top of the machine.
- In the event of an emergency, press the Red Emergency Off button located on the front of the machine. Locate this Emergency Off button before operating this machine.
- Shut off electrical power and unplug machine when servicing any area of the machine.
- If a malfunction should arise, depress the Emergency Off button to stop operation.
- Wear protective gloves when working with hot boards or gas nozzles.
- Refer to material safety data sheet of solder, flux, or any other product used in conjunction with the machine. Follow all warning labels and instructions.
- Follow proper handling and disposal instructions for the materials as supplied by their vendors.

Machine Operation

- Both the top and bottom heating elements can be programmed to reach high temperatures. Use caution near heated surfaces including the nozzle and the bottom heater.
- Hot surfaces are noted with labels but exposure to hazards is inevitable due to the nature of the process. Do not touch hot surfaces. Proper training is essential. Contact Air-Vac for additional training sessions if required.
- Always use the gas nozzle handling tool when installing or removing nozzles.
- The nozzle and vision systems are powered by motors and are programmed to move during operation. Use caution near these two moving areas.
- Observe the legal and specific national regulations concerning accident prevention and protection of the environment.
- Observe the general safety regulations concerning working with solder and flux. Fume extraction should be seriously considered.

Maintenance (see Maintenance Chapter of Manual)

1.4.2 Additional Safety Precautions

- Upper heater housing protects the upper heating element - marked with hot label.
- Bottom heater plate surface can be hot – protective covers are marked with hot label.
- Flux vapors can be hazardous to operators - fume extraction should be employed.
- Flux liquid is flammable and hazardous to operator health and safety.
- Nozzle and vision motion can cause injury to the operator.
- Sound levels are below 70 dba levels except for use of the nozzle cold air bypass at 100% flow (75 dba) and the optional bottom spot heater at high flow (78 dba). These are intermittent items that can be a small percentage of actual on time. If these are used they should be evaluated against local regulation to determine if any additional noise protection is required.

Handling of Hazardous Solder and Flux Products

AIR-VAC does not supply the solder or flux products with the DRS27 system. The end user of the DRS27 system should follow proper handling and disposal instructions for the materials as supplied by their vendors.

Nozzle Changeover: Safety Equipment Requirements

When changing out the part-specific gas nozzle, use the special nozzle removal tools (GNT1, GNT4) that are supplied in the tool kit of the system whenever handling a hot nozzle.

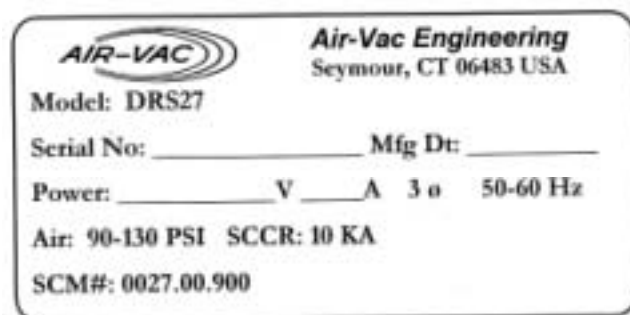
Removing a nozzle:

- Hold the hot nozzle with the nozzle removal tool and pull out of nozzle locking jaws.
- With the hot nozzle held firmly in the removal tool, place the nozzle in a container that can handle the heat of the nozzle.

To install a nozzle, reverse the above procedure.

1.4.3 Label Description and Placement

The following metal placards are affixed to the DRS27 system: This label describes the electrical and air requirements for the system. The overall system requirements can be found in the facilities section of this manual.



1.4.4 Machine warning labels

Label	Indication
CAUTION – HOT SURFACE	The Caution - Hot Surface labels found on the DRS27 system are intended to prevent injury to the operators and users of the system. The top heater and preheater of the system are required to reach temperatures well above 60°C. Labels are found on the covers of each heated surface as well as next to heated surfaces. Skin contact with these surfaces would result in a burn reaction and therefore presents an inherent potential thermal danger to the operators.

	This label indicates hot surfaces well above 60 °C. The hot gas head and the pre-heater are required to reach temperatures well above 60 °C. Hot surface warning labels are found on the covers of each such heated surface as well as next to heated surfaces. Skin contact with these surfaces would result in a burn reaction and therefore presents an inherent potential thermal danger to the operators.
	This label indicates the presence of a Laser diode module with a Class 2 Laser. Do not stare into the beam. Direct viewing into the beam or reflected beam can cause permanent eye damage. (Po = 1 mW, λ = 650 nm)
	This label indicates the presence of an area that presents a pinch point hazard when motion occurs. Keep hands and all objects clear of this area.
	This label indicates there are static sensitive components inside. Appropriate handling should be used.
CAUTION HIGH VOLTAGE DISCONNECT POWER BEFORE OPENING	High power warning labels advise personnel of potential shock issues when the machine covers are opened.

1.4.5 DRS27 System Alarms

The following alarms to the DRS27 system will halt the process until the problem has been corrected and the alarm is cleared:

This alarm type occurs when one of the following conditions is detected:

Machine Hardware Alarms

- * SerialPort_Failure
- Z_Axis_Motor_Comm_Restart
- Vision_Axis_Motor_Comm_Restart
- Nozzle_TempControl_Comm_Restart
- Left_Preheat_TempControl_Comm_Restart
- Right_Preheat_TempControl_Comm_Restart
- Center_Preheat_TempControl_Comm_Restart
- DeviceIO_Communication_Restart
- Low_Pressure_Air_Regulator
- Low_Pressure_N2_Regulator

Process Alarms

- Nozzle_Temperature_Limit,
- Nozzle_TC_Error,
- Left_Preheater_Temperature_Limit,
- Left_Preheater_TC_Error,
- Right_Preheater_Temperature_Limit,
- Right_Preheater_TC_Error,
- Center_Preheater_Temperature_Limit,
- Center_Preheater_TC_Error,
- Below_Minimum_Nozzle_Flow_Rate,
- Nozzle_Flow_Sensor_In_Position_Failed,
- Exceeded_Max_FootSwitch_Delay,
- Exceeded_Max_TC_Control_Delay,
- TC1_Not_Connected,
- TC2_Not_Connected,
- TC3_Not_Connected,
- TC4_Not_Connected,
- TC5_Not_Connected,
- TC6_Not_Connected,
- TC7_Not_Connected,
- TC8_Not_Connected,
- Site_Clean_Tool_Clogged

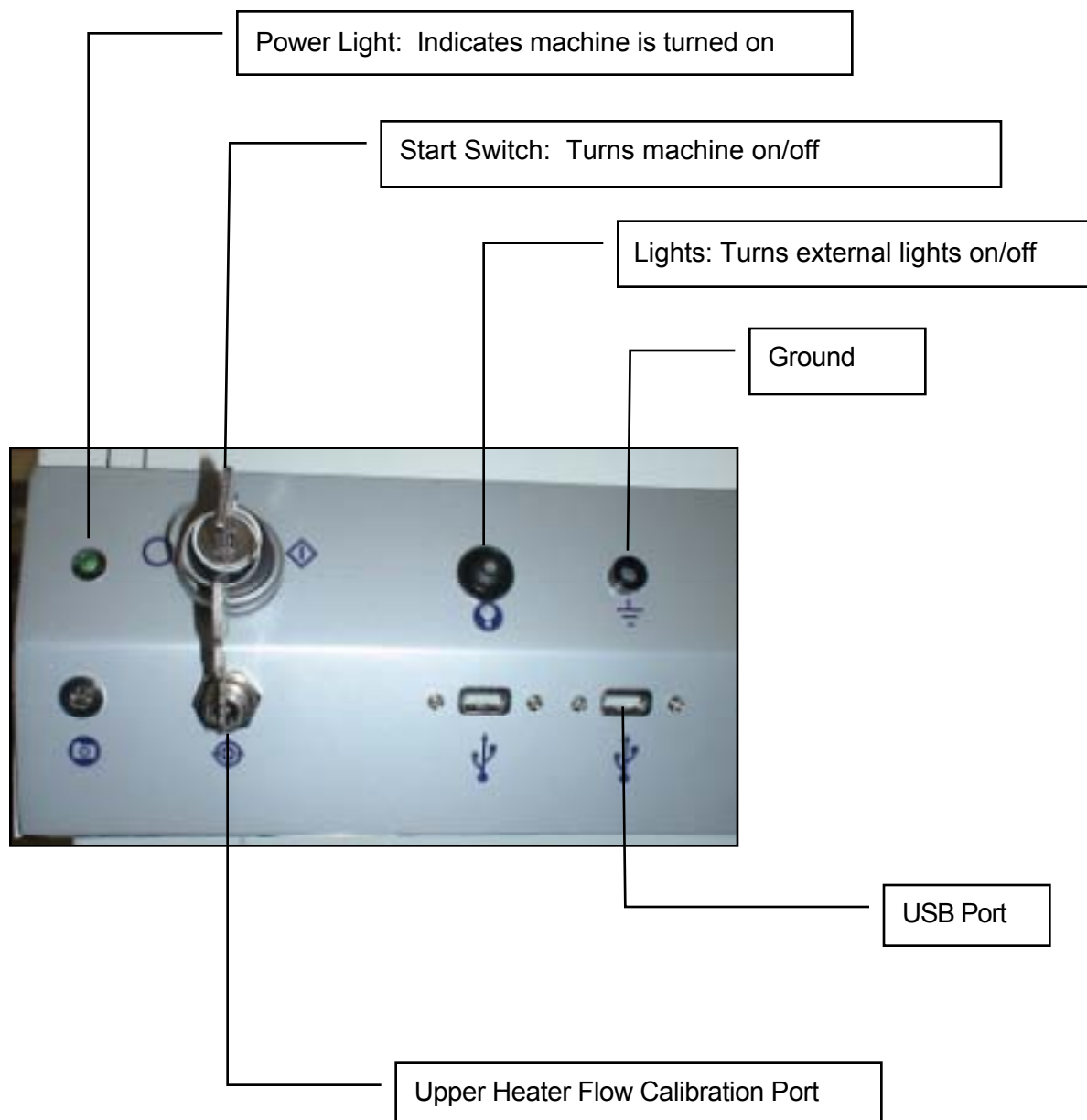
* Computer must be rebooted to clear.

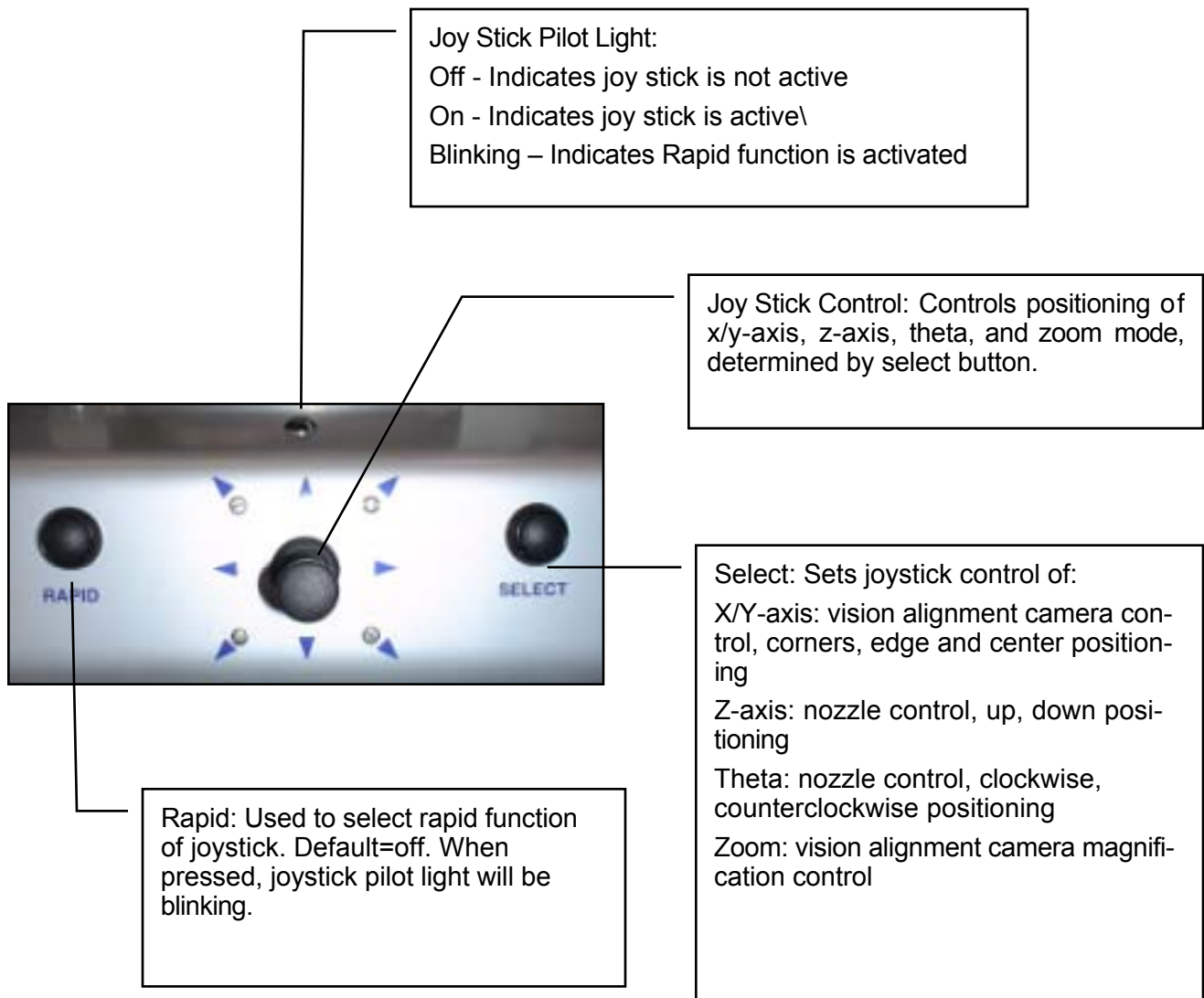
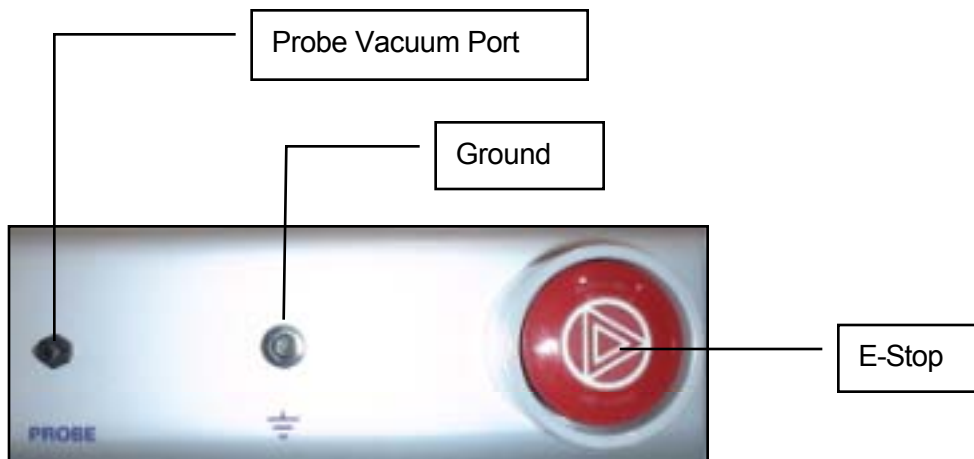
The various alarms are explained in further detail in the Software section.

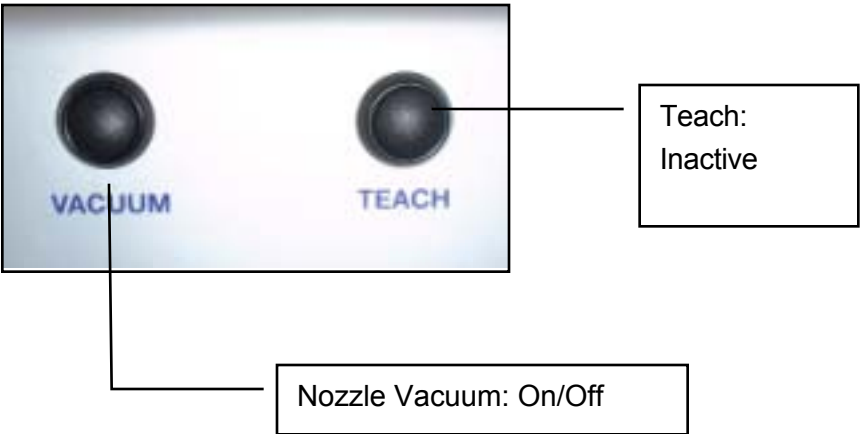
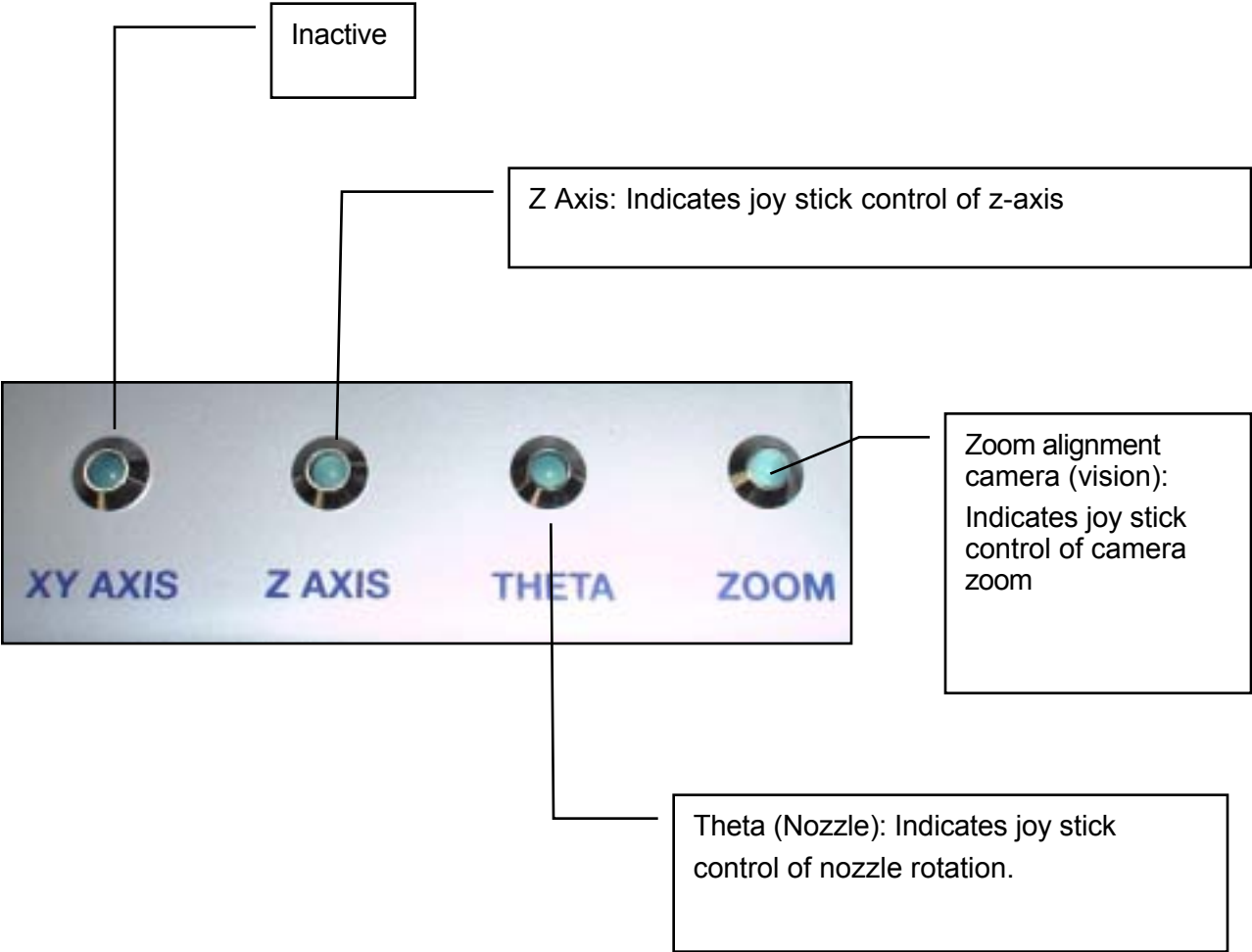
1.5 Machine Overview

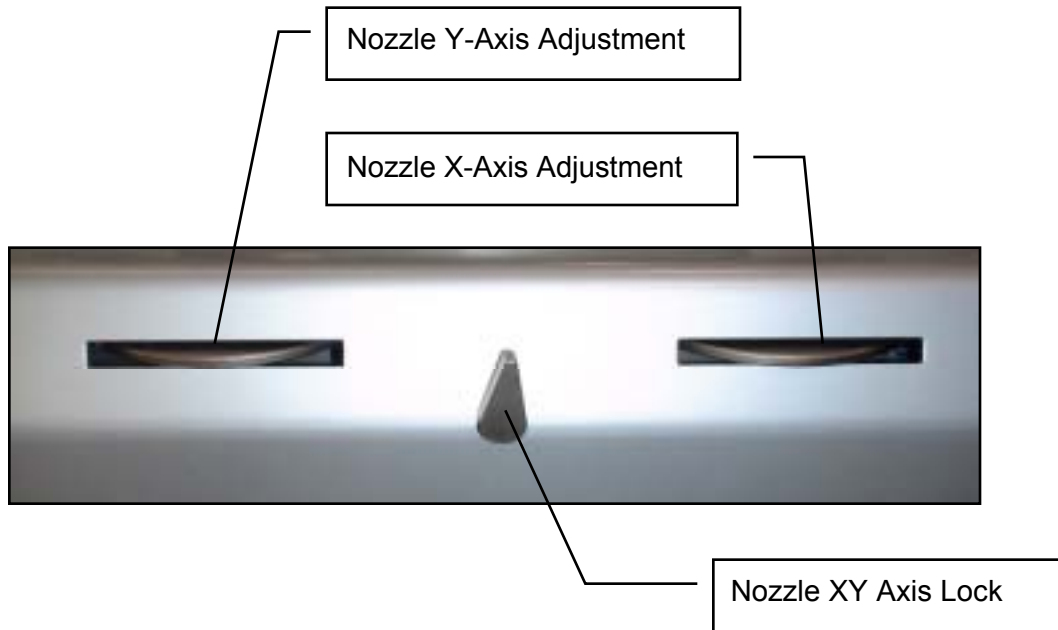
1.5.1 Front Panel Controls



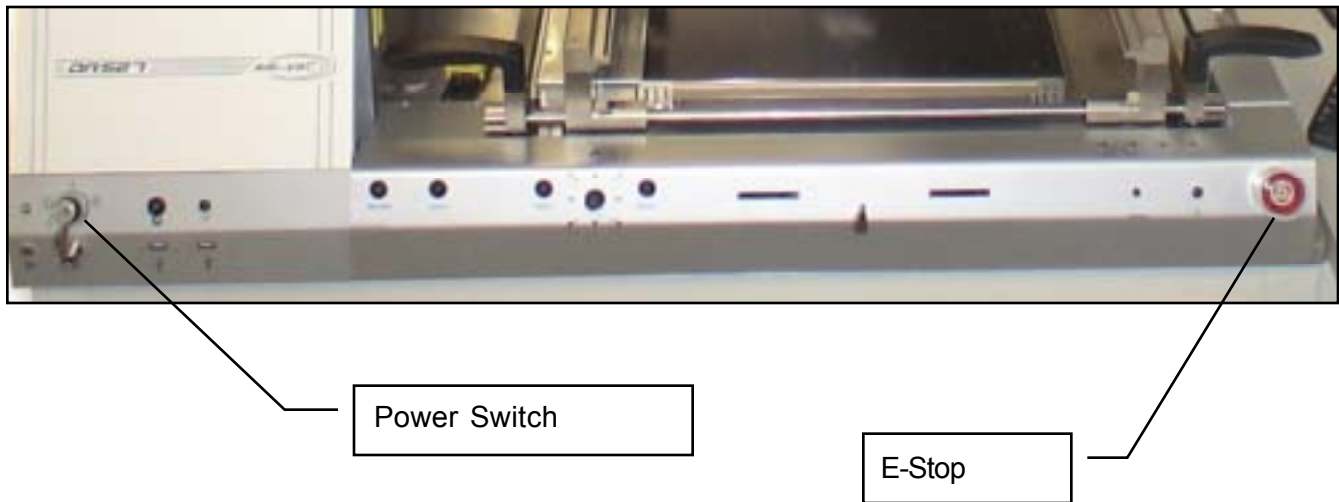








1.5.2 Power Start Up/Power Down Controls



Power Start Up

1. Turn on PC .
2. Release E-stop
3. Turn Power key on/off switch.
4. Boot software.
5. Enter operator name. Click on the Thumbs Up icon.
6. Enter password.

Power Down

1. Exit DRS27 software.
2. Turn off computer.
3. Turn power key off.

1.6 Options Overview

1.6.1 Site Cleaning System (0029.03.012)

Objective

- Fully automated removal of residual site solder without damaging the pads or solder mask. Eliminates the need for traditional solder iron/solder wick process and associated issues (ie. manual intervention, mechanical contact of pads).

How It Works:

- Hot gas reflows the residual solder on the pads.
- While viewing through the microscope, the operator moves the board with the x/y adjustment wheels to clean the pads on the site.
- A vacuum sensor continuously adjusts the height of the composite vacuum tip to provide non-contact site cleaning.

Notes Of Interest:

- Non-contact site cleaning will become critical for lead-free rework due to the significantly higher temperature required to reflow the residual site solder.
- Small, medium and large composite vacuum tips provided.
- Custom designs available for hard to access areas.



1.6.2 Pivoting IR Probe with Laser Pointer (0029.11.043)

Objective

- Provides process repeatability by insuring that the board is at the exact same target temperatures each time before localized reflow begins.

How It Works:

- Operator is instructed to position the sensor head at the beginning of the process.
- The non-contact temperature sensor monitors topside board temperature and automatically triggers the localized reflow process once the target temperature is reached.



1.6.3 Direct View Camera

Objective

- Provide operator viewing on computer screen for component alignment or reflow at board level.

How it works:

- Video is activated by operator or software. Focus/zoom/lighting adjustments are made to optimize clarity.
- The site image is integrated with the software and displayed on the PC monitor.



1.6.4 Universal Insertion Tool (AU6LGA47R)

- Mechanically self-centers any device for accurate pick up.
- Used in conjunction with component shuttle.



1.6.5 Paste-On-Device Micro Stencil Adapter (0024.24.111)

- Component-specific micro stencil applies solder paste directly to the component spheres.
- Pasted device in stencil is placed in micro stencil adapter, which is used in conjunction with the component shuttle to pick the pasted device.

Notes Of Interest:

- Air-Vac does not supply the component-specific micro stencils. Recommended supplier is Mini Micro Stencil (760-591-3804).
- Micro stencil installed into adapter for direct pick from shuttle.

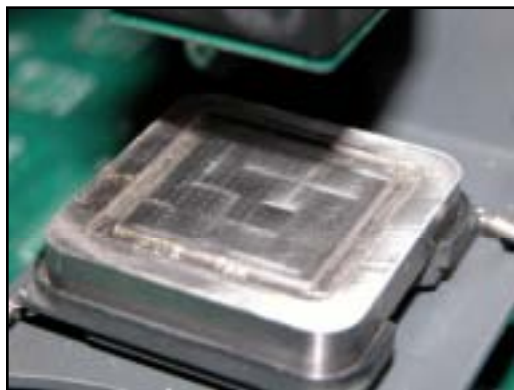


1.6.6 Flux Dip Pedestals (part number quoted per device)

- Stainless steel fluxing pedestals with precision-machined depth provides controlled application of tacky flux directly to the solder spheres on the device.
- Used in conjunction with the component shuttle.

Notes Of Interest:

- Various sizes and depths available.
Recommended depth is 50% of ball height.



1.6.7 Fume Extraction Manifold & Hose Assembly (300.00.547)

Objective

- Removes flux vapors from the work environment for operator health and safety.

Includes:

- Fume extraction manifold and hose assembly.

Notes Of Interest

- Requires connection to a central exhaust or self-contained filtering system.



2: Unpacking, Installations & Facility Requirements

- 2 Unpacking, Installations & Facility Requirements 3**
- 2.0 UNPACKING FROM CRATE..... 3
- 2.1 INSTALLING THE SIDE TABLE..... 10
- 2.2 INSTALLING THE BOTTOM HEATER 12
- 2.3 INSTALLING THE OPTIONAL BOTTOM SPOT HEATER 16
- 2.4 INSTALLING THE OPTIONAL DIRECT VIEW CAMERA..... 19
- 2.5 INSTALLING THE OPTIONAL IR SENSOR WITH FINE SPOT LASER POINTER 26
- 2.6 INSTALLING THE OPTIONAL PIVOTING IR SENSOR 28
- 2.7 INSTALLING THE OPTIONAL FUME EXTRACTION MANIFOLD..... 29
- 2.8 FACILITY REQUIREMENTS – DRS27 30
- 2.9 PNEUMATIC CONNECTIONS: TOP AND BOTTOM HEATER..... 32
- 2.10 OTHER CONNECTIONS 33
- 2.11 MATERIAL CHECK LIST..... 36

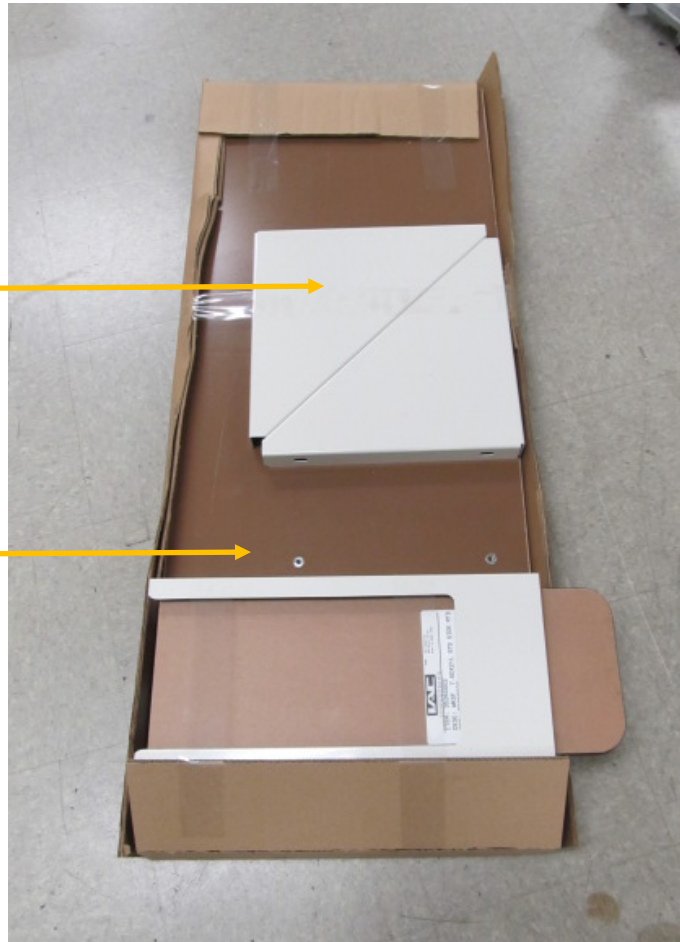
2 Unpacking, Installations & Facility Requirements

2.0 Unpacking from Crate

- Remove all boxes from crate.
- Remove side table and support wings from crate.

Table Support Wings (2)

Side Table with keyboard tray



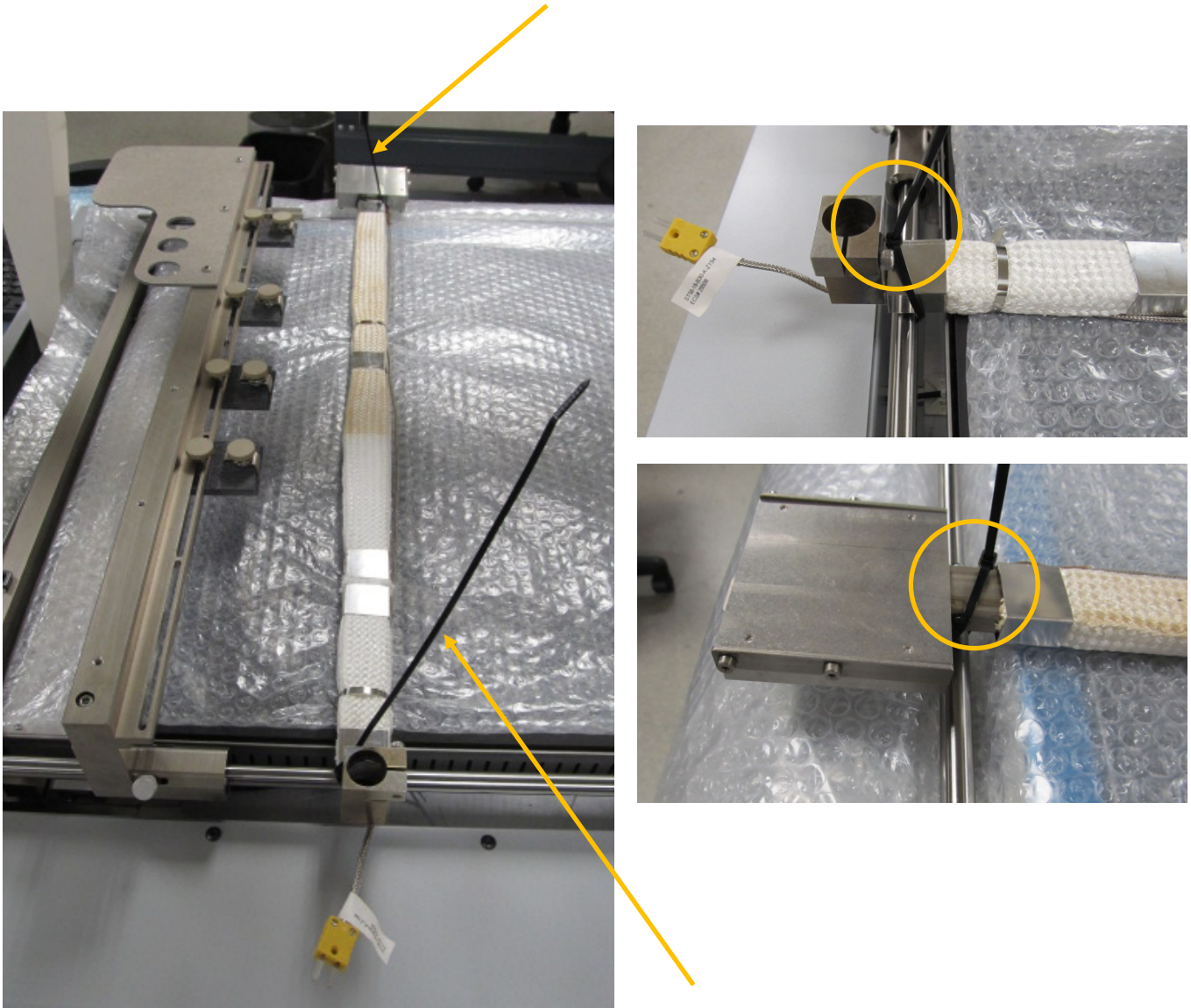
NOTE

FOR 3 ZONE MACHINES THE WINGS ARE MOUNTED ON THE TABLE.

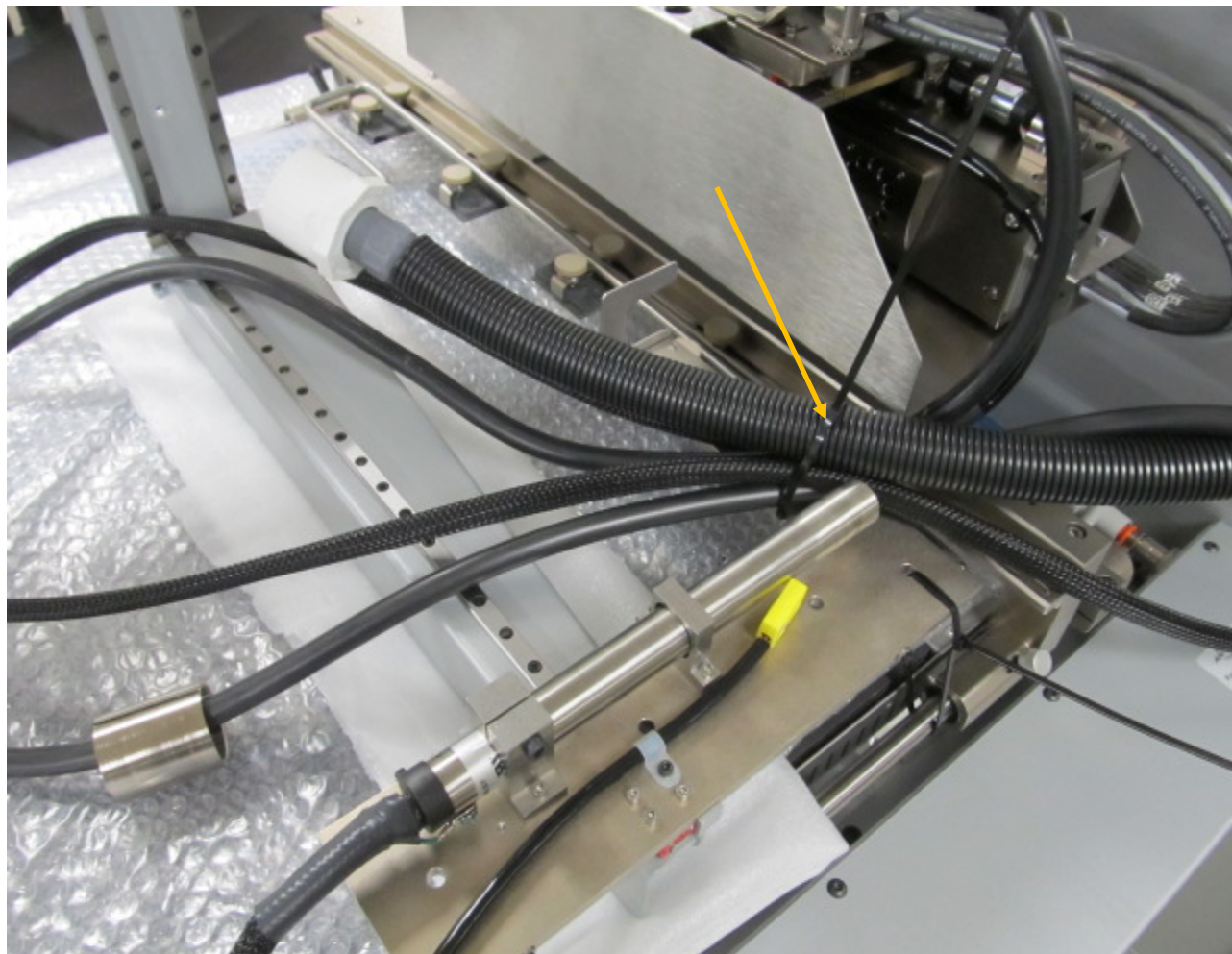
- Remove shrink wrap that's holding the X-Y-Z Axis in place.



- For spot heater equipped machines only, cut off wire ties that are holding the spot heater to the carrier rail rods.



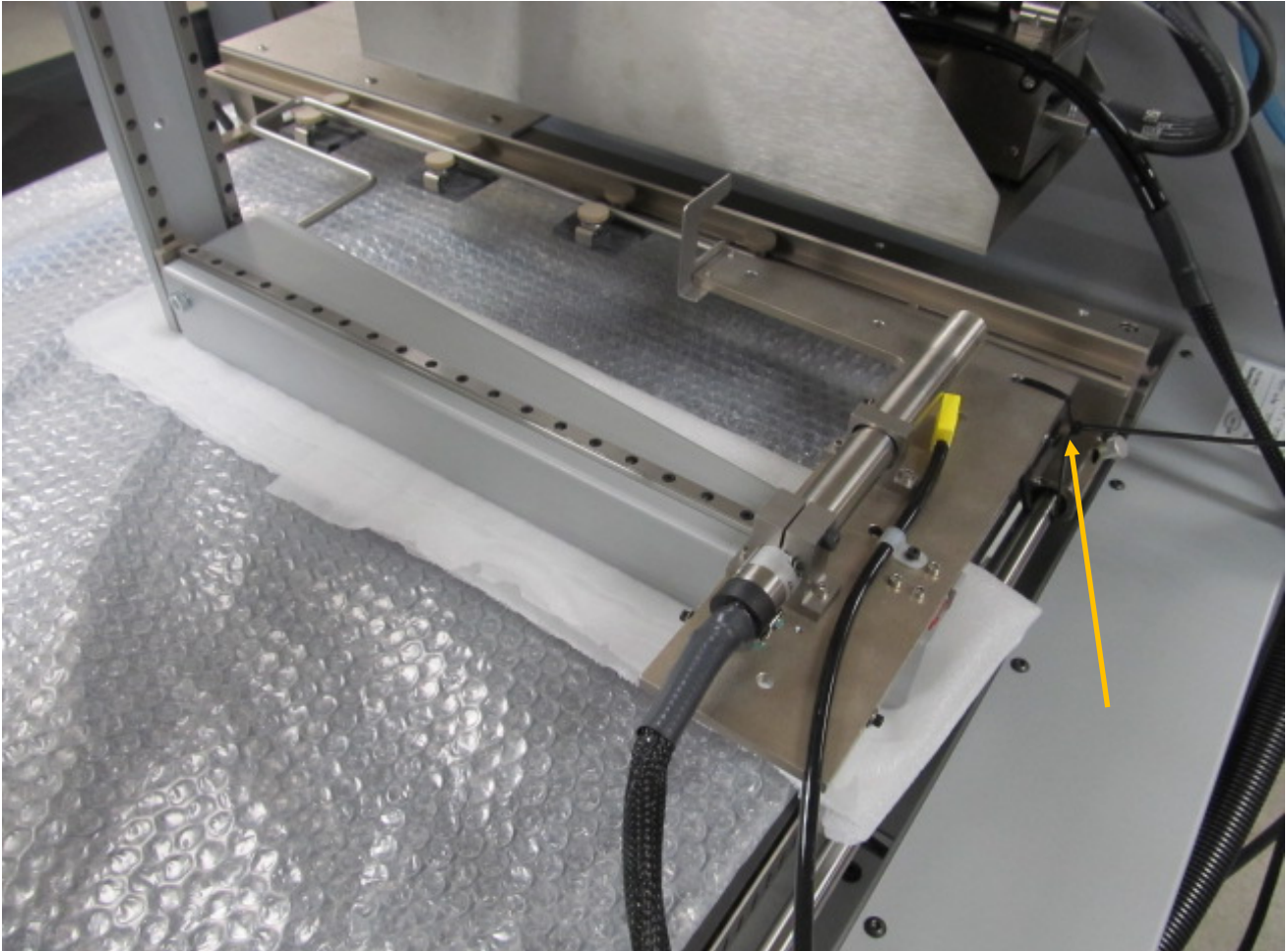
- Cut off wire ties holding the tubing and cables as shown.



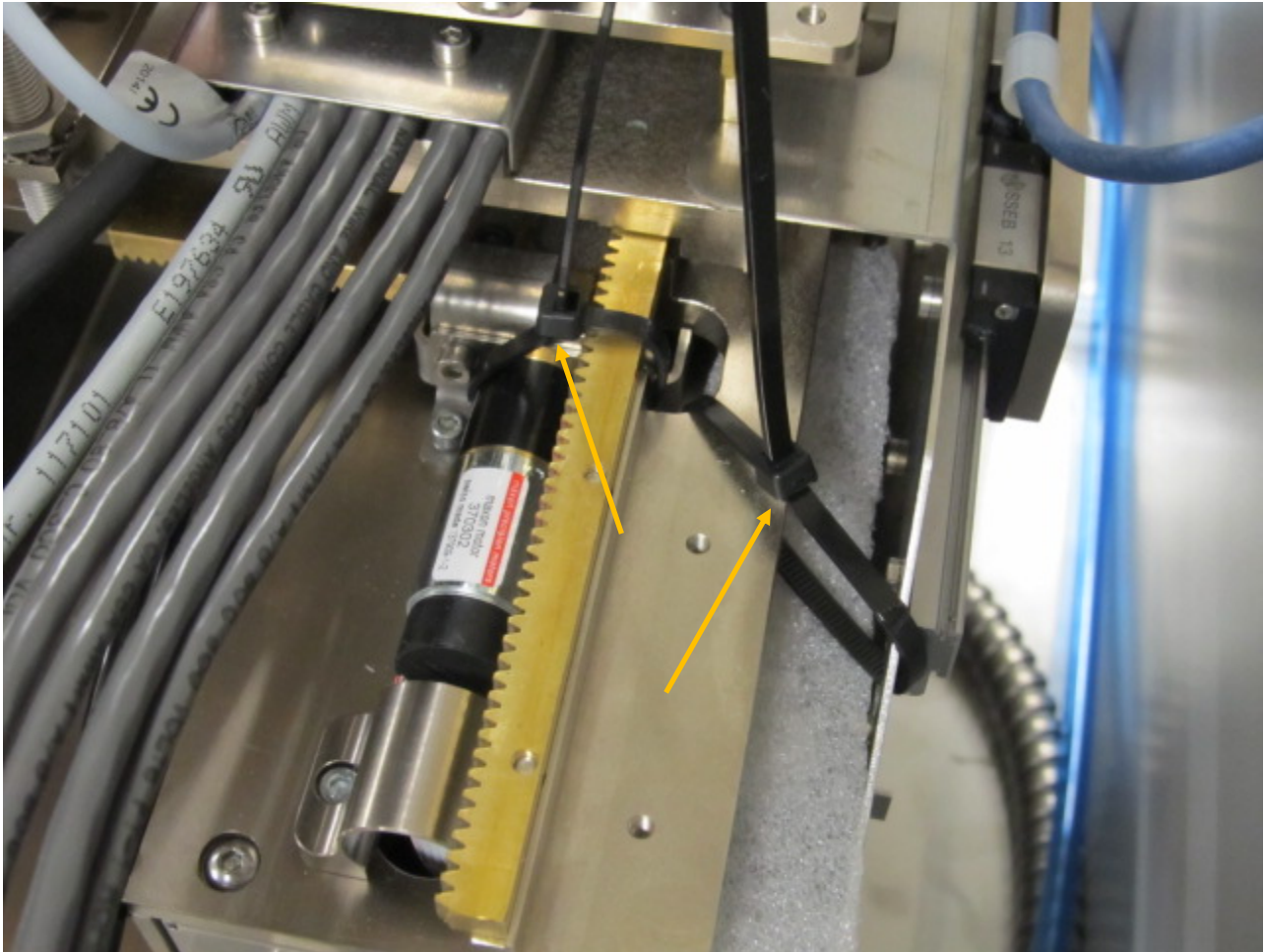
- Cut off wire ties holding the spot heater to the bridge as shown.



- Cut off wire ties holding the spot heater to carrier.

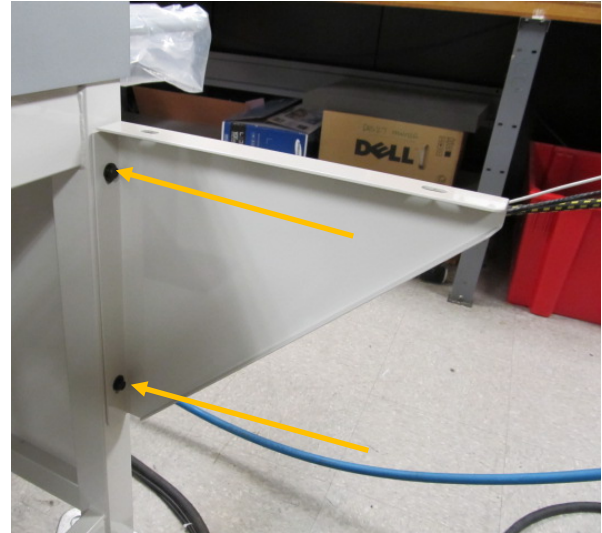


- Cut off wire ties holding the vision X and Y axis as shown.

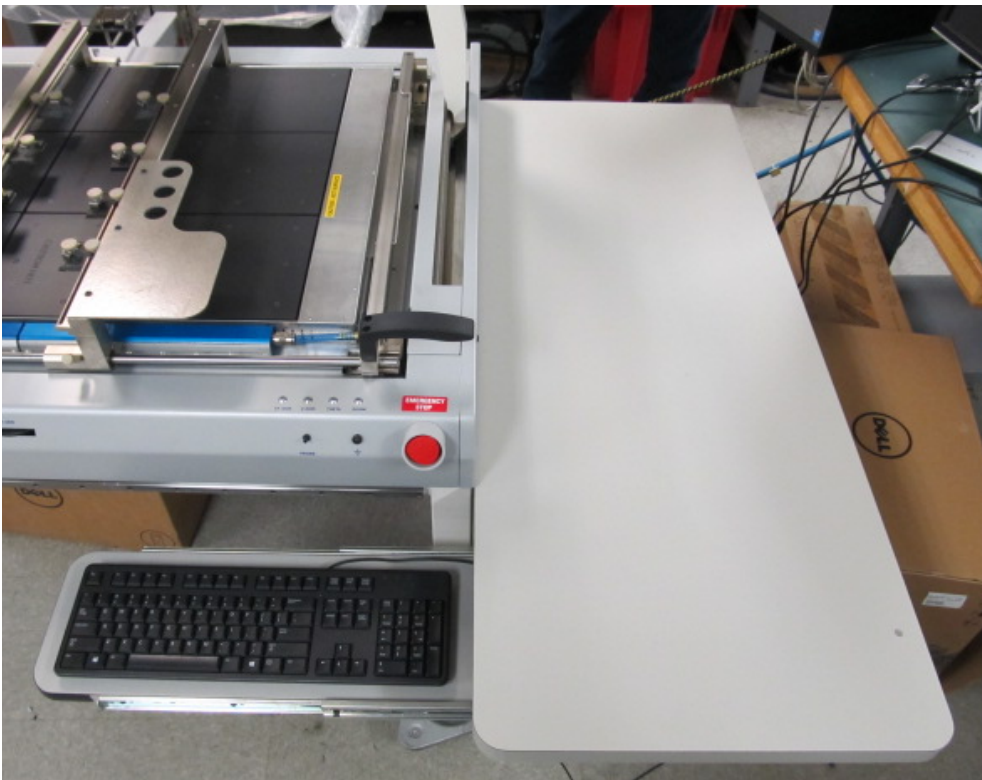


2.1 Installing the Side Table

- Install the front and rear table support wings to the right side of frame (2 bolts each wing).

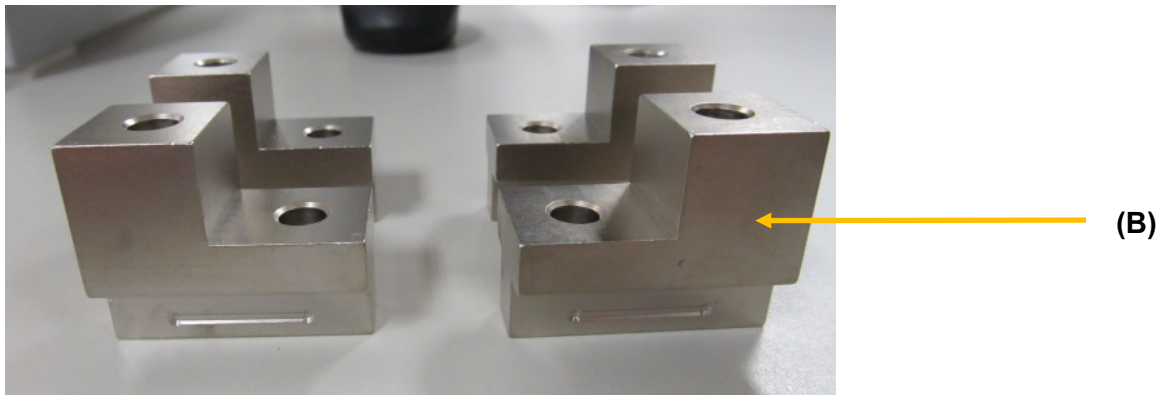


- Attach side table with keyboard tray to the support wings (4 bolts).

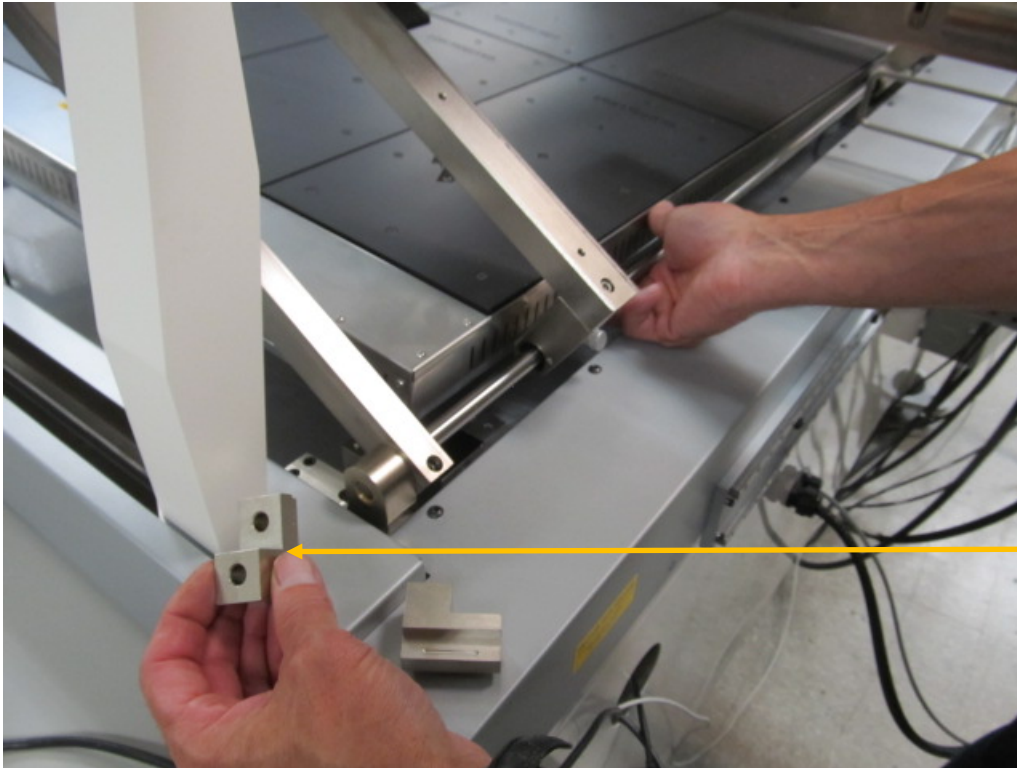
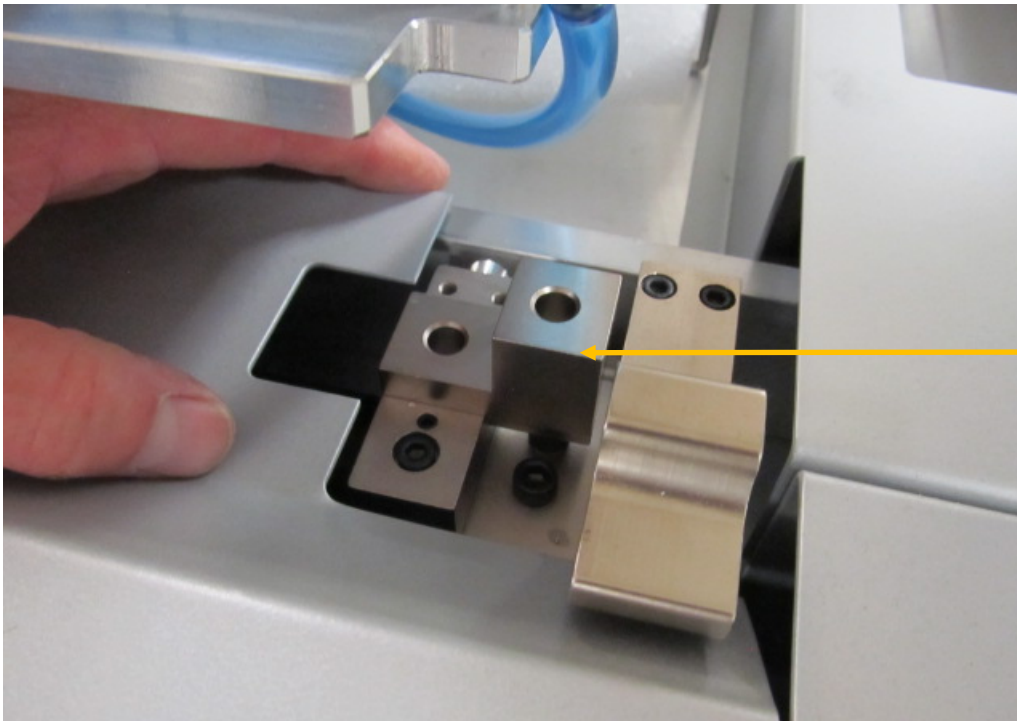


2.2 Installing the Bottom Heater

- Remove all bubble wrap covering the preheater.
- Release brake located on the front panel and push x-y axis to the rear of machine.
- Lift carrier and prop up using kick stand **(A)**.
- Locate preheater support blocks **(B)**.

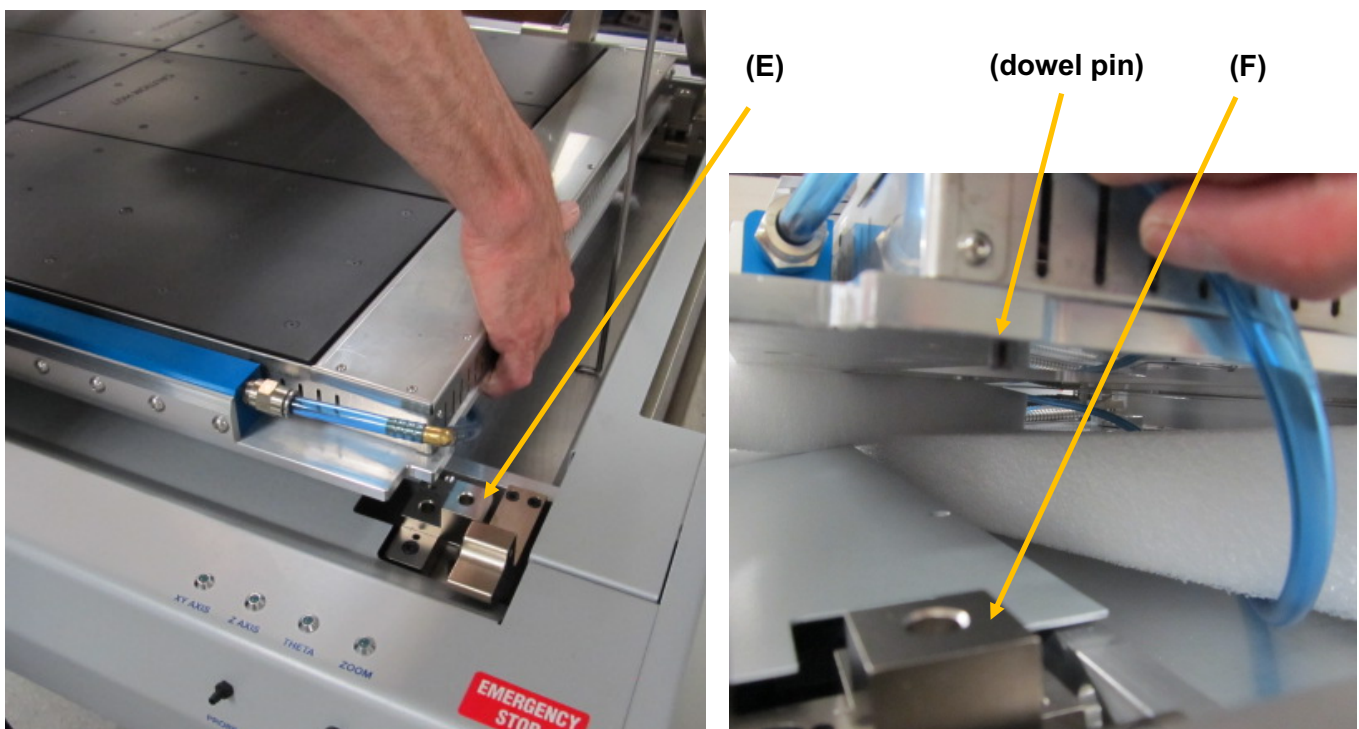
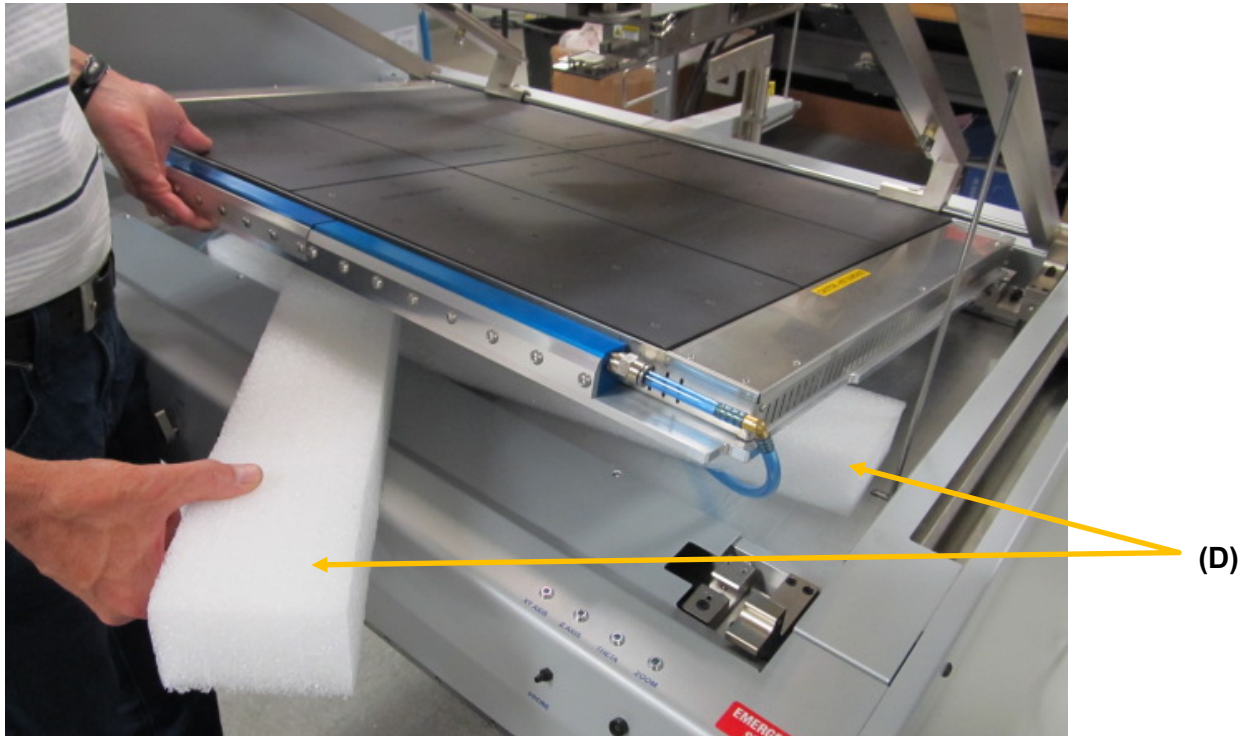


- Add preheater support block to each corner of the preheater (2 front, 2 rear) **(C)**.
- Position the four support blocks as shown in the photos so that the preheater is in its lowest possible position. This is necessary for proper clearance for the spot heater. The 41mm tall board supports are used with the preheater in the lowest position.

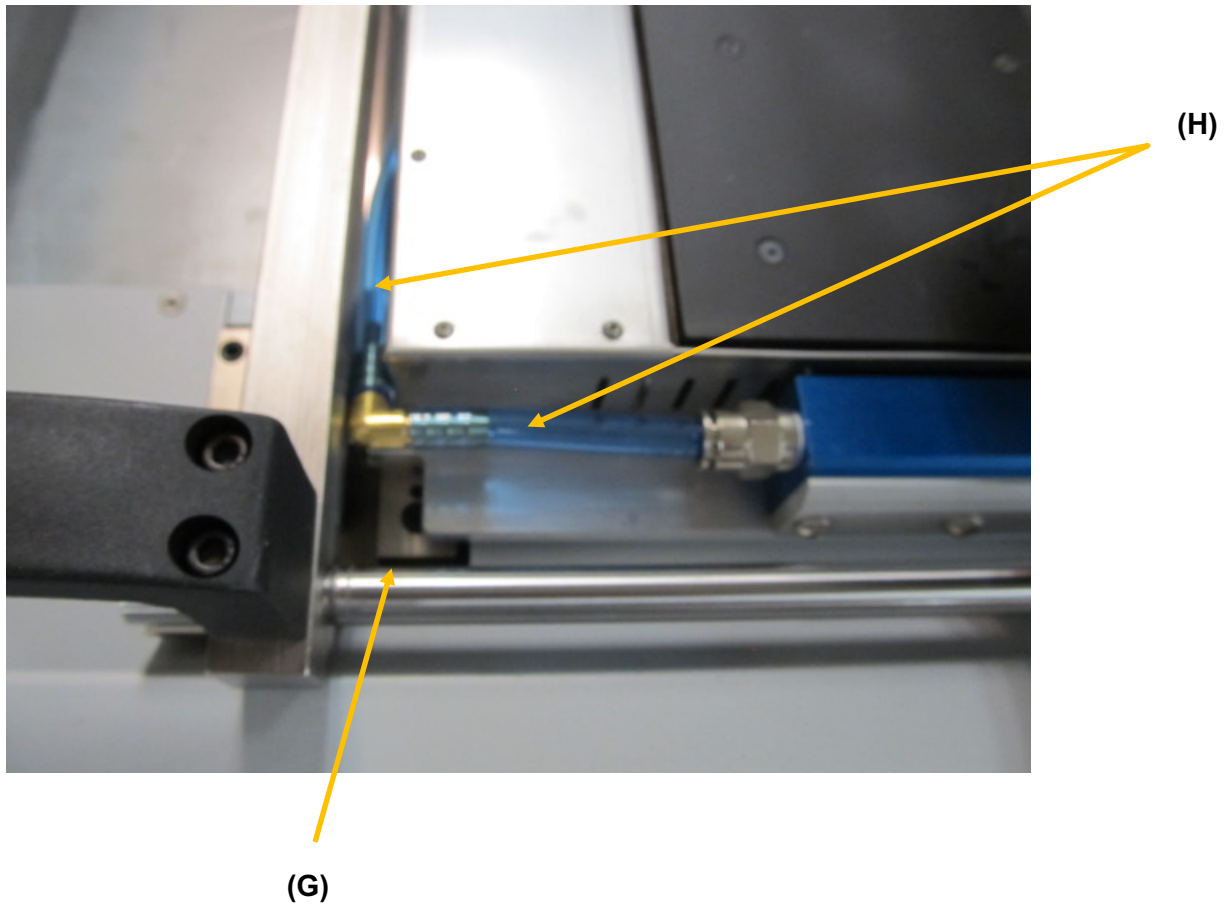
**(C)****(C)**

- Remove packing foam under preheater (it is recommended to have two people perform this). Lift front of heater and remove the two pieces of foam (D).
- Locate preheater onto the support blocks (E).

NOTE: The front right support (F) will locate with the dowel pin on the preheater.

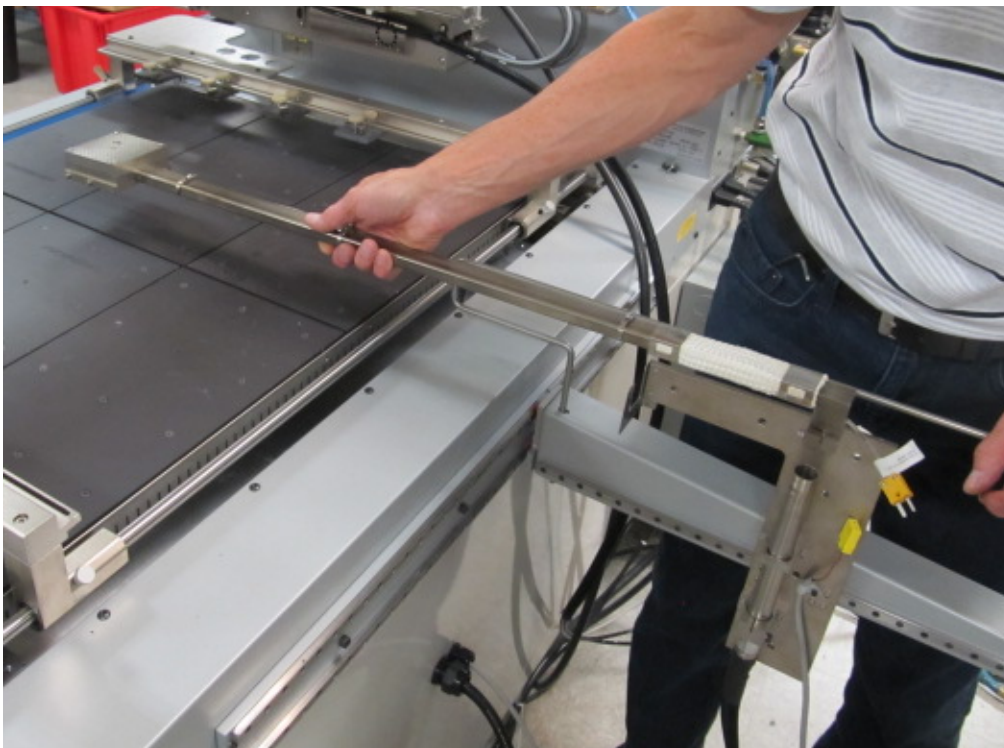
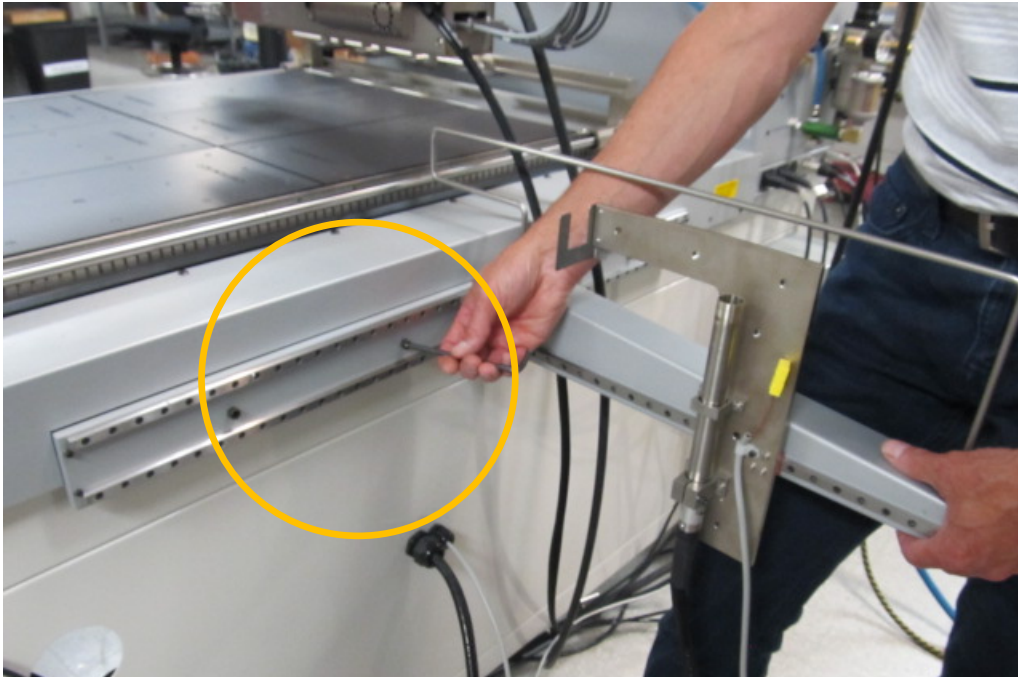


- Verify that the preheater is located on the other three support blocks in each of the 4 corners **(G)**.
- Situate the blue tube as shown **(H)** on the right and left side of preheater.

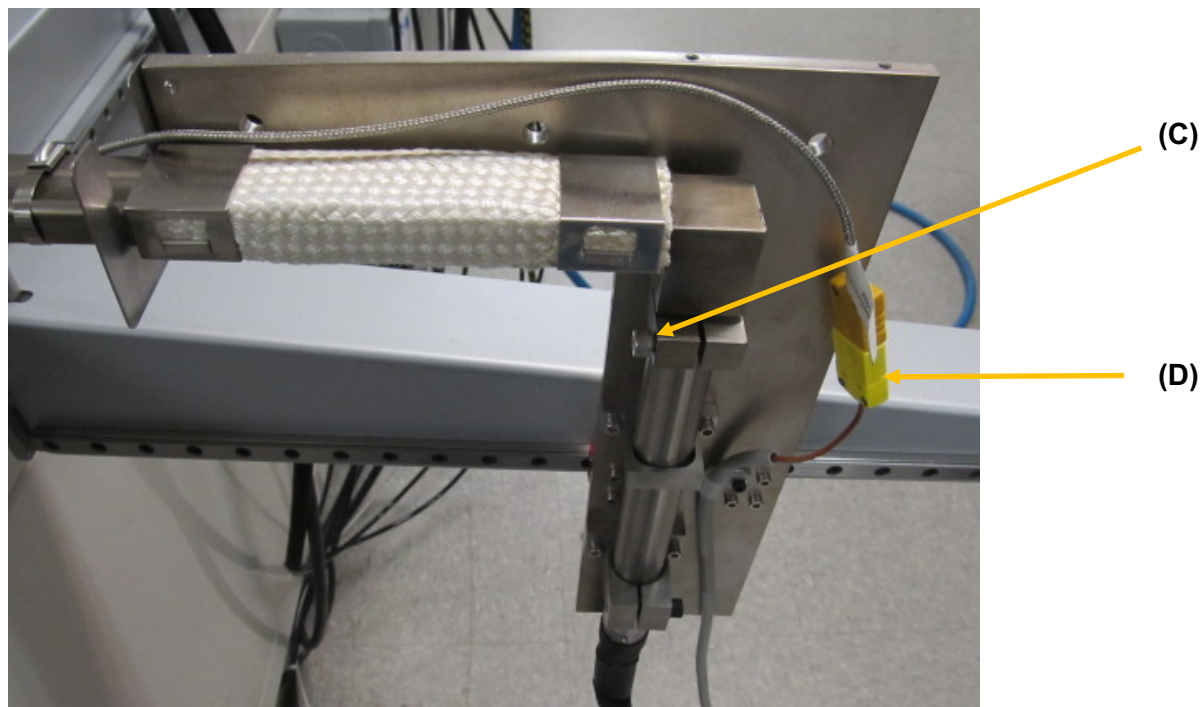
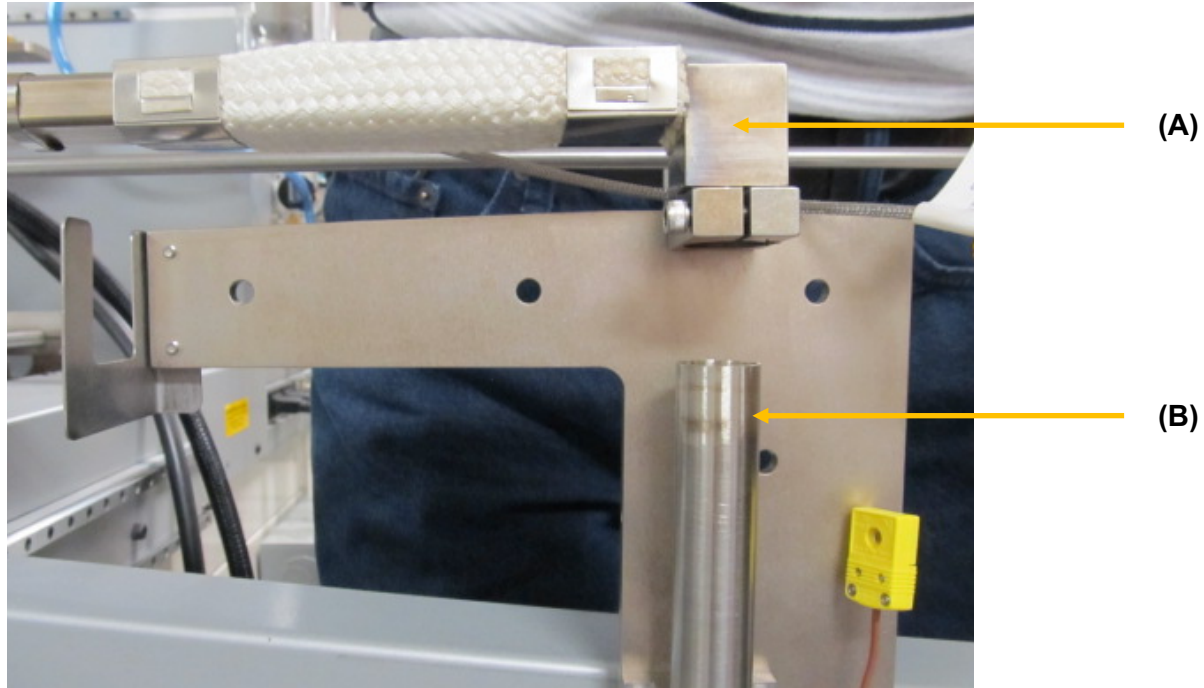


2.3 Installing the Optional Bottom Spot Heater

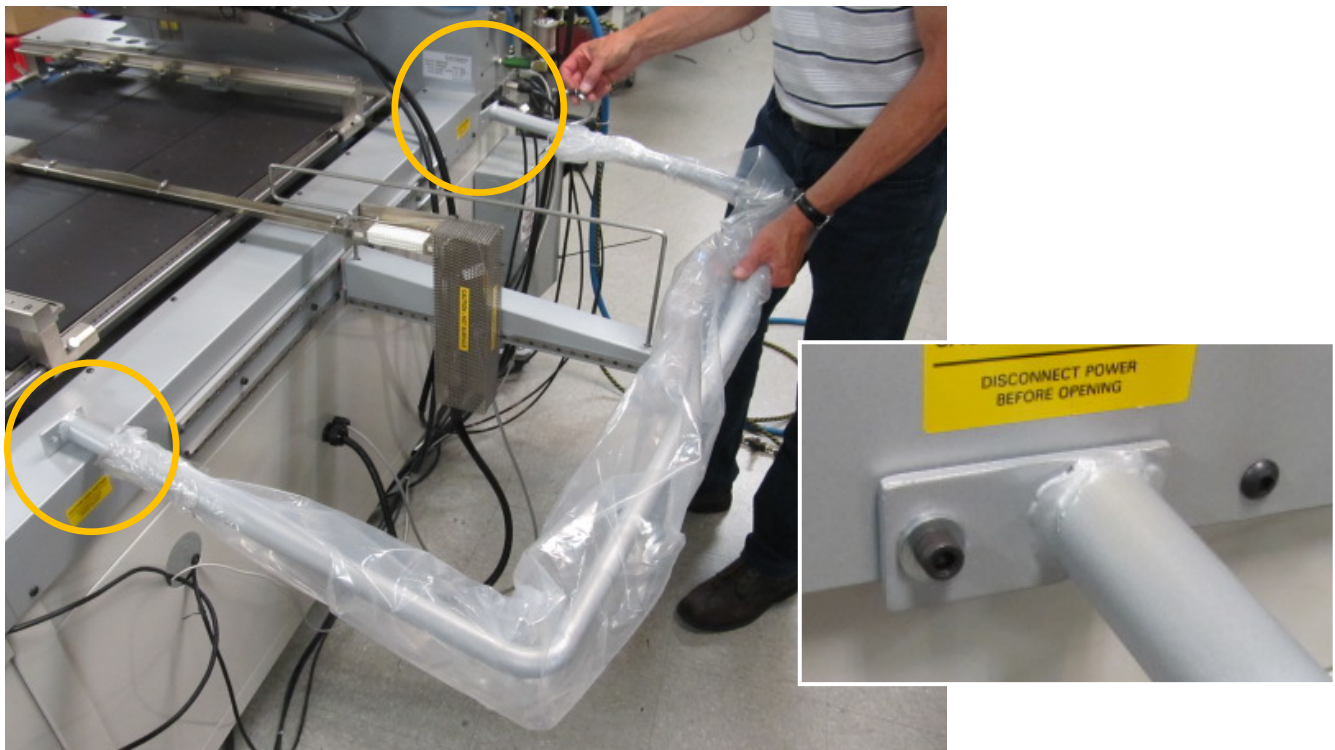
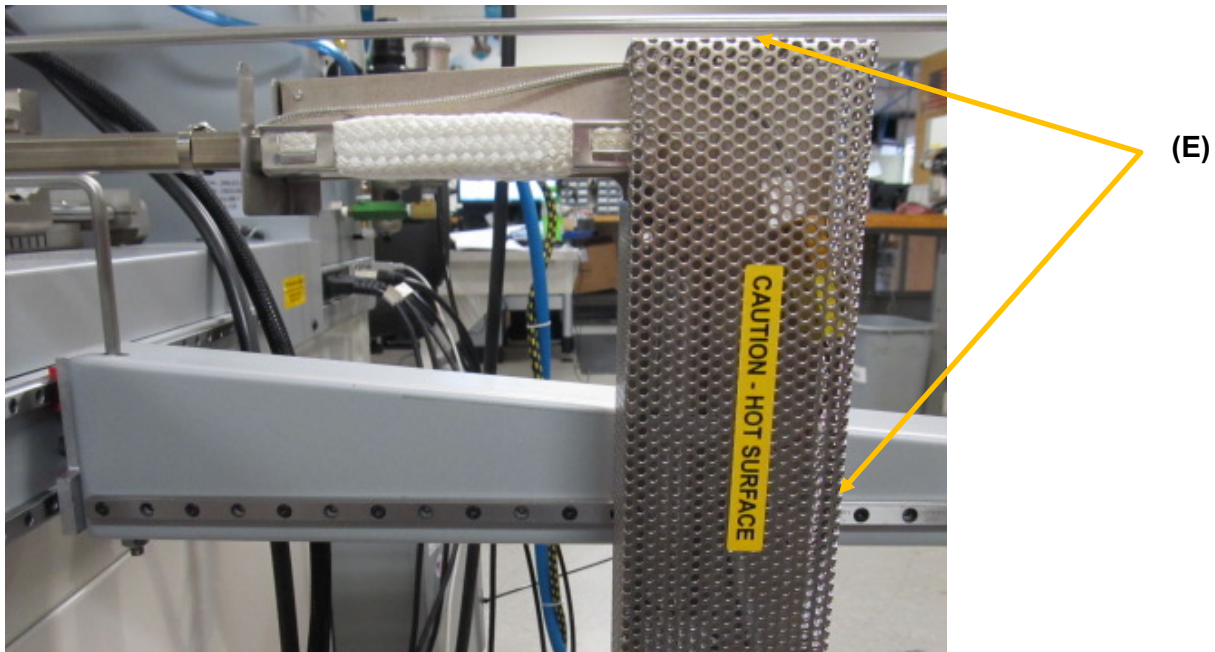
- Locate the spot heater and attach to the machine with four screws as shown.



- Attach spot heater arm (A) to the heating element (B). **NOTE: Preheater must be in place before arm can be added.**
- Tighten screw (C) to lock the arm to the heater.
- Connect thermocouple connectors (D).



- Install heat shield over heating element with 4-40 screws (supplied) **(E)**.
- Attach protection bar to machine with two 1/4-20 screws (supplied) as shown **(bottom photo)**.



2.4 Installing the Optional Direct View Camera

Trolley mounting bracket and cables (front of machine) as shown.



Locate camera arm pivot bracket **(A)** and mount with two screws supplied as shown.

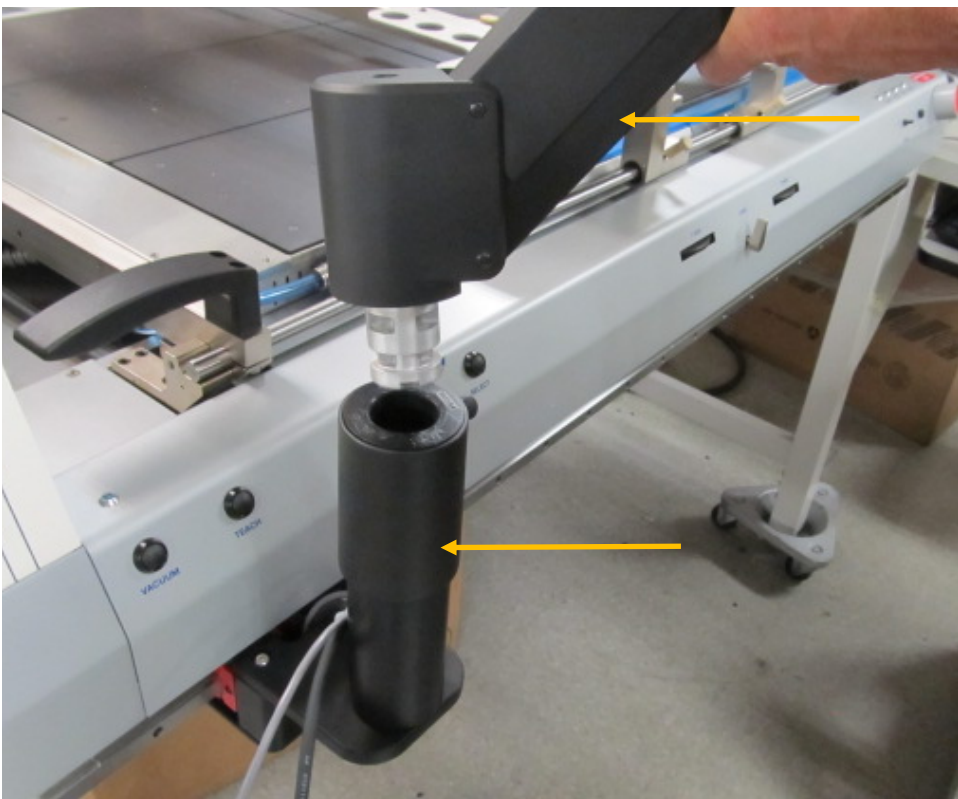


(A)

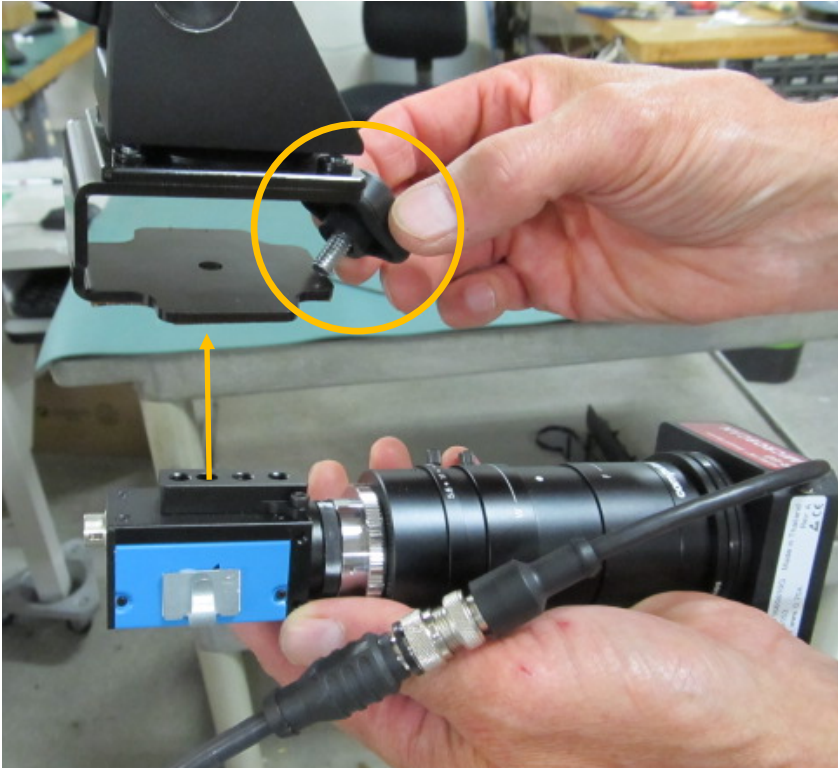
- Use wire clip to hold camera cables as shown.



- Insert camera arm into pivot bracket.



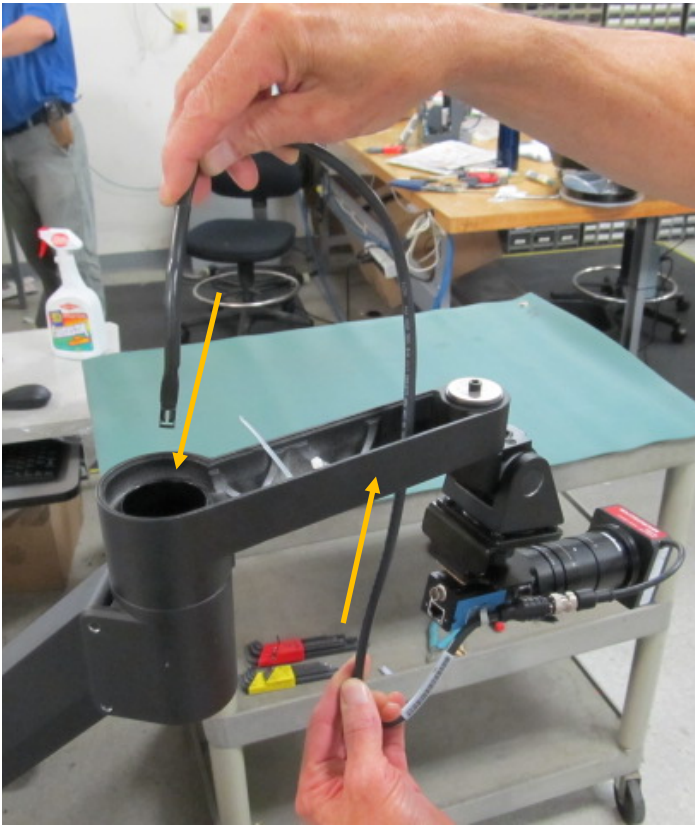
- Locate camera assembly and attach to camera arm with thumb knob as shown.



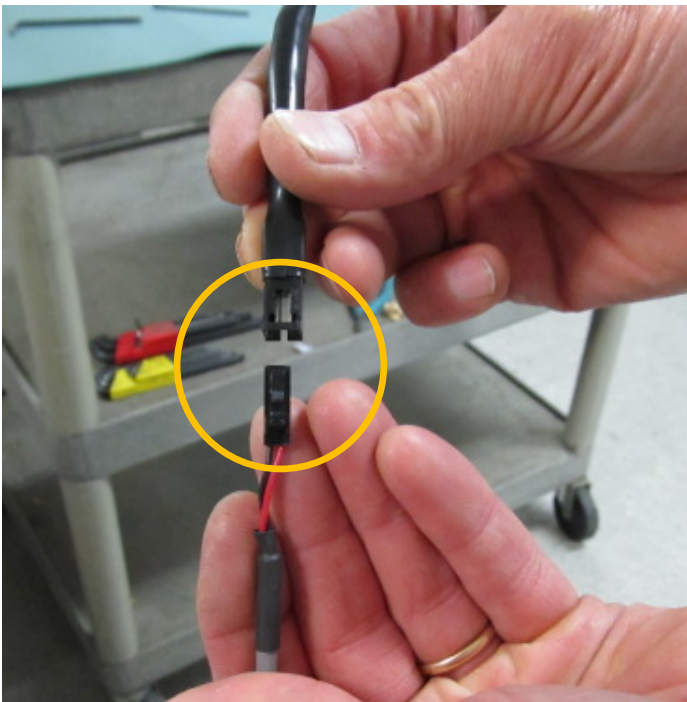
- Attach cable to clip.



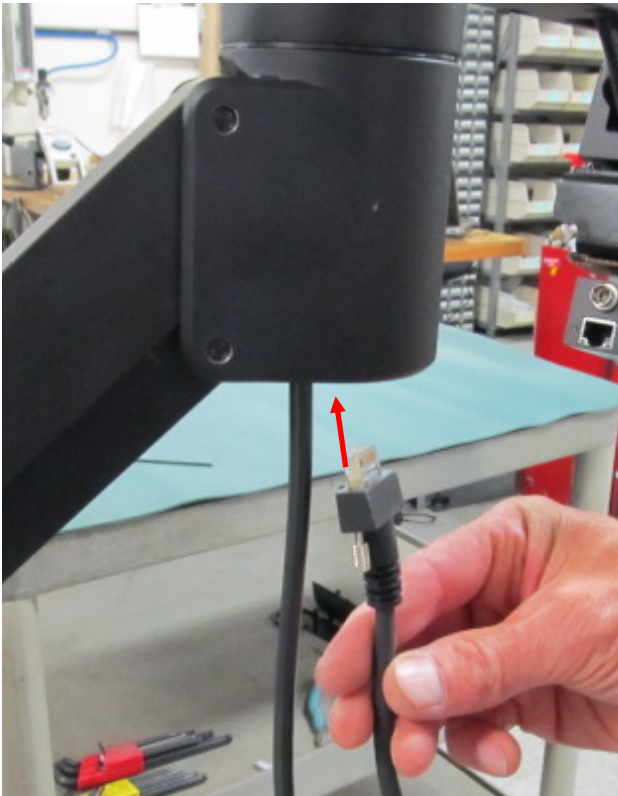
- Route camera light ring cable up and through camera arm as shown.



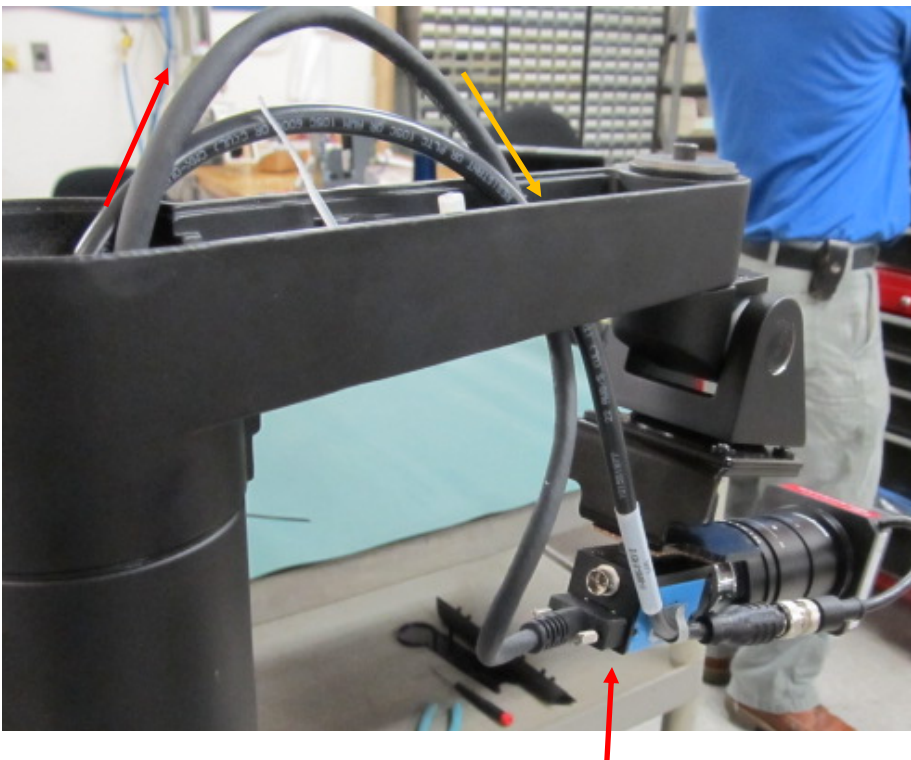
- Attach the ends of the camera light ring cables together.



- Route the Cat 5 camera cable up through the camera arm as shown.

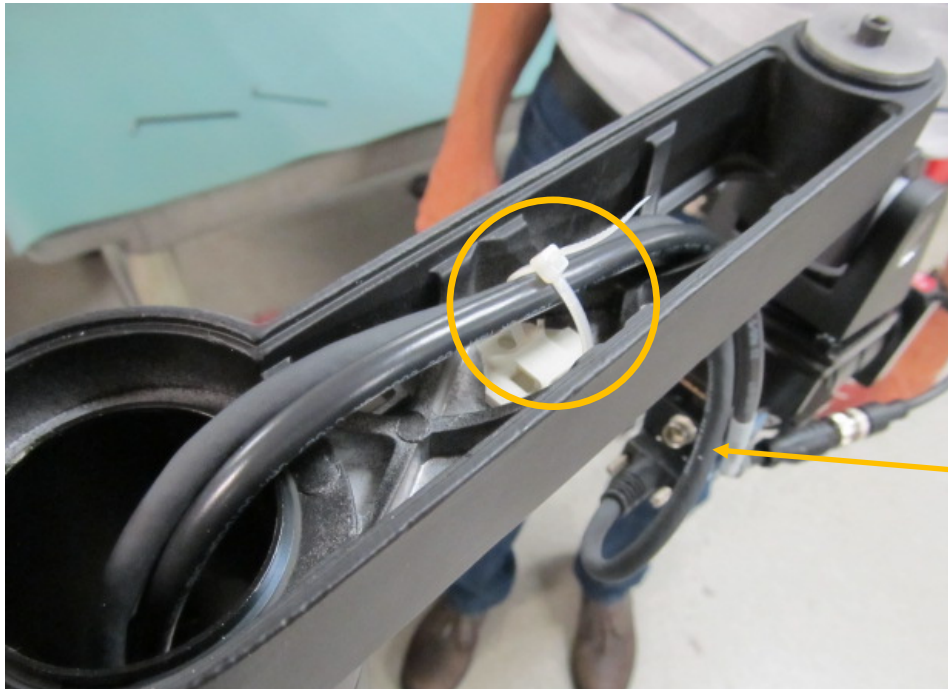


- Route Cat 5 cable down through camera arm and attach to camera.



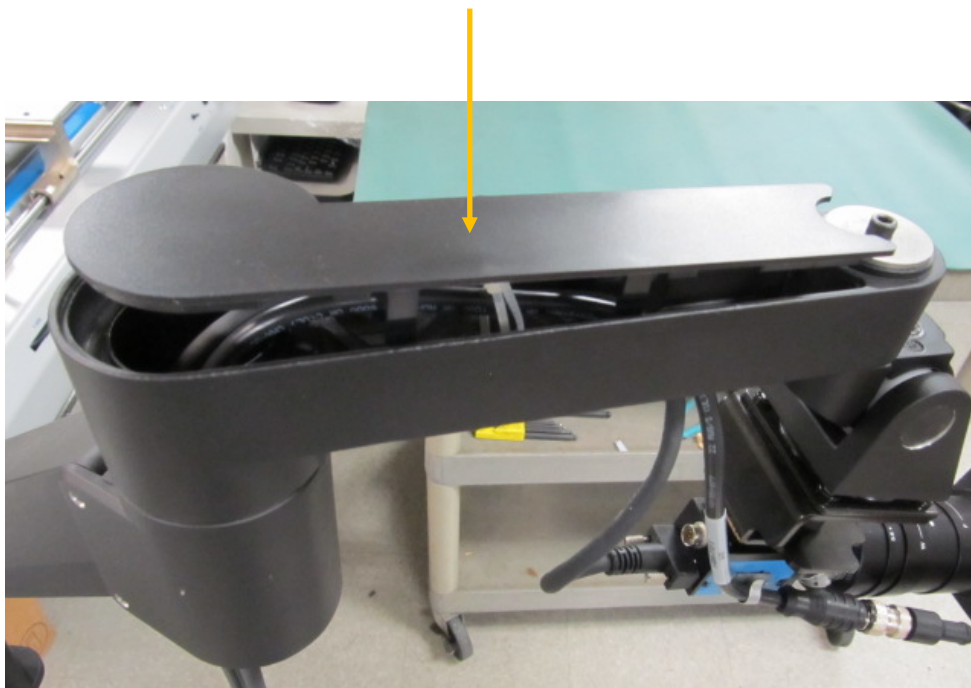
- Tie off cables as shown.

NOTE: Leave enough of a service loop so camera can pivot without pulling on the wires.



(service loop)

- Attach arm cover.



- Attach lower arm cover.

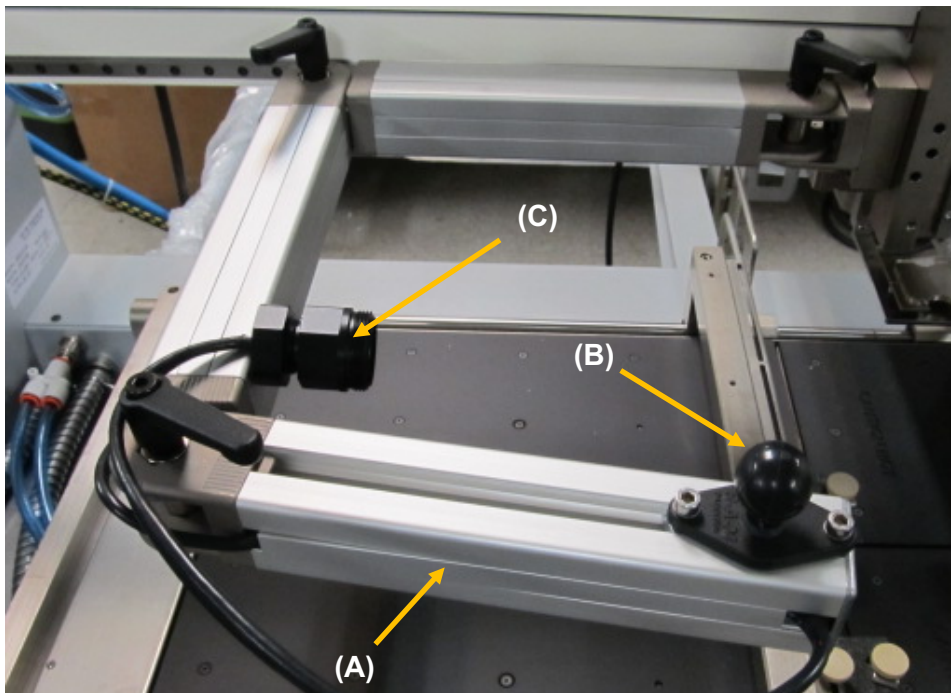
NOTE: Leave enough of a service loop so arm can pivot without pulling on wires.



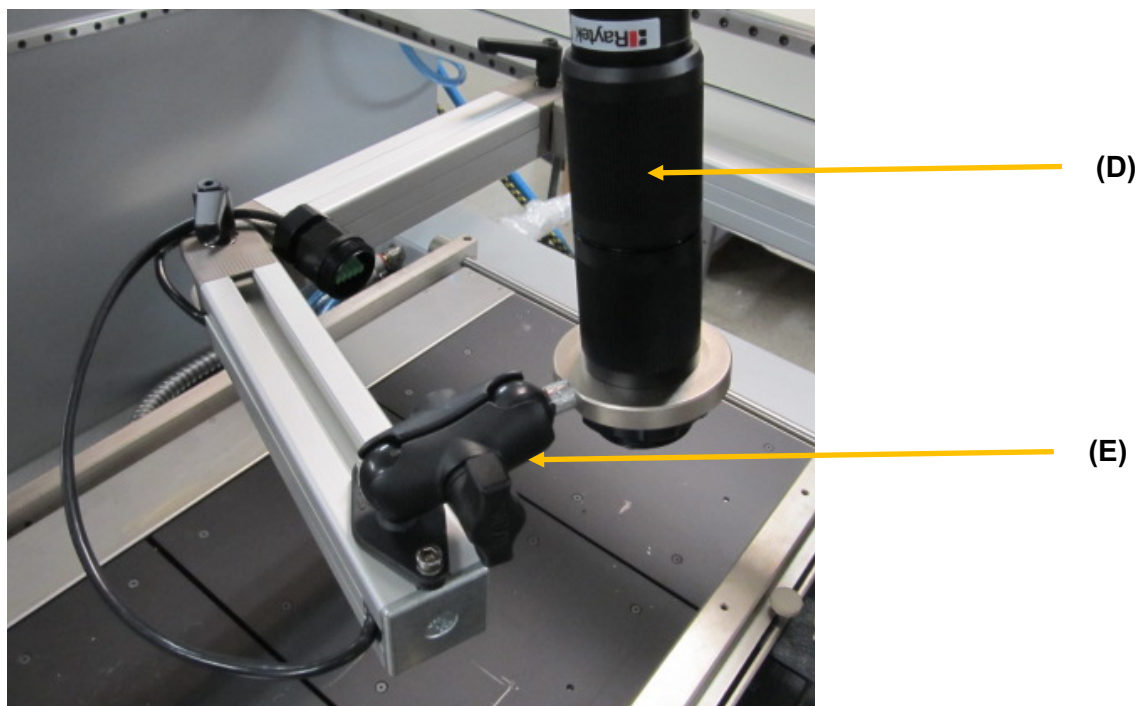
(service loop)

2.5 Installing the Optional IR Sensor with Fine Spot Laser Pointer

- IR probe arm (A) is shipped installed on machine with ball mount (B) and IR sensor connector (C).



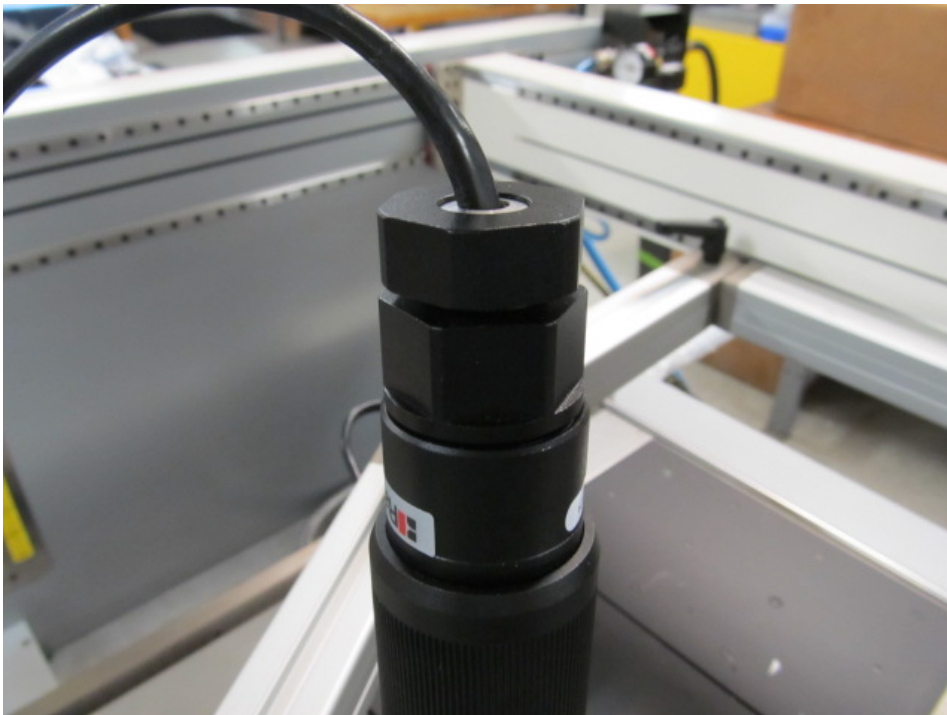
- Locate IR probe (D) and mount to ball mount (E) as shown.



- Install connector to the IR sensor and screw down nut.
- Install strain relief grommet and lock nut to the end of the IR sensor.

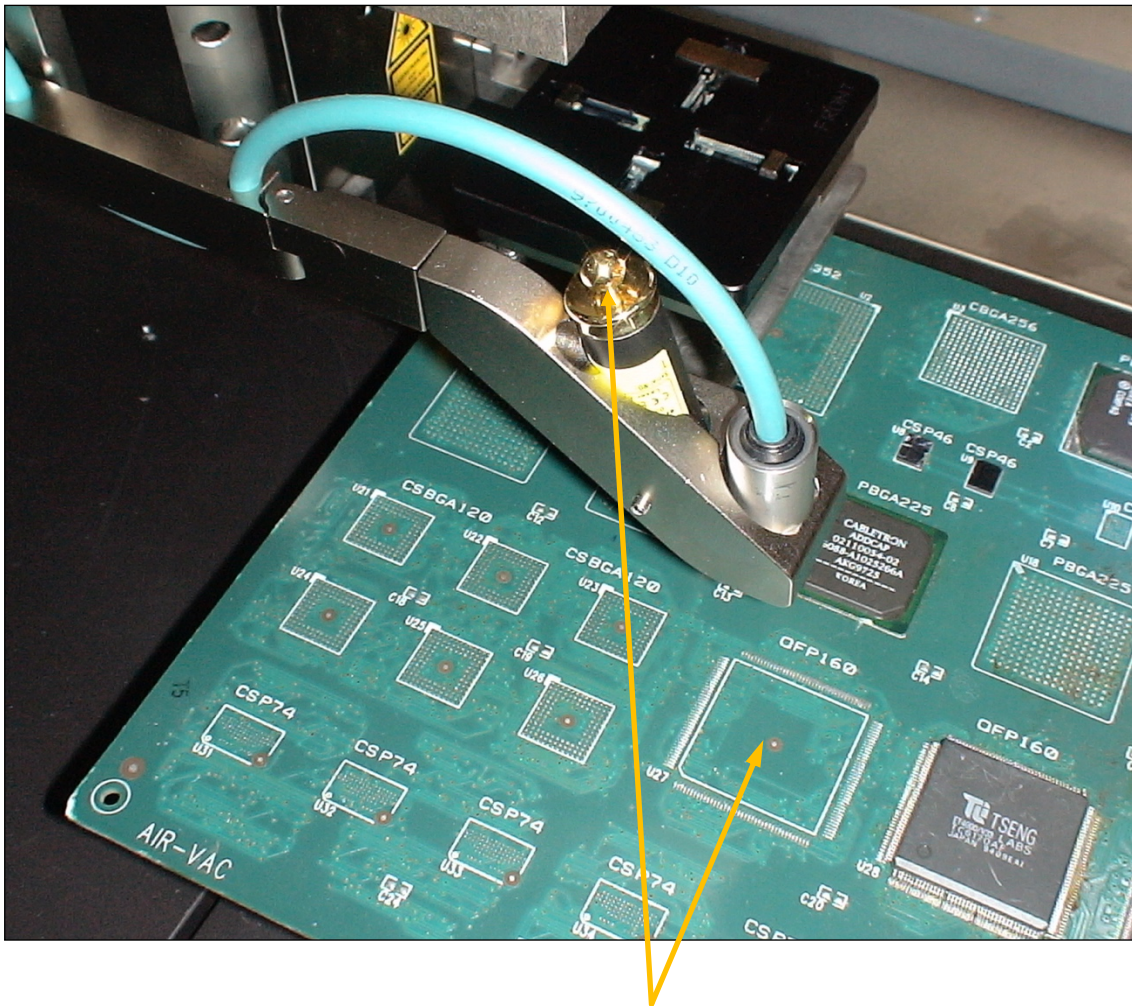


- Assembled view.



2.6 Installing the Optional Pivoting IR Sensor

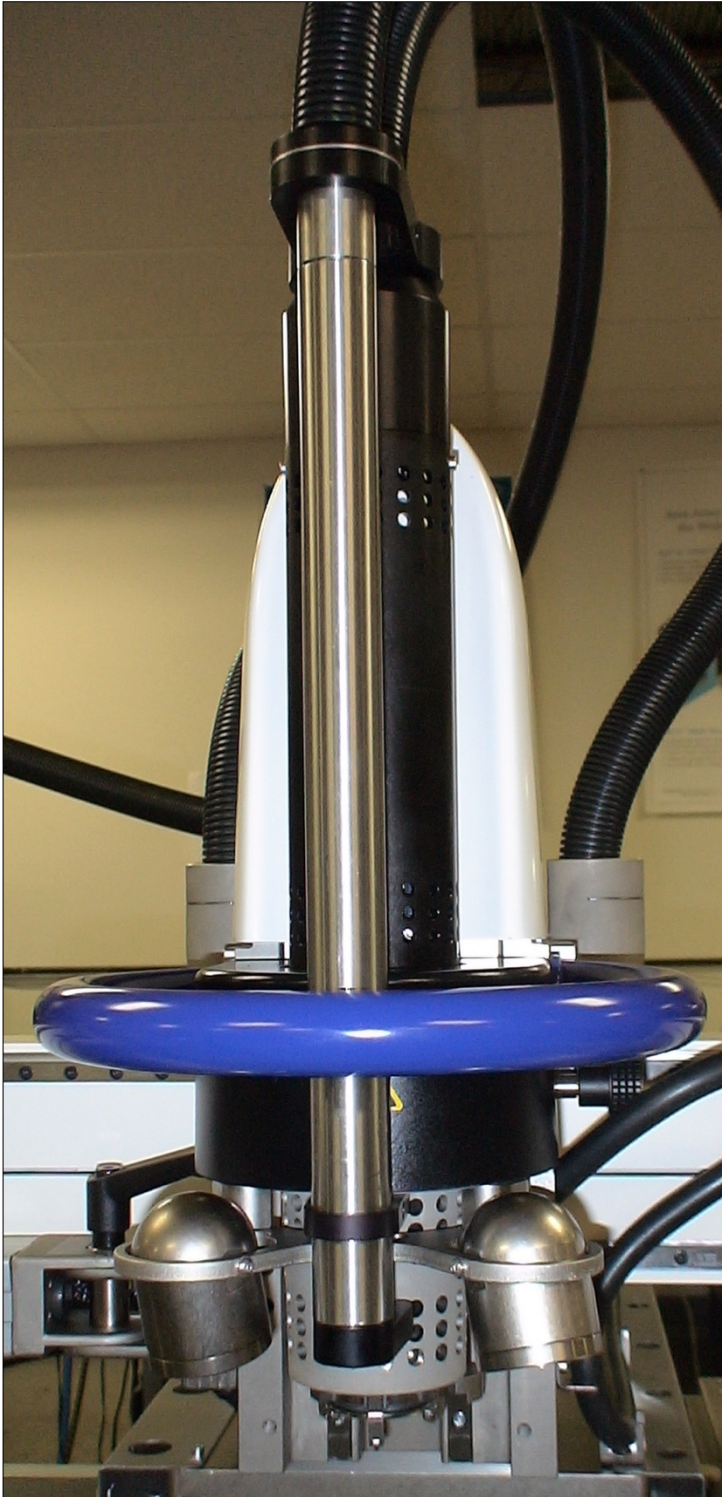
The IR Sensor option is installed by Air-Vac prior to shipment. No installation is required.



Laser Pointer to indicate area being monitored by IR Sensor.

2.7 Installing the Optional Fume Extraction Manifold

The Fume Extraction Manifold is installed by Air-Vac prior to shipment.



2.8 Facility Requirements – DRS27

Electrical (also see Operating Notes):

- Machine Power:

Configuration	Volts	Amp	Phase	Hz	Plug /Disconnect Rating (min amp)
DRS27 2 zone	3 x 208	25	3	50-60	Nema L15-30 (30a)
DRS27 3 zone	3 x 208	25	3	50-60	Nema L15-30 (30a)
DRS27 3 zone – Euro	3 x 400/230	25	3	50-60	No Plug (30a)
DRS27 3 zone, Spot heater	3 x 208	35	3	50-60	Hubbell CS8365C (50a)
DRS27 3 zone, Spot heater - Euro	3 x 400/230	35	3	50-60	No Plug (50a)
DRS27 6 zone	3 x 208	45	3	50-60	Disconnect box (50a)
DRS27 6 zone, Spot Heater	3 x 208	50	3	50-60	Disconnect box (60a)

Customer must follow the above recommendations for warranty and safety reasons.

- PC Power: (208/230 VAC) – Provided by convenience plug on machine
- Monitor Power: (208/230 VAC) – Provided by convenience plug on machine

Pneumatic:

- Upper Heater: 90-130 psi, 3 scfm, air or nitrogen. Clean, dry air (non-condensing) source. 1/8"-27 NPT male fitting x 6' hose supplied.
- Accessories: 90-130 psi, 21 scfm (intermittent). Clean, dry air (non-condensing) source. 1/4"-18 NPT male fitting x 6' hose supplied.

Operating Notes - IMPORTANT!:

Electrical:

- The DRS27 is supplied with either the above plugs or a disconnect box on the frame. The plug or disconnect arrangement is the means to have the machine be locked in the "Off" position. See Maintenance section for details of Lockout Tagout. The Euro versions are to be wired according to local electrical codes and are to be provided with a means of disconnect and lockout.
- This system is designed to operate on 208 VAC.
- **Under full load conditions**, power must not drop below 205 VAC. Full load is defined as DRS27 fully operating, plus all other equipment down the line fully operating. If 205 VAC is not met, a buck up transformer or another line must be connected. Under general conditions, expect incoming line voltage to drop approximately 3-10 volts.
- Under no load conditions, power must not exceed 220 VAC (US).
- If the PC and monitor are connected to a separate power source, or connected through a voltage regulator, the machine minimum voltage is 200 VAC.
- In areas susceptible to frequent power disturbances, line filtering/protection may be required.

Air/Nitrogen:

- With top heater and accessories operating at 100% flow, system consumes up to 24 scfm @80 psi. With all systems activated, 70 psi. must be maintained. Requires both gas lines be direct plumbed.
- A means of isolating the machine from compressed gas supply needs to be supplied. Examples of this are a lockable quick disconnect or a lockable valve. See maintenance chapter in LOTO section for more details. Be sure the device can handle the required flows.

Environmental:

- Temperature Range: +5°C to +40°C
- Relative Humidity: Not to exceed 50%
- Altitude: Up to 1500m above sea level

Physical:

- Machine Operating Dimensions (WxDxH): (DRS27) 67"x57"x72"; (DRS27.6Z) 82"x57"x72"
- Machine Weight: (DRS27) 750 lbs. (est.); (DRS27.6Z) 1000 lbs. (est.)
- Monitor Dimension (W x D x H): 17" x 17" x 10"
- Monitor Weight: 20 lbs.

Transportation:

- When transporting the machine, use factory crate and packing or equivalent / better.
- Contact Air-Vac for proper shipping hardware and instructions if original materials are not available.
- Storage temperatures to be -25°C to +55°C with short excursions (not exceeding 24 hrs) up to 70°C.

2.9 Pneumatic Connections: Top and Bottom Heater

CAUTION: REFER TO FACILITY REQUIREMENTS OF DRS27.

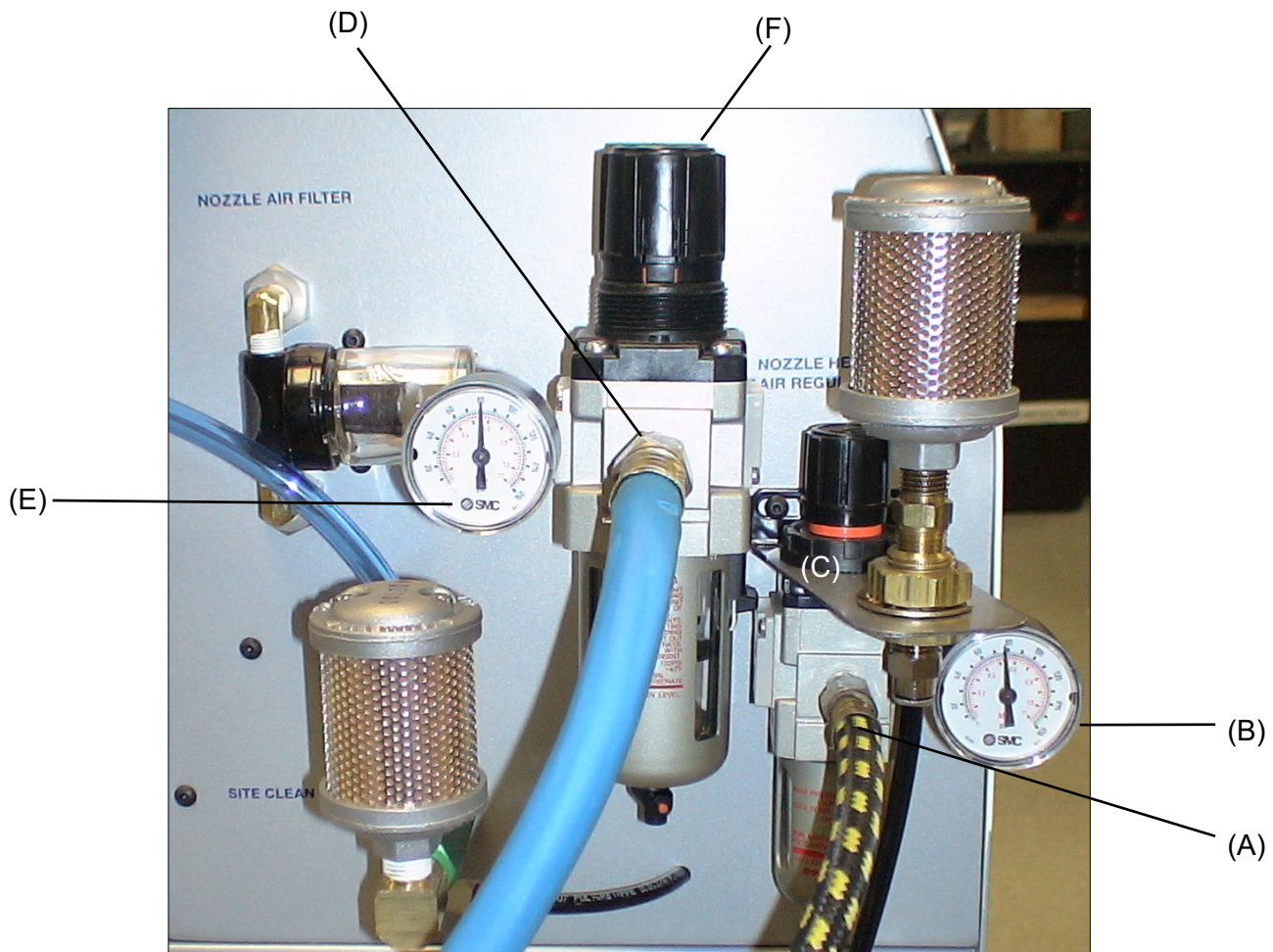
All Pneumatic and electrical connections described in the following sections must be done prior to powering on the DRS27.

Upper Heater Pneumatics:

- Connection (A): 1/8-27 NPT (male fitting) x 6 ft. hose (1/4" diameter) supplied
- Pressure Setting (B): 80 psi, adjust as required (C)
- Air/Nitrogen Consumption: 3 cfm

Other Pneumatics (nozzle vacuum, site cleaning vacuum, board cooling option):

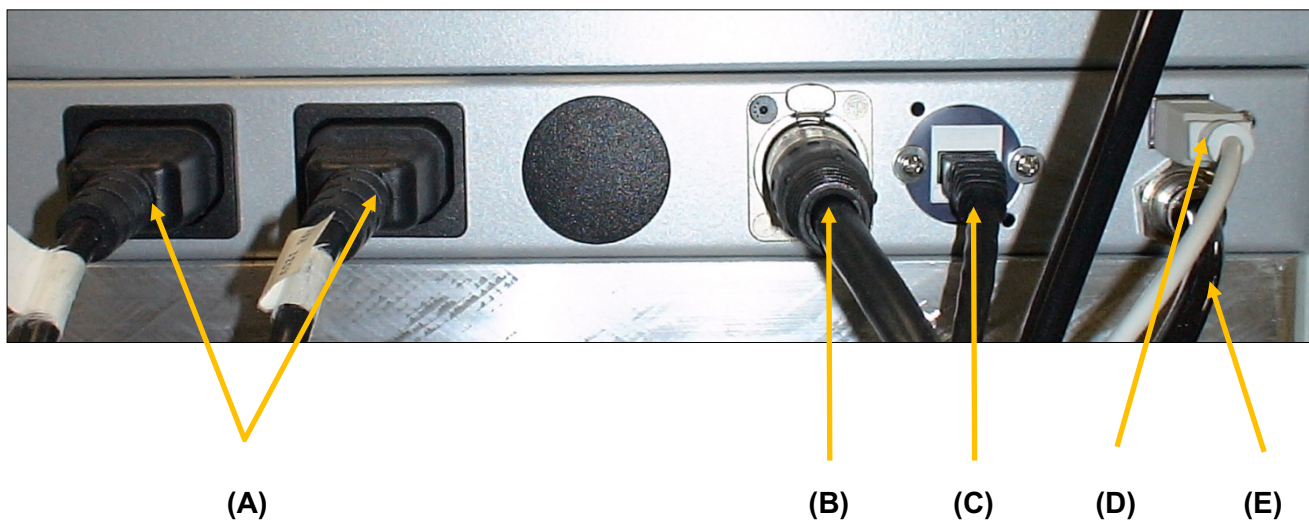
- Connection (D): 1/4-18 NPT (male fitting) x 6 ft. hose (3/8" diameter) supplied
- Pressure Setting (E): 80 psi, adjust as required (F)
- Air Consumption: 21 cfm



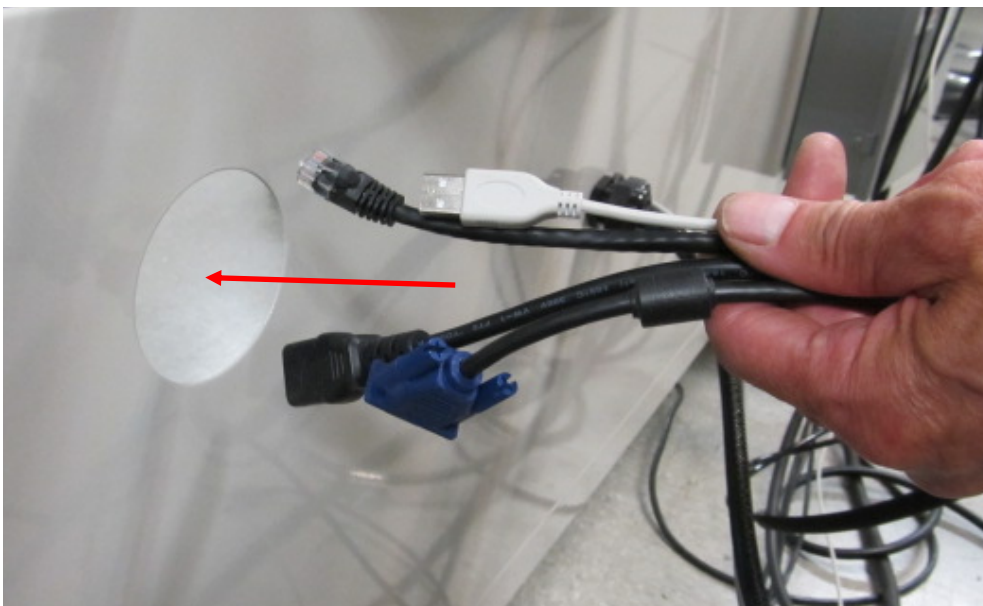
2.10 Other Connections

Accessory Panel

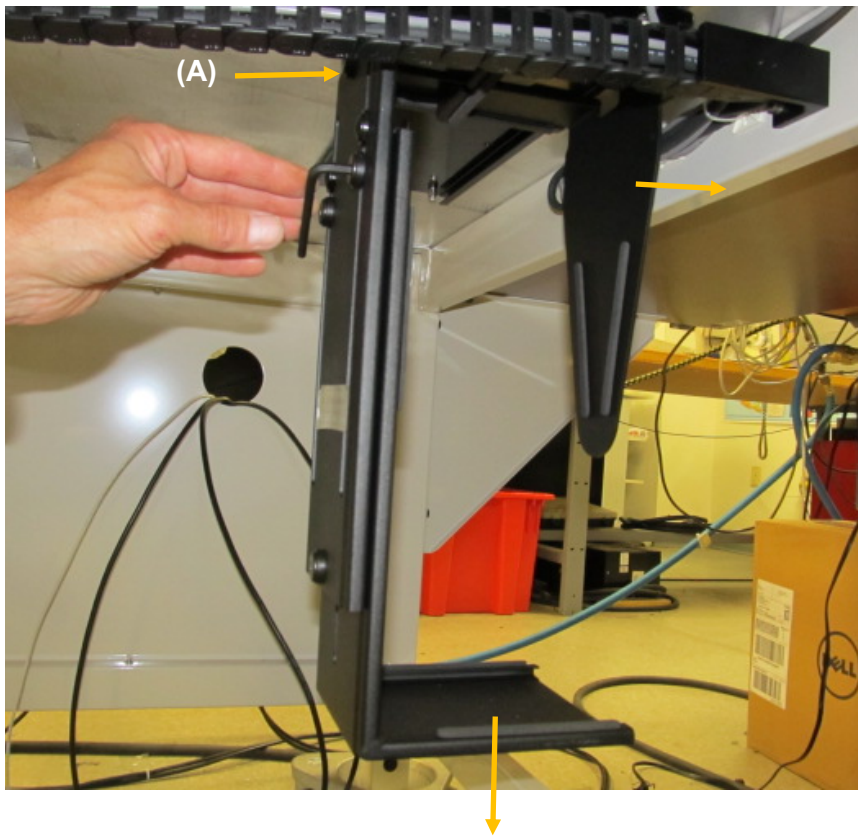
- Power (Computer and Monitor) **(A)**
- Footswitch **(B)**
- Ethernet **(C)**
- USB **(D)**
- Cooling Chamber Air **(E)**



- Route cables from accessory panel (and monitor) through the hole in rear of table frame to hook up to computer.



- Adjust the computer holder (3 places up or down) to accept the computer using Allen wrench (supplied) and adjust thumb knob **(A)** from right to left.

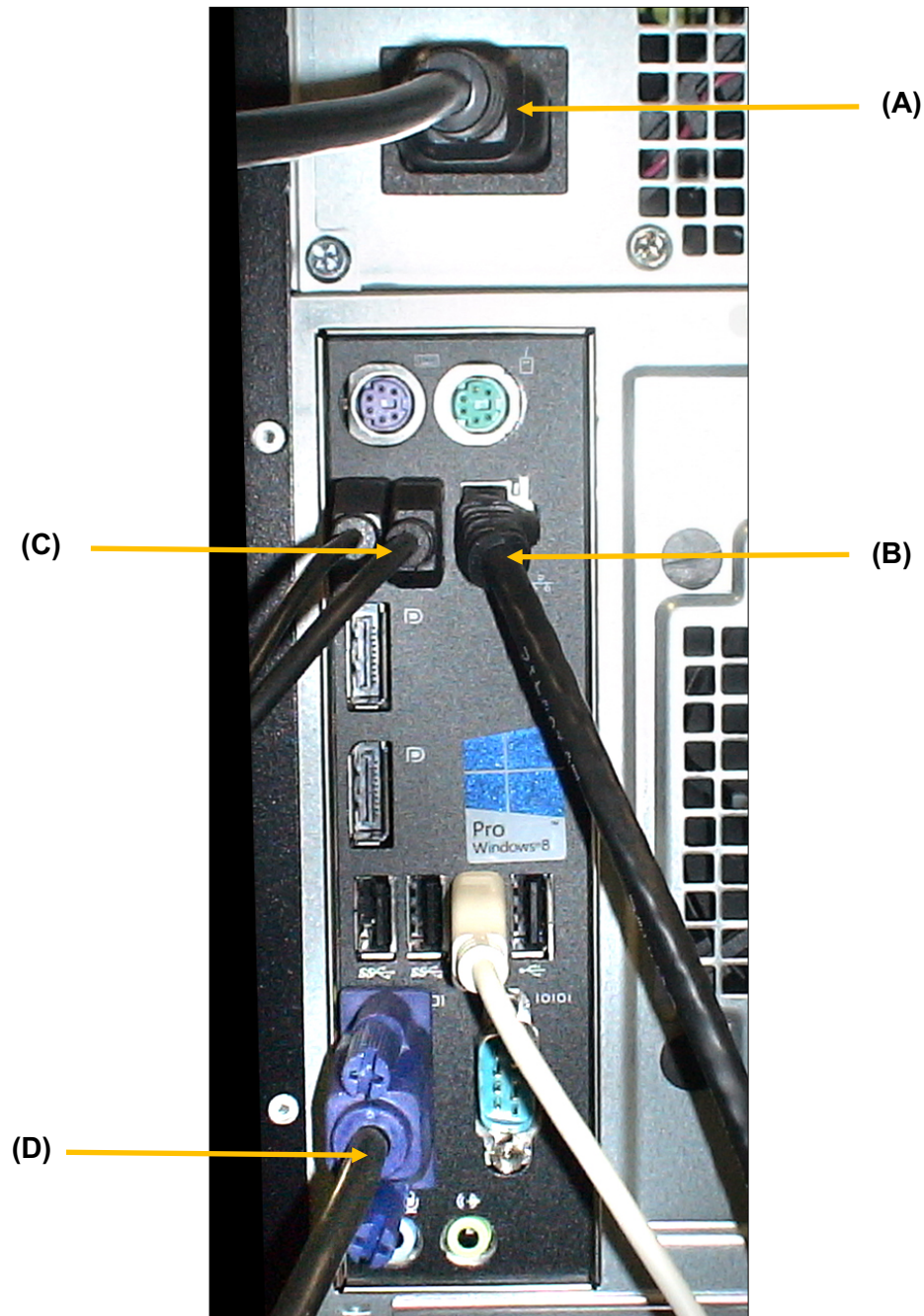


- Install computer into holder as shown and adjust as required then tighten adjustment screws.



CPU Connections

- Computer Power **(A)** - CPU and Monitor are both powered with 220V from machine.
- Machine Ethernet **(B)**
- Mouse and Keyboard **(C)**
- Monitor **(D)**



2.11 Material Check List

The following accessory items are shipped with all new DRS27 systems.

<u>Operators Manual</u>	0027.00.902
<u>Calibration Components</u>	
• Temperature Calibration Nozzle	NCAL-5
• Flow Meter	0024.00.104
• Flow Meter Hose	9001.15.036
• Flow Meter Fitting	9001.00.013
<u>Tool Kit (includes)</u>	0024.00.040
• Filter Element	0001.11.101
• Wrench Set All	12055
• Probe Tip, 3 De	29A3
• Button Probe	3SBP100
• Fitting, 1/4 BA	9001.00.013
• Tubing, Cond-SI	9001.15.018
• Tubing, 3/8"ID	9001.15.036
• Clip, Grounding	9002.01.065
• Fuse, 10 amp	9002.04.018
• Fuse, 4 amp	9002.04.033
• Fuse, 1/2 amp	9002.04.038
• Fuse, 12 amp	9002.04.055
• Component Assy	9002.14.005
• Board, 28mm QFP	9002.14.017
• Nozzle	NT27EZ27
• Box, Plastic	9004.00.005
• Case, Plastic	9005.03.029
• Anti-Seize	AS15
• Filter Element	F1AE
• Gas Nozzle Stand	GNS1
• Gas Nozzle Tool (small)	GNT1
• Gas Nozzle Tool (large)	GNT4
• O-Ring assortment	ORASST
• Steel Brush	STB7
• Needle	TS5LL-1
• Stringe (5cc)	TS5LL/PP
• Cup assortment, Silicone	VCASST

3: Machine Function Verifications

- 3 Machine Function Verifications 3
 - 3.0 VERIFICATION OVERVIEW..... 3
 - 3.1 VOLTAGE VERIFICATION..... 4
 - 3.2 PRESSURE VERIFICATION 6
 - 3.3 FLOW RATE VERIFICATION AND ADJUSTMENT 7
 - 3.4 NOZZLE HEATER TEMPERATURE VERIFICATION..... 13
 - 3.5 VISION ALIGNMENT VERIFICATION AND ADJUSTMENT 20

3 Machine Function Verifications

3.0 Verification Overview

Once the DRS27 has been setup according to the instructions as outlined in Chapter 2, critical machine functions including pressure, gas flow rate, temperature and vision must now be verified to ensure proper machine performance. It is important that the verification procedures be done sequentially as outlined in this section.

Machine verification should be done:

- After initial setup
- Anytime the system is physically moved or disconnected
- At regularly scheduled intervals such as every 3-4 months.

Verification processes are stored in a hidden menu, to enter the hidden menu please do the following:

- Right click on the Air-Vac logo **(A)** and the toolbar color will change to red.
- To return to the main menu, right click anywhere else on the screen and the toolbar will return to normal.



3.1 Voltage Verification

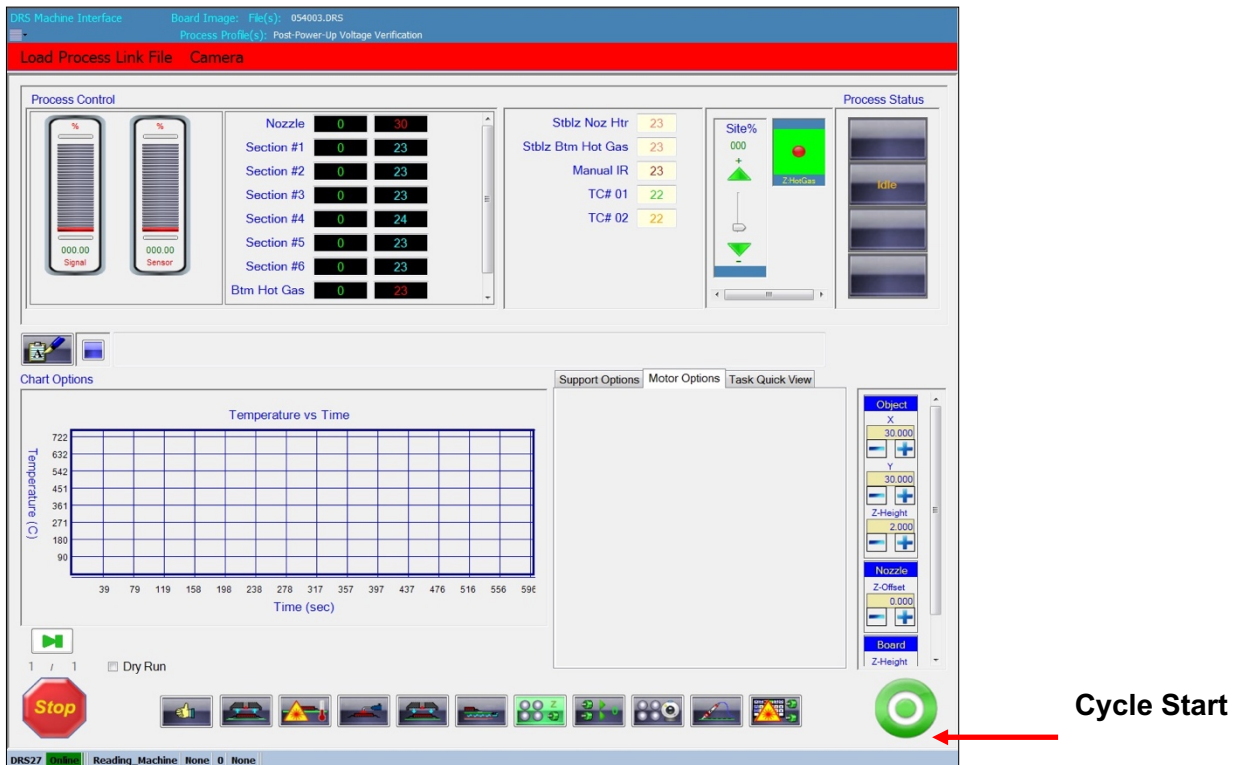
NOTE: Qualified Personnel ONLY.

1. Open the electrical box.
2. Turn machine power on (release e-stop and turn key).
3. Turn on PC .
4. Click on the black Air-Vac administrator icon. The administrator password is “AirVac”.
5. Double click on the DRS27 icon to load the software.



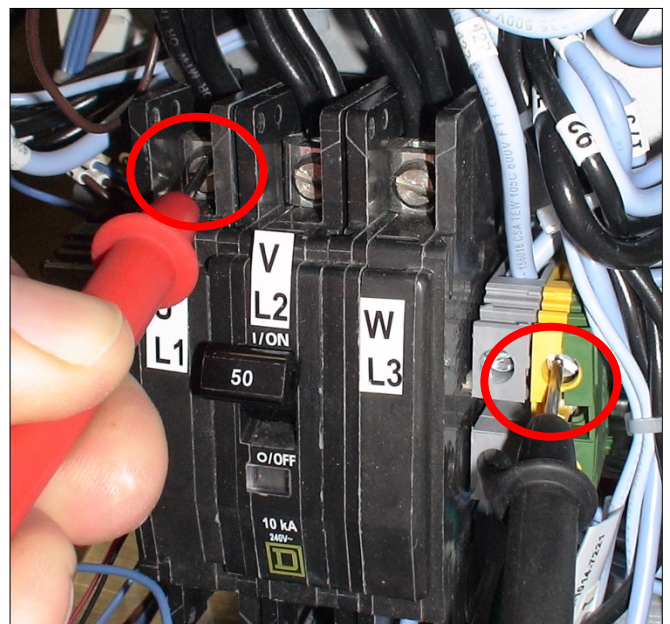
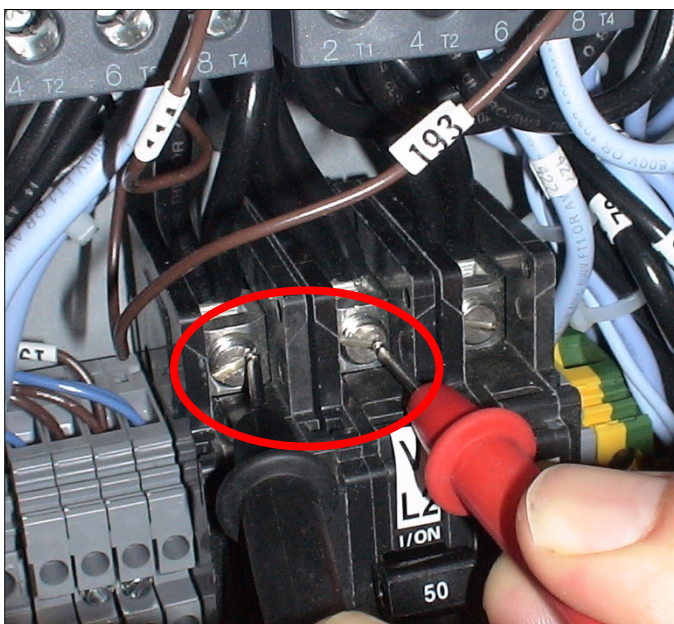
6. Type in “DRS27” as operator and select the thumbs up icon to advance to the next screen.
7. Select thumbs again when prompted for the password (system is shipped with no password).
8. Machine will perform a Home Operation. Click on OK.
9. Using the right side mouse button, click on the Air-Vac logo on the screen (main menu background color will change to red). You are now in the “Hidden” setup window.
10. Select Options from the menu bar.
11. Select Open, then Profile Open. The file group should default to System-System-System.
12. Select the Post-Power-Up Voltage Verification profile. Click on the Thumbs Up icon. Click on the thumbs up icon again to advance to the run screen.

13. Click on the cycle start icon to begin the process.



14. Verify that the machine voltage (**below left**) is between 205 and 220 volts while the process is running. Voltage must not be below 205 volts. See facility sheet regarding buck up transformer if the voltage drops below 205 volts.

15. Each leg (**below right**) must be approximately 120 volts.

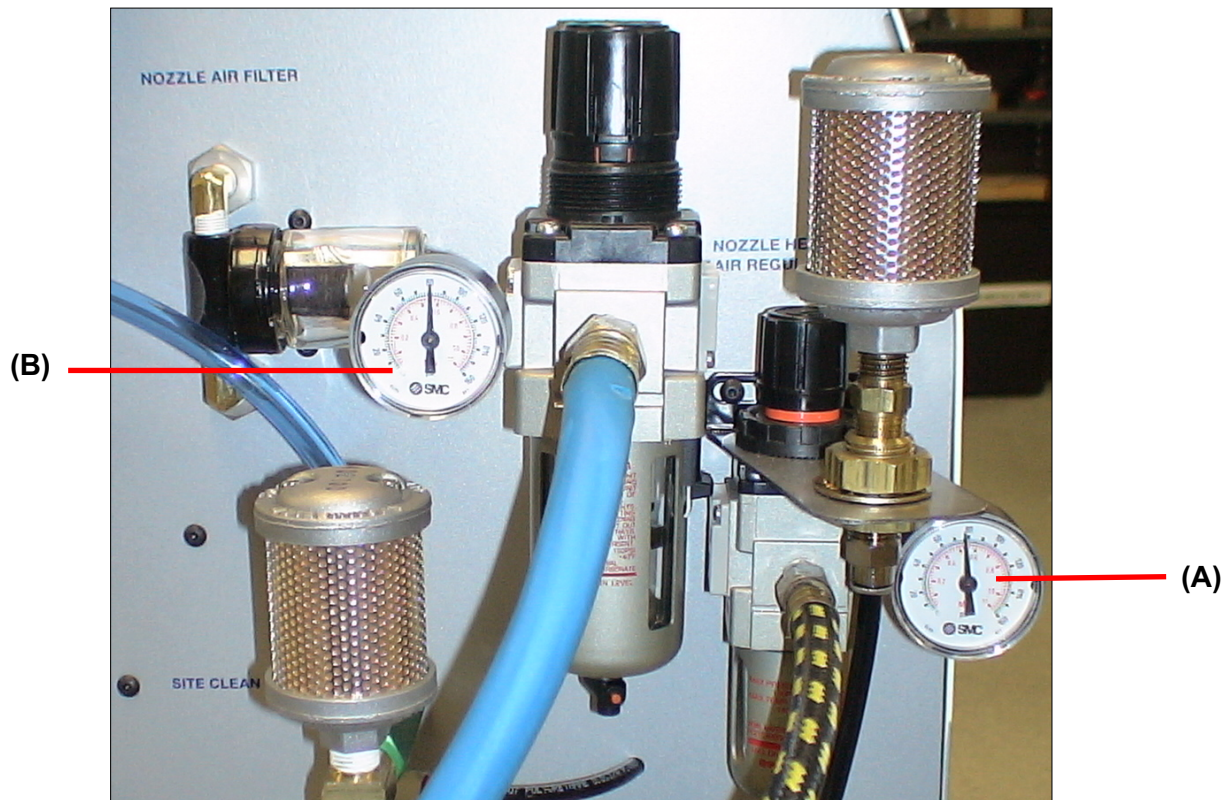


3.2 Pressure Verification

1. Check the air pressure to the upper heater and accessory ports.

Important:

THE PRESSURE GAUGE FOR THE UPPER HEATER (A) AND ACCESSORY PORTS (B) SHOULD READ 80 PSI. ADJUST REGULATORS AS NEEDED.

**Important:**

AIR CONSUMPTION FOR THE ACCESSORY PORT IS 21 SCFM. THE AIR CONSUMPTION FOR THE UPPER HEATER IS 3 SCFM. IF AIR LINE IS COMBINED, 24 SCFM MUST BE MAINTAINED AT 80 PSI.

INSUFFICIENT AIR SUPPLY (LOW VOLUME DUE TO QUICK DISCONNECTS, SMALL DIAMETER LINES OR ANY LINE RESTRICTION WILL CAUSE A PRESSURE DROP.

INSUFFICIENT AIR WILL RESULT IN PREMATURE HEATER DAMAGE AND/OR PROCESS REPEATABILITY ISSUES. IN ADDITION, TRANSFERRING PROFILES FROM MACHINE TO MACHINE WILL NOT BE POSSIBLE.

2. Close the machine cover and re-install the hold down screws.

3.3 Flow Rate Verification and Adjustment

Once the pressure verification is complete, the gas flow rate should be verified. Accurate gas flow through the nozzle is critical for achieving repeatable results. The DRS27 incorporates a Mass Flow Controller with closed loop control to monitor and regulate gas flow rates.

The two areas of flow verification include the Nozzle Flow Controller, which controls actual flow rates and the Nozzle Flow Sensor, which controls the Computer Digital Flow Display. Nozzle flow verification is required for initial installation, or any time the machine is disconnected and/or moved.

3.3.1 Nozzle Flow Controller Verification and Adjustment

Materials required:

- Scribed reference flow meter supplied with the machine.

Initial conditions:

- Pressure to upper heater must be set precisely to 80 psi (+/- .5psi).

Set-up:

- Connect the Black Hose from the Flow Meter into the Flow Cal Fitting.

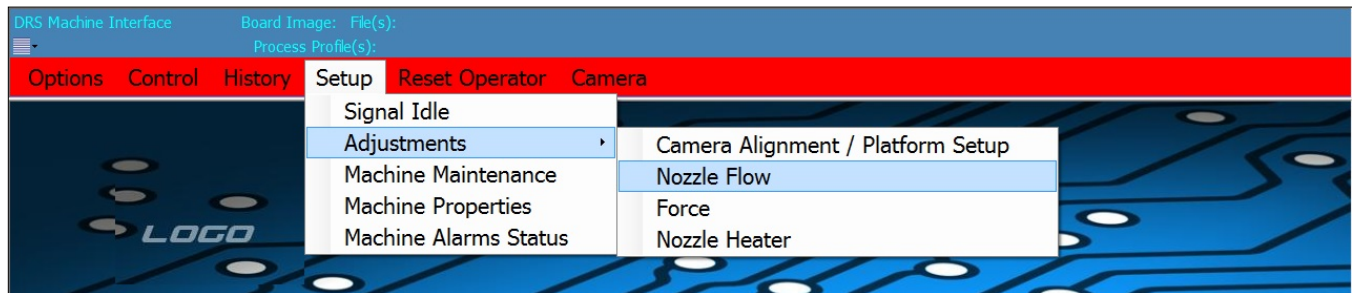
WARNING:

BE CERTAIN ALL THE BLACK HOSE IS INSERTED INTO FITTINGS COMPLETELY. A BAD CONNECTION CAN RESULT IN ERRONEOUS CALIBRATION READINGS.

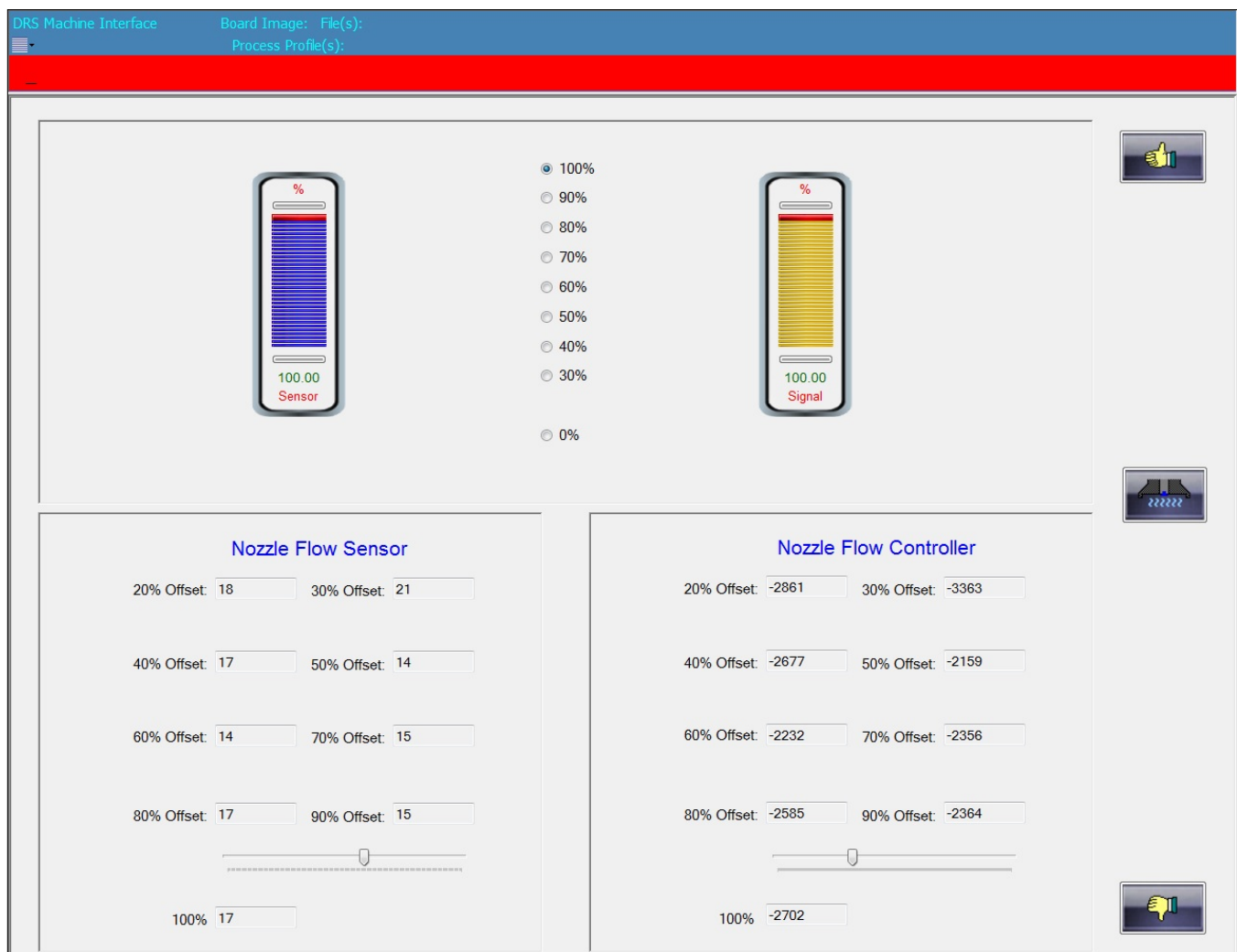


To access the Flow Adjustment Screen:

- Log on as “DRS27” or any “high level” security operator and select the Thumbs Up icon.
- Using right side mouse button, click the Air-Vac logo. You are now in the ‘Hidden’ Setup window.
- Select Setup/Adjustments/Nozzle Flow from the menu bar.



The Nozzle Flow Adjustment screen will appear as shown below.



Making Flow Controller Verifications and Adjustments:

- Click on the 100% radio button **(A)** on the Flow Adjustment Screen. The airflow will activate after 1-4 seconds.
- Wait 45 seconds before making any adjustments.
- Check the 100% scribe line on the flow meter. If the flow meter reads too high or too low, adjustments can be made immediately by dragging or clicking on the track bar within the Nozzle Flow Controller group box **(B)**. The airflow should not be interrupted. The adjustments will be automatically applied and stable within 3-5 seconds. The track bar is always connected to the active flow rate helping to minimize incorrect adjustments.

DRS Machine Interface Board Image: File(s):
Process Profile(s):



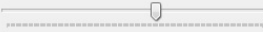
(A)

- ☒ 100%
- ☐ 90%
- ☐ 80%
- ☐ 70%
- ☐ 60%
- ☐ 50%
- ☐ 40%
- ☐ 30%
- ☐ 0%



Nozzle Flow Sensor

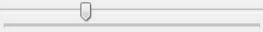
20% Offset: 18	30% Offset: 21
40% Offset: 17	50% Offset: 14
60% Offset: 14	70% Offset: 15
80% Offset: 17	90% Offset: 15



100% 17

Nozzle Flow Controller

20% Offset: -2861	30% Offset: -3363
40% Offset: -2677	50% Offset: -2159
60% Offset: -2232	70% Offset: -2356
80% Offset: -2585	90% Offset: -2364



(B)
 100% -2702



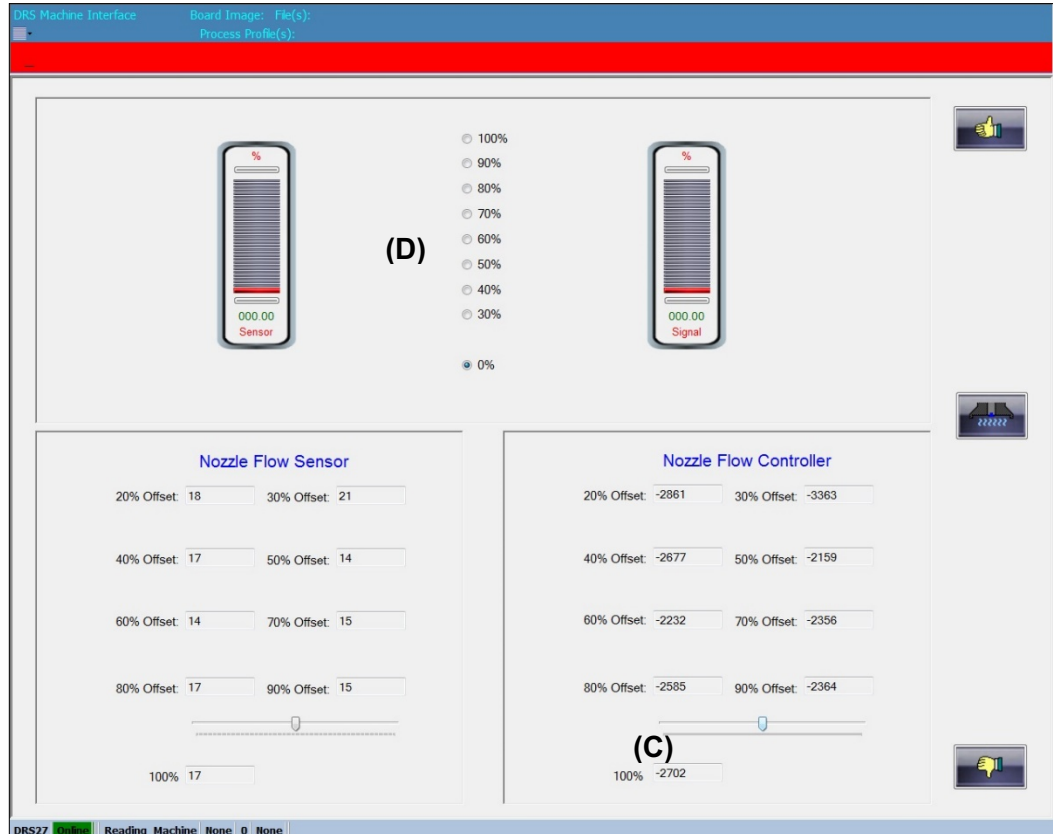
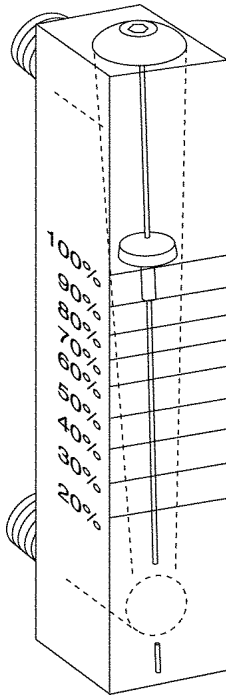


Note:

NO ADJUSTMENT IS NECESSARY IF THE FLOW IS OFF BY LESS THAN THE THICKNESS OF THE FLOAT +/- . READ THE BOTTOM OF FLOAT HEAD (LARGEST DIAMETER).

Flow Meter:

Air Flow Table:

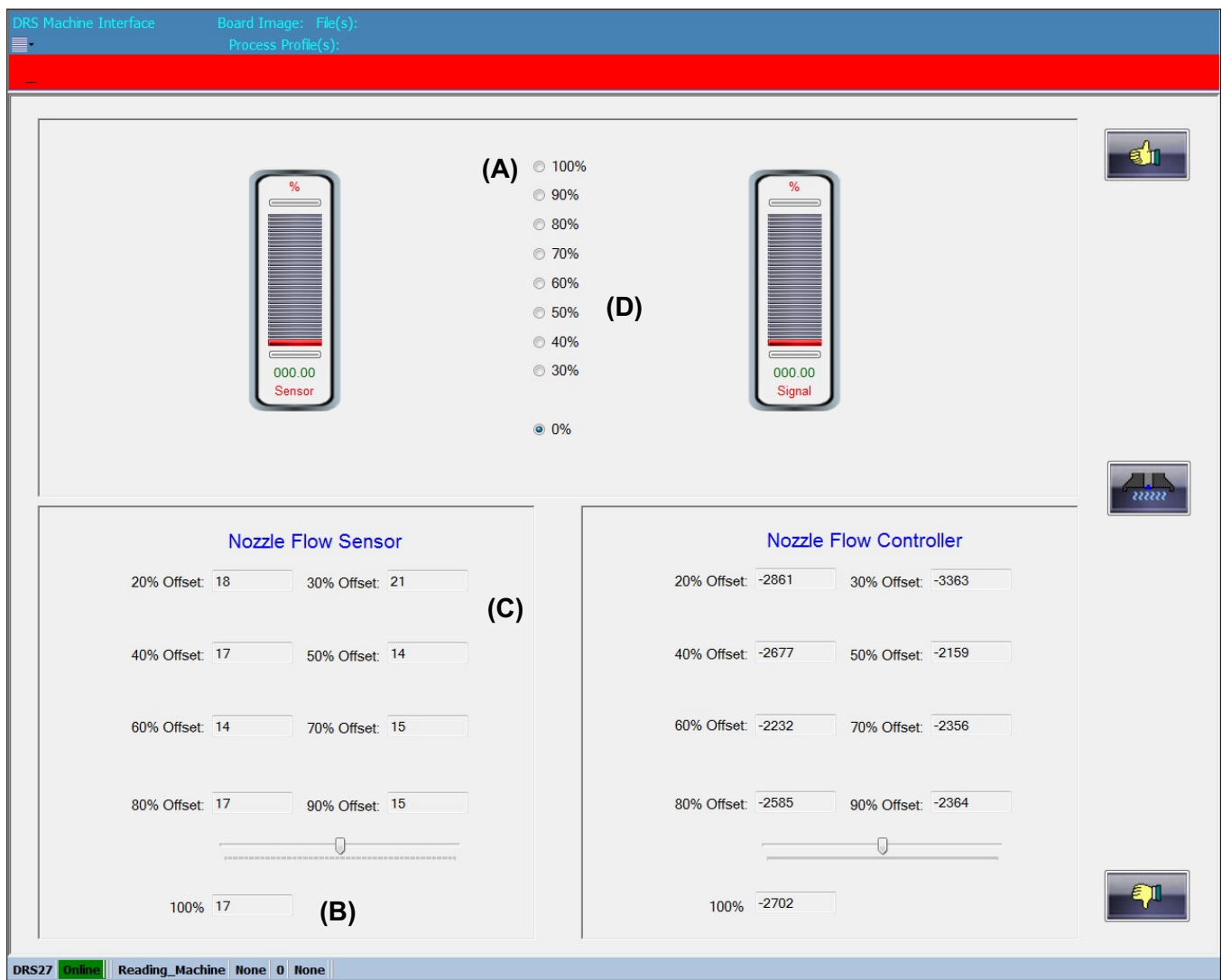


- If the flow meter reads too high, decrease make 2 clicks on the left side of the track bar **(C)**.
- If the flow meter reads too low, increase make 2 clicks on the right side of the track bar **(C)**.

Once the 100% Flow Controller value has been set, check flow controller verifications for 30-90% settings **(D)**. With the nozzle flow system activated for the various settings, check the flow using the meter. Adjust the nozzle flow controller **(C)** as required until the float corresponds to the scribed setting.

Making Flow Sensor Verifications and Adjustments:

- Click on the 100% radio button **(A)** on the Flow Adjustment Screen. The air flow will activate after 1-4 seconds.
- Wait 45 seconds before making any adjustments.
- Check the blue meter that is being displayed on the left side software screen. This meter represents the actual flow rate sensor output from the flow controller.
- If the blue meter is too high, decrease the value by making 2 clicks **(B)** on the left side of the track bar.
- If the blue meter is too low, increase the value make 2 clicks **(B)** on the right side of the track bar.
- Retest for 30-90% Flow Sensor values **(C)** for each nozzle flow setting **(D)**.



Making Flow Sensor Verifications and Adjustments:**Note:**

AFTER COMPLETING THIS VERIFICATION PROCEDURE, THE OPERATOR SHOULD QUICKLY RUN THROUGH ALL OF THE FLOW SENSOR RANGES (30-90%). THE PURPOSE OF THIS STEP IS TO ASSESS THE OVERALL PERFORMANCE OF THE FLOW SYSTEM.

- Select the **Thumbs Up icon to save changes** and exit the Flow Adjustment screen.
- Disconnect the black hose and the flow meter.

<u>Software Screen</u>	<u>Flow Meter</u> <i>Target Value</i>
30%	(30% scribe): .82 scfm
40%	(40% scribe): 1.10 scfm
50%	(50% scribe): 1.37 scfm
60%	(60% scribe): 1.65 scfm
70%	(70% scribe): 1.92 scfm
80%	(80% scribe): 2.20 scfm
90%	(90% scribe): 2.47 scfm
100%	(100% scribe): 2.75 scfm

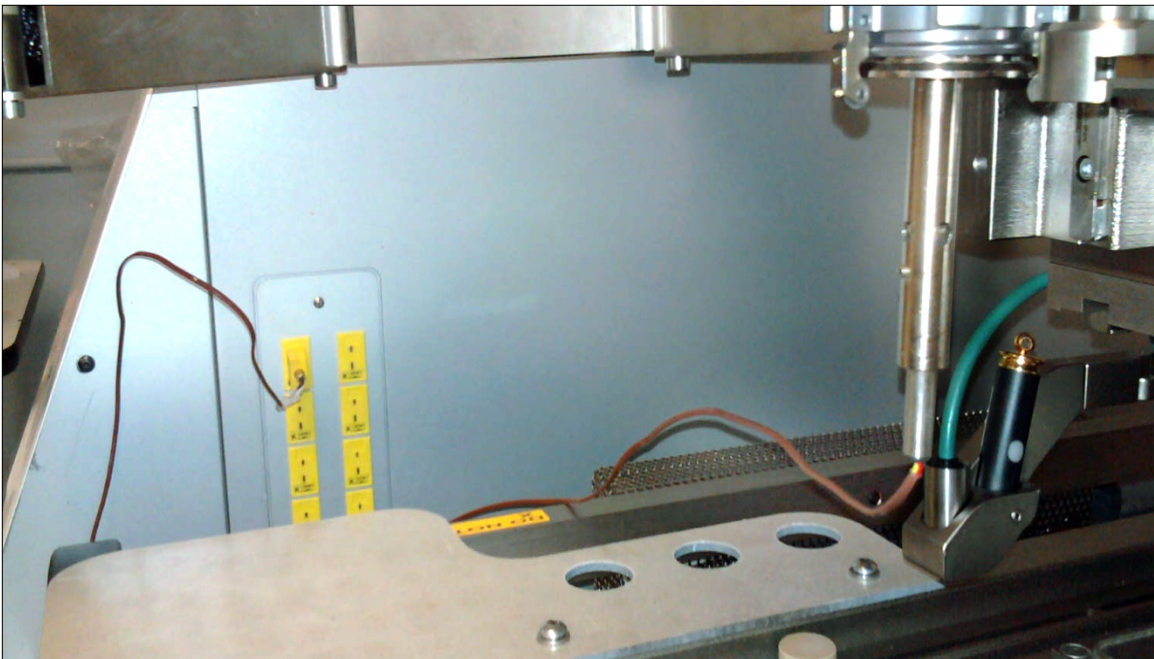
3.4 Nozzle Heater Temperature Verification

After the machine pressure and flow have been verified, the next step is to verify heater temperature accuracy.

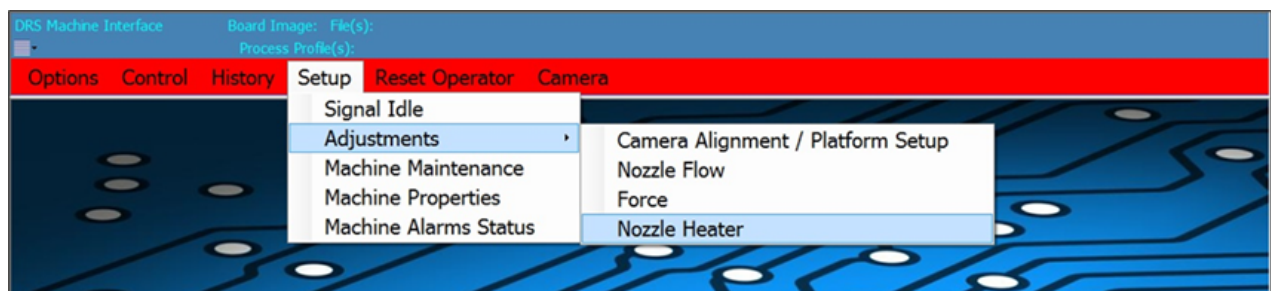
Overview- This verification assures 'programmed' temperatures stay within an acceptable range of +/- 10 degree's C accuracy at each level requested by the thermal-profile. You will run the process using the screen selection-COMPUTE NOZZLE OFFSETS, which records the heater thermocouple temperatures compared to the NCAL-5 nozzle thermocouple temperatures. During this thermal run, the software generates offset values for each temperature level and these values are *applied automatically* during the next thermal run called APPLY NOZZLE OFFSETS. This procedure is explained in detail, in the following pages.

Begin by-

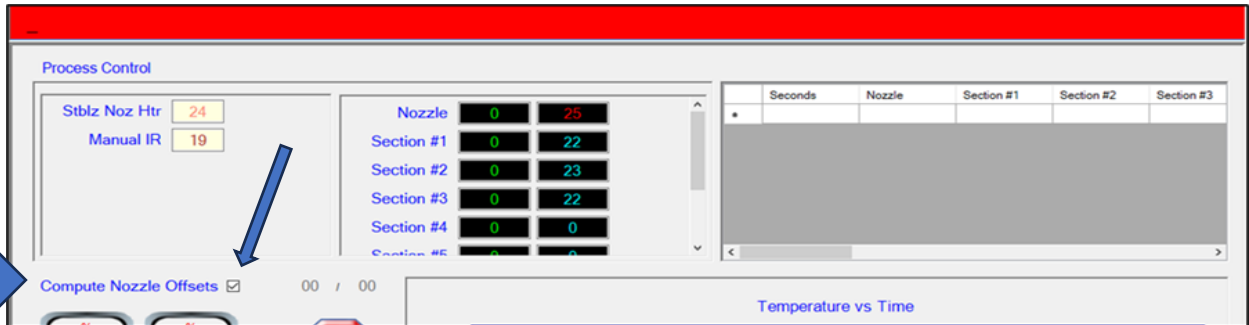
1. Install NCAL-5 temperature verification nozzle into the machine.
2. Plug the nozzle thermocouple into channel #1.



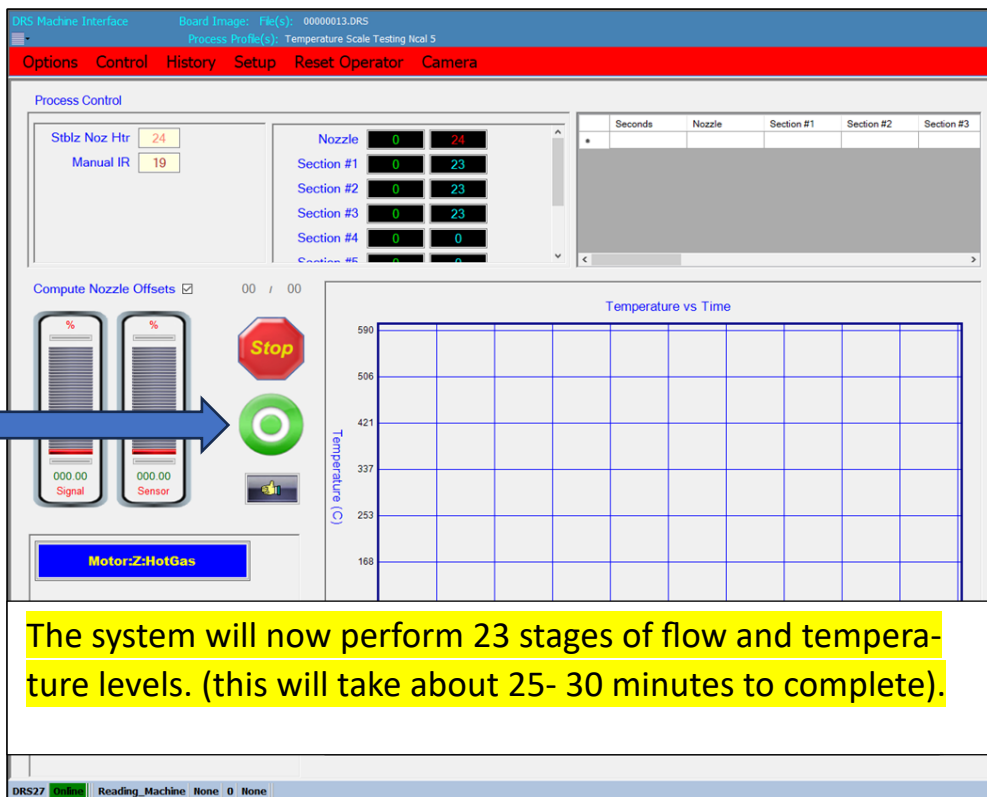
3. From the main screen, right-click on the Air-Vac LOGO to access the 'Hidden Menu' area with the top-bar highlighted in RED. You will now go to- SETUP/ADJUSTMENTS/NOZZLE HEATER.



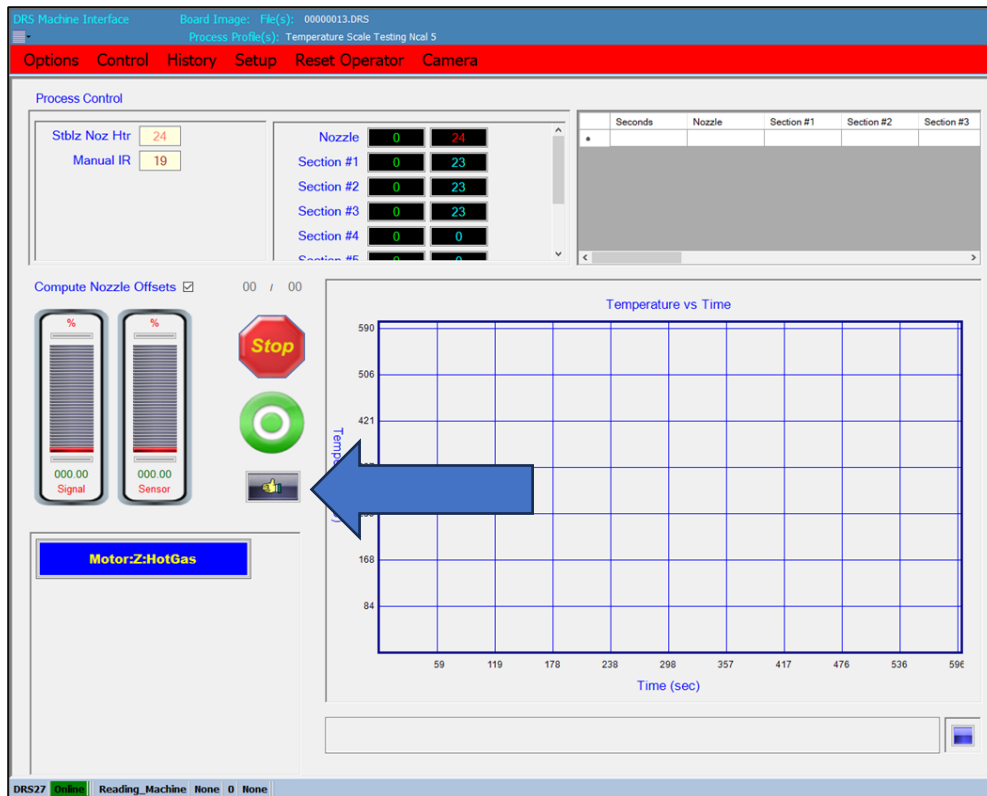
- On the Nozzle Heater Screen, be sure that COMPUTE NOZZLE OFFSETS (including a check in the box) is selected (in the upper left section of the screen), as shown here.



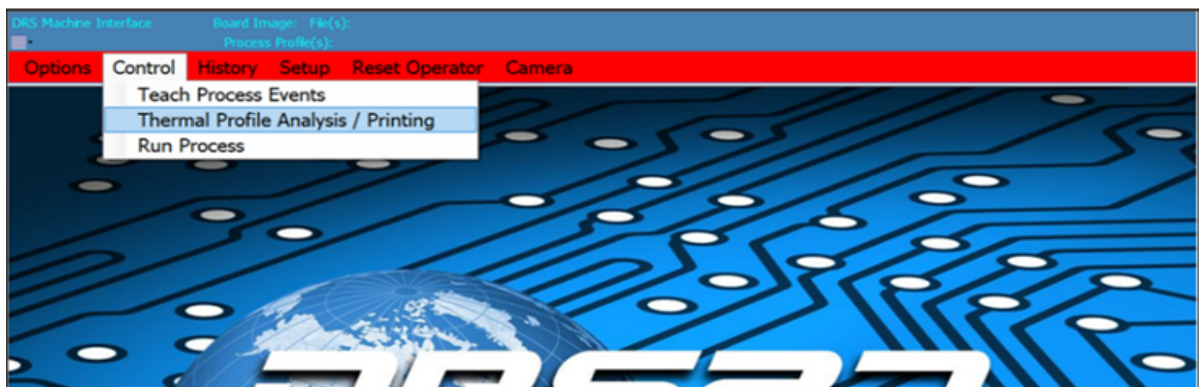
- Begin the Nozzle Heater Temperature Verification by clicking on the START ICON.



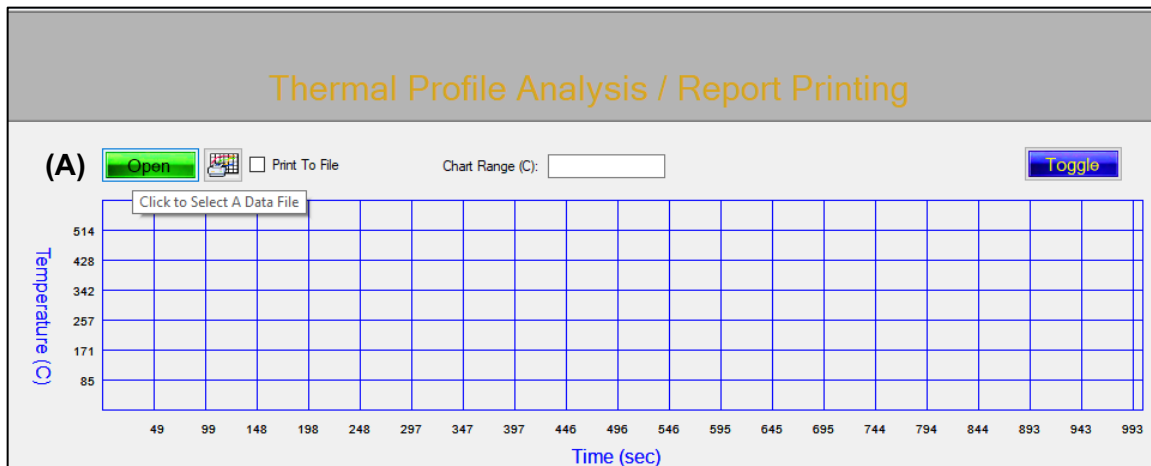
6. When the process is complete, you must save your thermal results. To do this, click on the blue box first, then hit the THUMBS UP ICON to save the data.



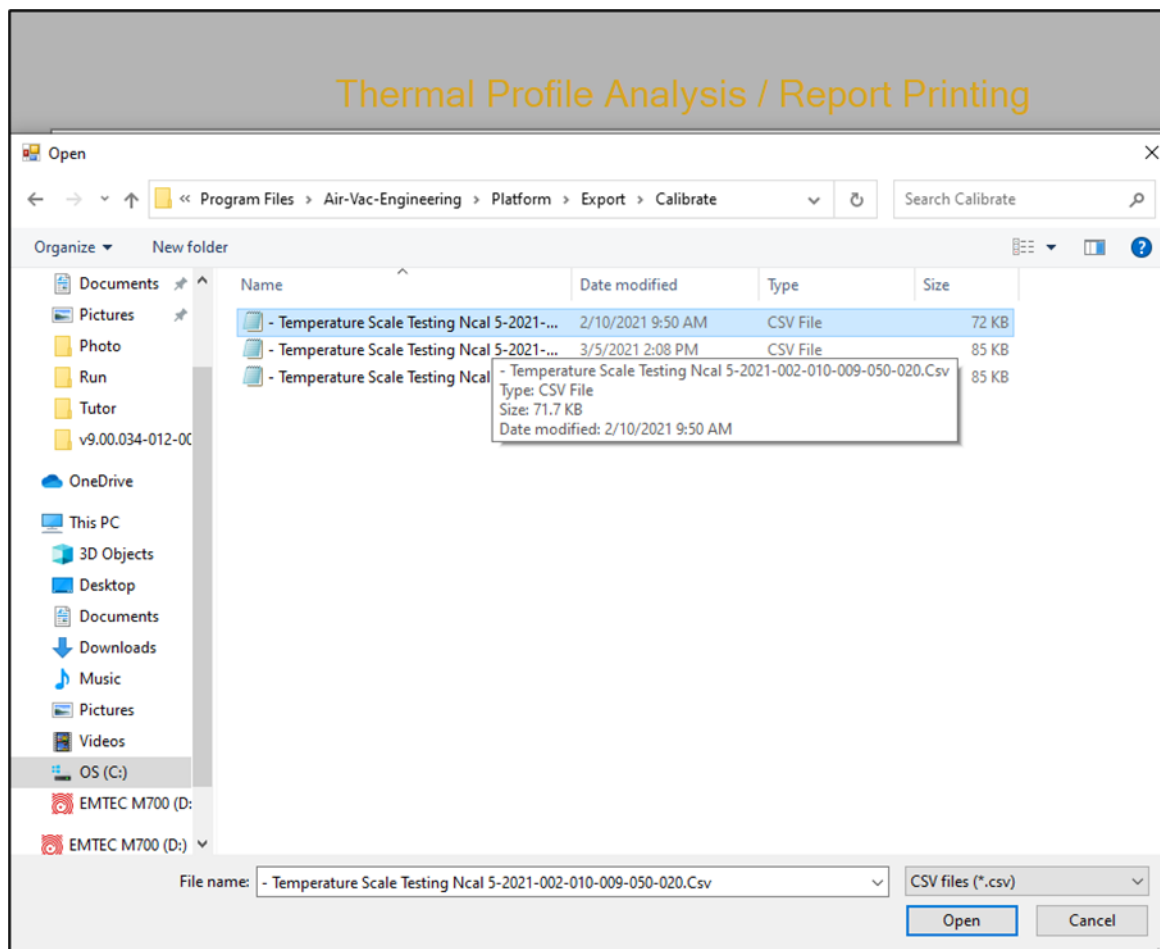
7. Verify your system is within acceptable range of plus/minus 10°C at any of the 100/200/300/400°C set point(s), by selecting **Control/Thermal Profile Analysis** from the main menu.



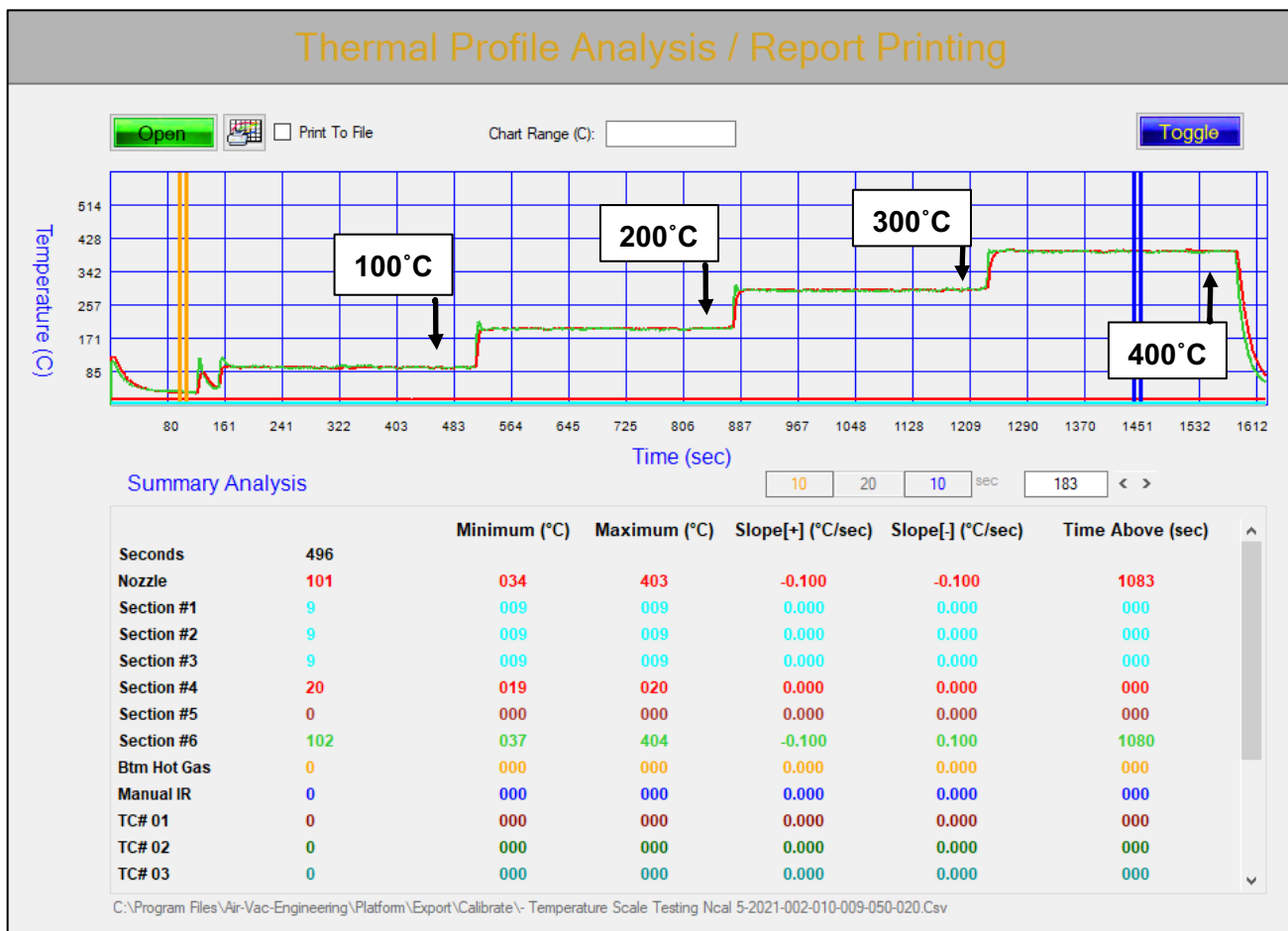
- Click on the green **Open** button (A).



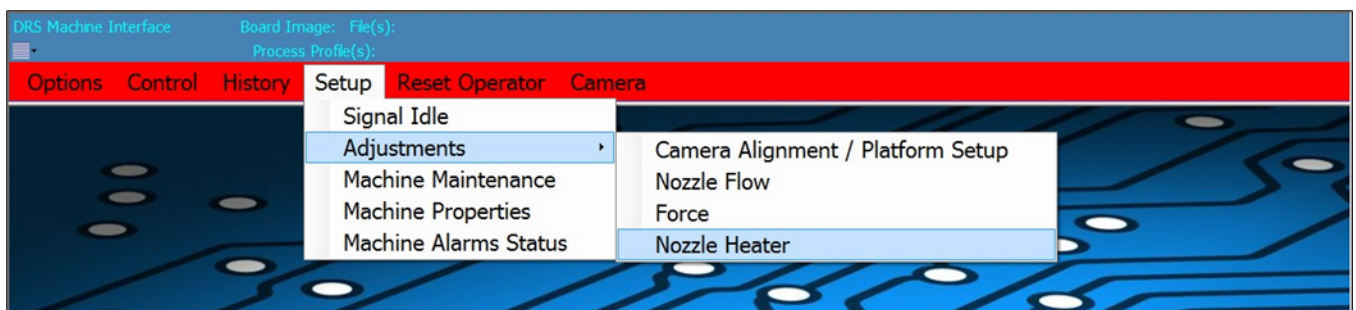
- Select the latest **Temperature Scale Testing Ncal-5** that you just ran.



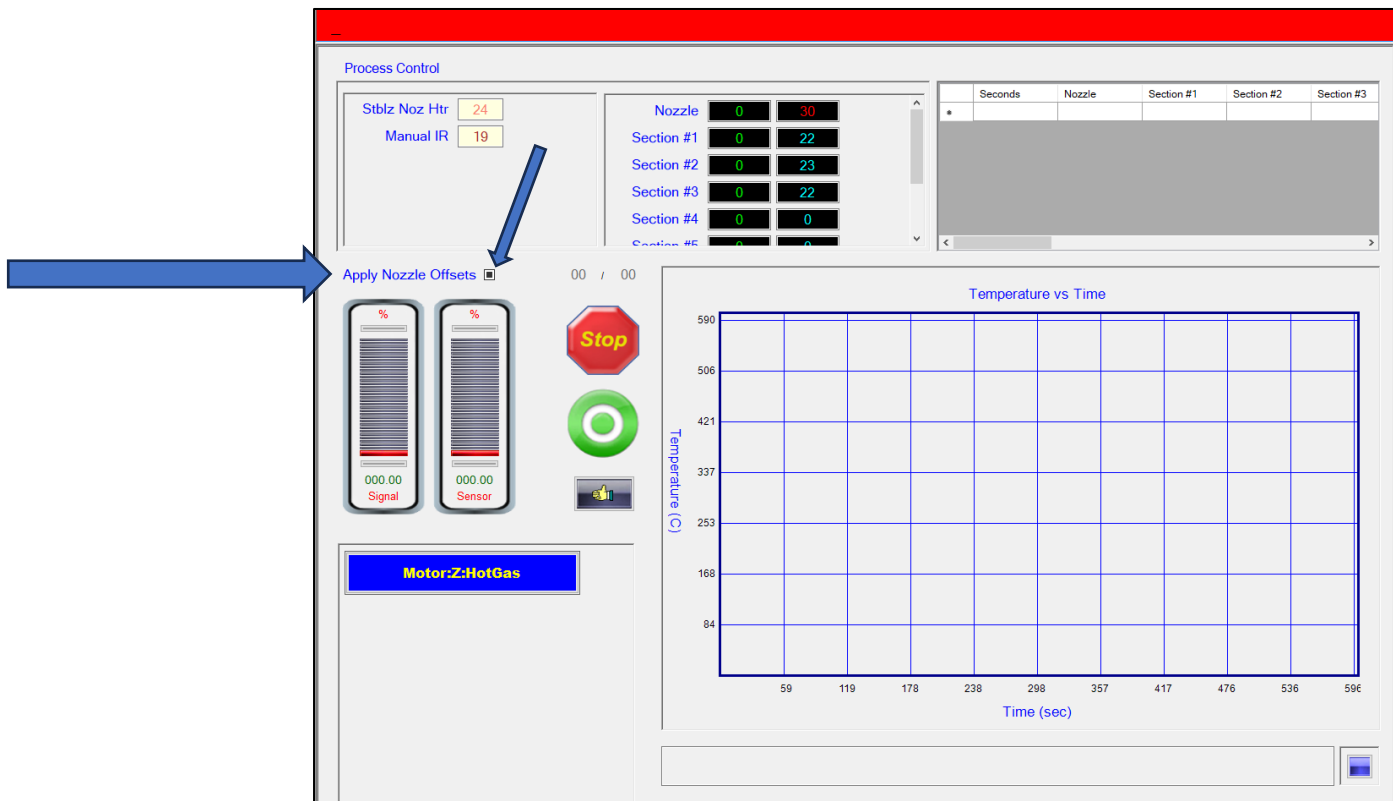
10. Move the cursor so that it points to the last few seconds of each level on the chart at 100°C, 200°C, 300°C, and 400°C.



11. The green Ncal5 temperature line at the four points should be plus/minus 10°C of the 100/200/300/400°C set points. If your temperature readings are within range at each temperature level, you are finished and you can thumbs-up to save results and leave the screen.
12. If the green Ncal5 temperature line is beyond plus/minus 10°C at any of the 100/200/300/400°C set points, you must re-run the thermal process. Right click on the Air-Vac logo to select the red hidden menu. Re-select **Setup/Adjustments/Nozzle Heater** from the main menu.



13. Be sure to change the RUN selection to APPLY NOZZLE OFFSETS (showing a solid box) in the upper left section of the screen, as shown here, before you begin.



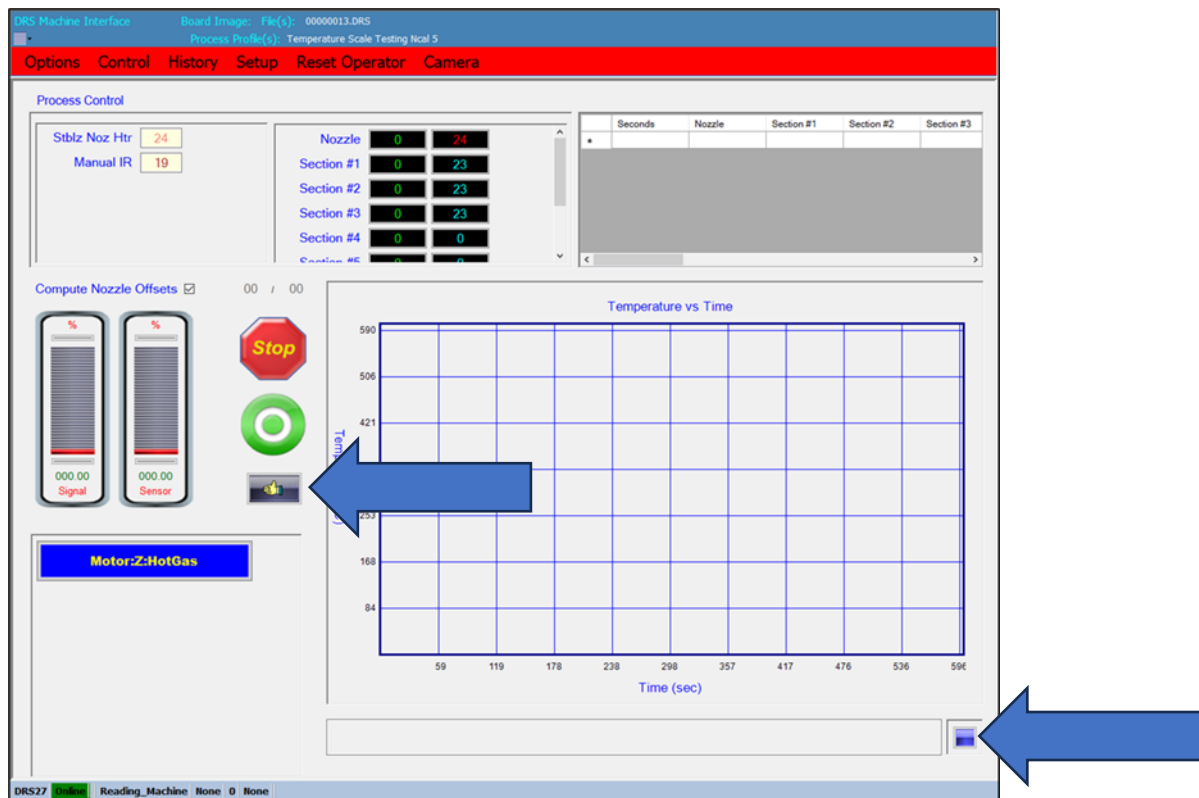
14. Begin the Nozzle Heater Temperature Verification again by clicking on the START ICON.



15. During this APPLY NOZZLE OFFSETS run, the software will *automatically adjust* the temperatures to be within the correct range.

The system will now perform 23 stages of flow and temperature levels. (this will take about 25- 30 minutes to complete).

16. When the process is complete, save your thermal results by clicking on the blue box **first**, then hit the THUMBS UP ICON to save the data.



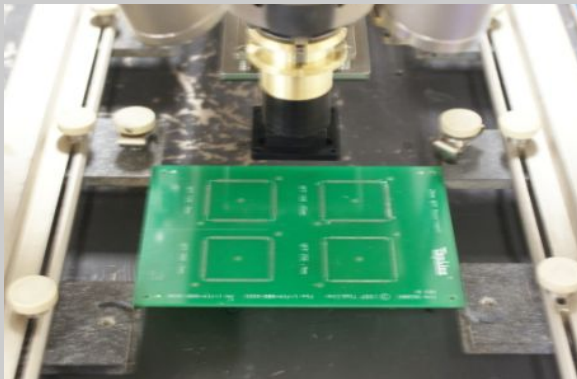
17. To view and confirm the upper heater temperatures are now within acceptable range, repeat steps 7 through 11. This will show the results of your last APPLY NOZZLE OFFSETS run.
18. This completes the **Nozzle Heater Temperature Verification**.

3.5 Vision Alignment Verification and Adjustment



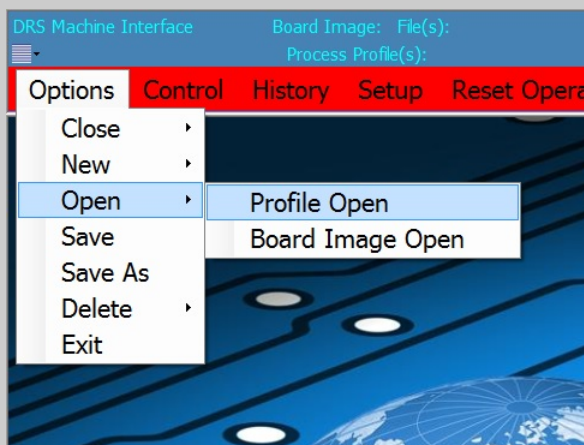
Vision Alignment Nozzle 1016.03.101

Vision Alignment Plate 1016.03.100

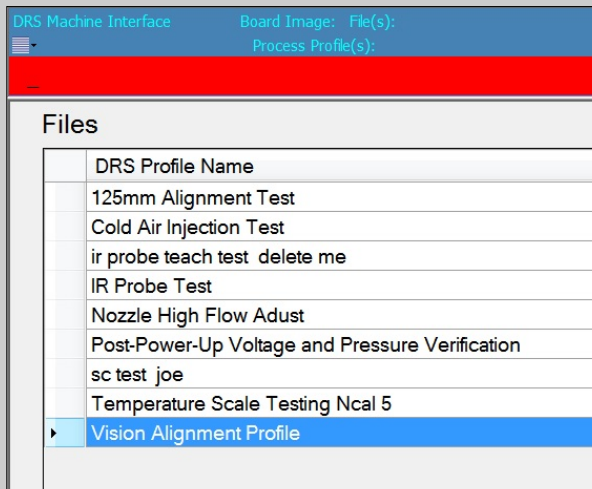


Load an unpopulated PCB into carrier.

Load Vision Alignment Nozzle into nozzle clamp.

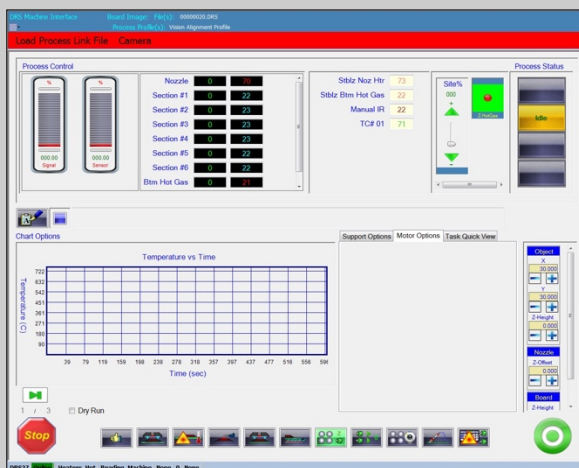


Select Options/Open/Profile Open from the Red Restricted menu.

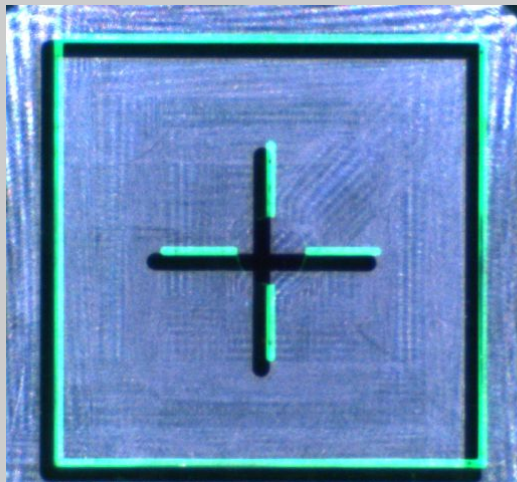


Select (Double click) the Vision Alignment profile.

Thumbs Up to continue to run screen.

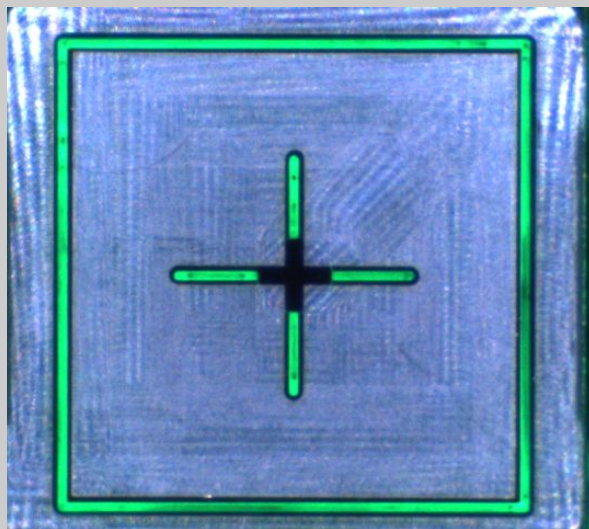


Click on the Green Cycle Start icon and follow prompts.



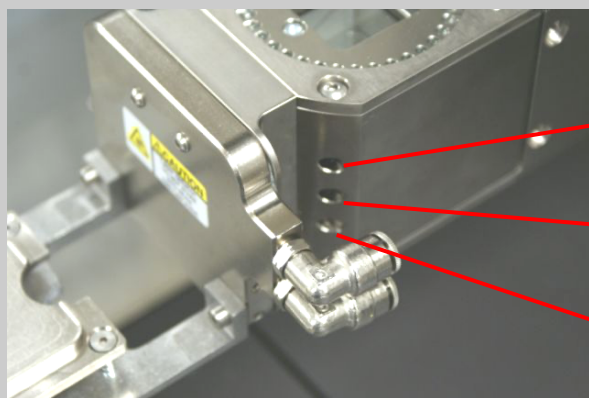
Shown is an image overlay of the Vision Alignment Nozzle and the Vision Alignment Plate. Note that the black lines do not match up with the green lines.

This indicates that an adjustment to the Vision System is required.



Use a 2mm Allen wrench to adjust the X and Y adjustment screws located on the right side of the vision assembly (see below). Adjust the image so that the green lines are centered as shown.

If it is not possible to center the green lines as shown, loosen the center lock screw slightly. Make X/Y adjustments as required and carefully tighten lock screw.



Y-Axis adjustment screw

Lock screw

X-Axis adjustment screw

Run the Vision Alignment Profile a second time to verify that the alignment is now correct.

4: Software Overview

- 4 **Software Overview..... 3**
- 4.0 WINDOWS TOOLS OVERVIEW..... 3
- 4.1 OPTIONS MENU FUNCTIONS..... 7
- 4.2 CONTROL MENU FUNCTIONS..... 21
- 4.3 HISTORY MENU..... 71
- 4.4 SETUP: 73
- 4.5 RESET OPERATOR:..... 77
- 4.6 CAMERA: 78
- 4.7 CAMERA VIEWS 79
- 4.8 PROTECTED SYSTEM SECURITY ACCESS:..... 82

4 Software Overview

NOTE

ACCESS TO MANY OF THE SOFTWARE SCREENS DETAILED IN THIS SECTION ARE RESTRICTED TO HIGH LEVEL USERS. OPERATOR LEVEL USERS CAN NOT ACCESS MOST OF THESE SCREENS.

4.0 Windows Tools Overview

DRS27 Software – Main Screen



Buttons:

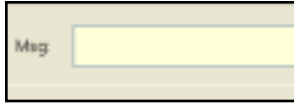


Ok / Exit Screen

Icon buttons are generally used to activate a procedure or function. Moving the cursor over the top of the icon and clicking on the left mouse button will initiate the button's functionality. Button icons have a popup message that will tell the operator what the purpose of the button is; this automatically occurs when the cursor is placed over the top of the icon.

Note:

IF A BUTTON IS COMPLETELY GRAY, THE FUNCTIONS ASSOCIATED WITH IT ARE DISABLED.

Edit Boxes:

Edit Boxes allow information to be entered by placing the cursor over the top of the box and clicking on the left mouse button. Characters are entered directly into the edit box from the computer keyboard.

Trackbar Buttons:

Trackbar Buttons are used to directly modify information within an edit box. Click and drag (using left button) slider to adjust the value in the edit box. Single increment adjustments can be made by single clicking on the range line or arrow. (tick marks - connected to the slider).

Boxes:

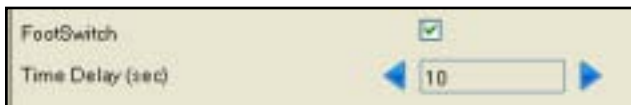
Check boxes are generally used to program a DRS25 function or activity.



Inactive Clear state: A blank check box indicates the Off or the inactive state.



Active Black state: A black check mark indicates the On condition or the active state.



For Example:

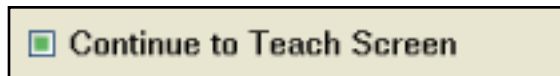
The footswitch mode is activated. The time mode and time delay value are not used.



Filled state: A filled box indicates a third option.

For Example: Clear – Continue to Main Screen. Checked – Continue to Run Screen.

Filled – Continue to Teach Screen.

**Radio Buttons:**

Similarly, radio buttons allow a functions or activities to be programmed. Typically, radio buttons are grouped together by related functionality. Within a group, only one option can be selected at a time.

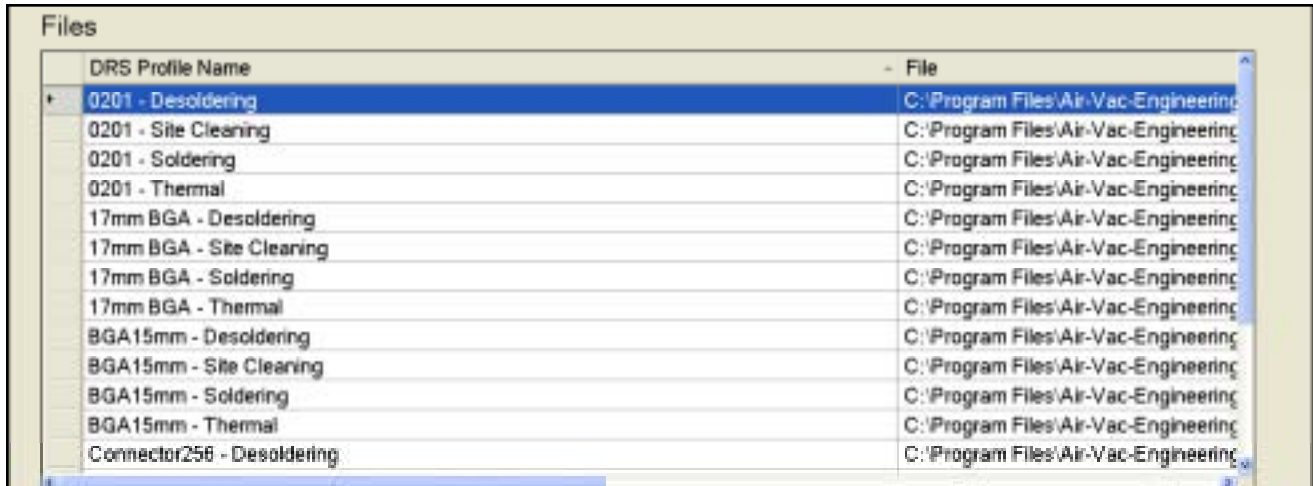


For Example:

The Time Function is selected. Time will run in the event for the value/time set in the box.

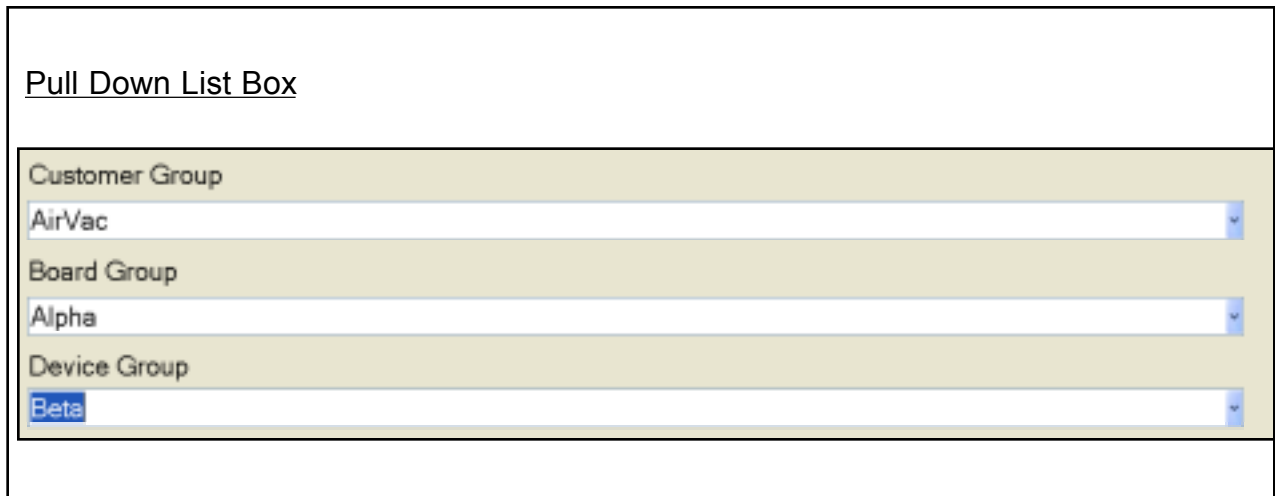
List Boxes:

A list box is a multiple line display of information. The operator can scroll through the list using the scroll bar to the right of the list box. The operator can select any line within the list by moving the mouse to that line and clicking (left button) on that line.



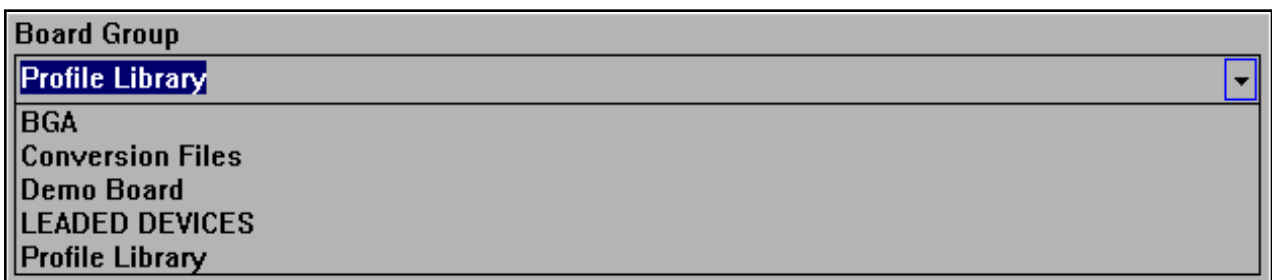
To select an entry, the operator can highlight the line (click) and then select the OK button (Up Thumb). The operator can also select an entry by double-clicking on the line.

A pull down list box is very similar to a full list box, except that this control is displayed on a single line and provides a pull down arrow. By clicking on that arrow the list box expands to display several lines of information on the screen. After making a selection, the list box collapses back down to one line.



For Example:

By clicking (left button) on the down arrow, the board group list box will expand to show more of the possible choices. The operator can select any line within the list box by simply clicking (left mouse) on that line. The edit box will return to its original state with the new selection being displayed.



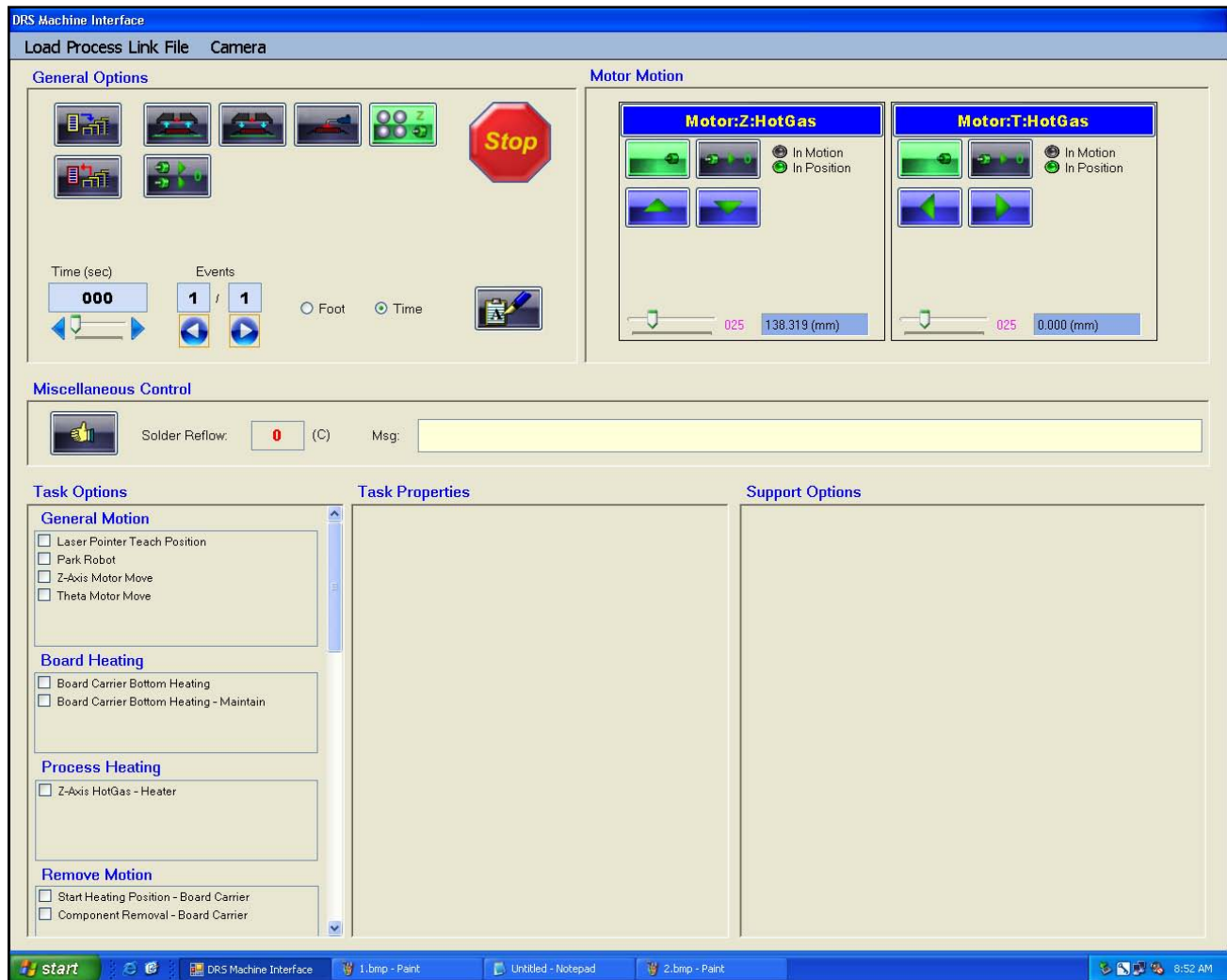
4.1 Options Menu Functions

View of the Options Menu



New (restricted access):

The **New** option, located on the **Options** menu, will automatically clear the current profile from memory and display the teach screen. The system is ready to teach a new profile.

**NOTE**

IT IS HIGHLY UNLIKELY THAT YOU WILL EVER NEED TO CREATE A NEW PROFILE FROM SCRATCH. THE **SAVE AS** AND **PROFILE BUILD** FUNCTIONS ARE TYPICALLY USED AND ARE EXPLAINED LATER.

Open:

The **Open** option is used to load an existing profile from a library. Selecting the **Open** option will display the **Open Profile** screen.

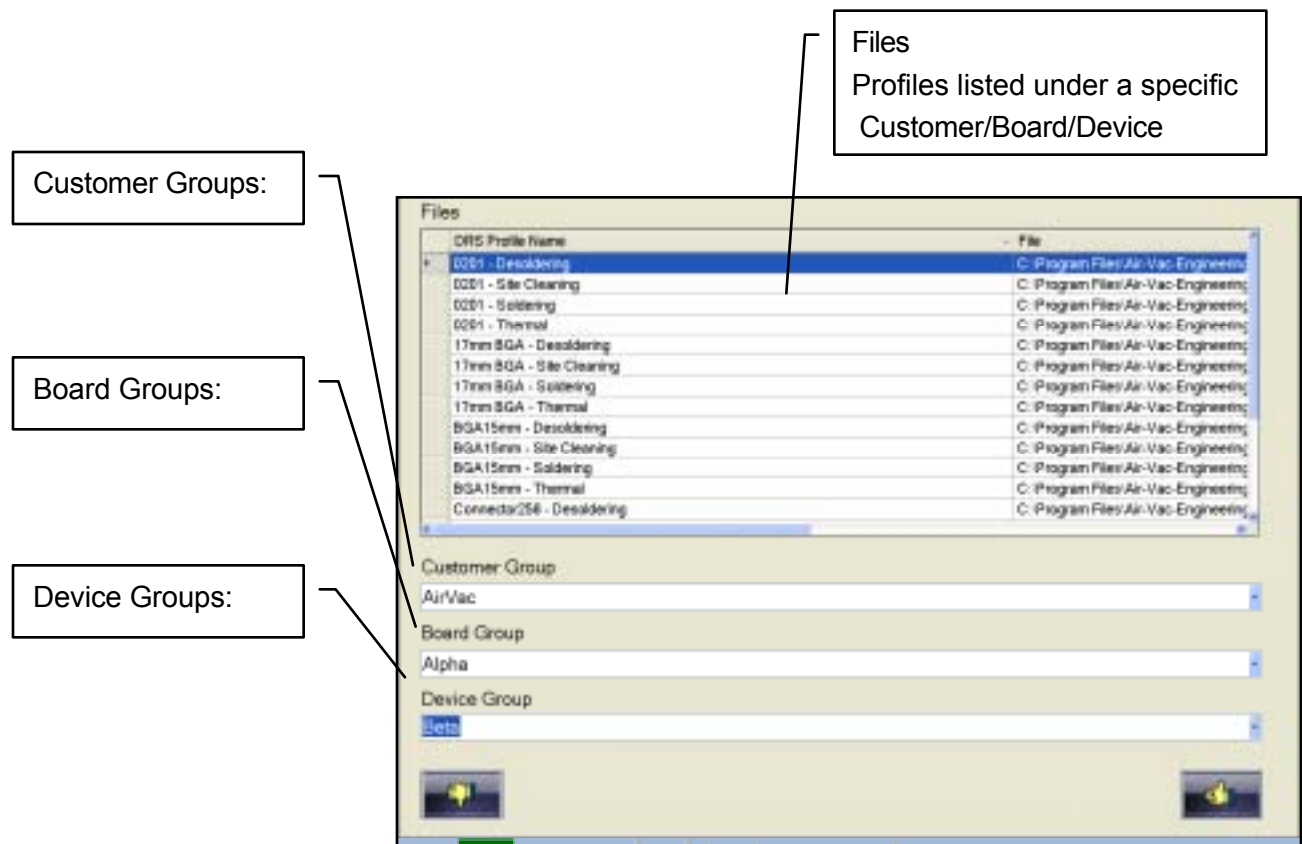
Three group categories are available to organize profiles into common or related processes:

- Customer
- Board
- Device

New groups can be easily added to expand the profile library organization.

The profile list can be adjusted by changing the group selection combination.

Clicking on the down arrow (of a group list box) will display a window with all the available options for that group. Use the scroll bar to view any additional entries beyond those that are currently displayed.



To make a profile selection, click on the desired entry (File list box), then, click on the Ok button to open this file or double click the File selected.

After selecting a file, the system will automatically take the operator to the **Open Profile Notes** screen.

38mm BGA - Site Cleaning :: C:\Program Files\Air-Vac-Engineering\Platform\Profiles\9999047.DRS

Camera

Application Notes

Description: SITE CLEANING:

Component:

Location:

Flux Type:

Nozzle #: enter tip size if different than "large" tip

Notes:

- Install Board (position board supports, if necessary)
- Thermocouple Must Be Plugged Into Thermocouple Channel #1



☒ Continue to Run Screen ☐ Default Reflow 183 217

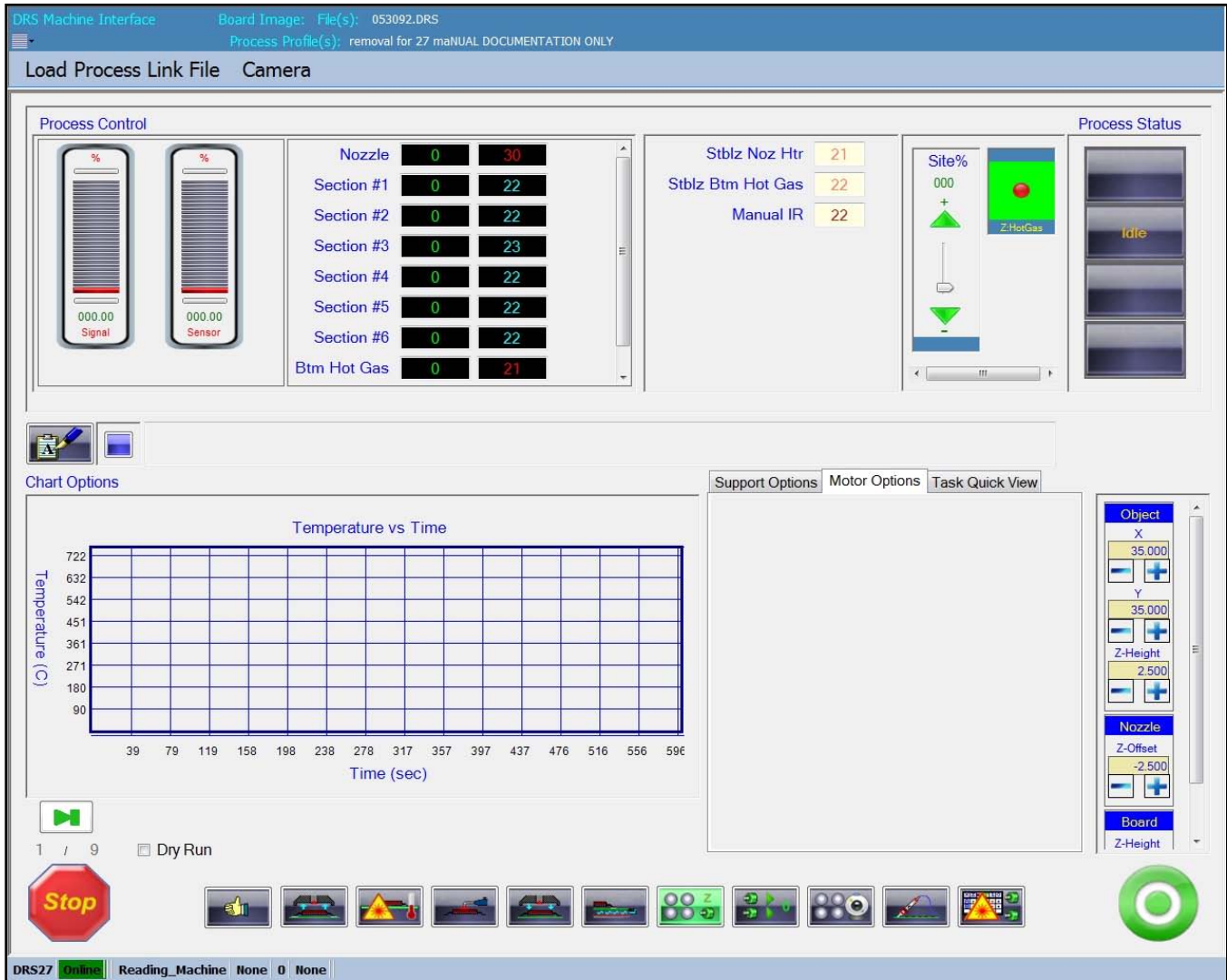
This screen is used to display general setup or process related information. Clicking on the **Ok** button will take the operator to the **Run** screen.

Note

HIGH PRIORITY USER HAS THE OPTION TO CLICK ON THE CONTINUE TO RUN SCREEN BOX TO ADVANCE TO THE MAIN MENU – CLEAR BOX OR TEACH SCREEN – FILLED BOX.

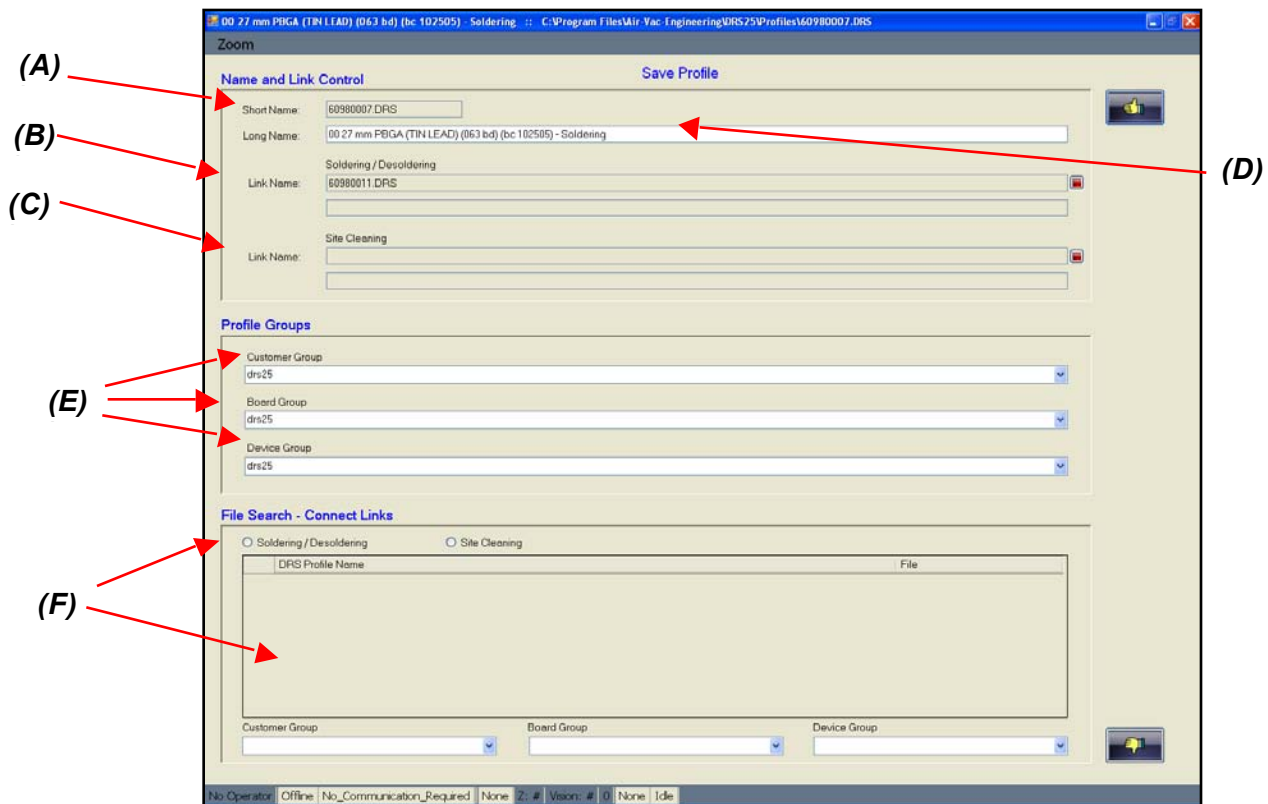
 Continue to Teach Screen

This screen allows the operator to process an application. In general, this screen provides the operator with messages, heating and flow rate information, thermocouple readings and the overall progress of the cycle. Please see the **Run** screen section for detailed information.



Save (restricted access):

The **Save** option is used to save a new profile or re-save an existing profile.



- Short Name:

The **Short Name** (A) is used to uniquely identify the profile. The **Short Name** is automatically generated and is composed of two separate elements. The first four characters of the **Short Name** are taken from the DRS27 machine serial number. The remaining numbers represent a sequence number. This sequence number changes as new profiles are saved. The file extension for all short file names must be [.DRS].

- Link Name – Soldering/Desoldering:

A soldering/desoldering link (B) allows the operator to quickly open a related profile (soldering or desoldering) without leaving the **Run** screen. The **Link Name** is not automatically generated. The **Link Name** identifies (points to) a previously created profile with process related functionality. Typically, a soldering profile has the desoldering **Short Name** entered as the Link Name.

- Link Name – Site Cleaning:

After the component has been removed, a **Site Cleaning** profile (C) is generally cycled to remove the excess solder from the site. The **Link Name** is not automatically generated. The **Link Name** identifies (points to) a previously created profile with process related functionality. Typically, a desoldering profile has the site cleaning **Short Name** entered as the **Link Name**.

- Long Name:

The **Long Name** (*D*) is used to describe the overall function (purpose) of the profile. Long names are used by the **Open** option to help the operator accurately select a profile. The **Long Name** can be up to 60 characters long. The **Long Name** is not automatically generated. The operator must enter this information.

Warning:

CAREFUL NOT TO ENTER (EXACTLY) A LONG NAME THAT ALREADY EXISTS. THE SYSTEM WILL ALLOW IDENTICAL LONG NAMES TO EXIST IN THE PROFILE LIBRARY.

- Customer, Board and Device Group:

These groups (*E*) allow profiles to be organized using a combination of customer, board and device name. New groups can be easily created (see **Setup – Group**). Categorizing profiles by group can significantly improve the ability to find the correct application profile.

- File Search:

These controls allow the user to interactively search for the necessary file links. The group drop-down list boxes can be used to help the operator filter file listings.

When the user clicks on the thumbs up button to save a profile, the system may notify the user about the pending activity



To complete the save, click on the **Ok** button.

When the user completes the save function, the system will automatically return to the main menu.

Save As (restricted access):

The **Save-As** option functions very similar to the **Save** option, however, the **Save-As** option also allows the user to make a copy of an existing profile. The Short name is always automatically updated (incremented) to the next available sequence number (see the **Save** option).

- The user can change the long name to reflect the new functionality of the profile.
- The user has the option to move the new profile to a different group.
- New link names can be added at any time.

The **Short Name** will automatically be updated with a new, unique name.

The user should edit the **Long name** to reflect the new functionality of the profile.

The **Link Names** for Soldering/Desoldering and Site Cleaning will automatically be cleared.

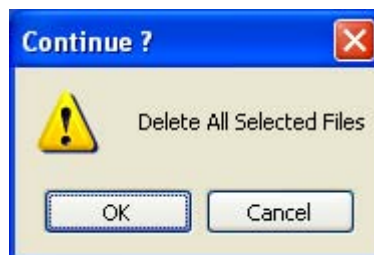
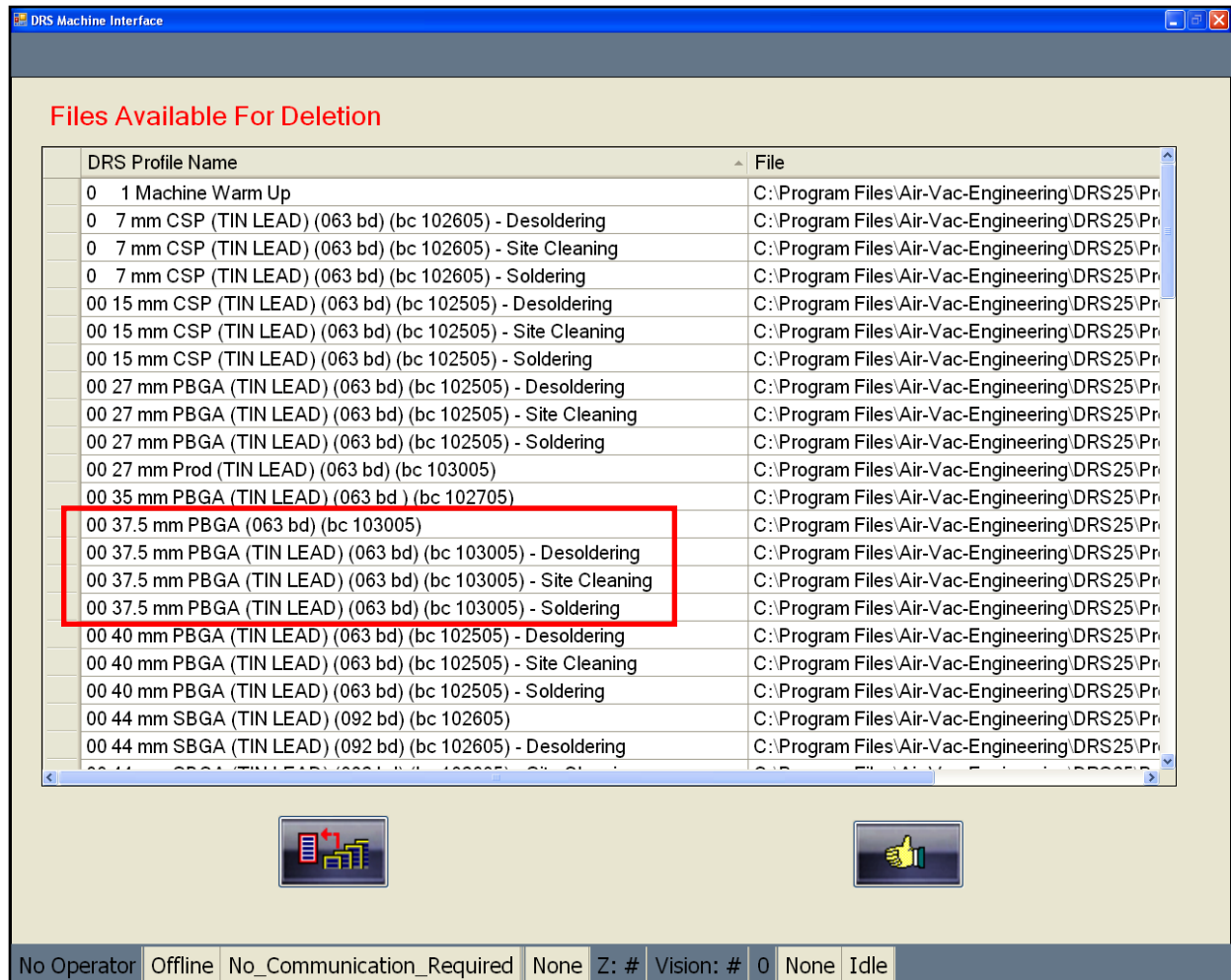
Note:

THE ORIGINAL PROFILE REMAINS UNCHANGED AND COMPLETELY INTACT.

THE USER SHOULD BE CAREFUL NOT TO ALLOW (EXACTLY) A LONG NAME THAT ALREADY EXISTS. THE SYSTEM WILL ALLOW IDENTICAL LONG NAMES TO EXIST IN THE PROFILE LIBRARY.

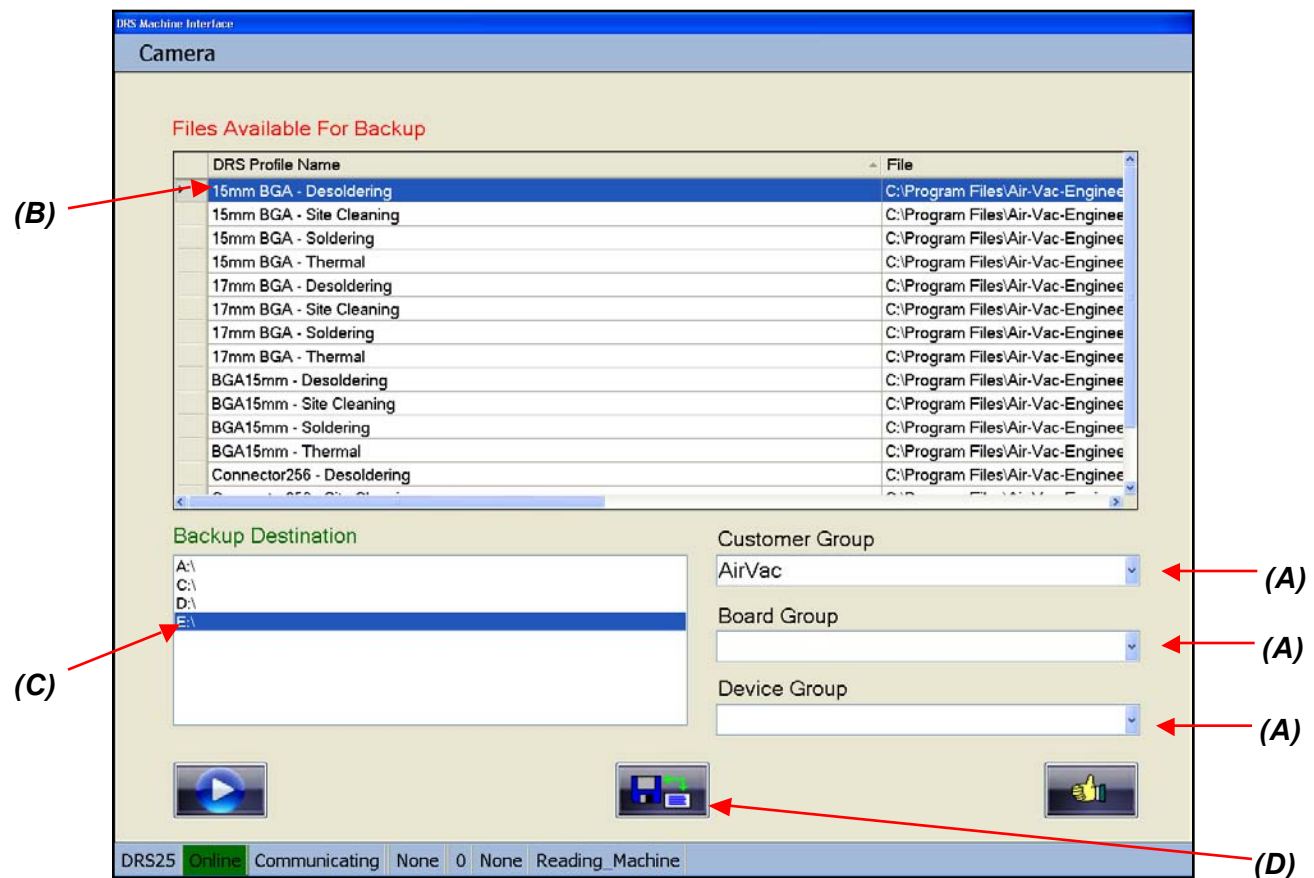
Delete Profiles (restricted access):

The **Delete Profile** screen allows the user to delete files based on the Long Name (similar to the **Open** option). The user will be prompted before any files are removed.

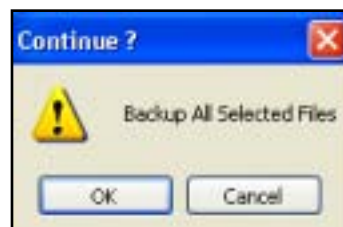


Backup (restricted access):

The Backup option allows profile(s) to be copied on USB Memory Storage Device.



- (A) Select the Customer, Board and Device group of the profile(s) to be backed up.
 - (B) Select the profile(s) to be backed up (one or more).
 - (C) Select the USB Memory Storage Device for the profiles to be backed up to. (Plug into computer)
 - (D) Click on the backup icon to backup.
- Click on Ok when asked to continue.
The profiles have been copied.



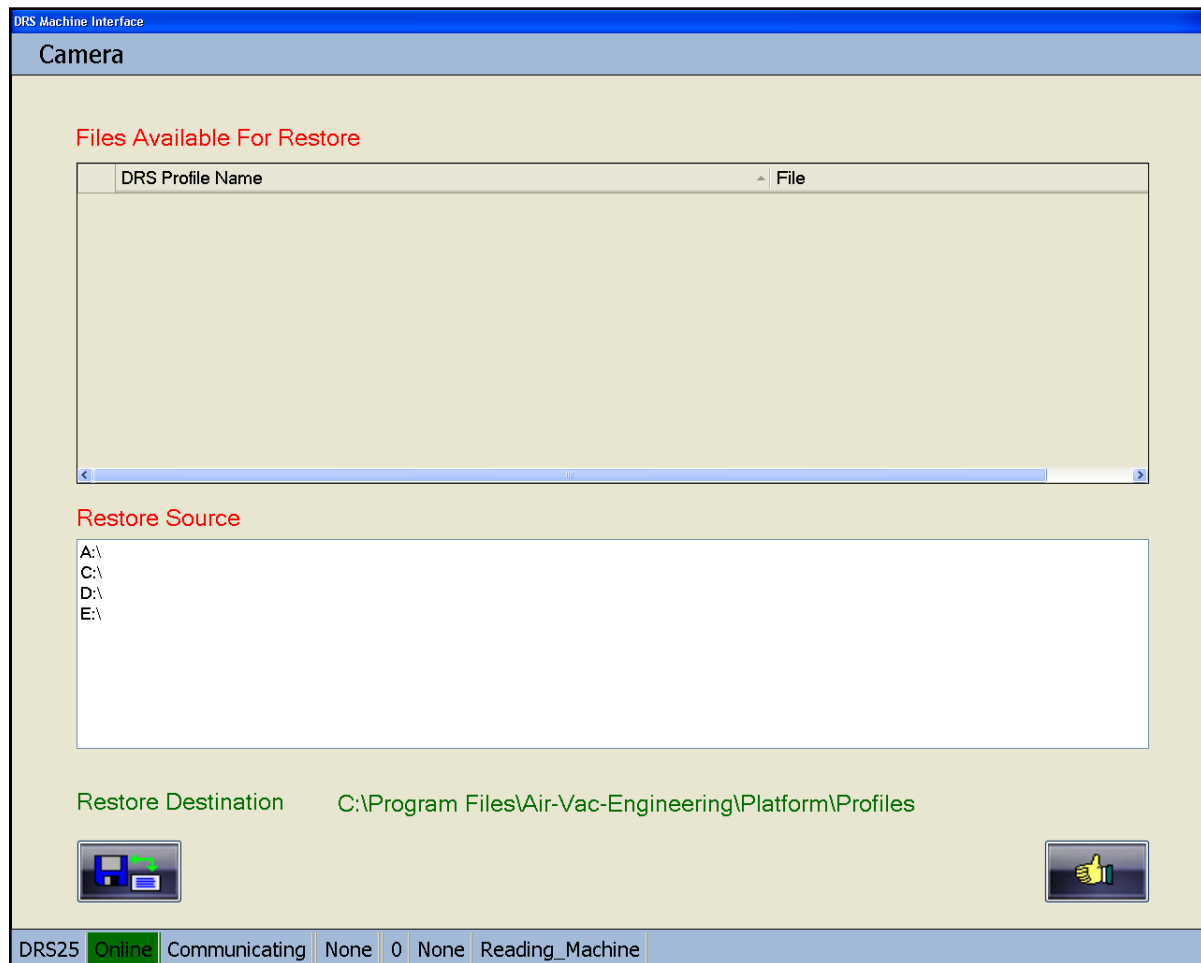
The triangle icon allows all the profiles of the machine to be accessed regardless of Customer, Board or Device group.

Select all profiles buttons.

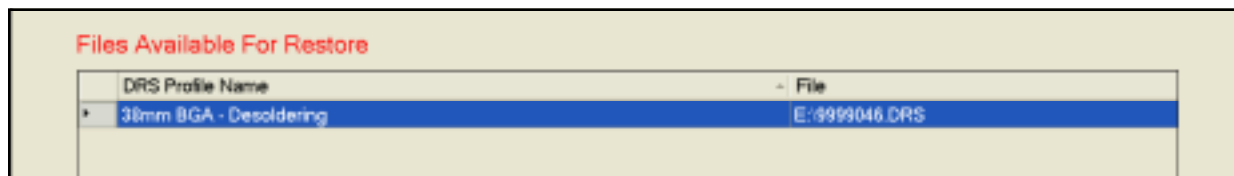


Restore (restricted access):

The Restore option allows profile(s) to be restored from a USB Memory Storage Device.



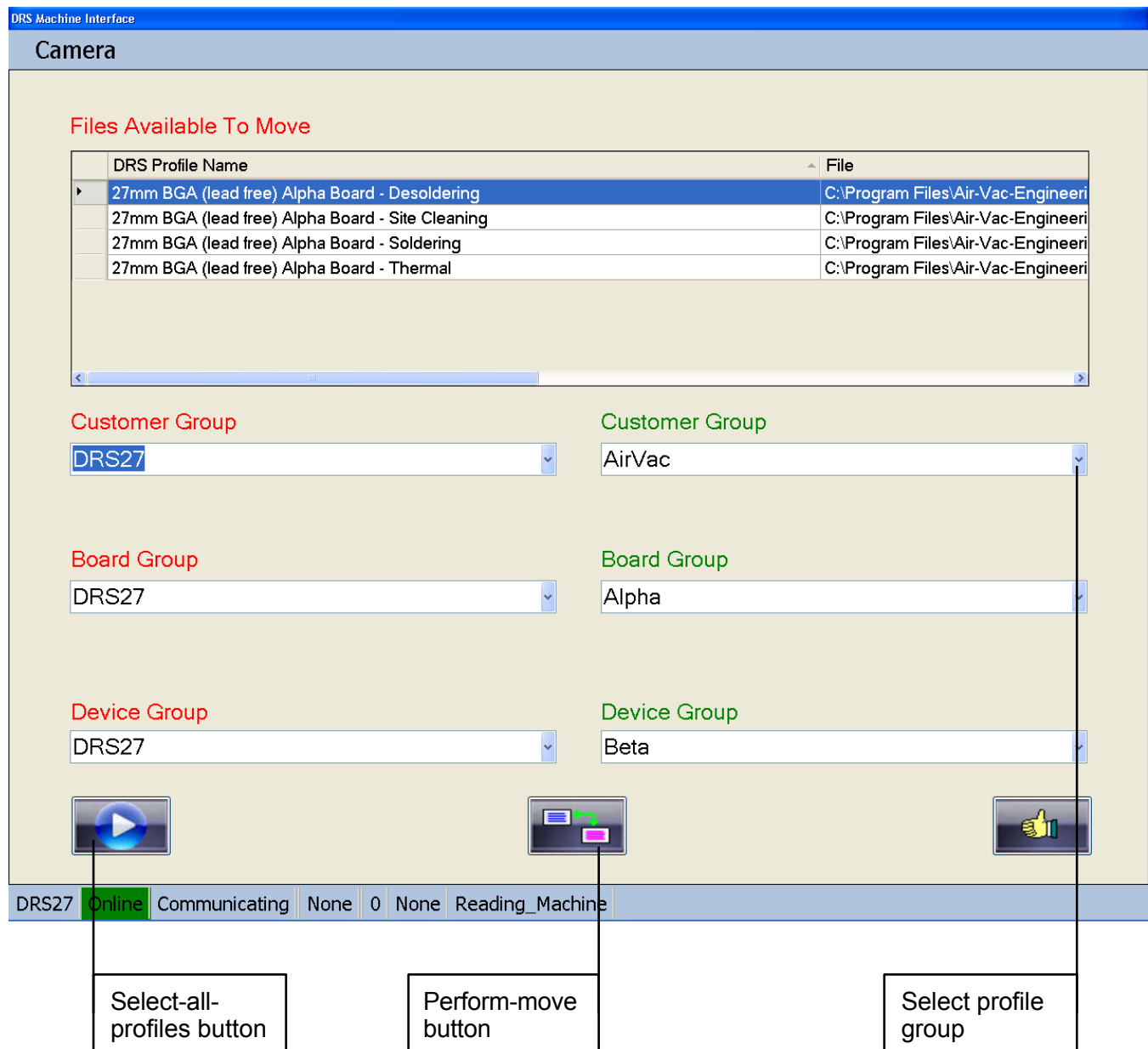
Select the Restore source. The files available for restore will appear.



Click the restore icon.



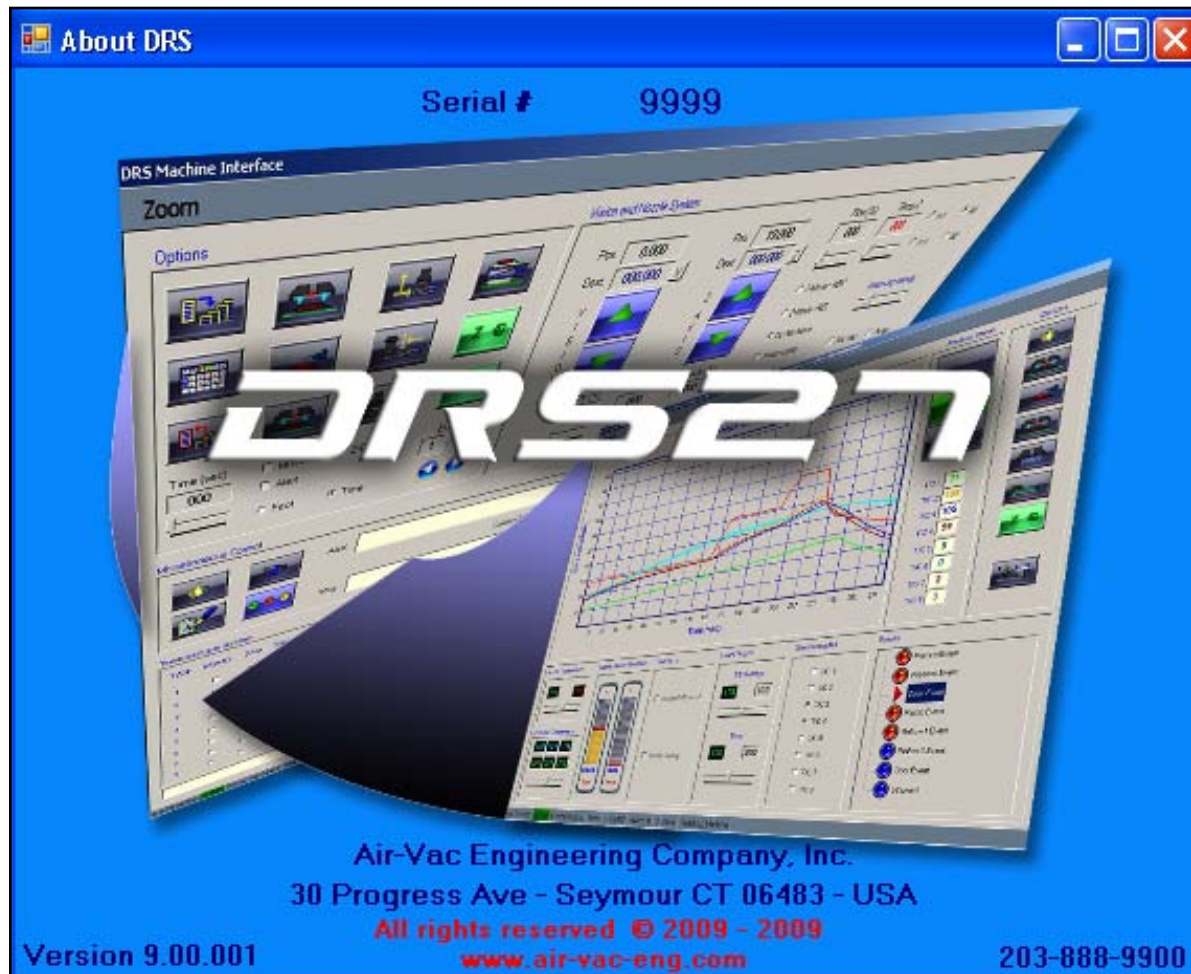
The profiles have been restored to the DRS27 in the appropriate customer, board and device group.

Move Screen (restricted access):**Procedure for moving profiles:**

1. Select a target profile or click on the select-all-profiles button.
2. Highlight (left single click) profile long name(s) (multiple selections allowed).
3. Select a destination profile group.
4. Click on perform move button.

About DRS (restricted access):

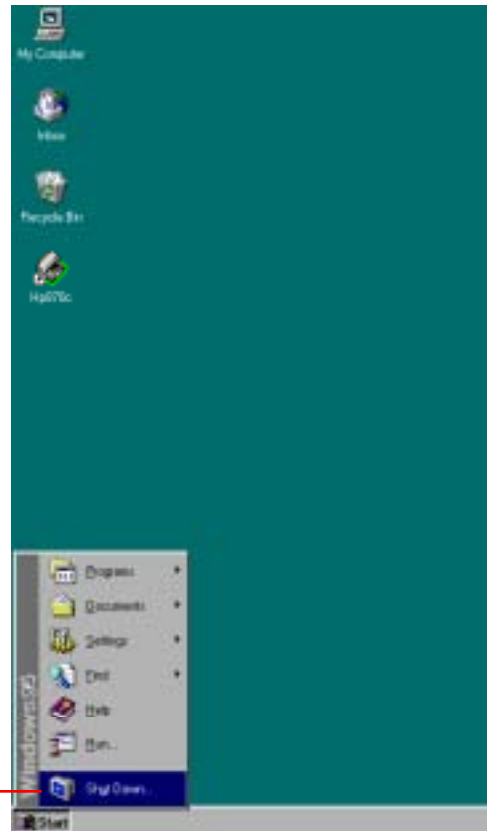
The **About** screen contains general information about the current software version.



Exit:

It is ***very important*** to shutdown the DRS27 system correctly. Click on the **Options** menu and select the **Exit** option. This will close the DRS27 software and shut down any active devices (vacuum, air flow, etc). The **Windows Desktop** screen will be displayed.

Click on the **Windows icon** menu located in the lower left corner of the screen. Then click on **Shutdown**.



4.2 Control Menu Functions

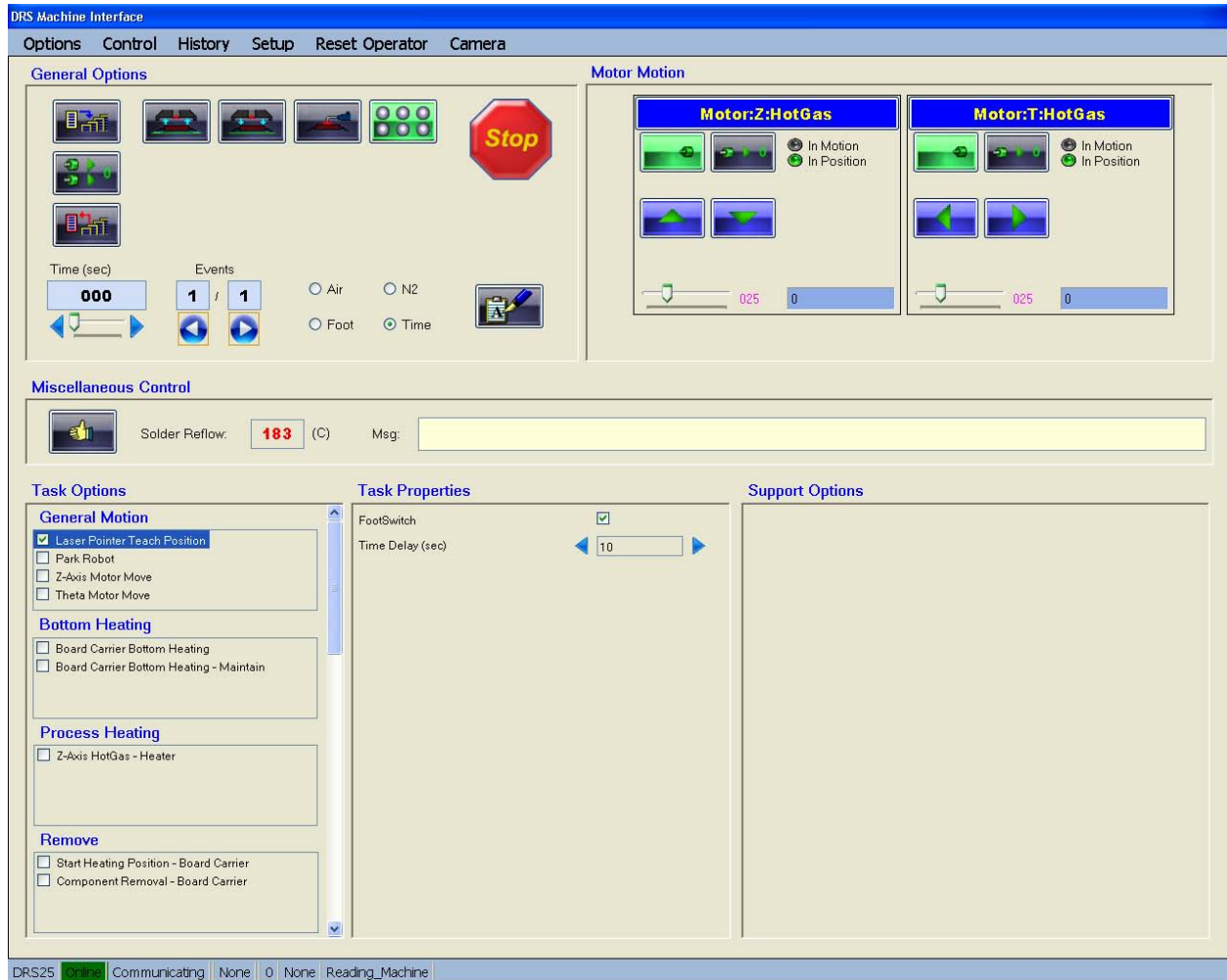
View of the Control Menu



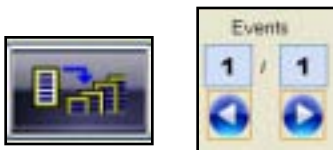
Teach Process Events (restricted access): Programming Functions

Selecting the **Teach Process Events** option (from the **Controls** menu) will present the user with the **Teach** screen. Events can be added or deleted based on the application's processing requirements.

Teach Process Events: Programming Functions



The Teach screen allows multiple Task Options to be processed in a single event. The Task Options have programmable Task Properties to provide process flexibility. The Task Options will be activated in order from the top to the bottom of the Task Options list.



The Event Insertion Icon adds events to the program.

All z-axis motion for task option processes are based on:

- Nozzle height, Component height, Board carrier height, and Feeder height

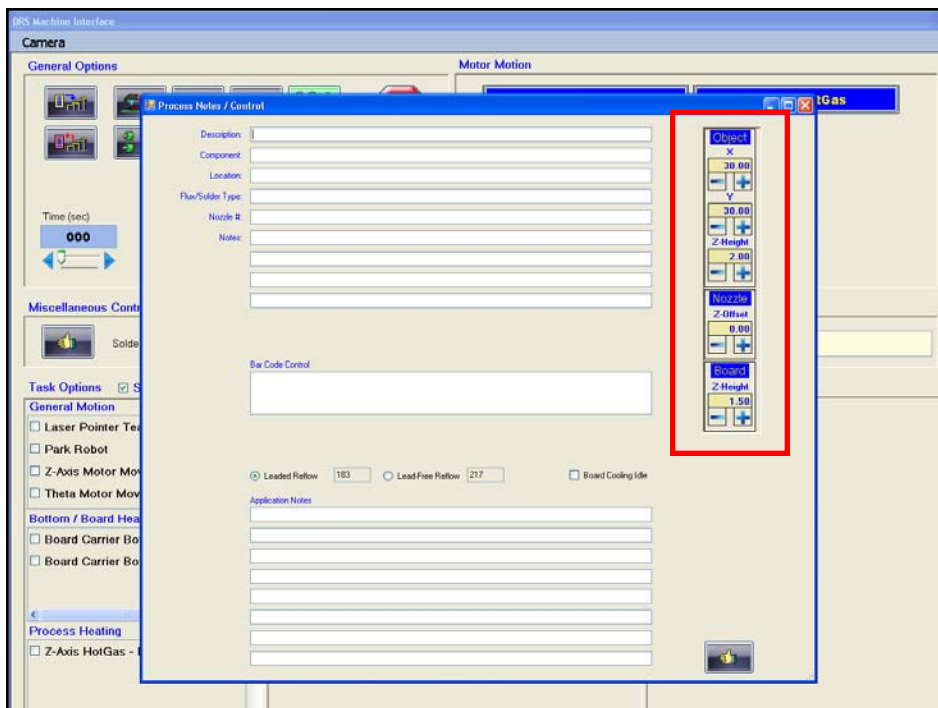
It is vital that those parameters be set correctly.



Process Notes / Control

Provides process information to the operator. This information is made available to the operator during the Run cycle.

Click on the Process Note/Control Icon to access Process Notes/Control screen.



Sets critical component and z-axis set up parameters for all motion functions.

Process Notes / Control

Description:

Component:

Location:

Flux/Solder Type:

Nozzle #:

Notes:

Text: Type pertinent information for program.

For example:

Component: BGA256

Location: U47

Nozzle #: N27EZ27

Notes: Install board with connector in front

The screenshot shows a vertical menu of settings. The 'Object' section has three parameters: X (30.00), Y (30.00), and Z-HEIGHT (2.00). The 'Nozzle' section has one parameter: Z-OFFSET (0.00). The 'Board' section has one parameter: Z-HEIGHT (1.50). Each parameter is displayed in a blue box with a white background and a blue border, with blue arrows on either side for adjustment.

Section	Parameter	Value
Object	X	30.00
	Y	30.00
	Z-HEIGHT	2.00
Nozzle	Z-OFFSET	0.00
Board	Z-HEIGHT	1.50

Object:

X: Defines component width (mm). Dimension is applied to camera view (corner and edge) during component alignment in vision.

Y: Defines component depth (mm). Dimension is applied to camera view

Note: Reducing the x and y object dimension will shift the corners of object during alignment viewing which may provide viewing of a larger corner area.

Z-Height: Defines component height (mm).

Nozzle:

Z-Offset: Defines nozzle height in relation to 66 mm standard nozzle. For example, the standard EZ nozzle measures 62.5 mm. The offset is -2.50 mm. The standard site cleaning nozzle is 70.0 mm. The offset is +4.00 mm.

Board:

Z-Height: Defines the board height. If the board does not rest on the carrier, i.e., assembly has a frame and board is raised, then, the height of the board in relation to the board carrier edge supports is the z-height dimension.

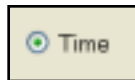
Critical: Object and board z-height and nozzle z-offset are used in calculation of z-axis movements. It is critical not to input undersized parameters.

Teach Screen: Basic Programming Functions

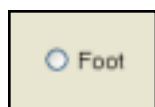


Events:

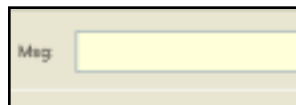
Indicates the current event of the Teach screen. The total number of events will be shown. The up/down arrows are used to go to specific event.



Time: Indicates time for the event. Time is programmed in the Time (sec) box. The slide bar or typing in the box will change the setting.



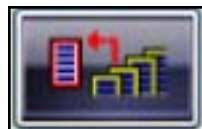
Foot: Indicates footswitch based event. Event will not advance in run screen until operator presses the footswitch. The time is limited to 10 minutes.



Msg: Message box provide operator information for event on run screen.



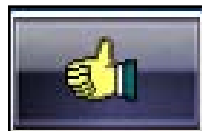
Event Insertion Button: The Insert event button allows the operator to temporarily add a new event in between two existing events. The inserted event will be an exact copy of the current event. The inserted event will be added ahead of the current event.



Event Delete Button: The Delete event button is used to temporarily remove the current event.



Light Icon: Turns on machine lights for event.



OK / Thumbs Up Button: Will exit the Teach screen and return to the Main screen.

Active Icons in the Teach Screen:



Home Icon: Retracts z-axis to top position. Retracts vision axis to the rear position.



Stop Icon: Stops z-axis and vision axis motion.



Motor: Z :Hot Gas / Motor: T :Hot Gas

Motor: Z : Controls z-axis, **Motor : T:** Controls theta axis



Motor On/Off Icon: Indicates z-axis motor is active.



Motor Theta Icon: Indicates theta motor is active.

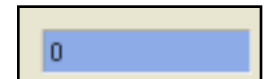


In Motion: Indicates z-axis or theta motor is in use.

In Position: Indicates z-axis or theta motor is at the position.



Up/Down Arrows: Used to activate motor

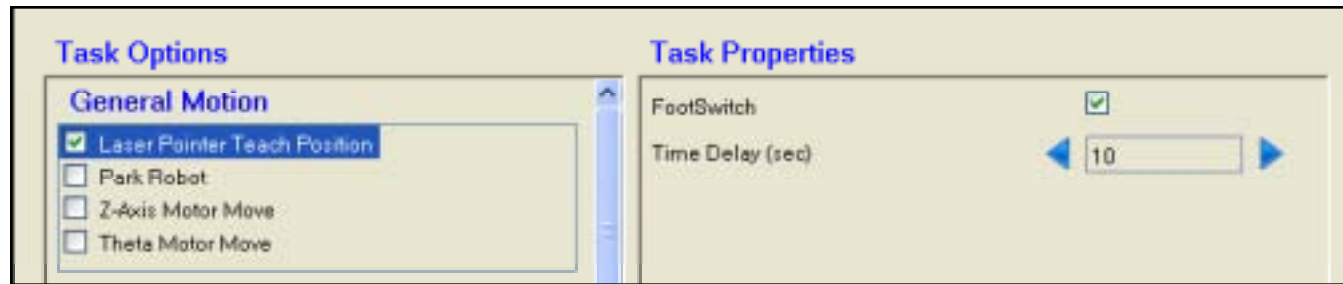


+/-1 Box: Sets velocity of motor

Blue Box: Displays the position of the z-axis

General Motion

Laser Pointer Teach Position



Function: Provides operator a light (spot) reference to locate center of z-axis motion. For:

Removal: Center of component to remove.

Site Cleaning: Start position of heating cycle.

Soldering: Center of placement site.

Action: Vision system extends. Laser pointer located under vision system is activated. The laser pointer message "Locate Target Site Using Laser Pointer" is then shown on the run screen. The operator moves the laser pointer to the site and presses the footswitch. The vision system retracts.

Task Properties:

Footswitch: Allows laser light to be on until footswitch is depressed.

Delay (sec): Sets time mode and time for laser pointer to be activated during process.

Park Robot



Function: Positions nozzle and vision system away from work area.

Action: Retracts z-axis to top position. Retracts vision axis to rear position.

Task Properties:

None

Z-Axis Motor Move

Task Options	Task Properties
General Motion ☐ Laser Pointer Teach Position ☐ Park Robot ☒ Z-Axis Motor Move ☐ Theta Motor Move	Position Height (mm) 50.00 Velocity (%) 100

Function: Positions nozzle height.

Action: Nozzle moves to set height (position height) relative to board carrier at the designated speed (velocity).

Task Properties:

Position Height (mm): Distance of nozzle in reference to board carrier position.

Velocity (%): Speed of z-axis, 0-100%.

Theta Motor Move

Task Options	Task Properties
General Motion ☐ Laser Pointer Teach Position ☐ Park Robot ☐ Z-Axis Motor Move ☒ Theta Motor Move	(+) Theta Move (deg) 0 (-) Theta Move (deg) 0

Function: Rotates nozzle to shear bonded components from board.

Action: Nozzle rotates clockwise (+ theta move) and counterclockwise (- theta move). Can allow multiple cycles (loop sequence) (loop attempts).

Task Properties:

(+) Theta Move (deg): Nozzle rotates clockwise to set angle.

(-) Theta Move (deg): Nozzle rotates counterclockwise to set angle.

Process Heating

Z-Axis Hot Gas - Heater

Function: Turns on or off the upper heater.

Action: The air flow (flow control) and temperature are selected. The upper heater is activated.

Task Properties:

Flow Control (%): Controls the air/nitrogen flow from the mass flow controller to the upper heater (20-100%). The settings generally correspond to the nozzle size. Recommended flows:

Nozzle Size (mm)	Heater Flow (%)	
Less than 10*	30	*For MNX nozzles set the flow to 60%
10-15	40	
16-26	50	
27-30	55	
31-34	65	
35-40	75	
40+	85	

Use Heater By-Pass Control: Indicates by-pass system is activated. Ambient air flows through the nozzle by passing the heating element. Generally, used to cool component, package and joints in the replacement program after peak reflow temperature is reached. This minimizes/controls the time from reflow 1 (peak temperature) to end of reflow 2 (just below melting temperature).

Temperature (° C): Sets the upper heater temperature.

Wait For Heater In-Position: Indicates wait for heater in-position function is activated. A separate thermocouple in the heater can be used to insure the temperature programmed is reached prior to a process.

In-Position Delay (sec): Used in conjunction with wait for heater in-position. Indicates the time after the temperature is reached prior to a process.

Use Heater Ramp: Indicates use heater ramp function is activated.

Ramp (° C): Used in conjunction with ramp. Indicates the programmed rate (° C /sec) for the heater.

Note: Heater will be activated until programmed to be turned off.

Use Stabilizing Option: Activates the stabilize function to heat or cool down to z-axis head.

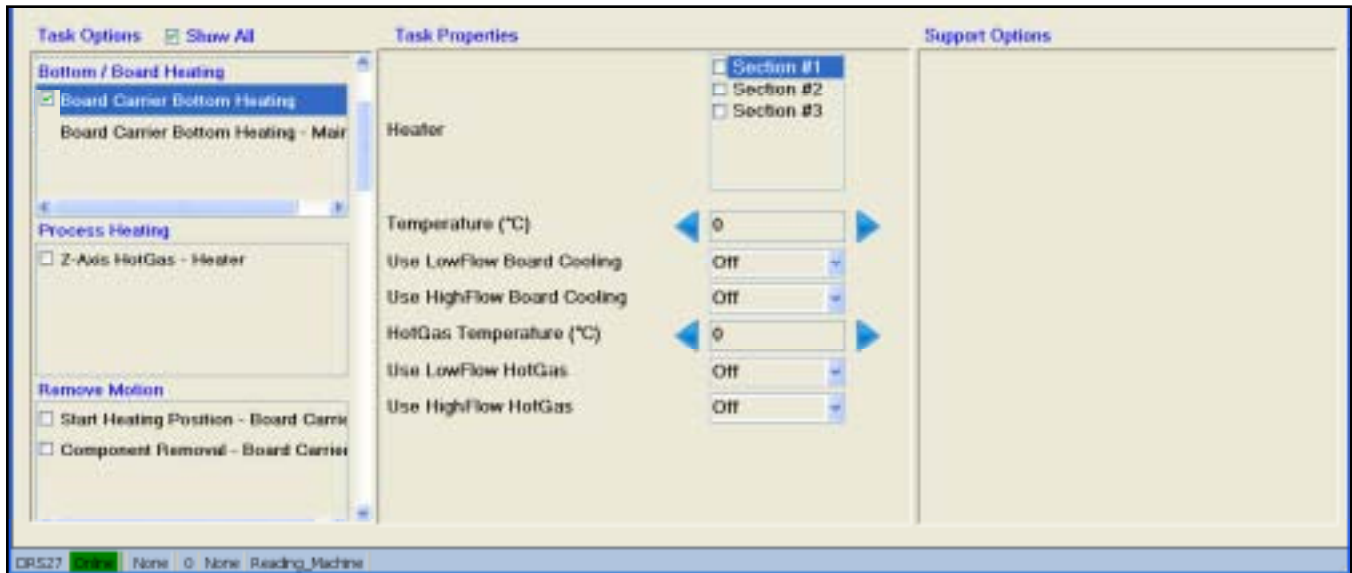
Stabilize Channel/Nozzle Heater Stabilize: Activates thermocouple attached to heater head.

Stabilize Temperature (°C): 90° default. Sets temperature heater head. Go to (up/down) prior to event time activated (for heater).

Stabilize Delay (sec): 600 default. Sets maximum time allowed for Stabilize Temperature to occur. 600 second default allows 0 minutes for stabilize process to occur.

Bottom/Board Heating

Board Carrier Bottom Heating



Function: Activates bottom heaters and board cooling system.

Action: Bottom heater sections (heaters) can be selected to be activated to the target temperature (Temperature). Spot heaters can be activated to target temperature (HotGas Temperature). Flow can be set for low flow (Use LowFlow HotGas – On), high flow (Use HighFlow HotGas – On), and extra high flow (Use LowFlow HotGas – On and Use HighFlow HotGas – On). Board cooling system can be set to low flow (Use LowFlow Board Cooling) or high flow (Use HighFlow Board Cooling).

Task Properties:

Heater: Any or all section #1-#3 can be selected to be selected to be activated (#1 in front).

Temperature (°C): The temperature of the bottom heaters can be programmed from 0-350°C.

Use LowFlow Board Cooling: Turns on low flow air to cool board and/or bottom heaters (3 cfm).

Use HighFlow Board Cooling: Turns on high flow air to cool board and/or bottom heaters (7cfm).

HotGas Temperature (°C): The spot heater temperature can be programmed from 0 – 450°C.

Use LowFlow HotGas: Turns on the low flow air to the spot heater (3 cfm).

Use HighFlow HotGas: Turns on the low flow air to the spot heater (7 cfm). Extra high flow setting can be set with both the LowFlow HotGas and HighFlow HotGas settings to On (10 cfm).

Note: Process parameters will be activated until programmed to be turned off.

Board Carrier Bottom Heating-Maintain

Function: Activates the closed loop maintain function of the bottom heaters based on a thermocouple input to control and limit board temperature through out the process.

Action: The process is activated and turned off by the start/stop function. The bottom heater (heater) sections are selected to the target temperature of the heaters (temperature). The selected thermocouple input (channel) controls the process by monitoring the board and when the temperature is reached (channel temperature (°c) the bottom heaters (heater) are turned off. If the channel temperature is exceeded the low flow board cooling system is then turned on until the board is cooled a few degrees below the channel temperature. When the board temperature is lower than the channel temperature the board cooling system will be off and the heaters reactivated.

Task Properties:

Heater: Section #1-#3. Activates the 3 sections of the bottom heater. (#1 in front)

Temperature (° C): Sets the bottom heater temperature for all sections selected.

Channel: IR Manual, TC01-TC08. Indicates and selects the IR temperature sensor or a thermocouple channel for board temperature monitoring.

Channel Temperature (° C): Sets the target and limit temperature of the object/board. If the channel temperature is exceeded the flow board cooling system is then turned on until the board is cooled a few degrees below the channel temperature. When the board temperature is lower than the channel temperature the board cooling system will be off and the heaters reactivated.

Start/Stop Function: Activates and turns off the maintain function.

Note: Maintain function will be activated until programmed to be turned off.

Remove

Start Heating Position – Board Carrier

Task Options	Task Properties
Remove	
☒ Start Heating Position – Board Carrier	Approach Height (mm) 2.00
☐ Component Removal – Board Carrier	Use Force Table ☐
	Place Target (gram) 50.00
	Depart Height (mm) -2.00

Function: Positions nozzle prior to heating process using a force sensing mode above board carrier.

Action: Nozzle moves above component on the board (approach height) for the removal process. The table force system (use force table) is activated and the nozzle moves until it registers a force (place target) programmed. The nozzle moves up (depart height).

Task Properties:

Approach Height (mm): Sets the initial distance of the nozzle to the component.

Use Force Table: Activates use of load cells (force measurement) of board carrier (50-2000g).

Place Target (grams): Sets force of nozzle against component to be reached prior to departure from component. Used in conjunction with depart height.

Depart Height (mm): Sets the distance of nozzle to component after the place target is reached.

Remove: Component Removal – Board Carrier

Function: Process used to activate vacuum sensor, force based, shear or object detection removal procedures to remove component from board.

Action: Most common sequence – vacuum sensor stop (use vacuum sensor stop). The nozzle moves up (sensor stabilize height) after the component heating events. The nozzle vacuum is turned on and its vacuum force measurement is recorded for reference. The nozzle moves down until the nozzle vacuum force (internal parameter) is reached (or force system (place target)). The nozzle moves up (depart height).

Task Properties:

Approach Height (mm): Position for nozzle to internally calibrate vacuum sensor. Height is based on distance from board carrier.

Note: Sufficient air passage is critical.

Use Vacuum Sensor Stop: Stops downward movement based on vacuum change.

Pick Velocity: Speed of nozzle moving down.

Safety Target (gram): Maximum force as backup.

(+) Theta Move (deg): Nozzle will rotate clockwise to set angle.

(-) Theta Move (deg): Nozzle will rotate counterclockwise to set angle.

Depart Height (mm): Sets distance of the component to the board after place target is reached.

Depart Delay (sec): Time between nozzle vacuum activates and motion prior to component removal (for any of the defined procedures).

Move to Safe Height: Moves nozzle automatically above the vision system.

Depart Velocity (%): Speed of nozzle depart.

Site Clean Motion

Non Contact – Vacuum Sensor Control

The screenshot shows a software interface for configuring the 'Site Clean Motion' task. It is divided into three main sections: Task Options, Task Properties, and Support Options.

- Task Options:** Contains checkboxes for 'Board Carrier Bottom Heating', 'Board Carrier Btm Panel - Maintain', and 'Board Carrier Btm HotGas - Maintai'. Below these are expandable sections for 'Remove Motion' (with 'Start Heating Position - Board Carri' and 'Component Removal - Board Carri') and 'Site Clean Motion' (with 'Non Contact - Vacuum Sensor Control', 'Non Contact - Fixed Height Control', and 'Manual Control').
- Task Properties:** A list of parameters with numerical values and up/down arrows for adjustment:
 - Sensor Approach Height (mm): 25.000
 - Approach Height (mm): 5.000
 - Initial Heating Delay: 0.000
 - Place Velocity (%): 2
 - Place Target (gram): 100.000
 - Depart Height (mm): -1.000
 - Vacuum Control (%): 35.000
 - Safety Target (gram): 500.000
- Support Options:** Currently empty.

Function: Sets site cleaning tool tip height in reference to pads of the site on the board.

Action: The site cleaning nozzle moves up (sensor approach height). The site cleaning vacuum sensor is activated. The nozzle moves down above the site (approach height) where the initial site heating is applied (from process heating task option). The event time or initial heating delay can be used to control the time. The nozzle touches the board and moves up a set distance (depart height). The site cleaning tip distance to the board adjusts according to the vacuum sensor initialize reading (vacuum motion) (vacuum control). The higher the setting the higher the tip is positioned above the solder pads.

Task Properties:

Sensor Approach Height (mm): Positions the nozzle above the board to internally calibrate vacuum sensor range of the site cleaning nozzle. Note: Sufficient air passage is critical.

Approach Height (mm): Sets initial distance of nozzle relative to board prior to process/heating.

Initial Heating Delay: Time nozzle heating is applied at the sensor approach height prior to x/y operator movement of the site cleaning tip. Note: It is important that the residue solder be molten prior to vacuum control being applied.

Place Velocity (%): Speed of nozzle tip moving down to board.

Place Target (gram): Force touch of tip to board.

Safety Target (gram): Force backup to vacuum sensor control of tip height.

Depart Height (mm): Sets distance of the nozzle after the initial heating delay and prior to activation of vacuum height adjustment.

Vacuum Control (%): Sets the distance of nozzle tip to the board during the process, the larger the number the higher the distance. The vacuum control is used throughout the operator movement of the tip across the site. The nozzle will adjust (move up/down) as per the site cleaning vacuum sensor and vacuum control setting.

Non Contact- Fixed Height Control

Task Options	Task Properties	Support Options
☐ Board Carrier Bottom Heating	Approach Height (mm) 5.000	
☐ Board Carrier Btm Panel - Maintain	Initial Heating Delay 0.000	
☐ Board Carrier Btm HotGas - Maintain	Place Velocity (%) 2	
☐ Remove Motion	Place Target (gram) 100.000	
☐ Start Heating Position - Board Carrier	Depart Height (mm) -1.500	
☐ Component Removal - Board Carrier	Frequency Height (mm) 1.000	
☐ Site Clean Motion	Accel % 100.000	
☒ Non Contact - Vacuum Sensor Control	Velocity % 15.000	
☒ Non Contact - Fixed Height Control	Start Frequency Delay (ms) 0.000	
☐ Manual Control	End Frequency Delay (ms) 0.000	

Function: Sets the site cleaning mode for fixed height control

Action: After the site cleaning nozzle alignment by the laser pointer the site cleaning nozzle moves over the site (sensor approach height). The site cleaning sensor is activated. The nozzle moves down (approach height) where the initial site heating is applied (initial heating delay). The nozzle moves down to the cycle start height (depart height) (start frequency delay). The nozzle oscillates (frequency height) (velocity). The operator presses the footswitch when the process is finished (end frequency delay).

Task Properties:

Approach Height (mm): Sets initial distance of nozzle relative to board prior to process/heating.

Initial Heating Delay: Time nozzle heating is applied at the sensor approach height prior to x/y operator movement of the site cleaning tip. Note: It is important that the residue solder be molten prior to vacuum control being applied. The nozzle tip must seal to register a correct vacuum force measurement used in conjunction with the sensor initialize reading.

Place Velocity (%): Speed of nozzle tip moving down to board.

Place Target (gram): Force touch of tip to board.

Depart Height (mm): Sets distance of the nozzle in relation to the board.

Frequency Height (mm): Controls the up/down motion of the nozzle during the process, the larger the number the larger the movement.

Accel (%): Accelerate of the nozzle frequency.

Velocity (%): Speed of the nozzle frequency.

Start Frequency Delay (ms): Time before frequency motion starts.

End Frequency Delay (ms): Time after frequency motion ends.

Feeder Pick Motion

Vision Feeder – Standard Universal Insertion Tool

Task Options	Task Properties	Support Options
Feeder Pick Motion ☒ Vision Feeder - Standard Universal Insertion Tool ☐ Manually Load Component ☐ Board Carrier Feeder - Board Level Dip Station Motion ☐ Dip Station - Vision Feeder Alignment Motion ☐ Object Alignment - Vision System	Feeder Tool Height (mm): 12.00 Approach Height (mm): 10.00 Operator Load Feeder Tray: ☒ Use Vacuum Sensor Stop: ☒ Pick Velocity (%): 3 Depart Height (mm): -5.00 Depart Delay (sec): 2 Depart Velocity (%): 3	

Function: Allows component to be positioned in the nozzle using the standard universal insertion tool in the vision system feeder prior to component alignment in the vision system.

Action: A message is presented to the operator to load the feeder tray (optional) (operator load feeder tray). The vision system moves until the feeder is under the nozzle. The nozzle moves above the feeder tool (approach height). Nozzle vacuum is applied and moves to the component in the feeder (pick velocity). When component is sensed by the nozzle vacuum (use vacuum sensor stop) the nozzle pauses (depart delay) and moves up (depart height, depart velocity). Optional object detection may be applied.

Task Properties:

Feeder Tool Height (mm): Sets the height of the universal feeder tool. Note: the feeder tool pick motion is based on the nozzle height, component thickness and feeder tool thickness. Incorrect information can result in damage to the machine and/or component.

Approach Height (mm): Sets the initial distance of the nozzle relative to the feeder tool platform.

Operator Load Feeder Tray: Activates message on run screen for operator to load the component to the load feeder tray.

Use Vacuum Sensor Stop: Activates use of nozzle vacuum sensor. The nozzle vacuum is turned on and stops when the component seals against the nozzle o-ring/vacuum cup (based on minimum internally set vacuum force being reached).

Pick Velocity (%): Speed the nozzle goes from the approach height to the component.

Depart Height (mm): Distance the nozzle moves from the feeder tool platform after the component is sensed with the vacuum sensor stop. Or the distance the nozzle/component moves up based on the nozzle, component and feeder tool height when use vacuum sensor stop is not activated.

Depart Delay (sec): Time prior to the nozzle/component moves to the depart height (mm) after the nozzle vacuum is activated.

Depart Velocity (%): Speed the nozzle/component moves away from the feeder tool to depart height.

Manually Load Component



Function: Allows the operator to manually load the component to the nozzle.

Action: The nozzle moves to a position above the board carrier (approach height) and the nozzle vacuum is applied. The nozzle movement is paused (depart delay) and then moves up (depart height).

Task Properties:

Feeder Tool Height (mm): Sets the height of the feeder tool (not active)

Approach Height (mm): Sets the distance the nozzle moves relative to the board carrier prior to the nozzle vacuum activated.

Depart Height (mm): The distance the nozzle moves after the nozzle vacuum is applied.

Depart Delay (sec): The time the between the nozzle going from the approach height (mm) to the depart height (mm).

Depart Velocity (%): Speed of depart.

Feeder Pick Motion

Board Carrier Feeder – Board Level

Task Options	Task Properties	Support Options
Feeder Pick Motion ☒ Vision Feeder - Standard Universal Dip Station Motion ☒ Dip Station - Vision Feeder	Feeder Tool Height (mm) 12,000 Approach Height (mm) 5,000 Operator Load Feeder Tray ☐ Use Vacuum Sensor Stop ☐ Pick Velocity (%) 10 Depart Height (mm) -3,000 Depart Delay (sec) 2 Depart Velocity (%) 5 Move To Safe Height ☐	

Function: Allows component to be positioned in the nozzle in reference to a board carrier feeder.

Action: A message is presented to the operator to load the feeder tray (optional) (operator load feeder tray). The vision system moves the feeder under the nozzle. The nozzle moves above the feeder tool (approach height). The nozzle vacuum is applied and moves to the component in the feeder (pick velocity). When component is sensed by the nozzle vacuum (use vacuum sensor stop) the nozzle pauses (depart delay) and moves up (depart height, depart velocity). Optional object detection may be applied.

Task Properties:

Feeder Tool Height (mm): Sets the height of the feeder tool based on the board carrier z-height position. Note: The feeder pick motion is based on the nozzle height, component thickness and feeder tool thickness. Incorrect information can result in damage to the machine and/or component.

Approach Height (mm): Sets the initial distance of the nozzle relative to the feeder tool with the component in place.

Use Vacuum Sensor Stop: Activates use of nozzle vacuum sensor. The nozzle vacuum is turned on and stops when the component seals against the nozzle o-ring/vacuum cup (based on minimum internally set vacuum force being reached).

Pick Velocity (%): Speed the nozzle goes from the approach height to the component.

Safety Target (gram): Sets force of nozzle against component to be reached prior to nozzle vacuum being activated. Used as back up system for vacuum sensor stop removal process.

Depart Height (mm): The distance the nozzle/component moves from the feeder tool after the component is sensed with the vacuum sensor stop or based on the nozzle touching the component on the feeder tool when use vacuum sensor stop is not activated.

Depart Delay (sec): Time prior to the nozzle motion to the depart height after the vacuum is activated.

Depart Velocity (%): Speed the nozzle/component moves away from the feeder tool to depart height.

Dip Station Motion

Vision Feeder

Task Options	Task Properties	Support Options
Show Any Selected Dip Station Motion ☒ Dip Station - Vision Feeder	Dip Station Tool Height (mm) 5.250 Approach Height (mm) 5.000 Operator Load Feeder Tray ☒ Place Velocity (%) 10 Depart Height (mm) -3.000 Depart Velocity (%) 5 Depart Delay (sec) 1	

Function: Allows component leads/balls to be dipped into flux or solder.

Action: A message is presented to the operator to load the dip station (optional)(operator load feeder tray). The vision system moves the dip station under the nozzle. The nozzle moves above the dip station (approach height). Nozzle moves component into undercut or dip station where flux or solder is applied (based on the dip station tool height). Nozzle/component moves away from dip station (depart height).

Task Properties:

Dip Station Tool Height (mm): Sets height of dip station tool. NOTE: The dip station-vision feeder motion is based on the nozzle height, component thickness and feeder tool thickness. Incorrect information can result in damage to the machine and/or component. NOTE: Measure the z-height of the Dip Tray (approx. 6.25mm) and subtract 1.0mm to obtain compression.

Approach Height (mm): Sets the initial distance of the component relative to dip station tool.

Operator Load Feeder Tray: Activates message on run screen for operator to load the load feeder tray.

Place Velocity: Dip entry speed.

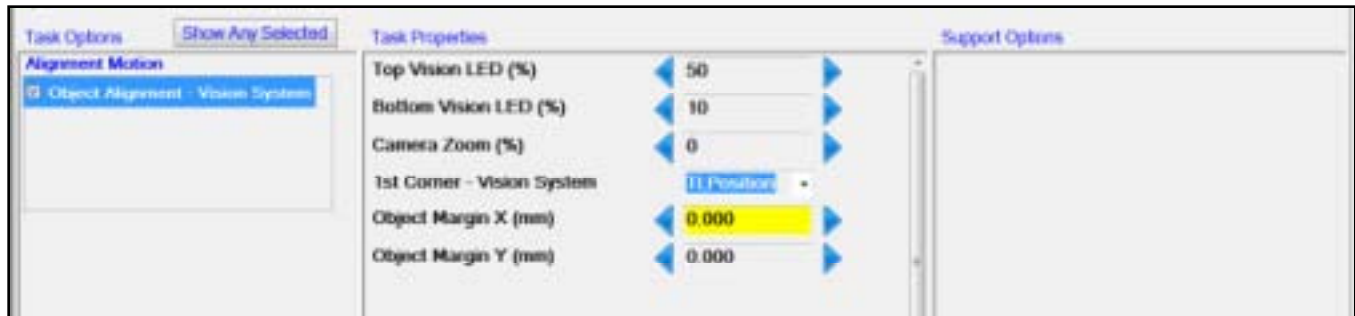
Depart Velocity: Dip exit speed.

Depart Delay: Time delay in dip station.

Depart Height (mm): The distance the nozzle moves from the dip station tool height (mm) after dipping process.

Alignment

Object Alignment – Board Carrier



Function: Allows operator to align component to board.

Action: Nozzle moves up and the vision system is positioned (1st corner – vision system) based on the position (MM position) using the laser pointer teach position and component dimension programmed. The vision system camera is turned on to the programmed LED intensity (top vision LED, bottom vision LED) and magnification (camera zoom).

Task Properties:

Top Vision LED (%): Controls the intensity of the top LED for component leads viewing.

Bottom Vision LED (%): Controls the intensity of the bottom LED for the top of the site/board viewing.

Camera Zoom (%): Controls magnification of the camera.

1st Corner – Vision System: Sets the first position of the camera to the site based on the center of the laser pointer teach position and component dimension programmed. Options include top left, top right, bottom left and bottom right corners.

Object Margin X (mm) & Object Margin Y (mm): If the corner view in vision is too small, enter positive margins to increase the corner image size.

Place Motion

Object Placement – Board Carrier

The screenshot shows a software interface with three main panels: Task Options, Task Properties, and Support Options. The Task Options panel on the left has a 'Show All' checkbox and lists three categories: 'Place Motion' (with 'Object Placement - Board Carrier' selected), 'Thermocouple Control' (with 'Thermocouple Wait' unchecked), and 'Inspection' (with 'Inspection - Direct View' and 'Inspection - Vision System' unchecked). The Task Properties panel in the center contains several adjustable parameters: 'Approach Height (mm)' set to 5.00, 'Place Target (gram)' set to 50.00, 'Place Velocity (%)' set to 2, 'Vacuum Off Delay (sec)' set to 2, 'Use Blow-Off Air' (unchecked), 'Blow-Off Air Delay (sec)' set to 0, 'Depart Height (mm)' set to -2.00, and 'Depart Velocity (%)' set to 2. Each parameter has a numeric input field and blue arrow controls for adjustment. The Support Options panel on the right is currently empty.

Function: Places component to the site.

Action: Component moves above site (approach height). The nozzle moves the component down (place velocity) to the board until the (place target) force is reached. The nozzle vacuum is turned off (vacuum off delay). Optional air pressure is normally applied to insure component does not stick to nozzle o-ring (use blow-off air) for programmed time (blow-off air delay). The nozzle moves from the board (depart height)(depart velocity).

Task Properties:

Approach Height (mm): Sets the initial distance of the component relative to the board.

Place Target (gram): Sets force of the component against the board to be reached prior to nozzle vacuum being turned off.

Place Velocity (%): Speed nozzle moves component to board.

Vacuum Off Delay (sec): Time the nozzle vacuum is off after place target (gram) is reached.

Use Blow-Off Air: Activates air pressure through nozzle vacuum o-ring/vacuum cup before nozzle retracts. Uses blow-off air delay before depart (sec) time setting.

Blow-Off Air Delay (sec): Time air use blow-off air system is activated.

Depart Height (mm): Distance nozzle moves up after component is placed on board.

Depart Velocity (%): Speed the nozzle moves away from component after component is placed on board.

Thermocouple

Thermocouple Wait

Function: Provides thermocouple feedback for a temperature based process. It is mainly used for process control preheating of the board from the bottom heater. It can be used to provide thermal feedback to create the thermal portion of removal or replacement programs.

Action: With the bottom preheater on, the designated (wait TC) thermocouple (channel) monitors top-side board temperature. When the target temperature (temperature) is reached (direction), the process is complete.

Task Properties:

Channel: Indicates the thermocouple channel(s) used, which is typically the IR Sensor.

Function: Wait TC sets the mode for one thermocouple usage.

Temperature (°C): Sets the target temperature for the thermocouple to be reached.

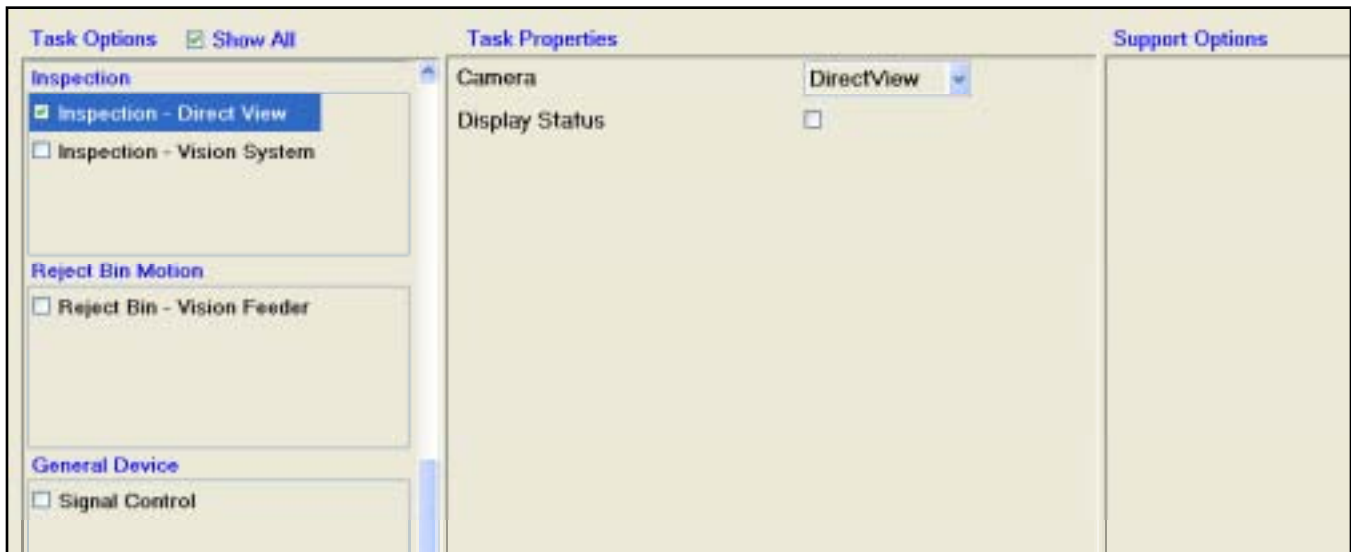
Direction: Sets the direction for the target temperature to be reached. Increase mode is used for heating applications. Decrease mode is used for cooling applications.

In-Position Delay (sec): Sets the time the function is in use. Normally not used as this is a temperature based event, but is used if a time limit needs to set. If target temperature is not reached and time has expired, program will continue to next step at the set time. If target temperature is the goal set time to 600 seconds.

Note: If target temperature cannot be reached in maximum in-position delay setting, 600 seconds, two events must be created and target temperatures set to reachable goals within 600 seconds.

Inspection

Inspection – Direct View



Function: Turns on direct view camera.

Action: The computer screen is switched from the run screen to the camera screen. The direct view camera (camera – direct view) is turned on (display status).

Task Properties:

Camera/Direct View: Determines camera to be activated – direct view camera.

Display Status: Turns on – no check in box or off – check in box camera.

Note: Operator can switch back and forth from run screen to camera view screen at any event in the program when display status is on.

General Device

Signal Control

Task Options	Task Properties	Support Options
☒ Show All Reject Bin Motion ☐ Reject Bin - Vision Feeder General Device ☒ Signal Control	Name: SiteCleanVacuum Status: On Wait For Signal: ☐ Maximum Delay (sec): 0	

Function: Turns on device programmed.

Action: For site cleaning, the site clean vacuum device (site clean vacuum) is selected. Status indicates device is activated.

Task Properties:

Name: Selects device for signal control:

- Site Clean Vacuum
- Nozzle Vacuum
- Probe Vacuum
- Manual IR Probe Home Sensor

Status: Turn signal on or off.

Wait for Signal: Can be used to delay signal control function if another device is activated.

Maximum Delay (sec): Allows delay of signal control for set time.

Reject Bin

Reject Bin – Vision Feeder

Task Options	Task Properties
Object Place	Reject Bin Tool Height (mm) 12.00
Reject Bin	Approach Height (mm) 10.00
☒ Reject Bin - Vision Feeder	Vacuum Off Delay (sec) 2
	Use Blow-Off Air ☒
	Delay Before Depart (sec) 0
	Depart Height (mm) -10.00

Function: Provides a position on the vision feeder for reworked component to be dropped off.

Action: A message is presented to the operator to empty the reject bin. The vision system moves until the reject bin is under the nozzle. The nozzle moves above the reject bin (approach height). The nozzle vacuum is turned off (vacuum off delay). Low pressure air (use blow-off air) is applied (delay before depart) to enhance component/o-ring separation. The nozzle moves away from the reject bin (depart height).

Task Properties:

Reject Bin Tool Height (mm): Sets height of reject bin. Note: The reject bin tool motion is based on the nozzle height, component thickness and reject bin tool thickness. Incorrect information can result in damage to the machine and/or component.

Approach Height (mm): Distance from component to reject bin.

Vacuum Off Delay (sec): Time nozzle vacuum is turned off after approach height is reached.

Use Blow-Off Air: Activates air pressure through nozzle vacuum o-ring/vacuum cup before nozzle retracts. Uses blow-off air delay before depart (sec) time setting.

Delay Before Depart (sec): Time from component drop off to nozzle movement away from reject bin.

Depart Height (mm): Distance nozzle travels after going to reject bin and vacuum/pressure functions are applied.

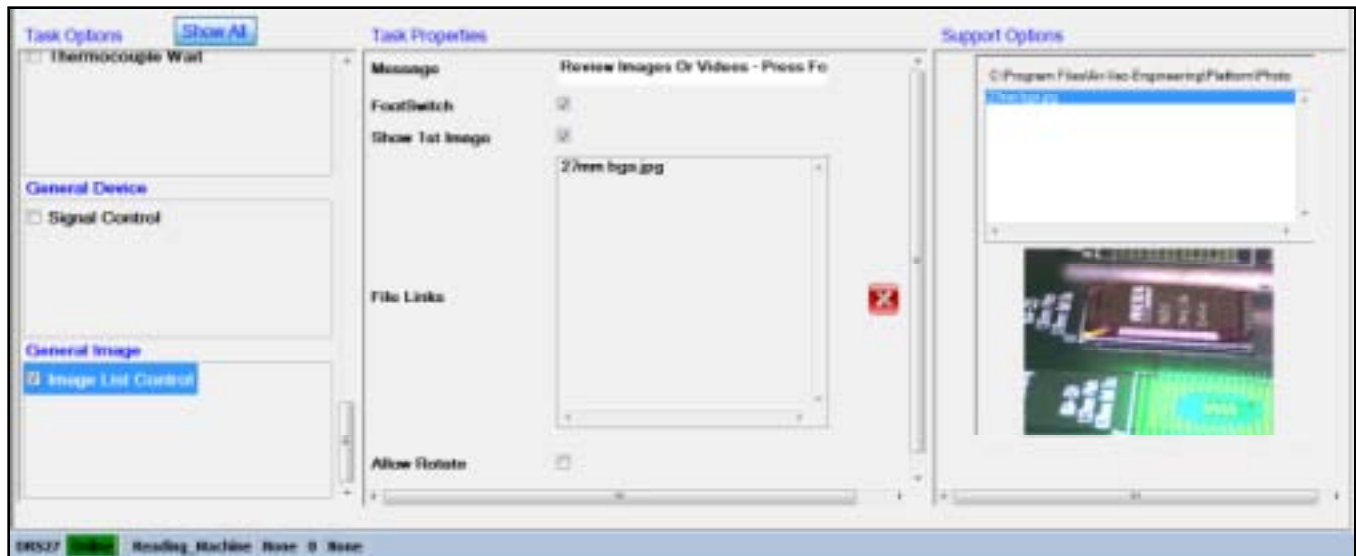
Notes:

It is advised to use tray provided to insure molten solder/solder balls do not dislodge/drop onto universal insertion tool or on the assembly.

If component sticks to nozzle o-ring/vacuum cup increase delay before depart time and use blow-off air to assist in separation.

General Image

Image List Control

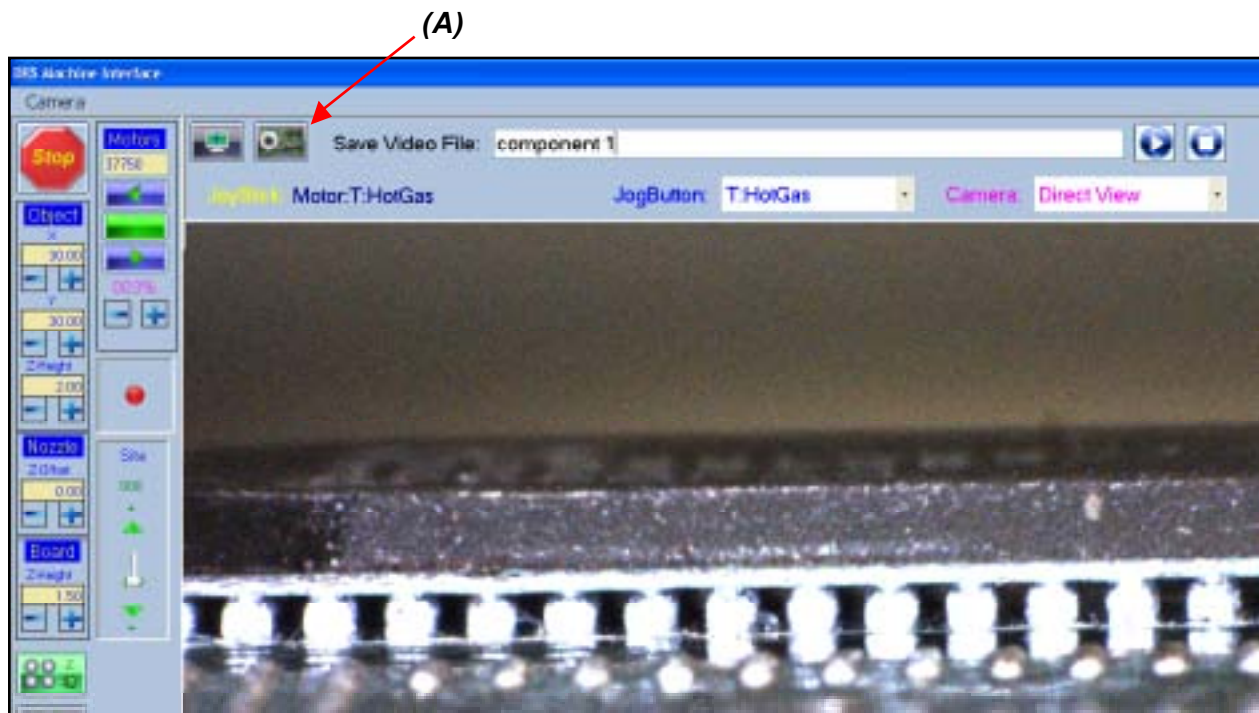


Function: Allows saved image or video to be displayed during an event of the program.

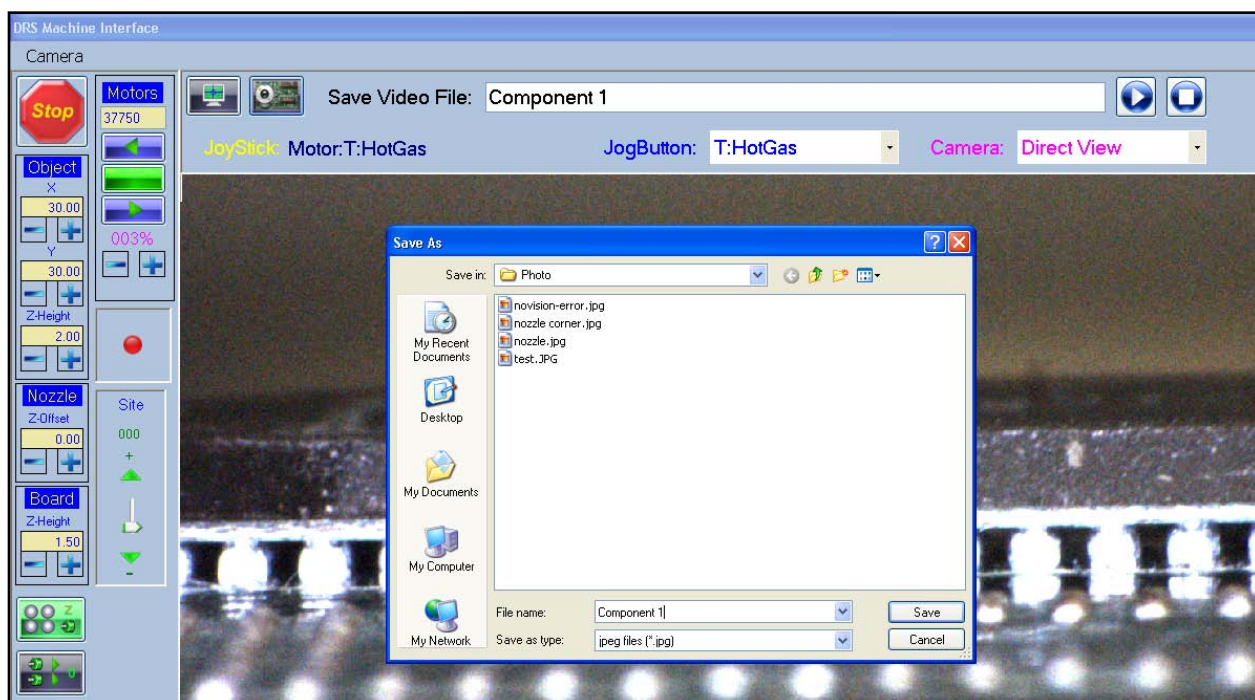
Action: An image or video is saved using the camera screen.



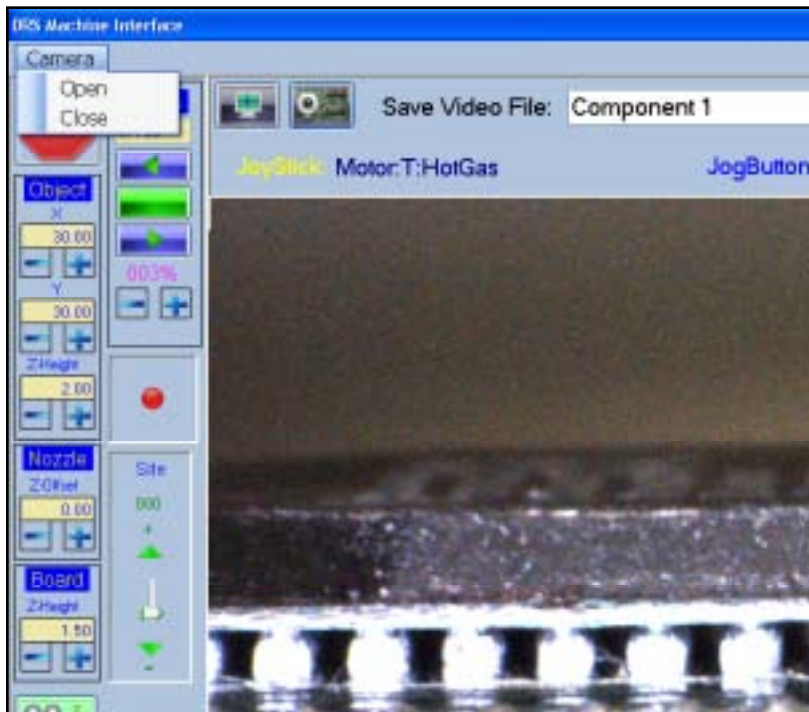
The camera screen will appear.



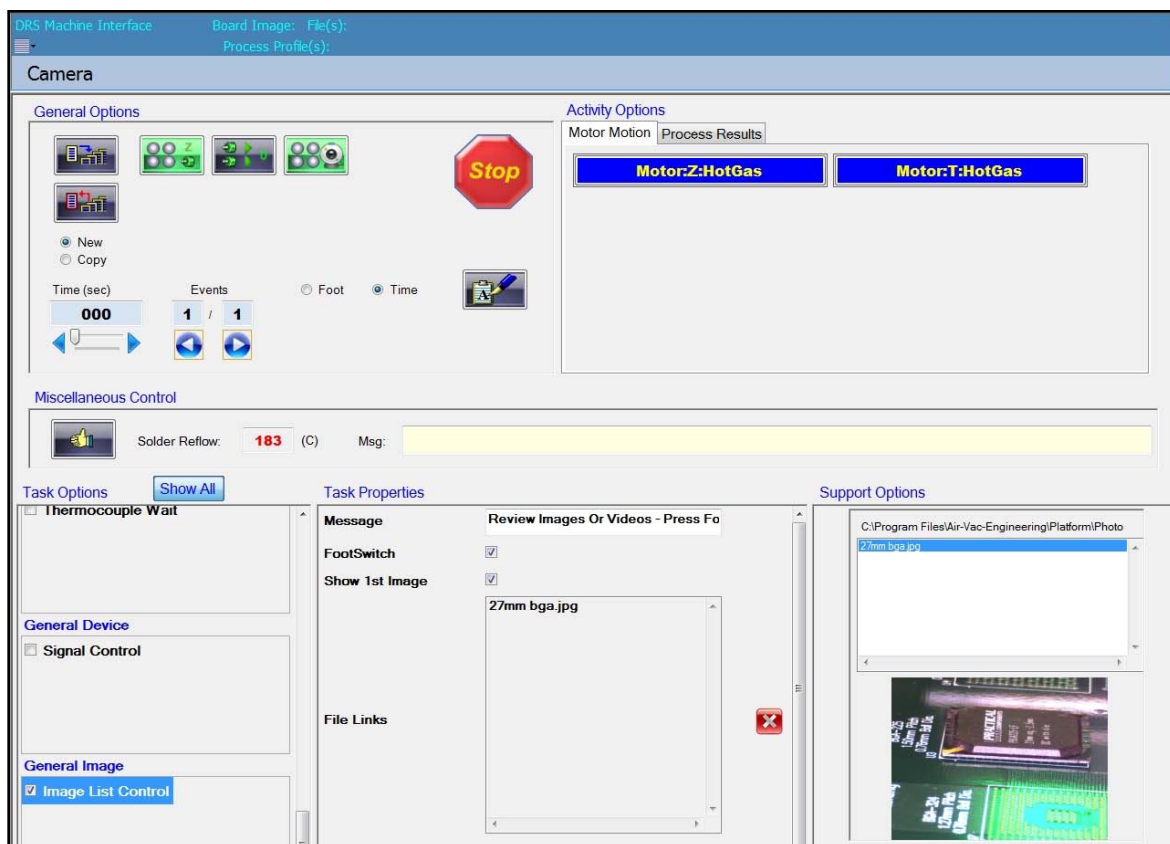
- 1 – Select Direct View or Vision System Camera **(A)**.
- 2 – For photo, click Save Camera Video image icon. For video, click Start Video/Stop Video icons.
- 3 – Name image in Save Video file box.



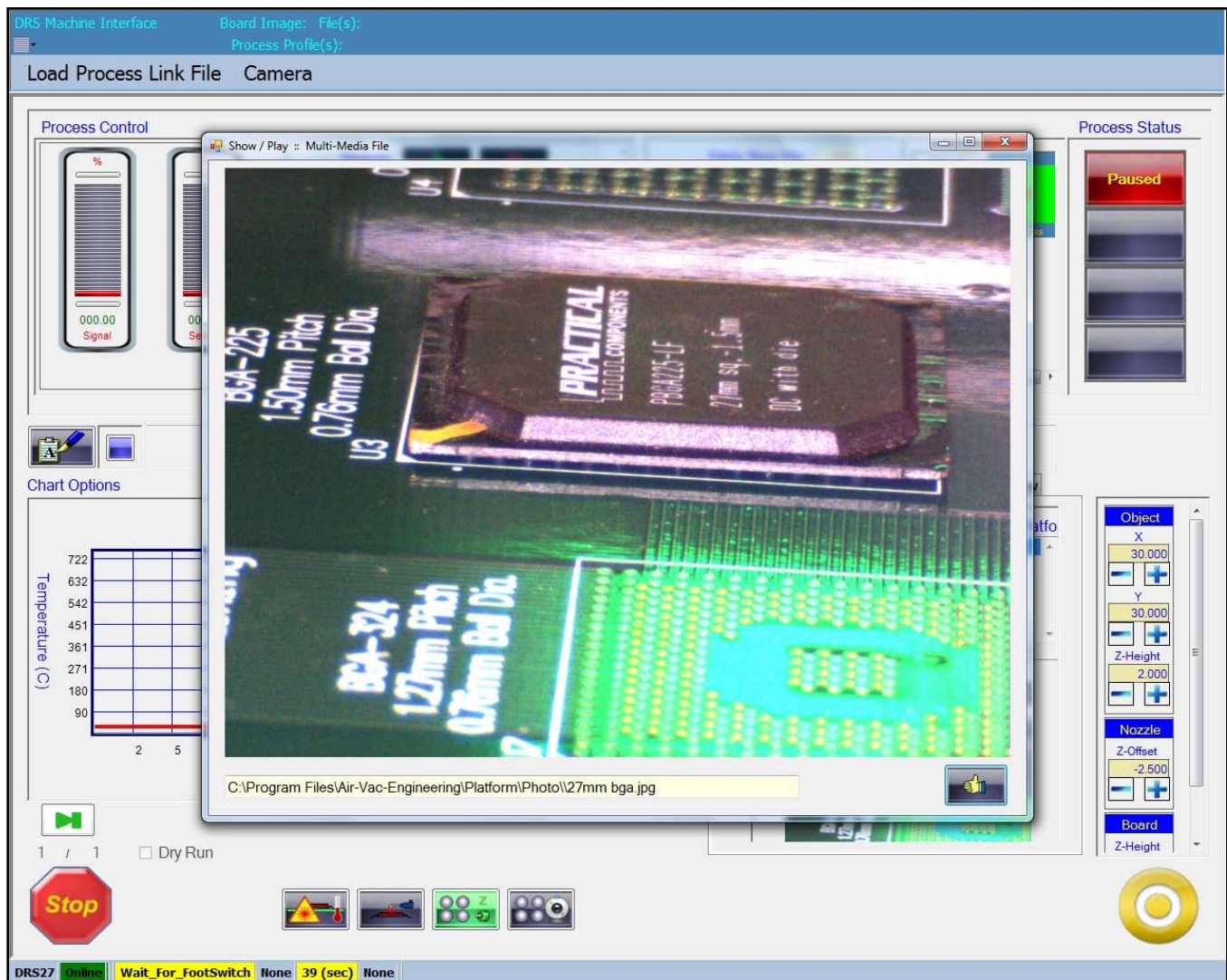
4 – Close Screen



5 – Go to Teach Screen and select Photo/Video for any event(s) of program to be displayed.



6 – Saved Photo/Video will be shown in Run Screen in Support Options.

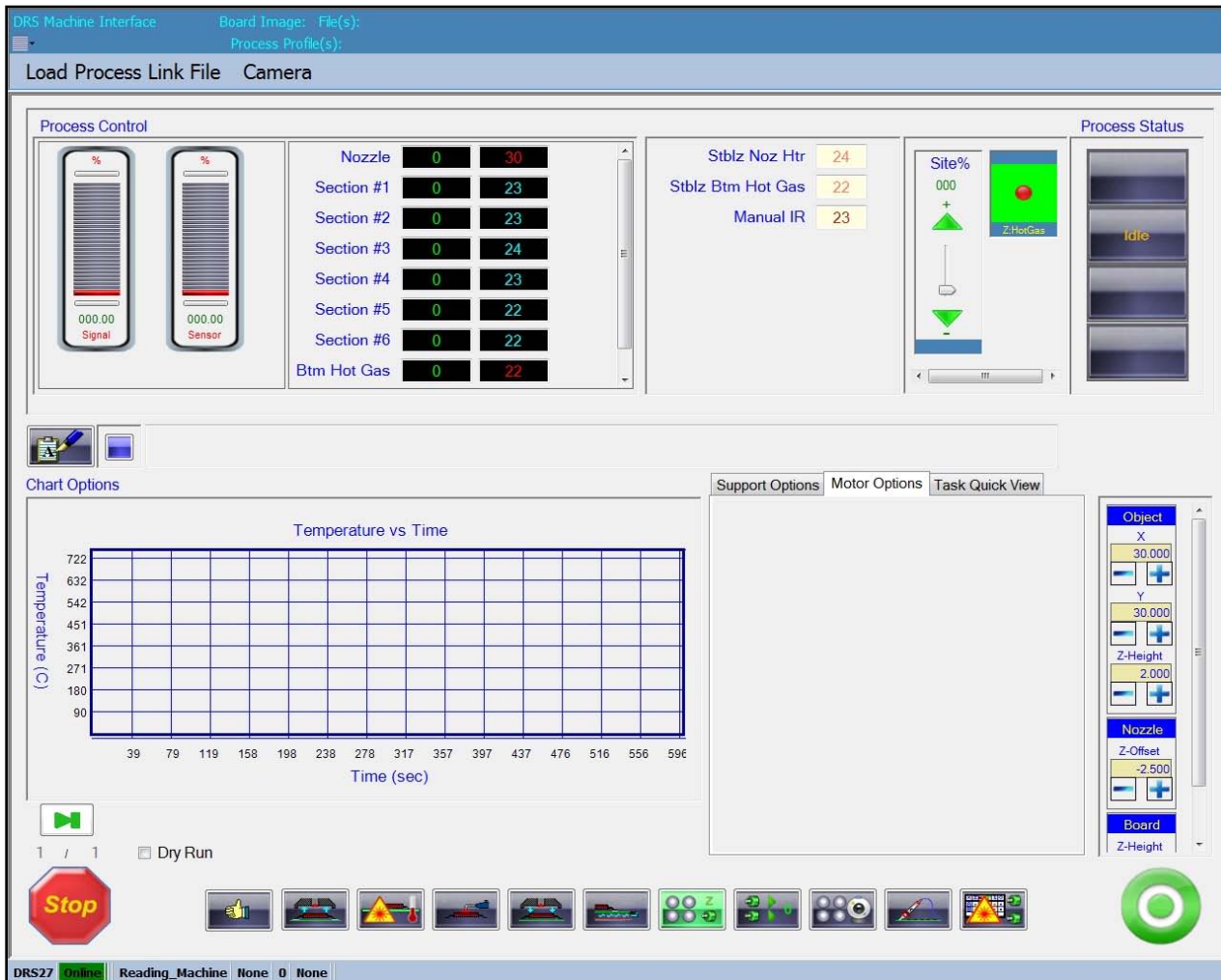


Run Process:

The **Run** screen allows the operator to cycle a process profile. A profile must first be opened using the **Open** option or created using the **Tutor / Teach** options. During each event of the cycle, the system continuously monitors and reports the following control information:

- Heater and thermocouple temperatures, Nozzle and diffuser flow rates, Force placement (removal) procedures, Foot switch control, and Alarm conditions.

Event messages and temperature plotting graphically show the progress of a cycle.



The **Cycle Start/Stop** button is used to activate or terminate the process cycle. This button will display a green background when the cycle is active or a gray background when the cycle is not active. Clicking on this button when the background is green will terminate the cycle.

Note:

DURING THE CYCLE, THE OPERATOR MAY BE PROMPTED TO PRESS THE FOOT SWITCH BEFORE ANY PROCESSING CAN CONTINUE. SOME EVENTS ARE DESIGNED TO ALLOW THE OPERATOR TO PERFORM A MANUAL TASK (FINAL COMPONENT ALIGNMENT).

Alarm Control

The DRS27 constantly monitors the controlling sub-systems. If any sub-system fails due to a process or hardware issue, the system will respond with an alarm.

There exist 2 types of software alarms:

1. Machine Hardware Alarms
2. Process Alarms

Machine Hardware Alarms

This alarm type occurs when one of the following conditions is detected:

```
SerialPort_Failure  
Z_Axis_Motor_Comm_Restart  
Vision_Axis_Motor_Comm_Restart  
Nozzle_TempControl_Comm_Restart  
Left_Preheat_TempControl_Comm_Restart  
Right_Preheat_TempControl_Comm_Restart  
Center_Preheat_TempControl_Comm_Restart  
DeviceIO_Communication_Restart  
Low_Pressure_Air_Regulator  
Low_Pressure_N2_Regulator
```



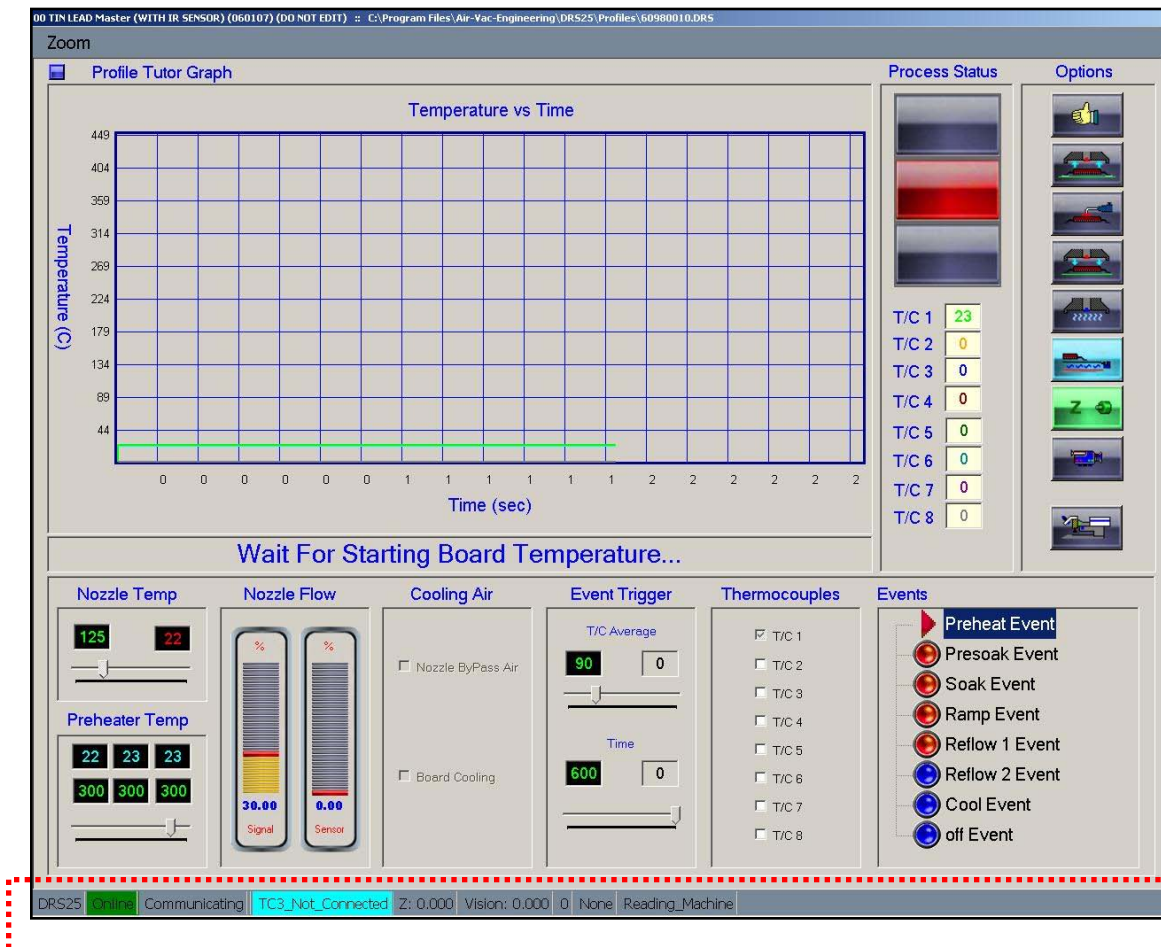
Process Alarms

This alarm type occurs when one of the following conditions is detected:

```

Nozzle_Temperature_Limit,
Nozzle_TC_Error,
Left_Preheater_Temperature_Limit,
Left_Preheater_TC_Error,
Right_Preheater_Temperature_Limit,
Right_Preheater_TC_Error,
Center_Preheater_Temperature_Limit,
Center_Preheater_TC_Error,
Below_Minimum_Nozzle_Flow_Rate,
Nozzle_Flow_Sensor_In_Position_Failed,
Exceeded_Max_FootSwitch_Delay,
Exceeded_Max_TC_Control_Delay,
TC1_Not_Connected,
TC2_Not_Connected,
TC3_Not_Connected,
TC4_Not_Connected,
TC5_Not_Connected,
TC6_Not_Connected,
TC7_Not_Connected,
TC8_Not_Connected,
Site_Clean_Tool_Clogged

```



Profile Notes Page



The **Profile Notes** button allows the operator to refer to any application related notes that may have been setup by the process engineer. The operator cannot access these notes while a cycle is active.

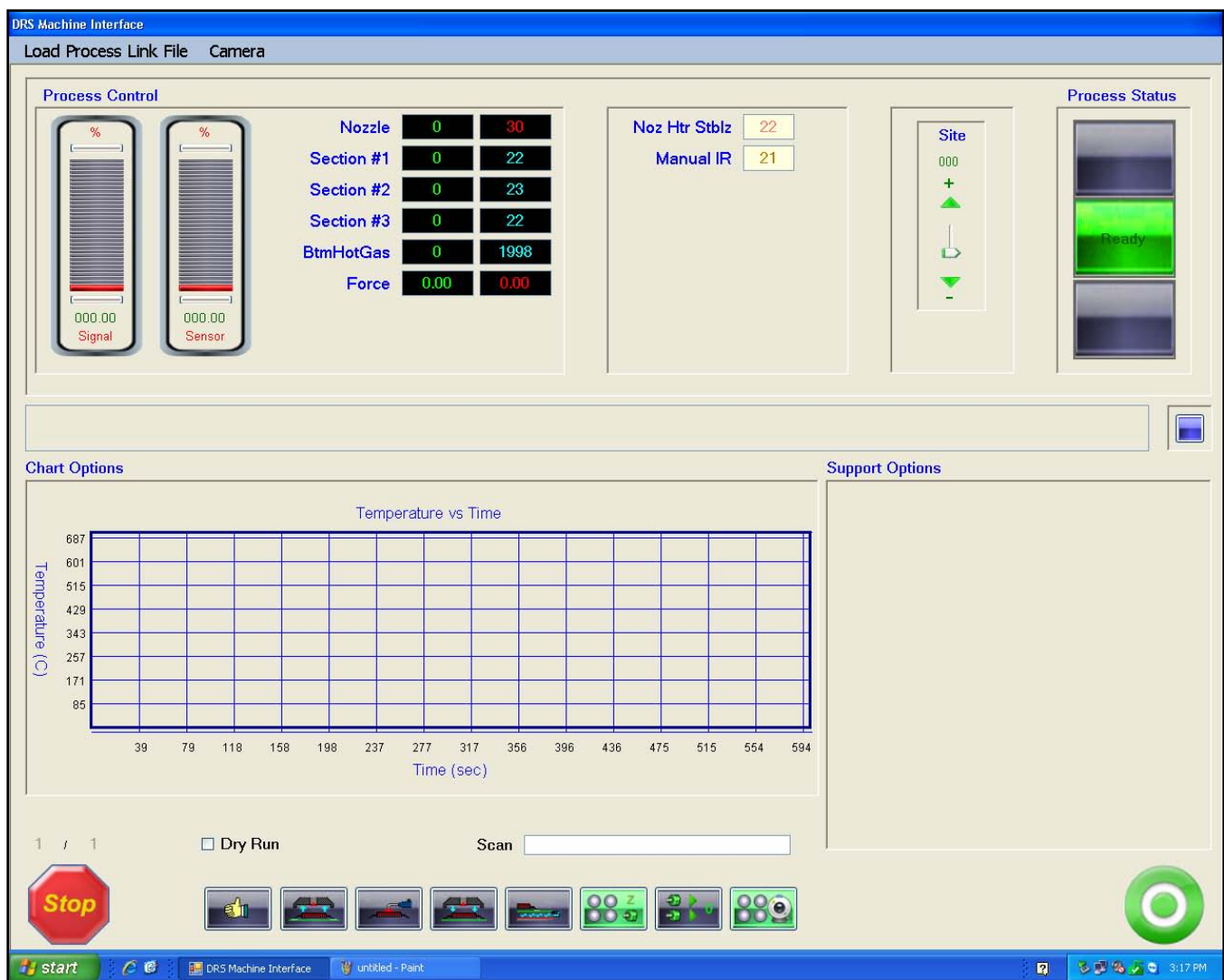
In the Teach Screen, notes can be provided for the operator. In addition, vital object, nozzle and board dimensions are stored and set.

The Profile Note Screen is activated when the program is selected prior to the Run Screen. The object, nozzles and board dimensions are not shown to the operator.

General Run Screen Layout:

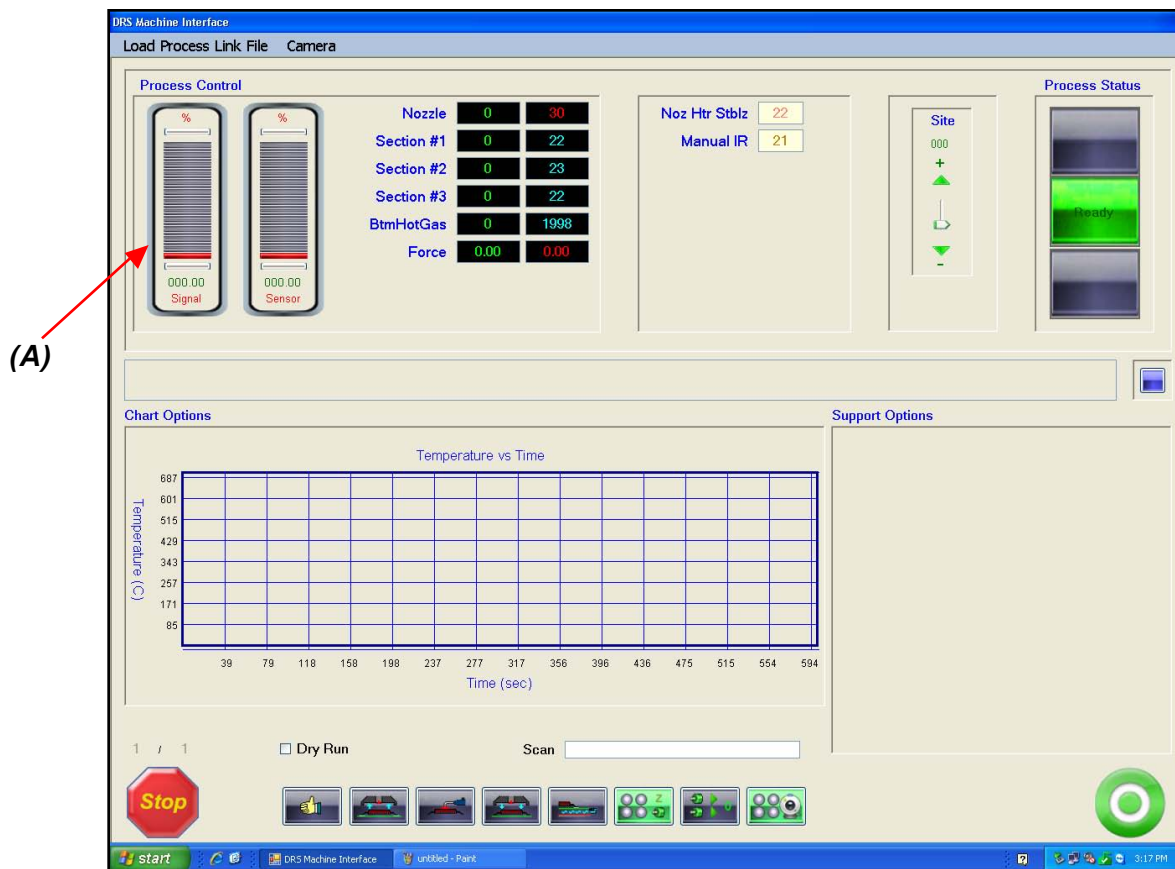
The Run screen is organized into the following sections:

- Numeric Process Information
- Profile Event / Alert / Foot Switch Messages
- Graph Process Information
- Event Time
- Event Counter
- Process Time
- Button Functions
- Software/Hardware Communication Link Error Status
- Bar Code / Board Serial Number Tracking
- Menu Functions



Numeric Process Information (A)

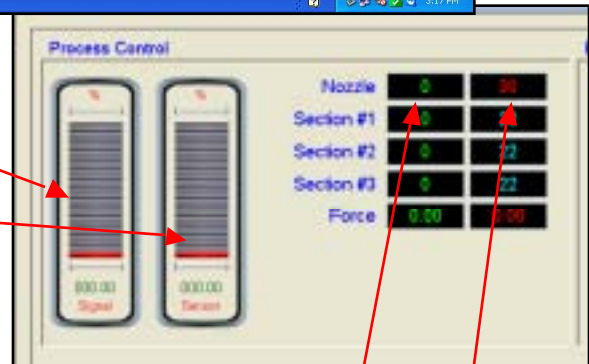
This section of the **Run** screen displays numeric information associated with process temperature, flow rate, force and thermocouples.



Nozzle and Preheater System:

The **Nozzle System** (upper heater) graphically displays the following control parameters:

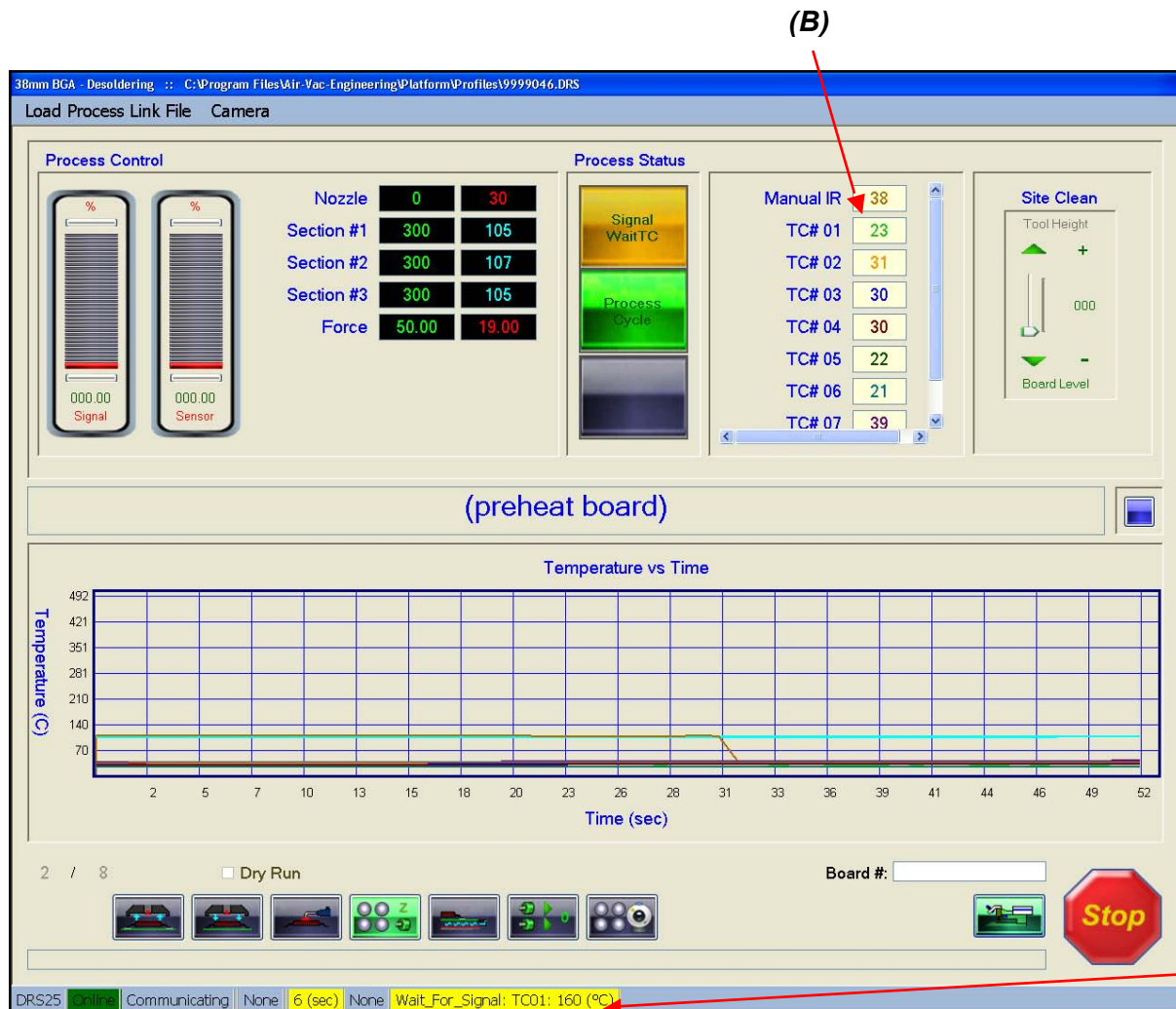
- Nozzle flow rate percentage (set point) (A) – yellow needle
- Nozzle flow rate actual percentage (B) – blue needle
- Nozzle target temperature (set point) (C) – green number
- Nozzle actual temperature (D) – red number



Thermocouple System:

The **Thermocouple System** has maximum of eight thermocouple channels. Only pre-programmed (active) channels will be displayed. Each channel will display an actual and a set point temperature. Each thermocouple channel has an identification number positioned between the set point and actual displays.

When a thermocouple channel is controlling the process, a yellow **T/C Control (A)** message will be displayed at the bottom of the screen. This message will define the type of thermocouple activity and the temperature target. A real-time display offers the current temperature of all thermocouple channels (B).



Note:

ALL ACTIVE THERMOCOUPLE CHANNELS MUST BE CONNECTED TO A THERMOCOUPLE SENSOR BEFORE THE PROCESS CYCLE IS STARTED. FAILURE TO DO SO WILL RESULT IN AN ALARM CONDITION.

Force System:

This system monitors and controls the activities associated with component force placement, force removal or force adjustment.

The **Force System** graphically displays the following control parameters:

- Force target (set point - green). **(A)**
- Force actual (applied force - red). **(B)**

Nozzle	0	30
Section #1	300	105
Section #2	300	107
Section #3	300	105
Force	50.00	19.00

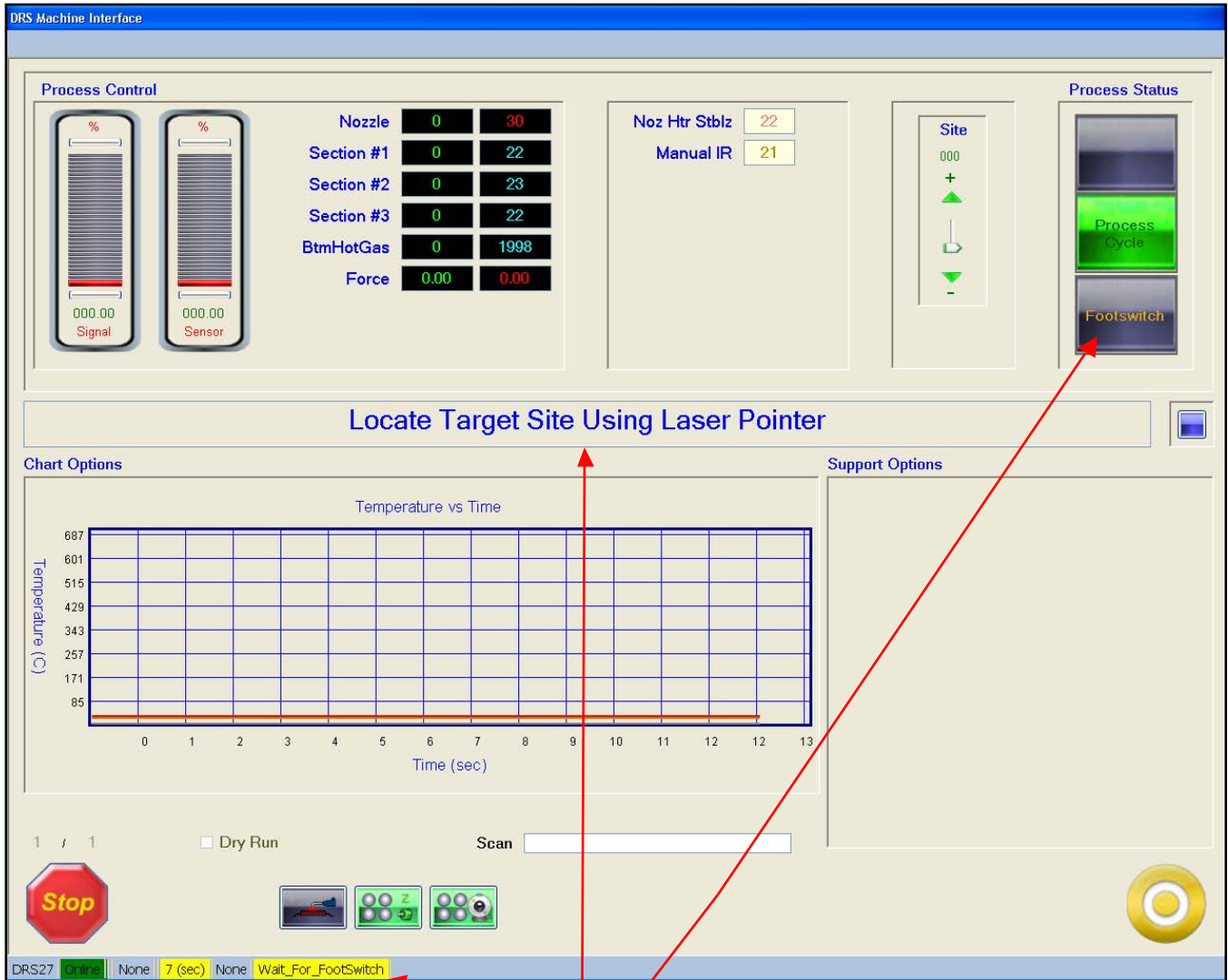
(A) (B)

Note:

DURING ANY FORCE-CONTROLLED ACTIVITY (PLACEMENT/REMOVAL/ADJUSTMENT), THE OPERATOR SHOULD NOT TOUCH ANY PART OF THE MACHINE.

Profile Event and Foot Switch Messages (B)

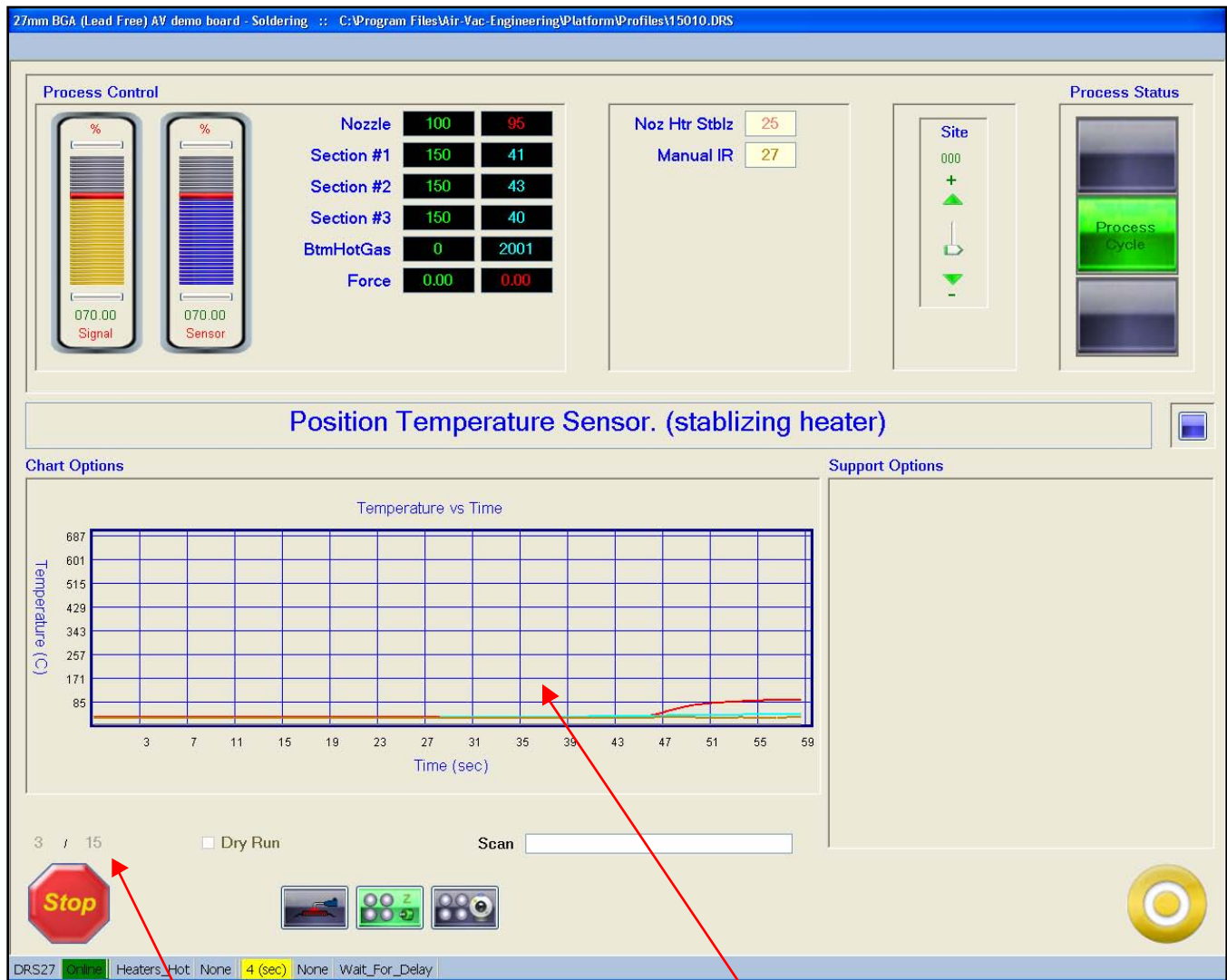
This section of the **Run** screen displays system (foot switch) messages or pre-programmed event/alert messages. Messages are used to inform the operator when machine interaction is required, or to communicate the general progress of the profile cycle.



(B)

Graph Process Information (C)

This section of the **Run** screen displays the **Temperature vs. Time** graph.



(E)

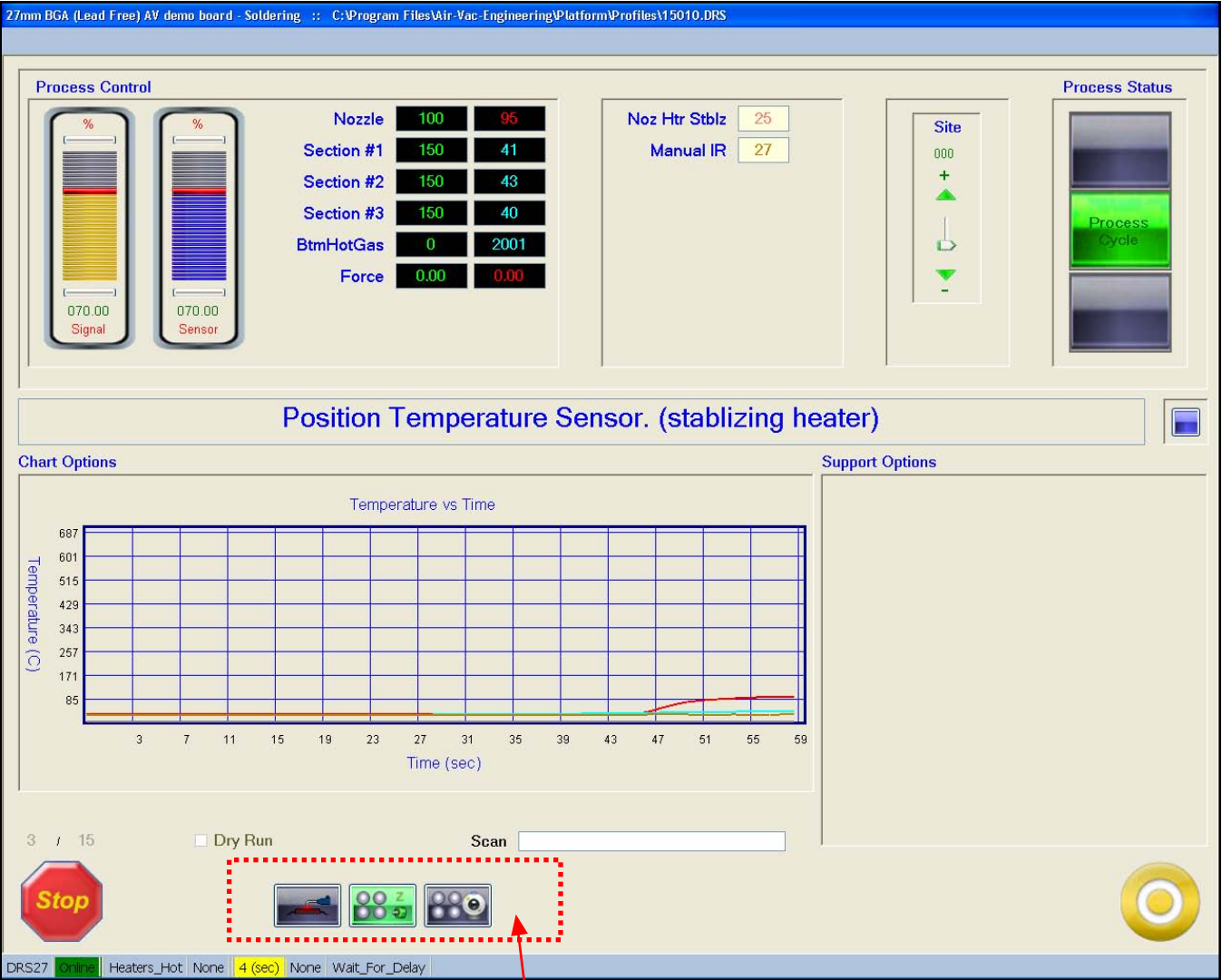
(D)

(F)

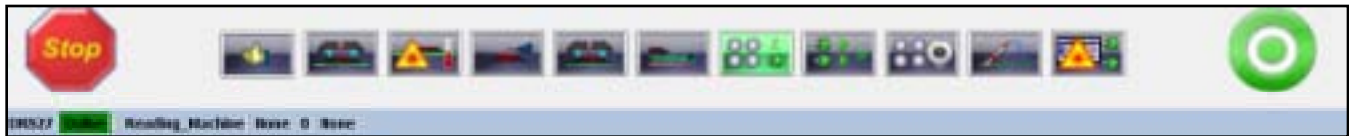
- Event Time **(D)** – Time remaining in the current event.
- Event Counter **(E)** – Current and maximum profile event counters.
- Process Time **(F)** – Total (overall) cycle time (all events) is plotted on the chart display.

Function Buttons (G)

This section of the **Run** screen displays the function buttons that are available to the operator.



(G)



Cycle Start/Stop



The **Cycle Start/Stop** button is used to activate or terminate the process cycle. This button will display a stop sign symbol when the cycle is active or a machine symbol when the cycle is not active. Clicking on the button when the stop sign symbol is visible will terminate the cycle.

Thumbs Up / OK / Exit



This button will exit the **Run** screen and return the operator to the **Main** screen.

Nozzle Vacuum



The **Nozzle Vacuum** button will activate or deactivate the nozzle vacuum. When this function is active, the button background will be display in green.

Nozzle Device Separation (Blow Off)



The **Device/Nozzle Separation** button will activate a small volume of air back through the nozzle vacuum tube (helps to separate the component from the nozzle). When this function is active, the button background will be display in green.

Probe Vacuum



The **Probe Vacuum** button will activate or deactivate the special vacuum probe port (used with component handling tool).

Laser Pointer



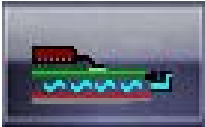
Turns the Laser Pointer on the IR Probe on (green) and off.

Z Axis Lights



This button will turn on the lights of the Z axis.

Board Cooling (High / Low Flow Rate)



This button will activate (toggle) through the available board cooling flow rates (low, high and off).

Home All Motors



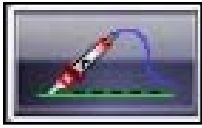
This button will home all Z and Vision motor axis.

Direct Vision Lights (option)



This button will turn on the lights of the direct view camera option.

Site Cleaning Vacuum



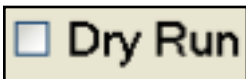
The Site Cleaning Vacuum button turns the Site Cleaning Vacuum on and off.

Laser Pointer Teach Position



Activates the Laser Pointer in the Vision Housing to teach the component location.

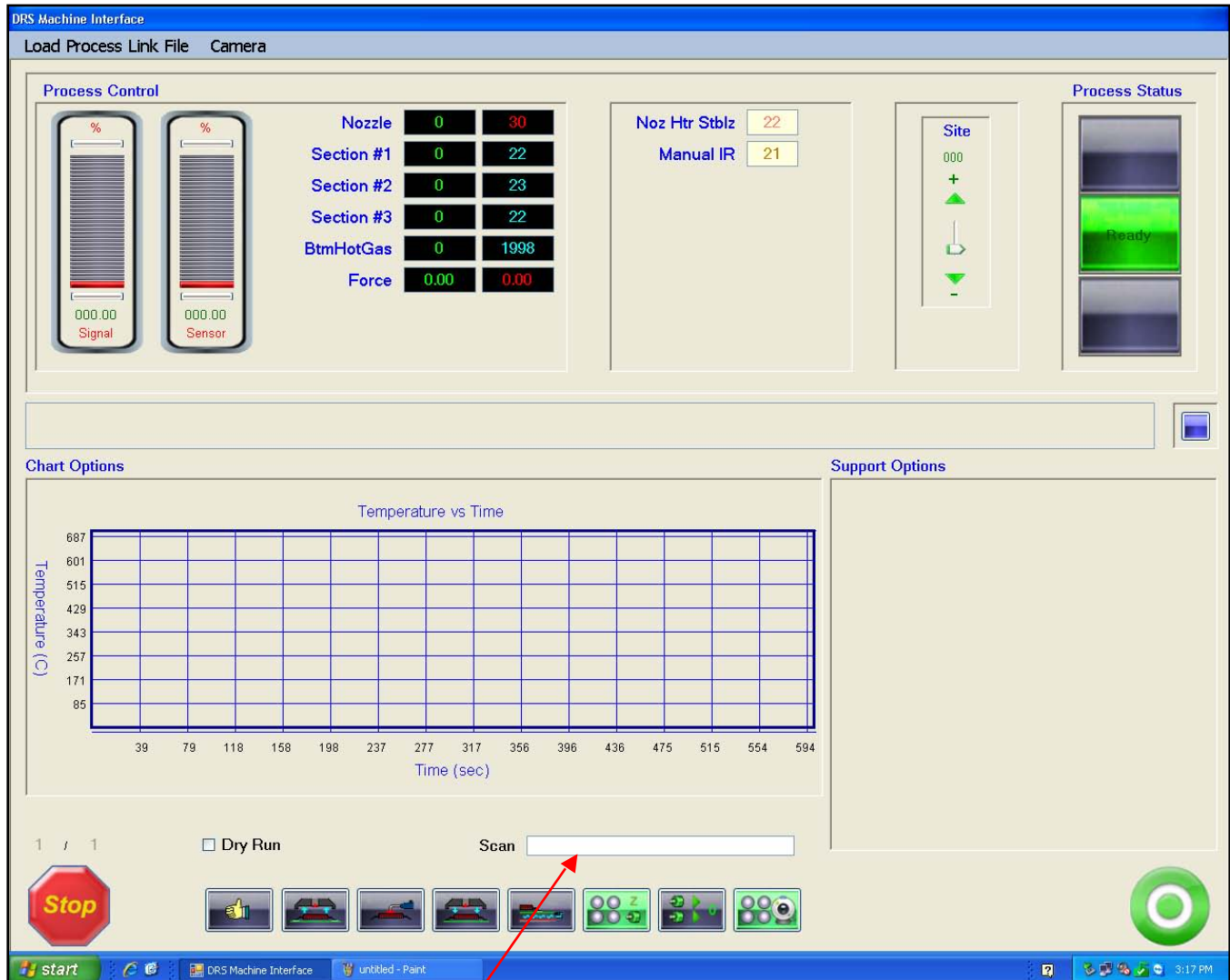
Dry Run



Activating this will allow the profile to run without heat.

Bar Code / Board Serial Number Tracking (I)

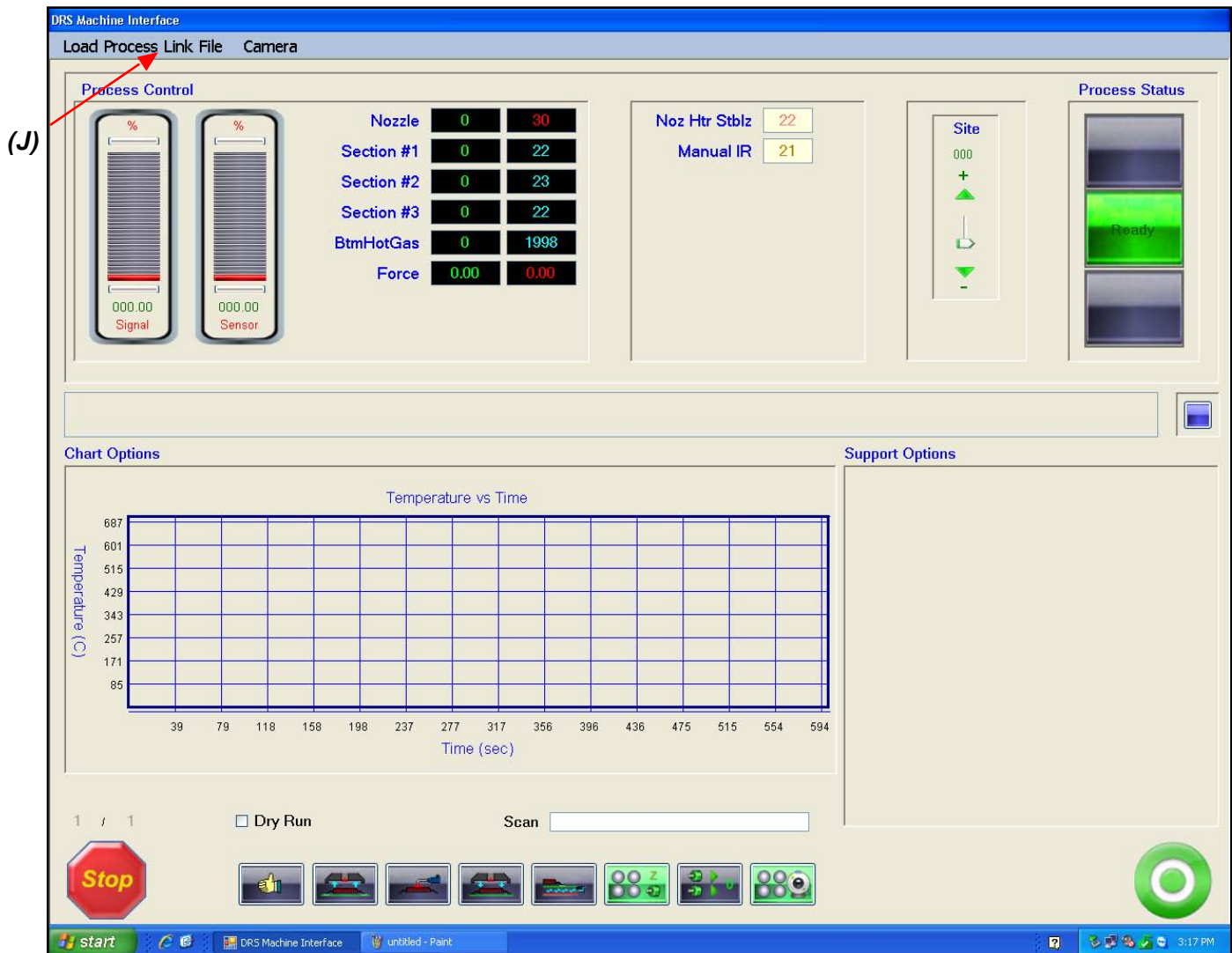
This section of the **Run** screen allows a board serial number to be tracked and recorded in the cycle history file. The operator has the option to enter this information using the standard keyboard or to use the optional bar code scanner.



(I)

Menu Functions

This section of the **Run** screen displays the function menus that are available to the operator.

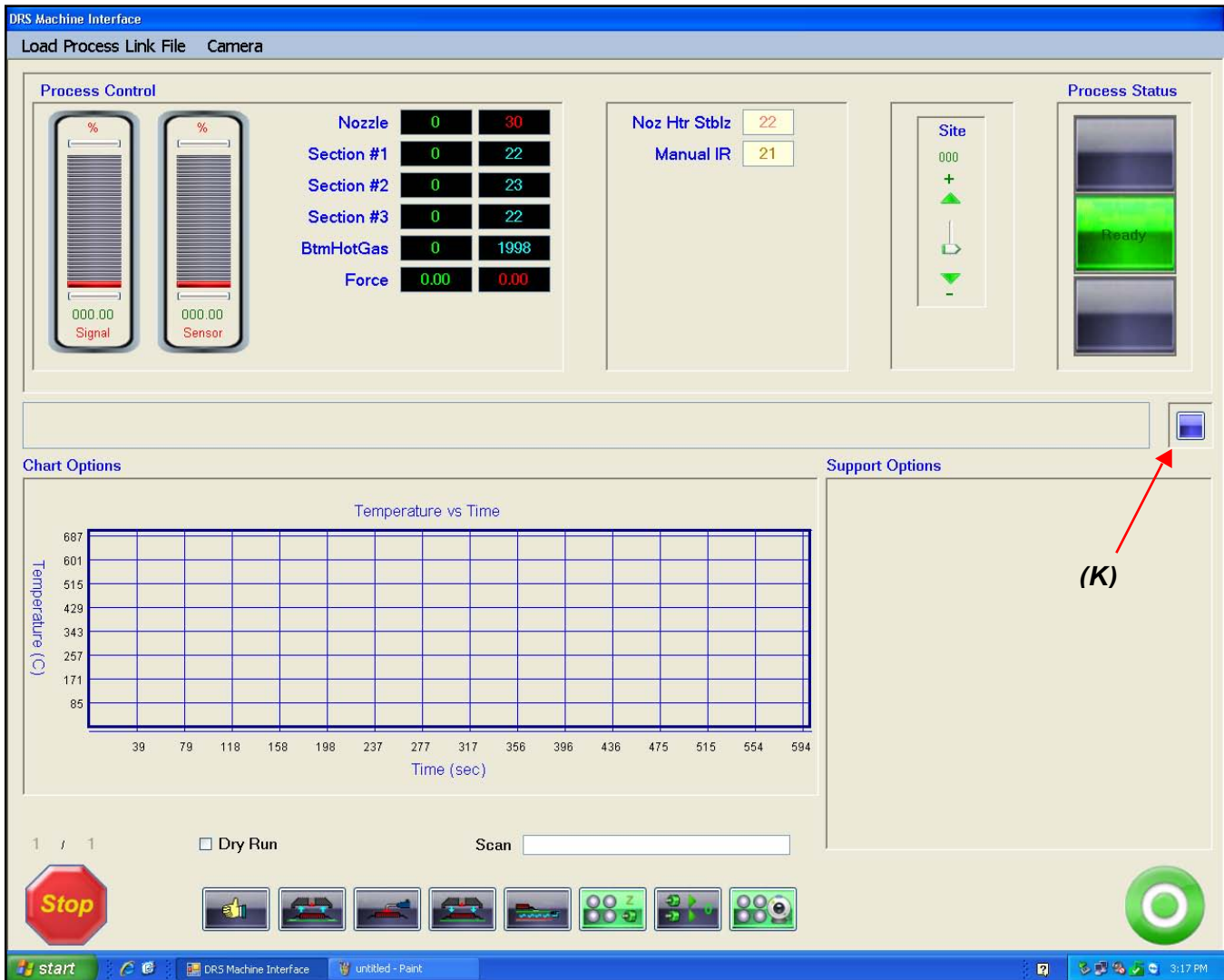


Load Process Link File Menu Option:

The **Load Process Link File** menu (J) allows the operator to toggle between the soldering, desoldering and site cleaning profiles. This allows related profiles to be cycled without leaving the **Run** screen. This menu option is only available when the process is not cycling.

Chart Data and Export History Option:

Graph data can be saved to the export folder.



- Clicking on the small blue button (K) will export the chart data to the export folder **Export** directory:

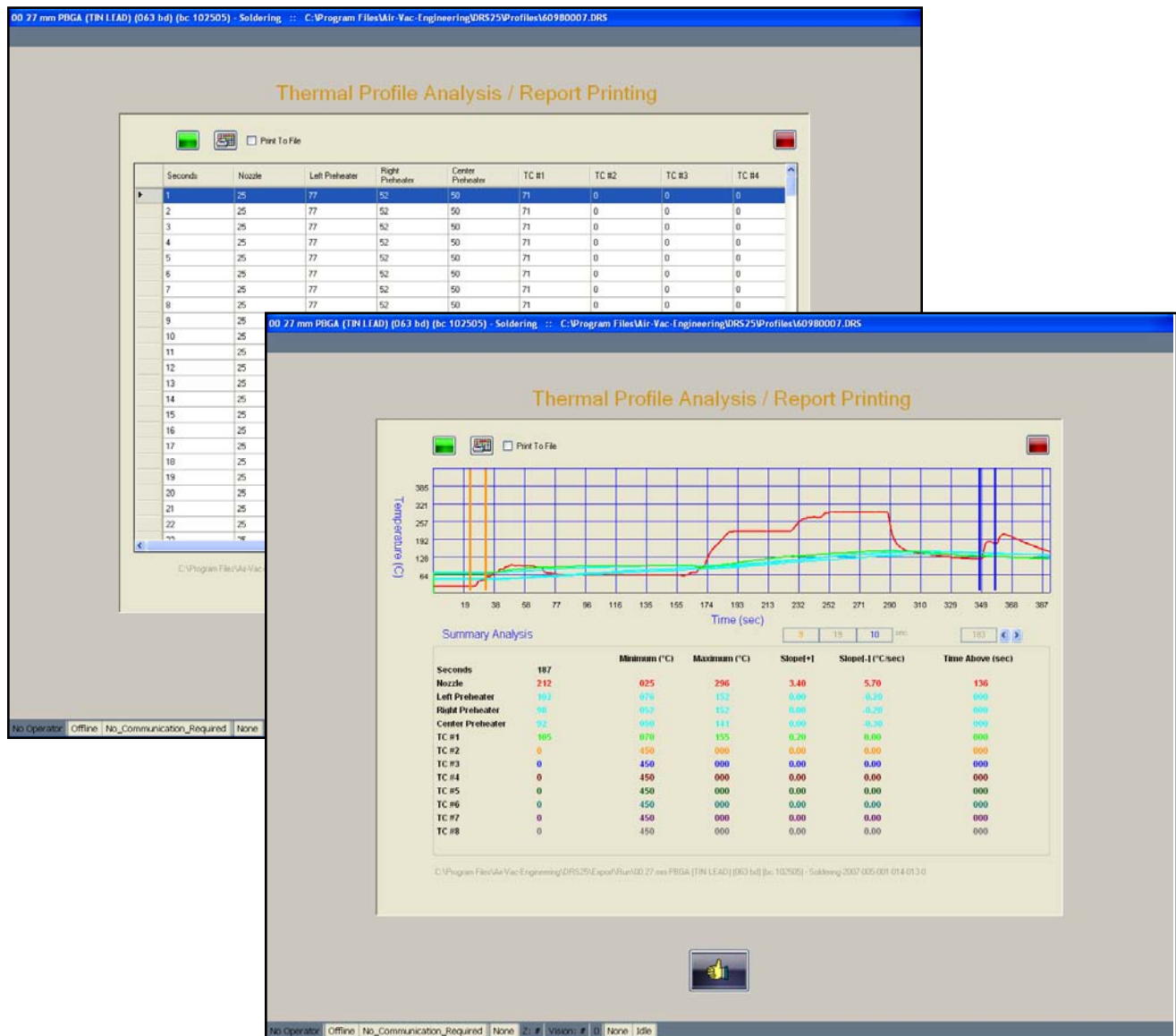
C:\Program Files\Air-Vac-Engineering\DRS27\Export\Run

- This information can be retrieved at a later time using the **Thermal Profile Analysis** utility.
- A help message will inform the operator that the graph data was successfully saved.



Thermal Profile Analysis / Printing:

This import menu allows the operator to reload and analyze historical graph data. Graph data is organized and stored using an 8 digit file sequence number.



- Clicking on the green button will present a file browse window allowing the operator to select chart data files from one of the following folders:

C:\Program Files\Air-Vac-Engineering\DRS27\Export\Run

C:\Program Files\Air-Vac-Engineering\DRS27\Export\Tutor

- Clicking on the red button will toggle the display from line graphics to a to data point table.

Thermal Profile Analysis / Printing

This import menu allows the operator to analysis historical graph data.



Clicking on Control / Thermal Profile Analysis / Printing will display the following screen.

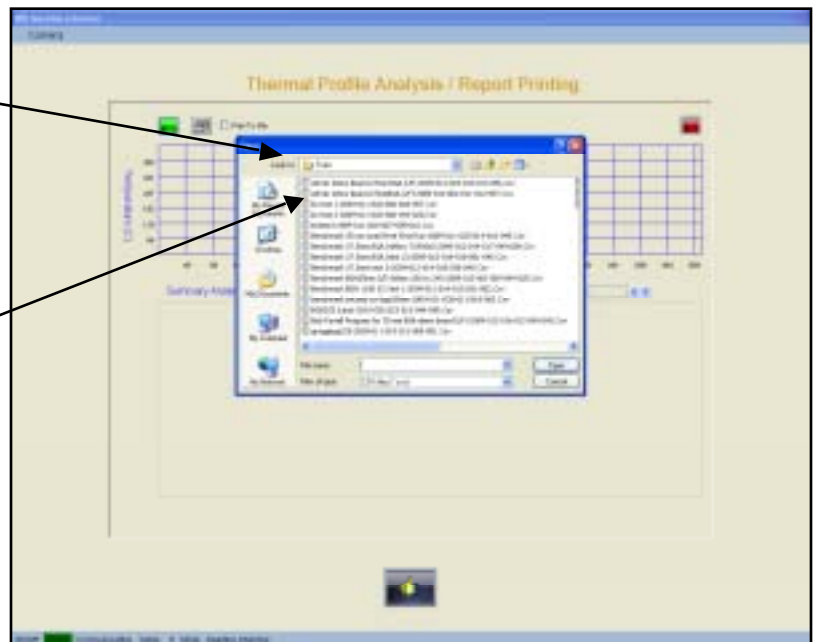
Clicking on the green button will present a file browse window allowing the operator to select chart data files from one of the following folders.

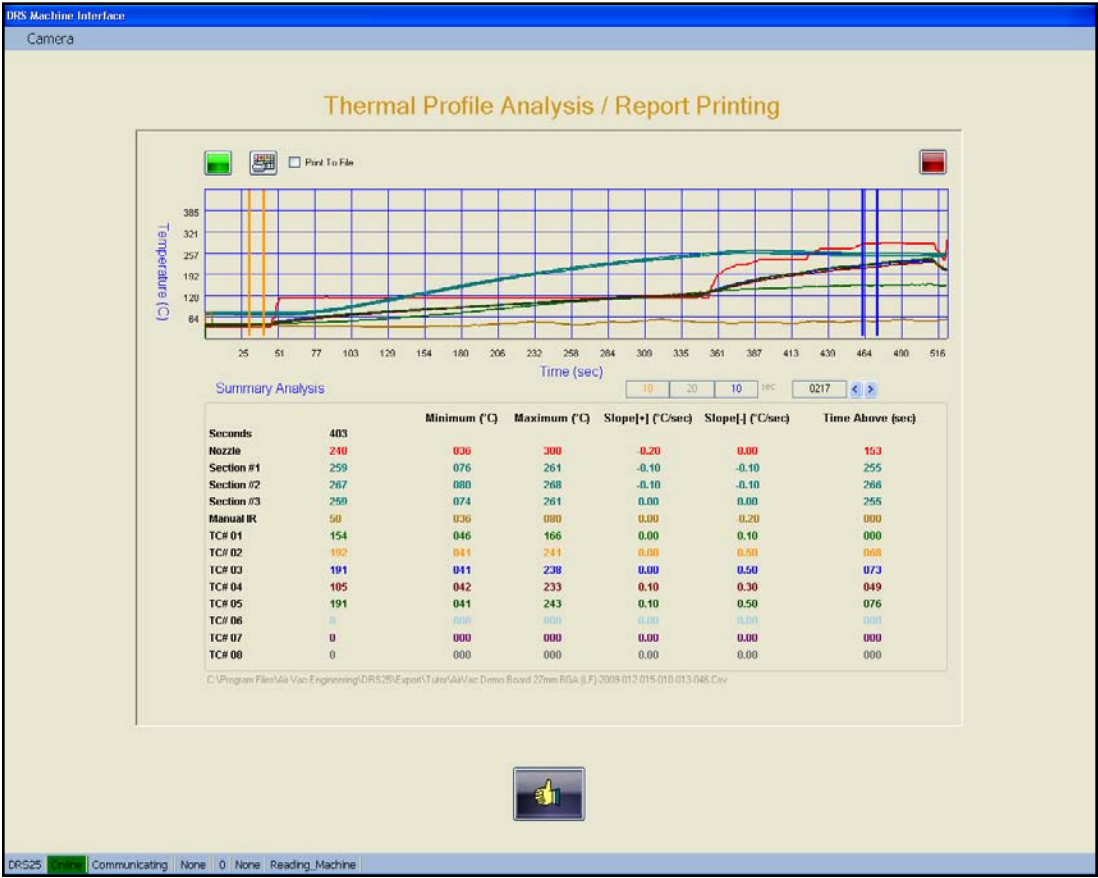


C:\Program Files\Air-Vac-Engineering\
DRS27\Export\Tutor

Or, C:\Program Files\
Air-Vac-Engineering\DRS27\Export\Run

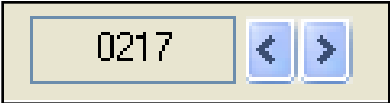
Click on the File to analysis.





Various thermal analysis can be reviewed such as maximum joint temperature, maximum package temperature, time over set temperature, etc.

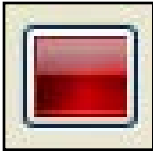
To change set temperature input desired temperature in box



To view specific slopes move vertical bars

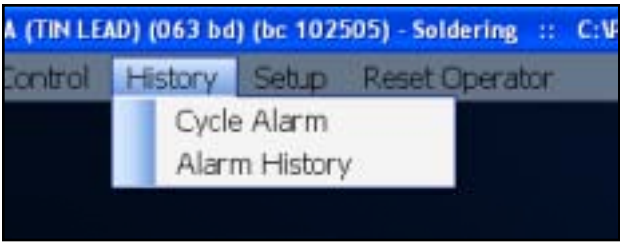


Clicking on the red button will toggle the display from line graphics to a data point table.



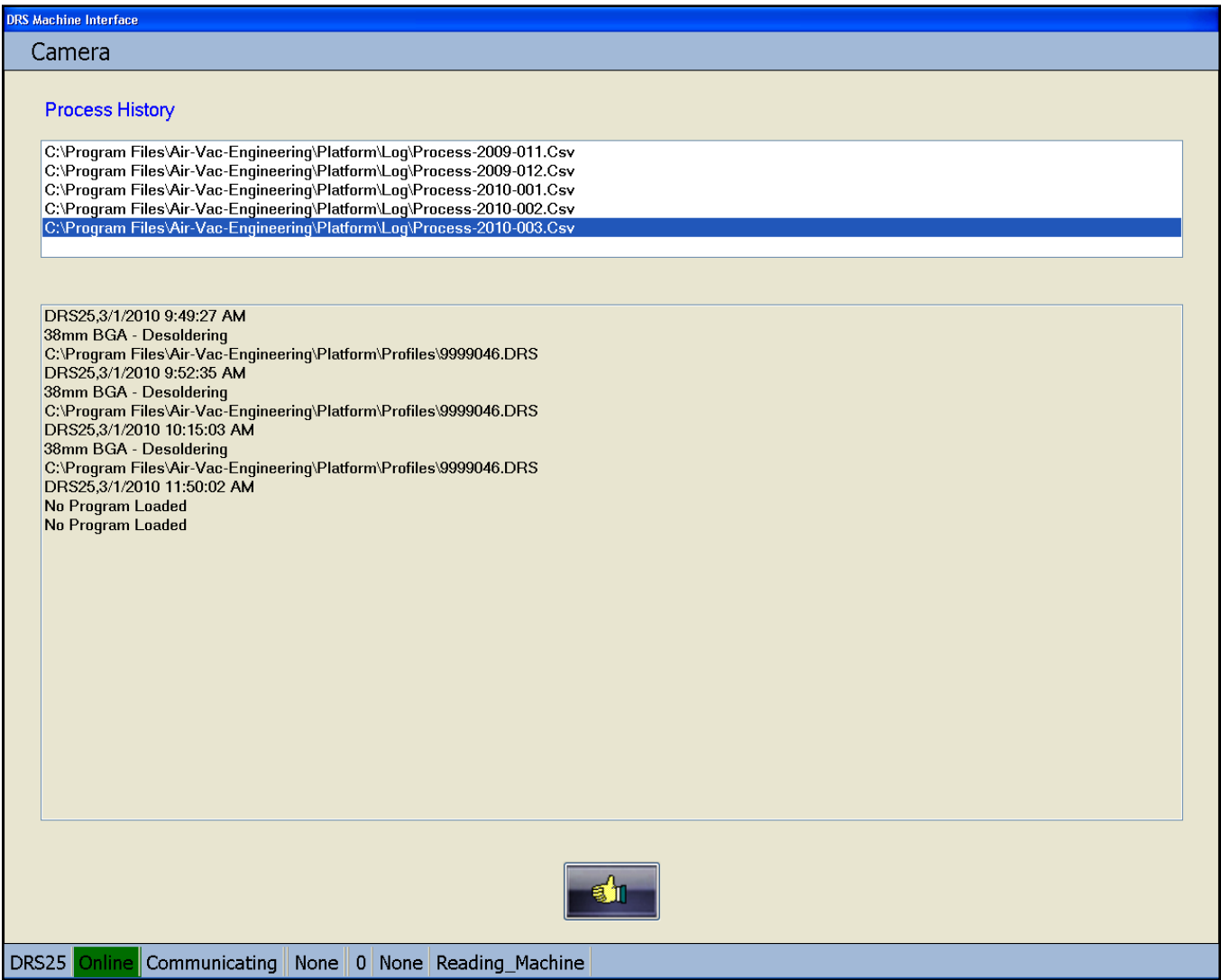
4.3 History Menu

The **History** menu has two options: **Cycle** and **Alarm**.



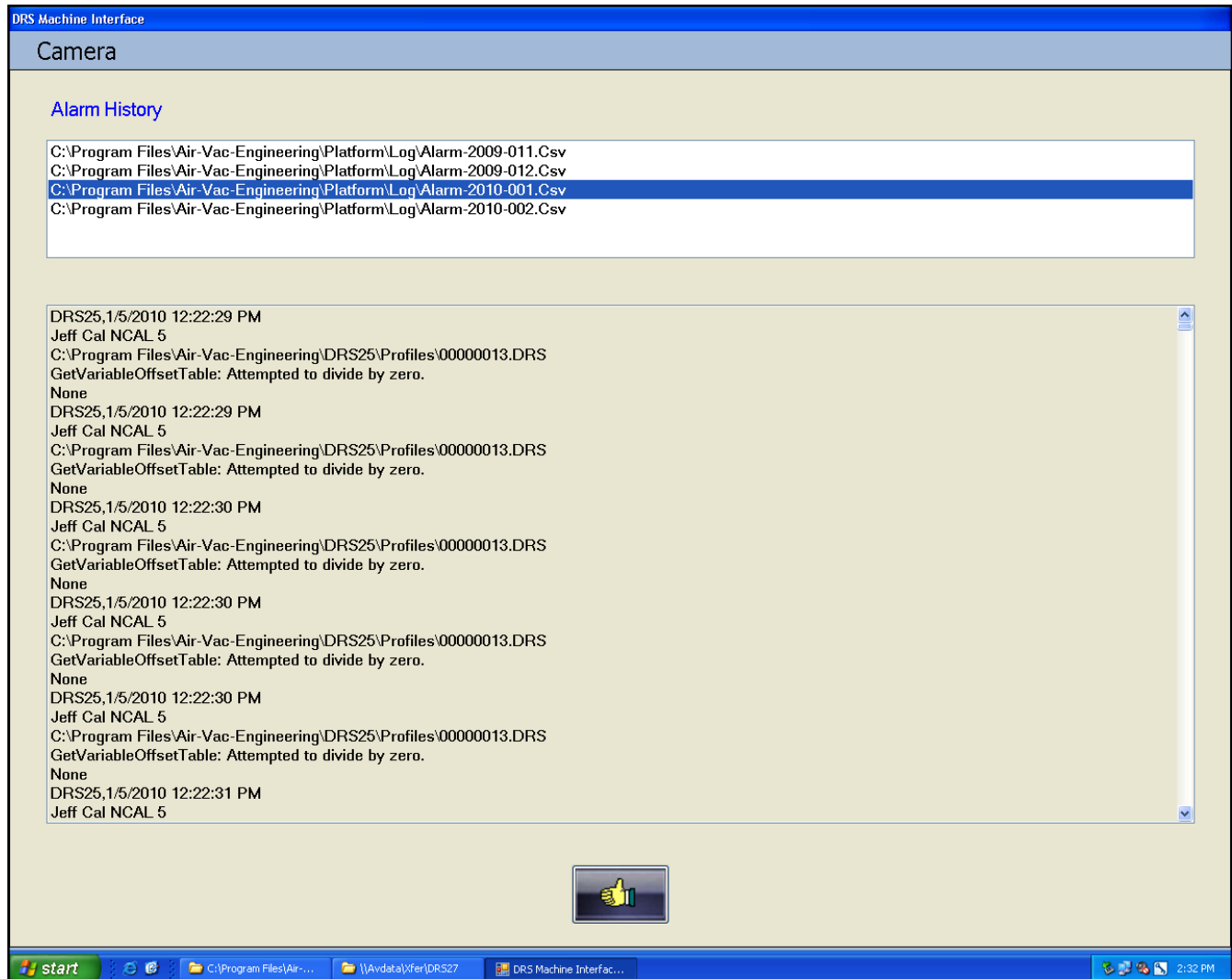
Cycle History:

A **History** file entry is recorded each time the operator cycles a process profile.



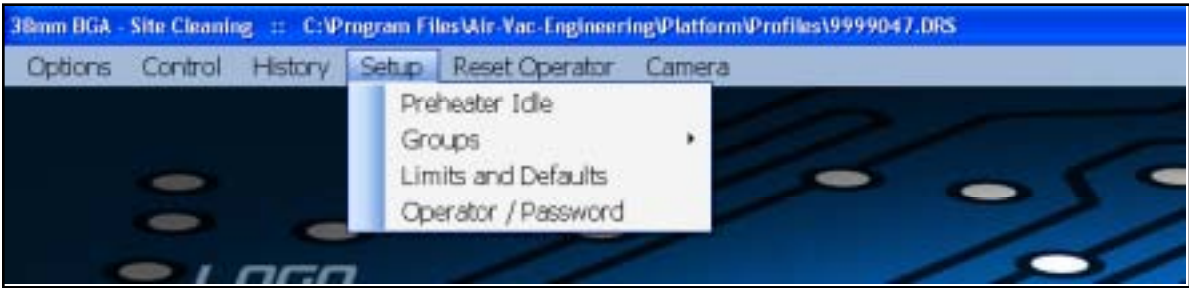
Alarm History:

The software continuously monitors the controlling sub-systems. If an alarm condition occurs for any process or hardware issue, an **Alarm** file entry will be recorded.



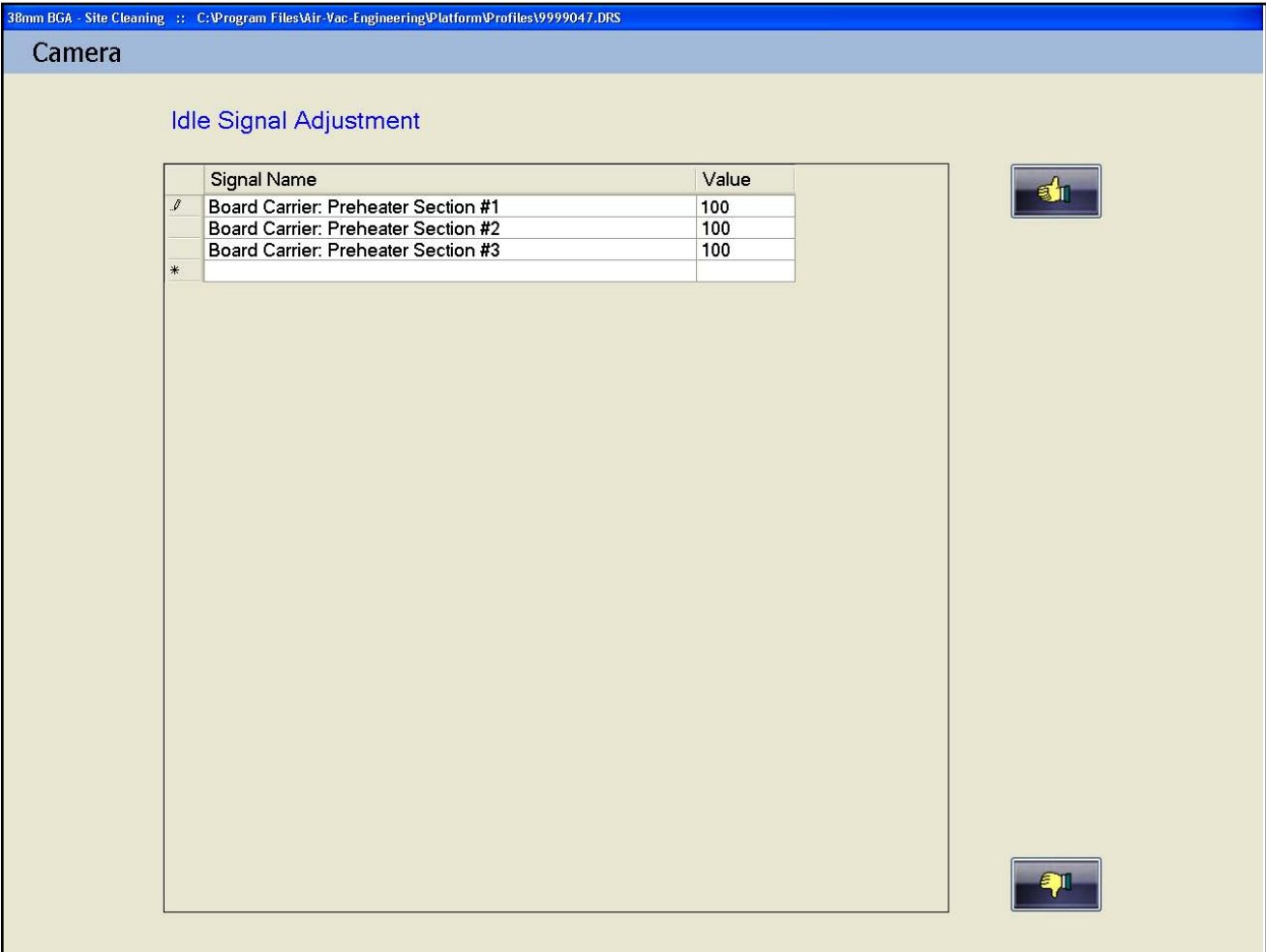
4.4 Setup:

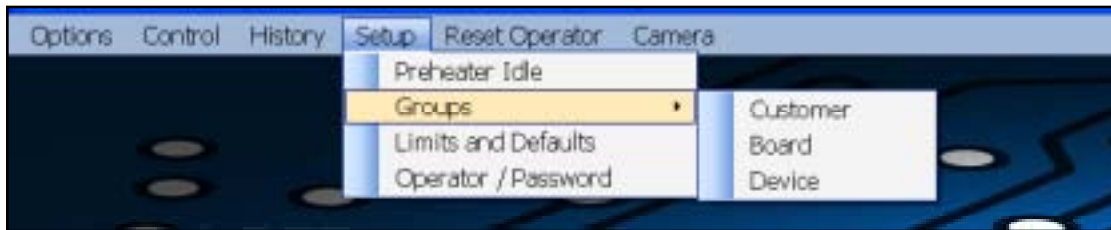
The standard **Setup** menu allows the operator to adjust machine related setup or control parameters. These options are only available to high priority operators.



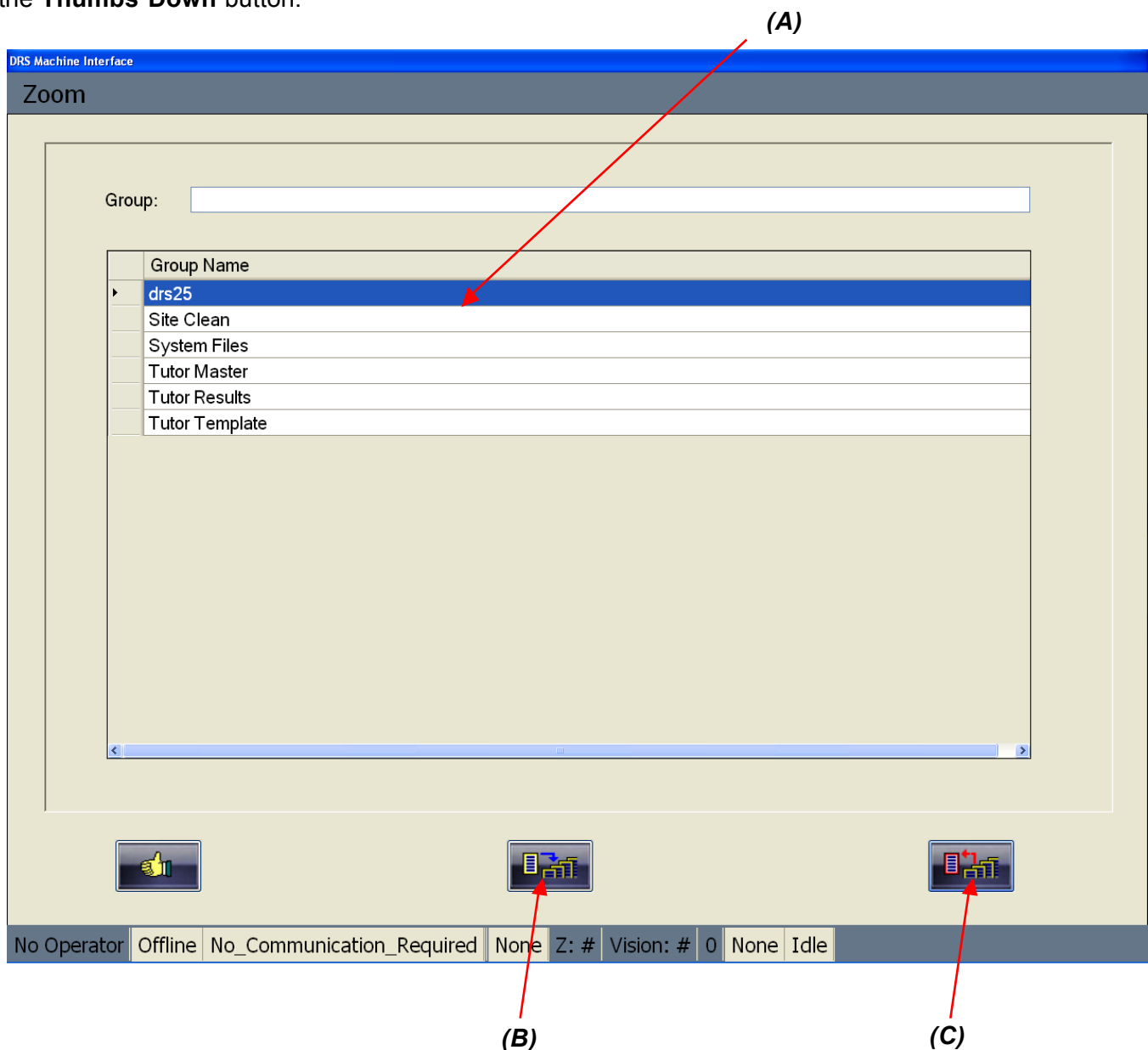
Preheater Idle:

Selecting the **Preheater Idle** from the **Setup** menu will present the operator with the **Preheater Idle Control** screen. These settings are global and will control the preheater during all screens except the **Run** screen. Individual profiles will control the preheater based on process requirements.



Customer, Board and Device Group Setup Screens:

The group maintenance screens allow the operator to create or delete a group. To create a new group name, type the desired group name into the group edit box (A). Click on the **New / Add Entry** button to insert the new group into the existing list (B). To delete a group, the operator must first highlight the group. Next, the operator can click on **the Delete Highlighted Entry** button (C) to remove the entry from the list. To save these changes, click on the **Thumbs Up** button. To cancel any changes, click on the **Thumbs Down** button.



Limits and Defaults:

This screen is used is primarily used to modify the default profile groups used by the Open profile option.

The process temperature limits are for reference only.

The screenshot displays the 'Camera' application window. The title bar shows the file path: '38mm BGA - Soldering :: C:\Program Files\Air-Vac Engineering\Platform\Profiles\9999045.DRS'. The main window has a light beige background and a blue header bar with the word 'Camera'.

Process Temperature Limits

This section contains two input fields for 'Default Solder Reflow Temperatures'. The first field contains the value '183' and the second field contains '217'. To the right of these fields is a checkbox labeled 'Use Lead Free', which is checked. A thumbs-up icon is located to the right of this section.

Profile Groups

This section contains three dropdown menus, all of which are set to 'DRS27':

- Customer Group
- Board Group
- Device Group

A thumbs-down icon is located to the right of this section.

The Windows taskbar at the bottom shows the 'start' button, several open applications (including '38mm BGA - Solderin...'), and the system clock showing '8:57 AM'.

Operator / Password Setup Screen:

This screen is used to modify the registered operator list. Operators are grouped into two categories:

High priority (Administrator): These operators have access to all screens. Caution should be taken when defining these operators. All critical machine parameters or process profiles can be adjusted.

Low priority (Operator): Operators can only run existing profiles and are not allowed to make process adjustments.

The password edit boxes are used to enter/modify/verify the password associated with each operator priority level.

The screenshot shows the 'DRS Machine Interface' window with a 'Zoom' title bar. The main area contains a form for setting up an operator. The form includes the following fields and controls:

- User Name:
- Full Name:
- Description:
- Password:
- Reenter Password:
- Group: (dropdown arrow)
- Language: (dropdown arrow)
- Motion Units: (dropdown arrow)
- Temperature Units: (dropdown arrow)
- Force Units: (dropdown arrow)

Below these fields is a section titled 'Operators' containing a table:

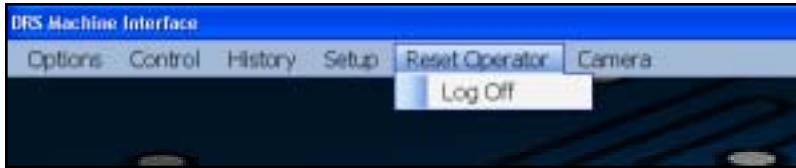
	User Name
▶	DRS25
	OPERATOR

At the bottom of the window, there are three icons: a thumbs up, a factory, and a red stop sign. The status bar at the very bottom displays the following information: No Operator | Offline | No_Communication_Required | None | Z: # | Vision: # 0 | None | Idle

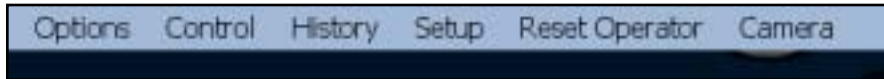
Users can have different machine units (Motion, Temperature and Force) defined as a login preference.

4.5 Reset Operator:

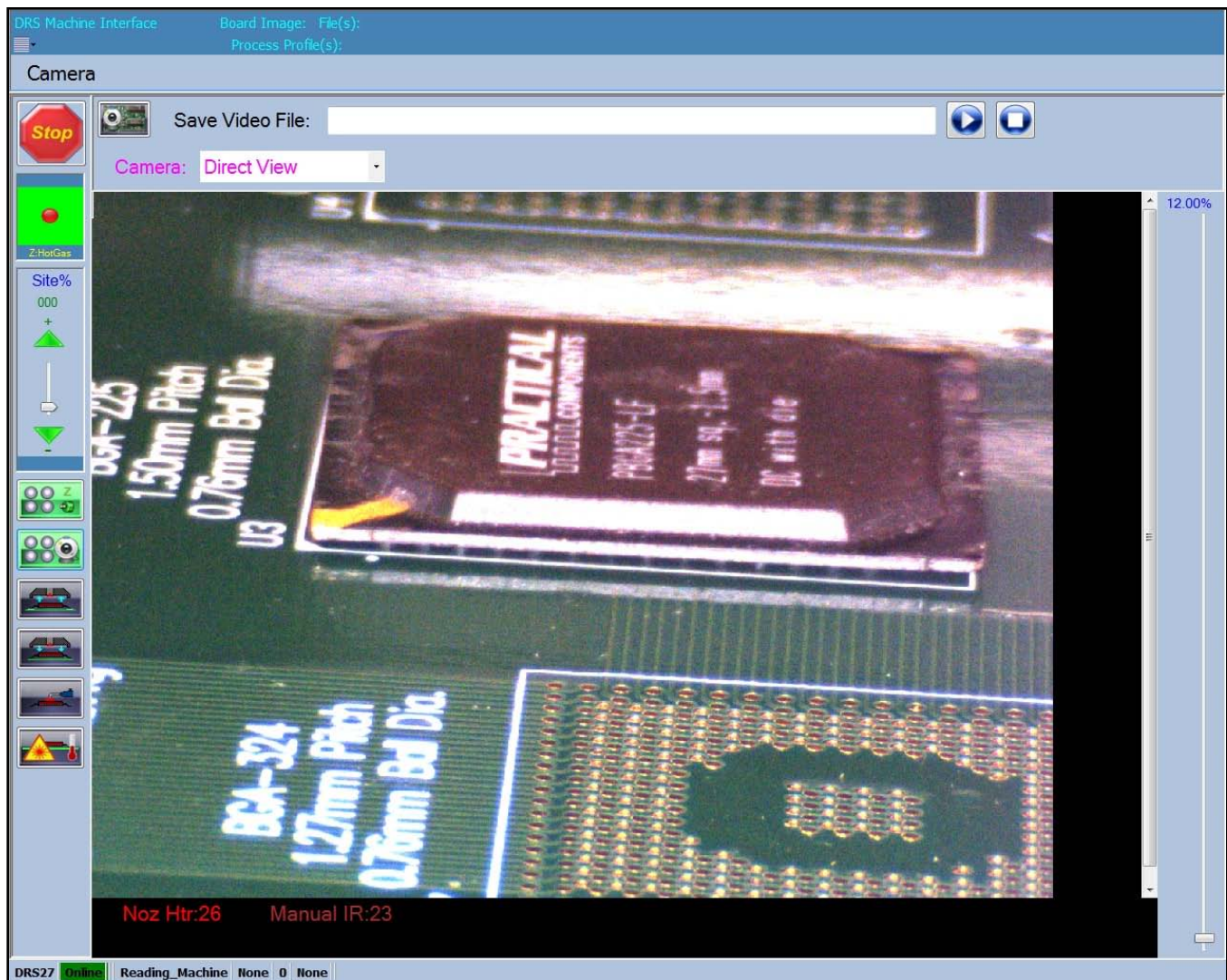
Click on the **Reset Operator / Log Off** option on the menu bar and the **Operator Login** screen will be displayed. Log in again followed with your security access code to gain access to the DRS27 machine.



4.6 Camera:



Click on the **Camera** option on the menu bar and the **Camera** screen will be displayed. The screen is to access the Vision System or Direct View (option) camera. The Camera screen will automatically be displayed when the Alignment Motion-Object Alignment-Board Carrier, Inspection-Inspection-Board Carrier, or Inspection-Inspection-Direct View box in the teach screen is activated.

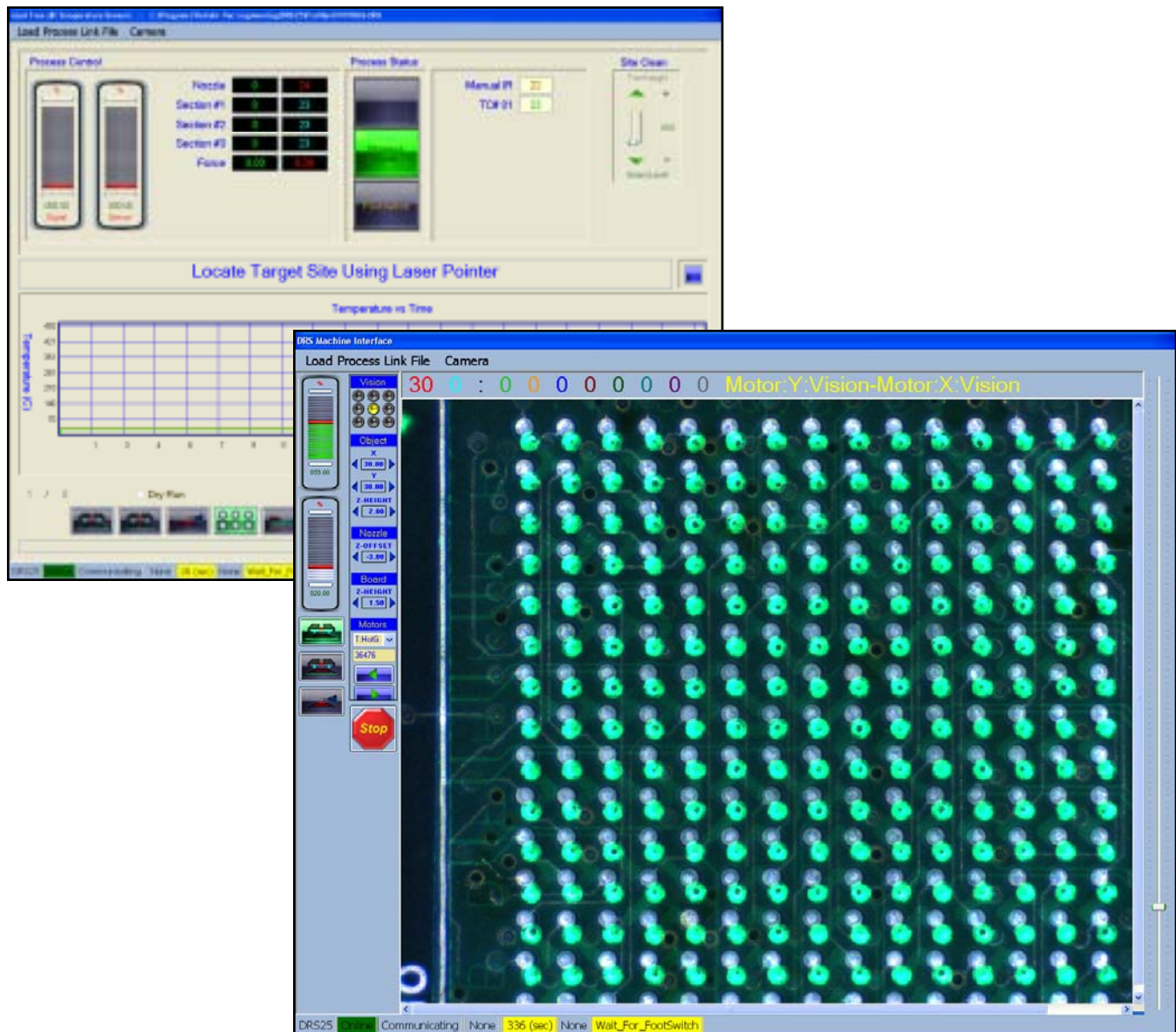


4.7 Camera Views

The camera screen is typically used for: component alignment or site inspection in conjunction with the vision system camera. Or, site cleaning and viewing reflow with the direct view camera. It is typically programmed in the inspection block, inspection vision system or inspection direct view. It can also be manually activated on the run screen.

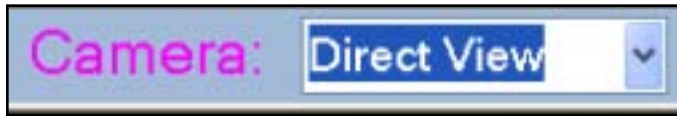
4.7.1 Vision System- Component Alignment

The camera screen will normally be activated automatically during the component replacement process. It is programmed in the Inspection block, Inspection-Vision System. The message "Locate Target Site Using Laser Pointer" will be shown on the run screen. Then the camera screen will be activated. Settings of the view are set by the programmer. The operator has the ability to change settings for personal viewing preference.



4.7.2 Direct View Camera

The direct view camera is typically programmed and will be viewed automatically in the direct view mode. The direct view mode can be activated manually in the run screen and using pull down menu activated.

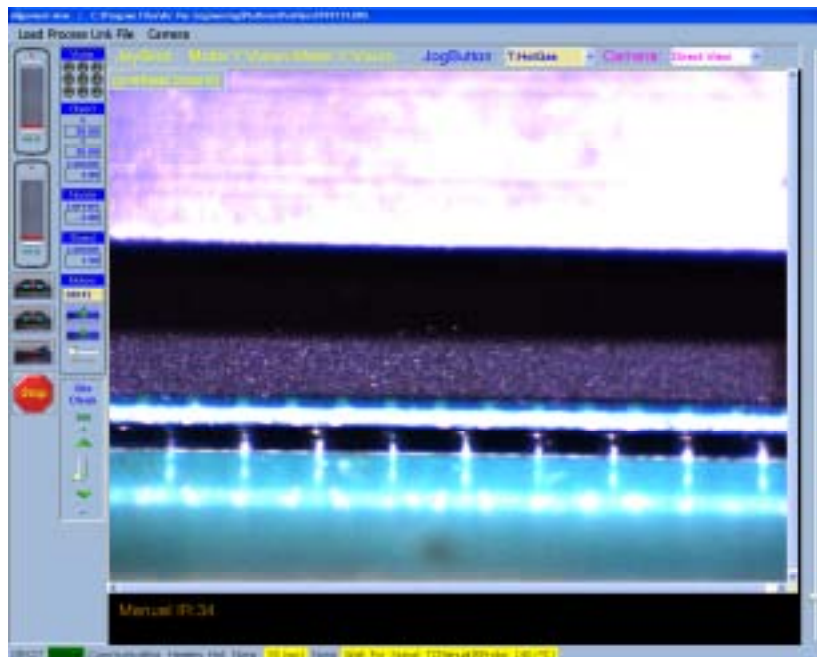


The DRS27 lights are turned on/off by the z-axis lights icon.

The camera lights are turned on/off by the camera light icon.

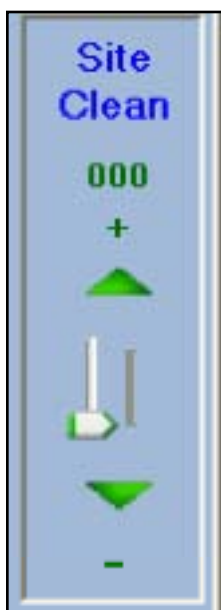
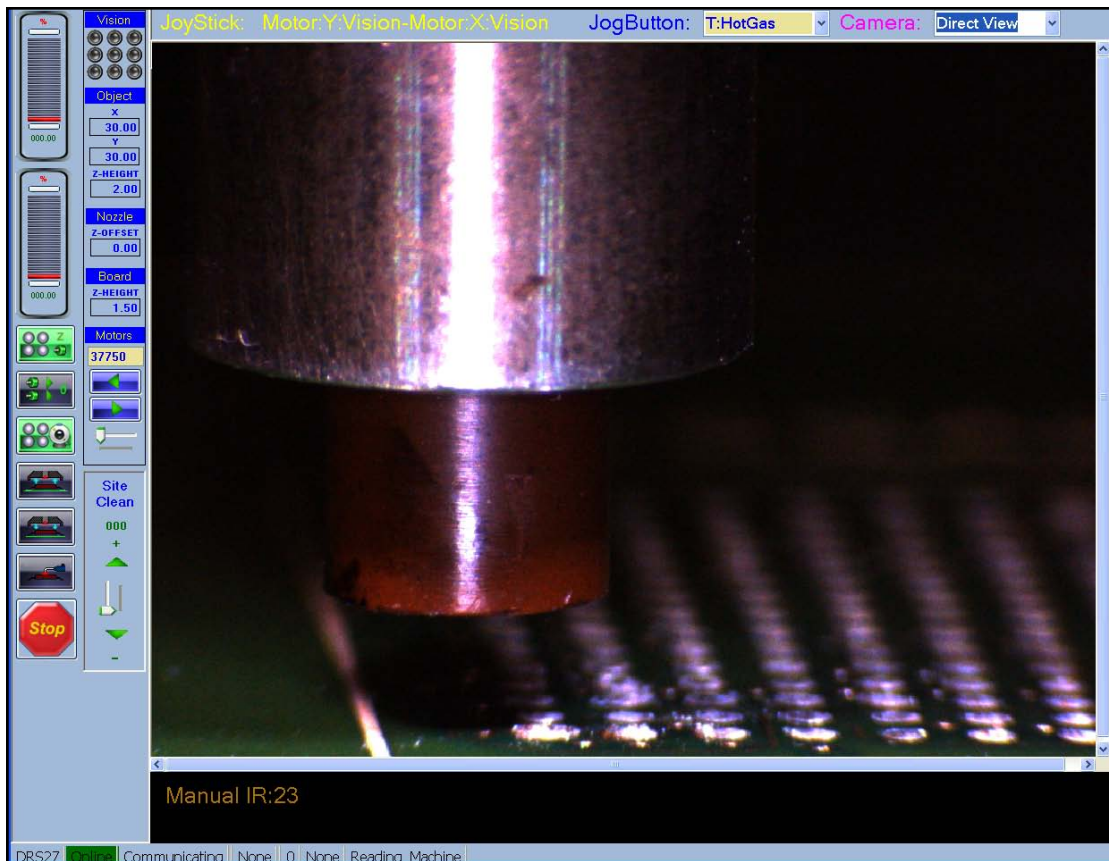
4.7.3 Direct View Camera – Reflow View

The direct view camera can be utilized to view solder reflow.



4.7.4 Site Cleaning

The direct view camera can provide close up view of the site cleaning process.



The z-height position can be adjusted using the site clean up/down arrows (+/-). The vacuum sensor of the site cleaning program will continue to automatically adjust based on the new settings.

4.8 Protected System Security Access:

To access the Protected System Menu, the user must click on the Air-Vac logo with the right mouse button. The menu background color will change to red. The menu options will be changed to allow access to machine calibration and critical properties / parameters.



The Protected System Security Menu consists of:

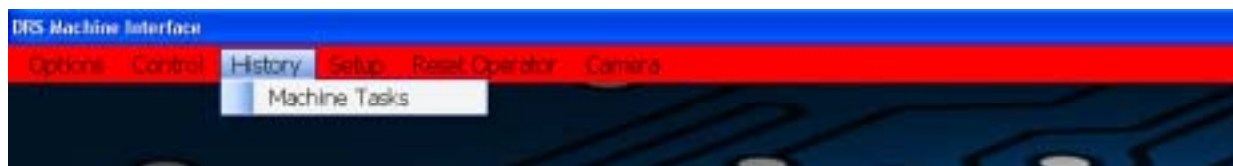
Options:



Control:



History



Setup



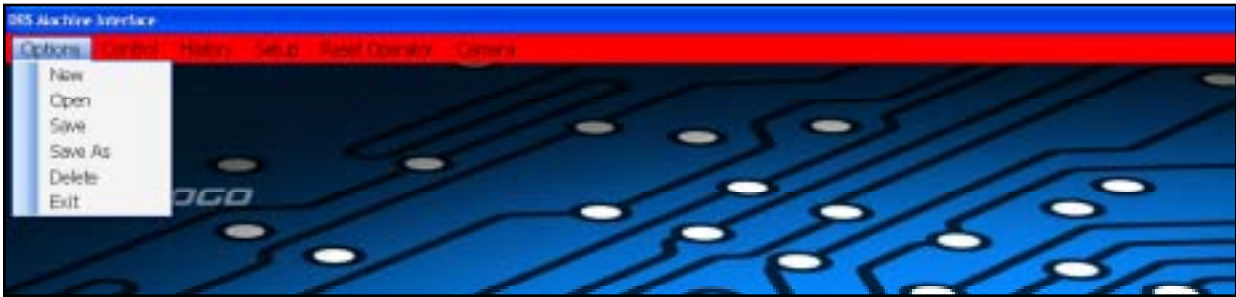
Reset Operator



Camera



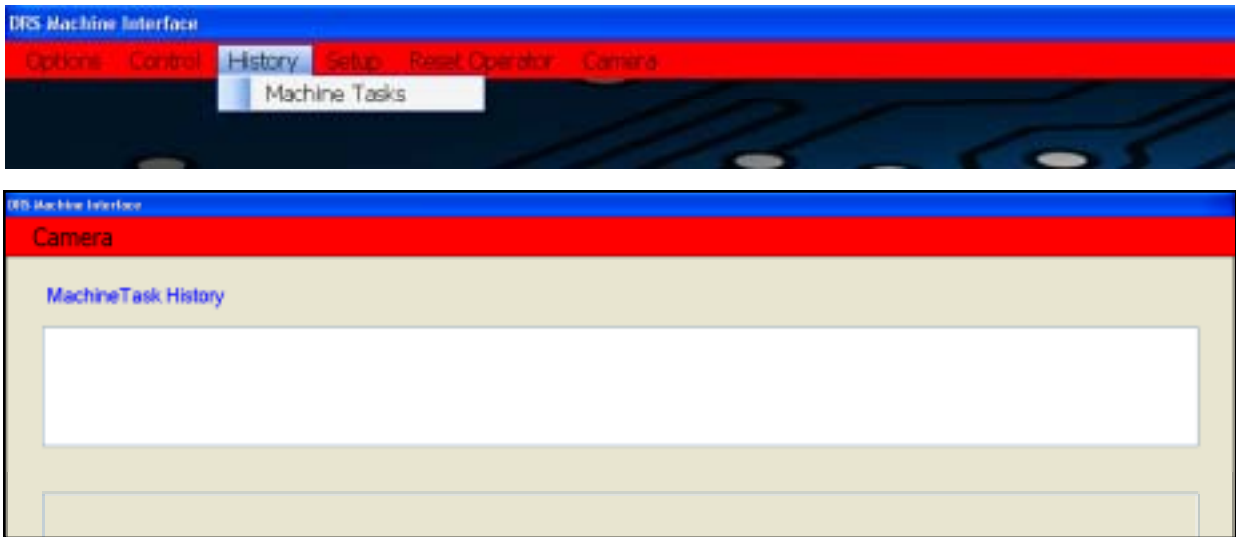
Options functions are the same as in the main menu.



Control functions are the same as in the main menu.



History function includes Machine Tasks

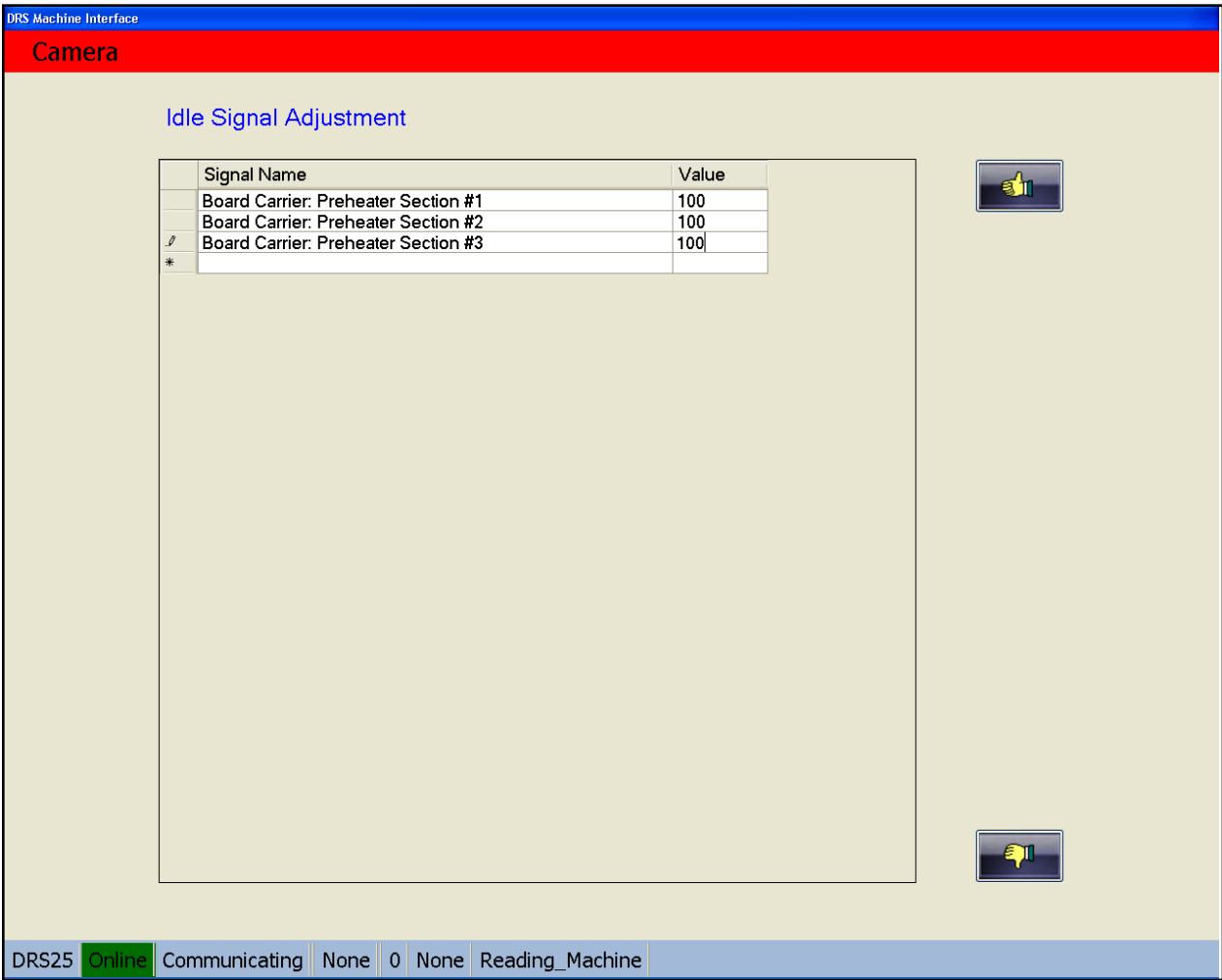


4.8.1 Preheater Idle

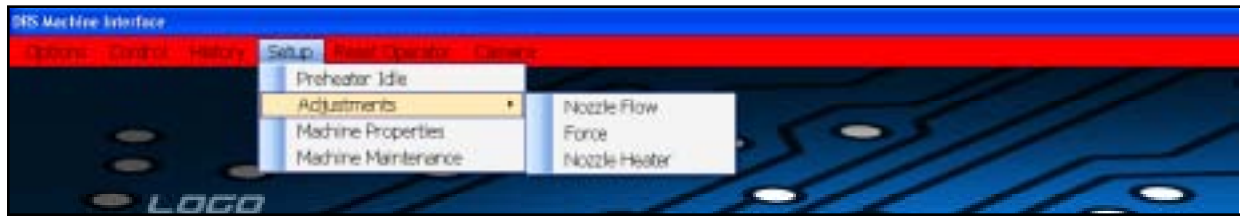


This menu option performs the same functionality as the standard operator idle option.

Selecting the **Preheater Idle** from the **Setup** menu will present the operator with the **Preheater Idle Control** screen. These settings are global and will control the preheater during all screens except the **Run** screen. Individual profiles will control the preheater based on process requirements.



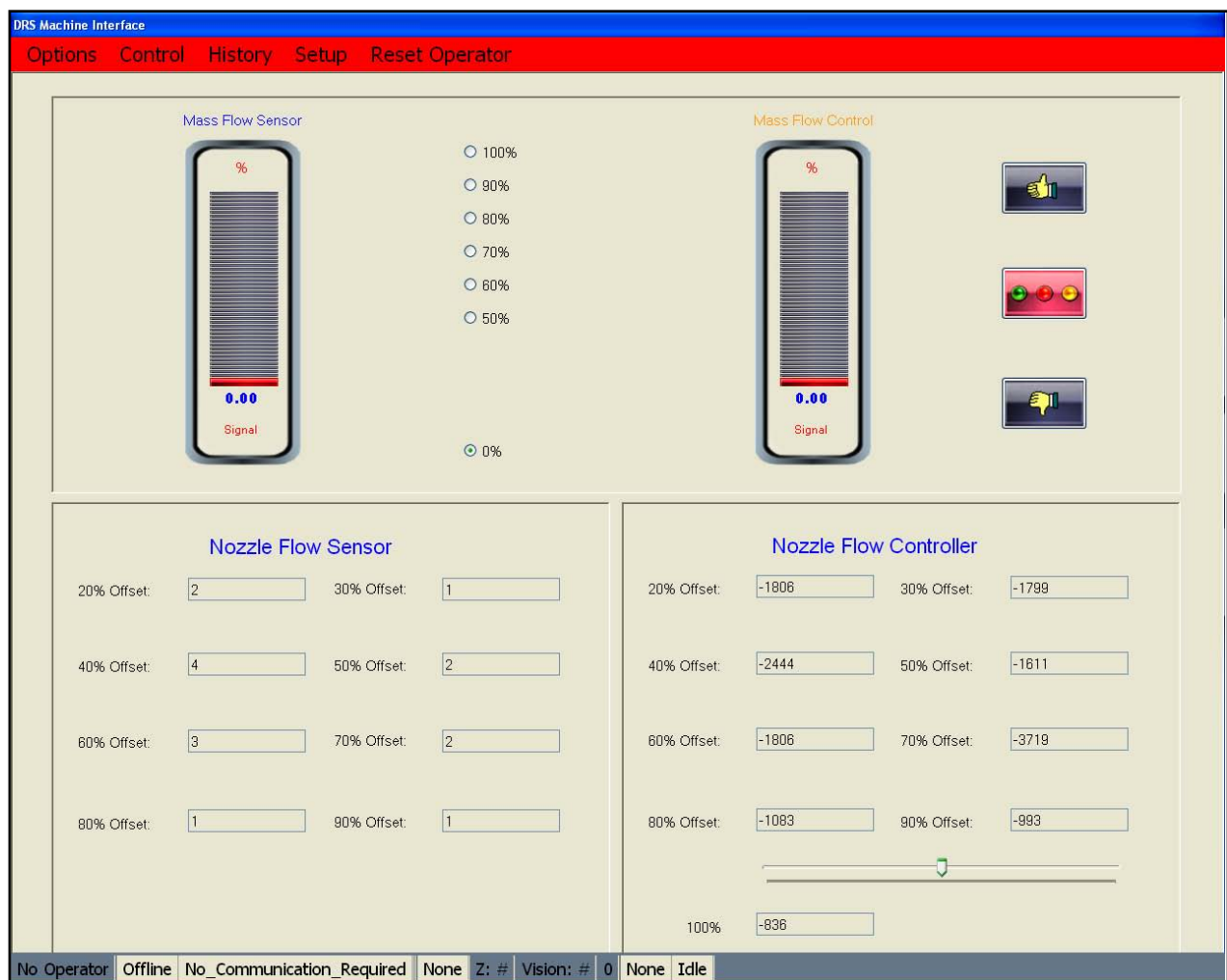
Adjustments:



- Nozzle Flow:

The Nozzle Air Flow is calibrated by adjusting the offset parameters. These offsets are set for each air-flow percentage reference, and calibrated to a certified flow meter. The Flow Sensor and Flow Controller have individual dial indicators and are adjusted individually starting at 100%.

Slide bars make adjustments easier and only the target flow rate that is currently being change; this reduces accidental adjustment to different flow rate parameters.



- Force Adjustment:

This screen is used to provide adjustment and calibration to the force system. This activity is performed at the factory and normally does required customer adjustments.

DRS Machine Interface

Camera

Force System

☒ Grams

☐ Newtons

Weight:

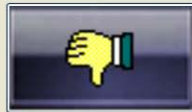
Force Limit:

Sensor:









DRS25	Online	Communicating	None	0	None	Reading_Machine
-------	--------	---------------	------	---	------	-----------------

- Nozzle Heater

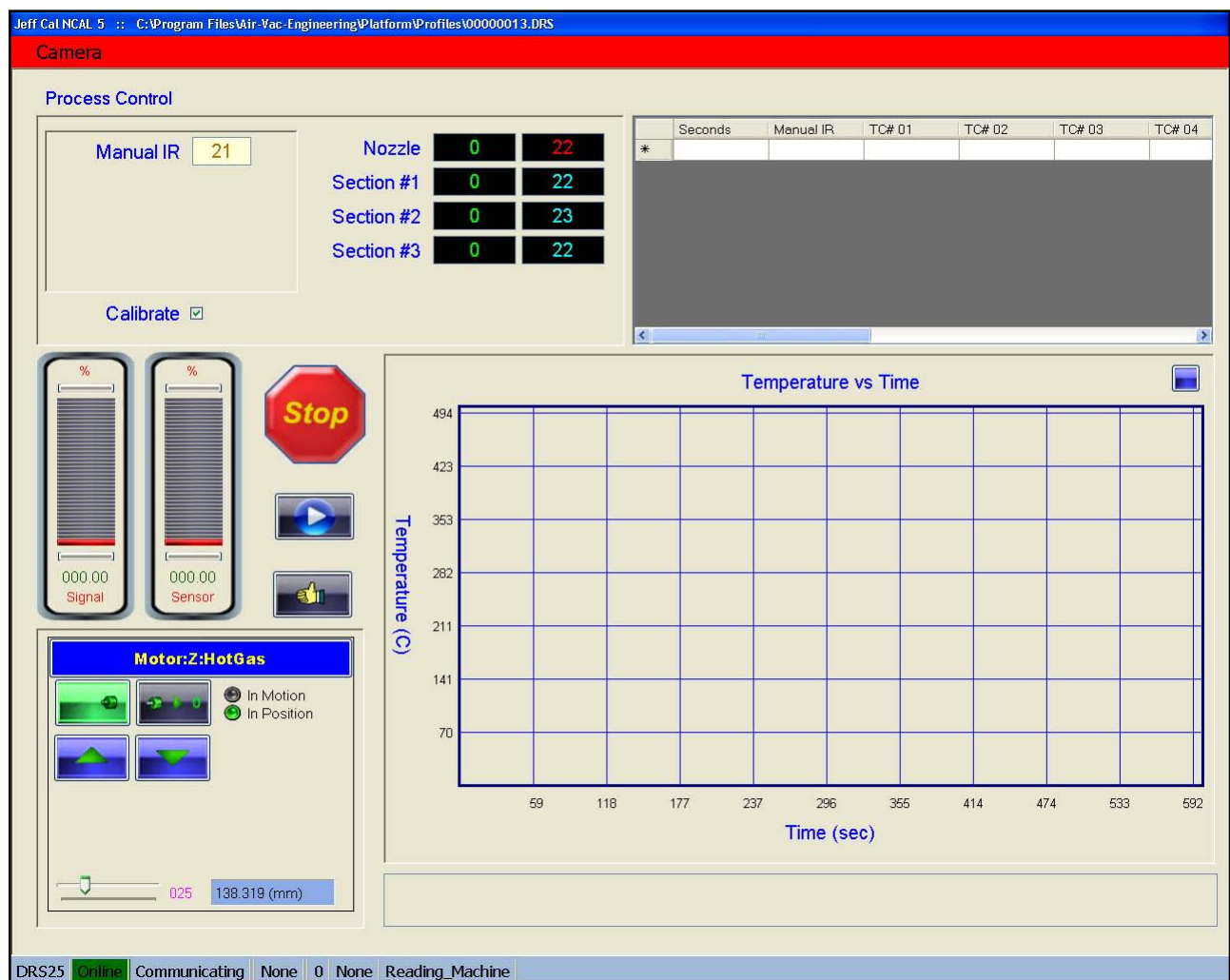
This screen is used to perform the automatic nozzle heater calibration.

Temperature offsets are calibrated based on flow rate (20-100%).

Adjustments to individual calibration points should not be made.

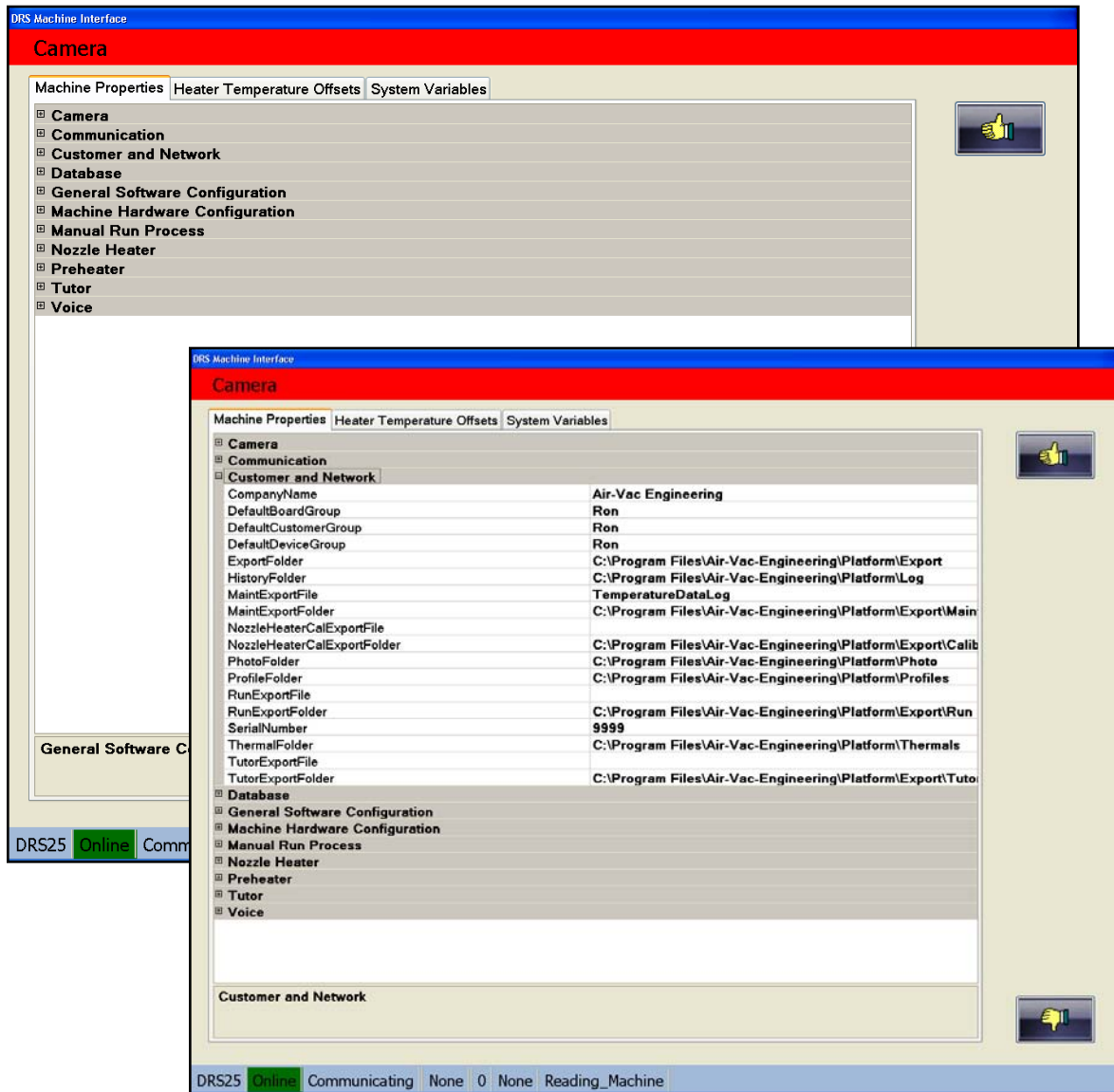
Adjustments are available to influence the automatic adjustment/decision logic (contact Air-Vac factory technicians).

To start the calibration sequence the operator need only plug the NCAL-5 nozzle into thermocouple channel #1 and click on the start button. The cycle will run for 25-35 minutes. All necessary offsets are automatically computed. Click the up-thumb button to save the results.



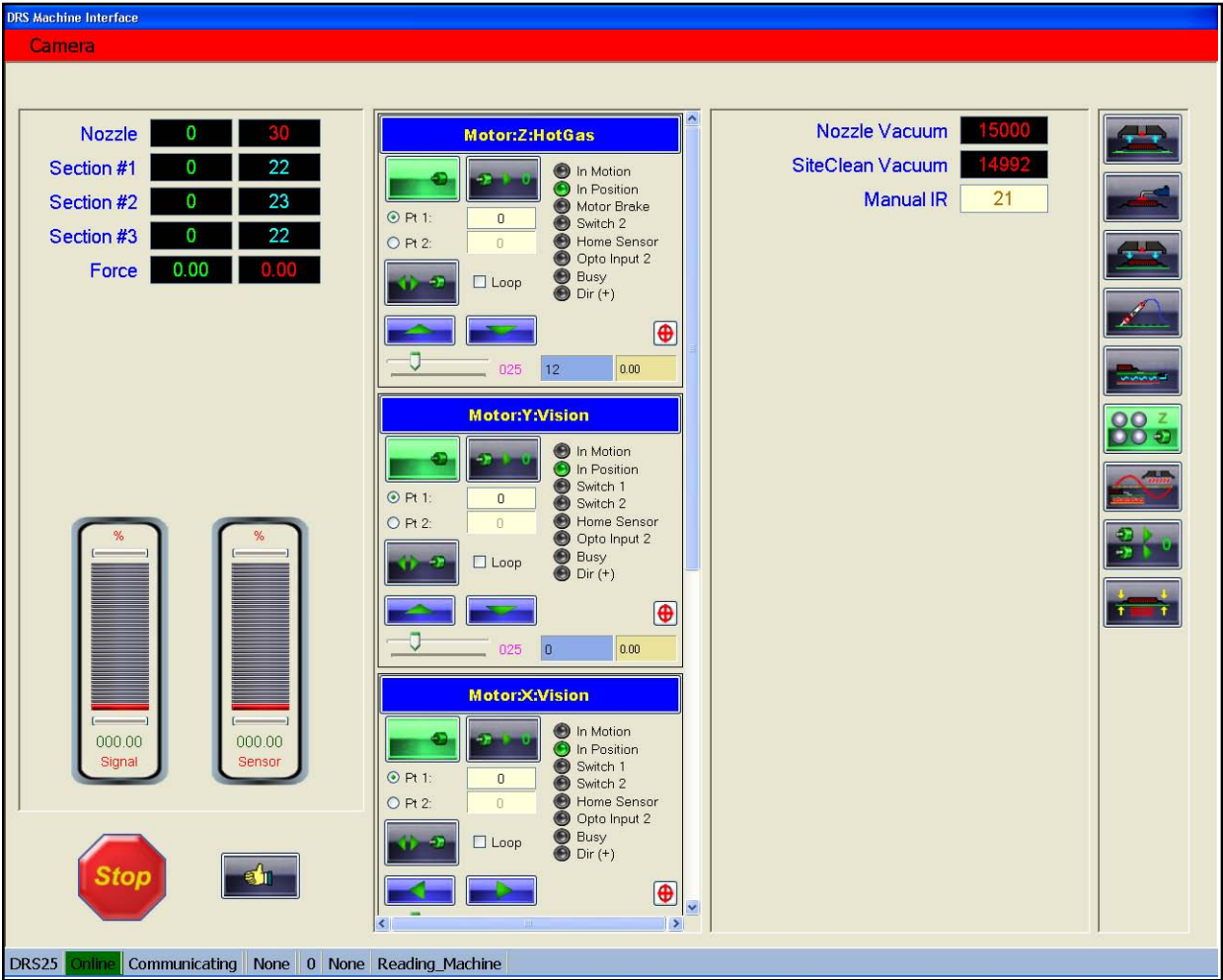
Machine Properties:

- All machine properties (control / setup parameters) are connected to this screen.
- Machine properties associated with different peripherals to be quickly adjusted.
- Click on the plus sign (+) to expand a category.
- Use caution before making any critical machine control properties.



Machine Maintenance:

This screen offers access to all machine the interface / control signals. This screen is normally used to test individual control signals diagnose a repeatable issue.



5: Process Development Guide/Engineering Training

- 5 **Process Development Guide/Engineering Training** 3
 - 5.0 PROFILE TUTOR SOFTWARE 3
 - 5.0.1 OVERVIEW 4
 - 5.0.2 PHYSICAL SETUP 4
 - 5.0.3 CREATING A THERMAL PROFILE 6
 - 5.0.4 TUTOR SCREEN: THERMAL ANALYSIS..... 28
 - 5.0.5 RUNNING A SECOND THERMAL CYCLE 29
 - 5.0.6 THERMAL PROFILE RECORD KEEPING 31
 - 5.0.7 PROFILE BUILD 34
 - 5.0.8 PROGRAM EXECUTION 40
 - 5.0.9 DIRECT VIEW CAMERA SOFTWARE SCREEN & LIVE VIEW 43

5 Process Development Guide/Engineering Training

5.0 Profile Tutor Software



Access to Profile Tutor requires high operator password level.

5.0.1 Overview

The DRS27 Process Development Guide is designed to allow novice users to create and run new processes. There are five (5) steps to creating and running a new process:

1. Physical Setup
2. Profile Tutor
3. Thermal Profile Analysis
4. Auto Profile Build
5. Program Execution

Each of the five steps is documented in detail in this Process Development Guide. Please contact Air-Vac with any questions (203-888-9900; request DRS27 Process Assistance).

5.0.2 Physical Setup

IR Sensor

The IR Sensor measures and monitors board temperature during the rework process. Its main function is to insure that the board is at the same starting temperature during each rework cycle. The IR Sensor is connected to its own internal TC port. If you did not purchase the optional IR Sensor, contact Air-Vac for further instructions. Position the IR Sensor on an open area of the board 2-3 inches away from the rework site.

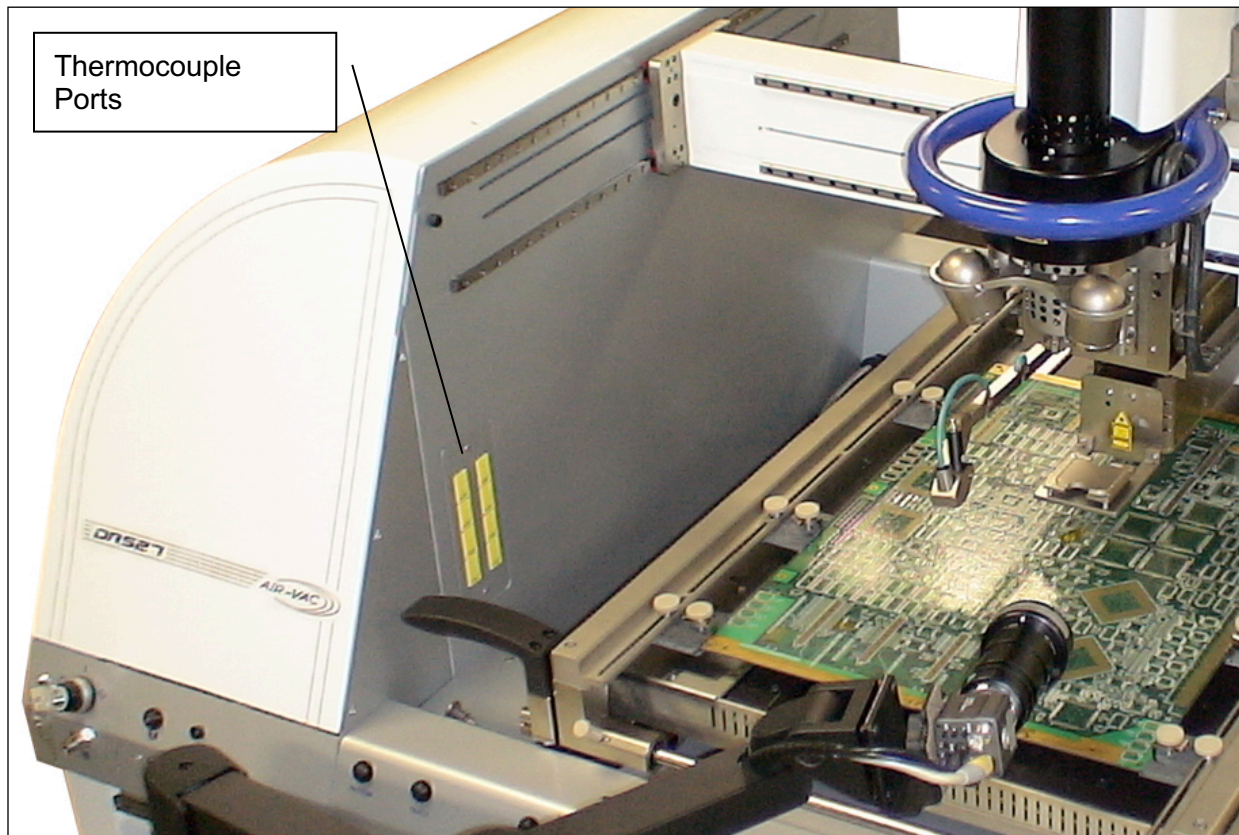
TC#1: Joints

Slide a TC underneath the BGA and plug into channel #1. If possible, slide two additional TC's underneath the BGA for additional data. For large components, 3 thermocouples will provide a good set of data to insure accurate profiling. Erroneous TC's can be removed while running the profile tutor. Air-Vac uses .003" gauge K-type TC's (1-888-TC-OMEGA, Part #5 SRTC-TT-K-40-36).

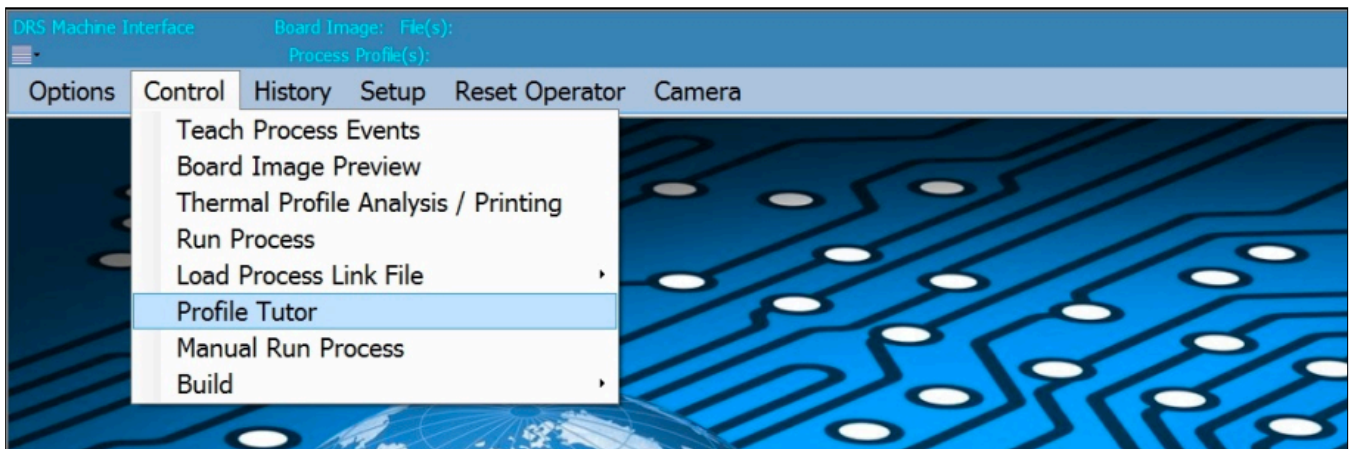
Apply Kapton tape to hold the TC's in place. If desired, x-ray will show the exact positioning of the TC head, however this is not critical. Studies have shown that TC's underneath the BGA that are not in direct contact with a solder joint are typically within -5 to 0 degrees of the joint temperature.

The major advantage of this approach is that it is non-destructive yet still highly accurate.

If the standoff height or ball density does not allow a TC to be slid underneath it, a scrap board should be drilled from the bottom, TC's installed into the joints are then epoxied in place.

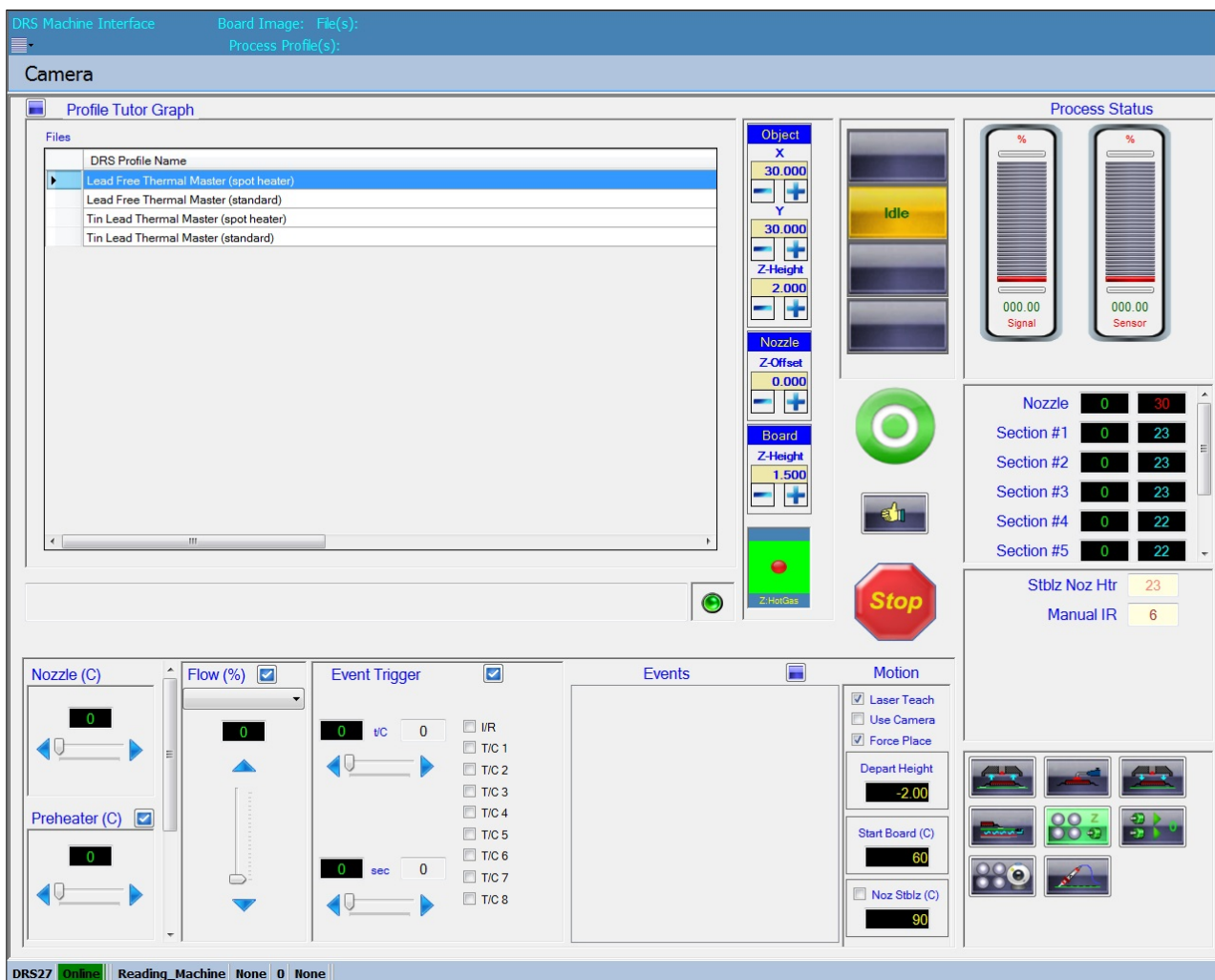


5.0.3 Creating a Thermal Profile

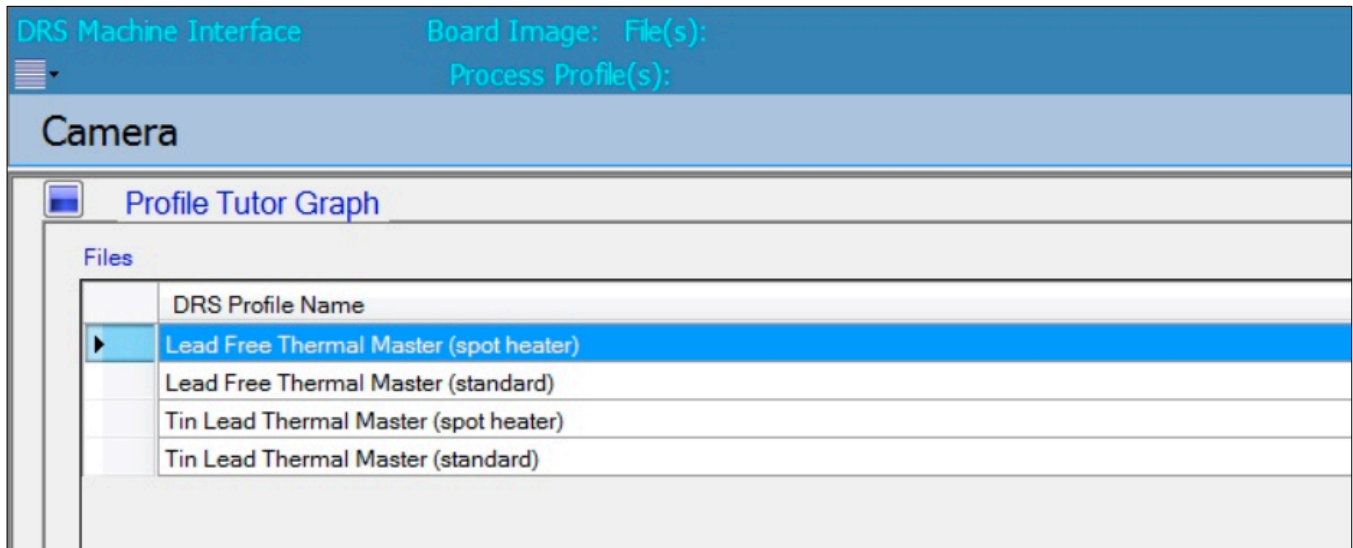


- From the toolbar, select **Control** then **Profile Tutor**.

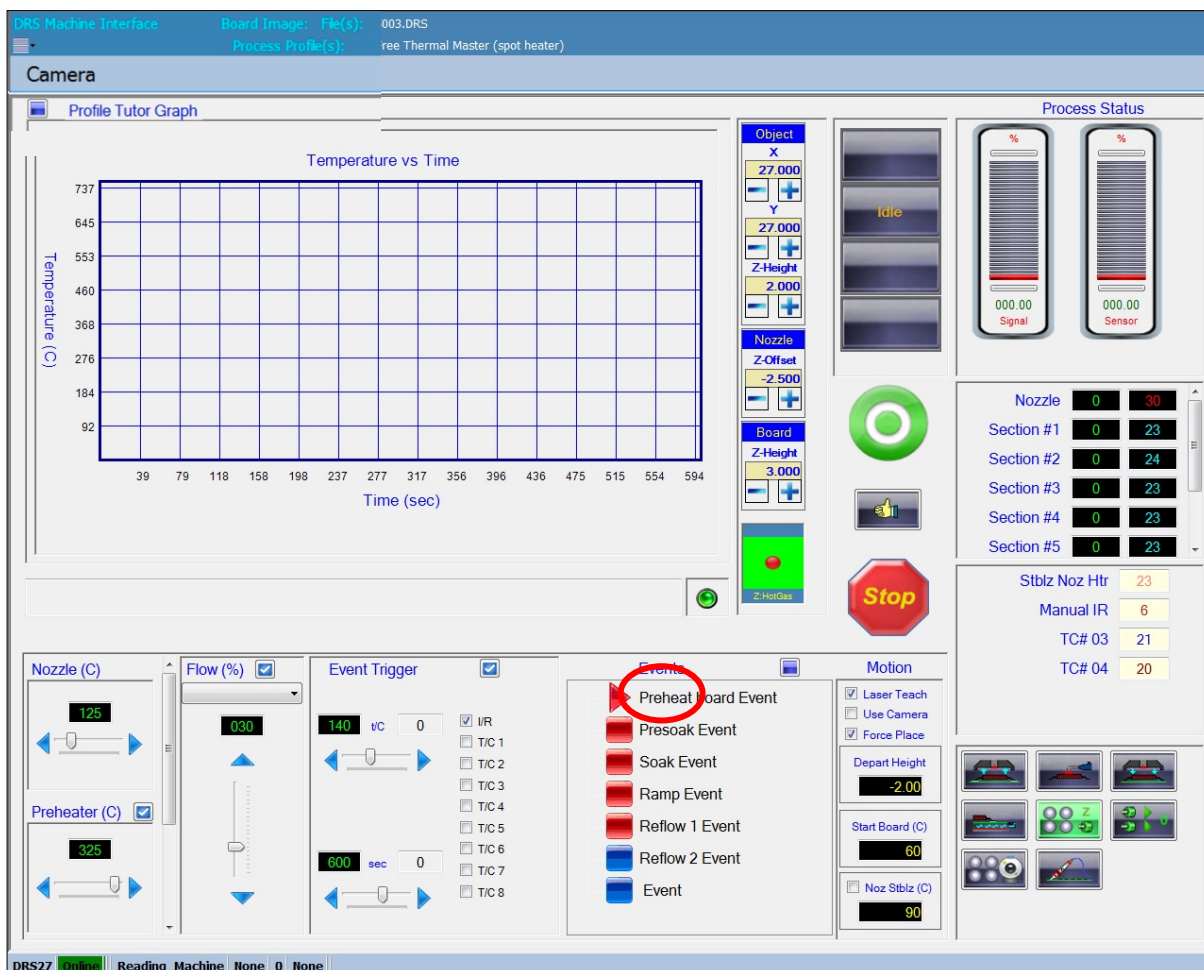
Profile Tutor screen shown.



1. Select (double click) the appropriate **Thermal Profile Master** that most closely matches the new application.



The selected Master will load and the Template steps will appear under the Events column (below).



The screenshot shows a vertical control panel with three main sections: Object, Nozzle, and Board. Each section has a title bar, a label, a numerical input field, and two buttons (minus and plus). The Object section has X (27.000), Y (27.000), and Z-Height (2.000). The Nozzle section has Z-Offset (-2.500). The Board section has Z-Height (3.000). At the bottom is a green square with a red dot and the label Z:HotGas.

Section	Parameter	Value
Object	X	27.000
	Y	27.000
	Z-Height	2.000
Nozzle	Z-Offset	-2.500
Board	Z-Height	3.000

Z:HotGas

- Measure the **Object** (component) width (X), length (Y) and thickness (Z) in mm and input into corresponding boxes.
- Measure the **Nozzle Z-Offset**, the total length of the nozzle (in mm) and subtract from 66. Enter the difference.
 - (Nozzle length) – 66 = Nozzle Z-Offset

NOTE: All EZ style nozzles are 63.5 mm long. (63.5-66= -2.5) For all EZ style nozzles enter –2.5mm

- Enter **Board Z-Height** (thickness) in mm.

IMPORTANT!

Entering the correct object (component), nozzle and board parameters is critical for proper z-axis positioning. Incorrect data can result in the nozzle contacting the part in a high speed mode.

Motion

☒ Laser Teach

☐ Use Camera

☒ Force Place

Depart Height

-2.00

Start Board (C)

90

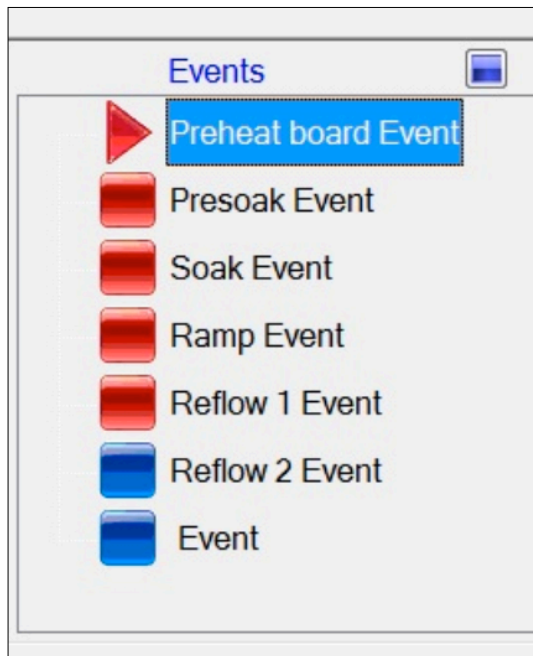
☒ Noz Stblz (C)

90

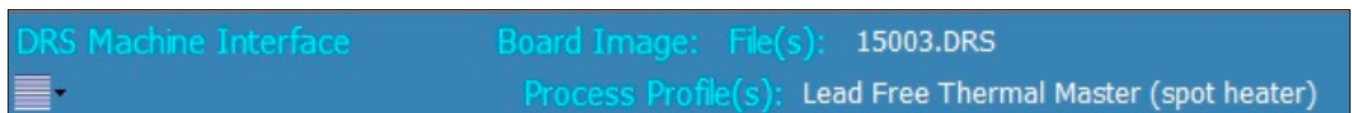
Motion

- **Laser Teach:** (always put a check in this box) Extends vision system to laser pointer position to teach component center position.
- **Use Camera:** (Optional - Direct View Camera option only) Takes user at cycle start directly to camera screen during Tutor process.
 - **NOTE:** If **Use Camera** is not selected here, user still has the option of manually selecting Direct View Camera screen from top tool bar at any time during process.
 - **NOTE:** See Addendum at back of this section for use and explanation of Direct View Camera screen.
- **Force Place:** (always put a check in this box) Allows nozzle to approach then force touch top of component.
- **Depart Height:** Distance of nozzle from component top after Force Place during heating/cooling events. Use -2.0mm
- **Start Board:** Additional development runs are typically necessary after the first iteration. This is the topside board temperature the machine will cool to at restart.
 - Typically 60°C for tin/lead assemblies
 - Typically 90°C for lead-free assemblies
- **Nozzle Stabilization:** (always put a check in this box) Will heat/cool nozzle head temperature prior to every start/restart for improved profile repeatability.
 - Use 90°C

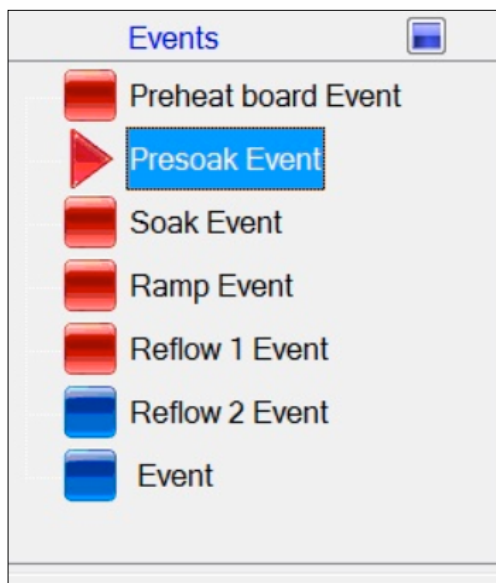
The events are shown.



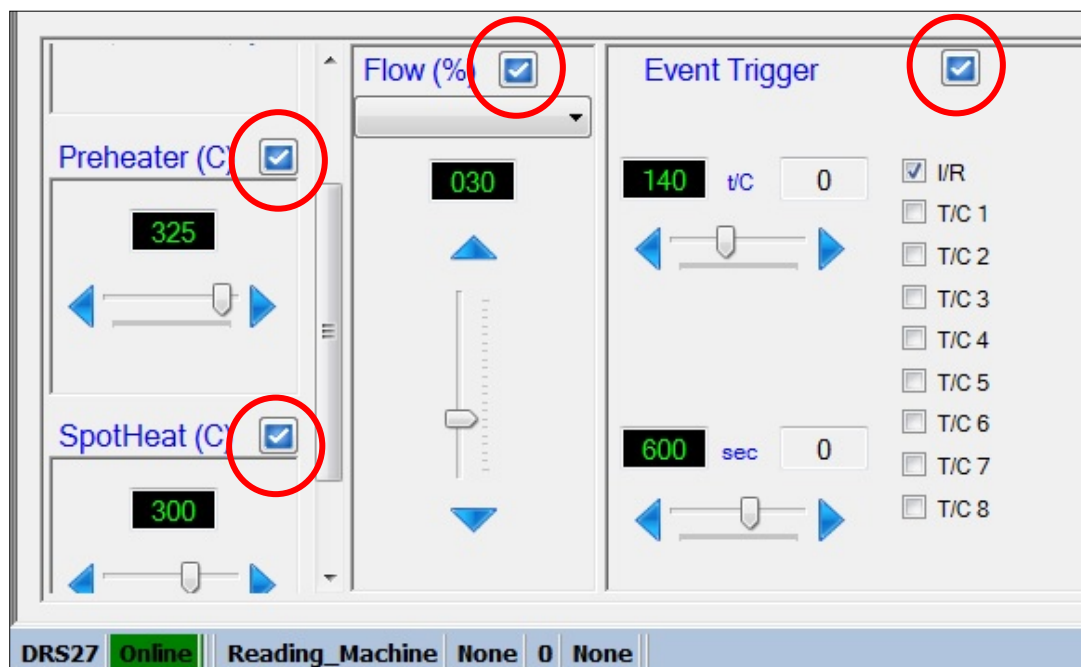
The master profile name will be displayed at the top of the page.



All master profiles typically have seven (7) stages (Events): Preheat, Presoak, Soak, Ramp, Reflow 1, Reflow 2, and Off.



The Update All button offers the ability to quickly update all events to the set value in that single event. Can be used for Preheater Temperature, Spot Heater Temperature, Nozzle Flow Rate, and Event Trigger TC's.



The following is a brief description of each stage (Event):

1. **PREHEAT:** Preheats the entire board to minimize the thermal differential between the reflow site and the rest of the board. Preheat minimizes board warpage and reduces the amount of component heating required to achieve reflow.
2. **PRESOAK:** Presoak is the period between preheat and soak.
3. **SOAK:** Flux is activated during the soak stage. Typically, significant voiding will occur without proper soak.
4. **RAMP:** Quickly takes the solder joints from the end of soak to the beginning of reflow.
5. **REFLOW 1:** Time over liquidus until the heaters are shut off.
6. **REFLOW 2:** Time until the joints fall back below liquidus.
7. **EVENT:** Turns off the heaters.

The following are typical time/temperature targets for each stage (Event):

	<u>Tin/Lead</u>	<u>Lead-Free</u>
PREHEAT		
- Topside Board Temp (°C)	90-120 avg=100	130-150 avg=140
PRESOAK		
- Joint Temp (°C)	101-139	141-169
- Time (seconds)	20-45	20-45
SOAK (joint)		
- Joint Temp (°C)	140-165	170-200
- Time (seconds)	45-75	45-75
RAMP (joint)		
- Joint Temp (°C)	165-182	201-216
- Time (seconds)	15-30	20-35
REFLOW 1 (joint)		
- Joint Temp (°C)	183-215	217-245
- Time (seconds)	30-50	35-55
REFLOW 2 (joint)		
- Joint Temp (°C)	215-183	245-217
- Time (seconds)	15-25	10-20
EVENT		
	Heaters Off	
Typical solder liquidus temp (°C)	183	217
Typical max joint temp (°C)	210	245
Typical max package temp (°C)	250	260

Parameter Adjustments

1. Prior to starting the cycle, the nozzle **Flow Rate (A)** needs to be adjusted for the new application.

The default nozzle heater flow rate in the template is 30% (100% = 2.75 scfm) in the Preheat event and 50% in all other events. Change the nozzle flow rate based on the nozzle you are using as shown below.

Nozzle Size (mm)	Nozzle Heater Flow (%)
Less than 10mm	30%
10-15 mm	35-40%
16-26 mm	45-50%
27-31 mm	55-60%
32-35 mm	65%
36-40 mm	70-75%
40+ mm	80%+
NMX Nozzles	40-60%

Be sure to change the flow in all events except Preheat (click on each event radio button to access the event flow rate).

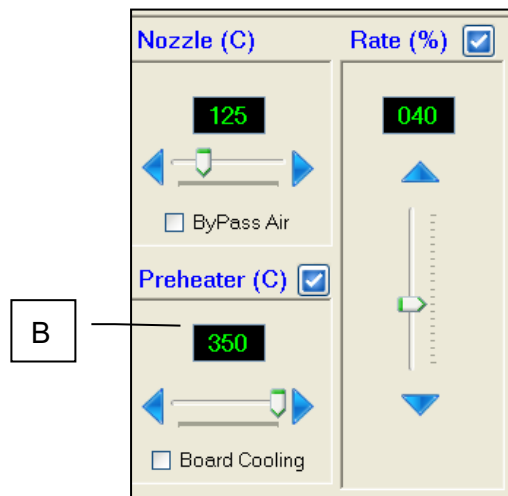
Update-all-flow-rates button

The update-all buttons offer the ability to quickly update all the events based on the current event settings.

NOTE: The flow rate in the preheat event will change when you update all flow rates. Change it back to the original 30%.

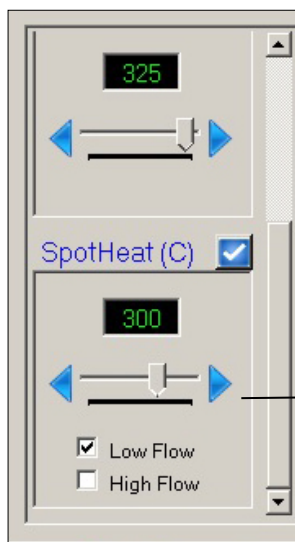
A

- If you are reworking a high thermal mass board, (3.0mm and higher thickness) increase the nozzle temperature by 25 degrees in each event except Preheat and Reflow 2.

**Preheater:**

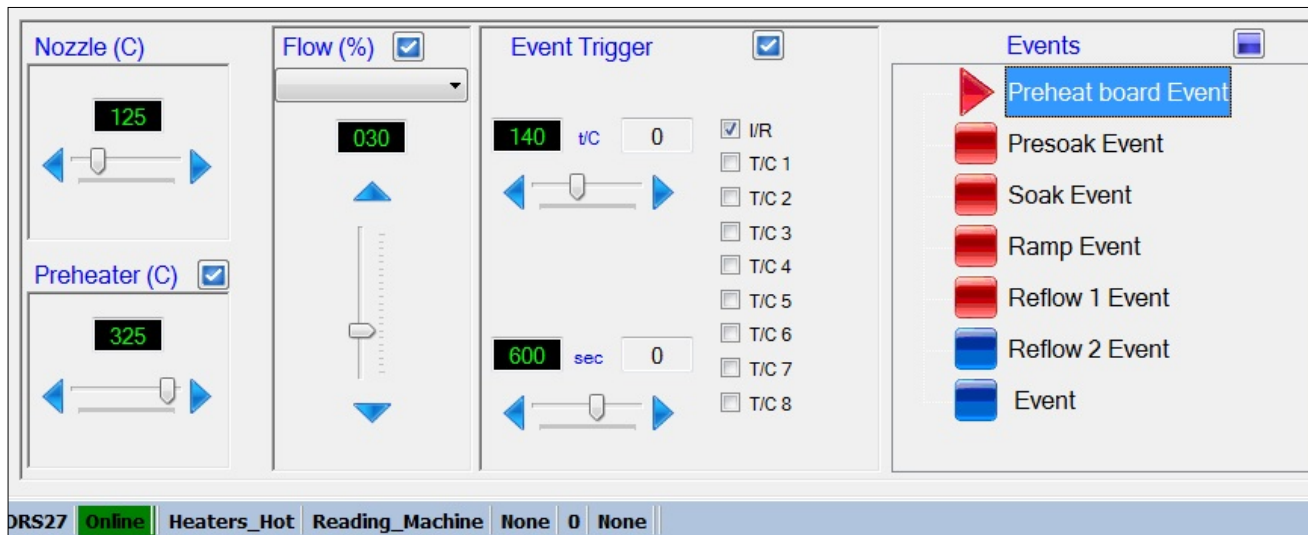
Preheater temperature (**B**) is typically set to 300°C (tin lead) or 325°C (lead-free) for the preheat event, then reduced to for subsequent events to a level that maintains board top side temperature.

NOTE: Preheater can be raised to a maximum of 350°C during preheat for high thermal mass assemblies.

**Spot Heater:**

If the Spot Heater option is installed on the system, this section can be adjusted (**C**) to set the spot heater temperature for each event and if low flow or high flow should be enabled.

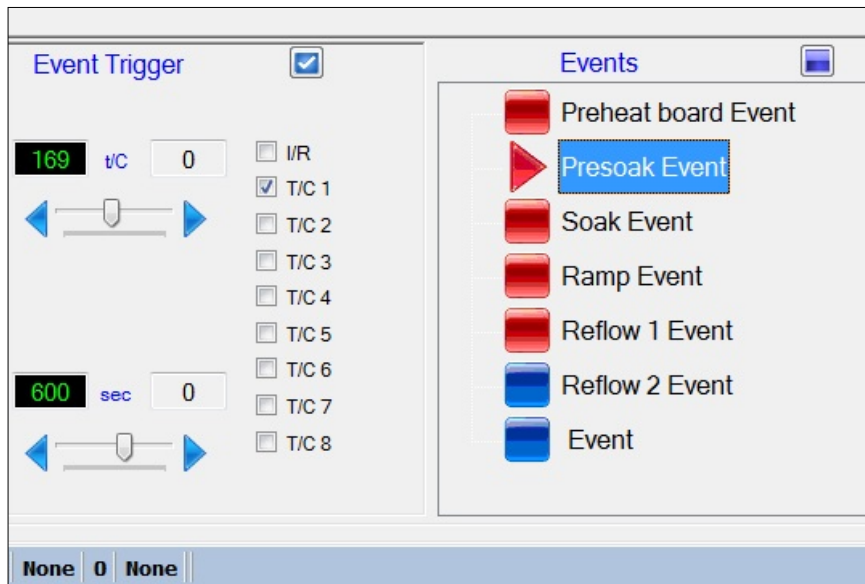
The default setting is 325°C, low flow.

Preheat Flow Rate:

Low temperature air flow from the nozzle may impede preheating the board due to ambient air moving across the surface. The programmer has the option to:

1. Keep the air flow of the upper heater low, for example, 30% to reduce the air current cooling effect. This method will allow the system to have stable, repeatable initial conditions prior to the remaining heating events.
2. Turn off the upper heater, no air flow or temperature, during the preheat event. This event may allow the board to preheat quicker.

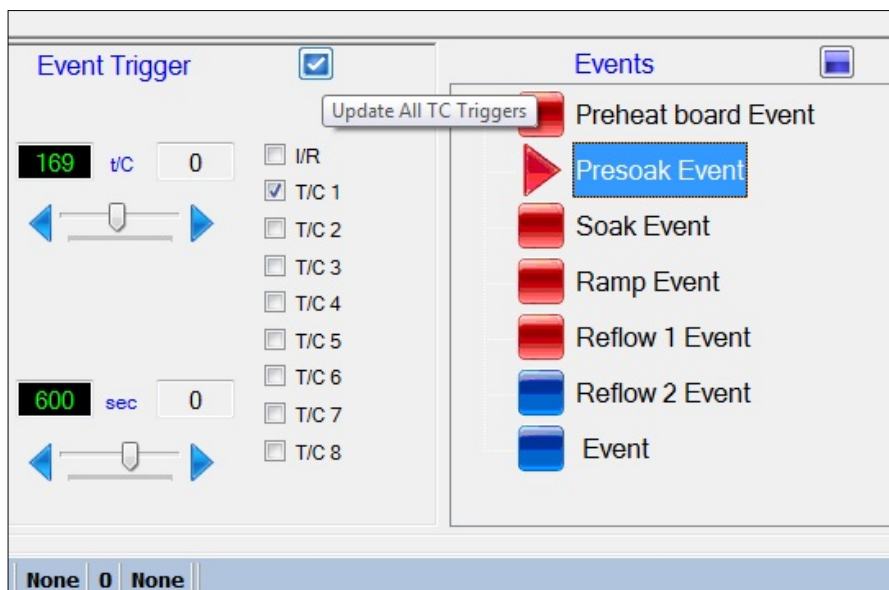
Event Trigger



Click on **PreSoak Event** Stage in the **Events** list and check mark the channel(s) being used to control joint temperatures during process.

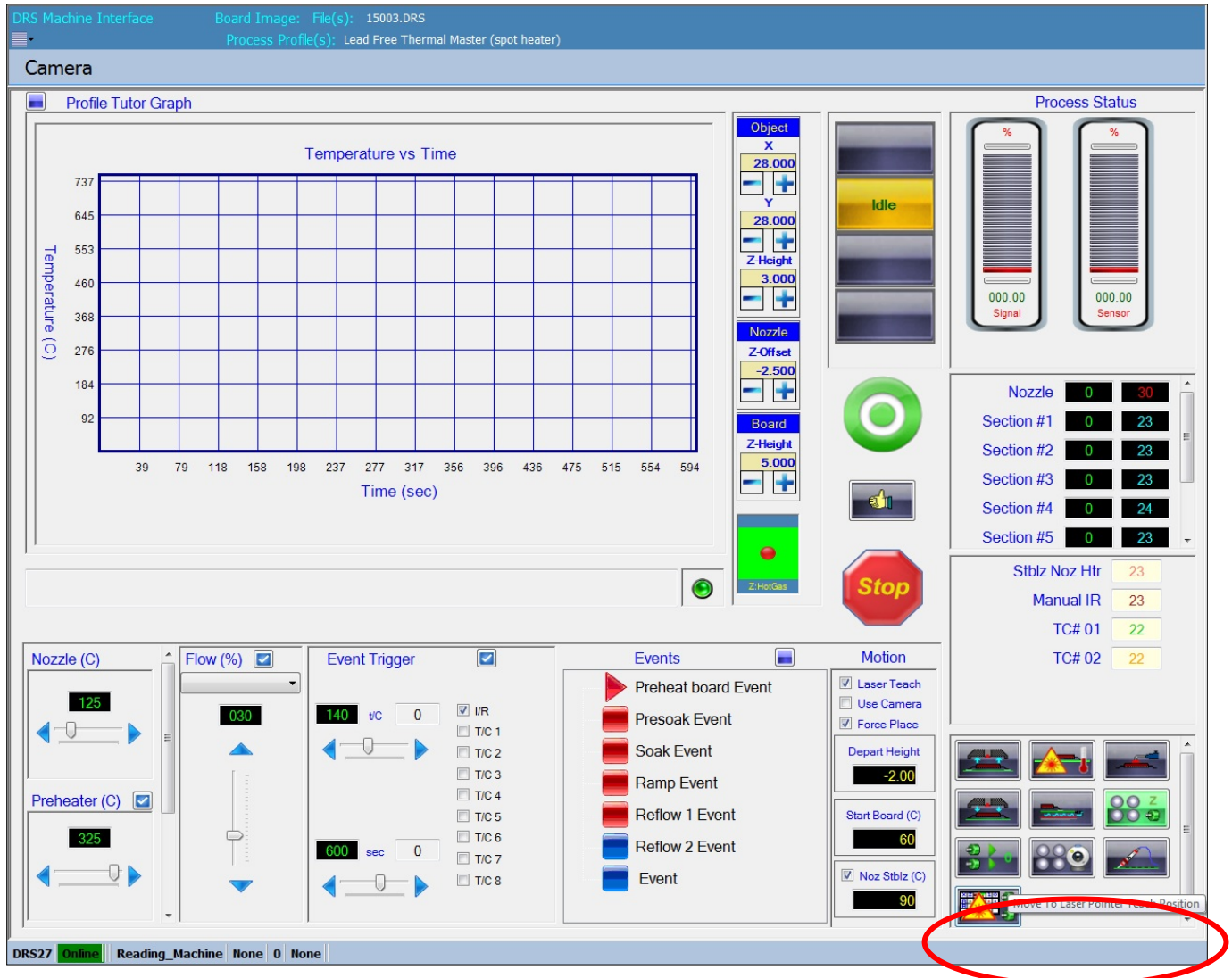
If only one TC is monitoring joint temperature, the T/C 1 box should be checked as shown above. If three TC's are monitoring joint temperature, T/C 1, 2, and 3 boxes all should be checked.

Click on the **Update All TC Triggers** box.

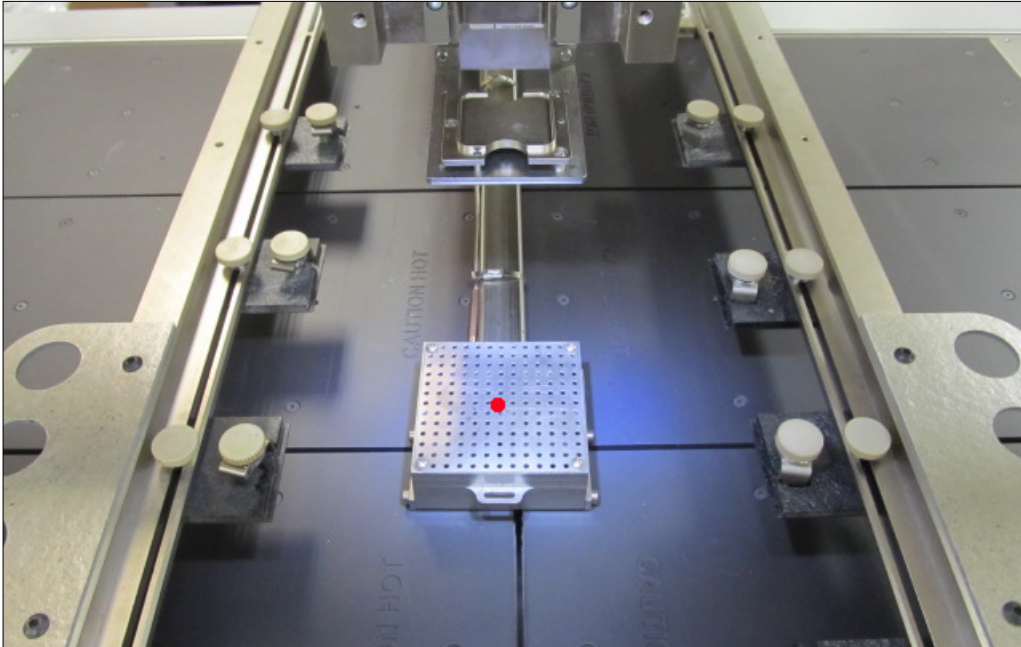


Initializing Process Development Run

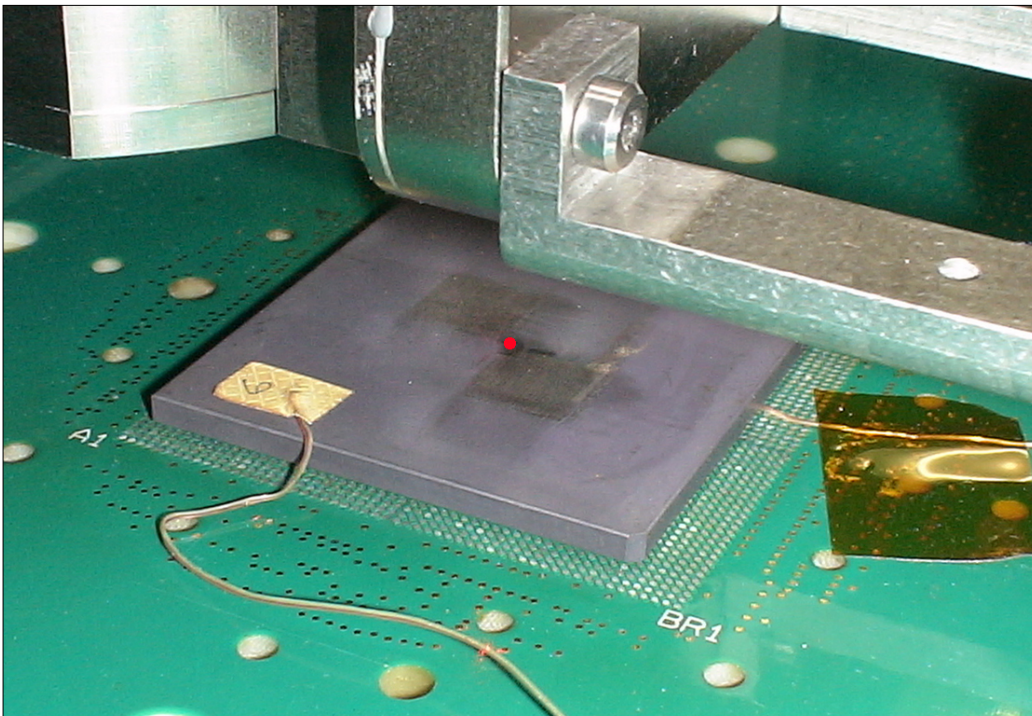
- Install the EZ Nozzle that matches the component size or is slightly larger than the component.
NOTE: If the EZ Nozzle is smaller than the component, heating uniformity will be poor.
- Click on the **Move To Laser Pointer Teach Position** icon.



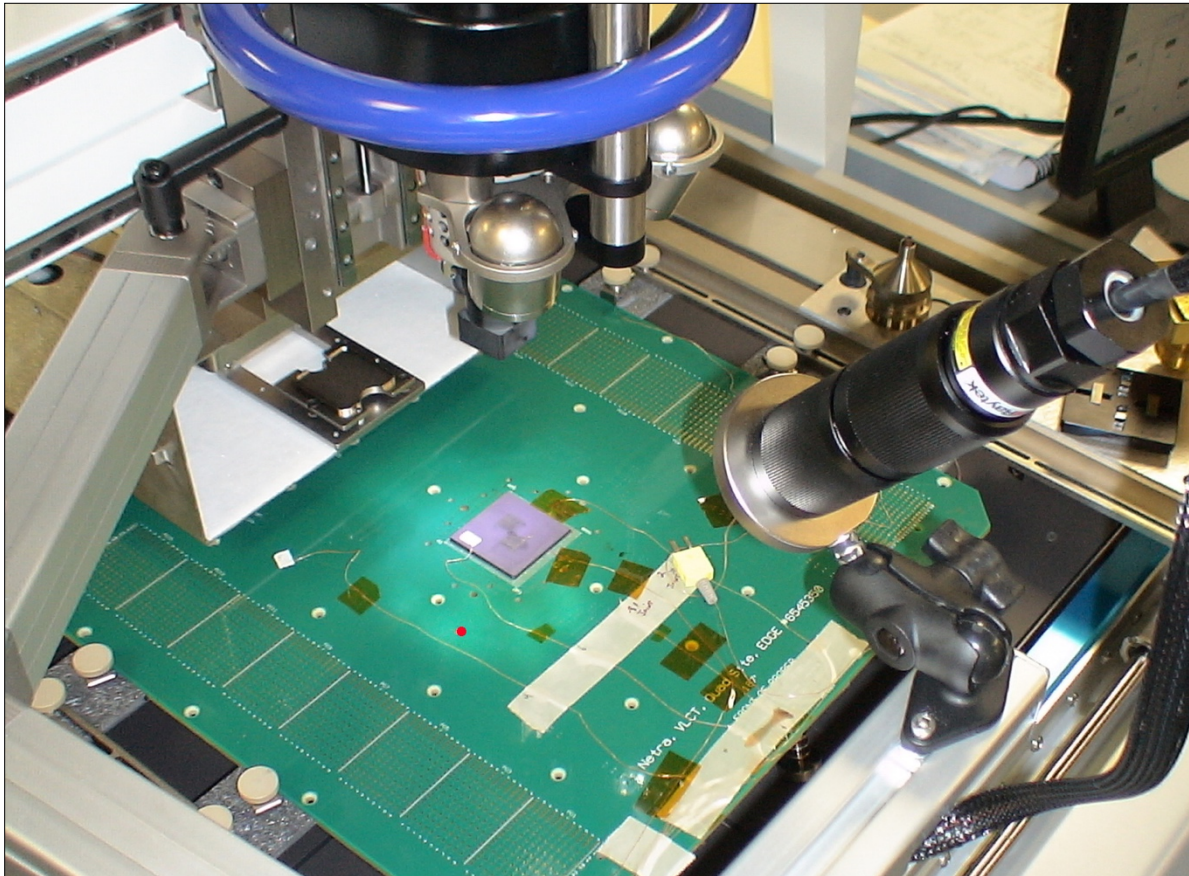
- The vision housing will move outward and the laser pointer will activate.
- Position the bottom spot heater near the center of the bottom heater plate.
- Move the z-head using the blue ring so the red laser dot is roughly centered on the spot heater.



- Install the board so the laser pointer is also centered on the component.



- Lock the carrier arms and tighten the hold down clamps.
- Position board supports if necessary.
- Install the joint thermocouple(s) and plug in to channel 1 (2,3).
- Click on the icon. Use the Laser Pointer to position the IR sensor 2-3 inches away from the component.



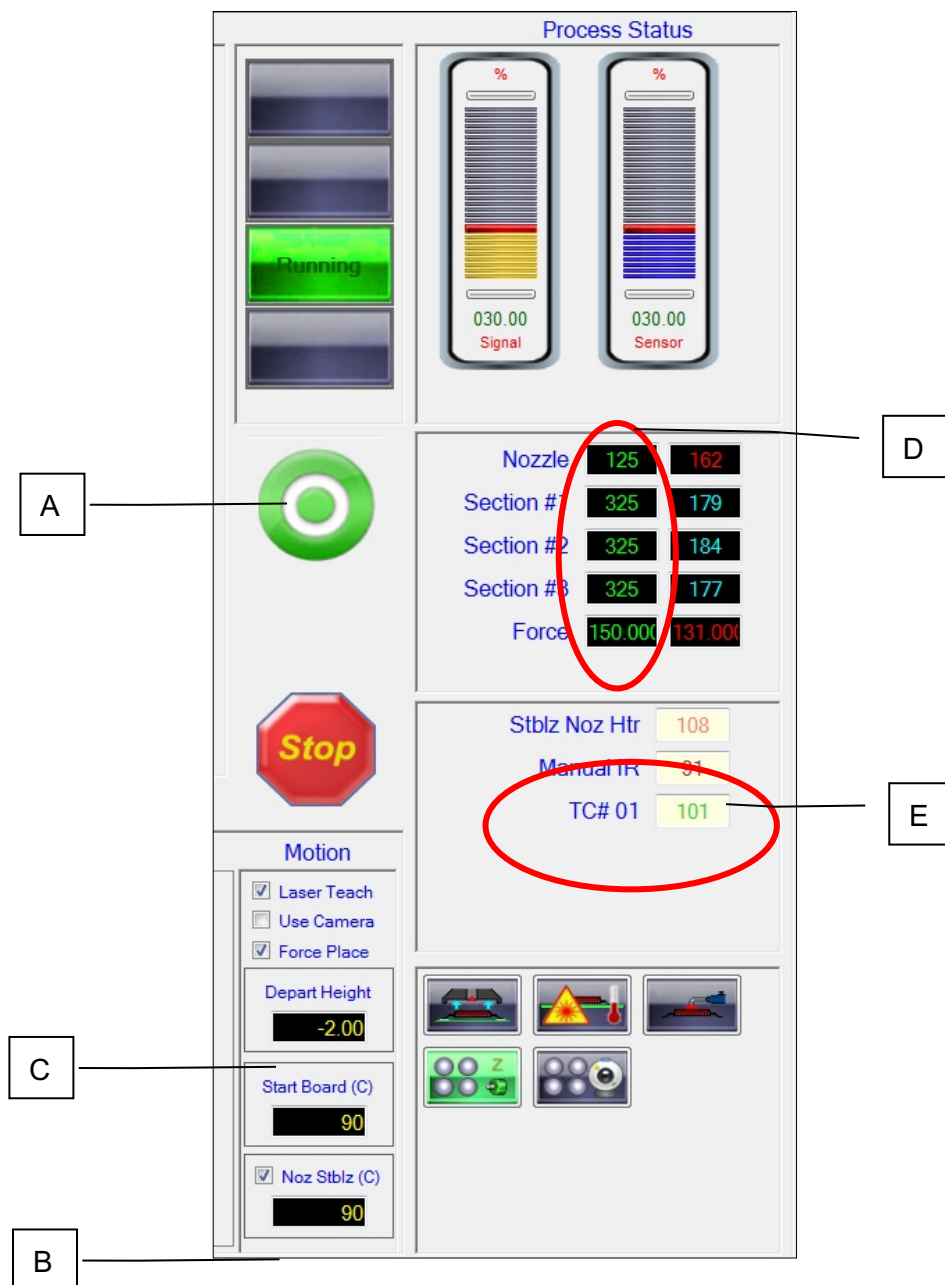
- Click on the Start icon (A).
- The nozzle stabilization routine will run until the head TC reaches its target temperature of 90°C (B).

NOTE: The head stabilization routine is critical for thermal repeatability.

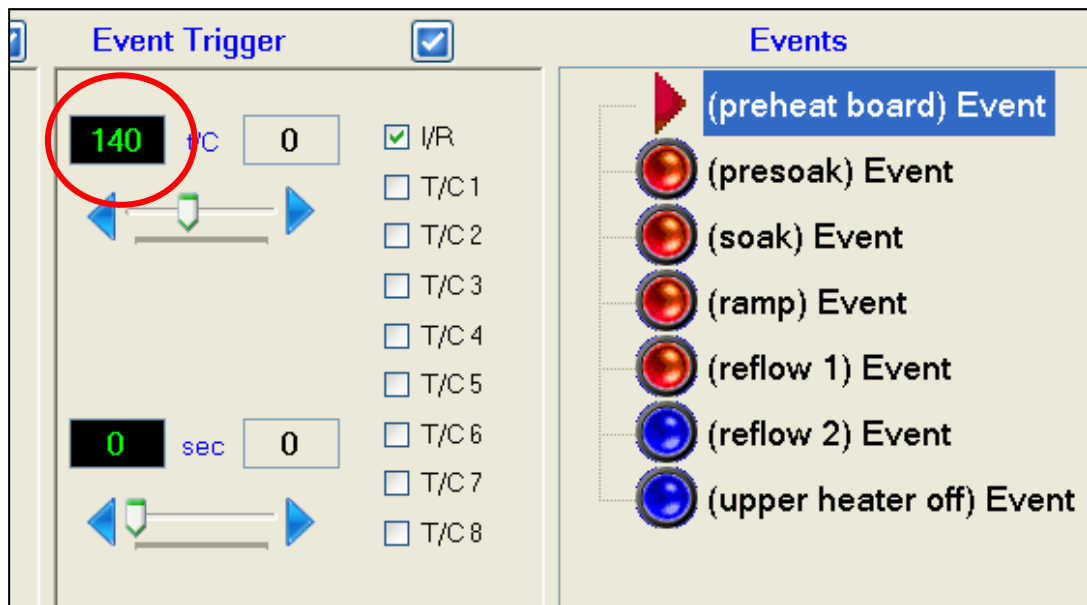
- The vision system will extend and the laser pointer teach position red dot will activate. The laser should already be centered on the component.
- The vision system will retract when you click on the yellow footswitch message.
- The nozzle will then move downward and touch the component under force control and will retract the programmed height (C).

NOTE: If the nozzle is not centered over the component, use the x/y wheels to correct this.

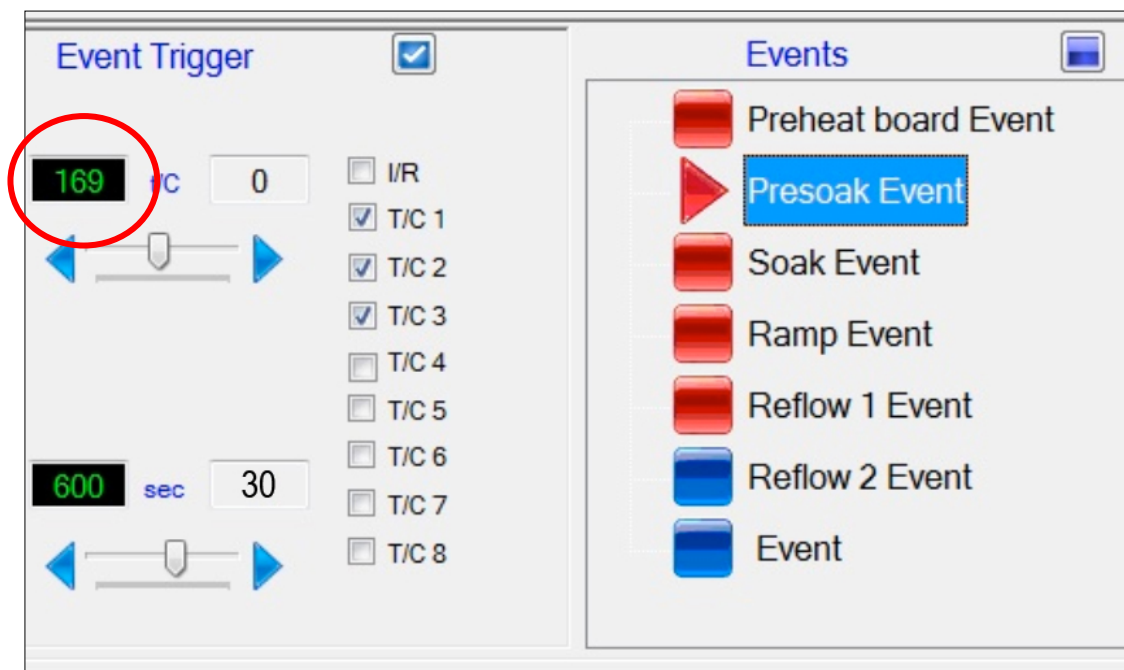
- The thermal profile will begin execution and the graph will plot temperatures for the heaters (D) and thermocouples (E).



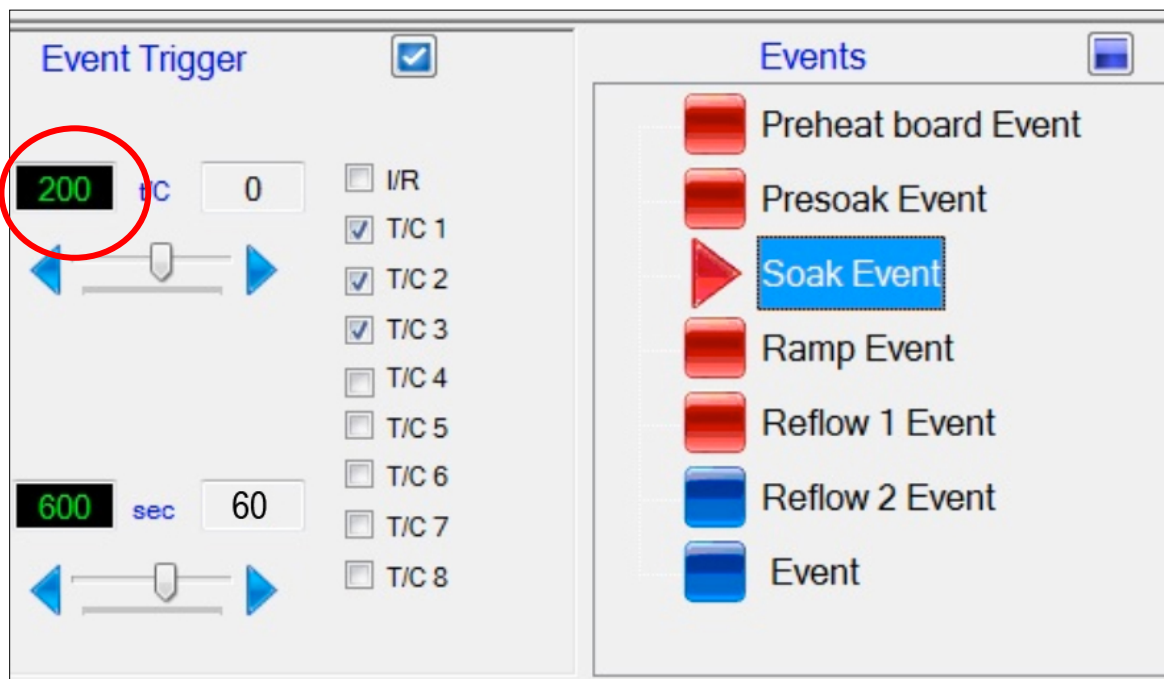
The **Preheat Event** will continue until the IR Probe reaches 140°C (Lead-Free profile) or 100°C: (Tin Lead profile). Time is not used as this is a temperature based event using the IR probe.



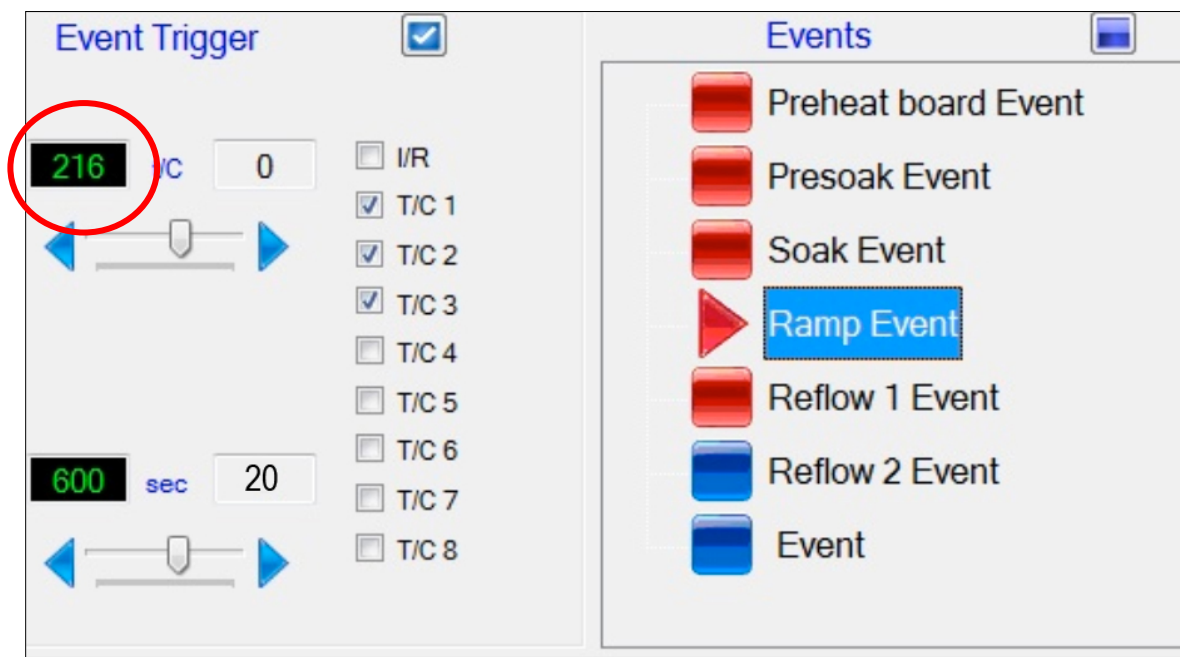
The **Presoak Event** will continue until T/C#1 (or multiple checked TC's if used) reaches 169°C (Lead-Free profile) or 139°C (Tin Lead profile). Time in Presoak stage is automatically recorded and saved. If one thermocouple is providing an erroneous reading it may be eliminated from the event by clearing the box.



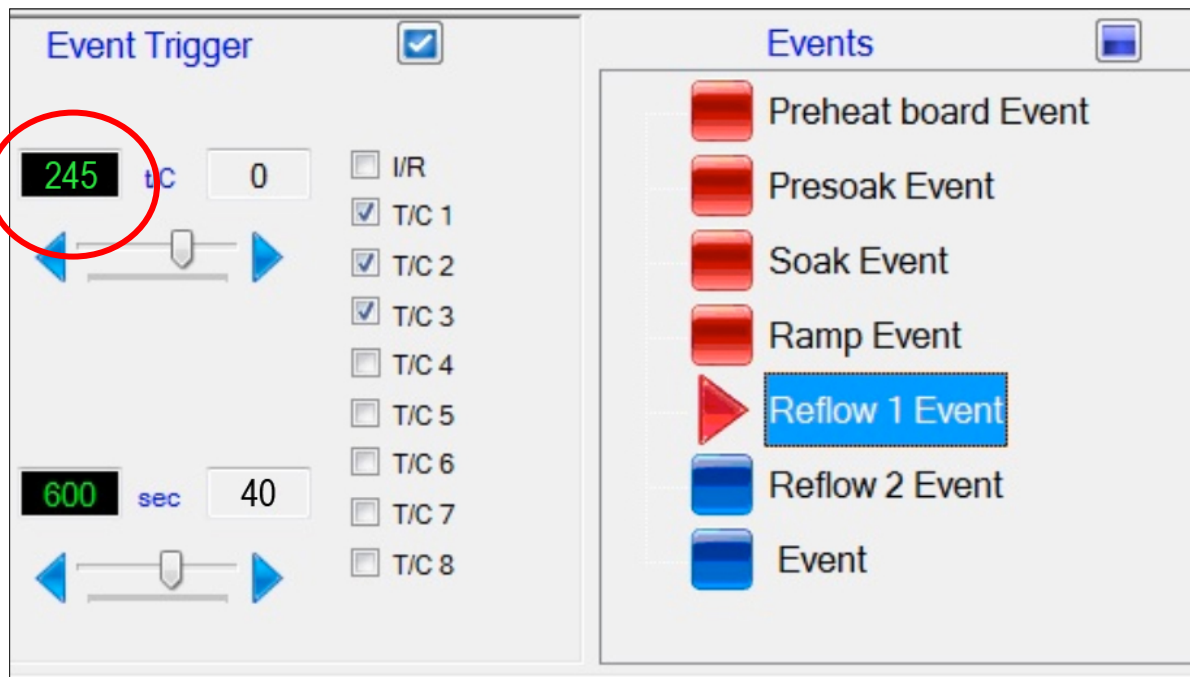
The **Soak Event** will continue until T/C#1 reaches 200°C (Lead-Free profile) or 165°C (Tin Lead profile). Time in Soak stage is automatically recorded and saved.



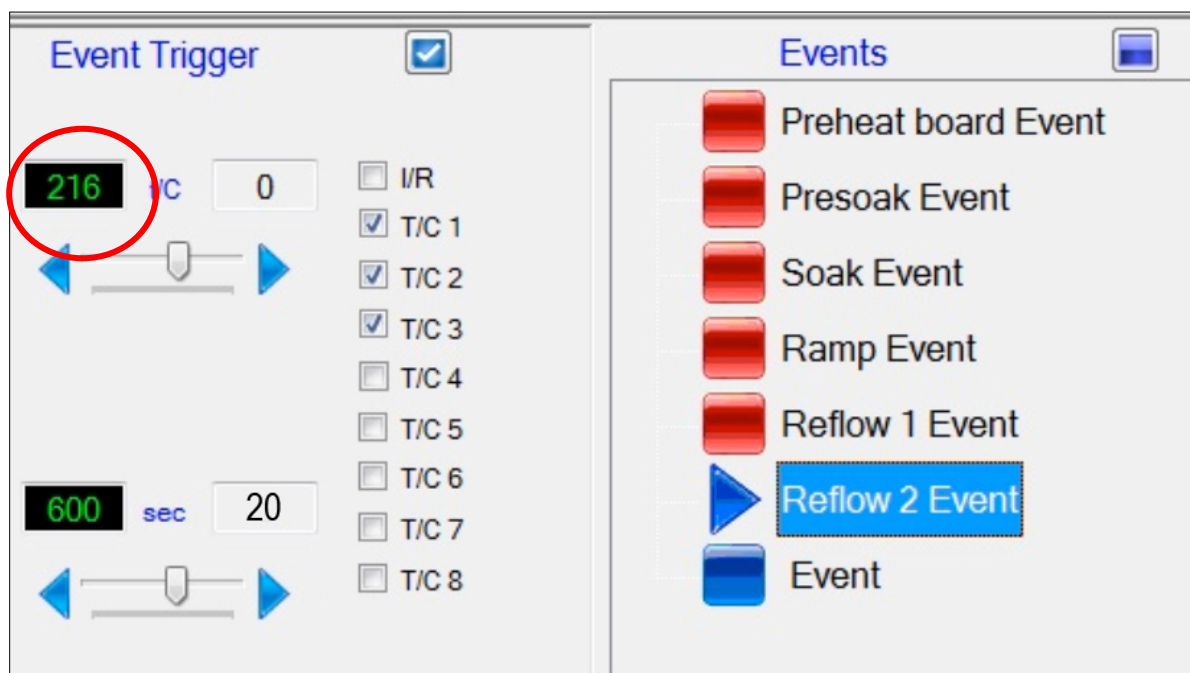
The **Ramp Event** will continue until T/C#1 reaches 216°C (Lead-Free profile) or 182°C (Tin Lead profile). Time in Ramp stage is automatically recorded and saved.

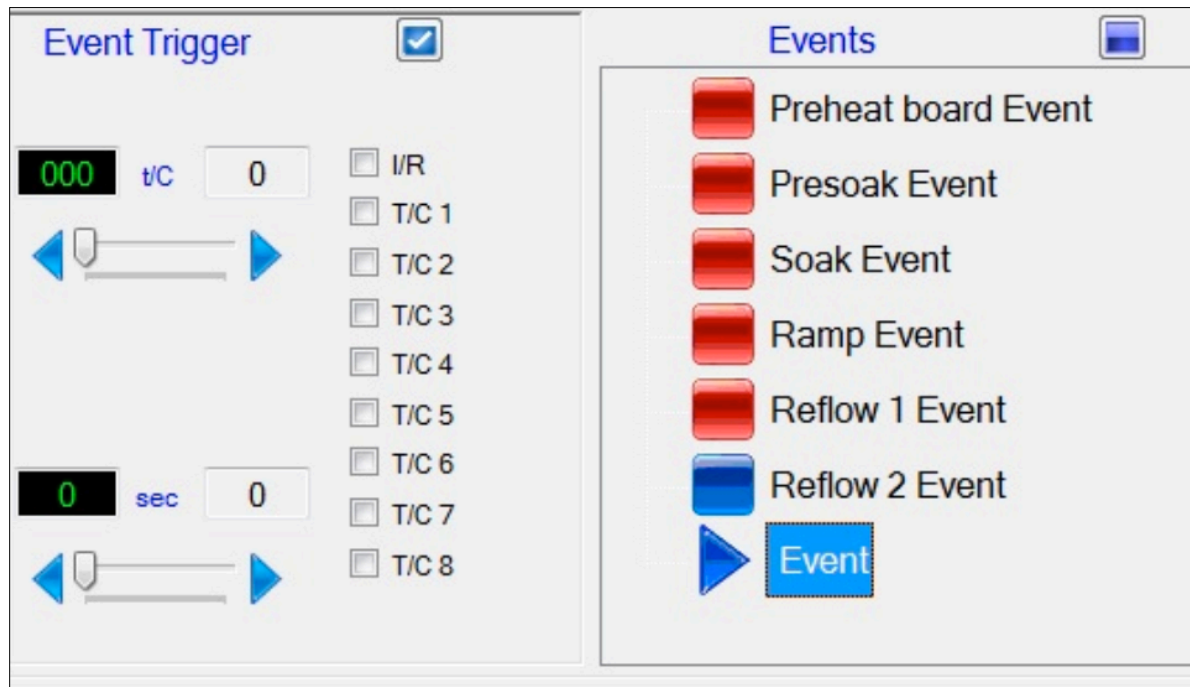


The **Reflow 1 Event** will continue until T/C#1 reaches 245°C (Lead-Free profile) or 215°C (Tin Lead profile). Time in Reflow 1 stage is automatically recorded and saved.

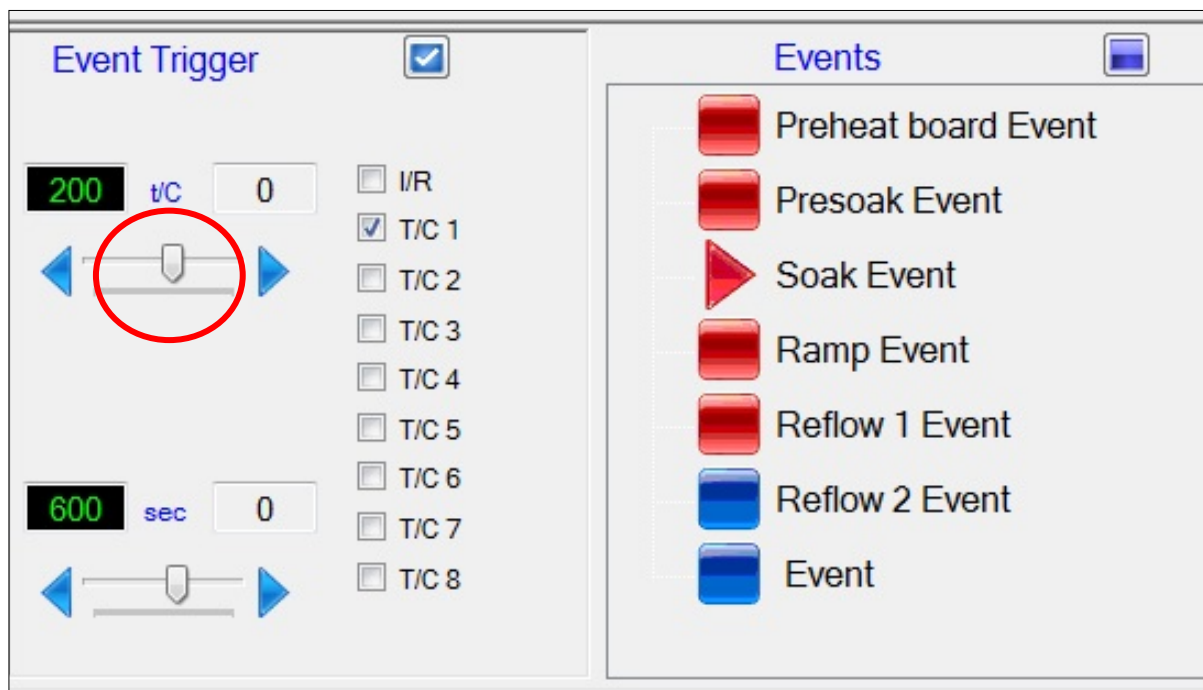


The **Reflow 2 Event** will continue until T/C#1 drops down below 217°C (Lead-Free profile) or (183°C: Tin Lead profile). Time in Reflow 2 stage is automatically recorded and saved. **NOTE: Total time over reflow is the sum of Reflow 1 and Reflow 2.**

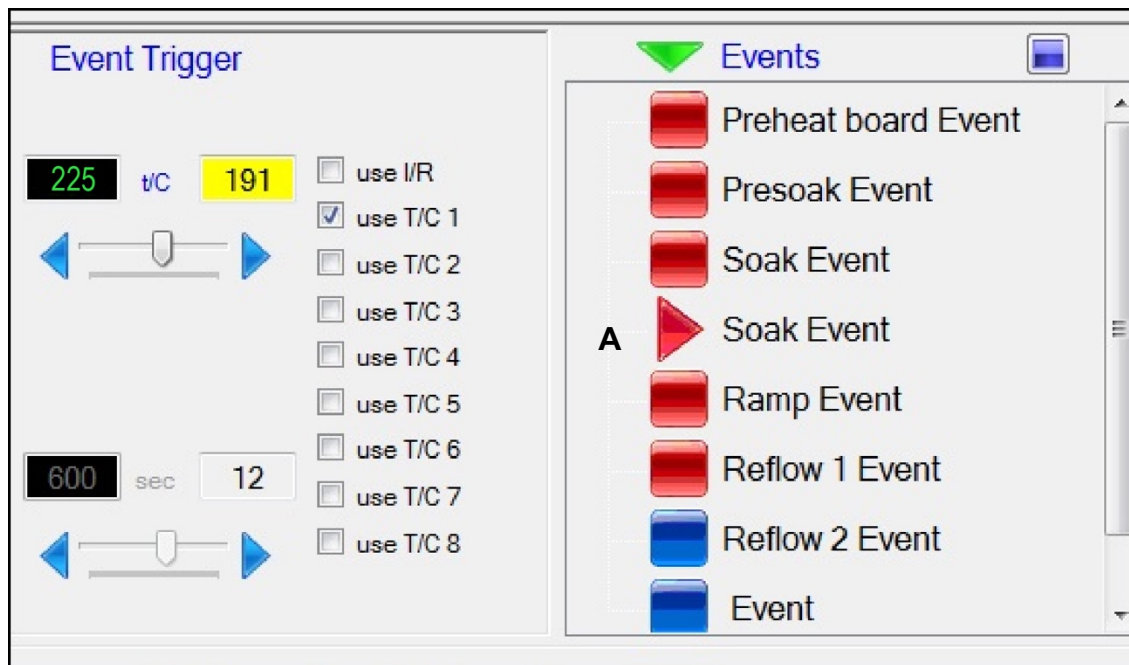


The Upper Heater Off Event – 0 seconds**IMPORTANT!**

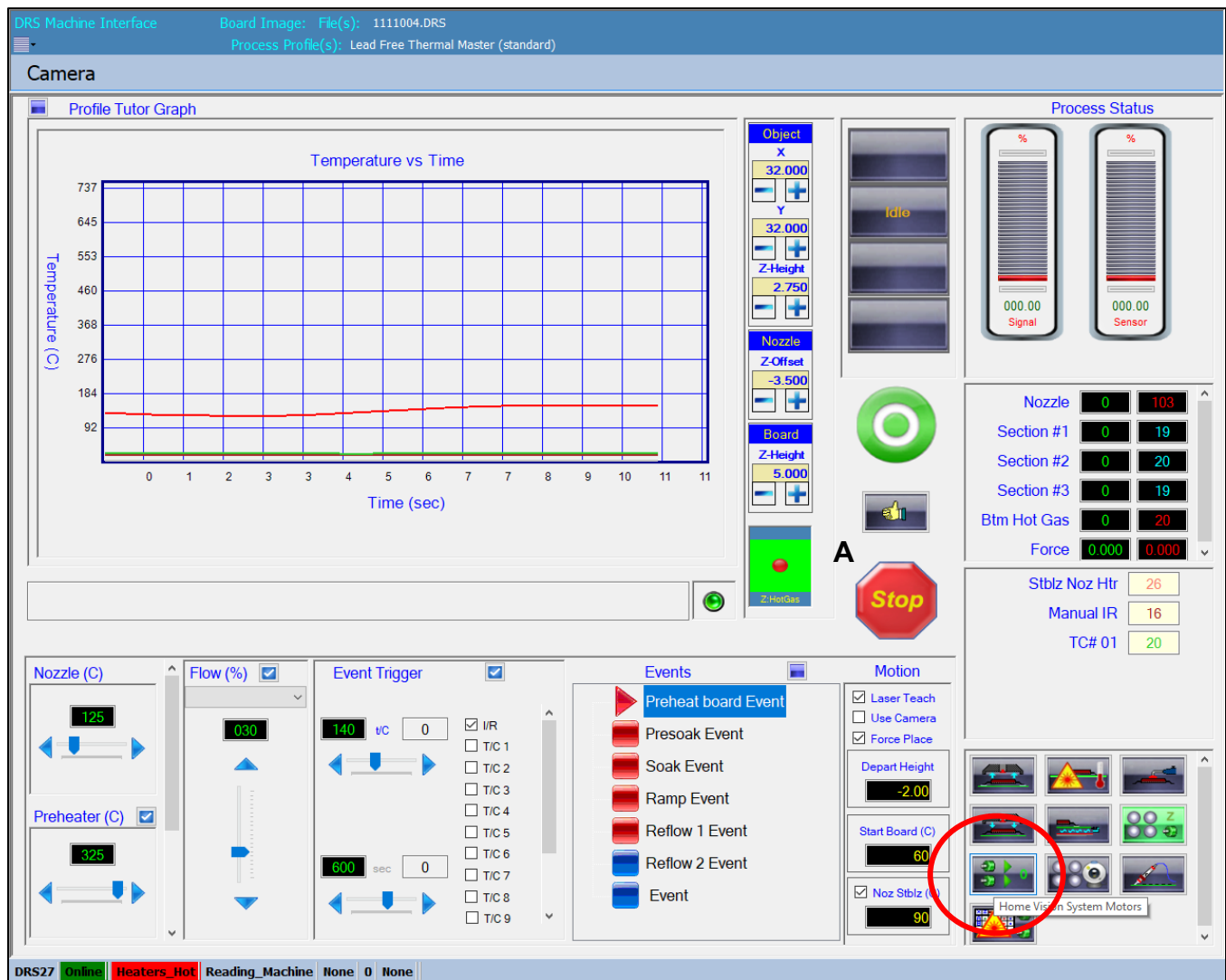
If the Event Trigger temperature is not being reached in a reasonable amount of time (30 seconds in Presoak and Ramp, 60 seconds in Soak and Reflow1) click on the Nozzle Temperature tab and drag it to the right so that the temperature increases by 25 degrees.



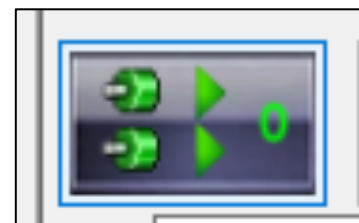
A new **Event (A)** will be inserted automatically and the nozzle temperature will increase to the new set-point.



If you **stop (A)** the Thermal Profile, you must click on the green **Home Vision System icon (B)**, before you restart the process.

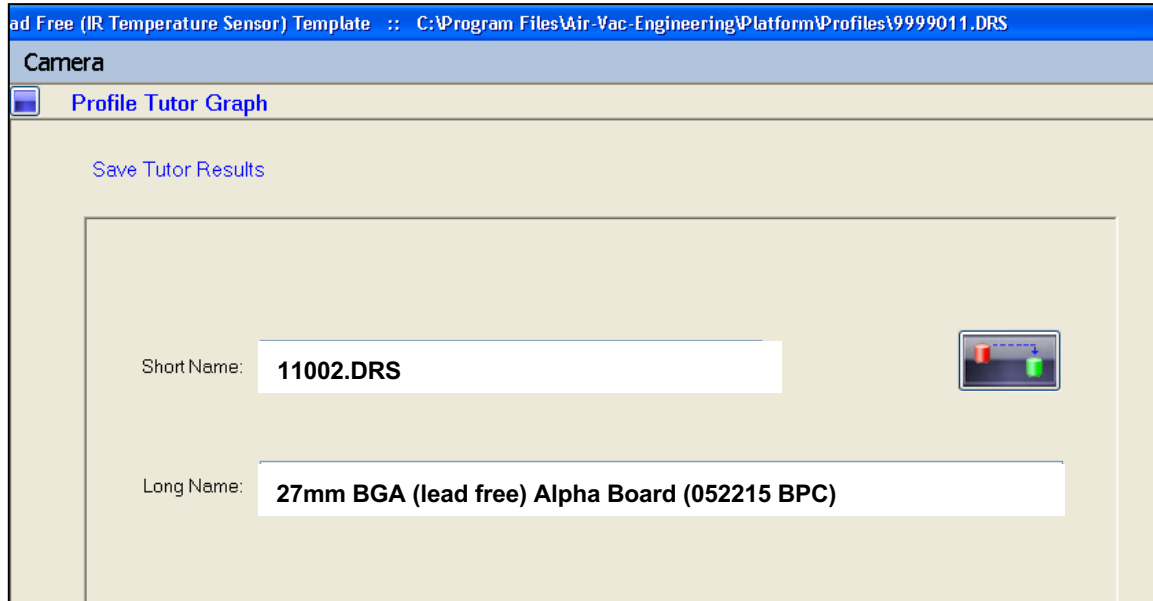


B



Automatic prompt to Name and Save new thermal profile.

- Input in Long Name box a name for this thermal profile. Common naming protocols include assembly name, component type and size, tin lead (TL) or lead-free (LF), nozzle used, and creation date/creator initials.
- Click on red/green icon to save.



ad Free (IR Temperature Sensor) Template :: C:\Program Files\Air-Vac-Engineering\Platform\Profiles\9999011.DRS

Camera

Profile Tutor Graph

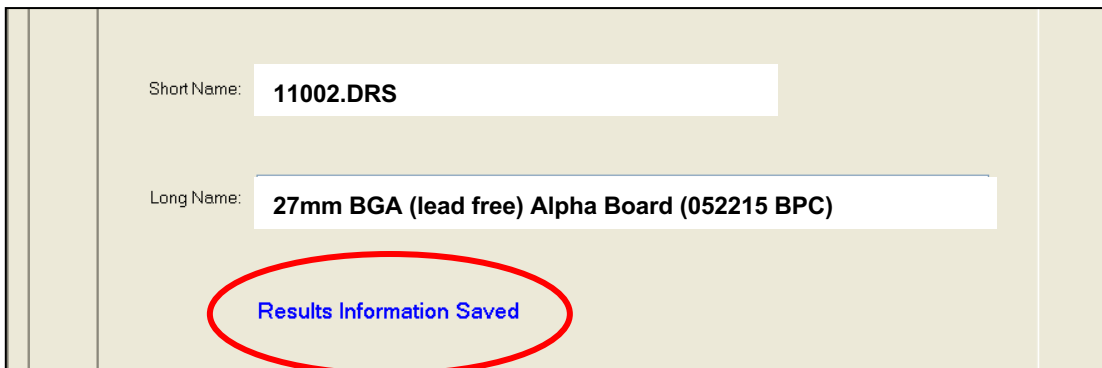
Save Tutor Results

Short Name: 11002.DRS

Long Name: 27mm BGA (lead free) Alpha Board (052215 BPC)

Confirmation of save.

WARNING: If you exit Tutor without saving the graph, the process information will be lost.

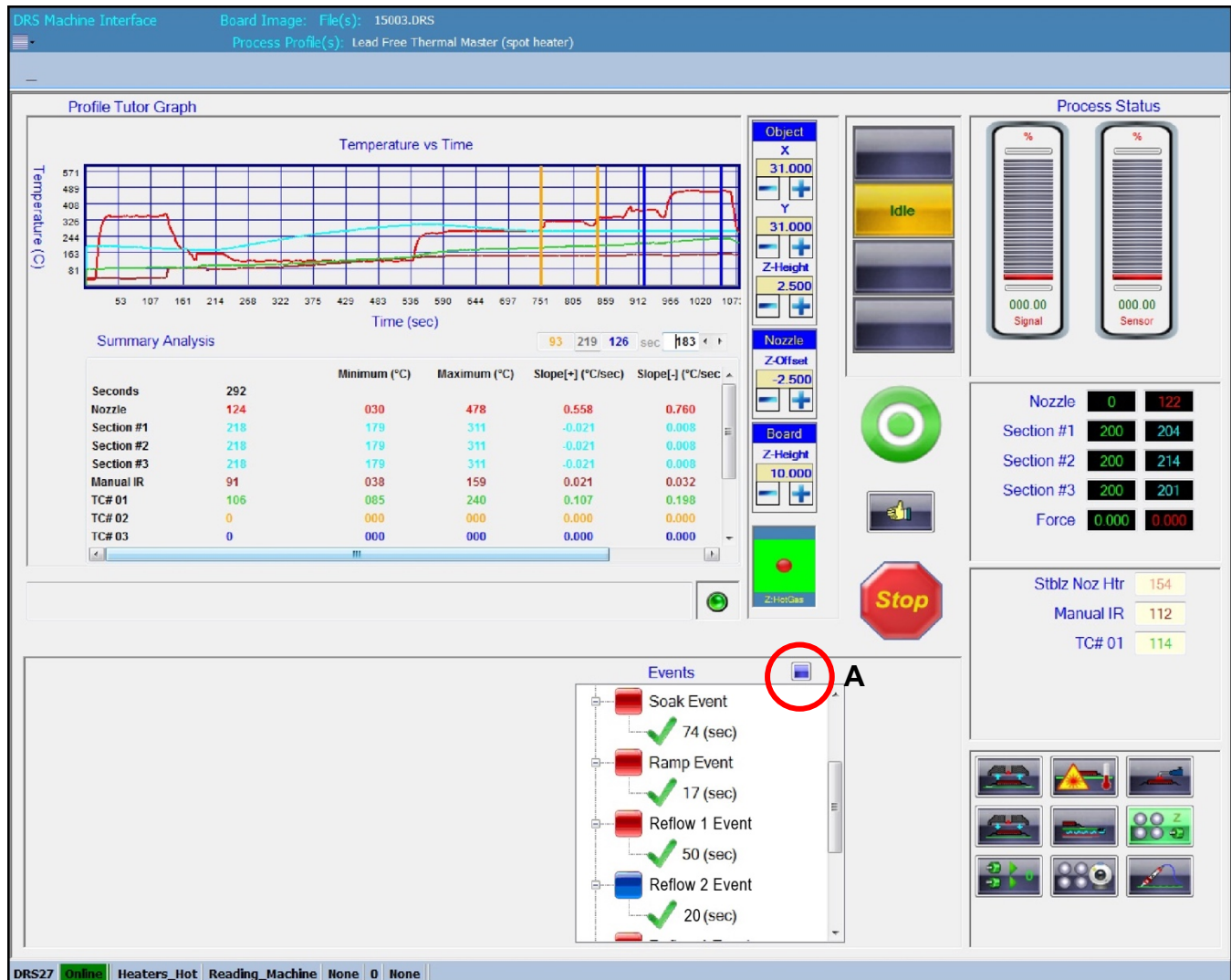


Short Name: 11002.DRS

Long Name: 27mm BGA (lead free) Alpha Board (052215 BPC)

Results Information Saved

5.0.4 Tutor Screen: Thermal Analysis

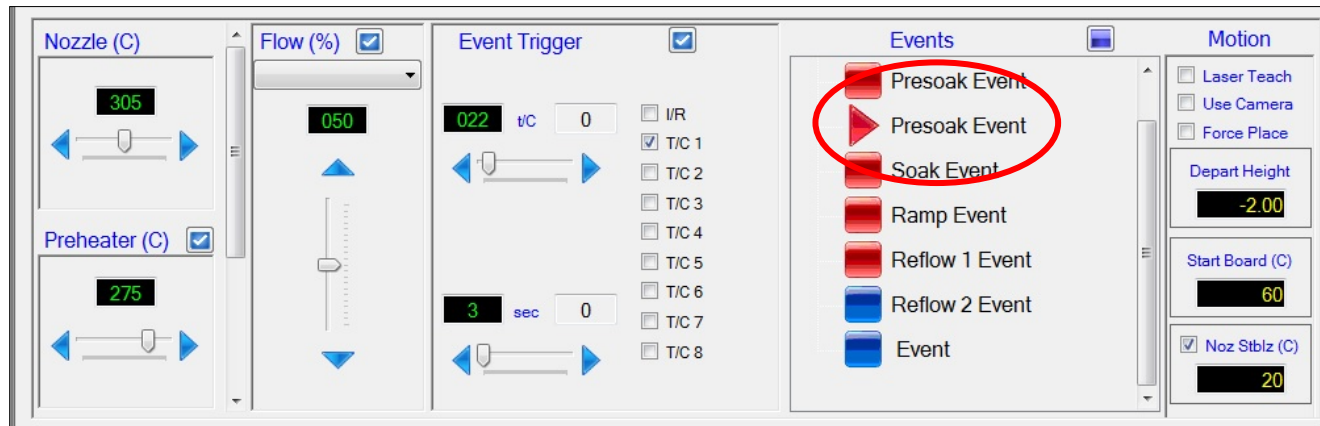


- This screen can be activated by clicking on the Analysis-toggle button (A).
- Compare the actual time in the Soak Event to the Target Soak time of 45-75 seconds.
- Compare the actual time in the Reflow 1 and 2 events to the Target Reflow time of 45-75 seconds.
- If the actual Soak and Reflow times fall within the targeted time ranges, you have created a good thermal profile. Proceed to the Profile Build section.
- If the Soak and/or Reflow stage(s) are less than the minimum target of 45 seconds, the profile is too "hot" and has run too fast.
- If the Soak and/or Reflow stage(s) are greater than the maximum target of 75 seconds, the profile is too "cold" and has run too slow.

NOTE: High thermal mass components on high thermal mass assemblies have a 45-75 second soak range, however, the reflow stage may be as long as 120 seconds due to the longer time required to return to minimum liquidus temperature.

- If the first iteration is too hot or too cold, a second iteration is required.

5.0.5 Running a Second Thermal Cycle

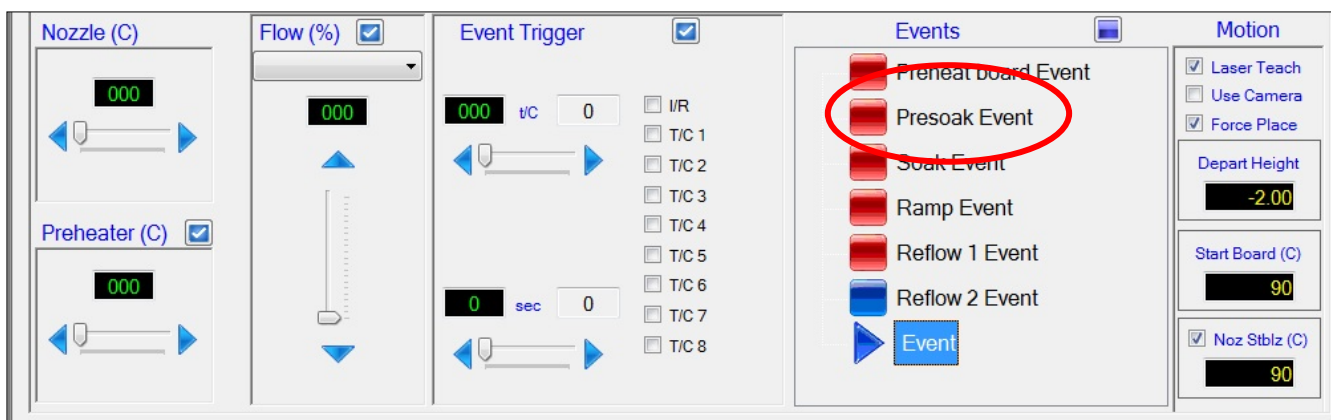


Profile events that have been added during the first run as a result of an on-the-fly adjustment should be deleted prior to starting additional tutor cycles.

NOTE: The Event Trigger temperature must be reset.

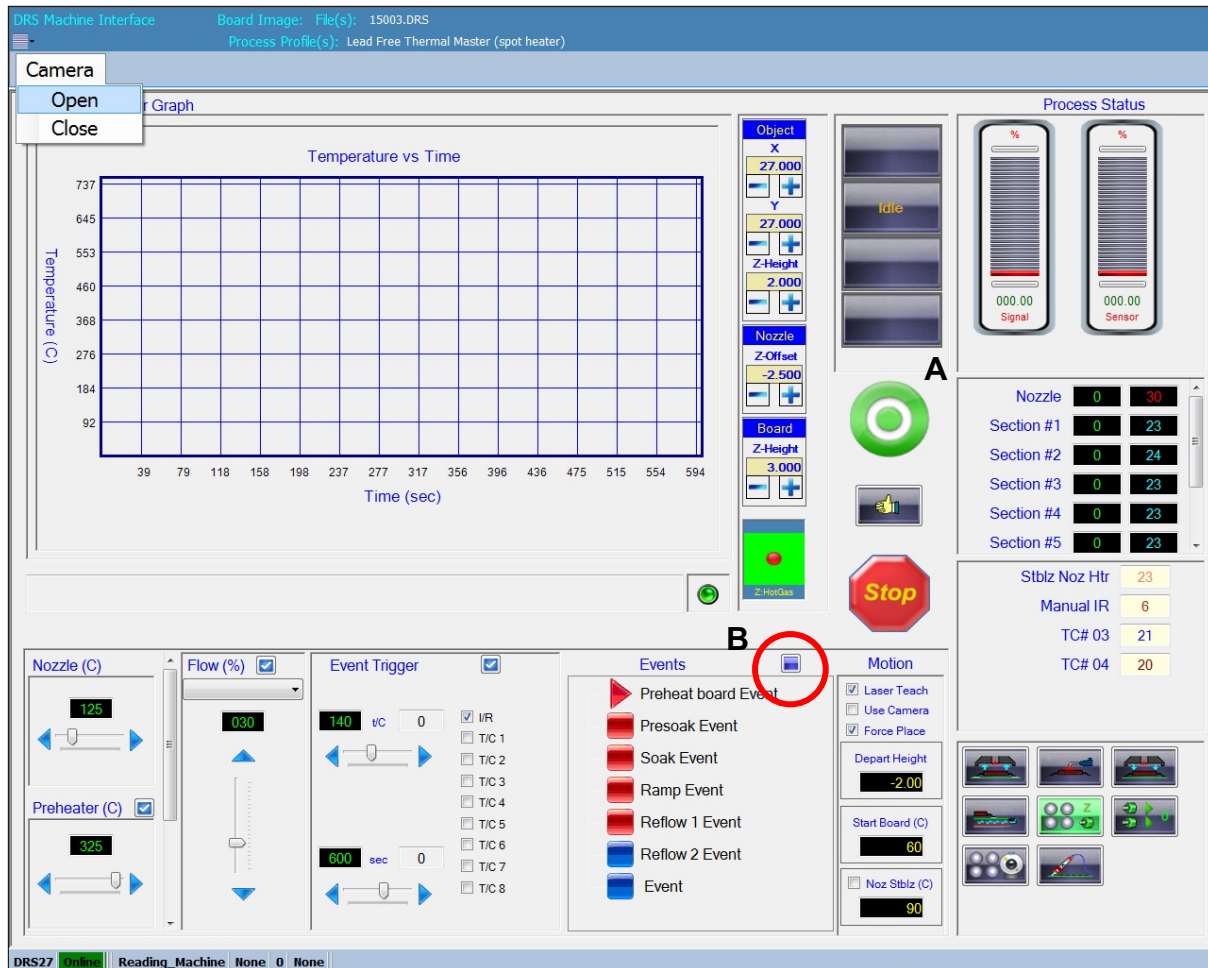
Procedure for deleting an added event:

1. Highlight the target event (left single click).
2. Right double click on the arrow event, will provide a delete message.
3. Click the ok button to accept/complete the delete activity.



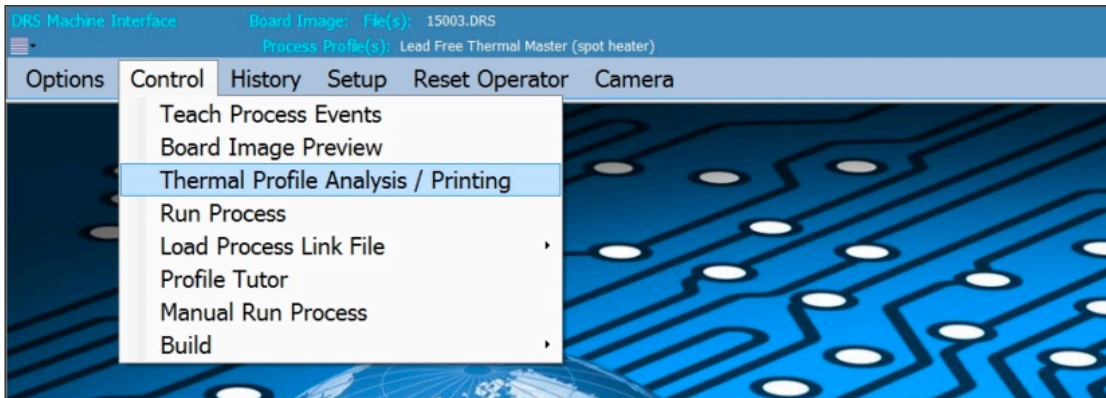
Before Running a Second Cycle

- Decrease the Nozzle temperature by 25 degrees in the Presoak/Soak/Ramp/Reflow 1 stages if the Soak and/or Reflow 1 stages are less than 45 seconds. Decreasing the Nozzle temperature will slow the profile down and increase the time in each event.
- Increase the Nozzle temperature by 25 degrees in the Presoak/Soak/Ramp/Reflow 1 stages if the Soak and/or Reflow 1 stages are longer than 75 seconds. Increasing the Nozzle temperature will speed up the profile and reduce the time in each event.



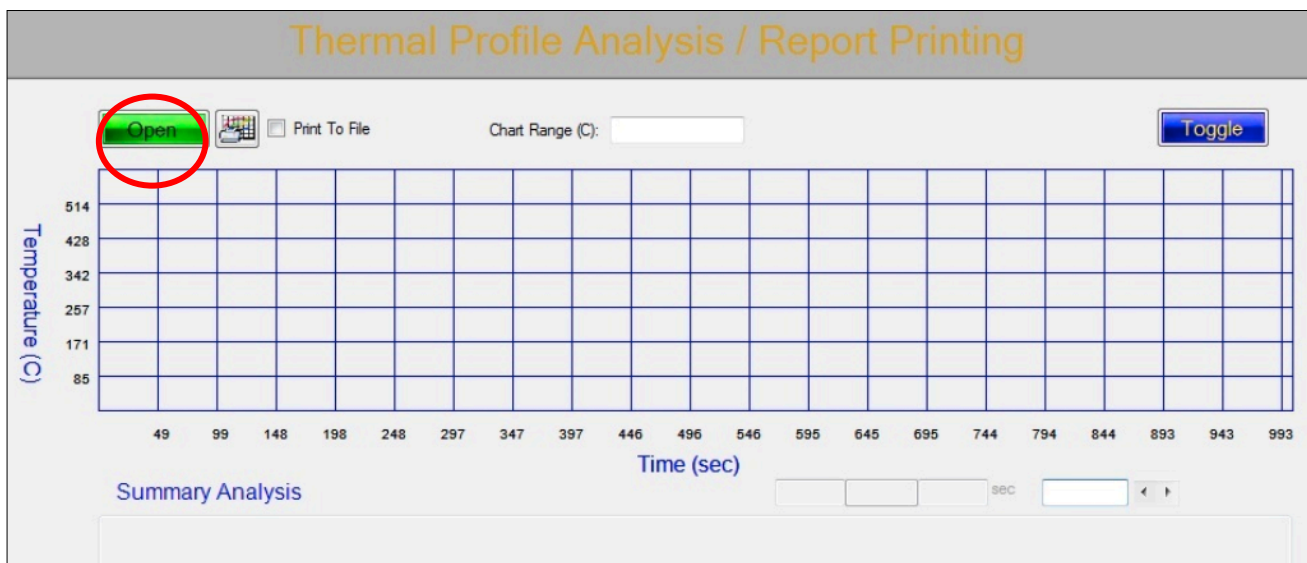
- Click on the **Start icon (A)**. Machine will automatically cool board and heater head to restart temperature then re-run process.
- Name and save the second run (recommended: same name as first run with "Rev 1" added).
- After the process is complete, click on the analysis icon **(B)** to again review the data. Continue to run iterations until acceptable soak and total reflow times are achieved.

5.0.6 Thermal Profile Record Keeping



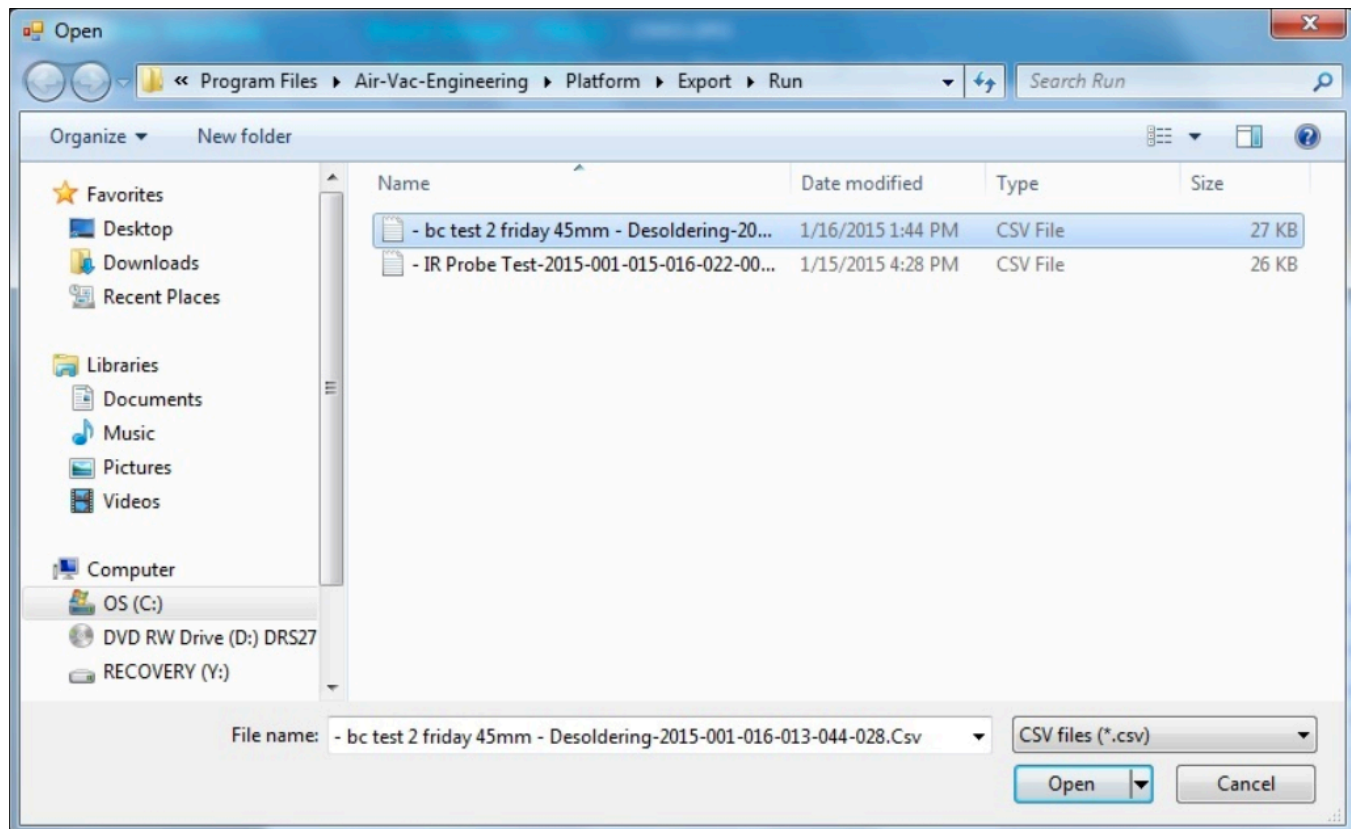
After a new thermal profile is created, the thermal profile is saved. The Thermal Profile Analysis tool is used for documentation and reference to analyze the profile.

- Click on the green icon.

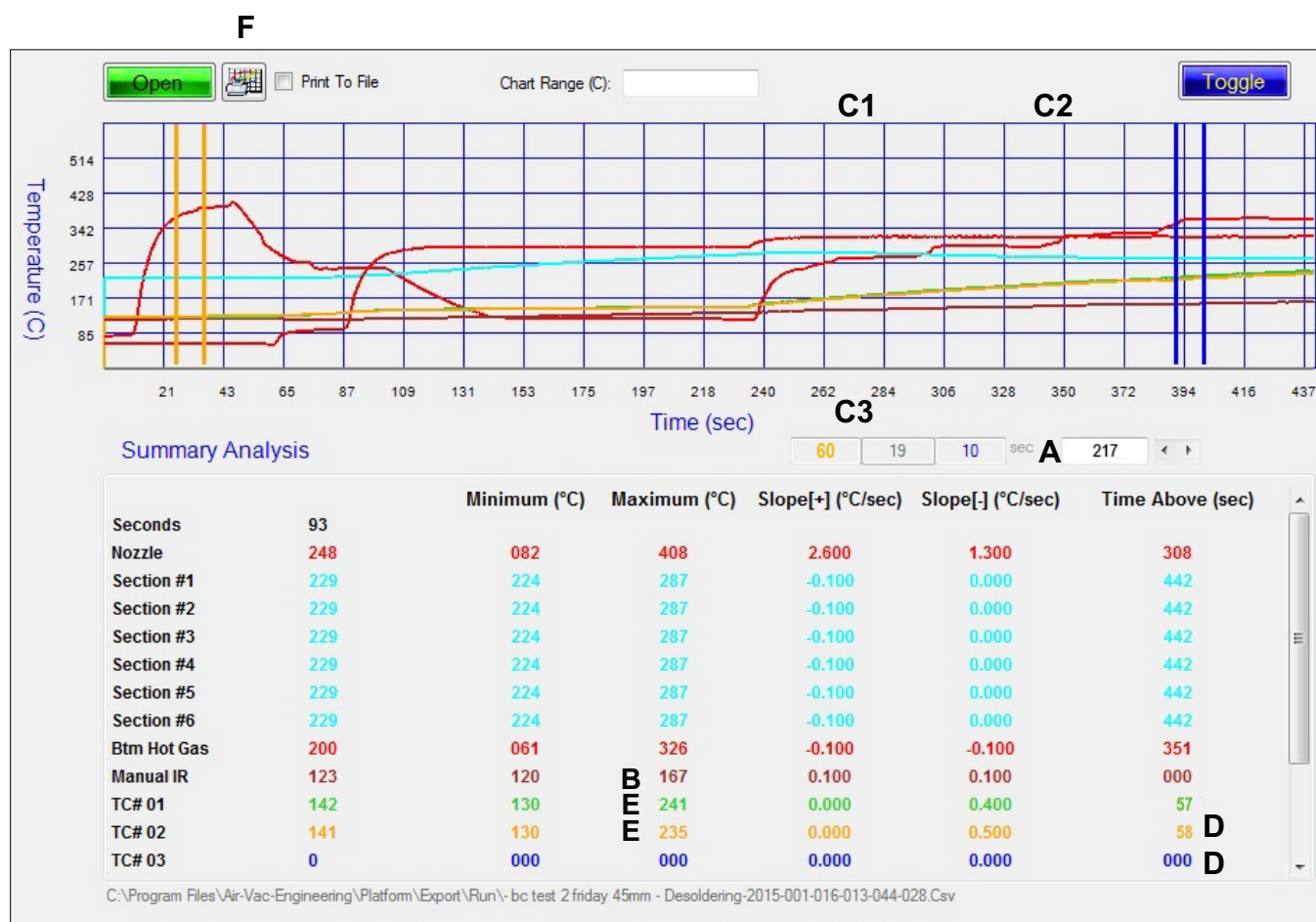


Insure that you are looking in the Tutor folder.

- Path to data is **C: Program Files>Air-Vac Engineering>Platform>Export>Tutor**
- Double click on the thermal profile that you just created to open it.



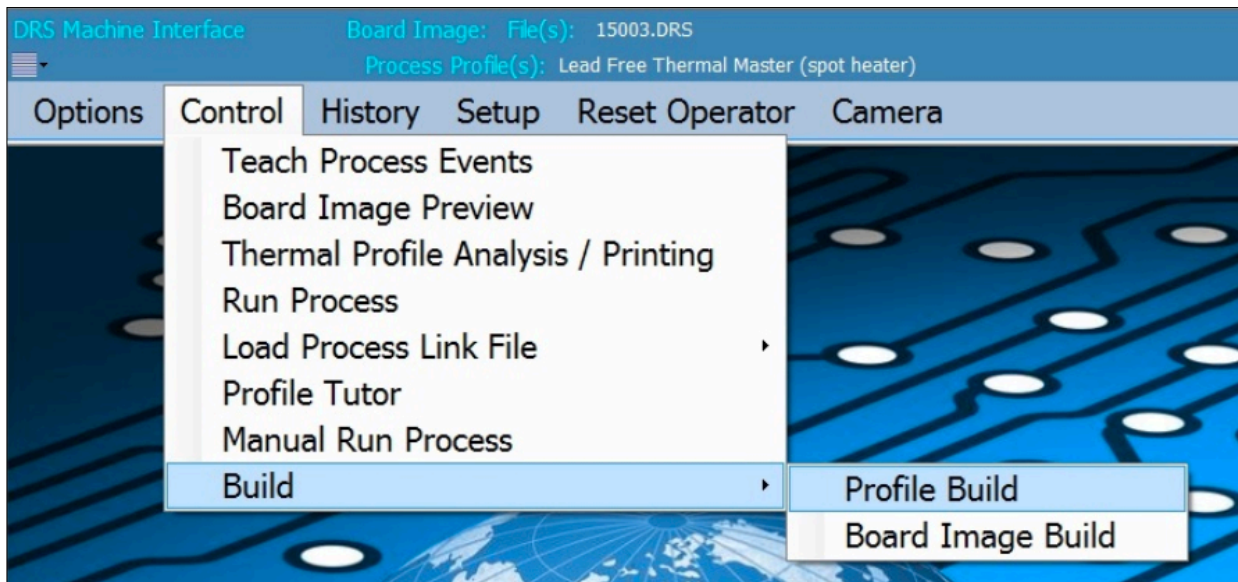
- Change “Time Above” box **(A)** to 217 (Lead-Free), 183 (Tin Lead).
- Preheat – Verify that max top side board temperature **(B)** did not exceed 190C (ok 167C).
- Soak – Position first yellow bar **(C1)** where T/C#1 is 170C, second yellow bar **(C2)** where T/C#1 is at 200C. Soak stage **(C3)** should be 45-75 seconds (ok 60 seconds).
- Reflow – Joints **(D)** should have time above 217C of 45-75 seconds (ok 57 and 58 seconds). Confirm max joint temperature **(E)** was approximately 240C (ok 241, 235).
- Maximum package temperature should not exceed 260 (ok 248C).
- The thermal profile can be printed **(F)** for permanent record keeping.



5.0.7 Profile Build

Now that a good thermal profile has been created and saved for the new application, the Automatic Profile Build function is used to integrate the new thermal profile into a complete rework process that enables the user to remove, site clean and replace the new component.

- Select Control/Build/Profile Build.



- Under Tutor Results **(A)** (radio button filled), select (double click) the thermal profile that you created **(A)**, saved and analyzed.
- The thermal profile will be shown in the “Tutor Results” box **(B)**.
- Click on the site cleaning radio button **(C)**. Select the appropriate site clean profile. It will be displayed in the site clean box **(D)**.
- Click on the Tutor Masters radio button **(E)** and select the appropriate Master Templates which will be displayed in the four boxes **(F)**.
- Select/create the profile groups **(G)** where you want the profile to be saved to.
- Name the new profile **(H)**.

NOTE: A good way to create the profile name is to copy the tutor results name and paste it in the Profile Name box.

DRS Machine Interface Board Image: File(s): 053112.DRS
Process Profile(s): 27mm BGA (lead free) Alpha Board (072215 bpc)

Name and Link Control **Tutor Build Profile**

☒ Use IR Sensor ☒ Replacement ☒ Removal ☒ Site Clean ☒ Thermal ☒ Update All Preheaters

Profile Name: **H** 27mm BGA (lead free) Alpha Board (072215 bpc)

Soldering: 27mm BGA (lead free) Alpha Board (072215 bpc) - Soldering 053176.DRS
Desoldering: 27mm BGA (lead free) Alpha Board (072215 bpc) - Desoldering 053177.DRS
Site Cleaning: 27mm BGA (lead free) Alpha Board (072215 bpc) - Site Cleaning 053178.DRS
Thermal: 27mm BGA (lead free) Alpha Board (072215 bpc) - Thermal 053179.DRS

Removal Master **Replacement Master**

Part 1 **F** DRS27 Removal Master (Part 1) (spot heater) 9999002.DRS **F** DRS27 Replacement Master (Part 1) (spot heater) 9999004.DRS
Part 2 **F** DRS27 Removal Master (Part 2) (spot heater) 9999003.DRS **F** DRS27 Replacement Master (Part 2) (spot heater) 9999005.DRS

Profile Groups - Save

Customer Group: DRS27
Board Group: DRS27
Component/Location Group: DRS27

File Search

A ☒ Tutor Results **C** ☐ Site Cleaning ☐ All ☐ Tutor Masters **E**

DRS Profile Name	File Path
00 27 mm Prod (TIN LEAD) (063 bd) (bc 103005)	C:\Program Files\Air-Vac-Engin
27mm BGA (lead free) Alpha Board (072215 bpc)	C:\Program Files\Air-Vac-Engin
45mm (042715)	C:\Program Files\Air-Vac-Engin
45mm substrate (042115)	C:\Program Files\Air-Vac-Engin
60mm MLC (42315)	C:\Program Files\Air-Vac-Engin

Tutor Results: **B** 27mm BGA (lead free) Alpha Board (072215 bpc)
Site Clean: **D** Lead Free Site Cleaning (with spot heater)

DRS27 Online Reading_Machine None 0 None

Object **J**
X 27.000
Y 27.000
Z-Height 2.000
Nozzle **J**
Z-Offset -2.500
Board **J**
Z-Height 2.300

- Check the “Use” box **(I)**.
- The Object/Nozzle/Board dimensions **(J)** should automatically update from the saved Tutor result. If they are not correct, update them.

Note: Incorrect Object/Nozzle/Board values may cause the nozzle to hit the component at high speed causing damage.

- Enter set-up notes for the application **(J)**.
- Select the Thumbs Up/Exit icon **(K)** to save.

Process Notes / Control

Description: Alpha board

Component: PBGA 27mm 324 I/O lead free

Location: U7

Flux/Solder Type: Kester 2331 no clean tacky paste flux

Tool #: NT27EZ27

Notes:

J

☐ Leded Reflow 183 ☒ Lead-Free Reflow 217 ☐ Board Cooling Idle

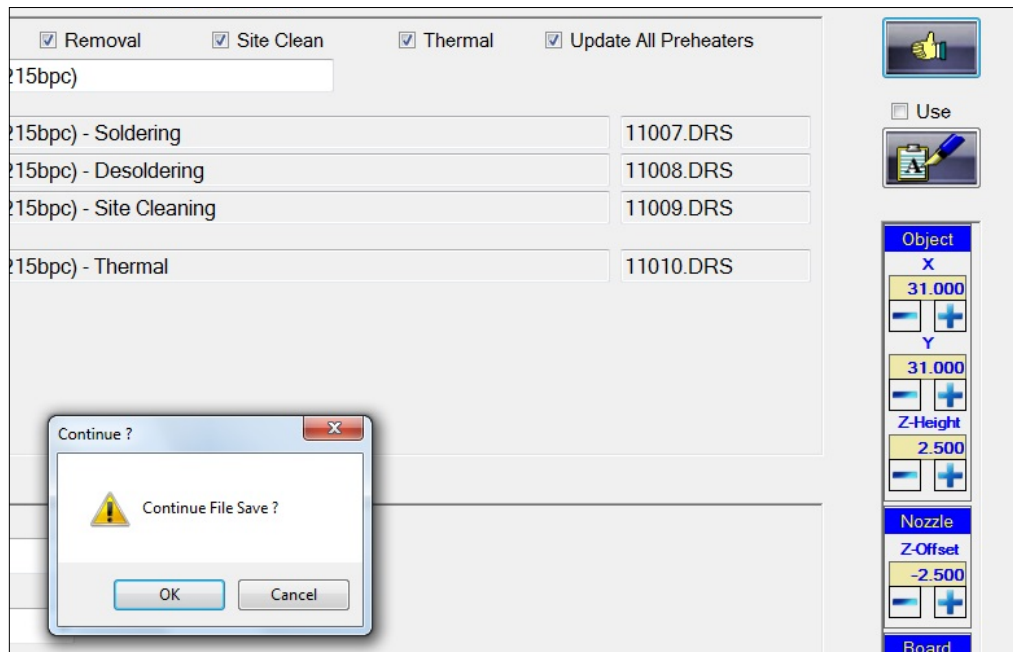
Application Notes

Use flux for site cleaning and component replacement

K



- Select the thumbs up icon **(L)** to save.
- Click “OK” **(M)** to continue file save.

**M**

- Select Options/Open/Profile Open from the main menu.



Four (4) new profiles will be displayed in the directory you specified in Profile Build:

- Desoldering: Automatic component removal using the thermal profile you developed, excluding cooling.
- Site Cleaning: Removal of residual site solder after component removal.
- Soldering: Component replacement using the thermal profile you developed, including cooling.
- Thermal: The thermal profile you created, but with time-based events.

DRS Machine Interface

Board Image: File(s):
Process Profile(s):

Files

DRS Profile Name	File
27mm BGA (lead free) Alpha Board (052215bpc) - Desoldering	C:\Program Files\Air-Vac-Engineering\PI
27mm BGA (lead free) Alpha Board (052215bpc) - Site Cleaning	C:\Program Files\Air-Vac-Engineering\PI
27mm BGA (lead free) Alpha Board (052215bpc) - Soldering	C:\Program Files\Air-Vac-Engineering\PI
27mm BGA (lead free) Alpha Board (052215bpc) - Thermal	C:\Program Files\Air-Vac-Engineering\PI

Customer Group

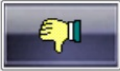
DRS27

Board Group

DRS27

Device Group

DRS27

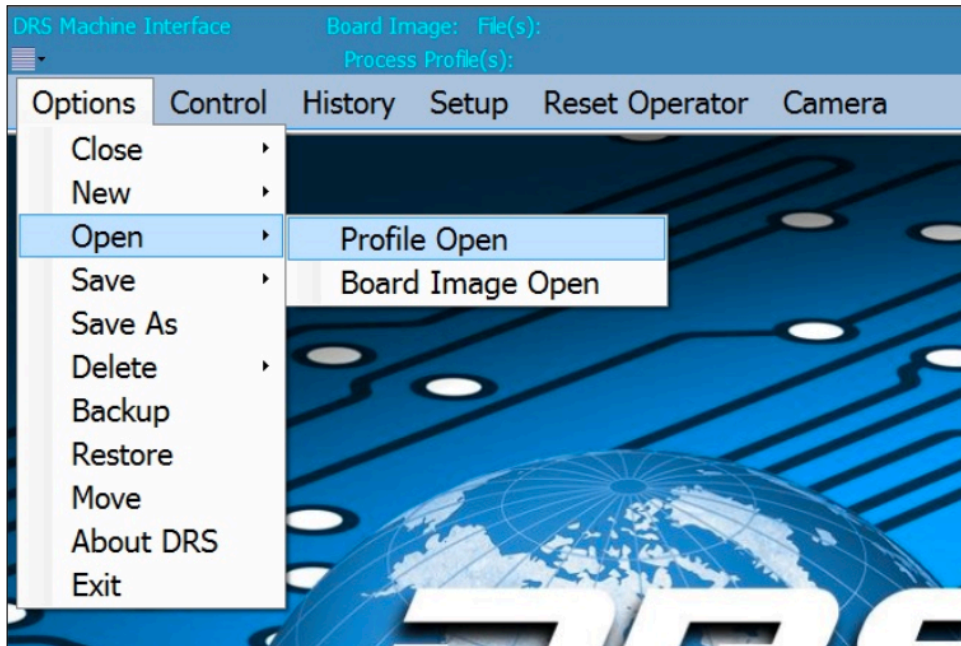


☒ DRS27 Profiles



DRS27 Online Heaters_Hot Reading_Machine None 0 None

5.0.8 Program Execution



Four new profiles should now be available. “Desoldering”, “Site Cleaning”, “Soldering”, and “Thermal” are automatically appended to the file name you created.

Files		
	DRS Profile Name	File
▶	U1 27mm BGA LF (NT27EZ27) 012315bc - Desoldering	C:\Program Files\Air-Vac-Engine
	U1 27mm BGA LF (NT27EZ27) 012315bc - Site Cleaning	C:\Program Files\Air-Vac-Engine
	U1 27mm BGA LF (NT27EZ27) 012315bc - Soldering	C:\Program Files\Air-Vac-Engine
	U1 27mm BGA LF (NT27EZ27) 012315bc - Thermal	C:\Program Files\Air-Vac-Engine

- Double click on the Desoldering profile to open it.

The process notes page is then displayed for the operator.

- Click Thumbs Up to continue to the Run screen after reviewing the setup notes.

DRS Machine Interface Board Image: File(s): 052004.DRS
Process Profile(s): U1 27mm BGA LF (NT27EZ27) 012315bc - Desoldering

Application Notes

Description: Component Removal

Component:

Location:

Flux Type:

Nozzle #: enter

Notes:

- Install Nozzle
- Install Board (position board supports, if necessary)



Continue To: RunProcess ☐ Default Reflow 183 ☒ 217

DRS27 Online | Reading_Machine None 0 None

The profile name **(A)** will be displayed at the top of the page.

- Select Cycle Start **(B)** to start the profile. Follow all prompts.
- After the component is removed, select “Load Process Link File” **(C)** for site cleaning. Execute and reiterate for soldering.

DRS Machine Interface Board Image: File(s): 052004.DRS
Process Profile(s): U1 27mm BGA LF (NT27EZ27) 012315bc - Desoldering **A**

C Load Process Link File Camera

Process Control

	0	30
Nozzle	0	30
Section #1	0	23
Section #2	0	24
Section #3	0	23
Section #4	0	23
Section #5	0	23
Section #6	0	22
Btm Hot Gas	0	22

Stblz Noz Htr 23
Manual IR 6
TC# 03 20
TC# 04 20

Site% 000
Z-HotGas

Process Status

Idle

Chart Options

Temperature vs Time

Temperature (C)

Time (sec)

1 / 13 ☐ Dry Run

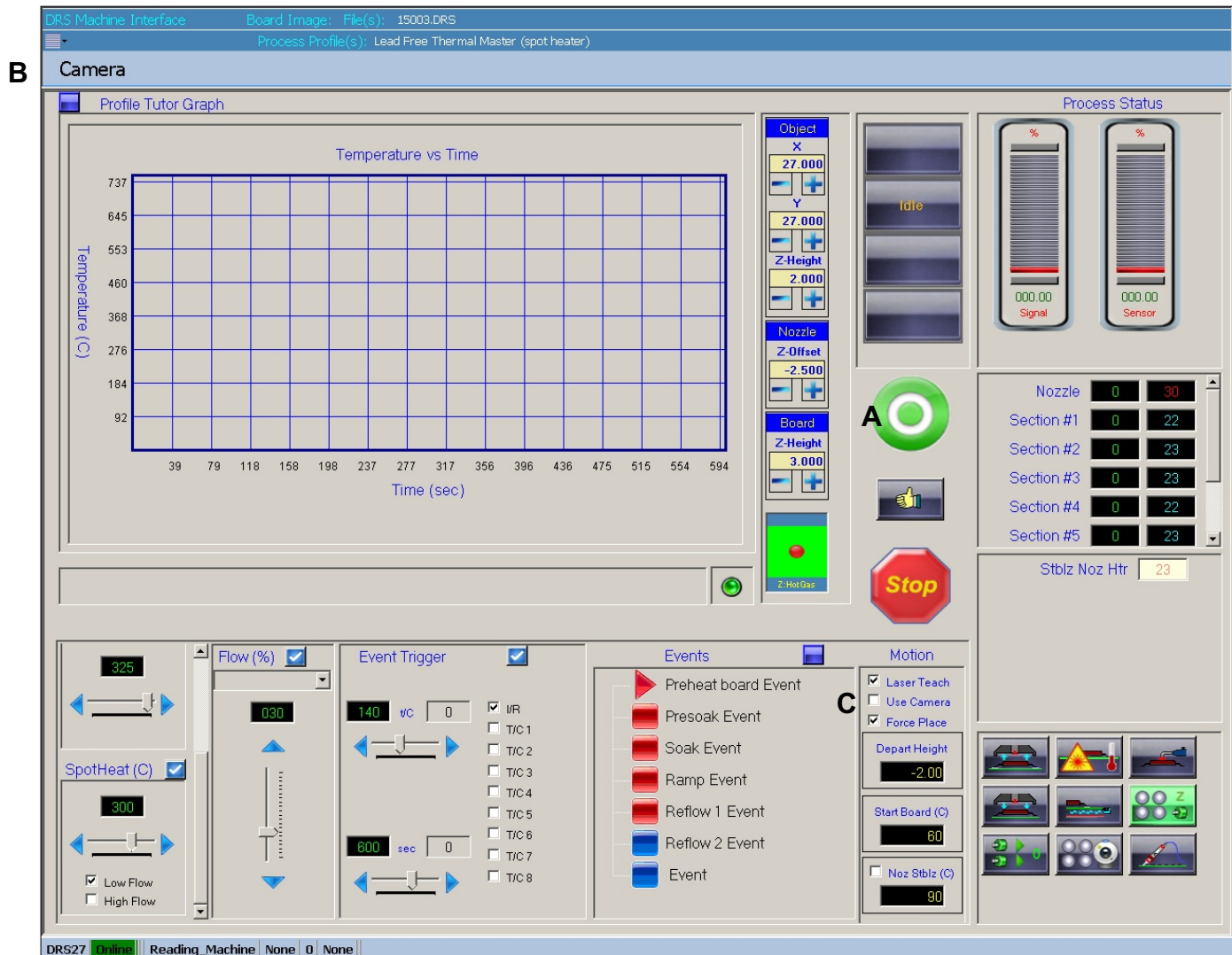
Stop

B

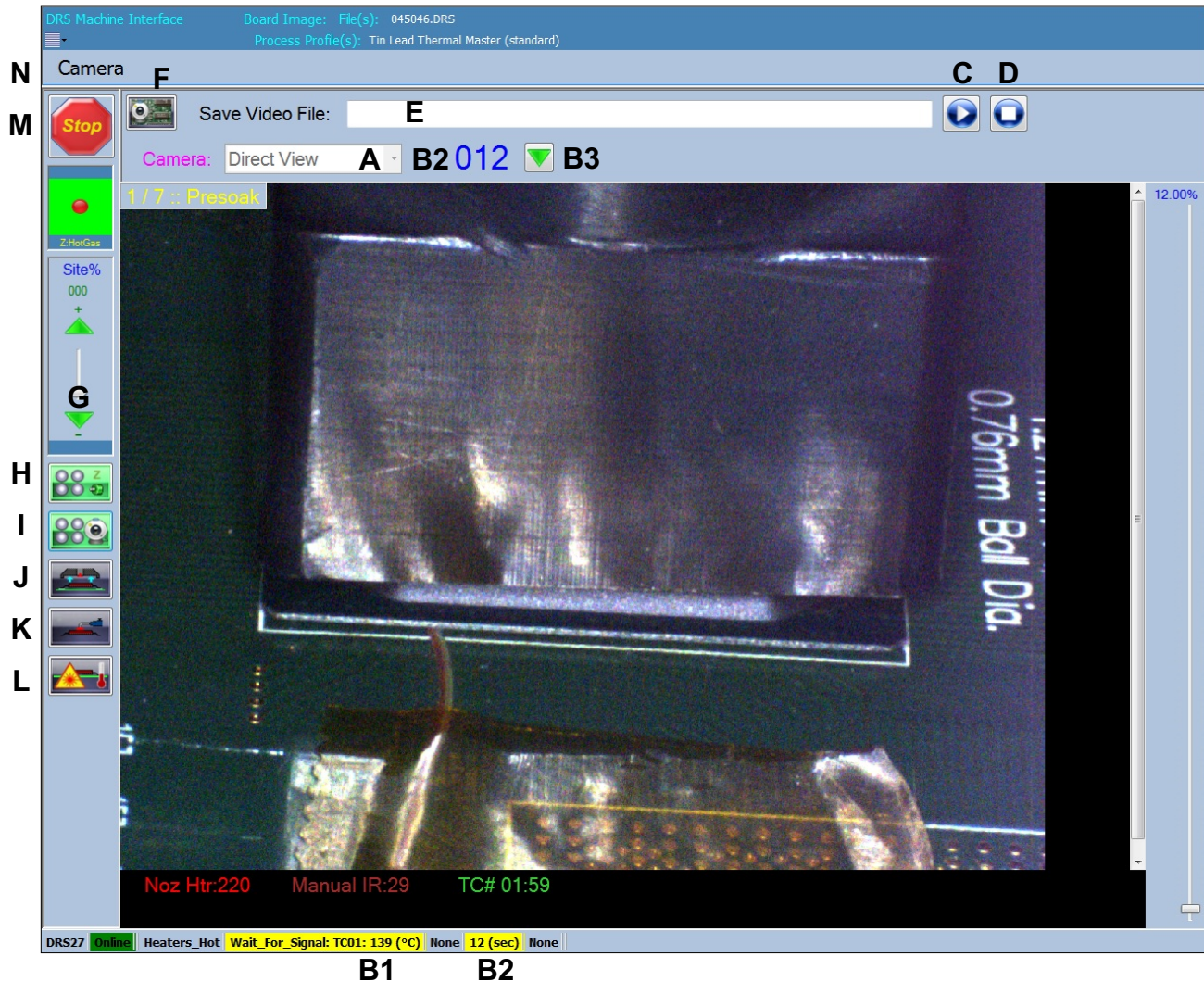
DRS27 Online Reading_Machine None 0 None

5.0.9 Direct View Camera Software Screen & Live View

Access the Tutor Camera screen after starting a Tutor Run **(A)**, by clicking on the **Camera** option **(B)** in the top left corner of the main Tutor screen, then choose **Open**.



If the **Use Camera** checkbox **(C)** was checked during setup, prior to starting a Tutor Run, the system will automatically go directly to the Camera screen after starting Tutor **(A)**.



A – Direct View Camera is automatically selected.

B1 – The Target temperature is displayed.

B2 – The Time is displayed and recorded.

B3 – Clicking Down Arrow advances to next event and records time.

C, D, E, F – Capture Live Video Files. Start the live video recording by clicking **C**, stop by clicking **D**.

Assign a name for file in **E**, then click **F** to choose a location to store file.

G – Adjusts height of Site Clean tool above site. **NOTE:** This feature is not active in Tutor, only active during the site cleaning process.

H – Takes the Z-Axis to the home position.

I – Turns the Direct View Camera light ring on and off.

J – Turns the Nozzle vacuum on and off.

K – Turns the Pickup Probe vacuum on and off.

L – Turns the Laser Pointer (aiming IR Sensor) on and off.

M – Stops the process.

N – Click **N** then choose Close to go back to the main Tutor screen.

6: Templates: Removal, Site Clean, Replacement

6	Templates	3
6.0	OVERVIEW	3
6.1	REMOVAL TEMPLATE	3
6.2	SITE CLEAN TEMPLATE	15
6.3	REPLACEMENT TEMPLATE (SOLDERING).....	25

6 Templates

6.0 Overview

After a user develops a new thermal profile in Profile Tutor, the Build function is used to create complete desoldering, site cleaning, and soldering profiles.

The events in these templates are explained and documented in this section.

6.1 Removal Template

- Select Options/Open/Profile Open
- Select the Customer/Board/Device Group where the new profile was saved.
- Highlight the desoldering profile and click on the thumbs up icon to proceed.

DRS Machine Interface

Board Image: File(s):

Process Profile(s):

Files

DRS Profile Name	File
45mmSBGA Cisco 052715 bpc - Desoldering	C:\Program Files\Air-Vac-Engineering\Pl
45mmSBGA Cisco 052715 bpc - Site Cleaning	C:\Program Files\Air-Vac-Engineering\Pl
45mmSBGA Cisco 052715 bpc - Soldering	C:\Program Files\Air-Vac-Engineering\Pl
45mmSBGA Cisco 052715 bpc - Thermal	C:\Program Files\Air-Vac-Engineering\Pl

Customer Group

Cisco

Board Group

Device Group

☒ DRS27 Profiles

DRS27

Online

Reading_Machine

None

0

None

- Select **TeachProcess** in the **Continue To** pull down box.

Application Notes

Description: Component Removal

Component:

Location:

Flux Type:

Nozzle #: enter

Notes:

- Install Nozzle
- Install Board (position board supports, if necessary)

Continue To: TeachProcess

Default Reflow 183 217

- The nozzle heater is turned on to stabilize the hot gas head.

Miscellaneous Control

Solder Reflow: 217 (C) Msg: Stabilizing Nozzle. Please Wait

Task Options Show Any Selected

Process Heating

- ☒ Z-Axis HotGas - Heater

Thermocouple Control

- ☒ Thermocouple Wait

Task Properties

Flow Control (%) 65

Use Heater By-Pass Flow ☐

Use High-Flow Range ☐

Temperature (°C) 400

Wait For Heater In-Position ☐

Use Heater Ramp ☐

Use Stabilize Option ☐

Support Options

- This event will continue until the hot gas head thermocouple reaches 90°C.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Stabilizing Nozzle. Please Wait

Task Options [Show Any Selected](#)

Process Heating

☒ Z-Axis HotGas - Heater

Thermocouple Control

☒ Thermocouple Wait

Task Properties

Channel: ☐ TC04 ☐ TC05 ☐ TC06 ☐ TC07 ☐ TC08 ☒ Stblz Noz Htr

Function: **WaitTC**

Temperature (°C): **90**

Direction: **Increase**

Maximum Delay (sec): **600**

Use Laser Pointer ☐

Move To Safe Height ☐

Support Options

- The nozzle heater is then shut off.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg:

Task Options [Show Any Selected](#)

Process Heating

☒ Z-Axis HotGas - Heater

Task Properties

Flow Control (%): **0**

Use Heater By-Pass Flow ☐

Use High-Flow Range ☐

Temperature (°C): **0**

Wait For Heater In-Position ☐

Use Heater Ramp ☐

Use Stabilize Option ☐

Support Options

- The Laser Pointer Teach is used to locate the component.
- The operator is instructed to position the IR sensor.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg:

Task Options Show Any Selected Task Properties Support Options

General Motion

☒ Laser Pointer Teach Position

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Remove Motion

☒ Start Heating Position - Board Carrier

FootSwitch ☒

- The bottom heater and spot heater are activated.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg:

Task Options Show Any Selected Task Properties Support Options

General Motion

☒ Laser Pointer Teach Position

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Remove Motion

☒ Start Heating Position - Board Carrier

Heater

☒ Section #1
☒ Section #2
☒ Section #3
☒ Section #4
☒ Section #5
☒ Section #6

Temp (°C) ◀ 250 ▶

Use LowFlow Board Cooling Off ▼

Use HighFlow Board Cooling Off ▼

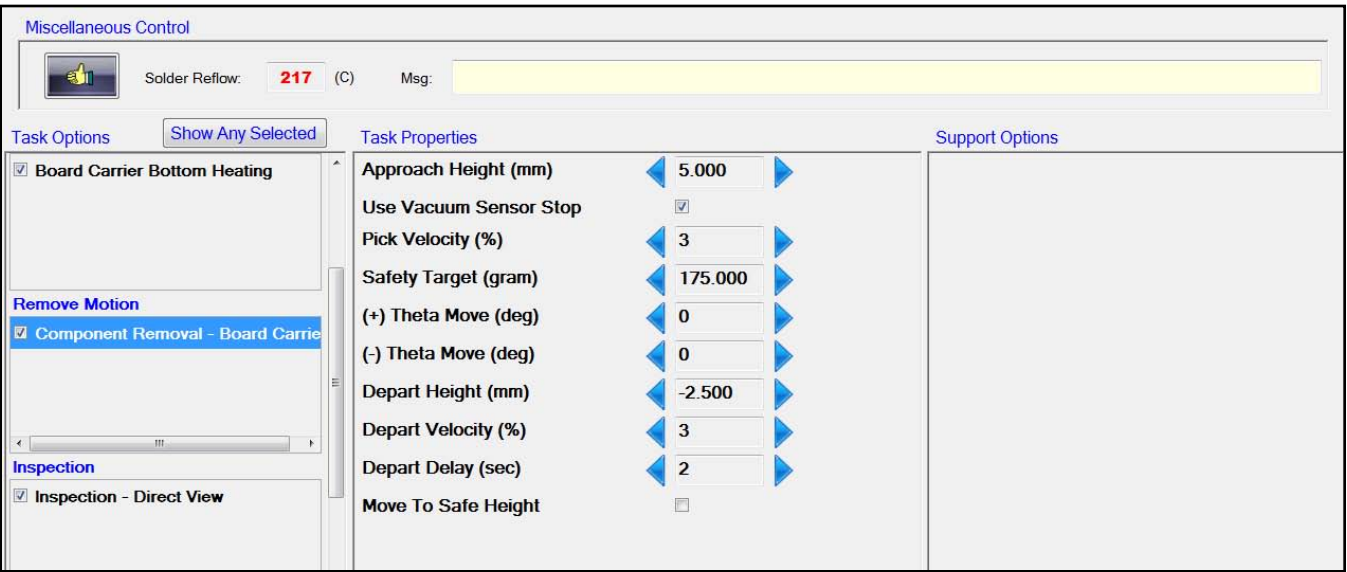
HotGas Temp (°C) ◀ 100 ▶

Use LowFlow HotGas On ▼

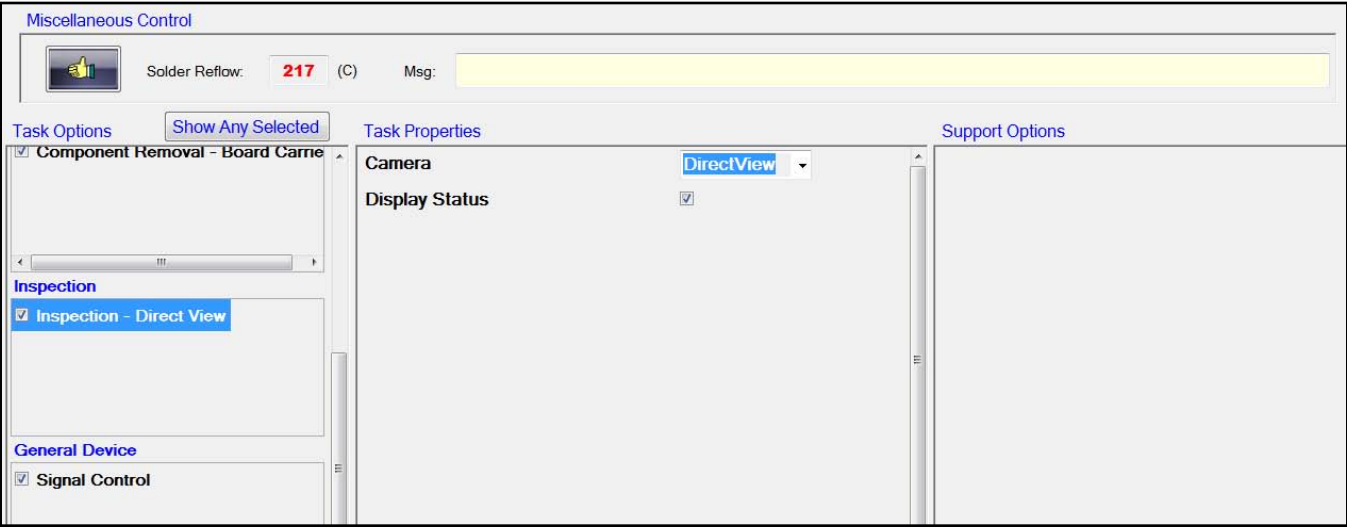
Use HighFlow HotGas Off ▼

Use Stabilize HotGas Option ☐

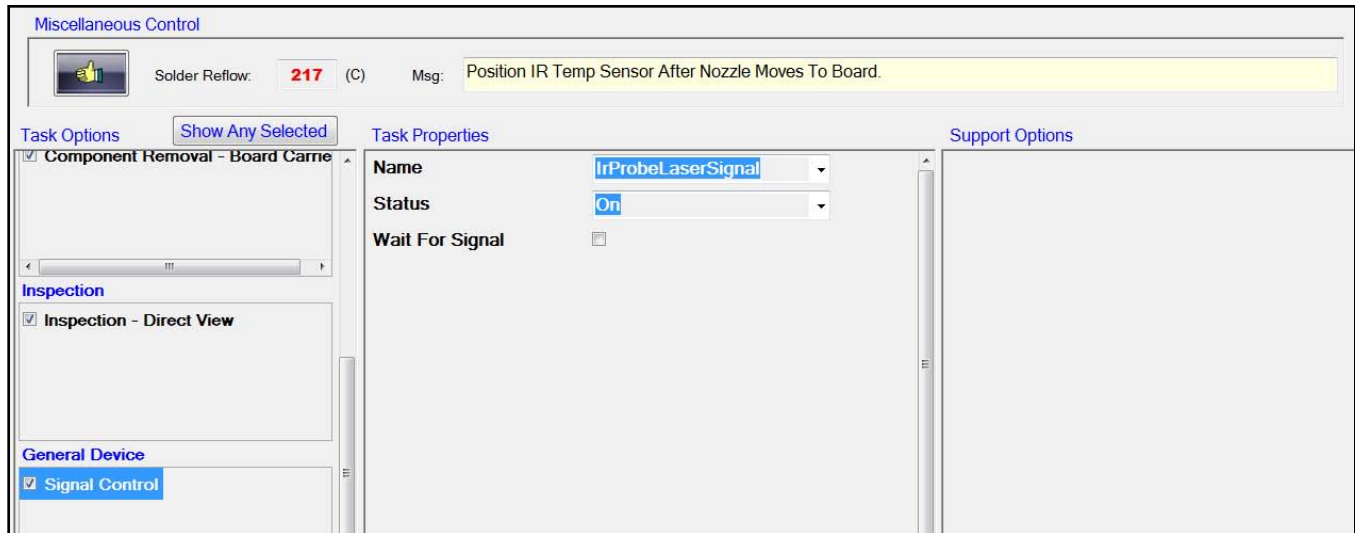
- The nozzle force touches the component and retracts the programmed distance (A).



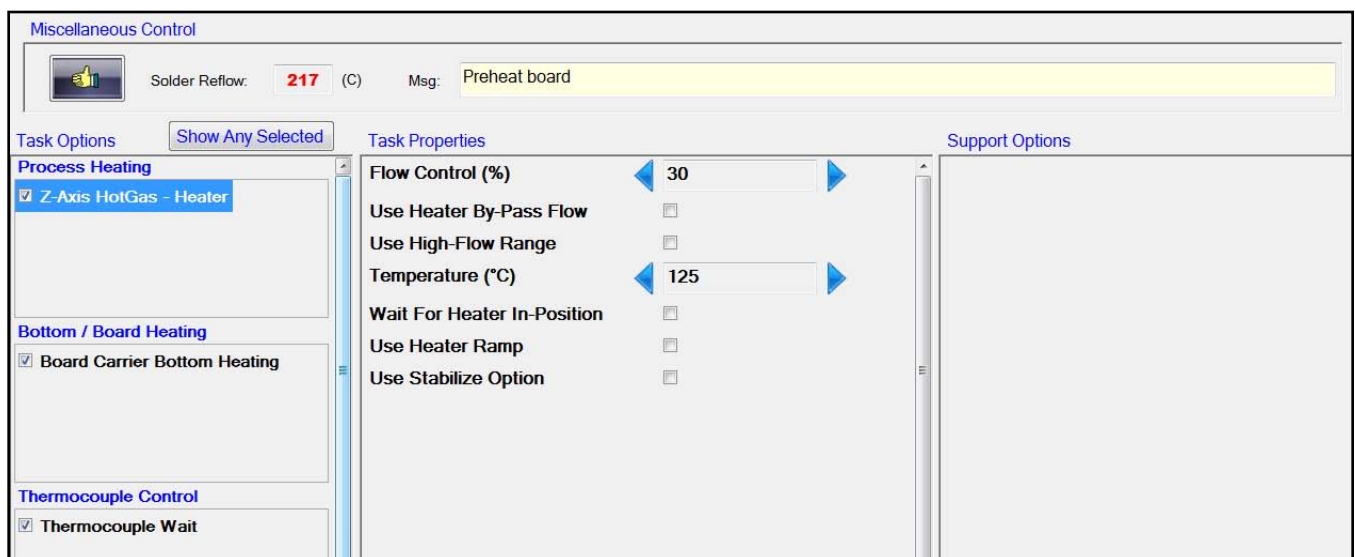
- The direct view camera activates.



- The laser pointer on the IR temperature sensor is activated.
- The operator is prompted to position the IR sensor.



- The nozzle heater is activated.



- The bottom heater and spot heaters are activated.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Preheat board

Task Options [Show Any Selected](#)

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Thermocouple Control

☒ Thermocouple Wait

Task Properties

Heater

☒ Section #1
☒ Section #2
☒ Section #3
☒ Section #4
☒ Section #5
☒ Section #6

Temp (°C)

Use LowFlow Board Cooling

Use HighFlow Board Cooling

HotGas Temp (°C)

Use LowFlow HotGas

Use HighFlow HotGas

Use Stabilize HotGas Option ☐

Support Options

- The board is preheated to 140°C from the thermal profile developed in profile tutor.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Preheat board

Task Options [Show Any Selected](#)

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Thermocouple Control

☒ Thermocouple Wait

Task Properties

Channel

☒ IR Manual
☐ TC01
☐ TC02
☐ TC03
☐ TC04
☐ TC05

Function

Temperature (°C)

Direction

Maximum Delay (sec)

Use Laser Pointer ☐

Move To Safe Height ☐

Support Options

- The nozzle heater setting and time from the presoak stage in the thermal profile.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Presoak

Task Options [Show Any Selected](#) Task Properties Support Options

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Flow Control (%)

Use Heater By-Pass Flow ☐

Use High-Flow Range ☐

Temperature (°C)

Wait For Heater In-Position ☐

Use Heater Ramp ☐

Use Stabilize Option ☐

- The bottom heater and spot heater settings from the presoak stage in the thermal profile.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Presoak

Task Options [Show Any Selected](#) Task Properties Support Options

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Heater

☒ Section #1
☒ Section #2
☒ Section #3
☒ Section #4
☒ Section #5
☒ Section #6

Temp (°C)

Use LowFlow Board Cooling

Use HighFlow Board Cooling

HotGas Temp (°C)

Use LowFlow HotGas

Use HighFlow HotGas

Use Stabilize HotGas Option ☐

- Soak stage time and nozzle heater settings from the thermal profile.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Soak

Task Options [Show Any Selected](#)

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Flow Control (%)

Use Heater By-Pass Flow ☐

Use High-Flow Range ☐

Temperature (°C)

Wait For Heater In-Position ☐

Use Heater Ramp ☐

Use Stabilize Option ☐

Support Options

- Bottom and spot heater soak stage settings from the thermal profile.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Soak

Task Options [Show Any Selected](#)

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Heater

☒ Section #1
☒ Section #2
☒ Section #3
☒ Section #4
☒ Section #5
☒ Section #6

Temp (°C)

Use LowFlow Board Cooling

Use HighFlow Board Cooling

HotGas Temp (°C)

Use LowFlow HotGas

Use HighFlow HotGas

Use Stabilize HotGas Option ☐

Support Options

- Ramp stage time and nozzle heater settings from the thermal profile.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Ramp

Task Options [Show Any Selected](#)

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Flow Control (%)

Use Heater By-Pass Flow ☐

Use High-Flow Range ☐

Temperature (°C)

Wait For Heater In-Position ☐

Use Heater Ramp ☐

Use Stabilize Option ☐

Support Options

- Ramp stage bottom heater and spot heater settings from the thermal profile.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Reflow 1

Task Options [Show Any Selected](#)

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Heater

☒ Section #1

☒ Section #2

☒ Section #3

☒ Section #4

☒ Section #5

☒ Section #6

Temp (°C)

Use LowFlow Board Cooling

Use HighFlow Board Cooling

HotGas Temp (°C)

Use LowFlow HotGas

Use HighFlow HotGas

Use Stabilize HotGas Option ☐

Support Options

- Automated component removal using the vacuum sensor. **NOTE: The Reflow 1 (cooldown) stage from the thermal profile was automatically deleted in the build function.**

Miscellaneous Control

Solder Reflow: **217** (C) Msg: Component Removal

Task Options

Remove Motion

☒ Component Removal - Board Carrier

Task Properties

Approach Height (mm)	5.000
Use Vacuum Sensor Stop	☒
Pick Velocity (%)	10
Safety Target (gram)	250.000
(+) Theta Move (deg)	0
(-) Theta Move (deg)	0
Depart Height (mm)	-5.000
Depart Velocity (%)	3
Depart Delay (sec)	2
Move To Safe Height	☒

Support Options

- Nozzle heater off after component removal.

Miscellaneous Control

Solder Reflow: **217** (C) Msg: Remove Component After Drop Off

Task Options

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Inspection

☒ Inspection - Direct View

Task Properties

Flow Control (%)	0
Use Heater By-Pass Flow	☐
Use High-Flow Range	☐
Temperature (°C)	0
Wait For Heater In-Position	☐
Use Heater Ramp	☐
Use Stabilize Option	☐

Support Options

- Bottom and spot heaters off.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Remove Component After Drop Off

Task Options Show Any Selected

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Inspection

☒ Inspection - Direct View

Task Properties

Heater

☒ Section #1
☒ Section #2
☒ Section #3
☒ Section #4
☒ Section #5
☒ Section #6

Temp (°C)

Use LowFlow Board Cooling

Use HighFlow Board Cooling

HotGas Temp (°C)

Use LowFlow HotGas

Use HighFlow HotGas

Use Stabilize HotGas Option ☐

Support Options

- Direct view camera off.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Remove Component After Drop Off

Task Options Show Any Selected

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Inspection

☒ Inspection - Direct View

Task Properties

Camera

Display Status ☐

Support Options

6.2 Site Clean Template

- Select Options/Open/Profile Open.
- Highlight the Site Cleaning profile.
- Thumbs up to proceed.

Files

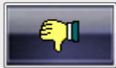
DRS Profile Name	File
45mmSBGA Cisco 052715 bpc - Desoldering	C:\Program Files\Air-Vac-Engineering\Pl
45mmSBGA Cisco 052715 bpc - Site Cleaning	C:\Program Files\Air-Vac-Engineering\Pl
45mmSBGA Cisco 052715 bpc - Soldering	C:\Program Files\Air-Vac-Engineering\Pl
45mmSBGA Cisco 052715 bpc - Thermal	C:\Program Files\Air-Vac-Engineering\Pl

Customer Group

Cisco

Board Group

Device Group

 ☒ DRS27 Profiles 

- Select TeachProcess from the pull down menu.

Application Notes

Description:

Component:

Location:

Flux Type:

Nozzle #:

Notes:

- Install Board (position board supports, if necessary)

Continue To: TeachProcess

Default Reflow 183 217

- Use the Laser Pointer Teach to locate the component.
- Position the IR sensor 2-3 inches away from the component.

Miscellaneous Control



Solder Reflow: **217** (C)

Msg: Position IR Sensor.

Task Options

Show Any Selected

Task Properties

Support Options

General Motion

☒ Laser Pointer Teach Position

Bottom / Board Heating

☒ Board Carrier Bottom Heating

General Device

☒ Signal Control

FootSwitch

☒

- Bottom and spot heaters on.

Miscellaneous Control

Solder Reflow: **217** (C) Msg: Position IR Sensor.

Task Options **Show Any Selected**

☒ Laser Pointer Teach Position

Bottom / Board Heating

☒ Board Carrier Bottom Heating

General Device

☒ Signal Control

Task Properties

Heater

☒ Section #1
☒ Section #2
☒ Section #3
☒ Section #4
☒ Section #5
☒ Section #6

Temp (°C) **325**

Use LowFlow Board Cooling **Off**

Use HighFlow Board Cooling **Off**

HotGas Temp (°C) **300**

Use LowFlow HotGas **On**

Use HighFlow HotGas **Off**

Use Stabilize HotGas Option ☐

Support Options

0

< > B D C Enter

1 2 3 4 5 6 7 8 9 0

Q W E R T Y U I O P

A S D F G H J K L

Z X C V B N M

Space

- IR probe laser on.

Miscellaneous Control

Solder Reflow: **217** (C) Msg: Position IR Sensor.

Task Options **Show Any Selected**

☒ Laser Pointer Teach Position

Bottom / Board Heating

☒ Board Carrier Bottom Heating

General Device

☒ Signal Control

Task Properties

Name **IrProbeLaserSignal**

Status **On**

Wait For Signal ☐

Support Options

- Operator prompted to Install SC Nozzle, Test vacuum and Position Direct View Camera.
- Bottom and spot heater on.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Install SC Nozzle. Test vacuum and Position Direct View Camera. Spot Heater On

Task Options Show Any Selected Task Properties Support Options

☒ Board Carrier Bottom Heating

Inspection

☒ Inspection - Direct View

General Device

☒ Signal Control

Heater

Temp (°C) 300

Use LowFlow Board Cooling Off

Use HighFlow Board Cooling Off

HotGas Temp (°C) 300

Use LowFlow HotGas On

Use HighFlow HotGas Off

Use Stabilize HotGas Option ☐

☒ Section #1
☒ Section #2
☒ Section #3
☒ Section #4
☒ Section #5
☒ Section #6

- Direct view camera on.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Install SC Nozzle. Test vacuum and Position Direct View Camera. Spot Heater On

Task Options Show Any Selected Task Properties Support Options

☒ Board Carrier Bottom Heating

Inspection

☒ Inspection - Direct View

General Device

☒ Signal Control

Camera DirectView

Display Status ☒

- Site cleaning nozzle vacuum on.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Install SC Nozzle. Test vacuum and Position Direct View Camera. Spot Heater On

Task Options [Show Any Selected](#)

☒ Board Carrier Bottom Heating

Task Properties

Name: **SiteCleanVacuum**

Status: **On**

Wait For Signal ☐

Support Options

Inspection

☒ Inspection - Direct View

General Device

☒ Signal Control

- Nozzle heater on.
- Operator prompted to flux site.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Flux Site. (preheating nozzle)

Task Options [Show Any Selected](#)

Process Heating

☒ Z-Axis HotGas - Heater

Task Properties

Flow Control (%)

Use Heater By-Pass Flow ☐

Use High-Flow Range ☐

Temperature (°C)

Wait For Heater In-Position ☐

Use Heater Ramp ☐

Use Stabilize Option ☐

Support Options

- Preheating board to 120°C.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Preheating Board To 120 C

Task Options Show Any Selected Task Properties Support Options

Thermocouple Control

☒ Thermocouple Wait

Channel

Function: WaitTC

Temperature (°C): 120

Direction: Increase

Maximum Delay (sec): 600

Use Laser Pointer ☐

Move To Safe Height ☐

☒ IR Manual

☐ TC01

☐ TC02

☐ TC03

☐ TC04

☐ TC05

- Bottom and spot heater temperatures reduced after board reaches 120°C.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: PLEASE WAIT Until Tip Touches Board. Then Use X/Y Wheels To Clean Site.

Task Options Show Any Selected Task Properties Support Options

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Site Clean Motion

☒ Non Contact - Vacuum Sensor Cont

Heater

Temp (°C): 270

Use LowFlow Board Cooling: Off

Use HighFlow Board Cooling: Off

HotGas Temp (°C): 270

Use LowFlow HotGas: On

Use HighFlow HotGas: Off

Use Stabilize HotGas Option ☐

☒ Section #1

☒ Section #2

☒ Section #3

☒ Section #4

☒ Section #5

☒ Section #6

- Force touch and retract of site clean vacuum tip.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: PLEASE WAIT Until Tip Touches Board. Then Use X/Y Wheels To Clean Site.

Task Options Show Any Selected

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Site Clean Motion

☒ Non Contact - Vacuum Sensor Cont

Task Properties

Sensor Approach Height (mm)	3.000
Approach Height (mm)	3.000
Initial Heating Delay	0.000
Place Velocity (%)	5
Place Target (gram)	175.000
Depart Height (mm)	-1.000
Vacuum Control (%)	35.000
Safety Target (gram)	750.000

Support Options

- Site clean nozzle retracts.
- Operator prompted to reflux site for second pass cleaning or stop process.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Reflux Site For Second Pass Or Stop Process

Task Options Show Any Selected

General Motion

☒ Park Robot

Task Properties

Use Z-HotGas	☒
Use XY-Vision	☐
Use Theta	☐

Support Options

- Second pass force touch and retract of site clean vacuum tip.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: PLEASE WAIT Until Tip Touches Board. Then Use X/Y Wheels To Reclean Site.

Task Options [Show Any Selected](#) Task Properties Support Options

Site Clean Motion

☒ Non Contact - Vacuum Sensor Cont

Sensor Approach Height (mm) 3.000

Approach Height (mm) 3.000

Initial Heating Delay 0.000

Place Velocity (%) 5

Place Target (gram) 175.000

Depart Height (mm) -1.000

Vacuum Control (%) 35.000

Safety Target (gram) 750.000

- Nozzle moves to park position.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: (board and machine cool down)

Task Options [Show Any Selected](#) Task Properties Support Options

General Motion

☒ Park Robot

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Use Z-HotGas ☒

Use XY-Vision ☐

Use Theta ☐

- Site clean nozzle heater cool down.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: (board and machine cool down)

Task Options [Show Any Selected](#) Task Properties Support Options

General Motion

☒ Park Robot

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Flow Control (%)

Use Heater By-Pass Flow ☐

Use High-Flow Range ☐

Temperature (°C)

Wait For Heater In-Position ☐

Use Heater Ramp ☐

Use Stabilize Option ☐

Support Options

- Board cool down.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: (board and machine cool down)

Task Options [Show Any Selected](#) Task Properties Support Options

☒ Park Robot

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Heater

☒ Section #1
☒ Section #2
☒ Section #3
☒ Section #4
☒ Section #5
☒ Section #6

Temp (°C)

Use LowFlow Board Cooling

Use HighFlow Board Cooling

HotGas Temp (°C)

Use LowFlow HotGas

Use HighFlow HotGas

Use Stabilize HotGas Option ☐

Support Options

- Site clean nozzle heater off.
- Operator prompted to remove site clean nozzle and install EZ nozzle for component replacement (soldering) process.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Remove Site Clean Nozzle. CAUTION HOT. Install EZ Nozzle

Task Options [Show Any Selected](#) Task Properties Support Options

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Flow Control (%)

Use Heater By-Pass Flow ☐

Use High-Flow Range ☐

Temperature (°C)

Wait For Heater In-Position ☐

Use Heater Ramp ☐

Use Stabilize Option ☐

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Remove Site Clean Nozzle. CAUTION HOT. Install EZ Nozzle

Task Options [Show Any Selected](#) Task Properties Support Options

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Heater

☒ Section #1
☒ Section #2
☒ Section #3
☒ Section #4
☒ Section #5
☒ Section #6

Temp (°C)

Use LowFlow Board Cooling

Use HighFlow Board Cooling

HotGas Temp (°C)

Use LowFlow HotGas

Use HighFlow HotGas

Use Stabilize HotGas Option ☐

6.3 Replacement Template (Soldering)

- Select Options/Open/Profile Open.
- Highlight Soldering process.
- Thumbs up to continue.

Files

DRS Profile Name	File
45mmSBGA Cisco 052715 bpc - Desoldering	C:\Program Files\Air-Vac-Engineering\Pl
45mmSBGA Cisco 052715 bpc - Site Cleaning	C:\Program Files\Air-Vac-Engineering\Pl
45mmSBGA Cisco 052715 bpc - Soldering	C:\Program Files\Air-Vac-Engineering\Pl
45mmSBGA Cisco 052715 bpc - Thermal	C:\Program Files\Air-Vac-Engineering\Pl

Customer Group

Cisco

Board Group

Device Group



☒ DRS27 Profiles



- Change pull down list to **TeachProcess**.

DRS Machine Interface Board Image: File(s): 054005.DRS
Process Profile(s): 45mmS8GA Cisco 052715 bpc - Soldering

Application Notes

Description: Component Replacement

Component:

Location:

Flux Type: enter

Nozzle #: enter

Notes:

- Install Board
- Install Nozzle



Continue To: TeachProcess

☐ Default Reflow 183 ☒ 217

DRS27 Online Reading_Machine None 0 None

- Bottom heater and spot heater on low temperature.

Miscellaneous Control

Solder Reflow: **217** (C) Msg: Install BGA Nozzle.

Task Options [Show Any Selected](#)

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Heater

Temp (°C)

Use LowFlow Board Cooling

Use HighFlow Board Cooling

HotGas Temp (°C)

Use LowFlow HotGas

Use HighFlow HotGas

Use Stabilize HotGas Option ☐

Support Options

☒ Section #1
☒ Section #2
☒ Section #3
☒ Section #4
☒ Section #5
☒ Section #6

- Nozzle heater activated for stabilization.

Miscellaneous Control

Solder Reflow: **217** (C) Msg: Stabilizing Hot Gas Head. HEATING Please wait

Task Options [Show Any Selected](#)

Process Heating

☒ Z-Axis HotGas - Heater

Thermocouple Control

☒ Thermocouple Wait

Task Properties

Flow Control (%)

Use Heater By-Pass Flow ☐

Use High-Flow Range ☐

Temperature (°C)

Wait For Heater In-Position ☐

Use Heater Ramp ☐

Use Stabilize Option ☐

Support Options

- Stabilization continues until the head thermocouple reaches 90°C.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Stabilizing Hot Gas Head. HEATING Please wait

Task Options [Show Any Selected](#)

Process Heating

☒ Z-Axis HotGas - Heater

Thermocouple Control

☒ Thermocouple Wait

Task Properties

Channel

Function: WaitTC

Temperature (°C): 90

Direction: Increase

Maximum Delay (sec): 600

Use Laser Pointer ☐

Move To Safe Height ☐

Support Options

TC04 ☐
TC05 ☐
TC06 ☐
TC07 ☐
TC08 ☐
Stblz Noz Htr ☒

- If the head thermocouple is above 125°C, nozzle cooling will turn.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Stabilizing hot gas head . COOLING Please Wait

Task Options [Show Any Selected](#)

Process Heating

☒ Z-Axis HotGas - Heater

Thermocouple Control

☒ Thermocouple Wait

Task Properties

Flow Control (%): 65

Use Heater By-Pass Flow ☐

Use High-Flow Range ☒

Temperature (°C): 0

Wait For Heater In-Position ☐

Use Heater Ramp ☐

Use Stabilize Option ☐

Support Options

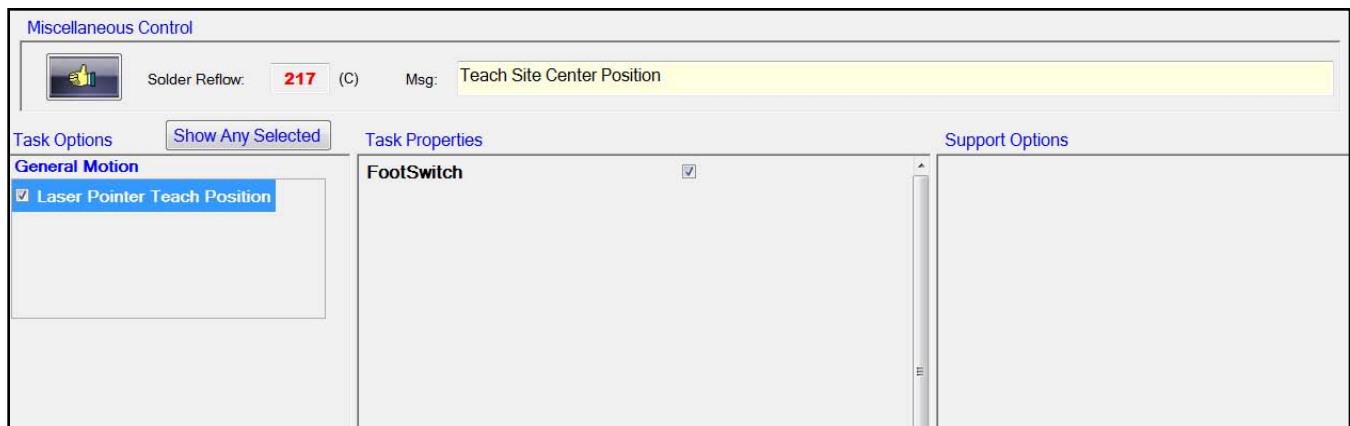
- Nozzle cooling continues until the head thermocouple falls below 125°C.
- **NOTE: The head thermocouple will be at a high temperature at the end of the site cleaning process. If a soldering process is run immediately after site cleaning, cooling of the head will take time. Cooling down the head is important for thermal repeatability.**

The screenshot shows the 'Miscellaneous Control' dialog box. At the top, there is a status bar with a thumbs-up icon, 'Solder Reflow: 217 (C)', and a message box containing 'Stabilizing hot gas head . COOLING Please Wait'. Below this, the dialog is divided into three main sections: 'Task Options', 'Task Properties', and 'Support Options'. In the 'Task Options' section, under 'Process Heating', the 'Z-Axis HotGas - Heater' checkbox is checked. Under 'Thermocouple Control', the 'Thermocouple Wait' checkbox is checked. The 'Task Properties' section contains a list of thermocouples (TC04, TC05, TC06, TC07, TC08) with 'Stblz Noz Htr' selected. Below this, the 'Function' is set to 'WaitTC', 'Temperature (°C)' is 125, 'Direction' is 'Decrease', and 'Maximum Delay (sec)' is 600. There are also checkboxes for 'Use Laser Pointer' and 'Move To Safe Height', both of which are unchecked.

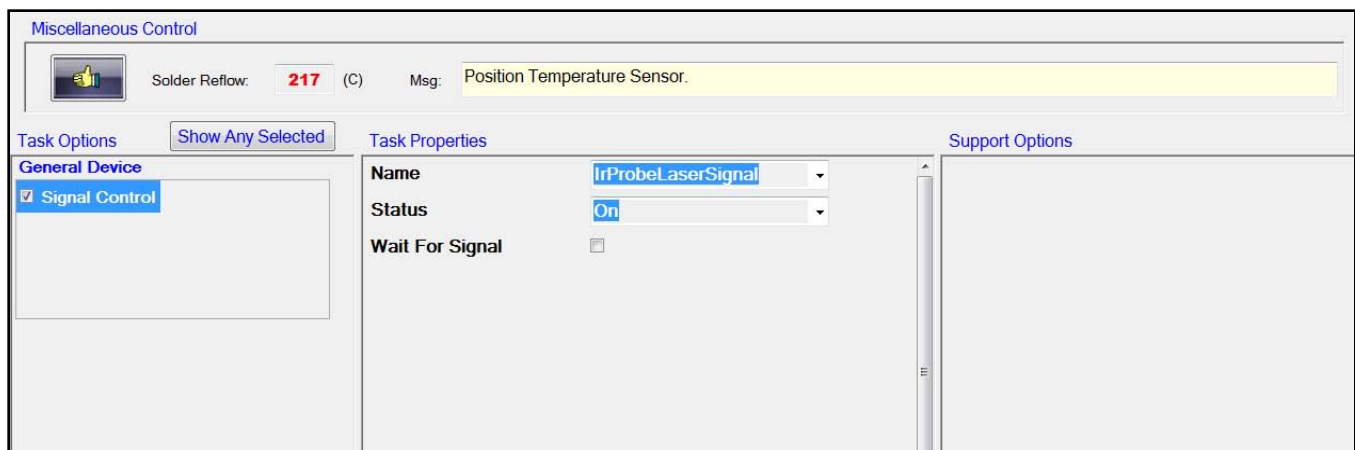
- The nozzle heater is shut off after heating/cooling of the head to the target temperature is complete.

The screenshot shows the 'Miscellaneous Control' dialog box with the 'Flow Control' section selected in the 'Task Properties' area. The 'Z-Axis HotGas - Heater' checkbox remains checked in the 'Task Options' section. In the 'Flow Control' section, 'Flow Control (%)' is set to 0, and 'Temperature (°C)' is also set to 0. There are checkboxes for 'Use Heater By-Pass Flow', 'Use High-Flow Range', 'Wait For Heater In-Position', 'Use Heater Ramp', and 'Use Stabilize Option', all of which are unchecked.

- The Laser Pointer Teach Position is activated and the operator is prompted to locate the component.



- The IR probe laser activates and the operator is prompted to position the IR probe 2-3 inches away from the component.



- The operator verifies component polarity and places the device in the universal insertion tool.
- The insertion tool is loaded in the component pickup station at the front of the vision housing.

Miscellaneous Control

Solder Reflow: **217** (C) Msg: Align Component After Pick Up

Task Options **Show Any Selected**

Process Heating

☒ Z-Axis HotGas - Heater

Feeder Pick Motion

☒ Vision Feeder - Standard Universal

Alignment Motion

☒ Object Alignment - Vision System

Task Properties

Feeder Tool Height (mm) 12.000

Approach Height (mm) 5.000

Operator Load Feeder Tray ☒

Use Vacuum Sensor Stop ☒

Pick Velocity (%) 10

Depart Height (mm) -5.000

Depart Delay (sec) 2

Depart Velocity (%) 3

Move To Safe Height ☒

Support Options

- Settings for the top and bottom LED lights, camera zoom, and initial corner view in vision during alignment.

Miscellaneous Control

Solder Reflow: **217** (C) Msg: Align Component After Pick Up

Task Options **Show Any Selected**

☒ Z-Axis HotGas - Heater

Feeder Pick Motion

☒ Vision Feeder - Standard Universal

Alignment Motion

☒ Object Alignment - Vision System

Task Properties

Top Vision LED (%) 20

Bottom Vision LED (%) 5

Camera Zoom (%) 1

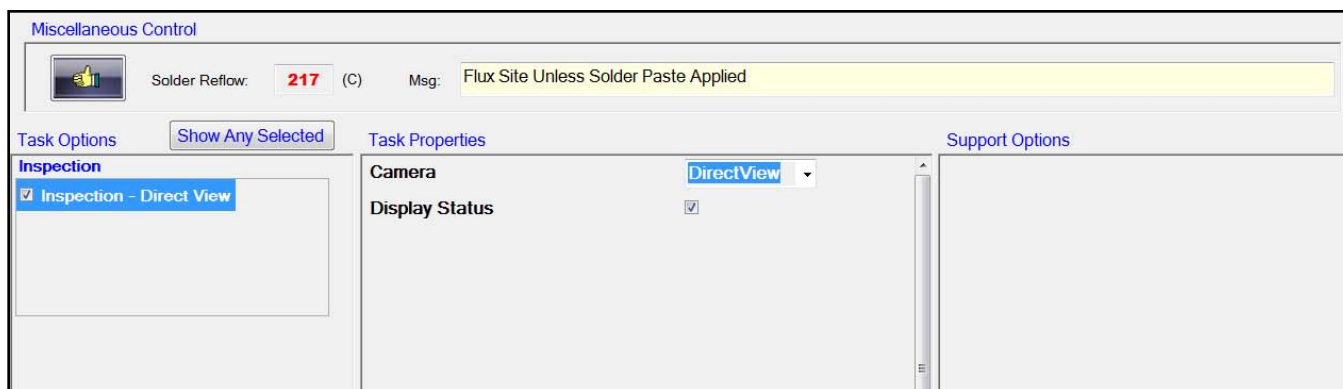
1st Corner - Vision System TLPosition

Object Margin X (mm) 0.000

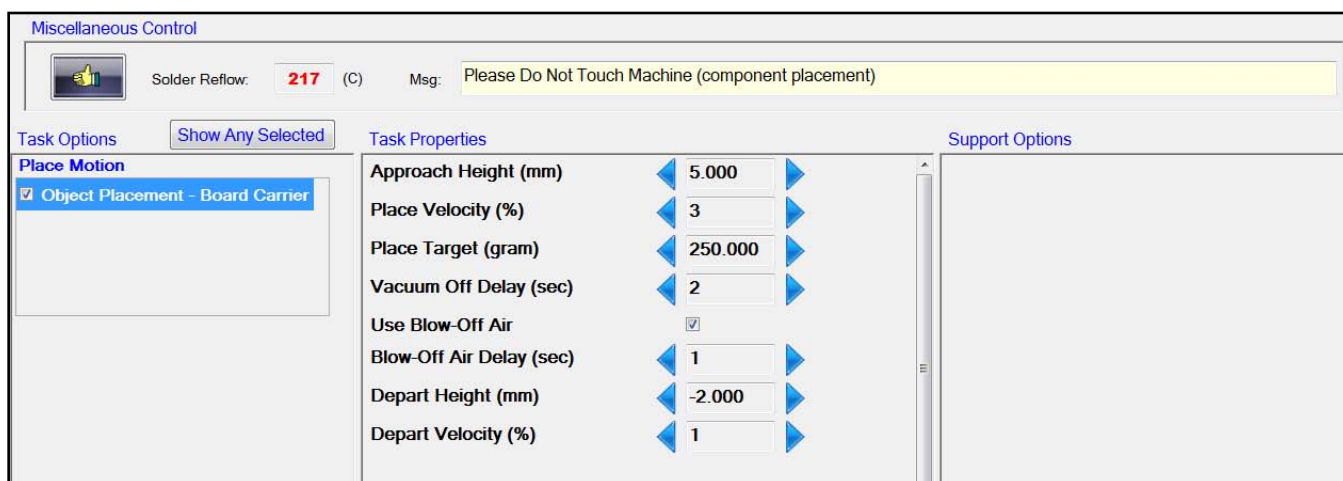
Object Margin Y (mm) 0.000

Support Options

- The direct view camera activates.
- After alignment is complete, the vision retracts and the operator is prompted to flux the site.
- **NOTE: Tacky flux should be used to hold the component in place and to improve wetting.**



- Automatic force placement of the component and retract of the nozzle.
- **NOTE: Do not touch machine during this event as it may create a false force trigger and drop the part.**



- Reflow 2 (cooling the component down from maximum temperature to below liquidus) will then execute.
- The Preheat/Presoak/Soak/Ramp/Reflow 1 stages from the thermal profile (same as in the desoldering profile) will run.

The screenshot shows the 'Miscellaneous Control' window. At the top, there is a thumbs-up icon, 'Solder Reflow: 217 (C)', and 'Msg: Reflow 2'. Below this are three tabs: 'Task Options', 'Task Properties', and 'Support Options'. The 'Task Options' tab is active, showing a list of options with checkboxes. Under 'Process Heating', 'Z-Axis HotGas - Heater' is checked. Under 'Bottom / Board Heating', 'Board Carrier Bottom Heating' is checked. Under 'Thermocouple Control', 'Thermocouple Wait' is checked. The 'Task Properties' tab is also visible, showing 'Flow Control (%)' set to 85, and several other options like 'Use Heater By-Pass Flow', 'Use High-Flow Range', 'Wait For Heater In-Position', 'Use Heater Ramp', and 'Use Stabilize Option'.

- Nozzle cooling off.

This screenshot shows the 'Miscellaneous Control' window with the 'Task Properties' tab selected. The 'Solder Reflow' temperature is still 217 (C), but the 'Msg' field is empty. In the 'Task Properties' tab, 'Flow Control (%)' is now set to 0, and 'Temperature (°C)' is also set to 0. The 'Task Options' tab remains active in the background, showing the same checked options as the previous screenshot.

- Board cooling off.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg:

Task Options Show Any Selected Task Properties Support Options

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Heater

☒ Section #1
☒ Section #2
☒ Section #3
☒ Section #4
☒ Section #5
☒ Section #6

Temp (°C) ◀ 0 ▶

Use LowFlow Board Cooling Off ▼

Use HighFlow Board Cooling Off ▼

HotGas Temp (°C) ◀ 0 ▶

Use LowFlow HotGas Off ▼

Use HighFlow HotGas Off ▼

Use Stabilize HotGas Option ☐

- Head to park position.

Miscellaneous Control

 Solder Reflow: **217** (C) Msg: Machine and Board Cooldown

Task Options Show Any Selected Task Properties Support Options

General Motion

☒ Park Robot

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Camera DirectView ▼

Display Status ☐

- Nozzle cool down.

Miscellaneous Control

Solder Reflow: **217** (C) Msg: Machine and Board Cooldown

Task Options [Show Any Selected](#) Task Properties Support Options

General Motion

☒ Park Robot

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Flow Control (%)

Use Heater By-Pass Flow ☐

Use High-Flow Range ☐

Temperature (°C)

Wait For Heater In-Position ☐

Use Heater Ramp ☐

Use Stabilize Option ☐

Support Options

- Board cool down.

Miscellaneous Control

Solder Reflow: **217** (C) Msg: Machine and Board Cooldown

Task Options [Show Any Selected](#) Task Properties Support Options

☒ Park Robot

Process Heating

☒ Z-Axis HotGas - Heater

Bottom / Board Heating

☒ Board Carrier Bottom Heating

Task Properties

Heater ☒ Section #1
☒ Section #2
☒ Section #3
☒ Section #4
☒ Section #5
☒ Section #6

Temp (°C)

Use LowFlow Board Cooling

Use HighFlow Board Cooling

HotGas Temp (°C)

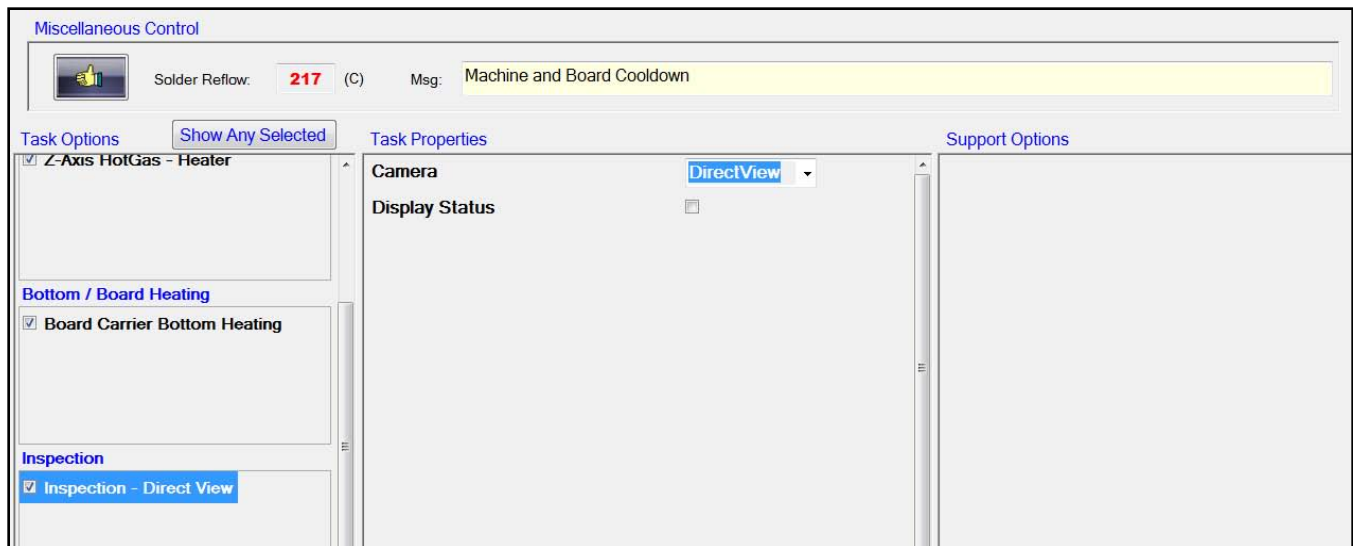
Use LowFlow HotGas

Use HighFlow HotGas

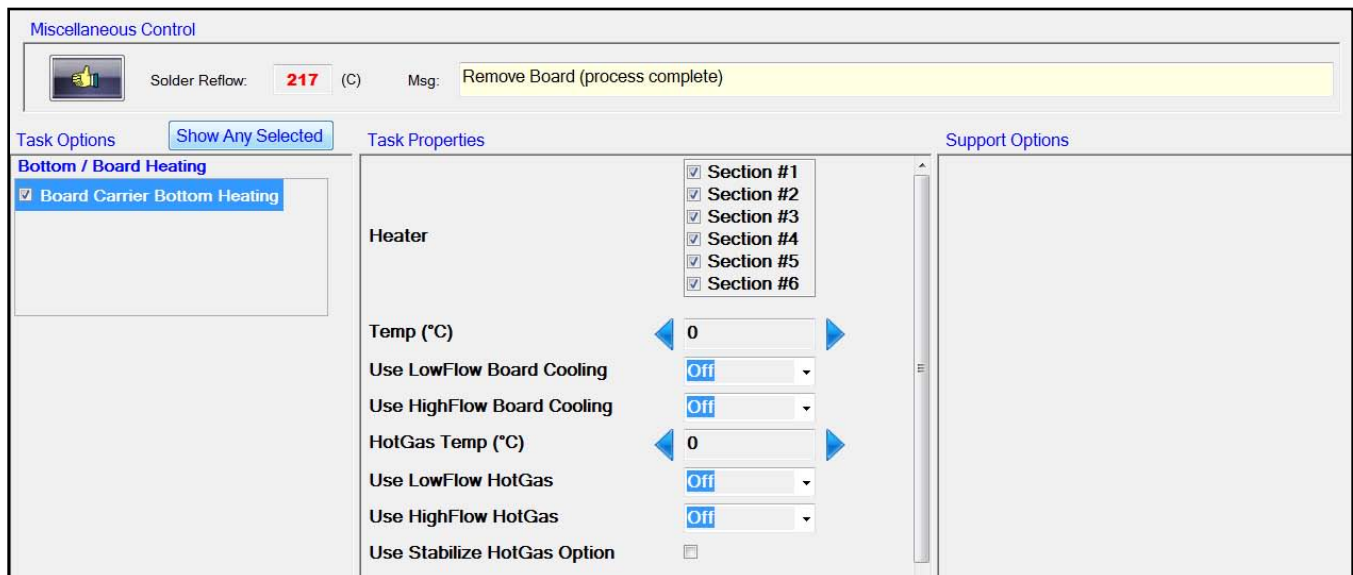
Use Stabilize HotGas Option ☐

Support Options

- Direct view camera off.



- Process complete.



7: Operator Training

7	OPERATOR TRAINING: EXECUTING A NEWLY CREATED PROFILE	3
7.0	OVERVIEW: BGA REMOVAL, SITE CLEANING, SOLDERING	3
7.1	POWER-UP/LOG IN	4
7.2	MAIN SCREEN OVERVIEW	6
7.3	OPEN A TYPICAL PROGRAM	9
7.4	INSTALL NOZZLE	11
7.5	RUNNING A TYPICAL REMOVAL PROGRAM	15
7.6	RUNNING A TYPICAL SITE CLEANING PROGRAM	21
7.7	RUNNING A TYPICAL SOLDERING PROGRAM.....	30
7.8	REFERENCE: RUN SCREEN - OPERATOR CONTROLS	41

7 Operator Training: Executing a Newly Created Profile

7.0 Overview: BGA Removal, Site Cleaning, Soldering

The following outline is an illustration of typical steps performed for BGA removal, site cleaning, and soldering.

- 1- Register as an operator.
- 2- Select the appropriate profile.
- 3- Follow the instructions of the first (note detail) screen such as load nozzle, load PCB, and position board supports.

Removal Program

- 1- Press the cycle start icon. Follow message prompts.
- 2- Automatic component removal.
- 3- Select "linking file" function to go to site cleaning program.

Site Cleaning Program

- 1- Press the cycle start icon. Follow message prompts.
- 2- Remove component nozzle with handling tools, install site cleaning nozzle.
- 3- Position nozzle tip at site, position direct view camera and flux site.
- 4- Move x/y wheels as solder melts to clean site.
- 5- Clean area and inspect.
- 6- Select "Linking File" function to go to the Soldering program.

Soldering Program

- 1- Remove site cleaning nozzle with handling tools and install component nozzle.
- 2- Follow message prompts..

WARNING!

The DRS machine is configured to run on the dedicated PC provided. The custom software is configured for optimum machine performance in conjunction with the Windows® operating system. Additional software loaded may affect performance and system integrity. The pc is not intended for personal/other use. The operator should not be in any screen other than the Air-Vac DRS27 program.

The intent of this section is to assist the operator in becoming familiar with the DRS27 Hardware and Software. In addition to this information, operator training should be supplemented by formal training from a qualified individual.

The DRS27 software is Windows®-based. When the module is powered, it automatically boots to the customized software. Extensive software knowledge is not required. The graphics interface is based on symbols (icon) or word buttons for operator functions. Operators use the software to run pre-tested/pre-approved profiles. Automatic steps and helpful prompt messages provide clear operation. Password protection restricts access to high security areas.

7.1 Power-Up/Log In

- Turn on machine power. (Disengage e-stop and turn power key.) The Green light next to the key will illuminate.
- Turn PC on and let it boot up to the Administrator screen. Click inside the black Air-Vac box. The administrator password is AirVac.
- Double click on the AV DRS27 icon to start the software.



- The Operator Registration screen will appear. Enter your operator name and click on Thumbs Up. If access is denied, contact supervisor.



- Enter Password. The Password screen will automatically appear after the Operator Registration screen. Enter a password and click on the Up Thumb icon to continue. If access is denied, consult supervisor.



NOTE: Operator Names and Passwords must be correct to access software. Low priority will only allow access to minimal screens. (The machine is shipped with “operator” and “no password” under low priority/limited access.)

Machine will perform a home operation – remove nozzle and click OK.

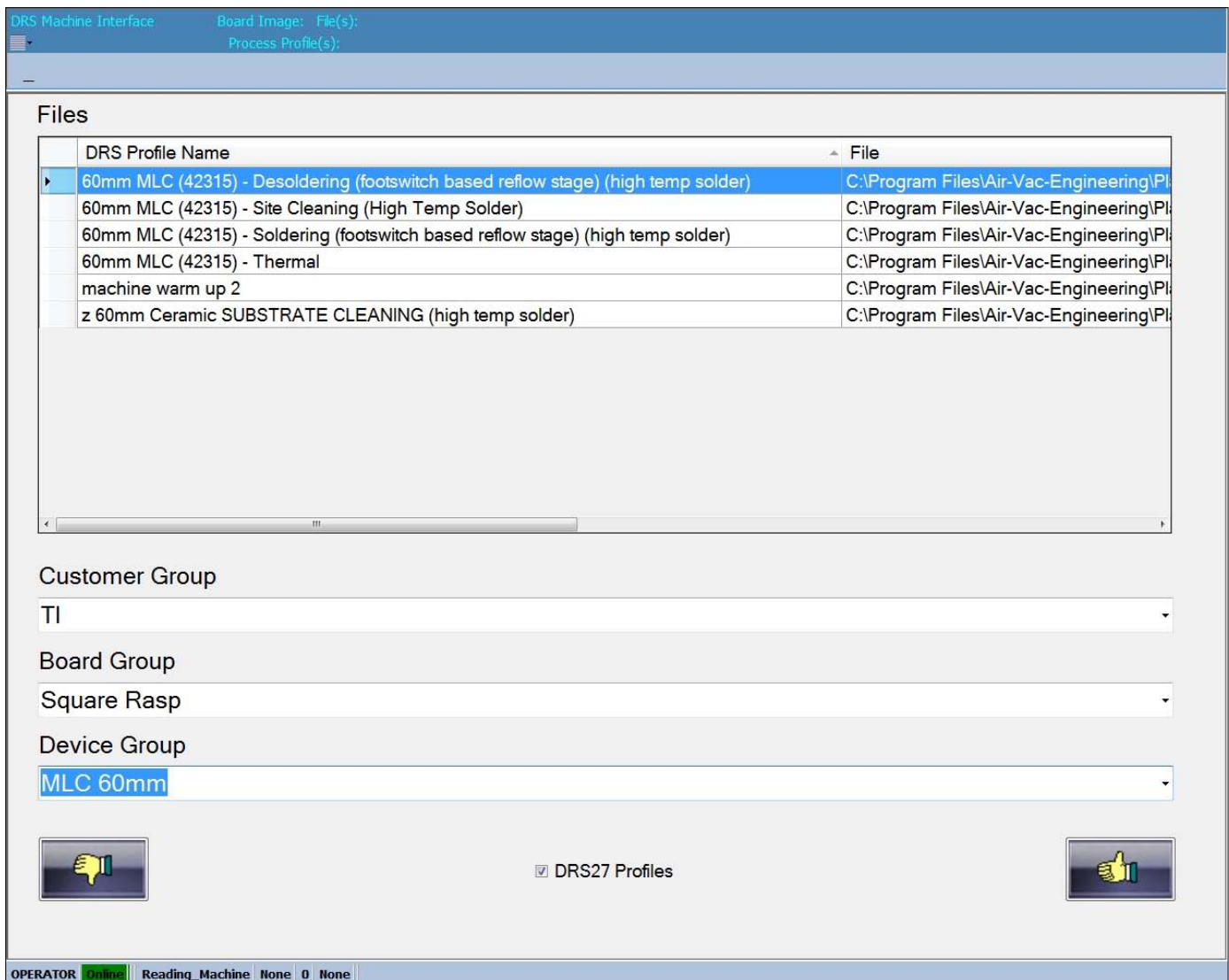
7.2 Main Screen Overview

**Note:**

Using the low priority password limits the operator access to computer screens and restricts parameters from being changed. This allows all profiles to be run as programmed.

Options:

Open/Profile Open: The programs are opened and executed. A file directory will be shown listing all created programs. In that directory, change the directory to open and execute other programs.



About DRS: Provides the current version of the software on the machine. Please note software upgrades are available; contact Air-Vac.

Exit: Closes the software prior to shutting the machine down.

Note

DO NOT TURN OFF MACHINE PRIOR BEFORE CLOSING THE SOFTWARE.

Control:

Run Process: Activates screen to run the program. This screen is automatically displayed after a program is opened and the **Open Profile screen** is presented.

Reset Operator:

Allows a new operator to log on.

Note

IT IS GOOD PROCEDURE TO PRESS **RESET OPERATOR** WHEN LEAVING THE MACHINE. THIS PREVENTS UNQUALIFIED PERSONNEL FROM USING THE MACHINE (UNDER THIS OPERATOR'S NAME). PROGRAMS AND OPERATOR NAMES ARE RECORDED IN A **HISTORY FILE**.

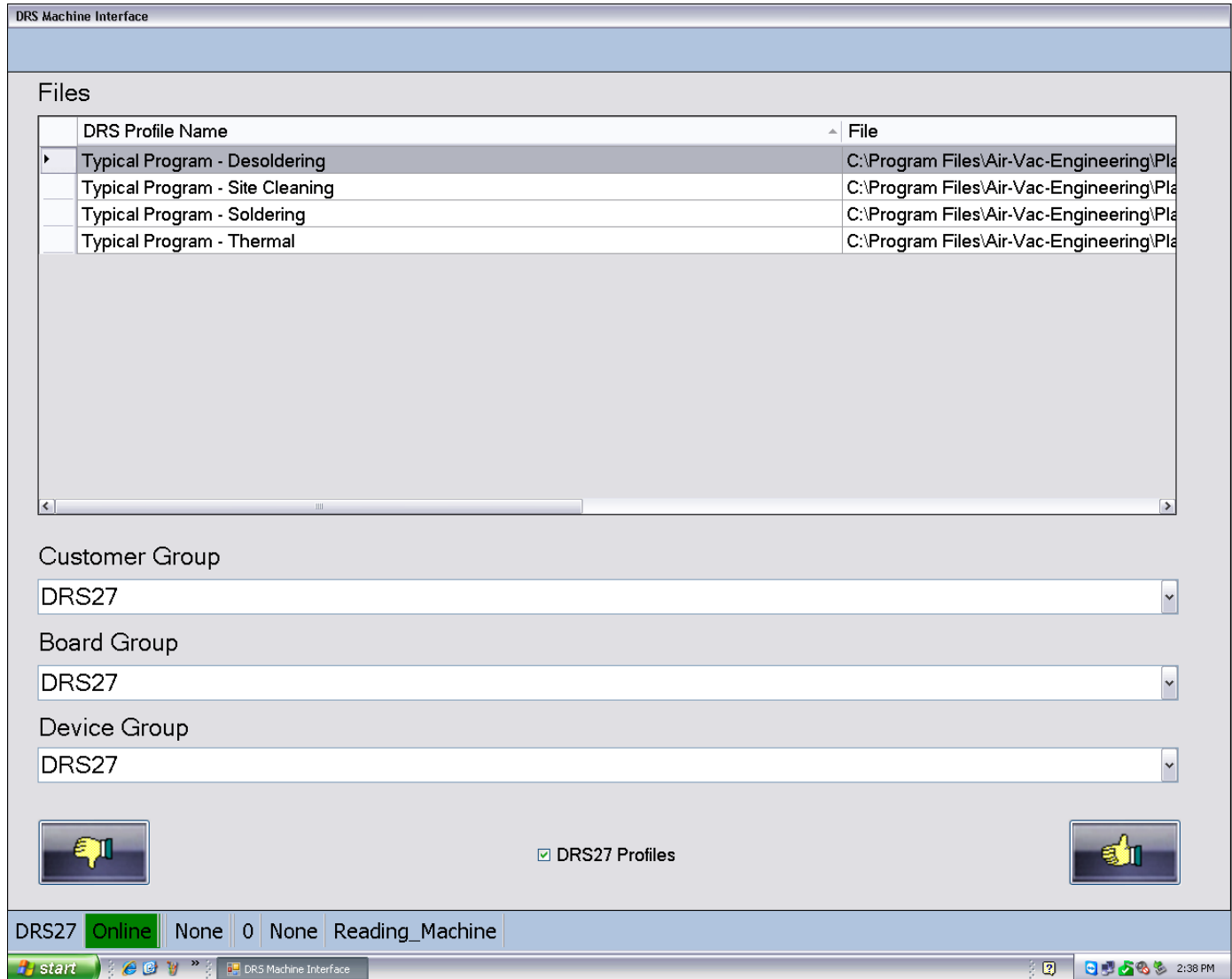
Camera:

Open: Opens screen to allow direct view or vision camera to be accessed.

7.3 Open A Typical Program

- Open Profile (All Listings Screen)

Selecting **Options**, then **Open/Profile Open** will present the **Open Profile – All Listings Screen**



- **Select Group.** The operator must select the correct Customer, Board and Device Group directory. Using the Up/Down Arrows at the right side of the each group box to select a BGA "file".
- **Select Program.** Under files highlight a program file.
- Click on **Thumbs Up** icon.

The **Open Profile Note screen** will appear. It provides information prior to running the program.

Process Notes / Control

Description: Component Removal

Component: PBGA 425 35mm lead free

Location: u3 on AQUUS board

Flux/Solder Type: Kester 2331 tacky no clean flux

Tool #: NT35EZ35EB

Notes:

☐ Leaded Reflow 183 ☒ Lead-Free Reflow 217 ☐ Board Cooling Idle

Application Notes

Install nozzle NT35EZ35EB with handling tool. Square as best as possible.

Object X: 35.000

Y: 35.000

Z-Height: 2.500

Nozzle Z-Offset: -2.500

Board Z-Height: 4.000

Thumbs Up Icon

- Follow all instructions on the Open Profile.

Description: Provides generic program title.

Component: Describes the device to be reworked. For example, PBGA 425 35mm Lead-Free

Location: Describes location and board. For example, U3 on Aqus Board.

Flux Type: Describes the flux to be used. For example, Kester 2331 NC Tacky Flux.

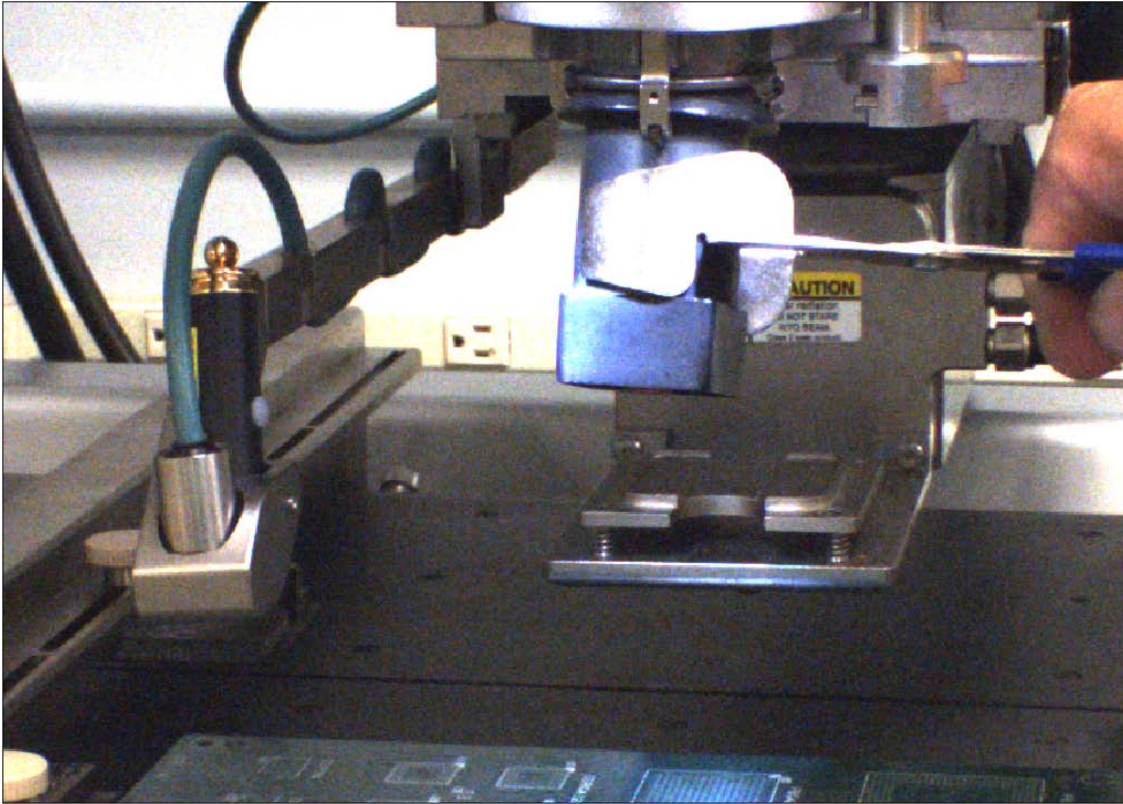
Tool #: The nozzle used. For example, N35EZ35EB.

Notes: Saves helpful information about the assembly. Provides operator tasks and checks prior to running the program. (Prior to going to the Run Screen.)

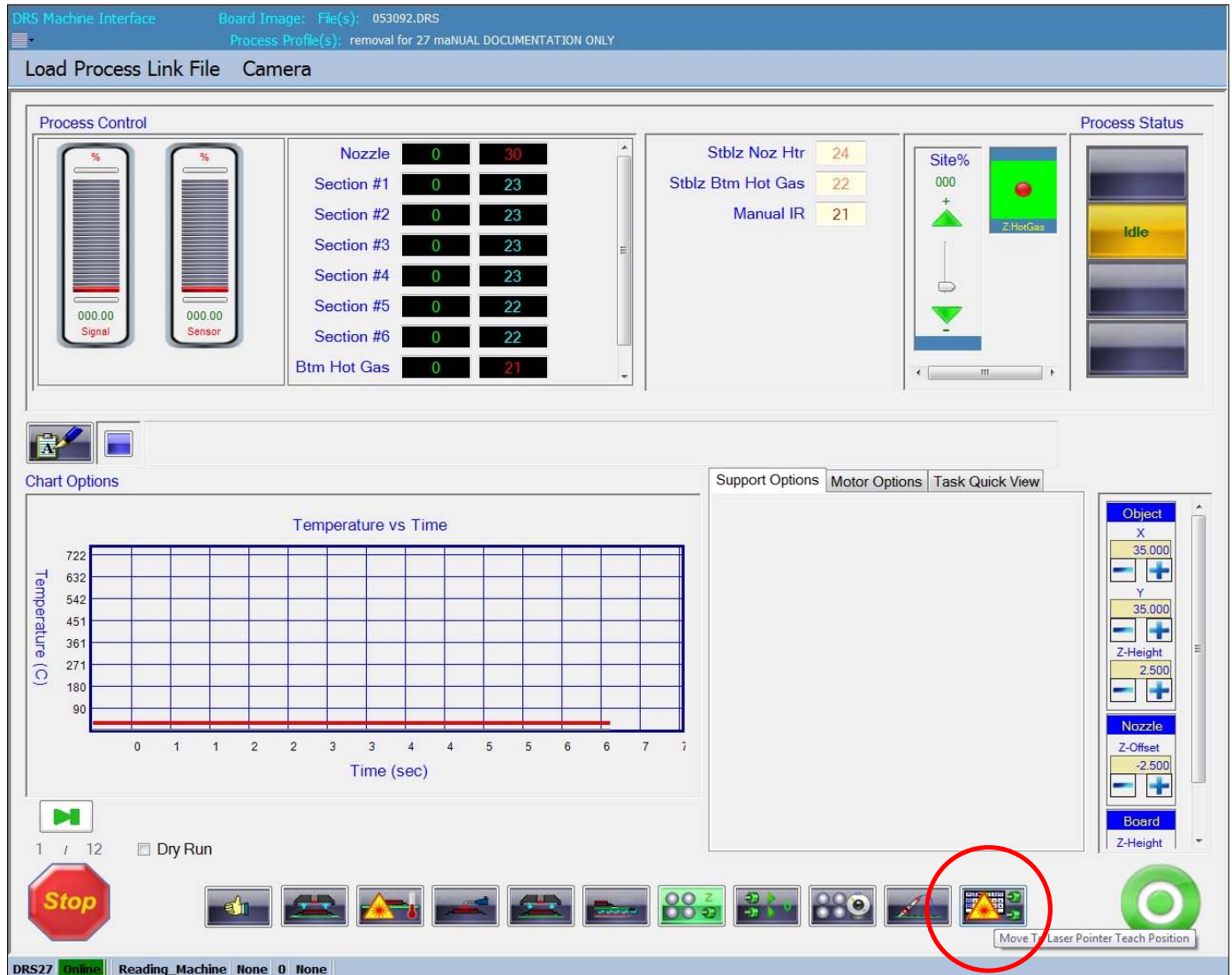
- INSTALL NOZZLE
- INSTALL BOARD INTO CARRIER
- POSITION BOARD SUPPORTS

7.4 Install Nozzle

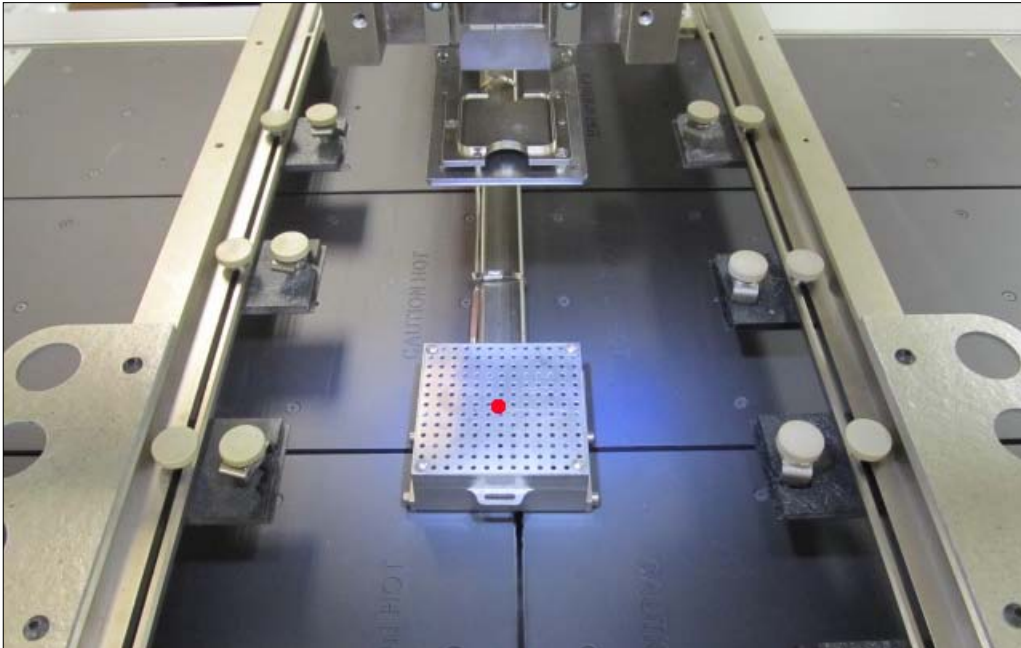
Install the nozzle relatively square into the nozzle fingers with pliers (supplied).



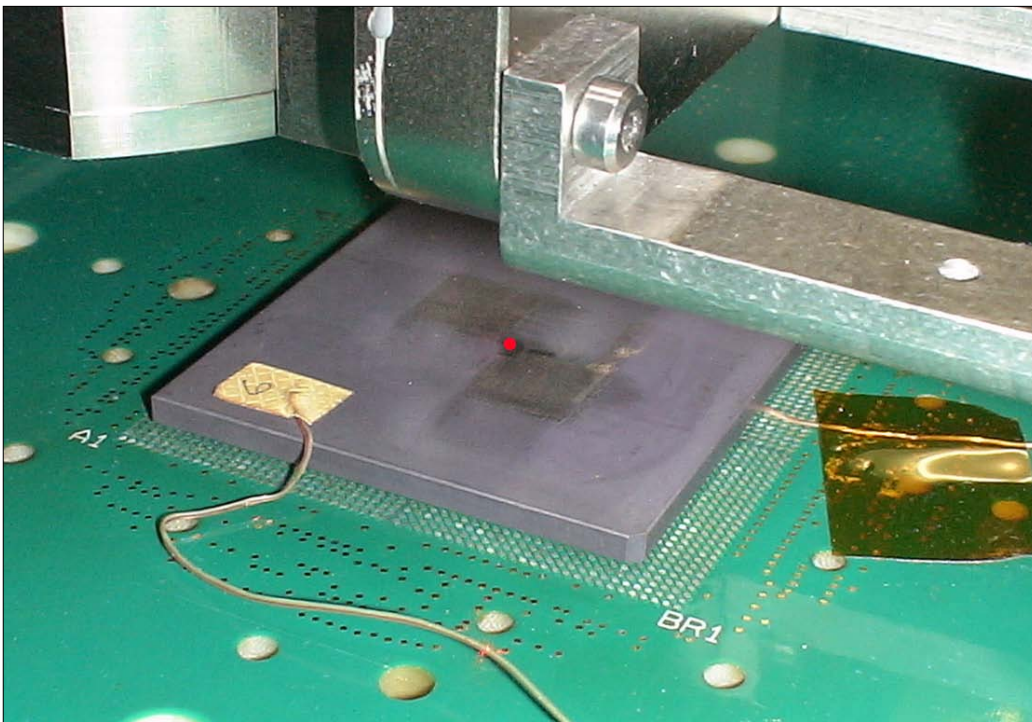
Prior to starting the Removal Process, click on the Move to Laser Pointer Teach Position icon.



If the machine has the optional Spot Heater, position the Spot Heater (using tool provided) so that the Spot Heater is near the center of the Bottom Heater plate and the Laser is centered over the Spot Heater plate.



Reinstall the board so that the Laser Pointer is also centered on the component to be reworked. Tighten the hold down clamps and position board supports if necessary.

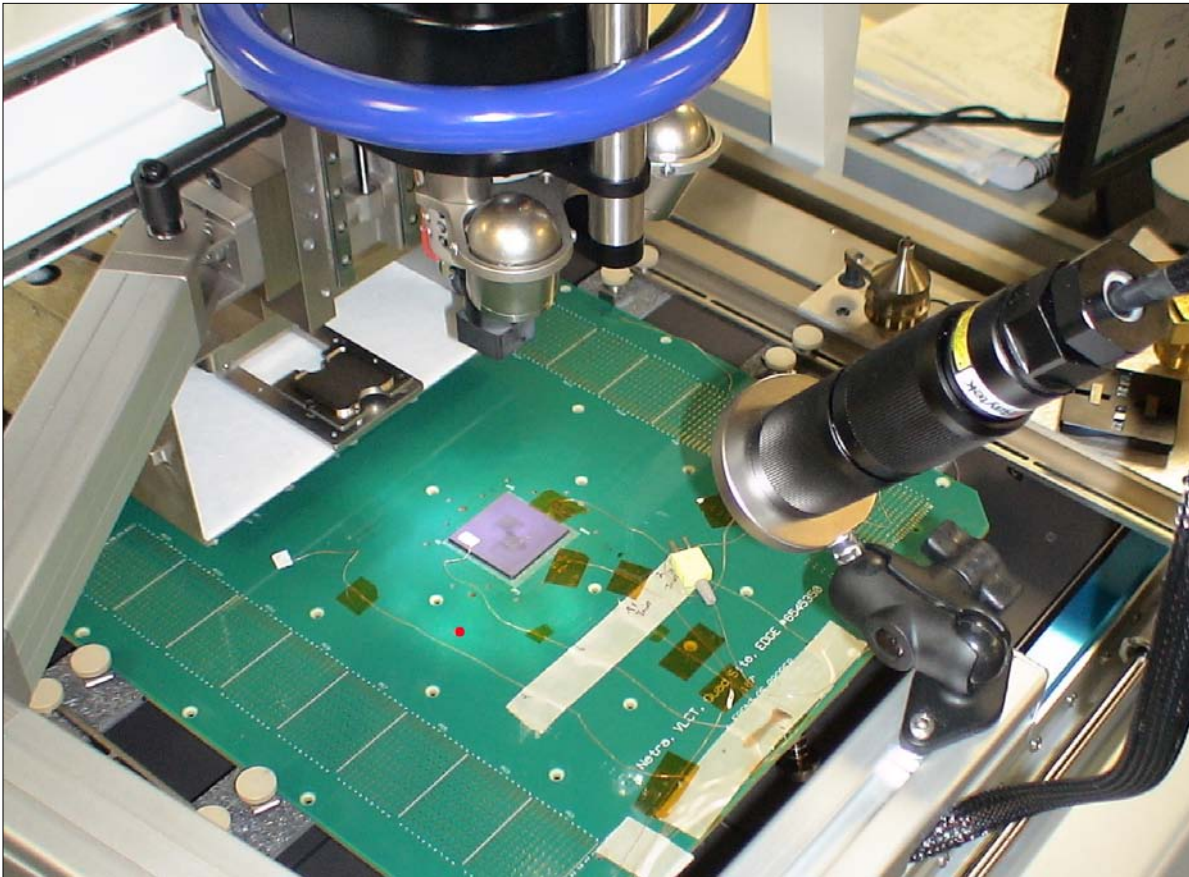


These two steps insure that both the Spot Heater and Nozzle are in the correct location. Click on the yellow footswitch message to retract the laser and vision.

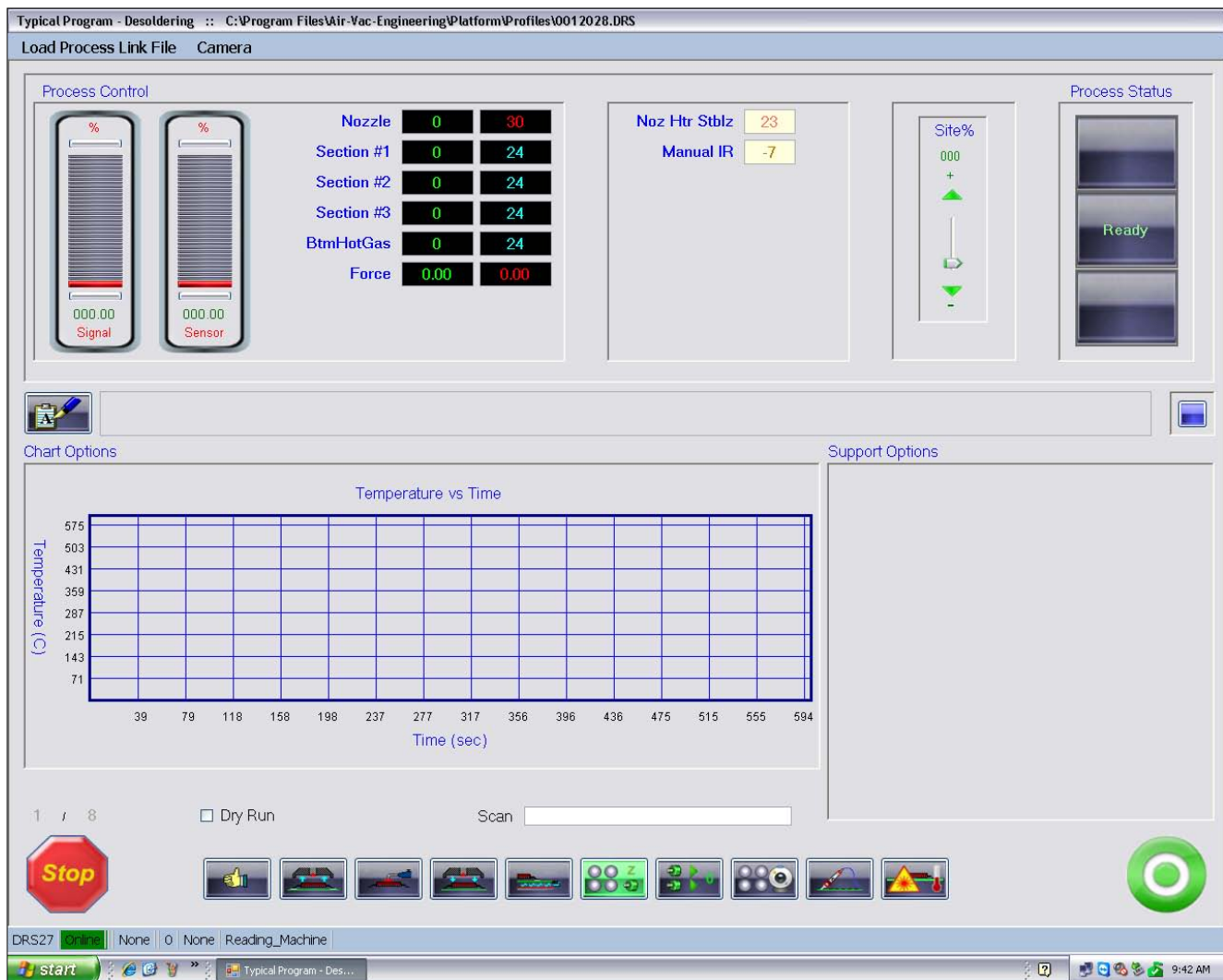
Next, position the IR Sensor prior to starting the process. Click on the Toggle IR Probe Laser Pointer icon. The icon will turn green and the Fine Spot Laser Pointer will illuminate.



Position the laser dot approximately 2-3 inches away from the BGA on an open area of the board.



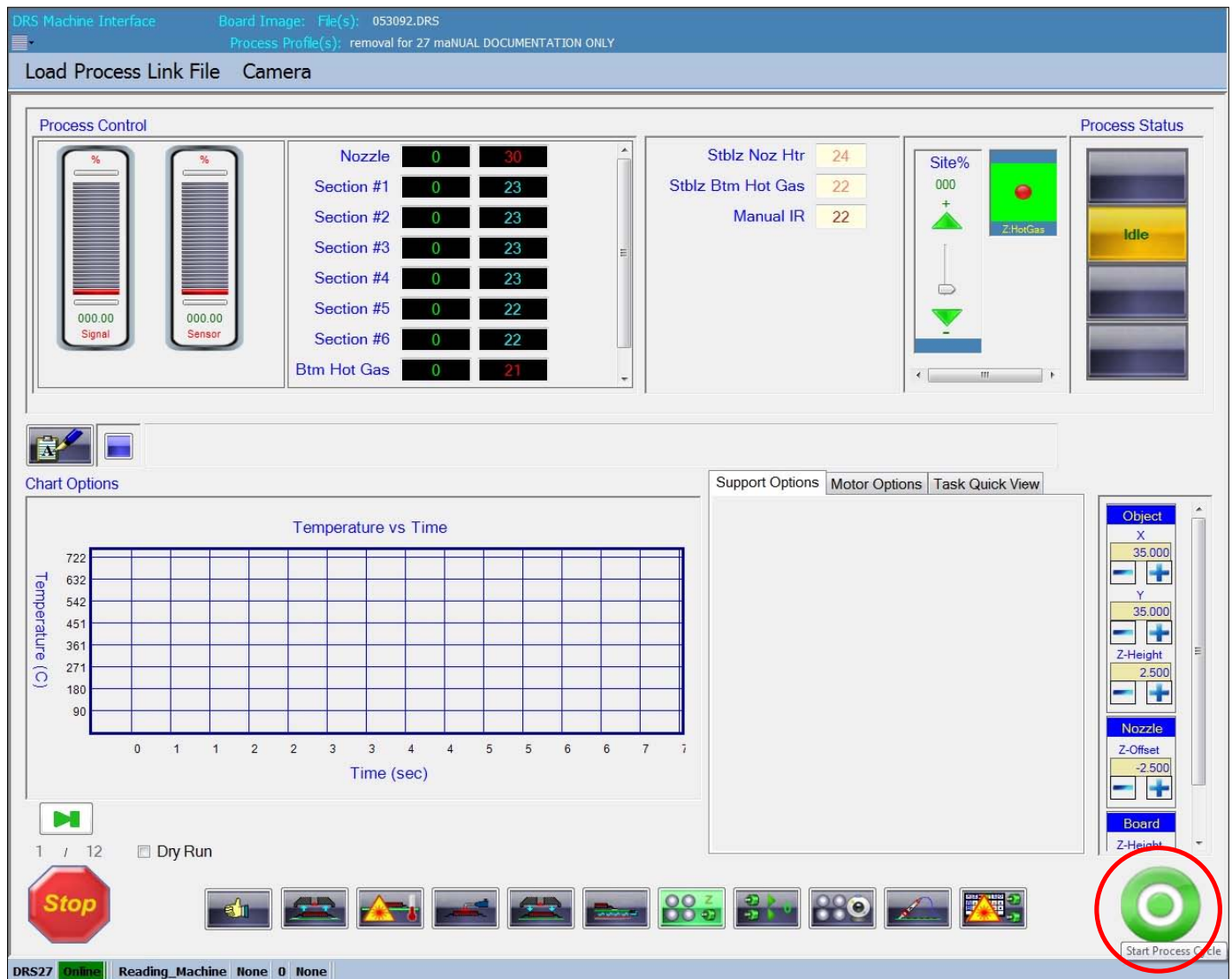
7.5 Running A Typical Removal Program



A program consists of a number of steps or events. The **Message Box** will change for each event to provide instructions.

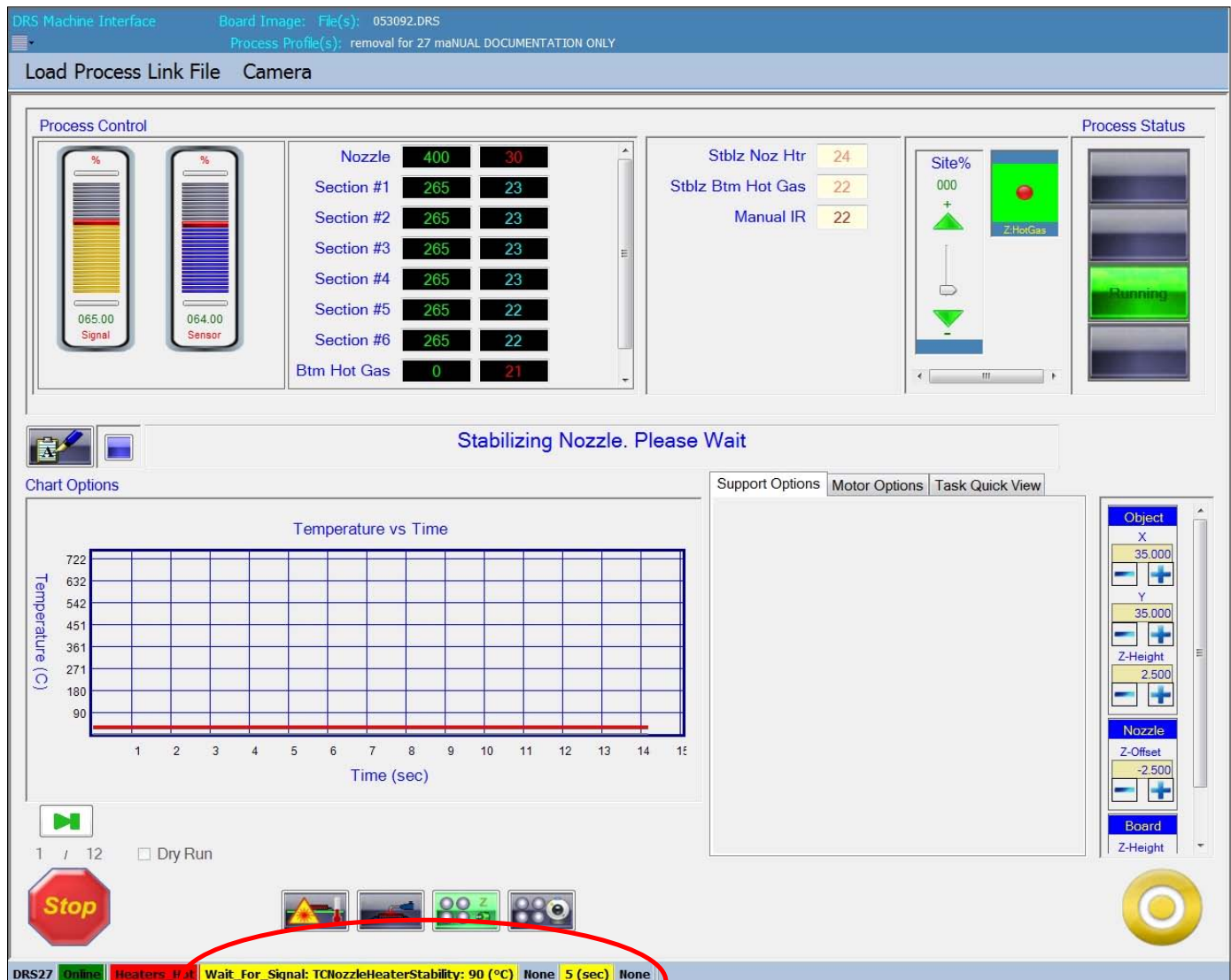
The information on the screen is only for recording to a history file. The operator is not responsible for process development. Temperatures, times and air flow settings cannot be changed on this screen.

Click on the green and white bullseye to start the process.



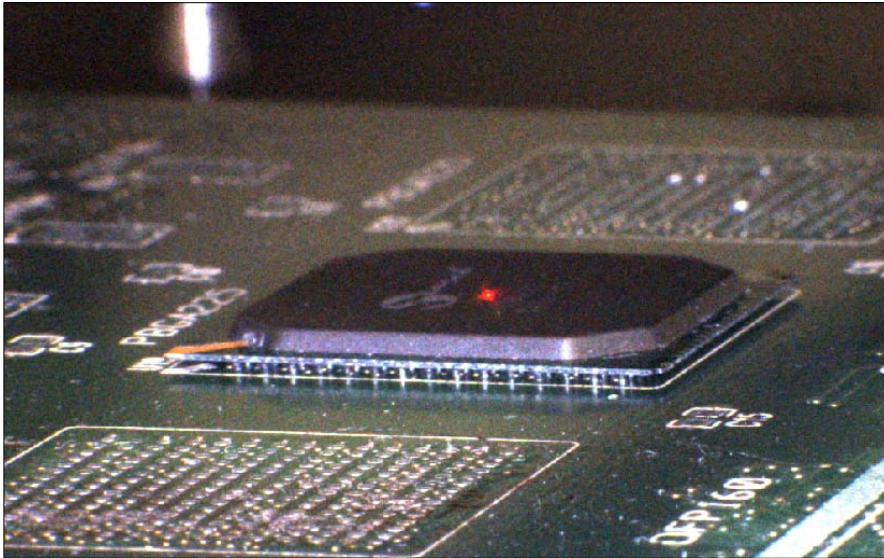
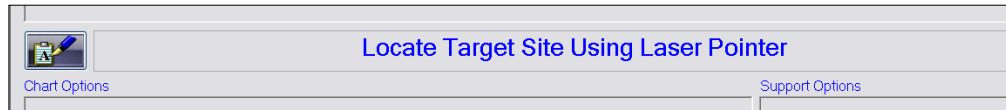
Event #1: Stabilizing Hot Gas Head.

It is important from a thermal repeatability standpoint to condition the temperature of the hot gas head prior to running a process. Event 1 stabilizes the hot gas head to a minimum temperature of 90°C.



Event #2: Component Location Teach.

- The Laser Pointer will activate and should already be centered on the component. Footswitch to continue.



- The Laser Pointer and Vision Housing will retract automatically.
- The Nozzle will move to the near place position.
- The Force System will control the Nozzle touch off of the component.
- The Nozzle will retract the programmed distance.

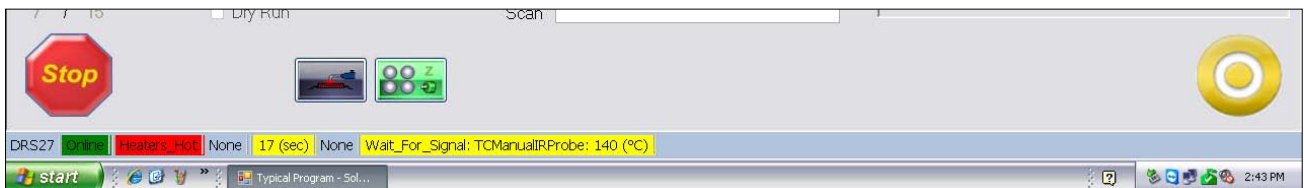
Event #3: Preheat Board

- The Direct View Camera will activate. Position the Camera so that reflow of the solder joints can be viewed.
- There is no operator involvement during this event, it is a temperature based event.
- The IR sensor will monitor the board temperature.
- The bottom heater temperature is displayed and will heat the board until the programmed board temperature is reached.

NOTE

BOARD PREHEATING TIME WILL VARY DEPENDING ON THE INITIAL TEMPERATURE OF THE BOTTOM HEATER, BOARD AND MACHINE.

BOARD PREHEATING TARGET TEMPERATURE MAY BE PROGRAMMED DIFFERENTLY FOR VARIOUS ASSEMBLIES.



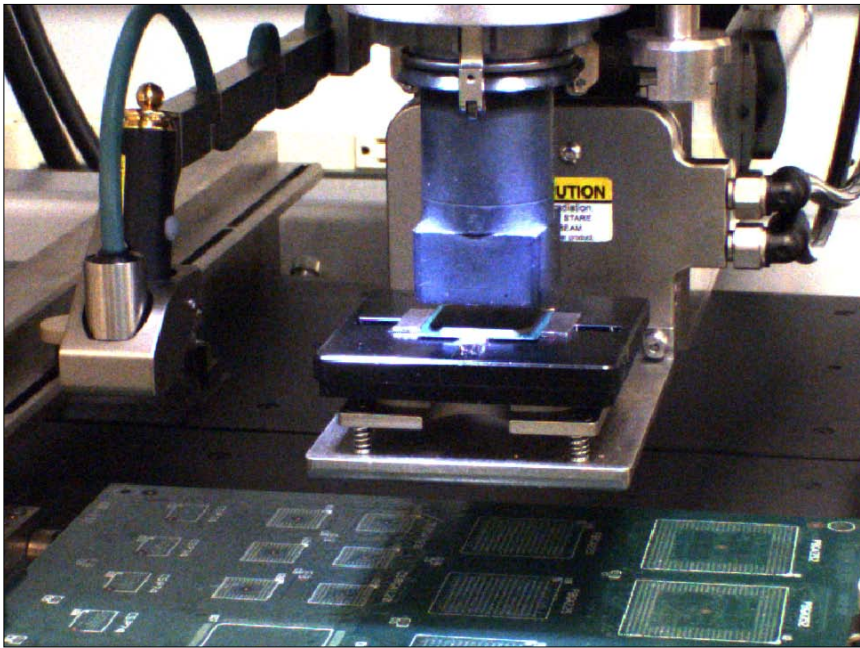
Events #4 - 7: Presoak, Soak, Ramp, Reflow 1

- There is no operator involvement during these events. The programmed heating of the BGA is automatic. These are timed events based on previous thermal profiling.
- The time for each event is displayed at the bottom of the screen. The time counts down for each event.
- The programmed and actual temperatures and flow rates are displayed in the Process Control box.

Events 8: Component Removal

- There is no operator involvement during this event.
- The nozzle will automatically move (slowly) to the BGA with the nozzle vacuum activated.
- The DRS27 has a vacuum sensor to sense the BGA, stop the Z-motion and remove the component automatically.

Events 9: Remove Component After Drop Off



- The operator is prompted to empty the reject bin to prevent accidental hitting of previously removed components.
- The component is dropped onto the tray in front of the vision system.
- The vision system and nozzle retract.
- At the end of the process the operator has three options.
 - Select the **Load Process Link File** for the site cleaning.



- Press the **Start Cycle icon** to start another removal cycle.
- Press **Thumbs Up icon** to exit the screen.

7.6 Running A Typical Site Cleaning Program

After the “Load Process Link File” is selected the profile name at the top of the Run Screen will change to the Site Cleaning Program.

00 27 mm PBGA (TIN LEAD) (063 bd) (bc 102505) - Site Cleaning :: C:\Program Files\Air-Vac-Engineering\DRS25\Profiles\60980012.DRS
Zoom Load Process Link File

To review the Application Notes for the Site Cleaning Program select the Application Notes icon.



The **Open Profile Note** screen will appear. It provides information prior to running the program.

It is important that the site cleaning nozzle be clean. See Maintenance Section.

Select the Cycle Start/Stop icon to begin the site cleaning program.

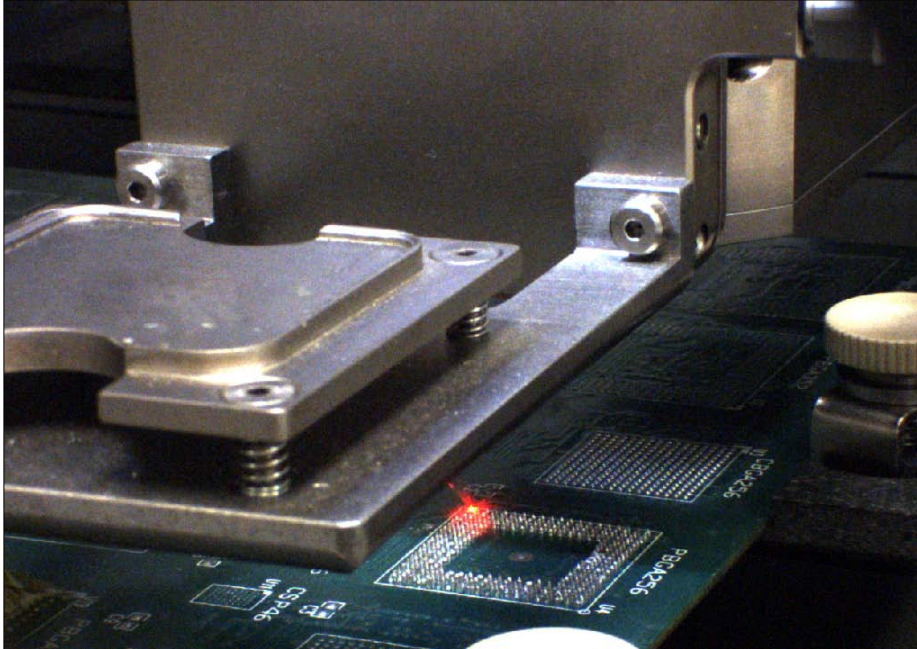


Process Hints:

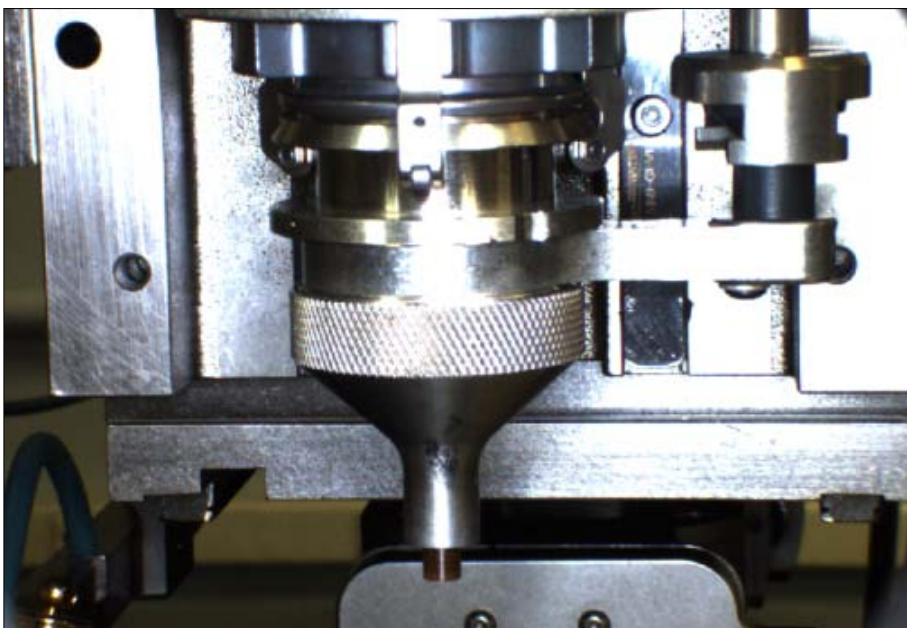
Running the site cleaning program immediately after the removal program will take advantage of the board being preheated. Less time will be required to heat the assembly.

Event #1: Position IR Sensor and Teach Site Position

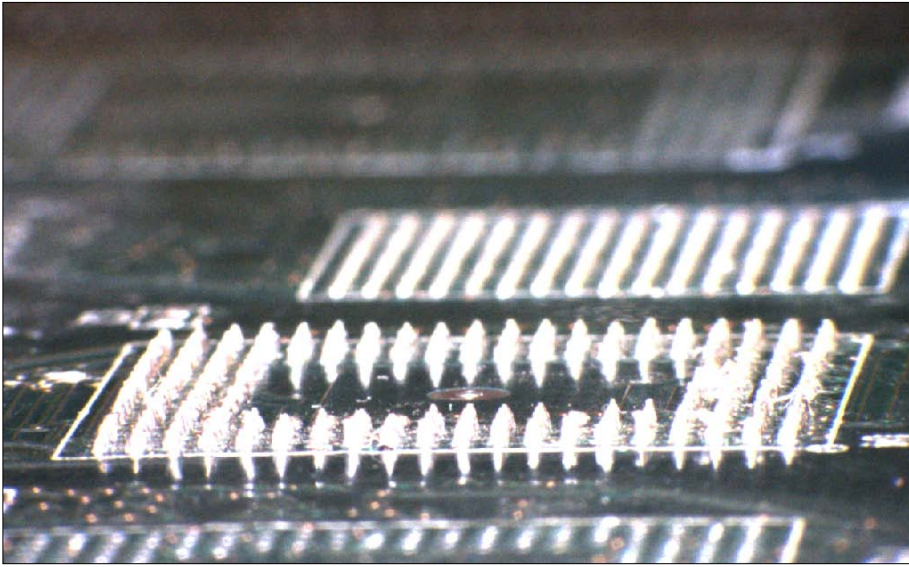
Locate target site using laser pointer. Position laser pointer to left/rear corner of site. This is advised to view solder reflow before moving site tool tip. Position IR Sensor 2-3 inches from site using the Fine Spot Laser. Footswitch to continue.

**Event #2: Install Site Cleaning Nozzle and Test Vacuum. Position Direct View Camera**

Install nozzle with vacuum port of nozzle to vacuum port of DRS27.



Position direct view camera to view site on screen.



Camera Adjustments:

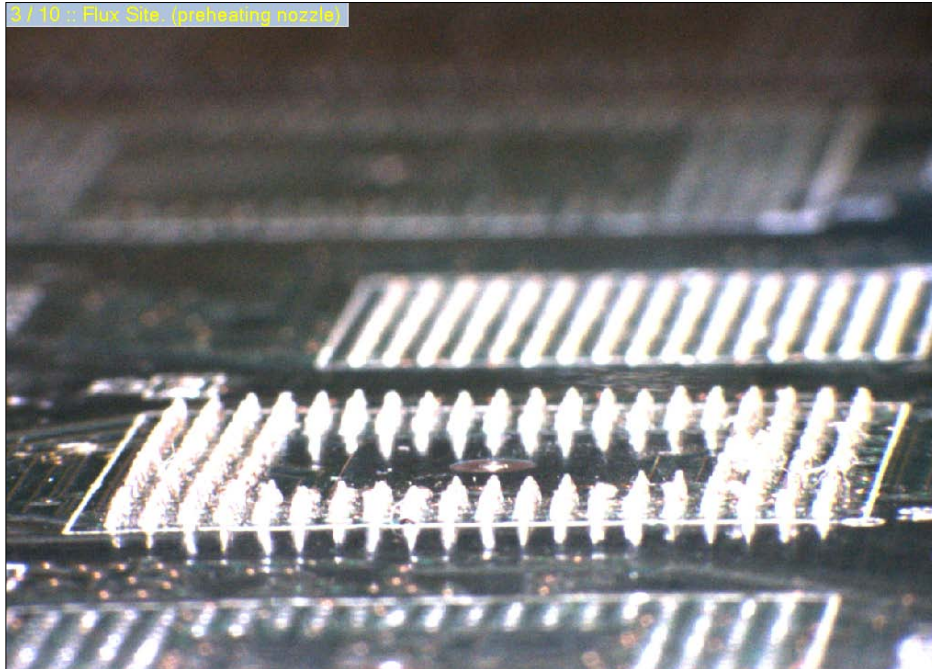
- Aperture adjusts the lighting.
- Zoom adjusts the magnification.
- Focus adjusts the focus.

Event #3: Flux Site (Preheating Nozzle)

This is a timed event (75 seconds) with the nozzle being heated during this time as the operator applies flux.

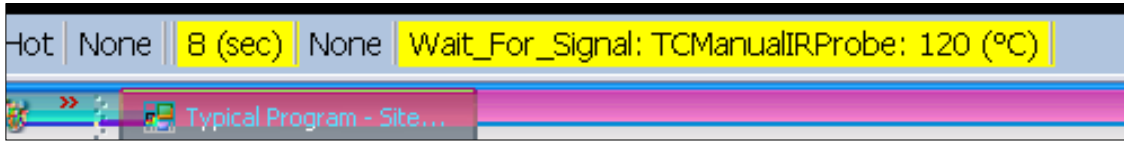
Apply flux paste generously over the entire site.

IMPORTANT!: The nozzle must heat soak prior to positioning at the board level. This will allow the heat of the tool to be efficiently applied to the pads when lowered.



Event #4: Preheating Board to 120°C

There is no operator involvement during this event. This is a temperature based event.



The temperature sensor will monitor the board temperature. It is displayed under **Thermocouple System**. The bottom heater is displayed and will heat the board until the set/programmed temperature is reached.

NOTES:

Board preheating time will vary depending on the initial temperature of the bottom heater, board and machine.

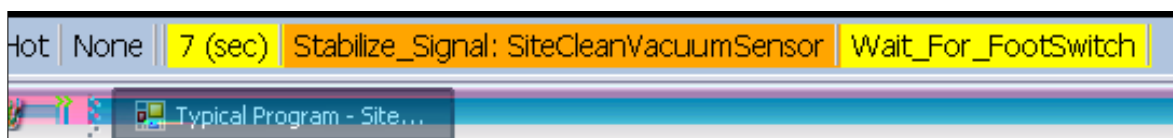
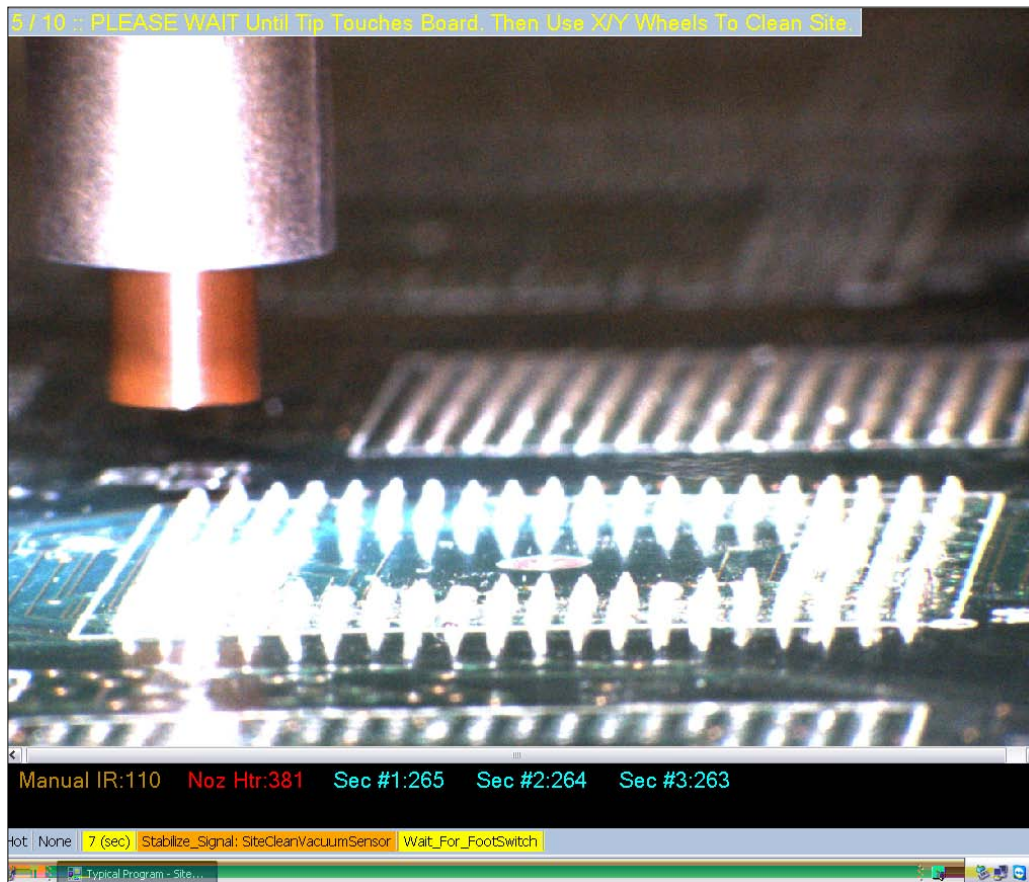
Board preheating temperature may be programmed differently for various assemblies. During this step, there is no operator involvement. The bottom heater heats the board until the set/programmed temperature is reached. Preheating does take time, but is important for reliable rework.

The time to heat the board will vary depending on the board.

Event #5: Please Wait Until Tip Touches Board Then Use X/Y Wheels To Clean Site.

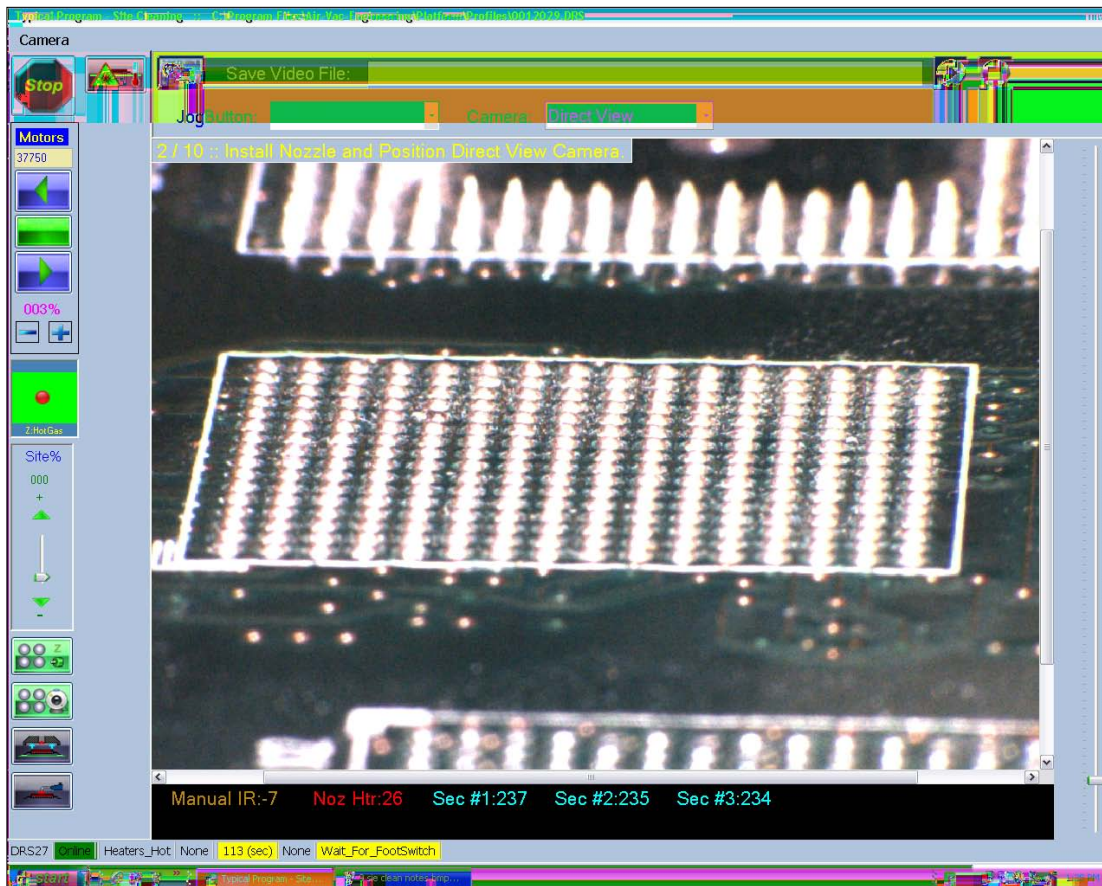
The nozzle will automatically be lowered to just above the board. The heated air will melt the solder. The nozzle tip height will adjust after touching the board to right above the pads.

The operator uses the X/Y wheels to clean the site. **NOTE: If the site solder does not reflow immediately during the tip's initial touch, stop the process and contact a supervisor.**



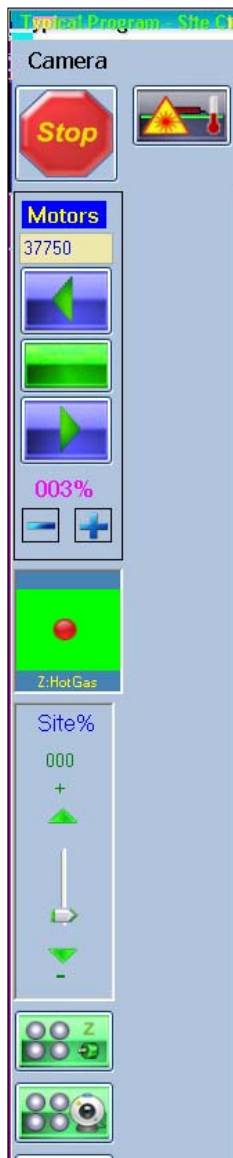
The tip will adjust according to programmed settings. The distance from the bottom of the tip to the board may be different on various boards as determined by the programmer.

A



NOTE: The overall controlling height (auto adjust mode) of the site clean nozzle can be adjusted during a process cycle. The site clean slide bar (A) can be used to raise or lower the auto height position. If the nozzle tip is too close to the board, move the slide bar slowly upwards until the overall position is optimized. If the nozzle is bouncing too far from the board (not collecting enough solder), move the slider bar slowly downwards until the overall position is optimized.

Miscellaneous site clean functions:

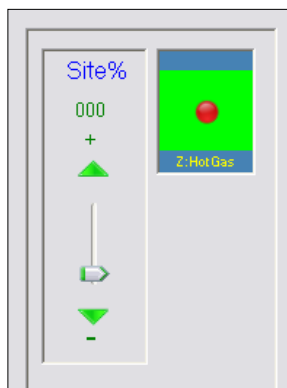


- Camera – open/close
- Toggle IR probe laser pointer

- To move, site clean tip up/down, adjust the slide bar in the **Site%** box.

- Machine light
- Camera light

If the direct view camera option is not installed, the site clean tip up/down adjustment slide bar is on the run screen.



Event #6: Reflux Site for Second Pass Cleaning or Stop Process

The nozzle moves up. The operator has an optional second pass to site clean. Press footswitch to continue.

Event #7: PLEASE WAIT Until Tip Touches Board, Then Use X/Y Wheels to Re-clean Site.

The heated air will melt the solder. The time will vary depending on board. The nozzle tip height will adjust to right above the pads. The operator uses the x/y wheels to clean the site.

Event #8: Board and Machine Cool Down

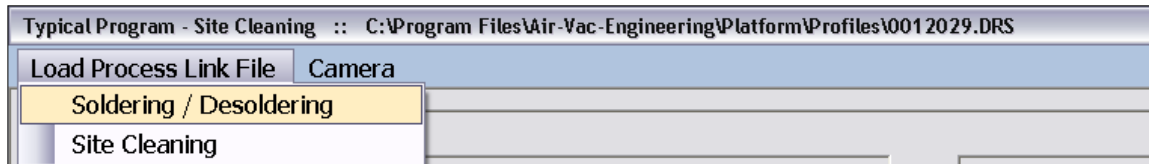
There is no operator involvement in this event. The nozzle goes to the park position and the nozzle heater is set at a low temperature to cool down.

Event #9: Remove Site Clean Nozzle. CAUTION HOT! Install EZ Nozzle.

The operator removes the site clean nozzle and installs EZ nozzle for the soldering process.

7.7 Running A Typical Soldering Program

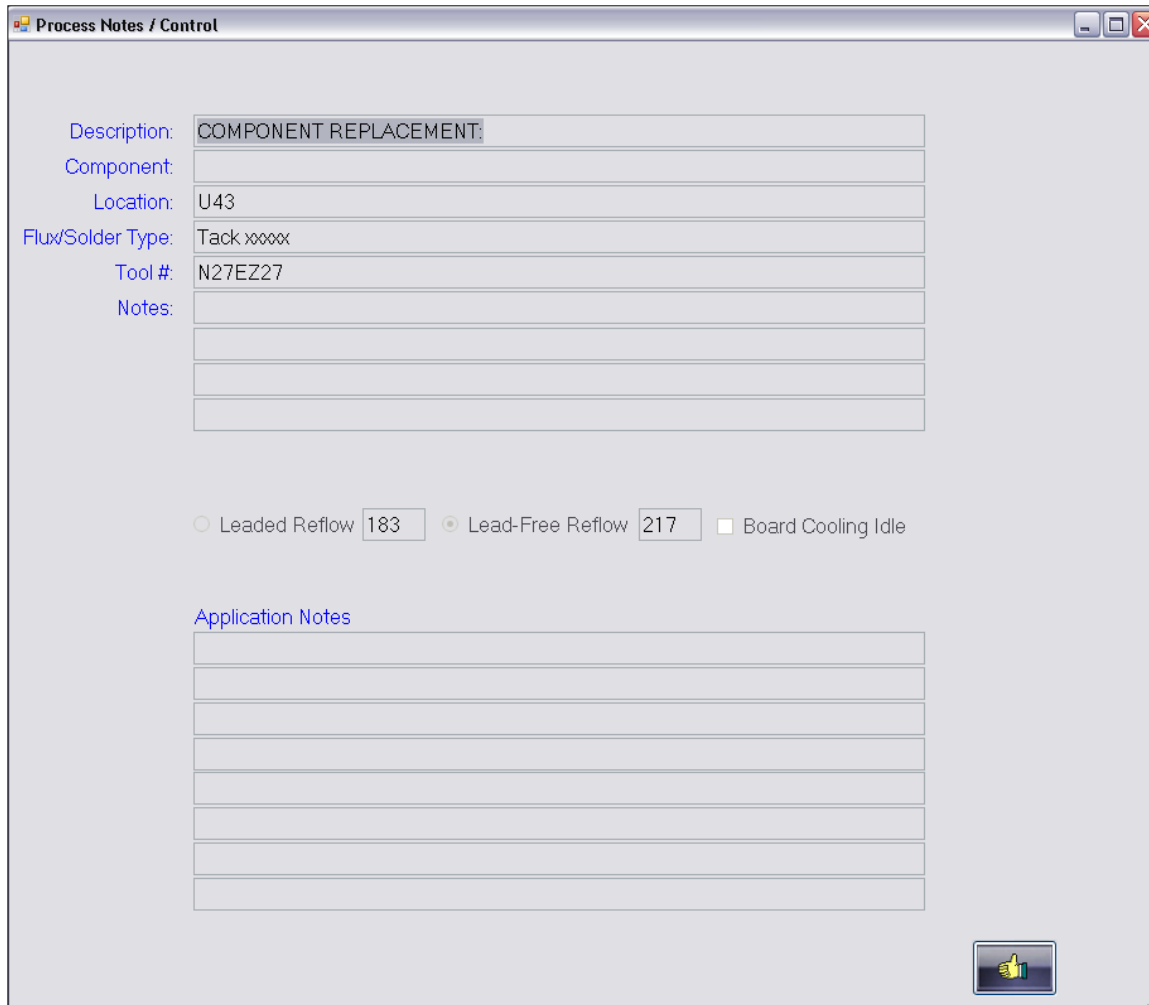
After the “Load Process Link File” is selected the profile name at the top of the Run Screen will change to the Soldering Program.



To review the Application Notes for the Soldering Program select the Application Notes icon.



The **Open Profile Note screen** will appear.
It provides information prior to running the program.



Select the Cycle Start/Stop icon to begin the soldering program.

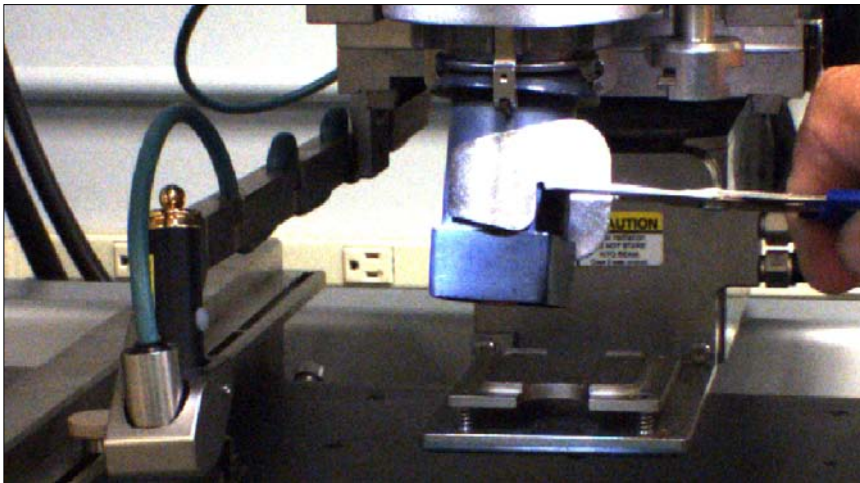


Event #1: Install BGA Nozzle

This is a footswitch based event. Install nozzle with handling tool. Square nozzle as best as possible. Footswitch to continue.

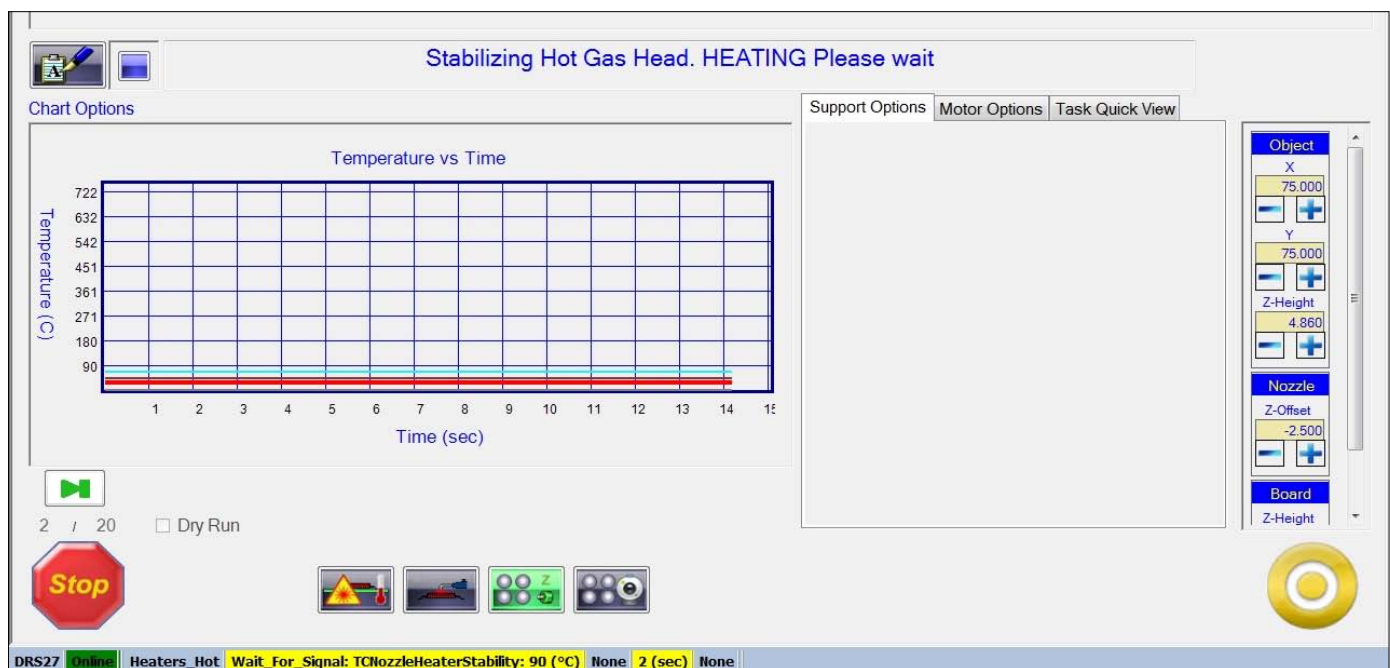
CAUTION

NOZZLE AND/OR MACHINE MAY BE HOT.



Event #2: Stabilize Hot Gas Head

The hot gas head will be heated up to 90°C if the machine is cold or cooled to 110°C if the machine is hot.



Event #3: Teach Site Center Position. Locate Target Site Using Laser Pointer.

This is a footswitch based event. Position laser pointer over center of site.

**Event #3: Position Temperature Sensor.**

The IR sensor is meant to read the board temperature. It is important to position the sensor, approximately 2-3 inches away from the component on an open area of the board.

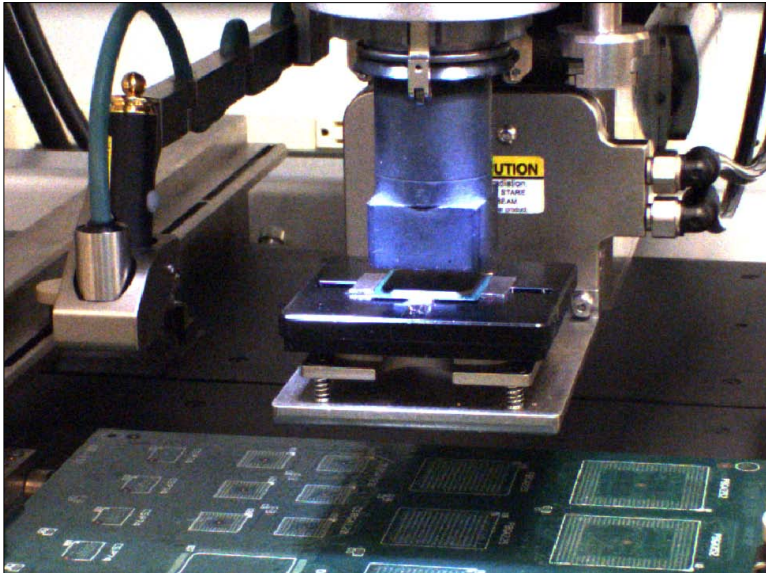
Event #3: Align Component After Pick Up.

Insert the new component into the Universal Insertion Tool and center the component. Install the Insertion Tool into the Component Pick-Up Tray. Footswitch to continue.

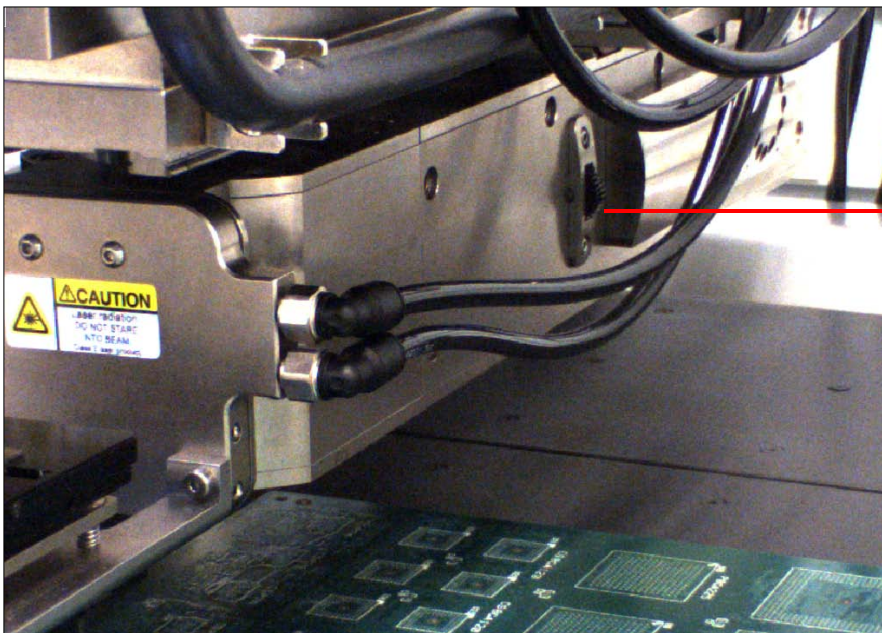
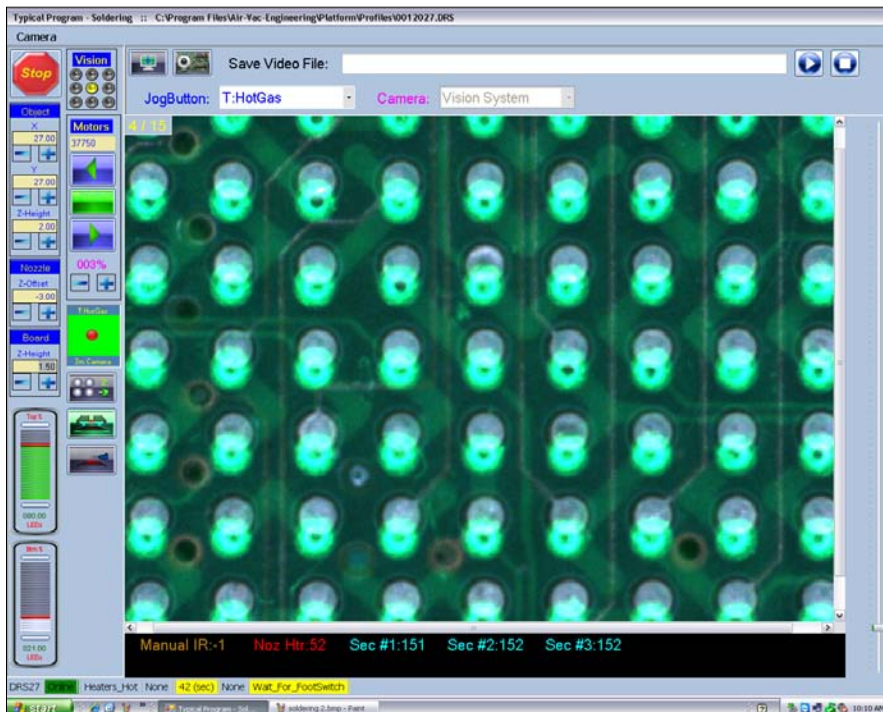


IMPORTANT!: Component orientation (polarity) must be correct.

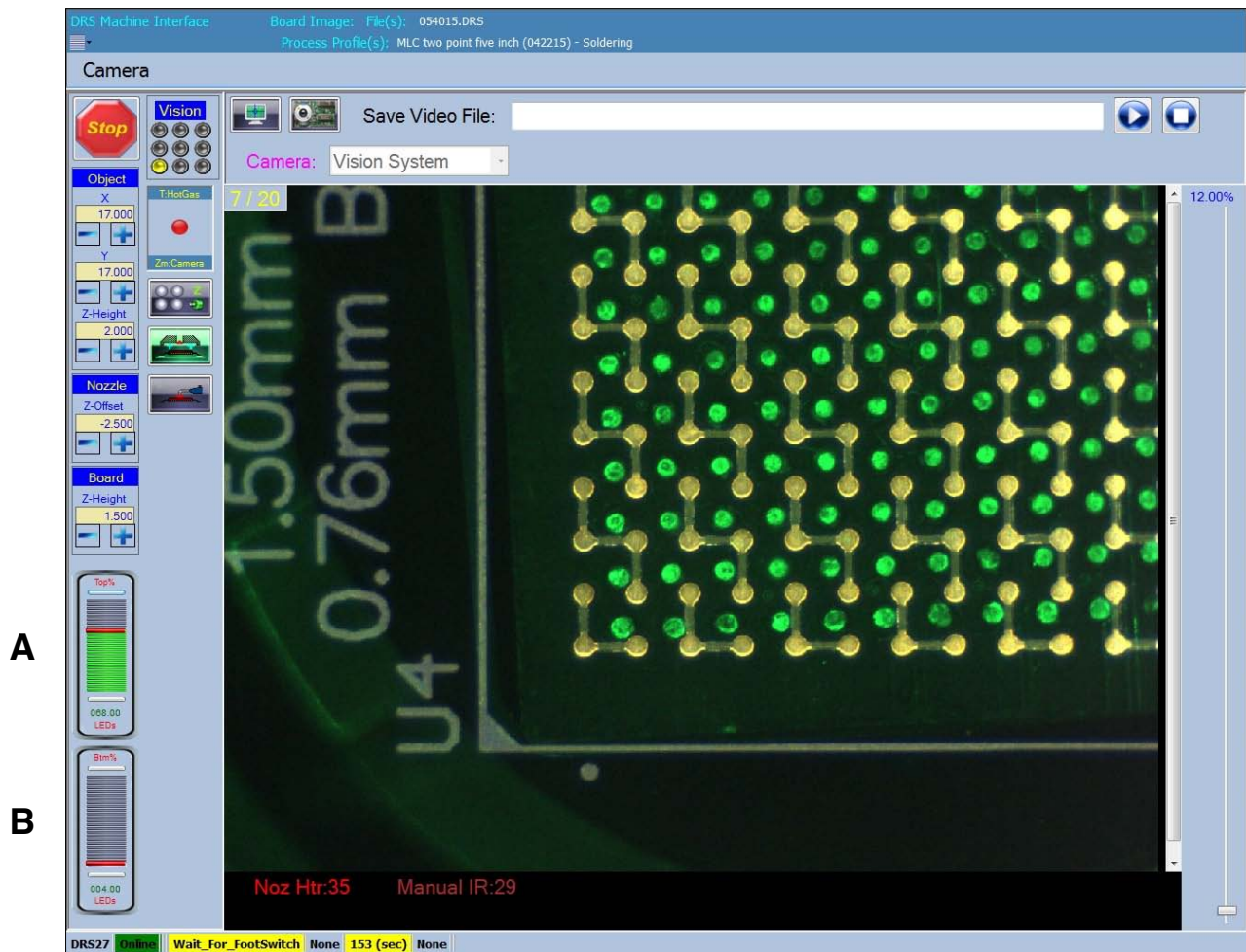
The nozzle picks up the component from the pick up tray. The nozzle and component retract. The vision alignment system is activated.



The vision system camera screen is activated. If pad and lead image is not clear, use focus adjustment **(A)** on side of vision system.



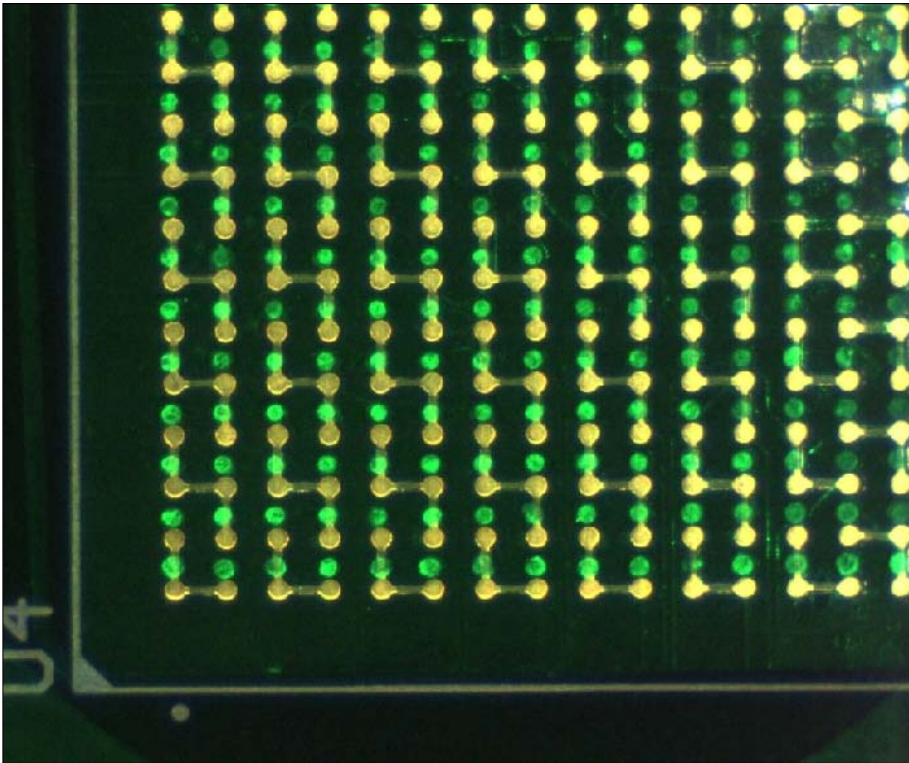
The green and white LED lighting may be adjusted to operator preference. Adjustment for lighting intensity of component **(A)** and lighting intensity of board **(B)** can be used.



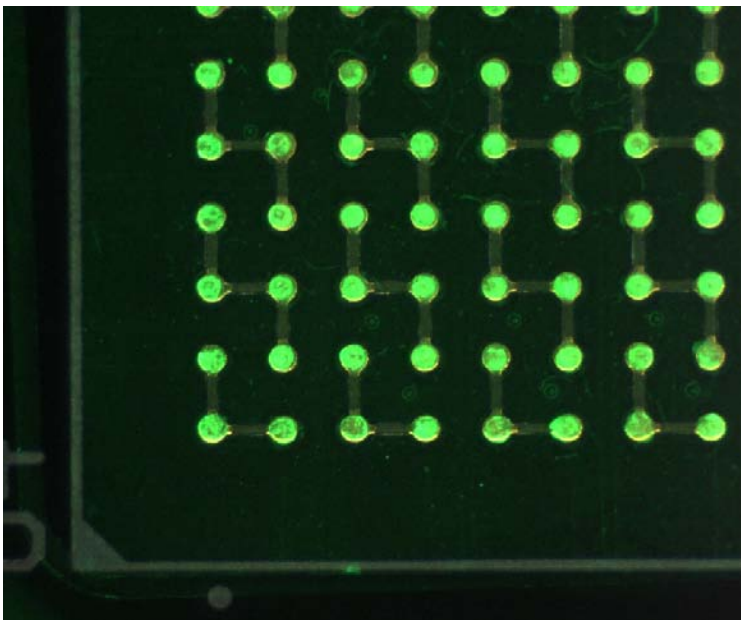
Most likely the component will be skewed. To correct for theta, use the joystick. The joystick has two functions available; theta and camera zoom. The joystick also has two speeds; slow and rapid. Pressing the rapid button sets the joystick functions in the fast mode. To correct for theta move the joystick left or right. To change the magnification, move the joystick up or down.



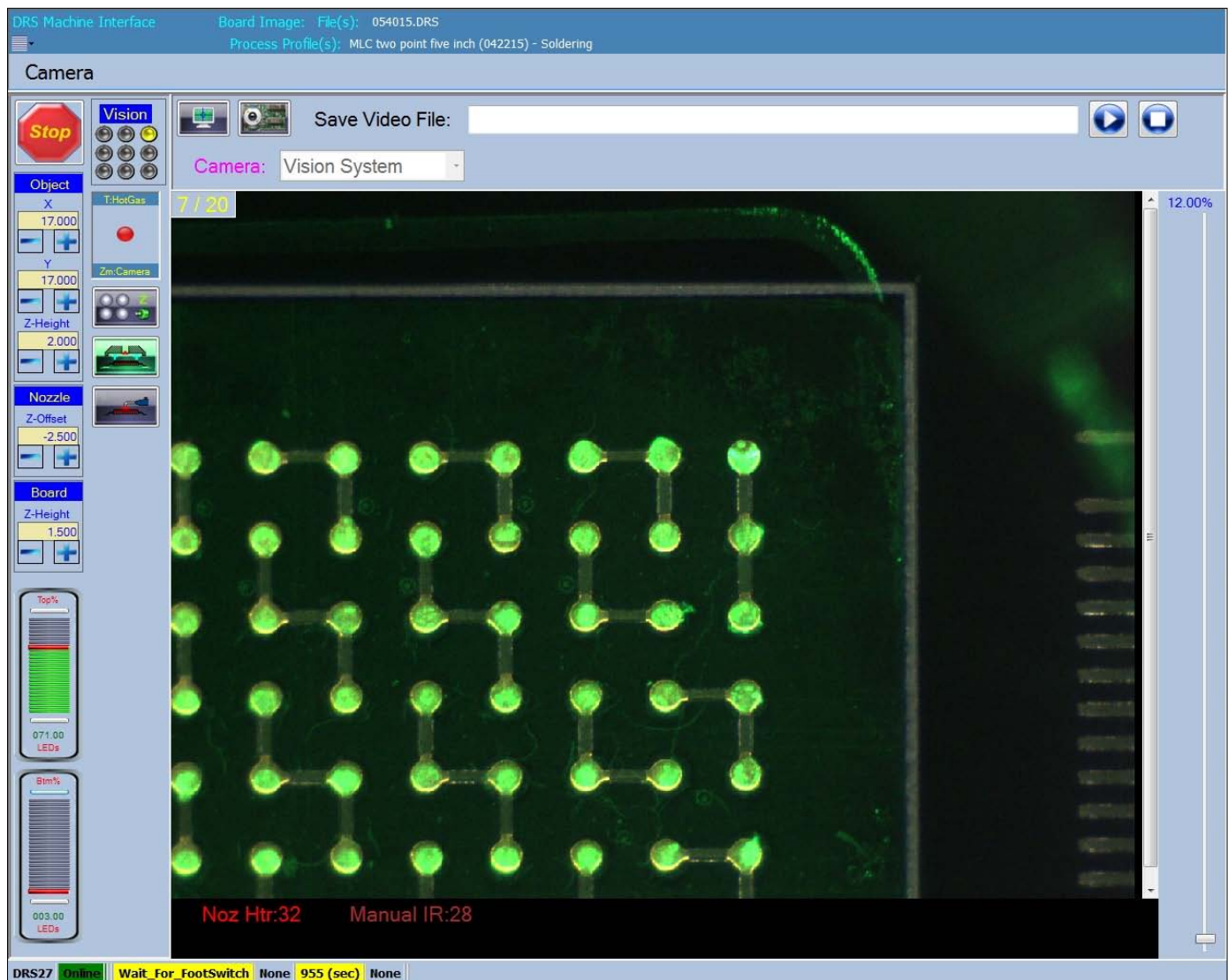
To make a theta adjustment, rotate the component until it is parallel to the pads and off in the y direction as shown below..



Move the x-axis wheel to align leads and pads in x direction and the y-axis wheel to align in y direction. Increase magnification with the joystick to enhance alignment accuracy. One corner of the BGA is now aligned

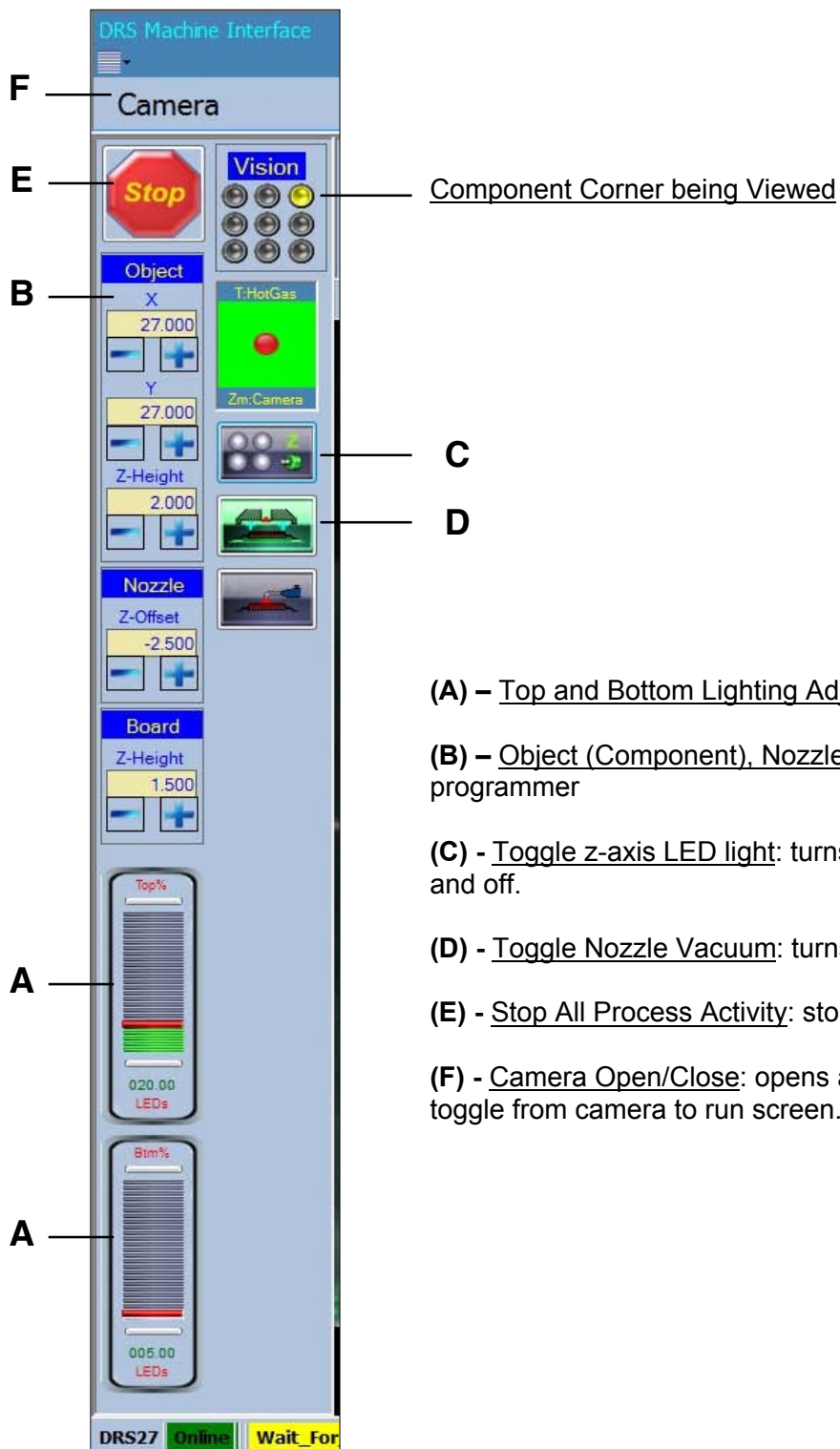


View the opposite corner by clicking on the opposite corner light under Vision. The light will turn green and the opposite corner will be shown. If the opposite corner is aligned, check the other two corners and center.



If the opposite corner is off in theta, make a 50% theta adjustment and then finalize X/Y. Check the opposite corner and reiterate until both corners are aligned.

Miscellaneous Camera: Vision Systems Icons:



(A) – Top and Bottom Lighting Adjustments:

(B) – Object (Component), Nozzle, Board Dimensions: set by programmer

(C) - Toggle z-axis LED light: turns lights over the nozzle on and off.

(D) - Toggle Nozzle Vacuum: turns nozzle vacuum on and off.

(E) - Stop All Process Activity: stops all movement and heating.

(F) - Camera Open/Close: opens and closes camera screen to toggle from camera to run screen.

Event #5: Flux Site and Position Direct View Camera

Operator is instructed to apply tacky flux to site and to position the DV Camera on the site to observe placement.

Event #6: Please Do Not Touch Machine (Component Placement)

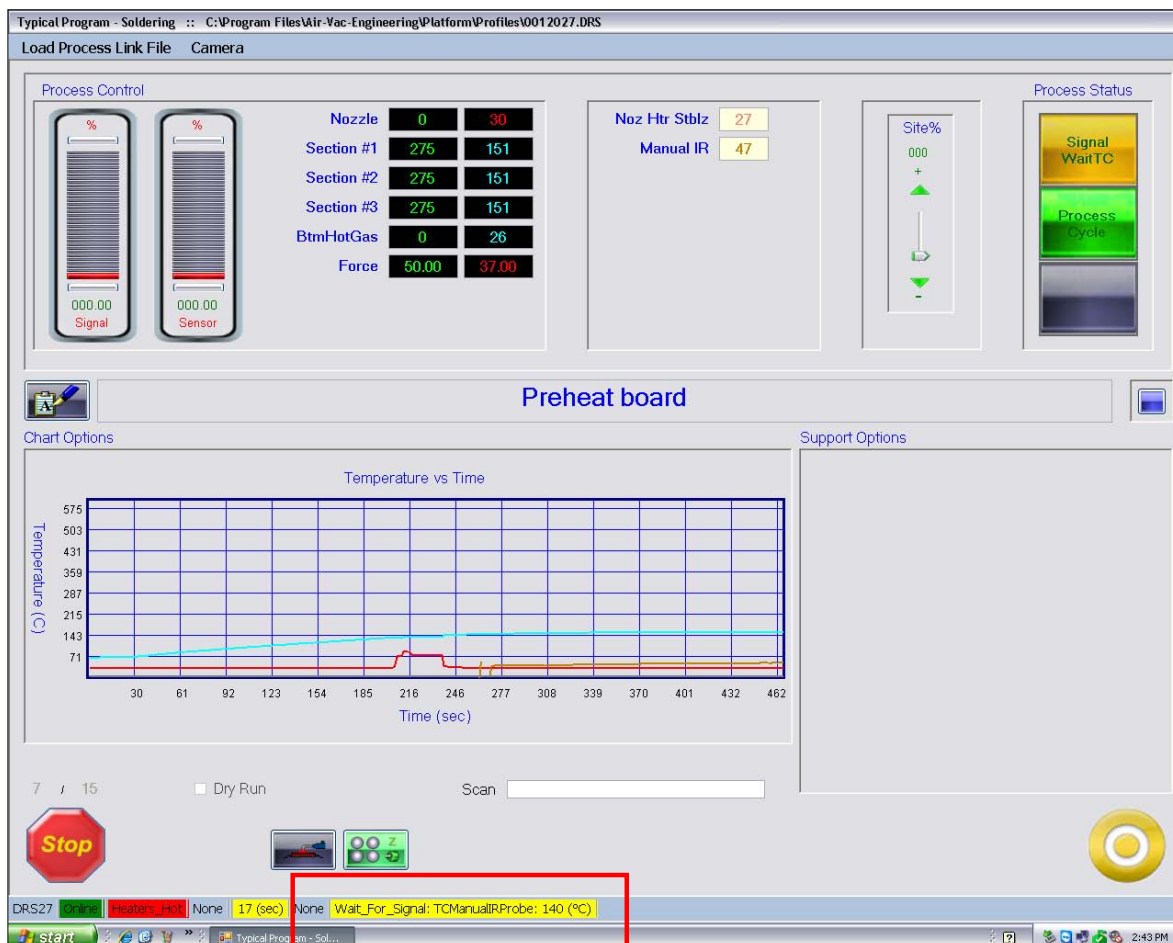
No operator involvement. BGA will be lowered to board using force placement system of machine. Nozzle vacuum is turned off. Slight pressure through the nozzle is applied. The nozzle retracts the programmed distance.

NOTE:

OPERATOR MUST NOT TOUCH MACHINE. IF MACHINE SENSES PRESSURE ON THE BOARD CARRIER, IT WILL AUTOMATICALLY GO TO THE NEXT EVENT. THE NOZZLE VACUUM WILL BE TURNED OFF AND THE COMPONENT WILL BE DROPPED (OUT OF ALIGNMENT).

Event #7: Preheat Board

There is no operator involvement during this event. This is a temperature based event.



The IR sensor will monitor the board temperature. It is displayed under Thermocouple System. The bottom heater is displayed and will heat the board until the set/programmed temperature is reached.

NOTE:

BOARD PREHEATING TIME WILL VARY DEPENDING ON THE INITIAL TEMPERATURE OF THE BOTTOM HEATER, BOARD AND MACHINE. THE BOARD PREHEATING TEMPERATURE TARGET MAY BE PROGRAMMED DIFFERENTLY FOR VARIOUS ASSEMBLIES

Events #8-11: Presoak, Soak, Ramp, Reflow 1

There is no operator involvement during these events. The programmed heating of the BGA is automatic. These are timed events. The total time is displayed at the bottom left of the Run screen.

Event #12: Reflow 2

There is no operator involvement during this event. The heating events are finished. Cool air will be controlled through the nozzle and the board cooling system. This is a timed event based on the programmer.

Event #13: Heaters Off

There is no operator involvement during this event. The preheater and upper heater are turned off.

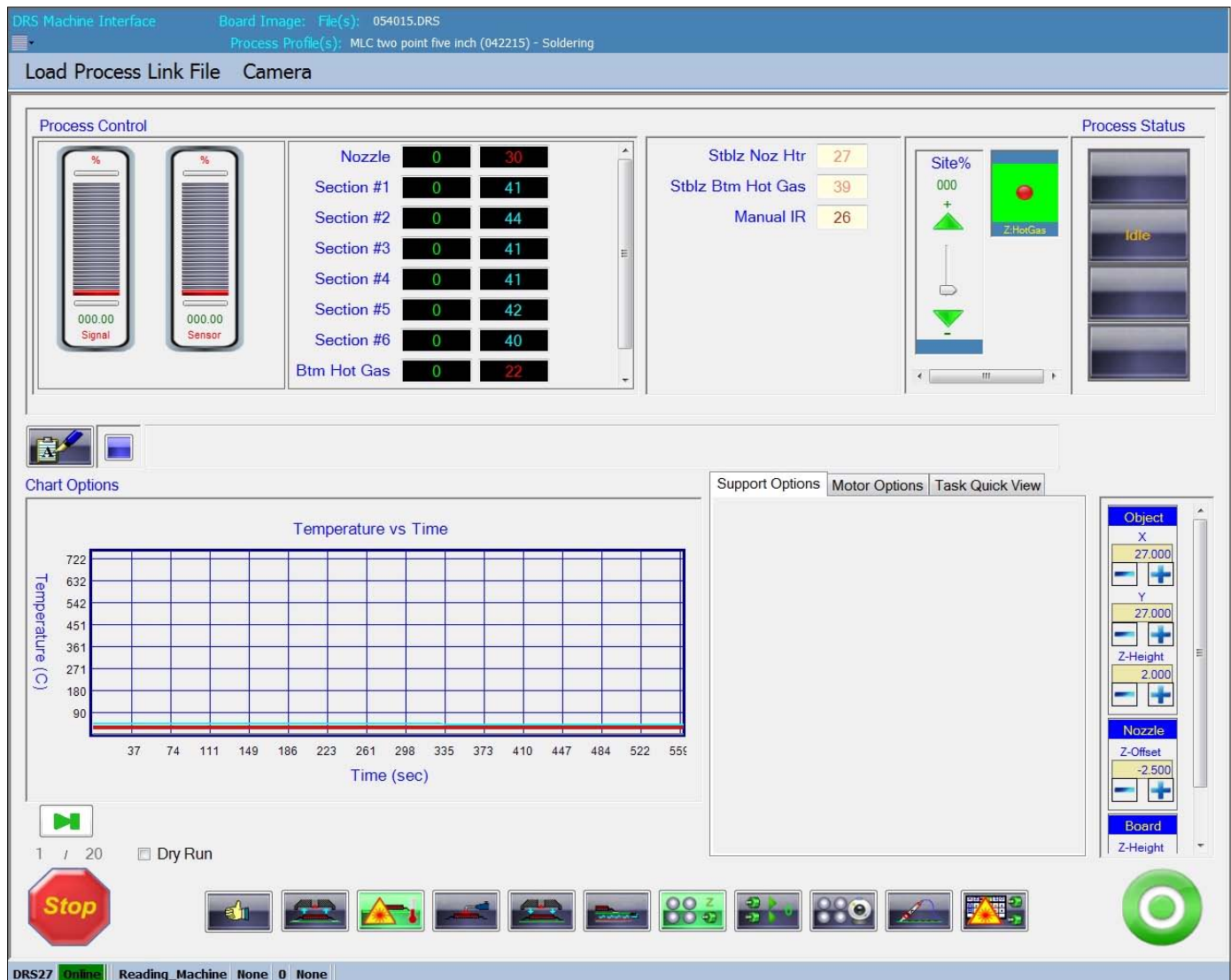
Event #14: Machine and Board Cooldown

There is no operator involvement during this event. This is a timed event for 50 seconds. The nozzle moves up. The board cooling system air flow is set to high flow. The upper heater is set to low temperature/high flow.

Event #15: Remove Board (Process Complete)

This is a timed event for 5 seconds. The nozzle retracts to its top position. The board carrier cooling system is turned off. The upper heater is turned off. At the end of the process the operator has three options:

7.8 Reference: Run Screen - Operator Controls



Laser Pointer Teach Position



Start Cycle



Stop Cycle



Ok/Exit Screen



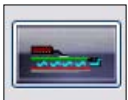
Nozzle Vacuum: On/off vacuum for nozzle



Component Probe Vacuum: On/off vacuum for vacuum probe port



Blow Off Air: On/off pressure for nozzle vacuum, used to gently blow the part away from nozzle.



Board Carrier Cooling Flow: Allows upper heater and bottom heater to perform rapid cooldown. The nozzle cooldown involves a bypass operation to deliver cool air directly into the nozzle chamber (does not cool down the heating element).



LED Light: On/Off machine lights



Home Vision Systems Motors: Brings nozzle (top position) and vision system (rear position) to home position.



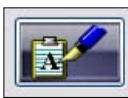
Direct View Camera Lights: On/Off



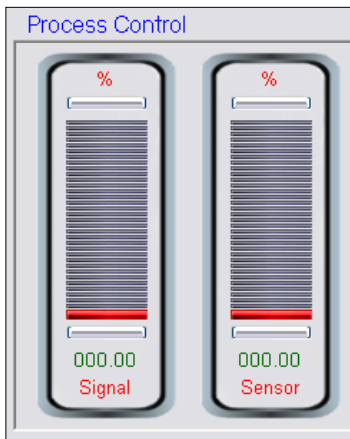
Site Cleaning Vacuum: On/Off



IR Probe Laser Pointer: On/Off light



Application Notes: Allows the operator to review profile notes prior to running the program. It may be useful to open when a linked profile is opened.



Process Control - % Signal: Indicates flow to nozzle (set).

Process Control - % Sensor: Indicates flow to nozzle (actual).

Nozzle	0	30
Section #1	0	24
Section #2	0	24
Section #3	0	24
BtmHotGas	0	24
Force	0.00	0.00

Nozzle: Left side – indicates set temperature to upper heater. Right side – indicates actual temperature to upper heater.

Section #1 - #3: Indicates set and actual temperature of preheat panels (#1 front, #2 middle, #3 rear).

Bottom Hot Gas Spot Heater: Indicates set and actual temperature of spot heater.

Force: Indicates force and actual setting of force system.

Noz Htr Stblz	23
Manual IR	-7

Noz Htr Stblz: Indicates temperature of thermocouple attached to hot gas head.

Manual IR/Thermocouples: Indicates temperature of IR temperature sensor.

Dry Run: When activated runs program without heat parameters applied.

☐ Dry Run

Scan: Allows bar scanner to be used for history file. Information can be entered manually without scanner.

Wait For Footswitch: In footswitch events, the operator can advance the program to the next event by clicking on “Wait For Footswitch” or by depressing the footswitch under the machine.

DRS27	Online	None	23 (sec)	None	Wait_For_FootSwitch
-------	--------	------	----------	------	---------------------

8: Maintenance

8.0 MAINTENANCE..... 3

8.1 GENERAL CAUTIONS..... 3

8.2 PREVENTATIVE MAINTENANCE SCHEDULE 4

8.3 VACUUM FILTER 5

8.4 FILTER ELEMENT REPLACEMENT 6

8.5 UPPER HEATING ELEMENT REPLACEMENT (NOTE: PHOTOS MAY VARY) 7

8.6 ASSEMBLY DIAGRAMS 11

8.0 Maintenance

- As a basic rule, disconnect the main 220 Vac power before servicing the machine or when the machine is taken off line.
- Only use the tools for their defined purpose.
- Never remove or disable any DRS27 safety features or software.
- Make sure that all electrical devices are leakage current protected and are stored and used in dry, dust-free surroundings.
- The machine contains static sensitive devices. Use caution to avoid static discharge when handling DRS27 machine parts.
- Use original spare parts only.

8.1 General Cautions

- The customer is responsible for the safety of their operations and the actions of their employees.
- The customer's employees are responsible for understanding and following all safety instructions outlined by the customer's process specification and safety policies.
- These employees should also be trained in electrical safety, and should be familiar with all hazards associated with Air-Vac Engineering systems. If toxic gases or chemicals are used with the equipment, the personnel working with these materials must also be familiar with related MSDSs and associated safety requirements. In addition, personnel working with Air-Vac Engineering equipment should observe to the following guidelines:
- Maintenance should be performed by qualified personnel only.
- Standard cautions should be observed when working on the machine
- If tasks do not require power, perform proper Lockout Tagout procedures to ensure machine is safe to work on. Note: heaters may still be hot for some time after removing power.
- If machine is required to be powered for maintenance tasks, use caution. Removal of covers exposes high voltage areas. Provide warnings to others in the area of exposed hazards.
- Moving axis produce a pinch point hazard. Be careful of Z and vision axis motion.
- Heaters can reach high temperatures that can burn skin on contact. If heater operation is required, do not touch surfaces or place anything on heater surfaces (fire hazard).
- Only use the tools for their defined purpose.
- Never remove or disable any DRS27 safety features or software.
- Make sure that all electrical devices are leakage current protected and are stored and used in dry, dust-free surroundings.
- The machine contains static sensitive devices. Use caution to avoid static discharge when handling DRS27 machine parts.
- Use original spare parts only.
- DO NOT smoke, eat, or drink while operating or servicing the system.
- Always work with a partner when conducting service and maintenance functions involving hazardous-voltage conditions: one person to monitor the system status; the other, to carry out the maintenance or service.

- Always wear appropriate protective clothing when working around the equipment. Consult your in-house safety coordinator for specific requirements.
- Avoid inhaling cleaning fluid vapors while cleaning the system components. Whenever using cleaning fluids or lubricants, follow all warnings and cautions contained on the labels.

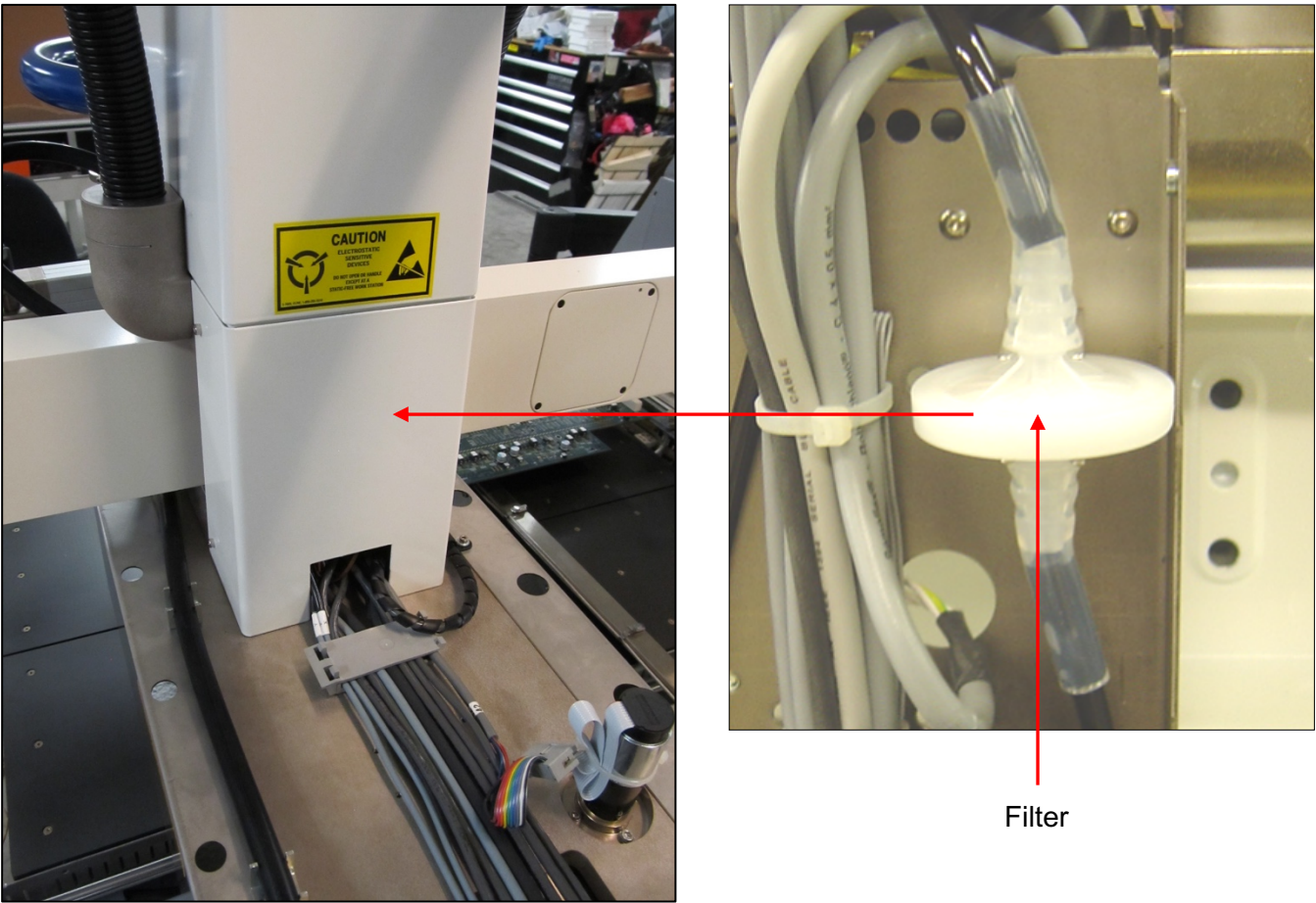
8.2 Preventative Maintenance Schedule

Machine Component	Maintenance Activity	Notes	Frequency		
			Daily	Weekly	Monthly
Data Backup	Profiles and part types must be written to an <u>off-machine storage media (network server, memory stick, cd, etc.)</u>	<u>Off-machine data back-up is the most critical maintenance task. Air-Vac is not responsible for lost data.</u>		X	
Nozzles	Clean nozzles of flux and inspect o-rings and vacuum cups			X	
Site Clean Tool (option)	Install the SC nozzle and activate the SC vacuum to verify that a strong vacuum exists. Inspect tip collector and blue vacuum cup for wear.	Vacuum cup should be replaced after 8 hrs. of use	X	X	
Machine Frame	Clean the machine frame and the machine covers Make sure there are no flux- or dispense media spoiled on the machine	Dry lint-free cloth, in case of flux, use flux remover			X
Vision Unit	Clean the protective cover glass on the lower and on the upper side of the vision unit	Kimwipes® Denatured Alcohol			X
Pneumatic Unit	Inspect and drain the air regulator filters of any water or oil as required (verify the air pressure is 0.55 mba)		X		
Vacuum Filter	Replace vacuum filter if vacuum is insufficient to hold component.	See instructions in Maintenance Section			X
X-Y-Z Axis Bearings	Clean all the linear bearing rails carefully. Lubricate the bearing rails afterwards slightly with oil	Benzine, dry lint-free cloth 3 in 1 oil			X
Z-axis Lead Screw	Clean the lead screw Lubricate the lead screw afterwards slightly with oil	Benzine, soft brush 3 in 1 oil			X
Computer/Machine	Hard Boot		8-10 hrs per shift		
Nozzle	Temperature Calibration	See instructions in Maintenance Section			X
Site Clean Jar	Filter Change	Changing filter is dependent on usage	As required		

Machine Component	Maintenance Activity	Notes	Frequency		
			Daily	Weekly	Monthly
Test Emergency Off		With machine on start any profile and press EMO - everything should stop and axis should be depowered.		weekly	
Machine	Machine Verification (Chapter 3)			Every 3-4 months	

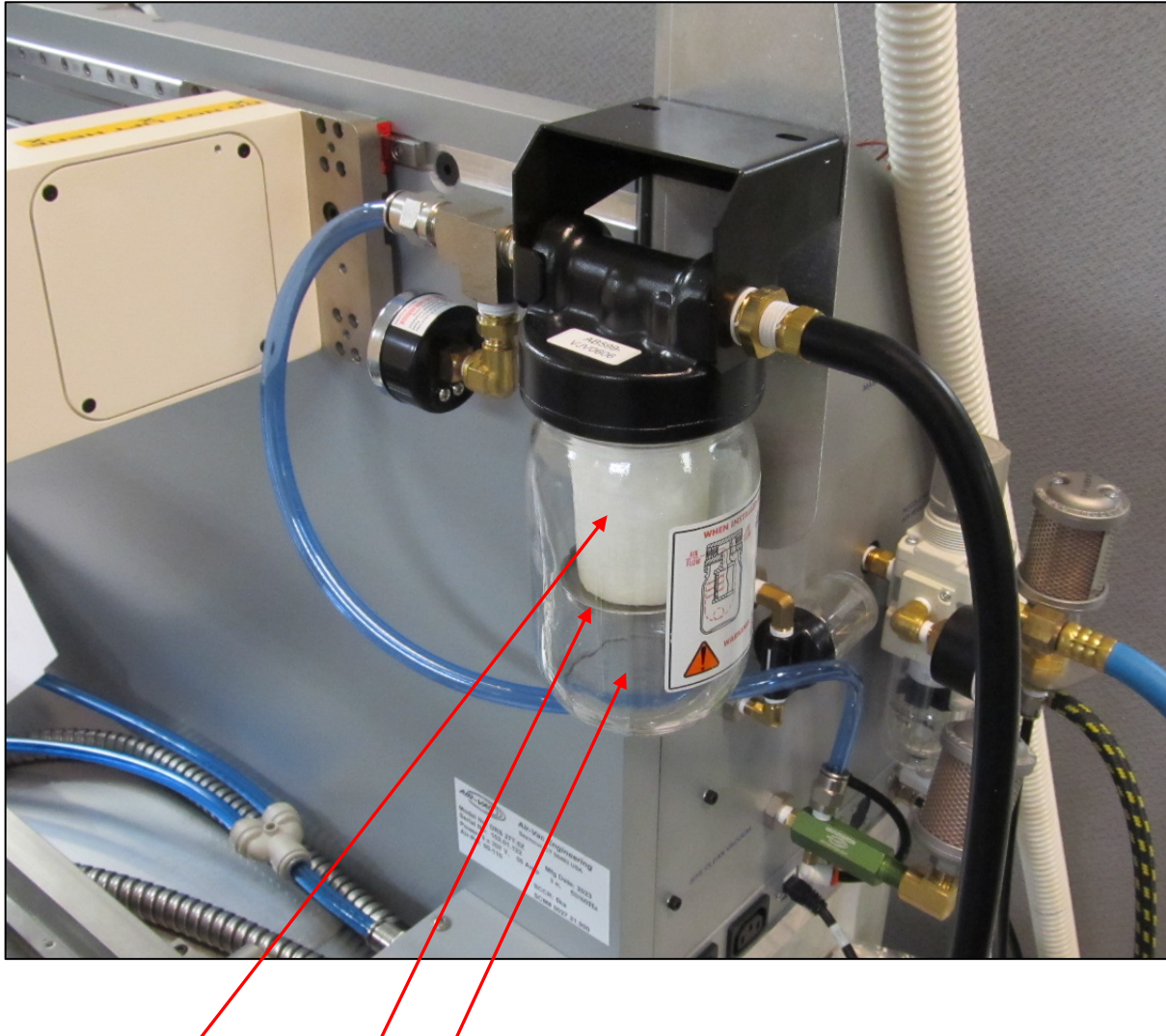
8.3 Vacuum Filter

The assembly head vacuum uses an inline filter. The filter is located under the back cover of the head. If the process includes heavy evaporating flux, then the filter must be replaced on a regular base.



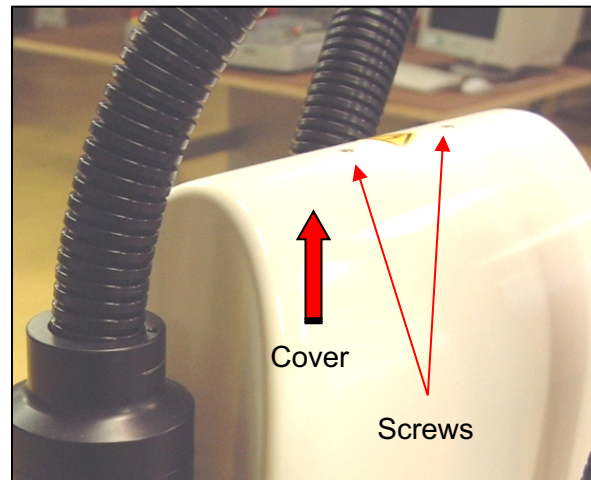
8.4 Filter Element Replacement

- Un-screw jar.
- Un-screw retaining flange.
- Replace filter.

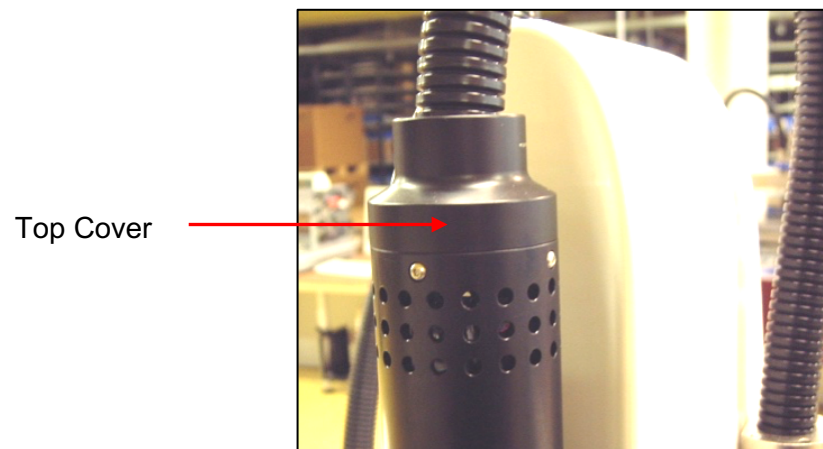


8.5 Upper Heating Element Replacement (Note: photos may vary)

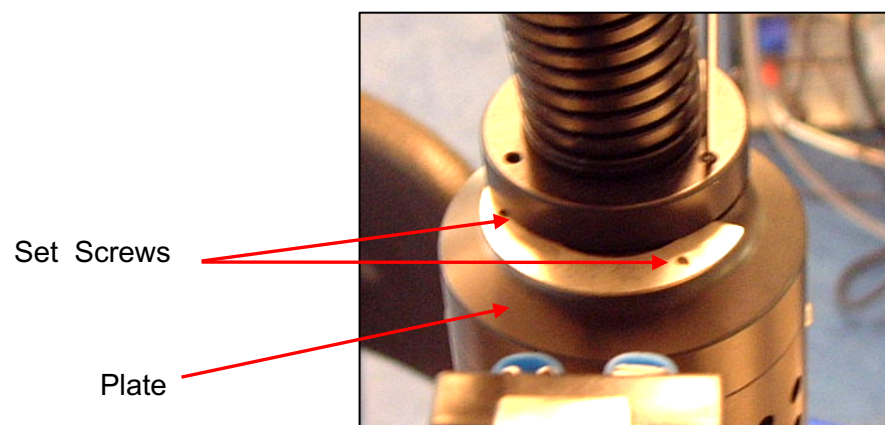
1. Take off the white Top Cover.



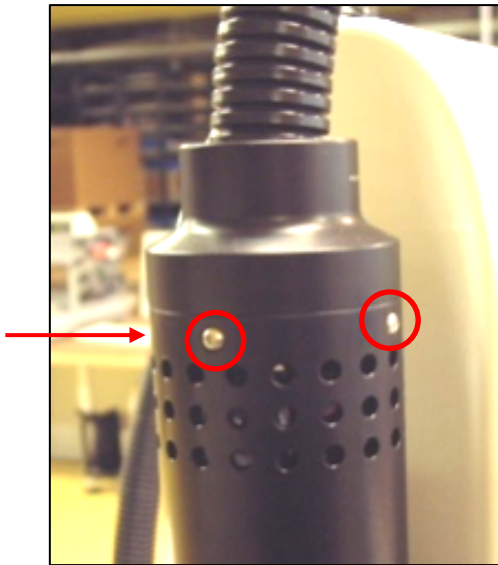
2. Take off the Top Cover by...



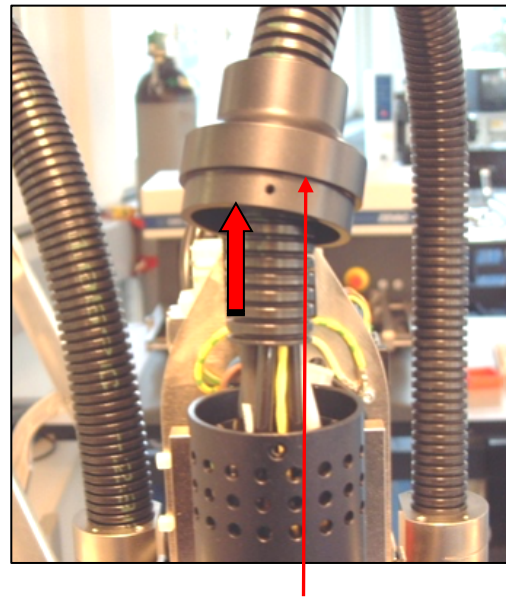
3. Loosening the two set Screws and take off the Plate.



4. Loosen the three Screws and slide the top Cover through the Tube.

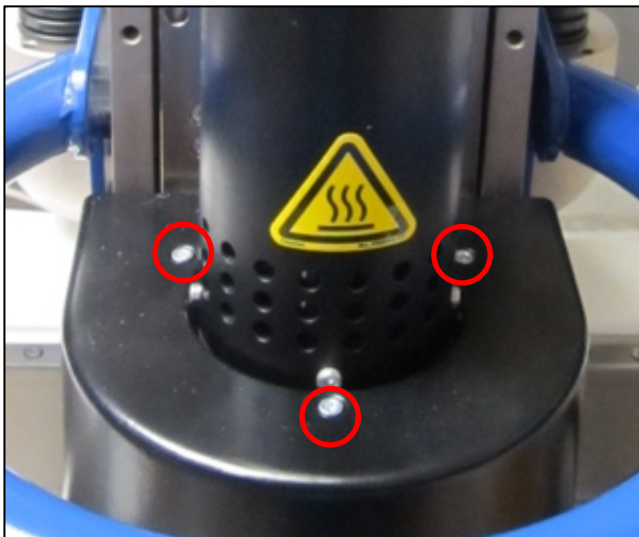


Screws

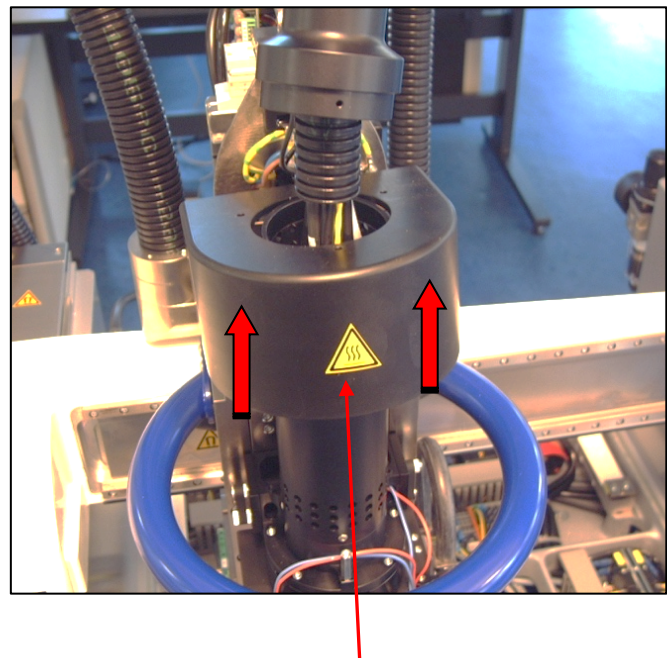


Top Cover

5. Take off the three Screws and lift up the Cover.



Screws

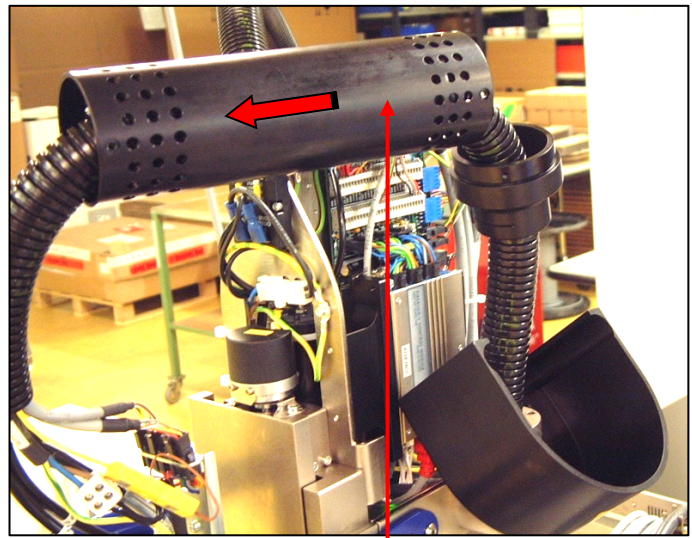


Cover

6. Take off the three Screws and slide the Pipe through the Tube.



Screws



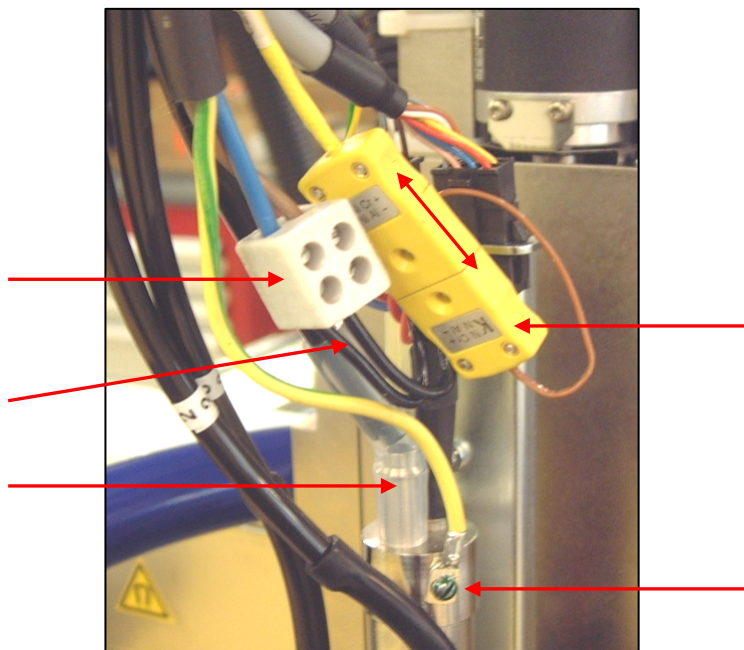
Pipe

7. Remove the two black Heater Wires from the ceramic Terminal Block.

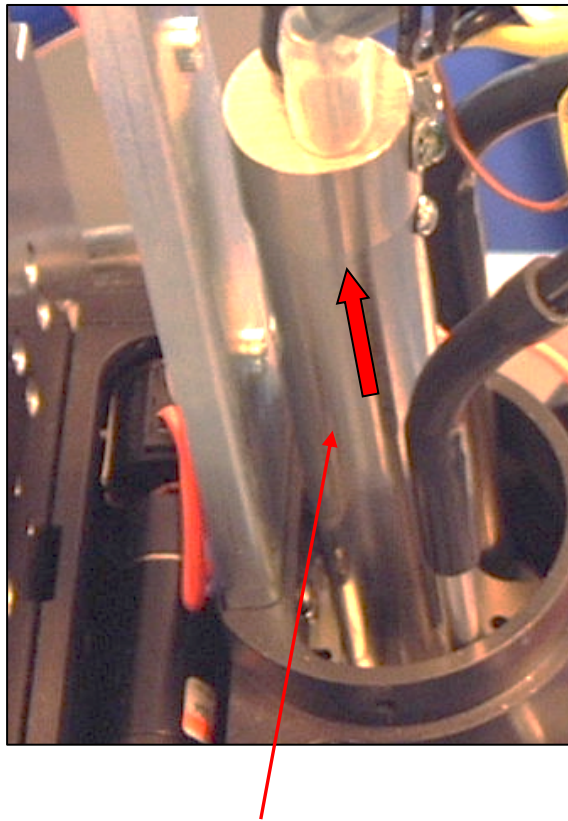
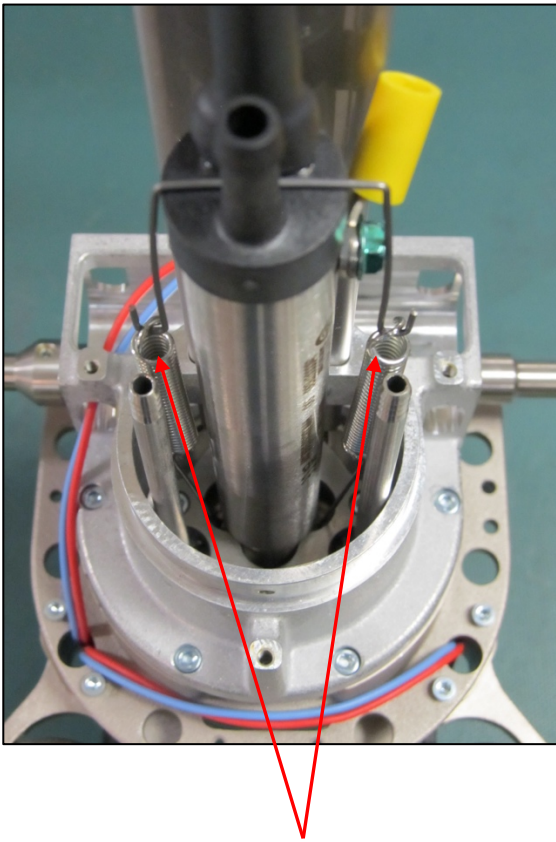
8. Remove the Ground Wire from the Heater.

9. Remove the Air Tube from the Heater.

10. Disconnect the T/C Plugs.



11. Remove the Spring Pack that holds the Heater in place.
12. Remove the Heater from Head assembly.

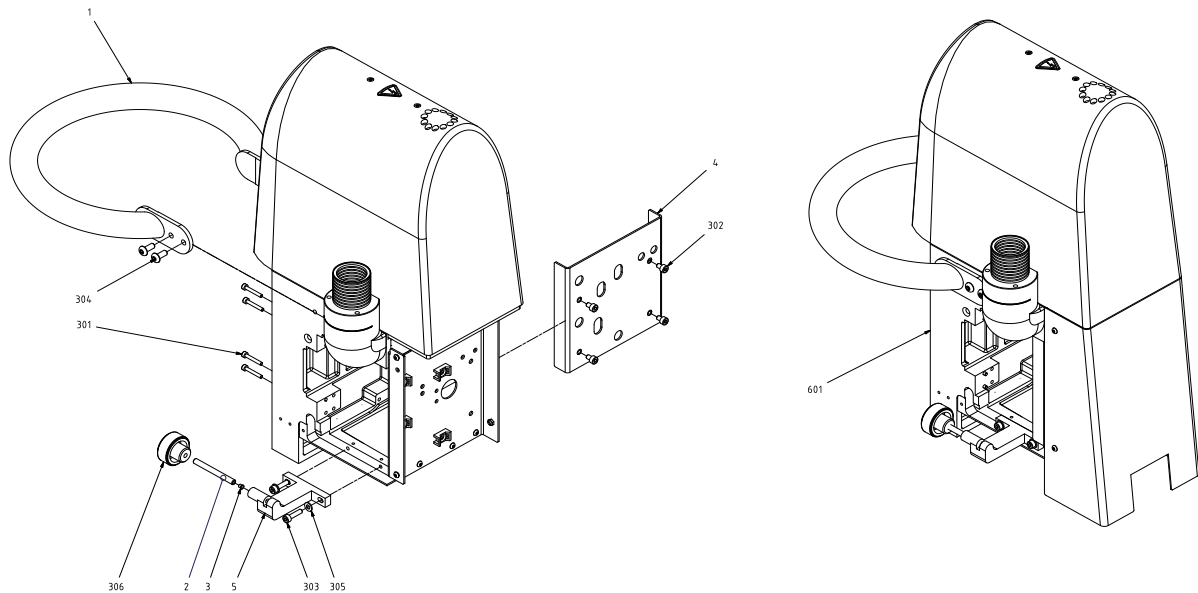
**Note**

To remount all removed parts, follow the same procedure in reverse.

8.6 Assembly Diagrams

300.00.968 X-Z-Axis 150mm

(OBC 30mm)

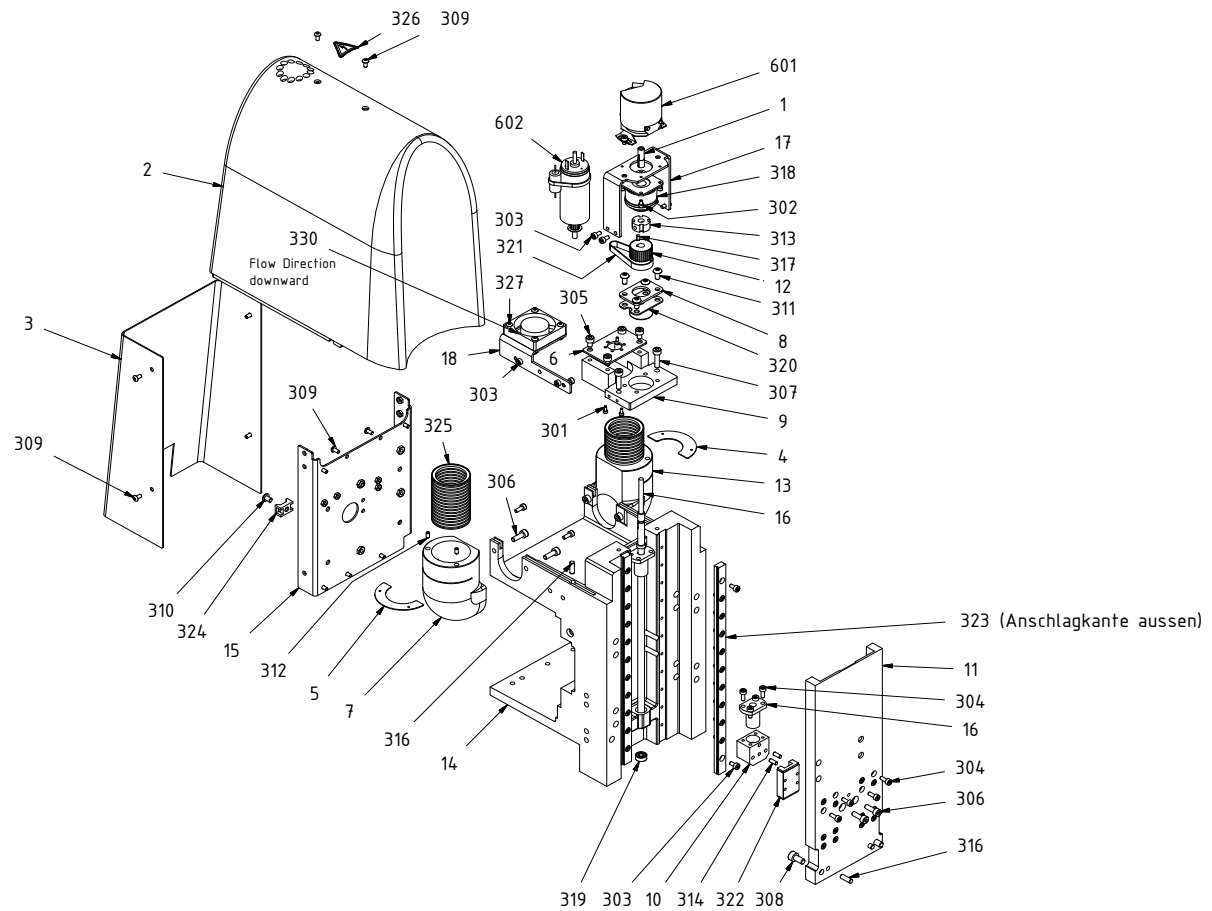


Initial date:14.02.2006/CL

Change index:0 /19.09.2008/AG

Pos.	Amount	Unit	Spare part class	Article number	Article description
1	1	pc.	-	200.01.158	Handle
2	1	pc.	-	200.01.891	Gewindestange
3	1	pc.	-	200.01.892	Druckstück
4	1	pc.	-	200.01.923	Anschlagblech
5	1	pc.	-	200.02.107	Halter
301	16	pc.	-	100.00.021	Cyl. Screw M3x20, BN3
302	4	pc.	-	100.00.027	Cyl. screw M4x6, BN3
303	2	pc.	-	100.00.032	Cyl. screw M4x16, BN3
304	4	pc.	-	100.00.166	Lens head Screw M5x12, BN1593
305	2	pc.	-	100.04.002	Washer M4, BN 726
306	1	pc.	-	101.26.003	Turning knob M5x10, BN14176
307	0.6	m	-	109.19.032	Conduit pipe PMARobot PCSG-23B.50
601	1	pc.	-	300.01.023	X-Z-Axis 150mm base module (OBC 30mm)

300.01.023 X-Z-Axis 150mm base module (OBC 30mm)



Initial date:09.05.2006/CL

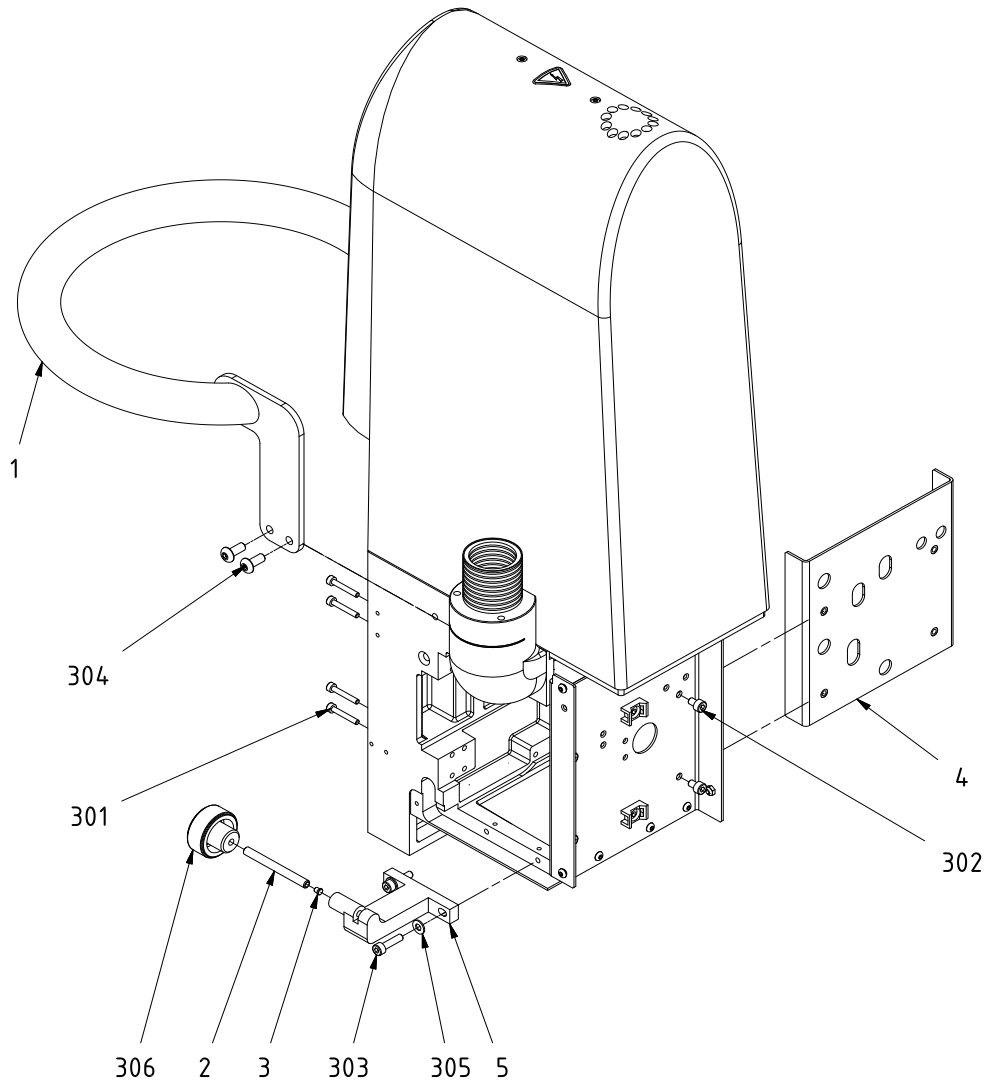
Change index:2 /23.12.2008/AG

Pos.	Amount	Unit	Spare part class	Article number	Article description
1	1	pc.	-	200.01.089	Huelse Encoder
2	1	pc.	-	200.03.390	Cover z-axis
3	1	pc.	-	200.01.155	Abdeckung Rueckwand
4	1	pc.	-	200.01.156	Segment 23
5	1	pc.	-	200.01.157	Segment 29
6	1	pc.	-	200.01.166	Motorplatte Z
7	1	pc.	-	200.01.408	Wellrohranschluss 29
8	1	pc.	-	200.01.430	Abschlussplatte
9	1	pc.	-	200.01.432	Attachment plate motor
10	1	pc.	-	200.01.433	Mutterflansch
11	1	pc.	-	200.01.435	Vertikalschlitten
12	1	pc.	-	200.01.436	Zahnscheibe Spindel
13	1	pc.	-	200.01.438	Wellrohranschluss 23
14	1	pc.	-	200.02.331	Grundplatte Kasten kurz
15	1	pc.	-	200.02.378	Cabinet back wall
16	1	pc.	-	200.02.418	Z-Spindel 150mm
17	1	pc.	-	200.02.419	Bügel
18	1	pc.	-	200.03.363	Fun holder

Pos.	Amount	Unit	Spare part class	Article number	Article description
301	3	pc.	-	100.00.003	Cyl. Screw M2x6 BN 11
302	4	pc.	-	100.00.007	Zyl. Schraube M2.5x4 BN 11
303	28	pc.	-	100.00.015	Cyl. screw M3x6, BN3
304	24	pc.	-	100.00.016	Cyl. screw M3x8, BN3
305	4	pc.	-	100.00.027	Cyl. screw M4x6, BN3
306	6	pc.	-	100.00.030	Cyl. screw M4x12, BN3
307	2	pc.	-	100.00.032	Cyl. screw M4x16, BN3
308	2	pc.	-	100.00.044	Cyl. screw M5x12
309	11	pc.	-	100.00.157	Lens head screw M3x6, BN1593
310	4	pc.	-	100.00.208	Lens head screw M4x6, BN1593
311	4	pc.	-	100.00.160	Lens head screw M4x8, BN1593
312	4	pc.	-	100.00.206	Threaded pin M3x6 with peak, BN29
313	1	pc.	-	100.02.019	Stellmutter Kuso MRR M6x0.5
314	2	pc.	-	100.05.027	Cyl. pin d 3-h6 x8
316	4	pc.	-	100.05.040	Cyl. pin d 4-h6x12 BN 858
317	1	pc.	-	100.05.095	Federkeil 2x2x6 BN 870
318	1	pc.	3	101.18.002	Z-axis break 86621-03H00-24V
319	1	pc.	3	101.22.007	Ball bearing 4/10/4
320	1	pc.	3	101.22.033	Axial bearing ZKLR 0624.2Z
321	1	pc.	2	101.28.006	Power grip belt GT 2MR-112, 6m
322	4	pc.	3	102.00.012	Linear bearing MNN 9-G1
323	2	pc.	-	102.00.024	Linearfuehrung Schiene MN 9-233-G1-V1
324	4	pc.	-	109.19.027	Attachment block TM-2S8
325	0.57	m	-	109.19.032	Conduit pipe PMARobot PCSG-23B.50
326	1	pc.	2	109.51.005	Warning label 25 x 25mm lightning
327	4	pc.	-	100.00.273	Lens head Screw M3x16 BN1593
330	1	pc.	3	109.08.003	Fan 40x40x10 mm, 24 VDC
331	2	pc.	-	100.00.014	Cyl. screw M3x5, BN3
332	2	pc.	-	100.00.159	Lens head screw M3x10, BN1593
601	1	pc.	2	300.00.038	Z-Encoder complete
602	1	pc.	3	9002.05.082	Z-Motor complete

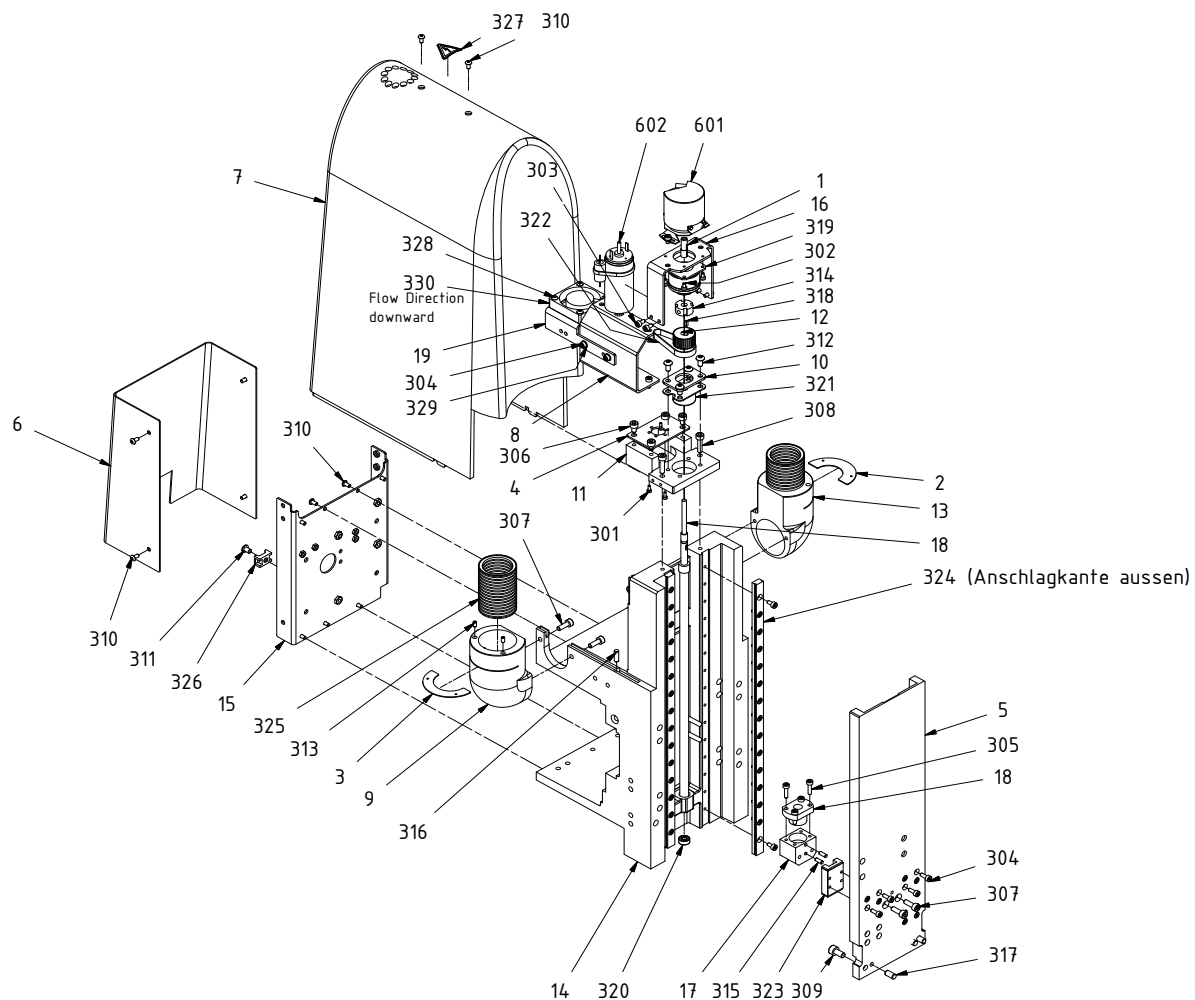
300.01.034 X-Z-Axis 230mm

(OBC 70mm)



Pos.	Amount	Unit	Spare part class	Article number	Article description
1	1	pc.	-	200.01.797	Handle (Z 230mm)
2	1	pc.	-	200.01.891	Gewindestange
3	1	pc.	-	200.01.892	Druckstück
4	1	pc.	-	200.01.923	Anschlagblech
5	1	pc.	-	200.02.107	Halter
301	8	pc.	-	100.00.022	Cyl. Screw M3x22, BN 3
302	4	pc.	-	100.00.027	Cyl. screw M4x6, BN3
303	2	pc.	-	100.00.032	Cyl. screw M4x16, BN3
304	4	pc.	-	100.00.166	Lens head Screw M5x12, BN1593
305	2	pc.	-	100.04.002	Washer M4, BN 726
306	1	pc.	-	101.26.003	Turning knob M5x10, BN14176
307	0.65	m	-	109.19.032	Conduit pipe PMARobot PCSG-23B.50
601	1	pc.	-	300.01.025	X-Z-Axis 230mm base module (OBC 70mm)

300.01.025 X-Z-Axis 230mm base module (OBC 70mm)



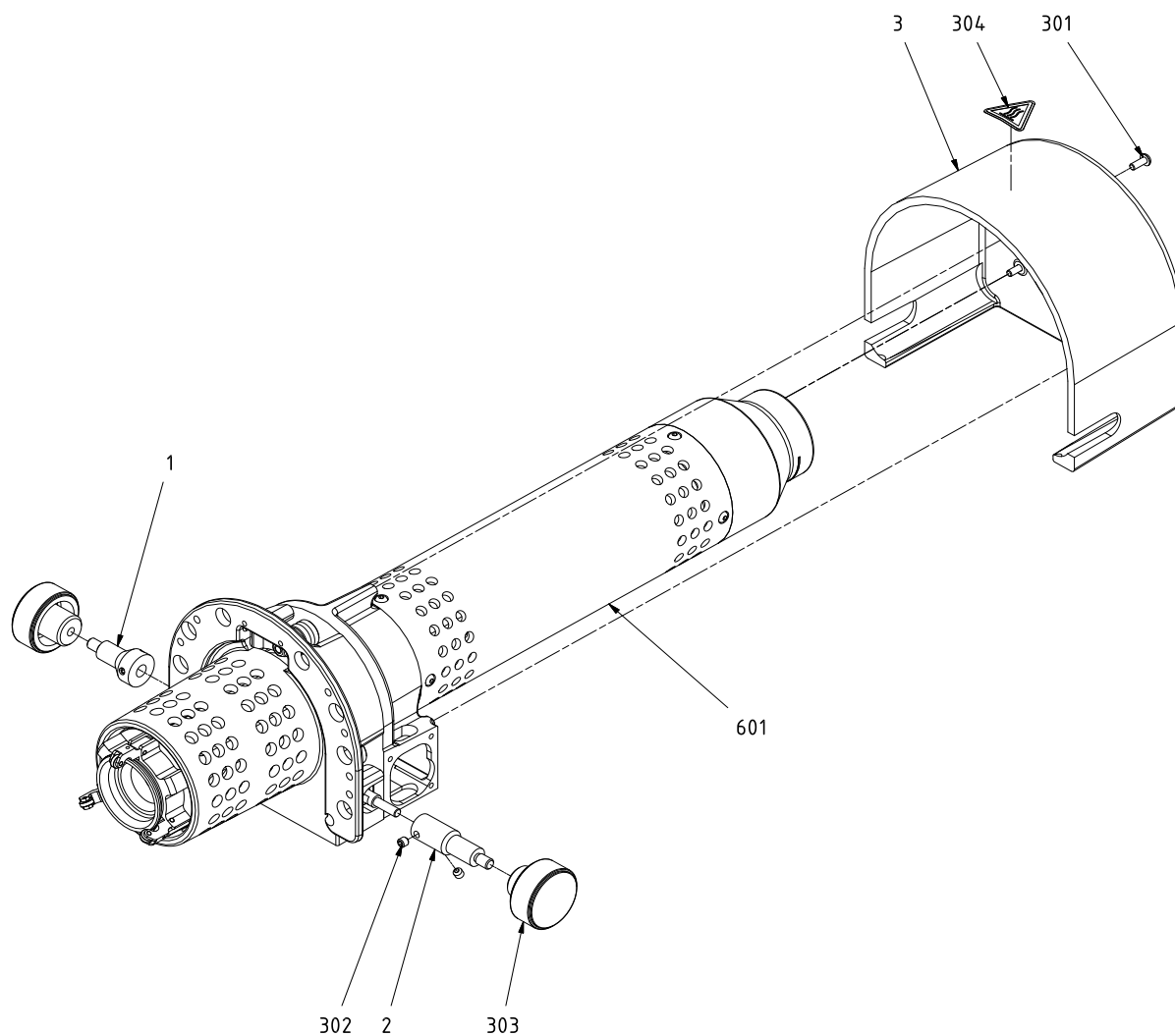
Initial date:10.05.2006/CL

Change index:1 /05.02.2009/MH

Pos.	Amount	Unit	Spare part class	Article number	Article description
1	1	pc.	-	200.01.089	Huelse Encoder
2	1	pc.	-	200.01.156	Segment 23
3	1	pc.	-	200.01.157	Segment 29
4	1	pc.	-	200.01.166	Motorplatte Z
5	1	pc.	-	200.01.367	Vertikalschlitten
6	1	pc.	-	200.01.368	Deckel Rueckwand
7	1	pc.	-	200.03.391	Haube Z-Achse hoch
8	1	pc.	-	200.03.385	Distance plate
9	1	pc.	-	200.01.408	Wellrohranschluss 29
10	1	pc.	-	200.01.430	Abschlussplatte
11	1	pc.	-	200.01.432	Attachment plate motor
12	1	pc.	-	200.01.436	Zahnscheibe Spindel
13	1	pc.	-	200.01.438	Wellrohranschluss 23
14	1	pc.	-	200.02.332	Grundplatte Kasten lang
15	1	pc.	-	200.02.378	Cabinet back wall

Pos.	Amount	Unit	Spare part class	Article number	Article description
16	1	pc.	-	200.02.419	Bügel
17	1	pc.	-	200.02.585	Mutterflansch
18	1	pc.	-	200.02.586	Z-Spindel 230mm
19	1	pc.	-	200.03.363	Fun holder
301	3	pc.	-	100.00.003	Cyl. Screw M2x6 BN 11
302	4	pc.	-	100.00.007	Zyl. Schraube M2.5x4 BN 11
303	34	pc.	-	100.00.015	Cyl. screw M3x6, BN3
304	24	pc.	-	100.00.016	Cyl. screw M3x8, BN3
305	4	pc.	-	100.00.017	Cyl. screw M3x10, BN3
306	4	pc.	-	100.00.027	Cyl. screw M4x6, BN3
307	6	pc.	-	100.00.030	Cyl. screw M4x12, BN3
308	2	pc.	-	100.00.032	Cyl. screw M4x16, BN3
309	2	pc.	-	100.00.043	Cyl. screw M5x10, BN3
310	11	pc.	-	100.00.157	Lens head screw M3x6, BN1593
311	2	pc.	-	100.00.208	Lens head screw M4x6, BN1593
312	4	pc.	-	100.00.160	Lens head screw M4x8, BN1593
313	4	pc.	-	100.00.206	Threaded pin M3x6 with peak, BN29
314	1	pc.	-	100.02.019	Stellmutter Kuso MRR M6x0.5
315	2	pc.	-	100.05.027	Cyl. pin d 3-h6 x8
316	2	pc.	-	100.05.040	Cyl. pin d 4-h6x12 BN 858
317	2	pc.	-	100.05.039	Cyl. pin d 4-h6 x10, BN 858
318	1	pc.	-	100.05.095	Federkeil 2x2x6 BN 870
319	1	pc.	3	101.18.002	Z-axis break 86621-03H00-24V
320	1	pc.	3	101.22.007	Ball bearing 4/10/4
321	1	pc.	3	101.22.033	Axial bearing ZKLR 0624.2Z
322	1	pc.	2	101.28.006	Power grip belt GT 2MR-112, 6m
323	4	pc.	3	102.00.012	Linear bearing MNN 9-G1
324	2	pc.	-	102.00.025	Linearfuehrung Schiene MN 9-313-G1-V1
325	1.2	m	-	109.19.024	Wellrohr PCSG-29B
326	4	pc.	-	109.19.027	Attachment block TM-2S8
327	1	pc.	2	109.51.005	Warning label 25 x 25mm lightning
328	4	pc.	-	100.00.259	Lens head Screw M3x16, BN1593
329	2	pc.	-	100.04.023	Washer M3, BN 715
330	1	pc.	3	109.08.003	Fan 40x40x10 mm, 24 VDC
331	2	pc.	-	100.00.159	Lens head screw M3x10, BN1593
601	1	pc.	2	300.00.038	Z-Encoder complete
602	1	pc.	3	9002.05.082	Z-Motor complete

300.00.784 Advanced solder head

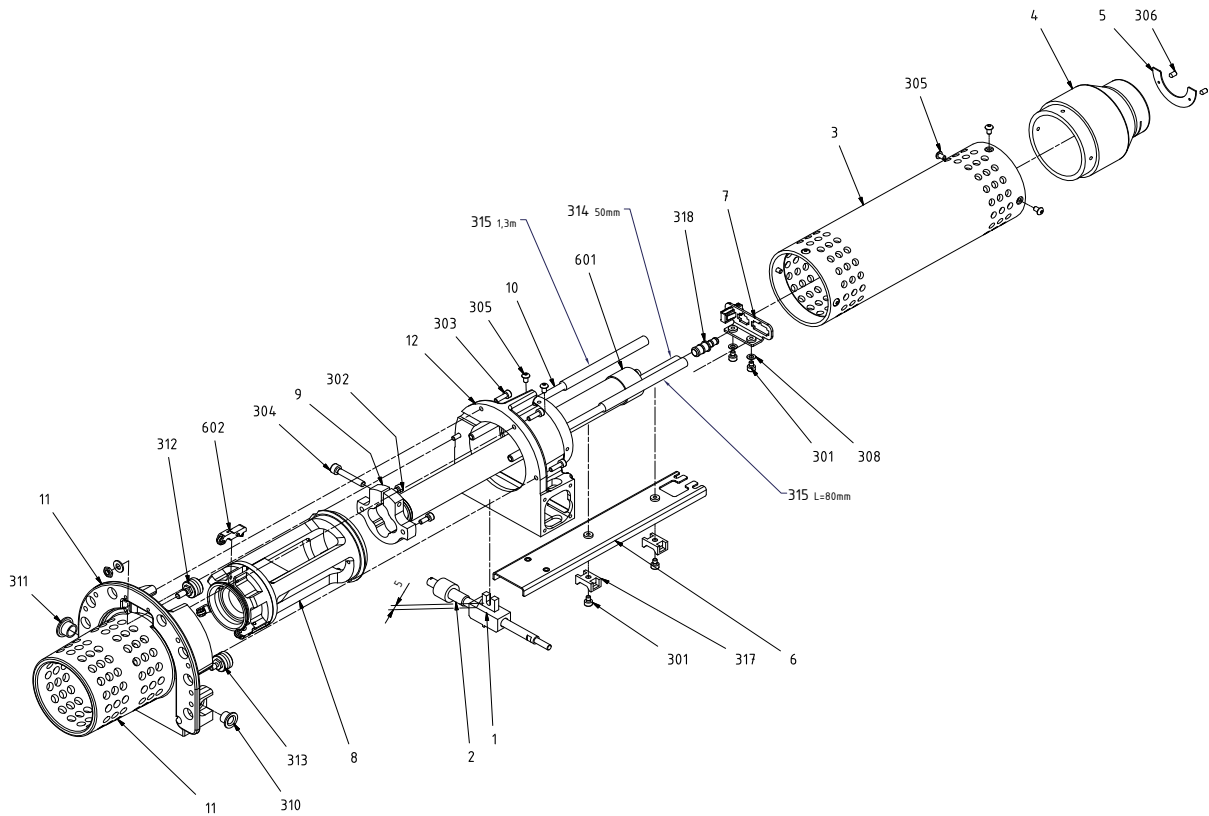


Initial date:13.02.2006/CL

Change index:0 /23.12.2008/AG

Pos.	Amount	Unit	Spare part class	Article number	Article description
1	1	pc.	-	200.01.912	Achsverlängerung links
2	1	pc.	-	200.01.913	Achsverlängerung rechts
3	1	pc.	-	200.01.914	Abdeckhaube Onyx 25
301	3	pc.	-	100.00.158	Lens head screw M3x8, BN1593
302	4	pc.	-	100.00.180	Threaded Pin M4x4, BN 28
303	2	pc.	-	101.26.003	Turning knob M5x10, BN14176
304	1	pc.	2	109.51.006	Warning label 25 x 25mm hot surface
601	1	pc.	-	300.01.006	Advanced solder head base

300.01.006 Advanced solder head base

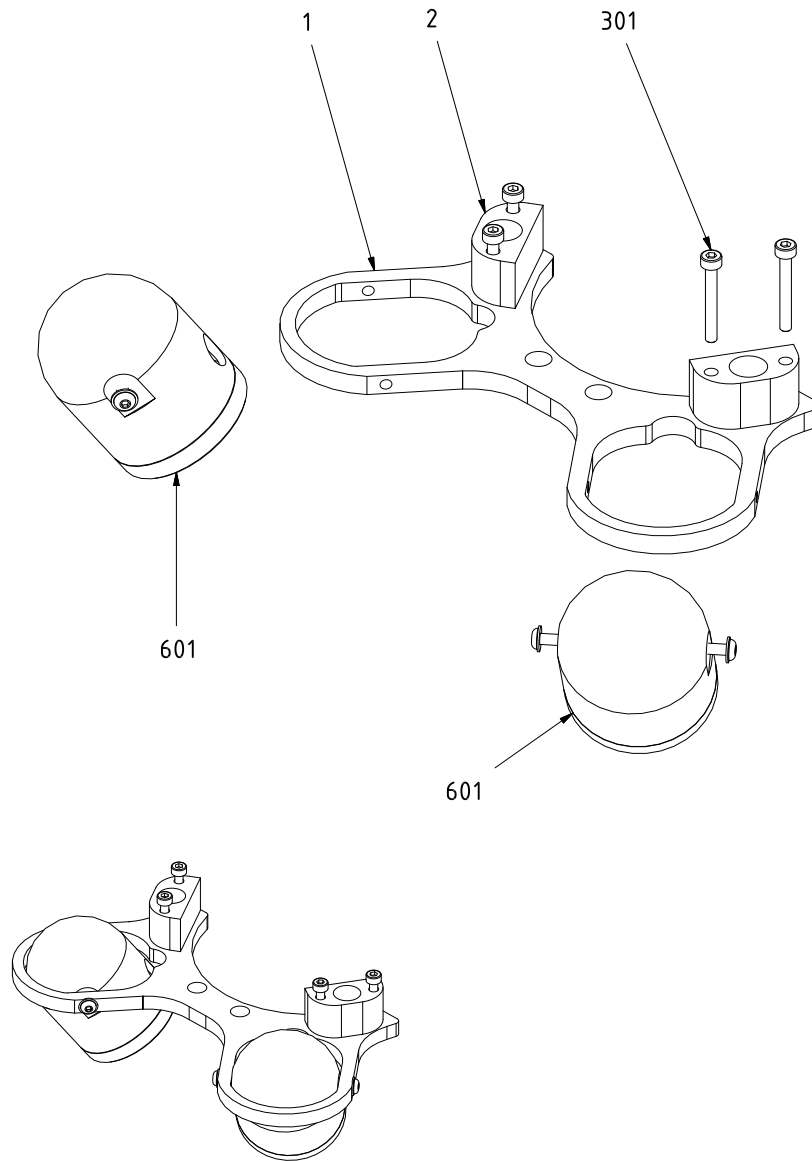


Initial date:24.04.2006/EG

Change index:0 /14.01.2009/AG

Pos.	Amount	Unit	Spare part class	Article number	Article description
1	1	pc.	-	200.01.033	Slider
2	1	pc.	-	200.01.219	Spindle
3	1	pc.	-	200.01.220	Schutzrohr
4	1	pc.	-	200.01.221	Abdeckkappe oben
5	1	pc.	-	200.01.231	Segment
6	1	pc.	-	200.01.235	Kabelhalter
7	1	pc.	-	200.01.236	Steckerhalter
8	1	pc.	-	200.01.259	Düsenkopf-Drehkörper
9	1	pc.	-	200.01.260	Klemmring
10	2	pc.	-	200.01.261	Luft-Vacuumrohr
11	1	pc.	-	200.01.403	Support head Z-axis
12	1	pc.	-	200.01.404	Motorflansch
301	2	pc.	-	100.00.014	Cyl. screw M3x5, BN3
302	2	pc.	-	100.00.017	Cyl. screw M3x10, BN3
303	4	pc.	-	100.00.017	Cyl. screw M3x10, BN3
304	1	pc.	-	100.00.035	Cyl. Screw M4x25, BN 3
305	8	pc.	-	100.00.156	Lens head screw M3x5, BN 1593
306	2	pc.	-	100.00.206	Threaded pin M3x6 with peak, BN29
308	1	pc.	-	100.04.023	Washer M3, BN 715
310	1	pc.	3	101.22.026	Rotational spacer 6x8x12x7
311	1	pc.	3	101.22.027	Rotational spacer 8x10x15x7.5

300.01.423 Field Illumination (adjustable)

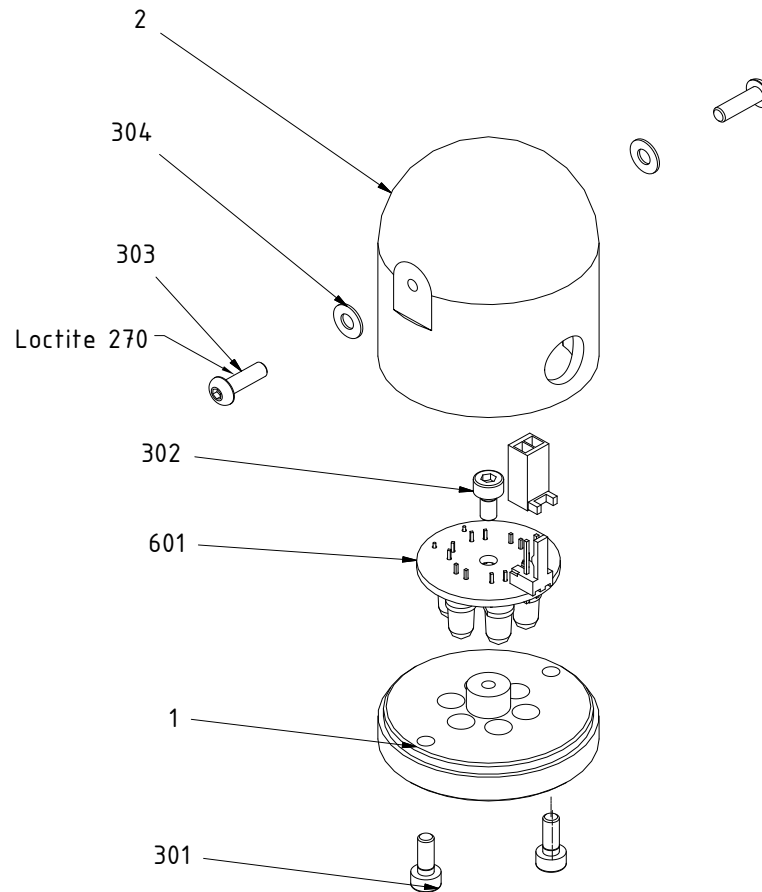


Initial date:21.03.2007/EG

Change index:0 /29.01.2009/AG

Pos.	Amount	Unit	Spare part class	Article number	Article description
1	1	pc.	-	200.03.256	Lampenhalter
2	2	pc.	-	200.03.328	Unterlage
301	4	pc.	-	100.00.023	Cyl. Screw M3x25, BN 3
601	2	pc.	-	300.01.422	Lamp (adjustable)
602	1	pc.	-	300.01.479	Y-Cable field illumination
603	1	pc.	-	300.00.910	Cable field illumination

300.01.422 Lamp (adjustable)

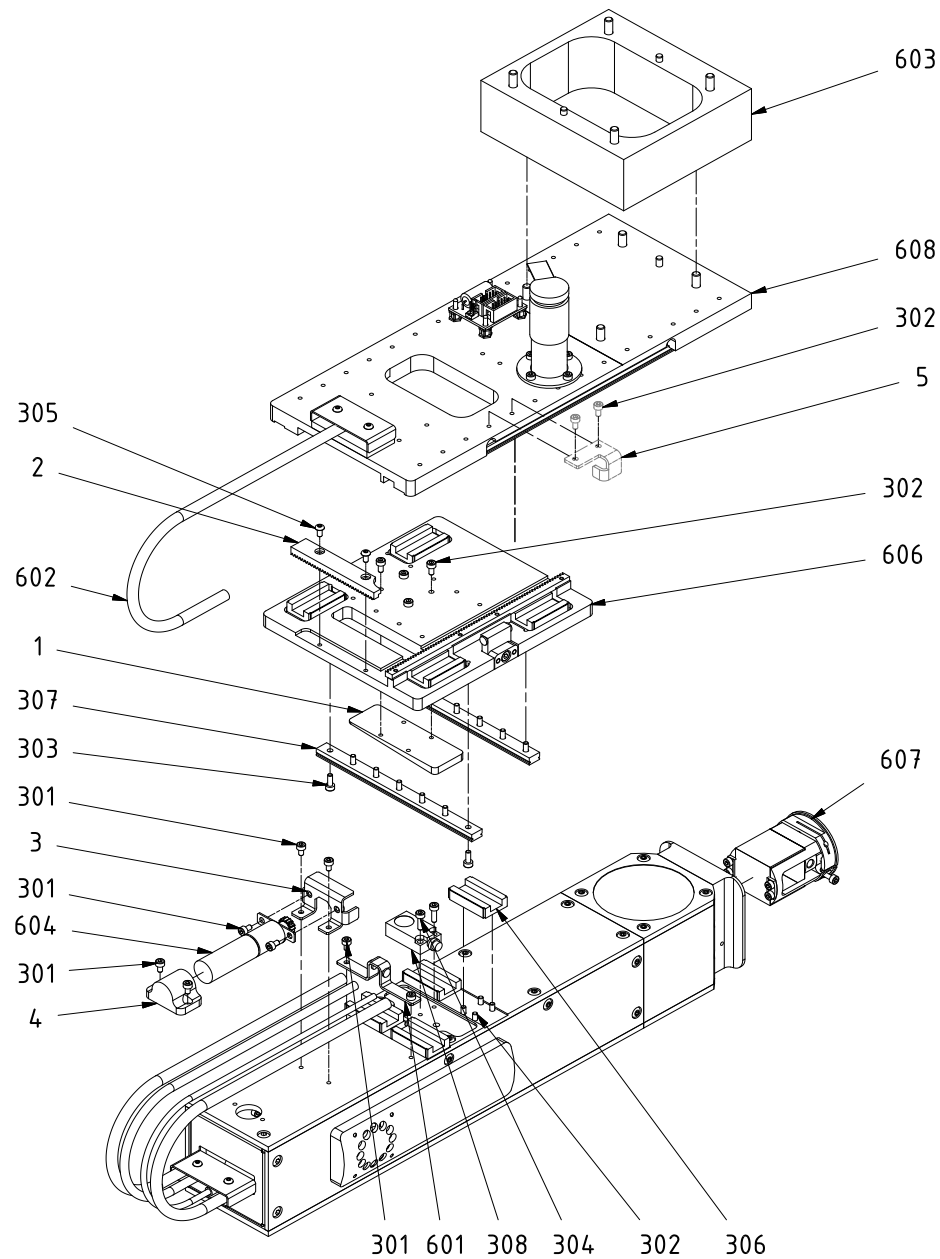


Initial date:21.03.2007/EG

Change index:0 /04.02.2009/MH

Pos.	Amount	Unit	Spare part class	Article number	Article description
1	1	pc.	-	200.01.228	LED-Gehäuse
2	1	pc.	-	200.03.263	Lampengehäuse
301	2	pc.	-	100.00.016	Cyl. screw M3x8, BN3
302	1	pc.	-	100.00.015	Cyl. screw M3x6, BN3
303	2	pc.	-	100.00.159	Lens head screw M3x10, BN1593
304	2	pc.	-	100.09.004	U-Scheibe 3.2/7x0.5 BN670 rostfrei
305	0.2	ml	-	115.14.012	Loctite 270 10ml, Gew.-Sich. hochfest
601	1	pc.	3	300.00.433	Illumination board field illumination

300.01.419 Vision system with MFOV extension



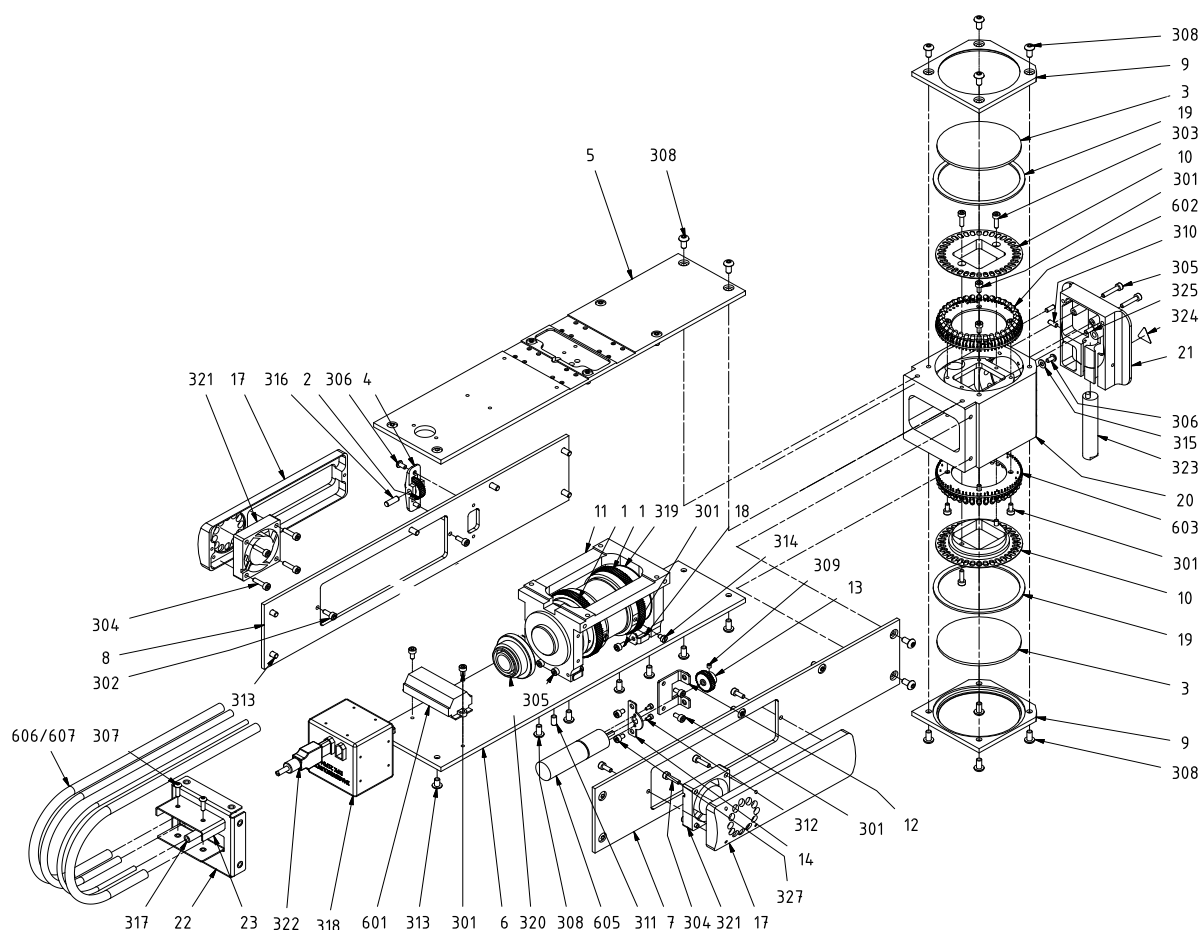
Initial date:20.02.2007/WB

Change index:0 /04.02.2009/MH

Pos.	Amount	Unit	Spare part class	Article number	Article description
1	1	pc.	-	200.01.179	Keil
2	1	pc.	-	200.01.180	Zahnstange X
3	1	pc.	-	200.01.200	Haltewinkel X-Motor
4	1	pc.	-	200.01.202	Motorstuetze X
5	1	pc.	3	200.02.490	Transport safety lock Vision Y
301	8	pc.	-	100.00.014	Cyl. screw M3x5, BN3

Pos.	Amount	Unit	Spare part class	Article number	Article description
302	6	pc.	-	100.00.015	Cyl. screw M3x6, BN3
303	14	pc.	-	100.00.016	Cyl. screw M3x8, BN3
304	2	pc.	-	100.00.017	Cyl. screw M3x10, BN3
305	2	pc.	-	100.00.157	Lens head screw M3x6, BN1593
306	4	pc.	3	102.00.012	Linear bearing MNN 9-G1
307	2	pc.	-	102.00.017	Linearfuehrung Schiene MN 9-135-G1-V1
308	1	pc.	3	109.04.028	Inductive sensor IWFM 18U7504/S35A
309	1	pc.	-	109.04.029	Kabeldose ESG 32AH0200 4Pol
310	16	pc.	-	100.00.013	Cyl. Screw M3x4 BN 3
601	1	pc.	-	300.00.454	Mechanical stop X complete
602	1	pc.	-	300.00.501	Robotic cable vision motors
603	1	pc.	-	300.00.564	Distance block vision system
604	1	pc.	3	9002.15.011	Gear motor Vision X
605	1	pc.	-	300.01.416	Vision unit base module
606	1	pc.	-	300.01.049	Y-carriage vision
607	1	pc.	-	300.01.052	Prism attachment adjustable
608	1	pc.	-	300.01.072	Vision Y-guiding plate

300.01.416 Vision unit base module



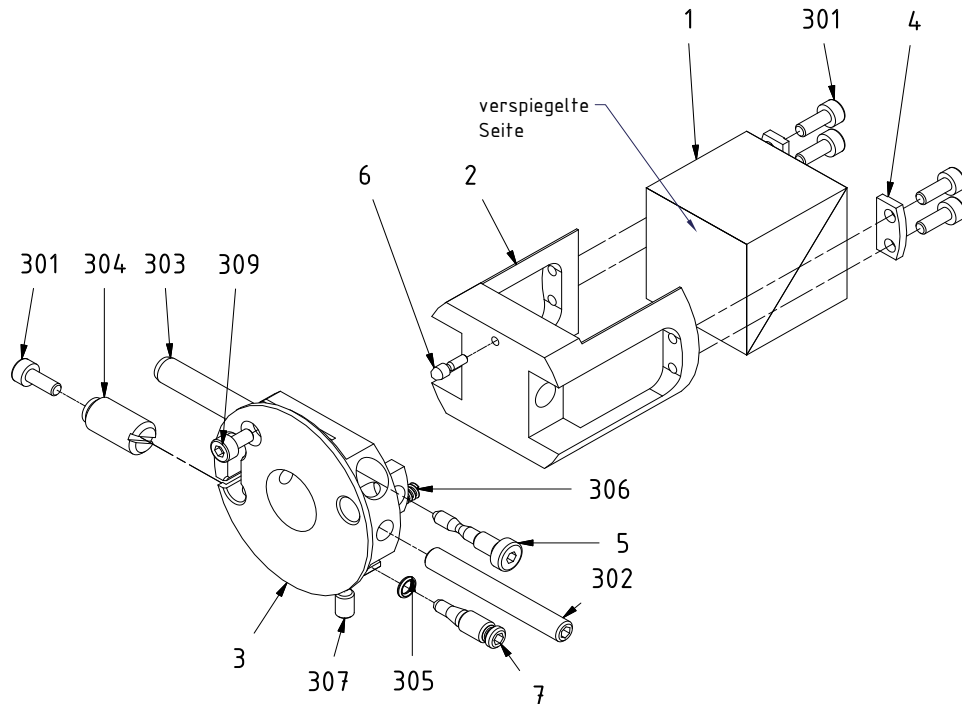
Initial date:19.02.2007/WB

Change index:0 /23.12.2008/AG

Pos.	Amount	Unit	Spare part class	Article number	Article description
1	2	pc.	-	200.01.023	Drive Ring
2	1	pc.	-	200.01.025	Handrad Objektiv
3	2	pc.	3	200.01.131	Protection glass
4	1	pc.	-	200.01.184	Zahnradgehaeuse
5	1	pc.	-	200.01.186	Grundplatte Vision
6	1	pc.	-	200.01.187	Bodenplatte
7	1	pc.	-	200.01.188	Seitenplatte links
8	1	pc.	-	200.01.189	Seitenplatte rechts
9	2	pc.	-	200.01.190	Frame protection glass
10	2	pc.	-	200.01.191	LED-Abdeckring
11	1	pc.	-	200.01.193	Objektivgehaeuse
12	1	pc.	-	0027.17.102	Grundplatte Zoomantrieb
13	1	pc.	-	200.01.195	Toothed Gear
14	1	pc.	-	0027.17.103	Motor Plate
17	2	pc.	-	200.01.199	Cover motor

Pos.	Amount	Unit	Spare part class	Article number	Article description
18	2	pc.	-	200.01.204	Kabellascche
19	2	pc.	-	200.01.282	Disc
20	1	pc.	-	200.01.927	Prismagehaeuse
21	1	pc.	-	0027.10.104	Laserpointergehaeuse
22	1	pc.	-	200.02.449	Rahmen Vision
23	1	pc.	-	200.02.450	Kabelbride
301	18	pc.	-	100.00.015	Cyl. screw M3x6, BN3
302	4	pc.	-	100.00.016	Cyl. screw M3x8, BN3
303	4	pc.	-	100.00.017	Cyl. screw M3x10, BN3
304	8	pc.	-	100.00.018	Cyl. screw M3x12, BN3
305	4	pc.	-	100.00.020	Cyl. screw M3x16, BN3
306	4	pc.	-	100.00.157	Lens head screw M3x6, BN1593
307	2	pc.	-	100.00.018	Cyl. screw M3x12, BN3
308	28	pc.	-	100.00.160	Lens head screw M4x8, BN1593
310	1	pc.	-	100.00.179	Gew.Stift M3x 8 BN 28
311	1	pc.	-	100.00.183	Threaded pin M4x8, BN 28
312	2	pc.	-	100.00.197	Cyl. Screw M2x4, BN 11
313	8	pc.	-	100.00.208	Lens head screw M4x6, BN1593
314	2	pc.	-	100.03.014	Zyl. Schraube mit Schlitz M3x4 BN 330
315	2	pc.	-	100.04.023	Washer M3, BN 715
316	1	pc.	-	100.05.040	Cyl. pin d 4-h6x12 BN 858
317	0.025	m	3	106.17.002	Polyurethane tube d=6mm, black
318	1	pc.	3	108.00.013	FireWire camera DFK 21F04
319	1	pc.	3	108.01.004	Macro zoom objective Computar MLH-10X
320	1	pc.	3	108.06.010	Tele converter 2x with C-mount
321	2	pc.	3	109.08.003	Fan 40x40x10 mm, 24 VDC
322	1	pc.	3	109.16.095	Cable Firewire 6pin/6pin, Length 3m
323	1	pc.	3	109.24.027	Dioden Pointer
324	1	pc.	2	109.51.058	Warning label 15 x 15mm Laser beam
325	2	pc.	-	100.05.027	Cyl. pin d 3-h6 x8
327	2	pc.	-	100.00.014	Cyl. screw M3x5, BN3
601	1	pc.	-	300.00.439	Terminal strip
602	1	pc.	3	300.01.214	Upper illumination board (LED green)
603	1	pc.	3	300.00.458	Lower illumination board
axis					
605	1	pc.	3	9002.15.011	Gear motor vision
606	1	pc.	-	300.00.501	Robotic cable vision motors
607	1	pc.	-	300.00.526	Robotic cable IO-Signal vision
608	1	pc.	-	300.00.908	LED-Vision light cable

300.01.052 Prism attachment adjustable

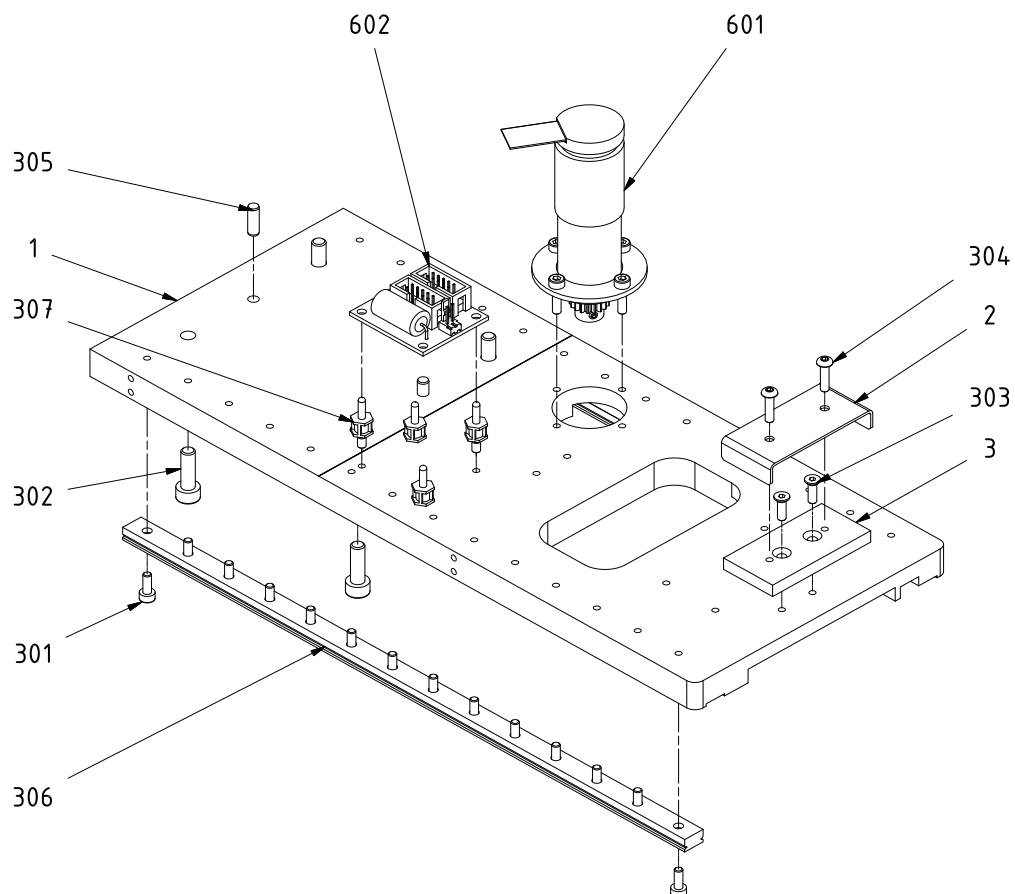


Initial date:12.06.2006/CL

Change index:0 /04.02.2009/MH

Pos.	Amount	Unit	Spare part class	Article number	Article description
1	1	pc.	3	200.01.123	Beam splitter prism 30mm
2	1	pc.	-	200.01.929	Fassung Prisma
3	1	pc.	-	200.01.930	Drehlager
4	2	pc.	-	200.01.931	Klemmplatte Prisma
5	1	pc.	-	200.01.932	Justierschraube Y
6	1	pc.	-	200.01.933	Nocken
7	1	pc.	-	200.01.934	Justierschraube X
301	5	pc.	-	100.00.016	Cyl. screw M3x8, BN3
302	1	pc.	-	100.00.233	Gew.Stift M5x40 BN28
303	1	pc.	-	100.05.070	Zyl.Stift d 6-h6 x30 BN 858
304	1	pc.	-	100.12.016	Druckstueck M8x16 BN 13364
305	1	pc.	2	101.20.024	O-Ring di=3, s=1 Normatec
306	1	pc.	3	101.27.021	Spring D-090P
307	1	pc.	-	100.00.182	Threaded pin M4x6, BN28
308	4	pc.	-	100.10.001	U-Scheibe d3.2/6x0.5 Messing
309	1	pc.	-	100.00.015	Cyl. screw M3x6, BN3

300.01.072 Vision Y-guiding plate



Initial date:09.06.2006/CL

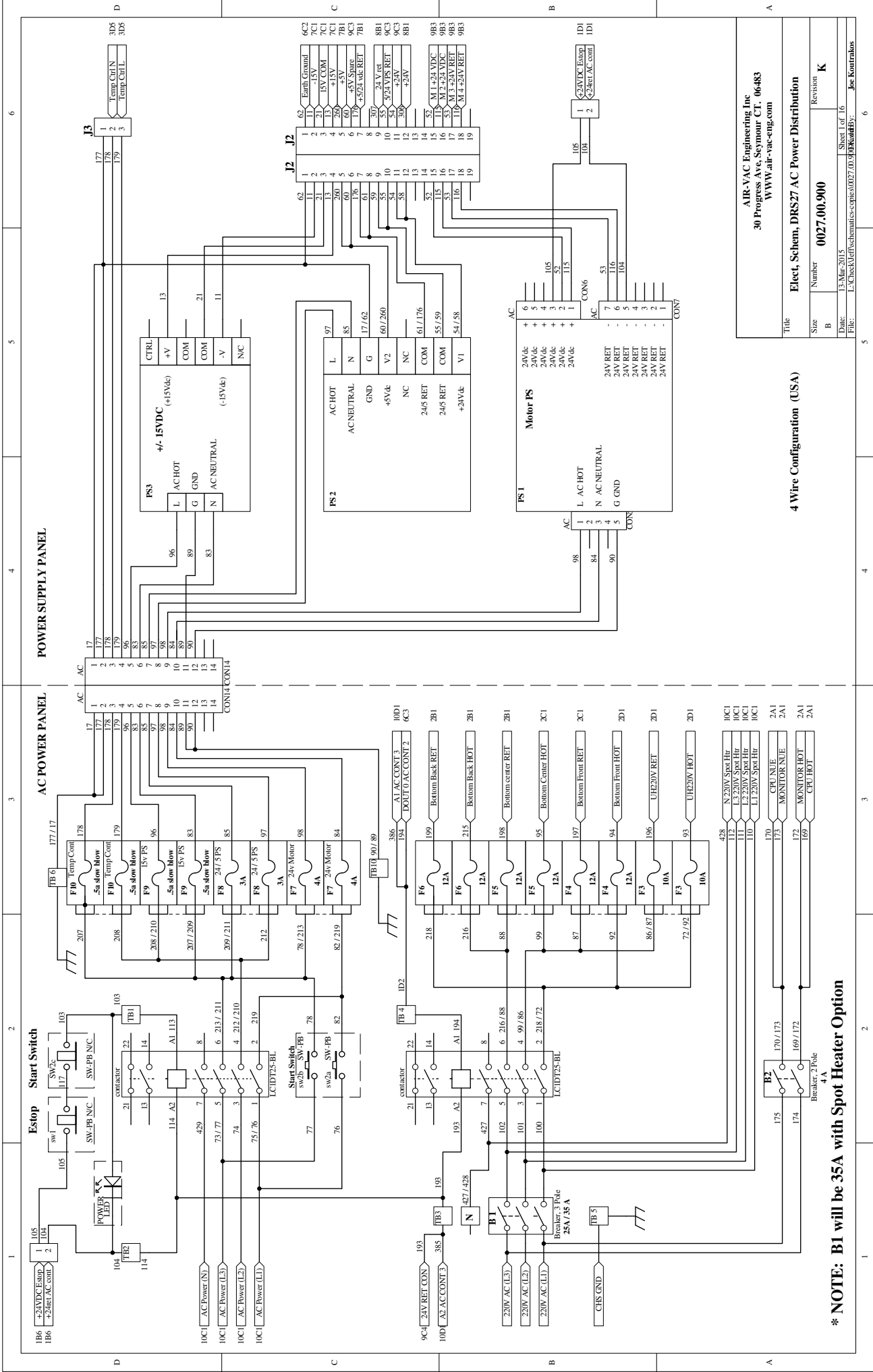
Change index:0 /23.12.2008/AG

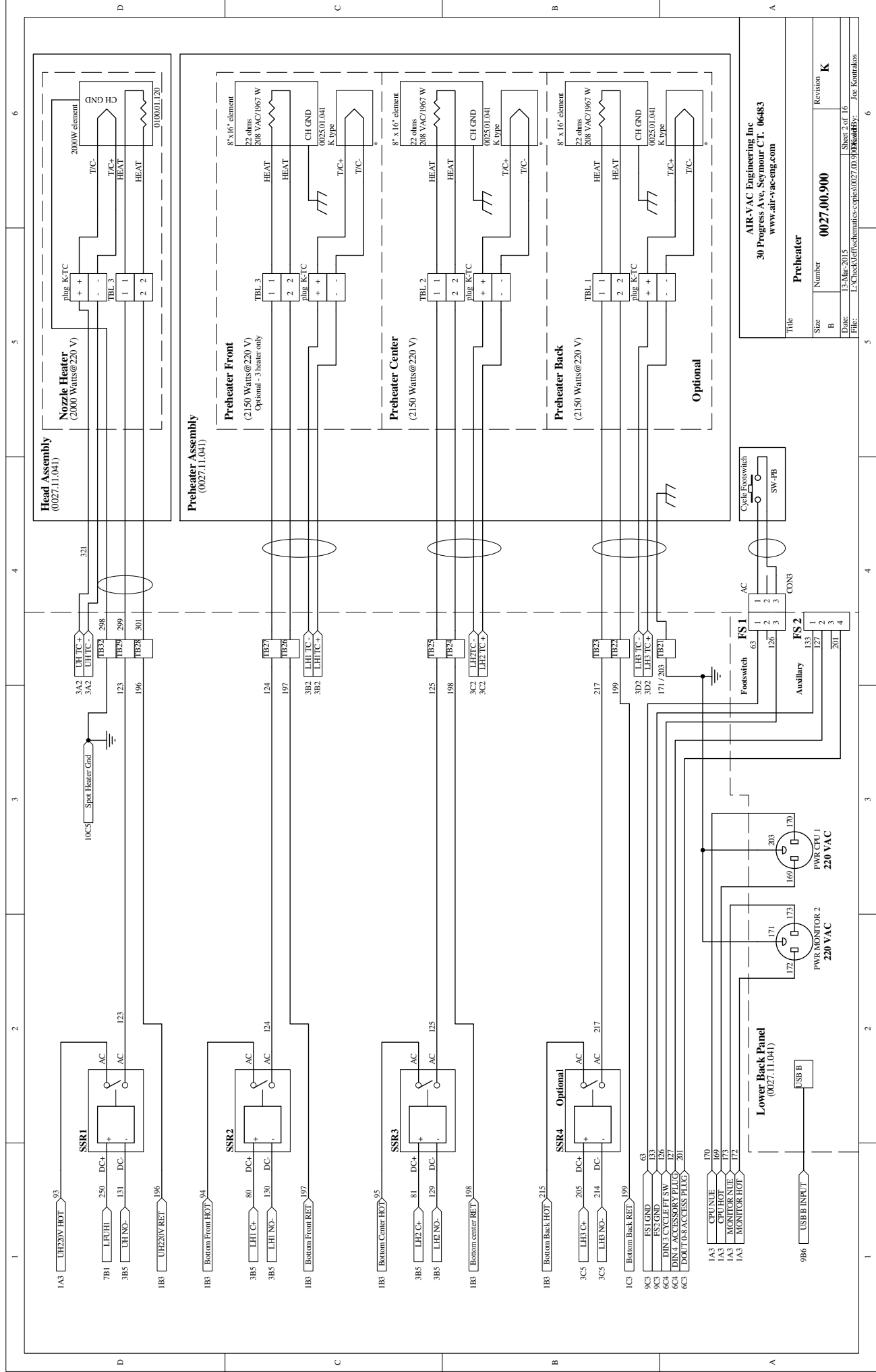
Pos.	Amount	Unit	Spare part class	Article number	Article description
1	1	pc.	-	200.01.170	Grundplatte Y-Fuehrung
2	1	pc.	-	200.02.450	Kabelbride
3	1	pc.	-	200.02.451	Kabelbride Platte
301	28	pc.	-	100.00.016	Cyl. screw M3x8, BN3
302	4	pc.	-	100.00.046	Cyl. screw M5x16, BN3
303	2	pc.	-	100.00.126	Countersunk screw M3x10, BN21
304	2	pc.	-	100.00.017	Cyl. screw M3x10, BN3
305	2	pc.	-	100.05.042	Cyl. pin d 4-h6 x16
306	2	pc.	-	102.00.022	Linear guiding rail MN 9-275-G1-V1
307	4	pc.	-	109.19.007	Spacer M3, l = 6.35mm
601	1	pc.	3	9002.05.083	Motor vision Y-axis
602	1	pc.	3	300.00.636	Motor/Encoder Interface Card
603	1	pc.	-	300.00.902	Motor interface cable
604	1	pc.	-	300.00.975	Encoder cable vision Y

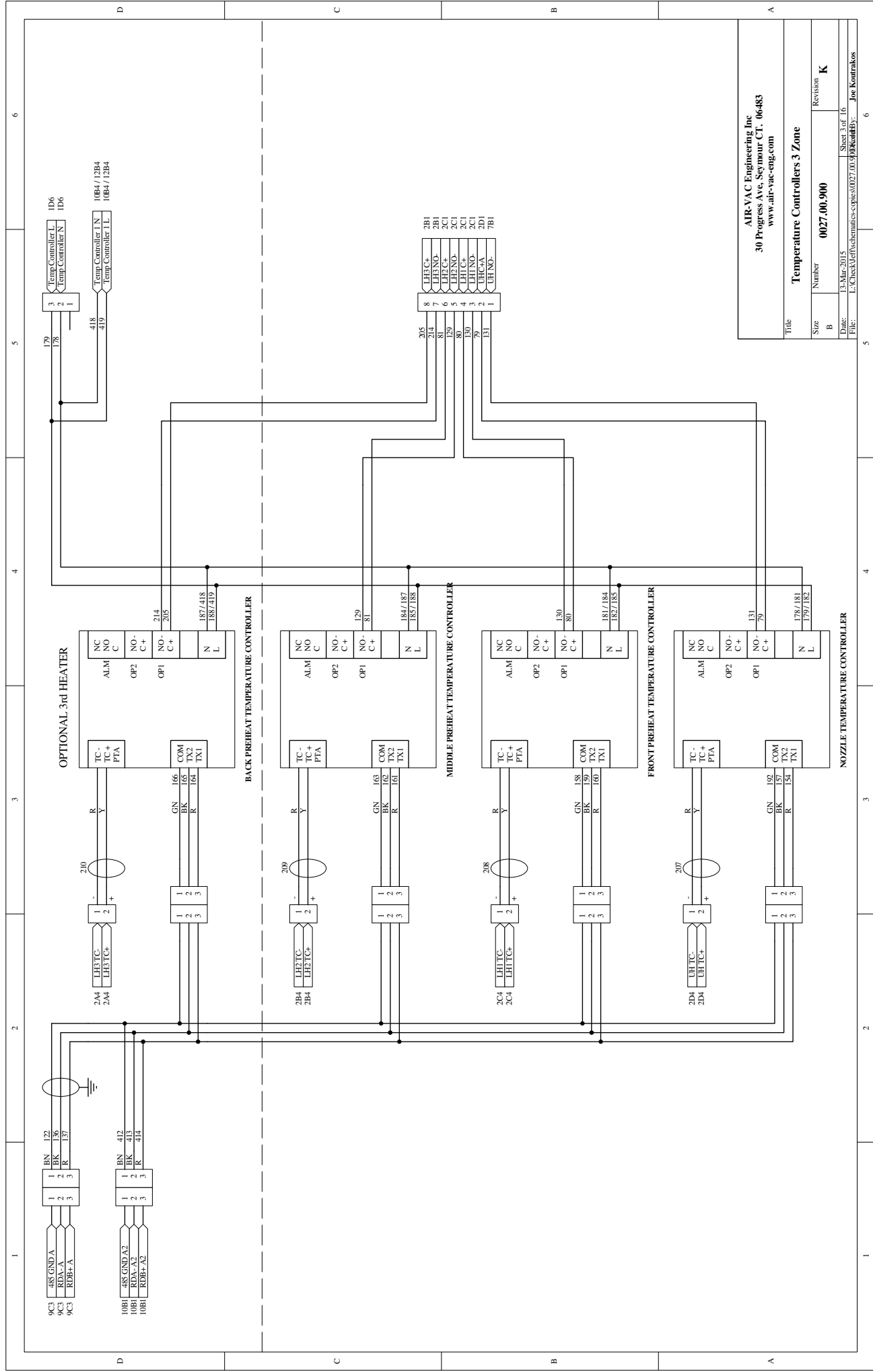
9: Schematics

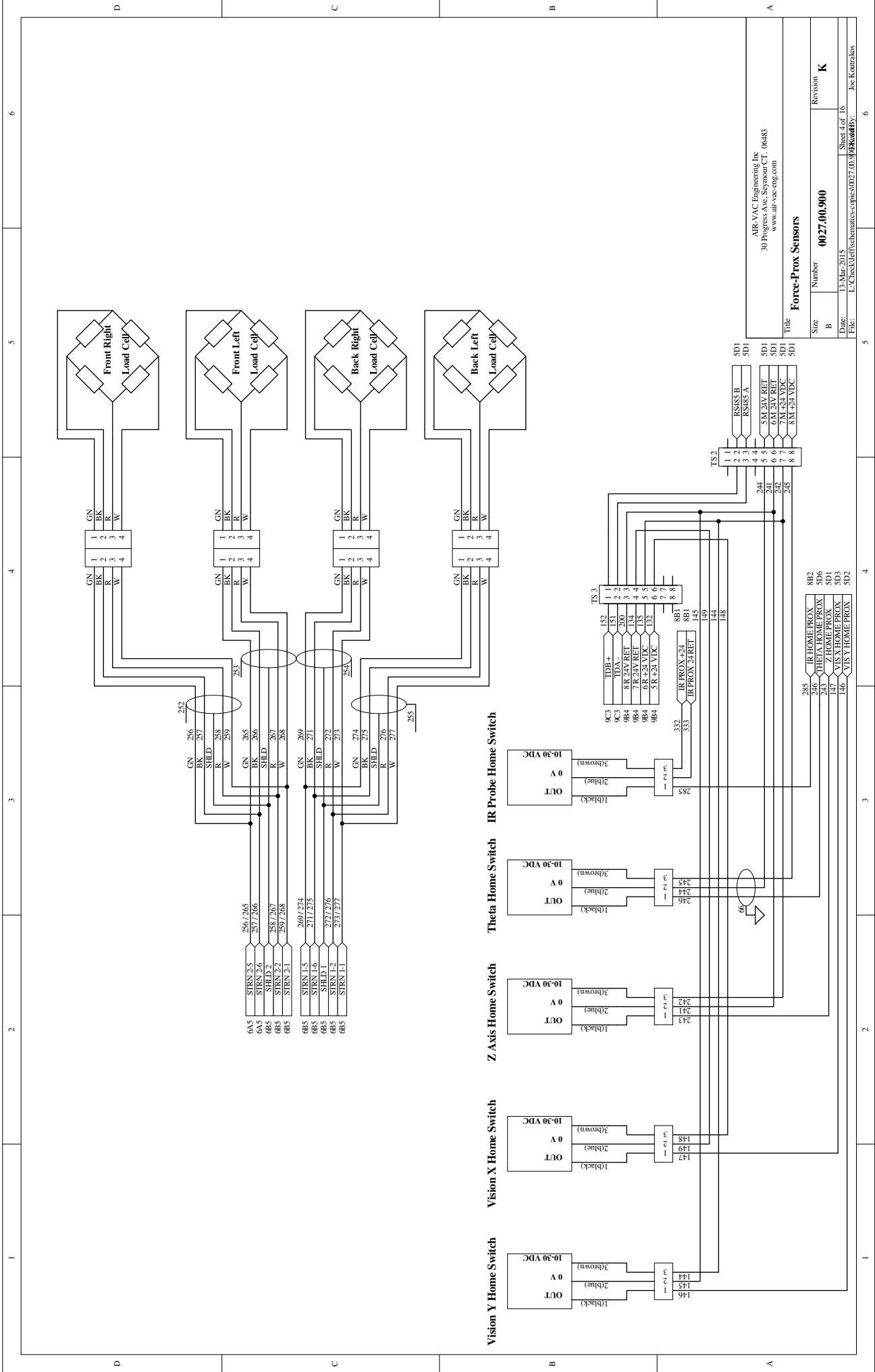
#0027.00.900: DRS27 3-Zone Preheater

#0027.21.900: DRS27 6-Zone Preheater





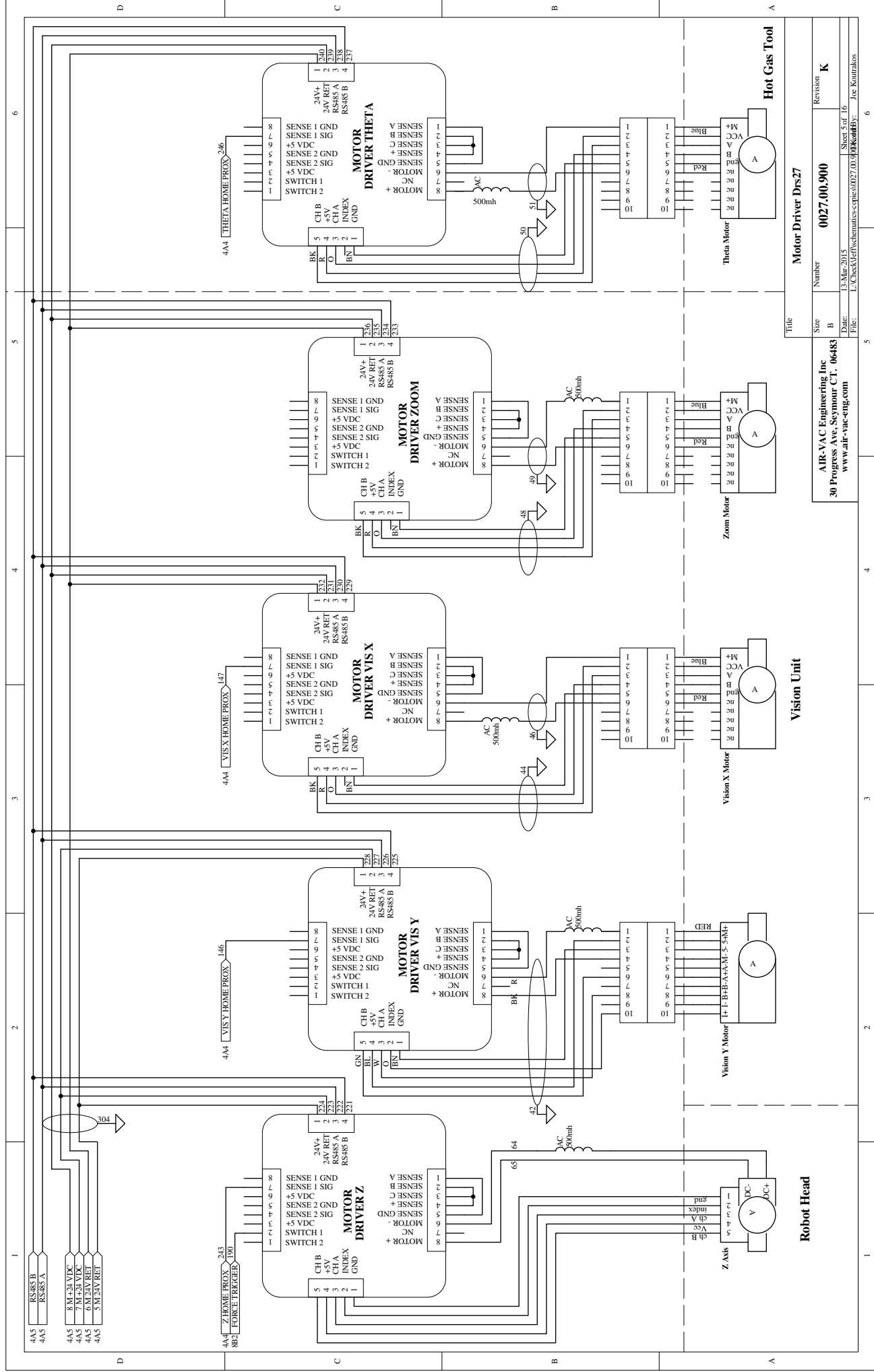




AIR-VAC Engineering Inc
30 Progress Ave. Seymour CT. 06483
www.air-vac-eng.com

Force-Prox Sensors

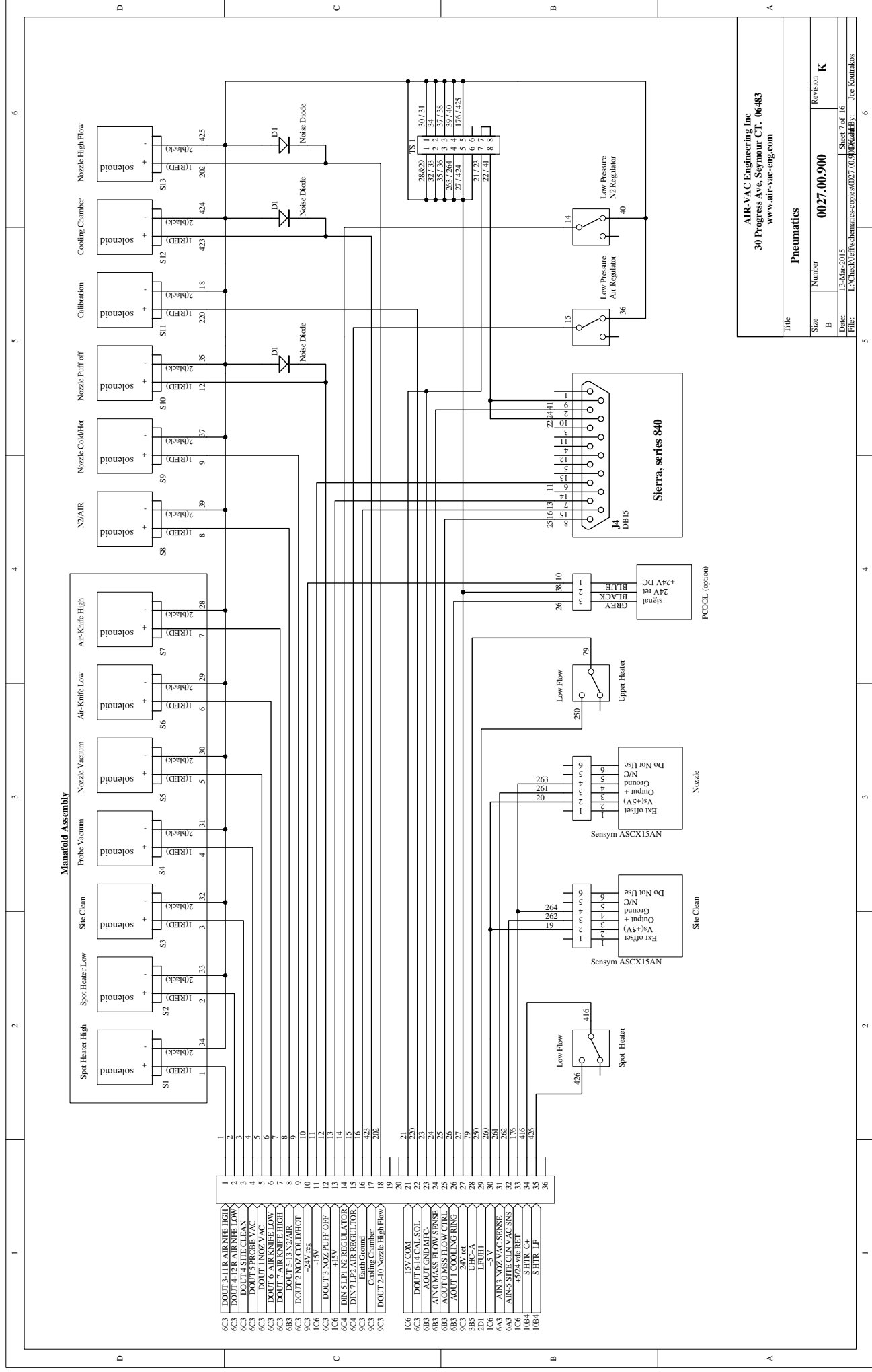
Size	Number	Revision
B	0027.00.900	K
Date:	13-Mar-2015	Sheet 4 of 16
File:	L:\Check\left\schematics\cscope\0027.00.900\K.dwg	Joe Kourmbos

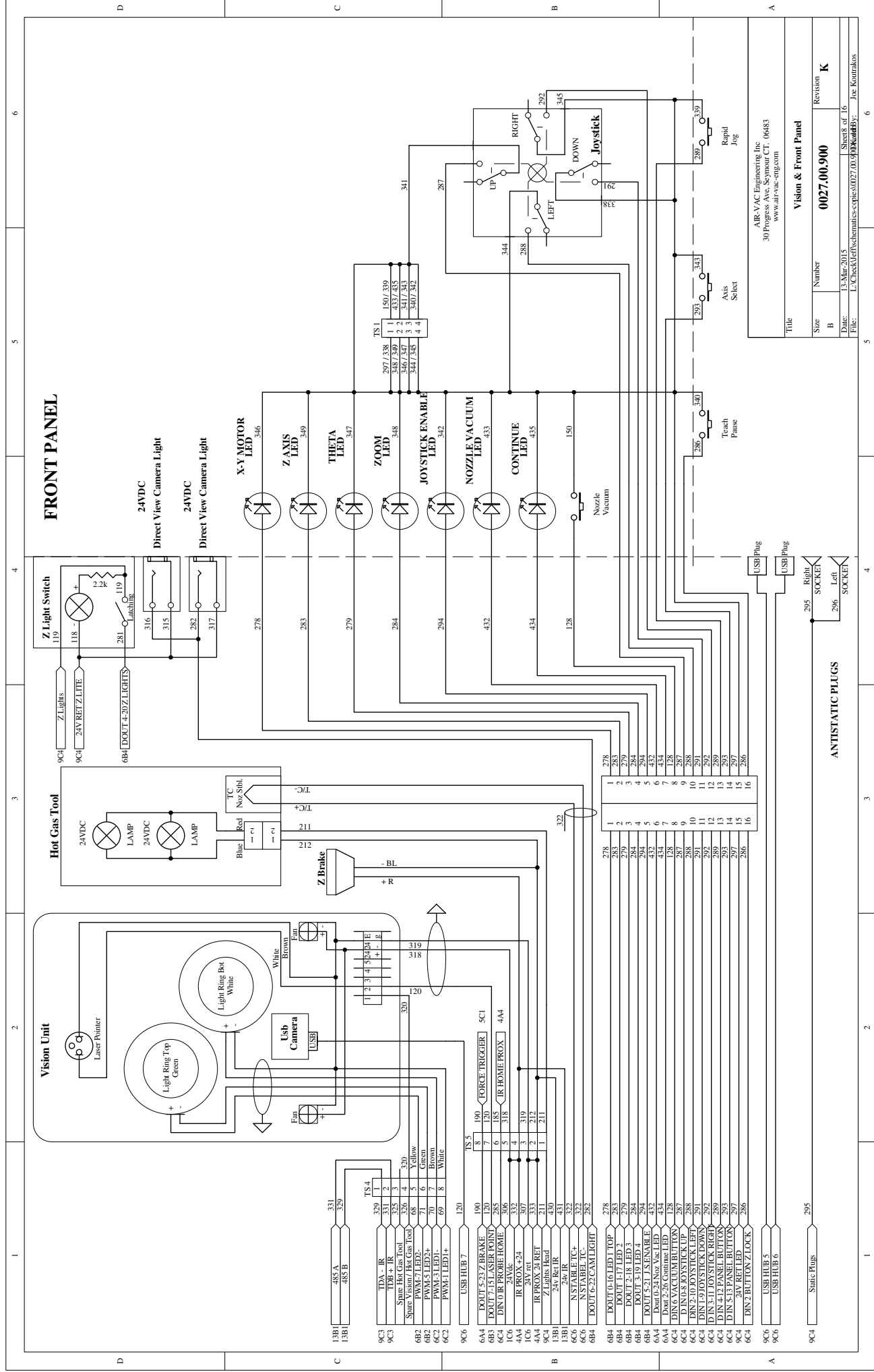


Wago Panel-1

The diagram illustrates the wiring for a WAGO Panel-1, showing the connection of various modules to a terminal block. The modules are organized into sections: 24 VDC INPUT, PWM, ANALOG OUT, DIGITAL OUT 1, DIGITAL OUT 2, DIGITAL OUT 3, DIGITAL OUT 4, DIGITAL IN 1, DIGITAL IN 2, STRAIN 1, STRAIN 2, THERMOCOUPLE 1, THERMOCOUPLE 2, THERMOCOUPLE 3, THERMOCOUPLE 4, THERMOCOUPLE 5, and END SECTION. The terminal block is labeled with 1346, WAGO X2, and 1481. The diagram also shows a side panel with terminal block connections for DIN, DOUT, and TCS modules. The side panel includes a terminal block labeled 1346, WAGO X2, and 1481. The diagram is a detailed wiring schematic for a WAGO Panel-1, showing the connection of various modules to a terminal block. The modules are organized into sections: 24 VDC INPUT, PWM, ANALOG OUT, DIGITAL OUT 1, DIGITAL OUT 2, DIGITAL OUT 3, DIGITAL OUT 4, DIGITAL IN 1, DIGITAL IN 2, STRAIN 1, STRAIN 2, THERMOCOUPLE 1, THERMOCOUPLE 2, THERMOCOUPLE 3, THERMOCOUPLE 4, THERMOCOUPLE 5, and END SECTION. The terminal block is labeled with 1346, WAGO X2, and 1481. The diagram also shows a side panel with terminal block connections for DIN, DOUT, and TCS modules. The side panel includes a terminal block labeled 1346, WAGO X2, and 1481.

Date:	13-Mar-2015	Sheet 6 of 16
File:	L:\Check\Jeff\schematics-copies\0027.00.9006\Bv- Joe Koutrakos	





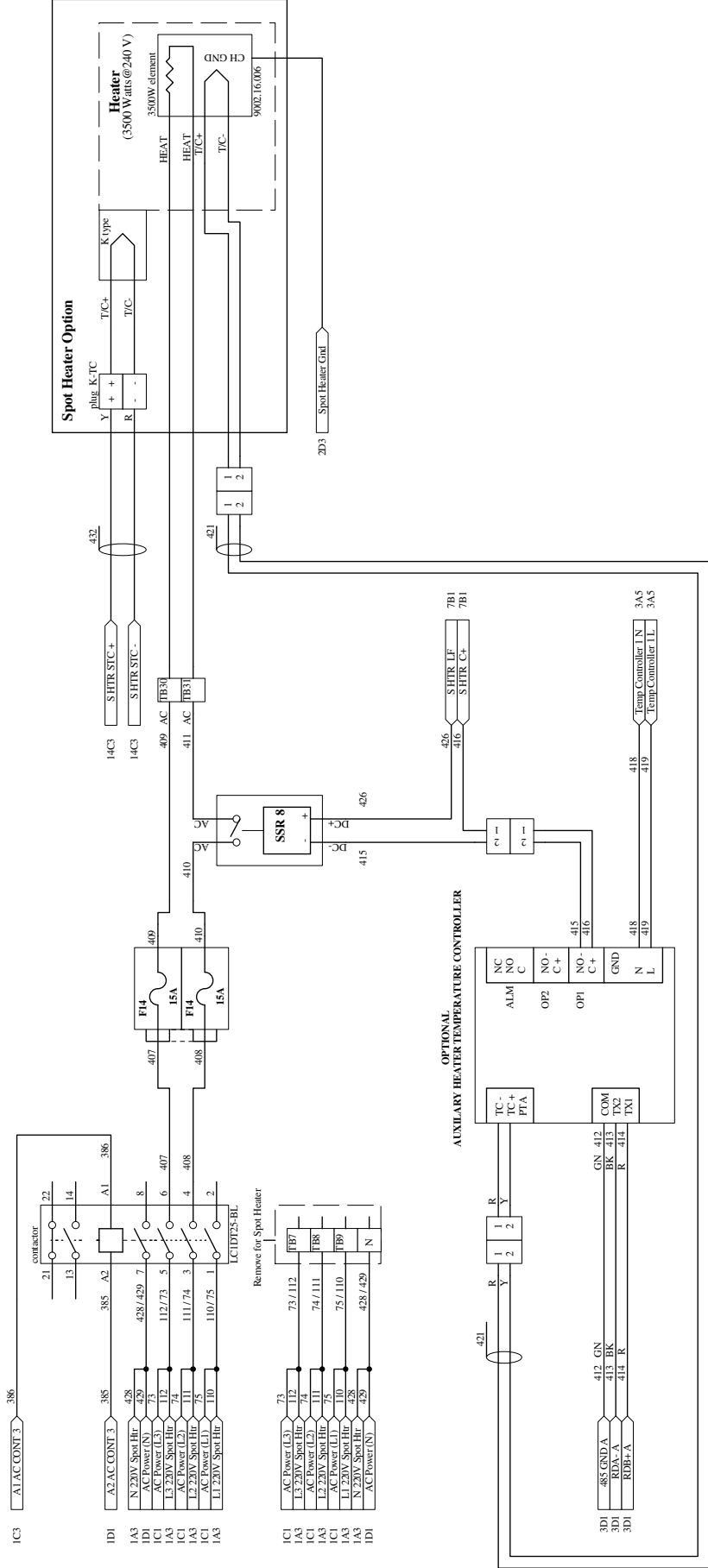
1000



McC Engineering Inc
Ave, Seymour CT.

Revision	K
Sheet 9 of 16	
Drawn By:	Joe Kontralos

Spot Heater

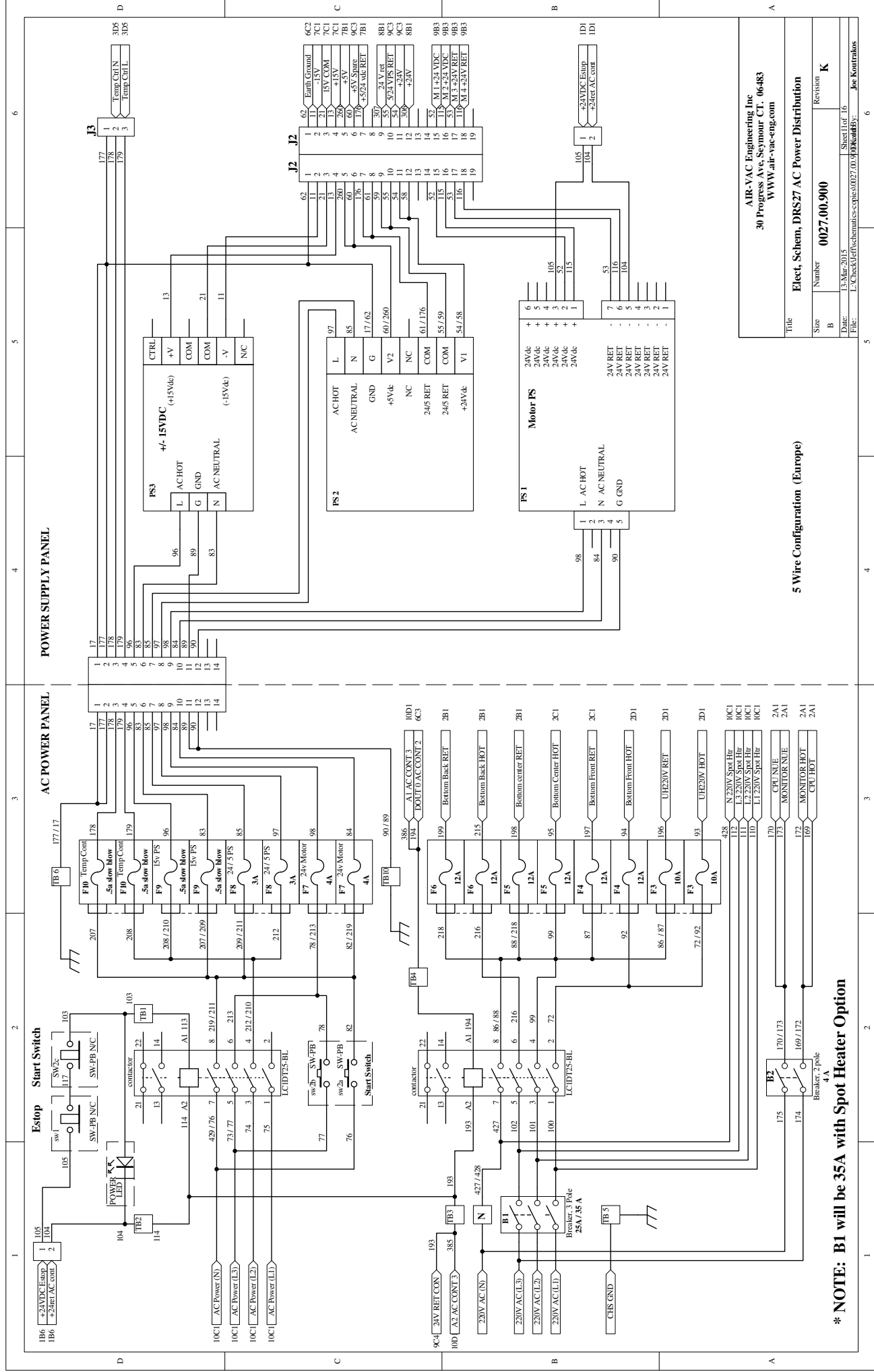


AIR-VAC Engineering, Inc.
30 Progress Ave, Seymour CT.
06483

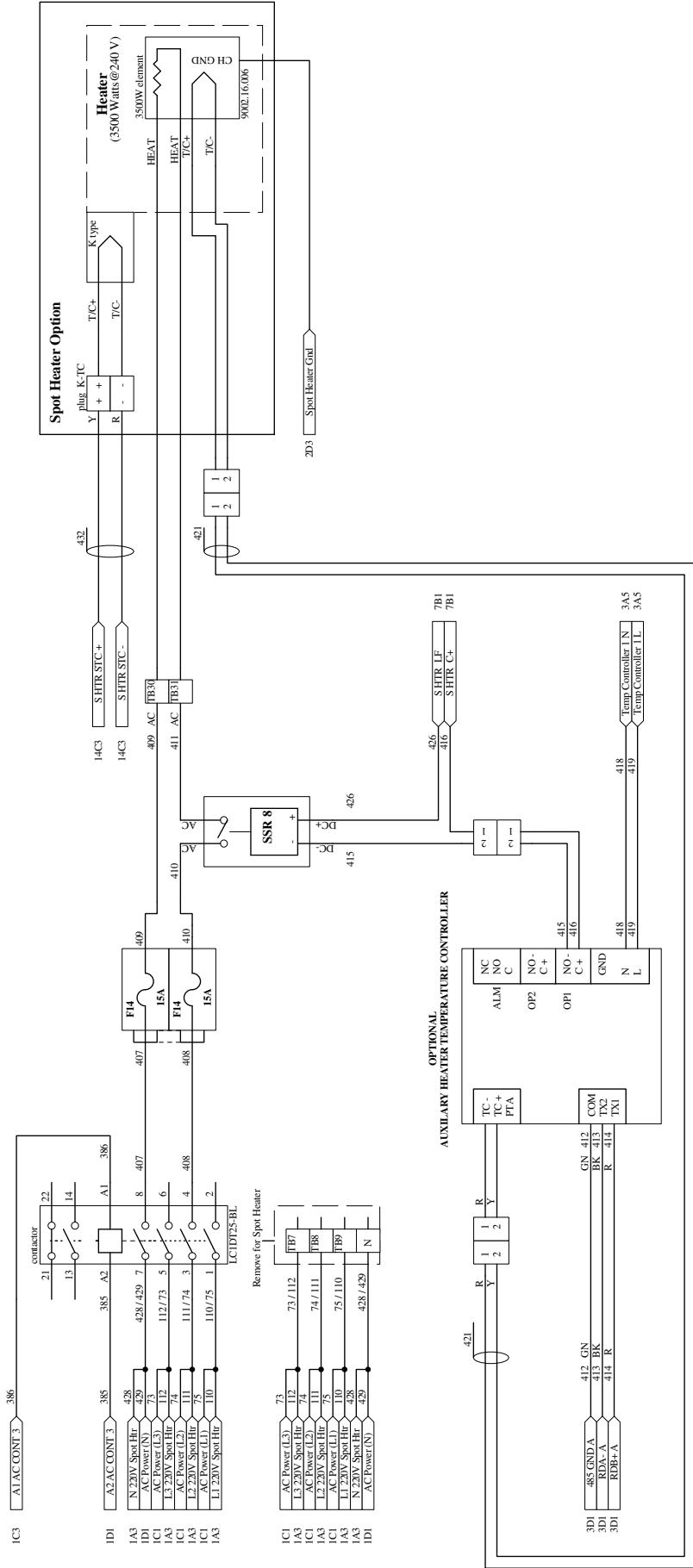
4 Wire Configuration (USA)

Spot Heater

Title		Revision	
Size	Number	Revision	
B	0027.00.900	K	
Date:	13-Mar-2015	Sheet 06 of 16	Joe Kourmbos
File:	L:\Check\left\{schematics\cops\0027\00900\K\left\{K\right\}.docx		



Spot Heater



AIR-VAC Engineering, Inc.
30 Progress Ave, Seymour CT.
06483

Title
Spot Heater

Size
B

Number
0027.00.900

Revision
K

Date
13-Mar-2015

File
L:\Check\left\schematics\cops\0027.00.900\K.dwg

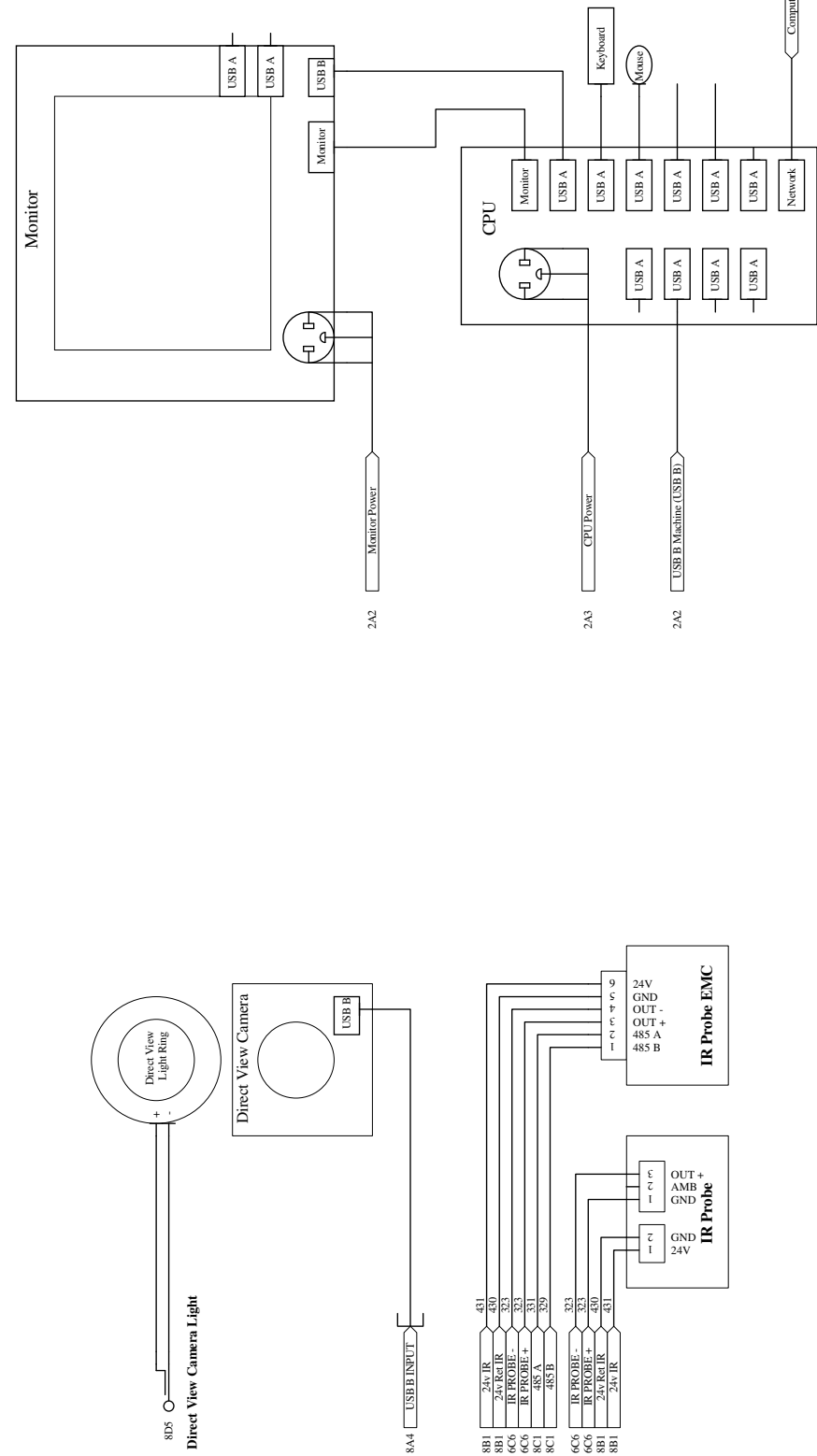
Sheet 12 of 16

Joe Kourmbos

Computer & Options

Machine Options

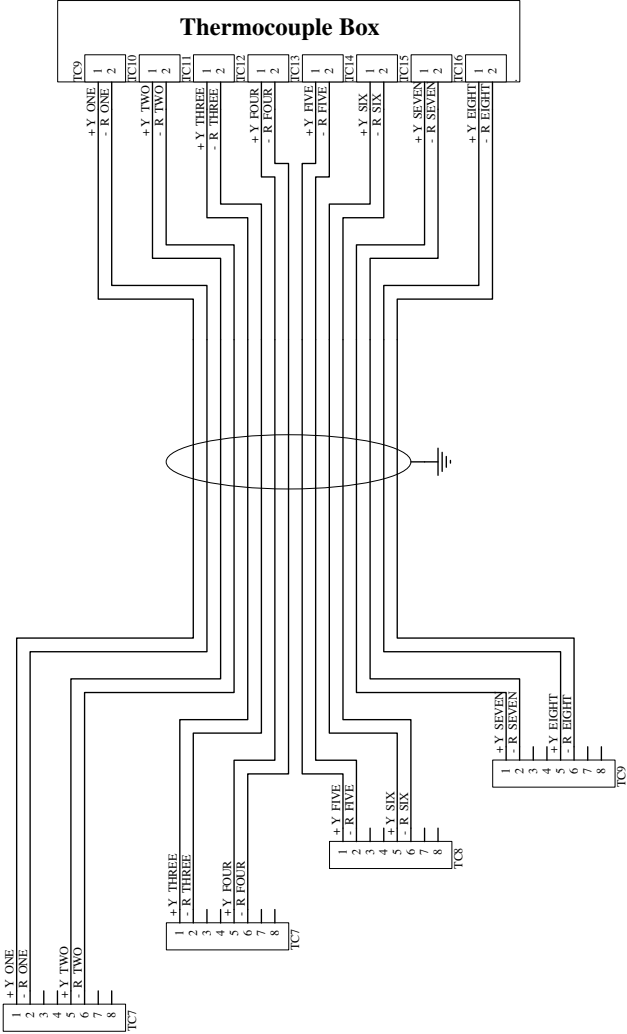
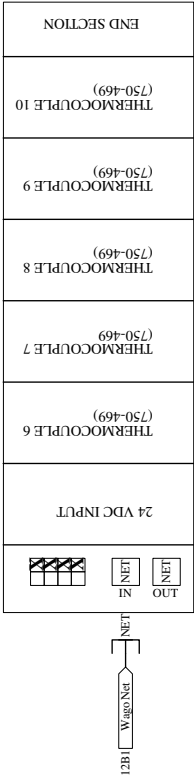
Computer & Monitor



AIR-VAC Engineering, Inc.
30 Progress Ave, Seymour CT.
06483

Computer & Options			
Title	Size	Number	Revision
	B	0027.00.900	K
Date:		13-Mar-2015	Sheet 13 of 16
File:		L:\Check\left\{schematics-copie\0027.00.900\0027.00.900.dwg	Joe Kourmikos

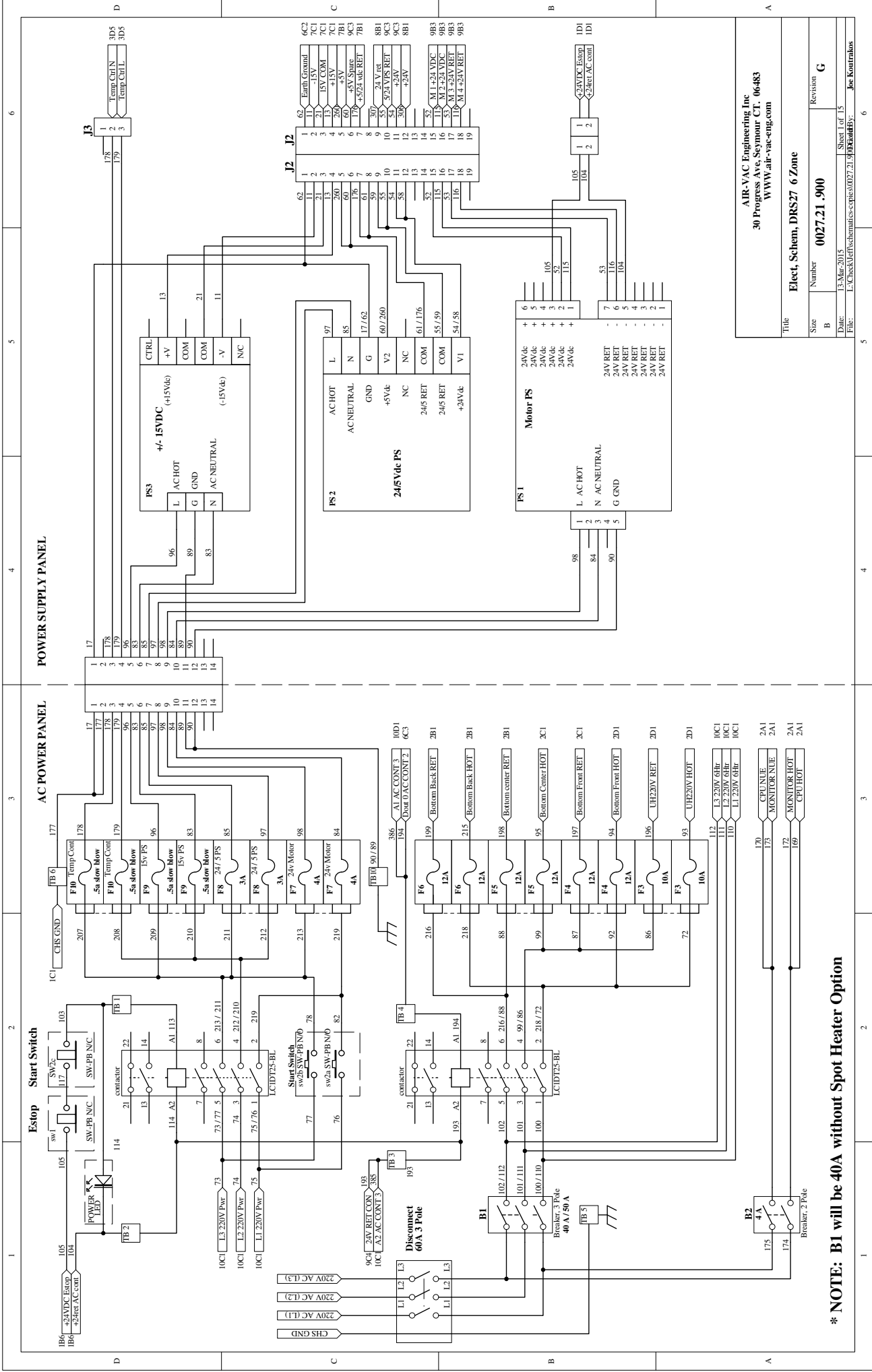
Wago Panel-1

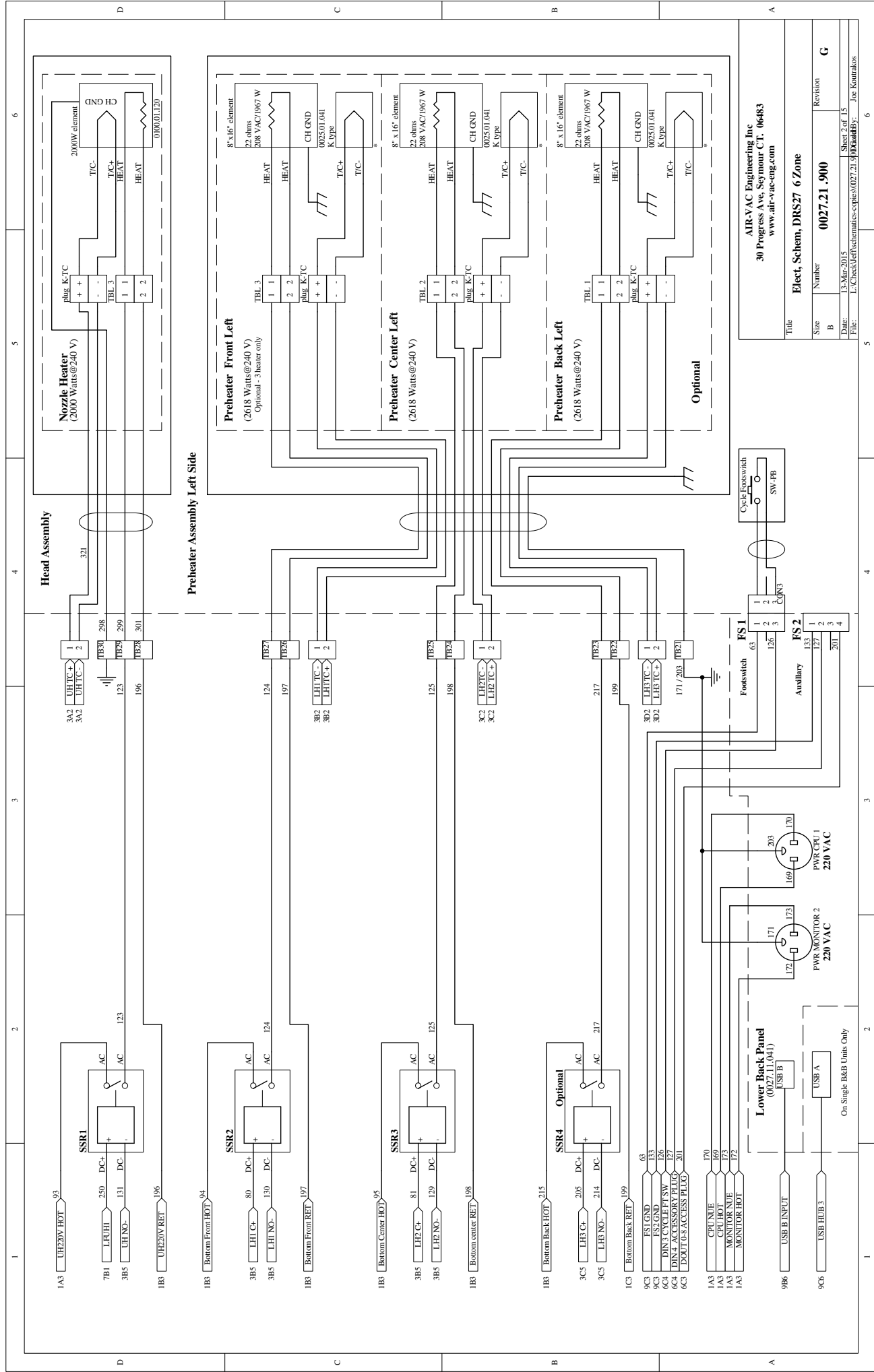


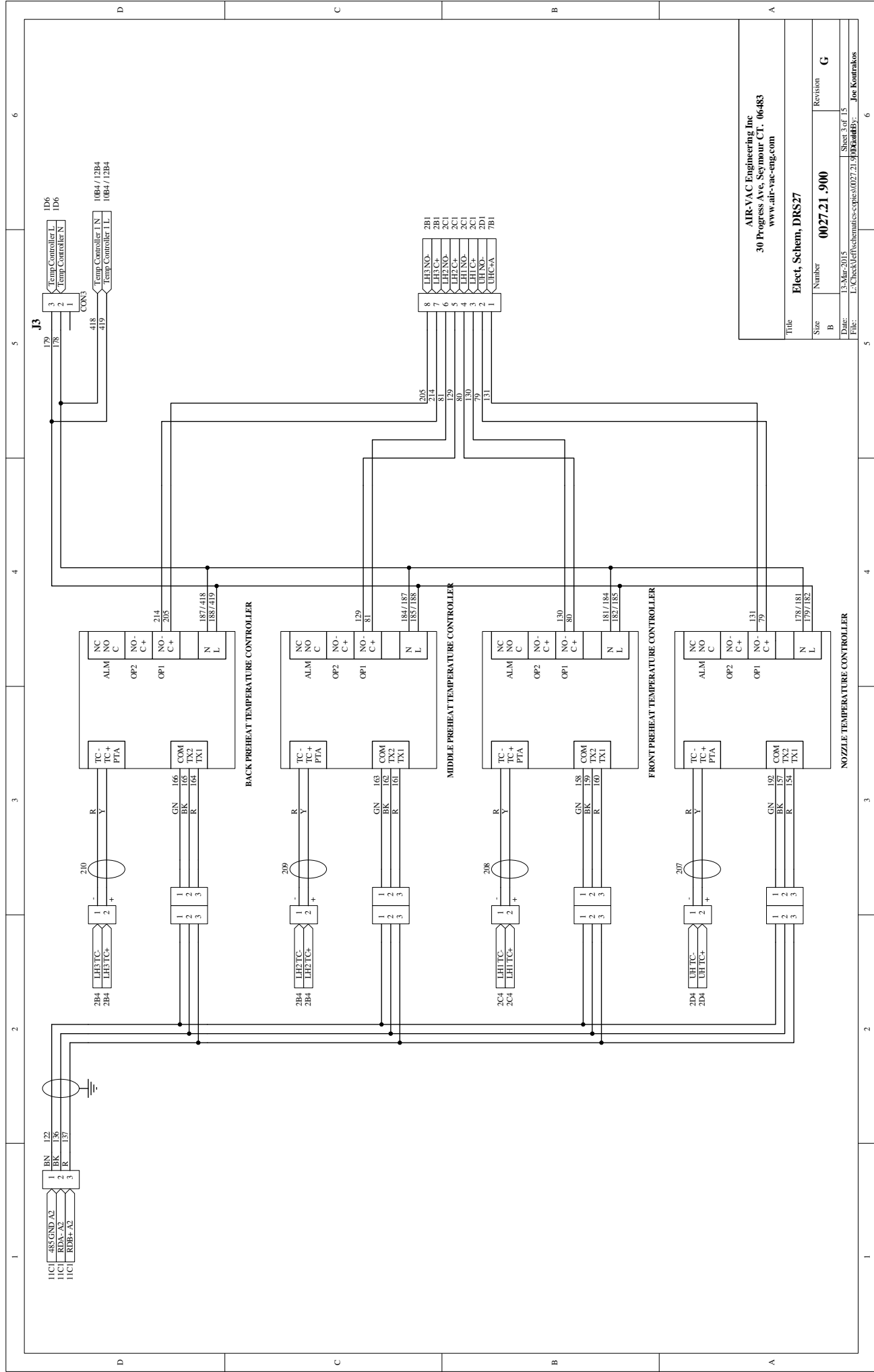
AIR-VAC Engineering, Inc.
30 Progress Ave, Seymour CT.
06483

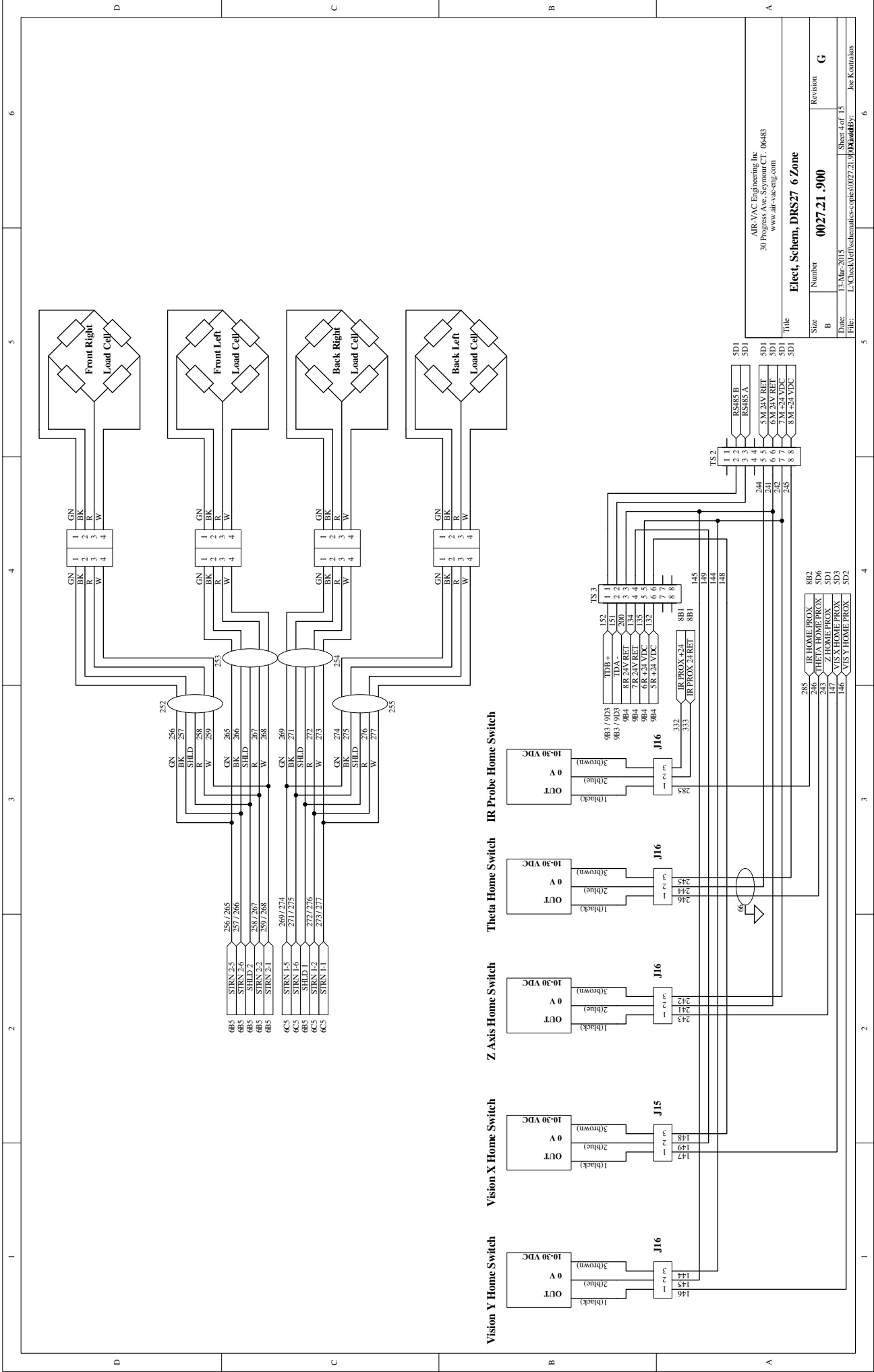
Wago 2 Option
0027.00.900

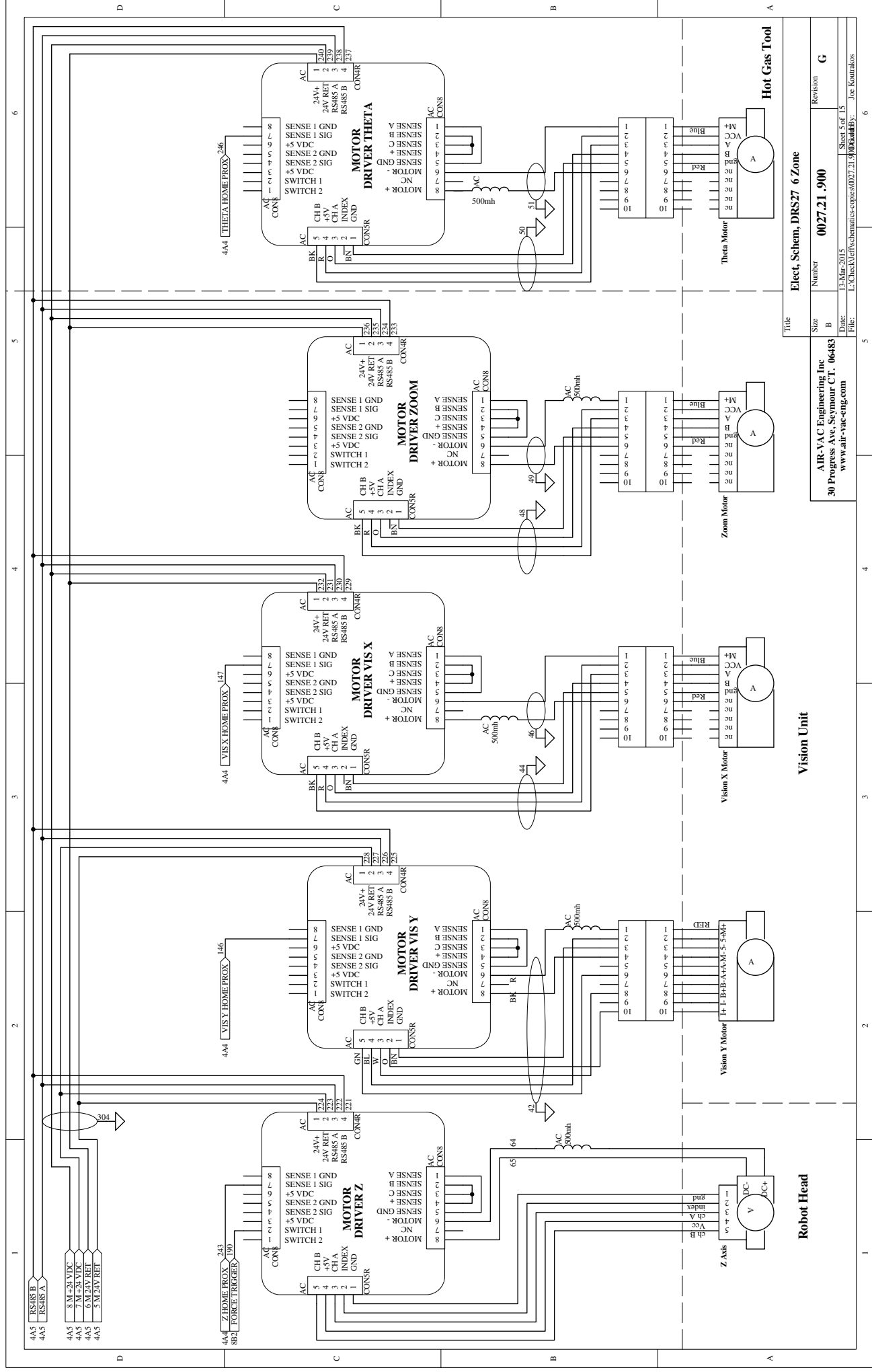
Size	Number	Revision
B	0027.00.900	K
Date:	13-Mar-2015	Sheet 4 of 16
File:	L:\Check\left\schematics-copys\0027.00.900\K\	Joe Kourmbos







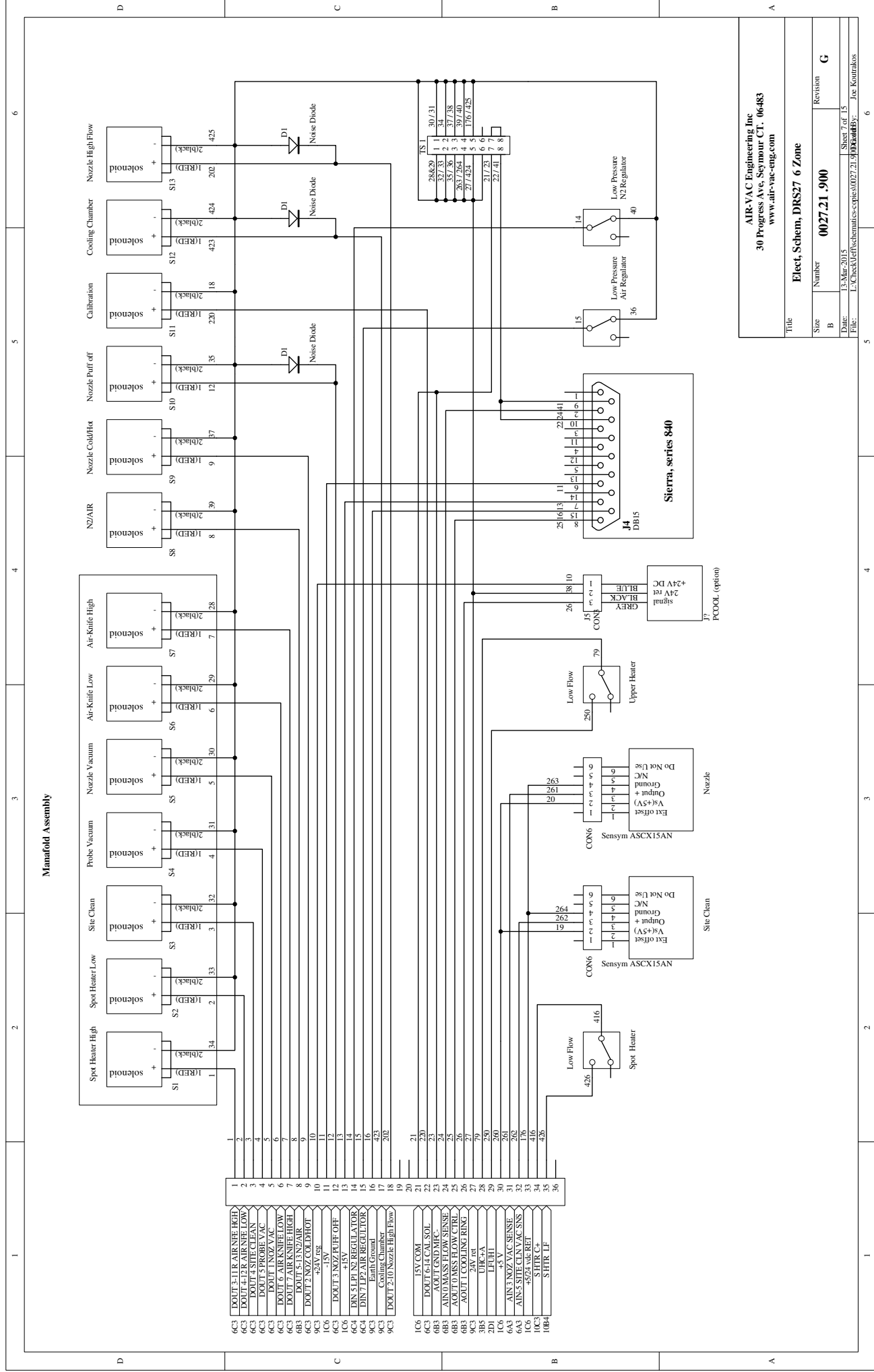


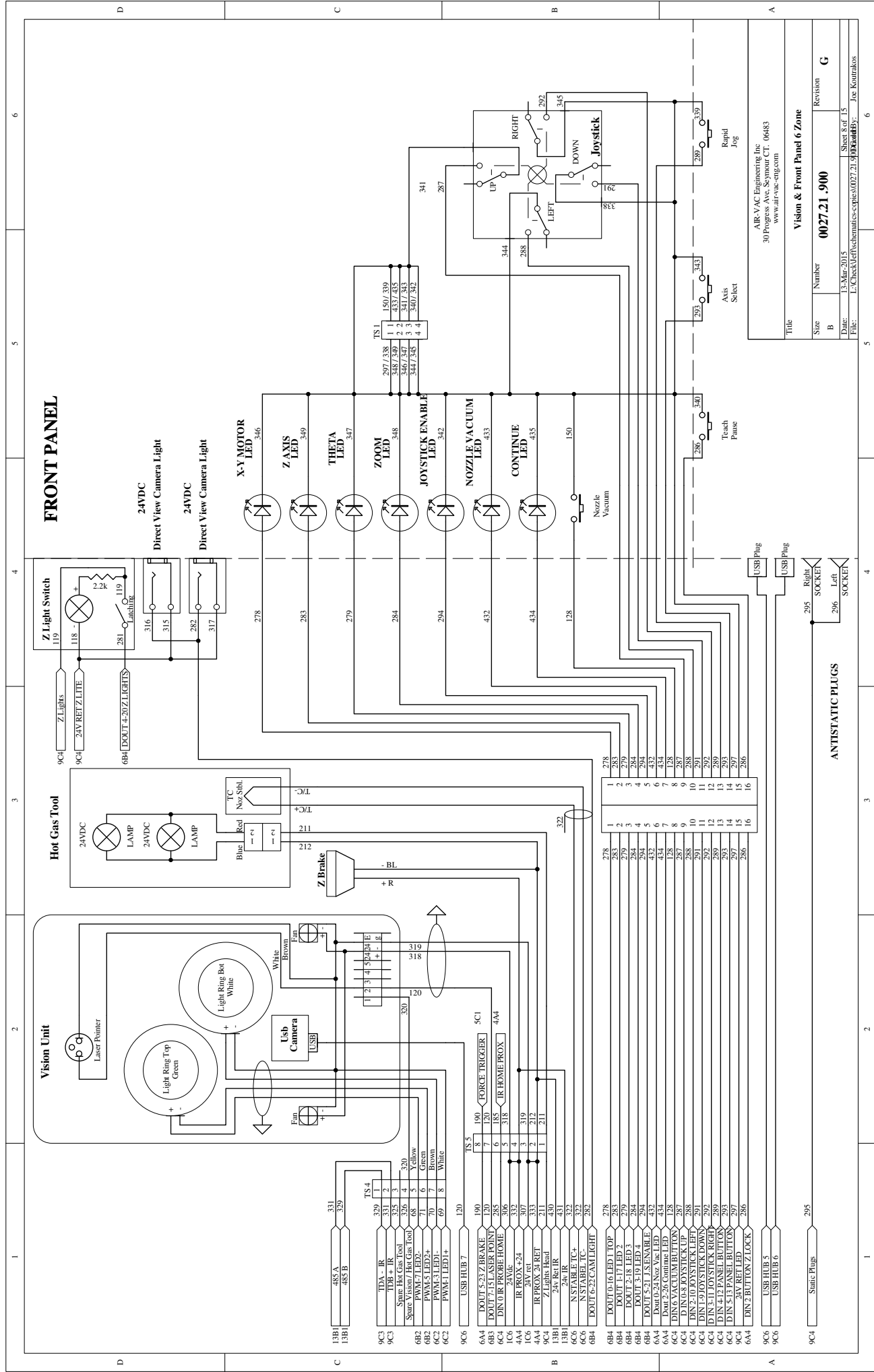


[illegible]

Title	
Size	Number
	0027.21.900

Title		Elect, Schem, DRS27 6 Zone
Size B	Number	
		0027.21 .900
Date:		13-Mar-2015
File:		L:\CheckUser\thermatics-copies\0027.21

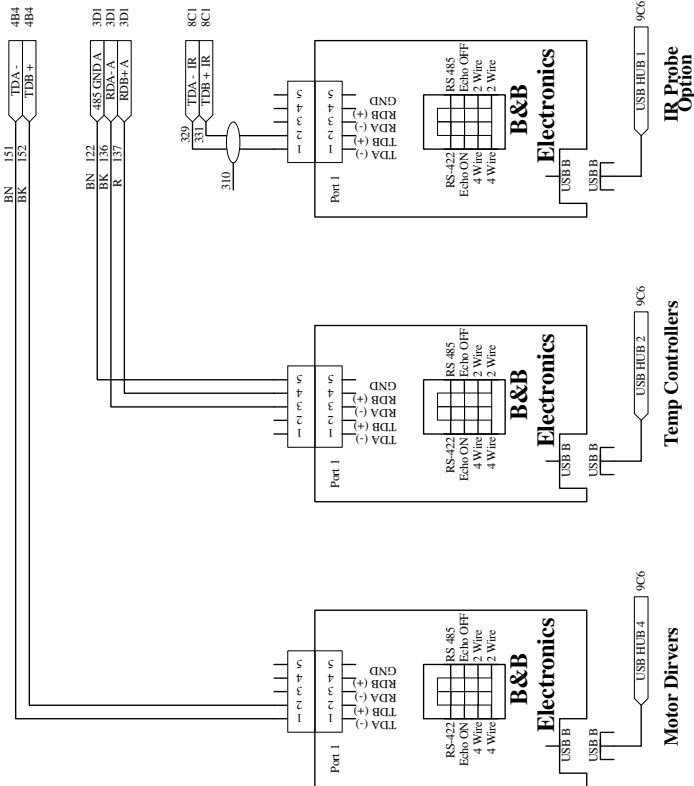




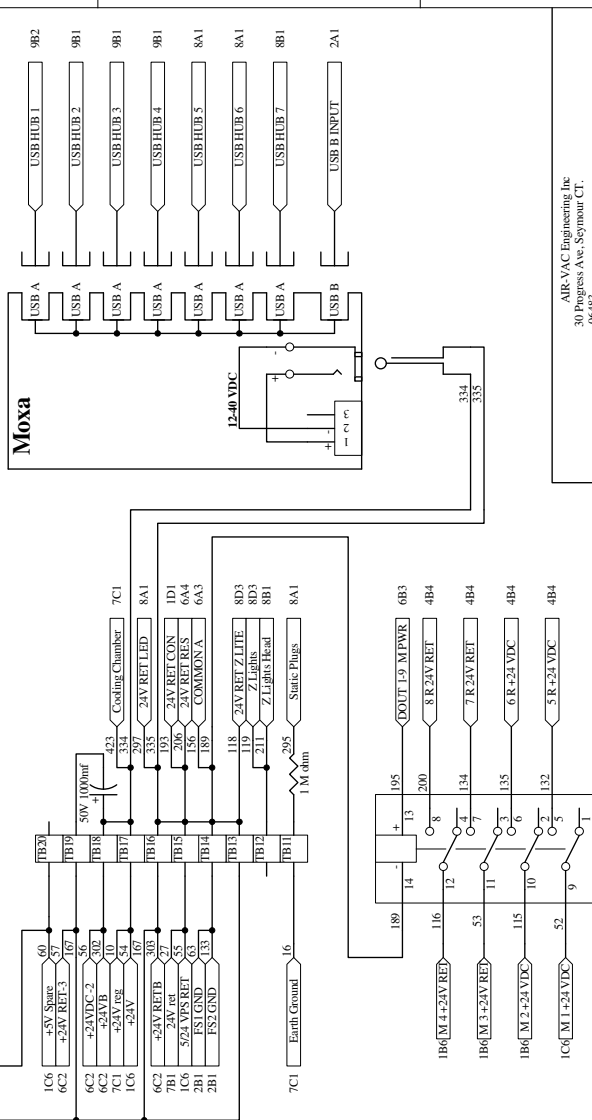
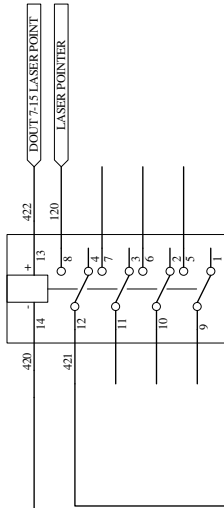
Wago Panel-2

Left Wall

Base



5 Vdc Laser Option (UL)



AIR-VAC Engineering, Inc.
30 Progress Ave, Seymour CT.
06483

Title **Elect. Schem. DRS27 6 Zone**

Size **0027.21 .900**

Number

Revision

G

Date: 13-Mar-2015

Sheet 9 of 15

Joe Kourklos

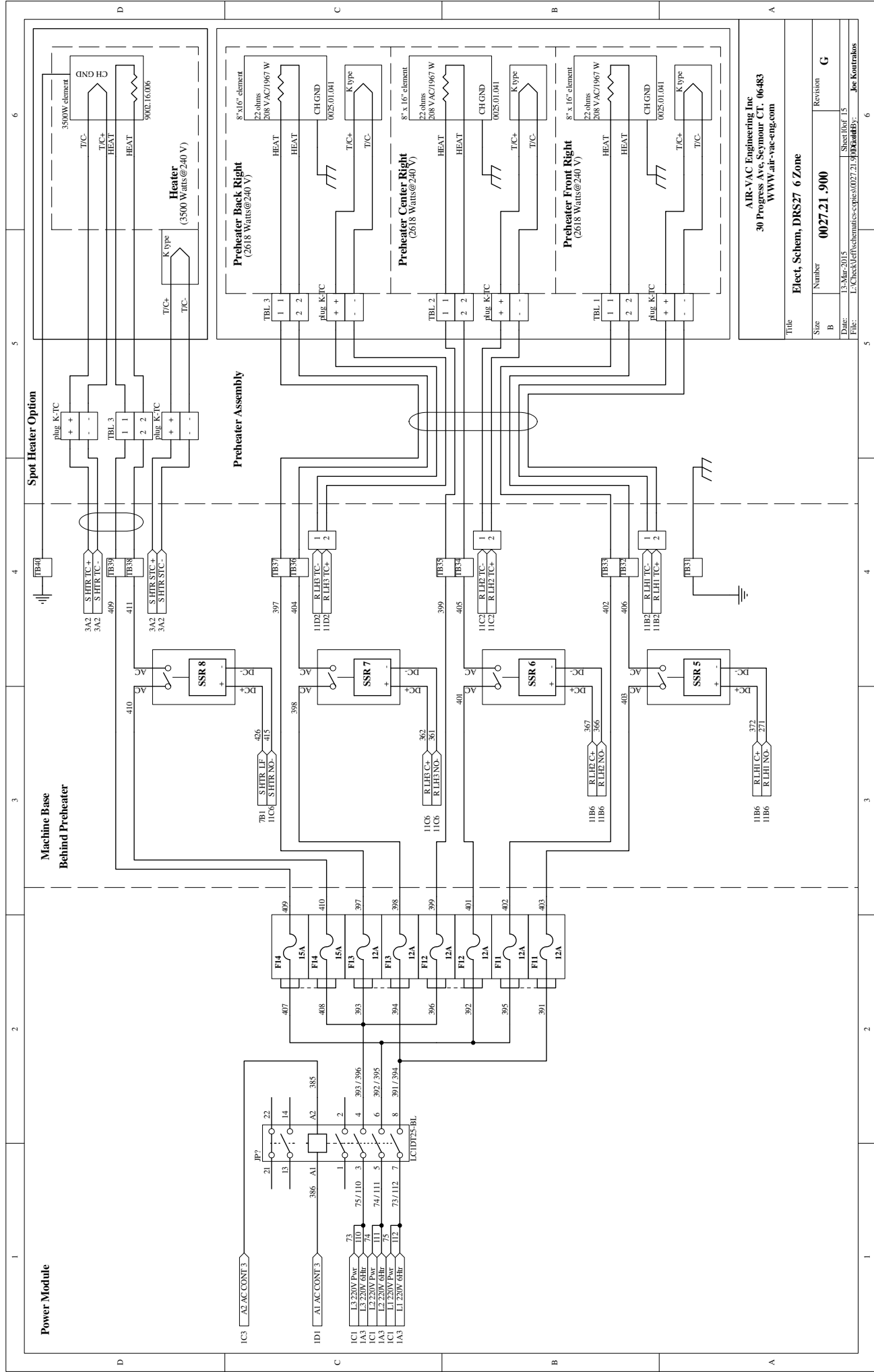
File: L:\Check\left\schematics-copys\0027.21.900\elect.dwg

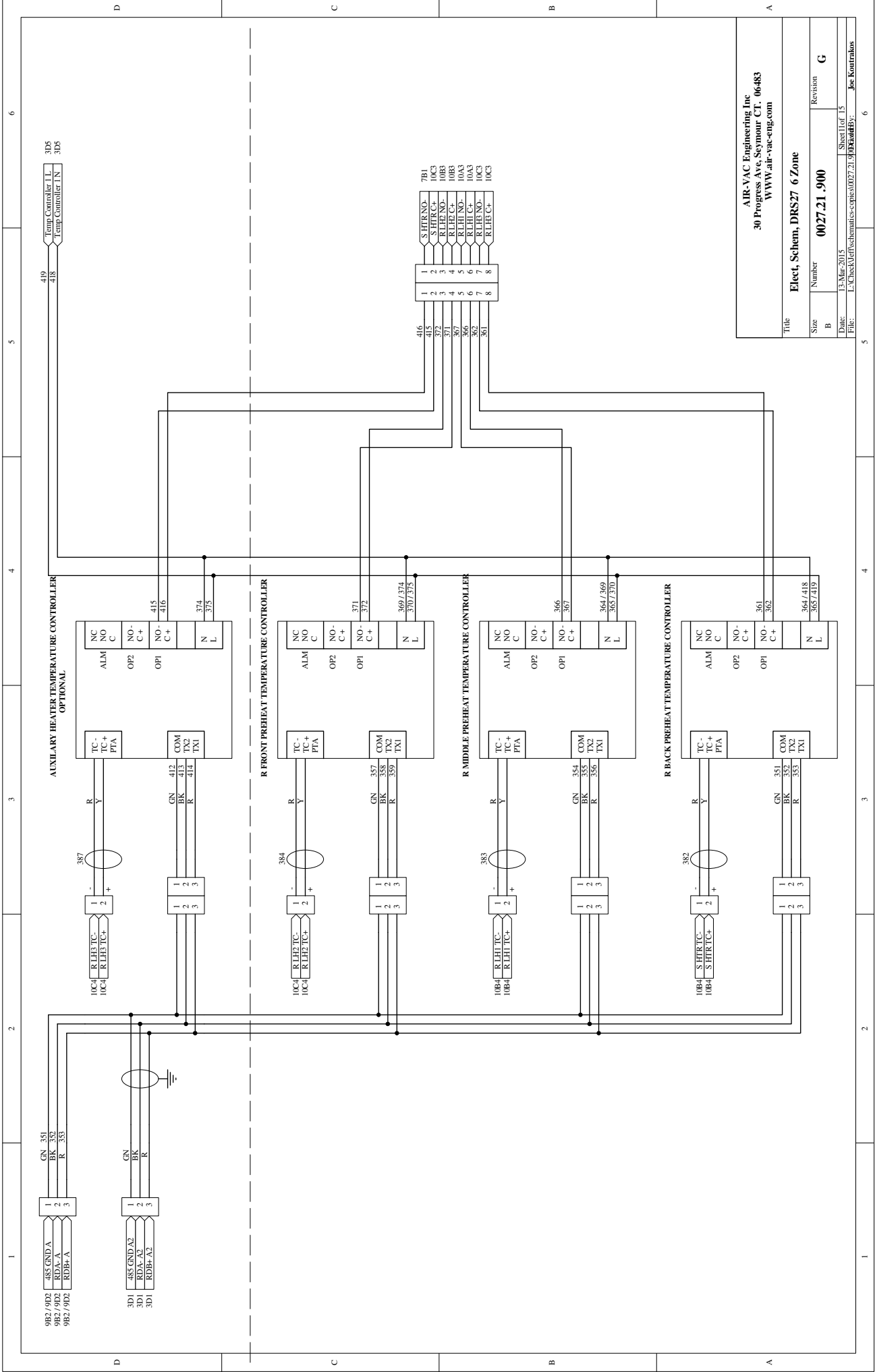
0027.21.900

13-Mar-2015

Sheet 9 of 15

Joe Kourklos





AIR-VAC Engineering Inc 30 Progress Ave, Seymour CT. 06483 WWW.air-vac-eng.com			
Title Elect, Schem, DRS27 6 Zone			
Size B			
Number 0027.21 .900			
Revision G			
Date 13-Mar-2015			
File L:\Check\left\{schematics\scope\0027.21.900\0027.21.900.dwg			
Joe Koutalos			

6



--	--

21

6

1

